Spectre® Circuit Simulator Reference

Product Version 5.0 July 2002

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Preface

This manual assumes that you are familiar with the development, design, and simulation of integrated circuits and that you have some familiarity with SPICE simulation. It contains information about the Spectre[®] circuit simulator.

Spectre is an advanced circuit simulator that simulates analog and digital circuits at the differential equation level. The simulator uses improved algorithms that offer increased simulation speed and greatly improved convergence characteristics over SPICE. Besides the basic capabilities, the Spectre circuit simulator provides significant additional capabilities over SPICE. SpectreHDL (Spectre High-Level Description Language) and Verilog[®]-A use functional description text files (modules) to model the behavior of electrical circuits and other systems. SpectreRF adds several new analyses that support the efficient calculation of the operating point, transfer function, noise, and distortion of common RF and communication circuits, such as mixers, oscillators, sample holds, and switched-capacitor filters.

This preface discusses the following topics:

- Related Documents on page Preface-9
- Typographic and Syntax Conventions on page Preface-10
- References on page Preface-11

Related Documents

The following can give you more information about the Spectre circuit simulator and related products:

- To learn more about the equations used in the Spectre circuit simulator, consult the Spectre Circuit Simulator Device Model Equations manual.
- The Spectre circuit simulator is often run within the Cadence[®] analog circuit design environment, under the Cadence[®] design framework II. To see how the Spectre circuit simulator is run under the analog circuit design environment, read the <u>Cadence Analog Design Environment User Guide</u>.
- For more information about using the Spectre circuit simulator with SpectreHDL, see the SpectreHDL Reference manual.

- For more information about using the Spectre circuit simulator with Verilog-A, see the Verilog-A Language Reference manual.
- If you want to see how SpectreRF is run under the analog circuit design environment, read <u>SpectreRF Help</u>.
- For more information about RF theory, see <u>SpectreRF Theory</u>.
- For more information about how you work with the design framework II interface, see <u>Design Framework II Help</u>.
- For more information about specific applications of Spectre analyses, see *The Designer's Guide to SPICE & Spectre*¹.

Typographic and Syntax Conventions

This list describes the syntax conventions used for the Spectre circuit simulator.

- literal Nonitalic words indicate keywords that you must enter literally. These keywords represent command (function, routine) or option names, file names and paths, and any other sort of type-in commands.
- argument Words in italics indicate user-defined arguments for which you must substitute a name or a value. (The characters before the underscore (_) in the word indicate the data types that this argument can take.

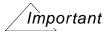
 Names are case sensitive.

|Vertical bars (OR-bars) separate possible choices for a single argument. They take precedence over any other character.

- Brackets denote optional arguments. When used with OR-bars, they enclose a list of choices. You can choose one argument from the list.
- { }Braces are used with OR-bars and enclose a list of choices. You must choose one argument from the list.
- . . . Three dots (...) indicate that you can repeat the previous argument. If you use them with brackets, you can specify zero or more arguments. If they are used without brackets, you must specify at least one argument, but you can specify more.

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^{1.} Kundert, Kenneth S. The Designer's Guide to SPICE & Spectre. Boston: Kluwer Academic Publishers, 1995.



The language requires many characters not included in the preceding list. You must enter required characters exactly as shown.

References

Text within brackets ([]) are references. See <u>Appendix A, "References,"</u> for more detailed information.

1

Introducing the Spectre Circuit Simulator

This chapter discusses the following:

- <u>Improvements over SPICE</u> on page 12
- Analog HDLs on page 16
- RF Capabilities on page 17
- Mixed-Signal Simulation on page 19
- Environments on page 19

The Spectre[®] circuit simulator is a modern circuit simulator that uses direct methods to simulate analog and digital circuits at the differential equation level. The basic capabilities of the Spectre circuit simulator are similar in function and application to SPICE, but the Spectre circuit simulator is not descended from SPICE. The Spectre and SPICE simulators use the same basic algorithms—such as implicit integration methods, Newton-Raphson, and direct matrix solution—but every algorithm is newly implemented. Spectre algorithms, the best currently available, give you an improved simulator that is faster, more accurate, more reliable, and more flexible than previous SPICE-like simulators.

Improvements over SPICE

The Spectre circuit simulator has many improvements over SPICE.

Improved Capacity

The Spectre circuit simulator can simulate larger circuits than other simulators because its convergence algorithms are effective with large circuits, because it is fast, and because it is frugal with memory and uses dynamic memory allocation. For large circuits, the Spectre circuit simulator typically uses less than half as much memory as SPICE.

Introducing the Spectre Circuit Simulator

Improved Accuracy

Improved component models and core simulator algorithms make the Spectre circuit simulator more accurate than other simulators. These features improve Spectre accuracy:

- Advanced metal oxide semiconductor (MOS) and bipolar models
 - ☐ The Spectre BSIM 3v3 is a physics-based metal-oxide semiconductor field effect transistor (MOSFET) model for simulating analog circuits.
 - The Spectre models include the MOS0 model, which is even simpler and faster than MOS1 for simulating noncritical MOS transistors in logic circuits and behavioral models, MOS 9, EKV, BTA-HVMOS, BTA-SOI, VBIC95, TOM2, and HBT.

Charge-conserving models

The capacitance-based nonlinear MOS capacitor models used in many SPICE derivatives can create or destroy small amounts of charge on every time step. The Spectre circuit simulator avoids this problem because all Spectre models are charge-conserving.

Improved Fourier analyzer

The Spectre circuit simulator includes a two-channel Fourier analyzer that is similar in application to the SPICE .FOURIER statement but is more accurate. The Spectre simulator's Fourier analyzer has greater resolution for measuring small distortion products on a large sinusoidal signal. Resolution is normally greater than 120 dB. Furthermore, the Spectre simulator's Fourier analyzer is not subject to aliasing, a common error in Fourier analysis. As a result, the Spectre simulator can accurately compute the Fourier coefficients of highly discontinuous waveforms.

Better control of numerical error

Many algorithms in the Spectre circuit simulator are superior to their SPICE counterparts in avoiding known sources of numerical error. The Spectre circuit simulator improves the control of local truncation error in the transient analysis by controlling error in the voltage rather than the charge.

In addition, the Spectre circuit simulator directly checks Kirchhoff's Current Law (also known as Kirchhoff's Flow Law) at each time step, improves the charge-conservation accuracy of the Spectre circuit simulator, and eliminates the possibility of false convergence.

Superior time-step control algorithm

The Spectre circuit simulator provides an adaptive time-step control algorithm that reliably follows rapid changes in the solution waveforms. It does so without limiting assumptions about the type of circuit or the magnitude of the signals.

Introducing the Spectre Circuit Simulator

More accurate simulation techniques

Techniques that reduce reliability or accuracy, such as device bypass, simplified models, or relaxation methods, are not used in the Spectre circuit simulator.

User control of accuracy tolerances

For some simulations, you might want to sacrifice some degree of accuracy to improve the simulation speed. For other simulations, you might accept a slower simulation to achieve greater accuracy. With the Spectre circuit simulator, you can make such adjustments easily by setting a single parameter.

Improved Speed

The Spectre circuit simulator is designed to improve simulation speed. The Spectre circuit simulator improves speed by increasing the efficiency of the simulator rather than by sacrificing accuracy.

Faster simulation of small circuits

The average Spectre simulation time for small circuits is typically two to three times faster than SPICE. The Spectre circuit simulator can be over 10 times faster than SPICE when SPICE is hampered by discontinuity in the models or problems in the code. Occasionally, the Spectre circuit simulator is slower when it finds ringing or oscillation that goes unnoticed by SPICE. This can be improved by setting the macromodels option to yes.

Faster simulation for large circuits

The Spectre circuit simulator is generally two to five times faster than SPICE with large circuits because it has fewer convergence difficulties and because it rapidly factors and solves large sparse matrices.

Improved Reliability

The Spectre circuit simulator offers you the following improvements in reliability:

Improved convergence

Spectre proprietary algorithms ensure convergence of the Newton-Raphson algorithm in the DC analysis. The Spectre circuit simulator virtually eliminates the convergence problems that earlier simulators had with transient simulation.

Helpful error and warning messages

The Spectre circuit simulator detects and notifies you of many conditions that are likely to be errors. For example, the Spectre circuit simulator warns of models used in

Introducing the Spectre Circuit Simulator

forbidden operating regions, of incorrectly wired circuits, and of erroneous component parameter values. By identifying such common errors, the Spectre circuit simulator saves you the time required to find these errors with other simulators.

The Spectre circuit simulator lets you define soft parameter limits and sends you warnings if parameters exceed these limits.

Thorough testing

Automated tests, which include over 1,000 test circuits, are constantly run on all hardware platforms to ensure that the Spectre circuit simulator is consistently reliable and accurate.

■ Benchmark suite

There is an independent collection of SPICE netlists that are difficult to simulate. You can obtain these circuits from the Microelectronics Center of North Carolina (MCNC) if you have File Transfer Protocol (FTP) access on the Internet. You can also get information about the performance of several simulators with these circuits.

The Spectre circuit simulator has successfully simulated all of these circuits. Sometimes the netlists required minor syntax corrections, such as inserting balance parentheses, but circuits were never altered, and options were never changed to affect convergence.

Improved Models

The Spectre circuit simulator has MOSFET Level 0–3, BSIM1, BSIM2, BSIM3, BSIM 3v3, EKV, MOS9, JFET, TOM2, GaAs MESFET, BJT, VBIC, HBT, diode, and many other models. It also includes the temperature effects, noise, and MOSFET intrinsic capacitance models.

The Spectre Compiled Model Interface (CMI) option lets you integrate new devices into the Spectre simulator using a very powerful, efficient, and flexible C language interface. This CMI option, the same one used by Spectre developers, lets you install proprietary models.

Spectre Usability Features and Customer Service

The following features and services help you use the Spectre circuit simulator easily and efficiently:

- You can use Spectre soft limits to catch errors created by typing mistakes.
- Spectre diagnosis mode, available as an options statement parameter, gives you information to help diagnose convergence problems.

Introducing the Spectre Circuit Simulator

- You can run the Spectre circuit simulator standalone or run it under the Cadence analog design environment. To see how the Spectre circuit simulator is run under the analog design environment, read the <u>Cadence Analog Design Environment User Guide</u>. You can also run the Spectre circuit simulator in the Composer-to-Spectre direct simulation environment. The environment provides a graphical user interface for running the simulation.
- The Spectre circuit simulator gives you an online help system. With this system, you can find information about any parameter associated with any Spectre component or analysis. You can also find articles on other topics that are important to use the Spectre circuit simulator effectively.
- The Spectre circuit simulator also includes a waveform display tool, Analog Waveform Display (AWD), to use to display simulation results. For more information about AWD, see the *Analog Waveform User Guide*.
- If you experience a stubborn convergence or accuracy problem, you can send the circuit to Customer Support to get help with the simulation. For current phone numbers and e-mail addresses, see the following web site: http://sourcelink.cadence.com/supportcontacts.html.

Analog HDLs

The Spectre circuit simulator works with two analog high-level description languages (AHDLs): SpectreHDL and Verilog®-A. These languages are part of the Spectre Verilog-A Simulation option. SpectreHDL is proprietary to Cadence and is provided for backward compatibility. The Verilog-A language is an open standard, which was based upon SpectreHDL. The Verilog-A language is preferred because it is upward compatible with Verilog-AMS, a powerful and industry-standard mixed-signal language.

Both languages use functional description text files (modules) to model the behavior of electrical circuits and other systems. Each programming language allows you to create your own models by simply writing down the equations. The AHDL lets you describe models in a simple and natural manner. This is a higher level modeling language than previous modeling languages, and you can use it without being concerned about the complexities of the simulator or the simulator algorithms. In addition, you can combine AHDL components with Spectre built-in primitives.

Both languages let designers of analog systems and integrated circuits create and use modules that encapsulate high-level behavioral descriptions of systems and components. The behavior of each module is described mathematically in terms of its terminals and external parameters applied to the module. Designers can use these behavioral descriptions in many disciplines (electrical, mechanical, optical, and so on).

Introducing the Spectre Circuit Simulator

Both languages borrow many constructs from Verilog and the C programming language. These features are combined with a minimum number of special constructs for behavioral simulation. These high-level constructs make it easier for designers to use a high-level description language for the first time.

RF Capabilities

SpectreRF adds several new analyses that support the efficient calculation of the operating point, transfer function, noise, and distortion of common analog and RF communication circuits, such as mixers, oscillators, sample and holds, and switched-capacitor filters.

SpectreRF adds four types of analyses to the Spectre simulator. The first is periodic steady-state (PSS) analysis, a large-signal analysis that directly computes the periodic steady-state response of a circuit. With PSS, simulation times are independent of the time constants of the circuit, so PSS can quickly compute the steady-state response of circuits with long time constants, such as high-Q filters and oscillators.

You can also embed a PSS analysis in a sweep loop (referred to as an SPSS analysis in the Cadence analog design environment), which allows you to easily determine harmonic levels as a function of input level or frequency, making it easy to measure compression points, intercept points, and voltage-controlled oscillator (VCO) linearity.

The second new type of analysis is the periodic small-signal analysis. After completing a PSS analysis, SpectreRF can predict the small-signal transfer functions and noise of frequency translation circuits, such as mixers or periodically driven circuits such as oscillators or switched-capacitor or switched-current filters. The periodic small-signal analyses—periodic AC (PAC) analysis, periodic transfer function (PXF) analysis, and periodic noise (Pnoise) analysis—are similar to Spectre's AC, XF, and Noise analyses, but the traditional small-signal analyses are limited to circuits with DC operating points. The periodic small-signal analyses can be applied to circuits with periodic operating points, such as the following:

- Mixers
- VCOs
- Switched-current filters
- Phase/frequency detectors
- Frequency multipliers
- Chopper-stabilized amplifiers
- Oscillators

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- Switched-capacitor filters
- Sample and holds
- Frequency dividers
- Narrow-band active circuits

The third SpectreRF addition to Spectre functionality is periodic distortion (PDISTO) analysis. PDISTO analysis directly computes the steady-state response of a circuit driven with a large periodic signal, such as an LO (local oscillation) or a clock, and one or more tones with moderate level. With PDISTO, you can model periodic distortion and include harmonic effects. PDISTO computes both a large signal, the periodic steady-state response of the circuit, and also the distortion effects of a specified number of moderate signals, including the distortion effects of the number of harmonics that you choose. This is a common scenario when trying to predict the intermodulation distortion of a mixer, amplifier, or a narrow-band filter. In this analysis, the tones can be large enough to create significant distortion, but not so large as to cause the circuit to switch or clip. The frequencies of the tones need not be periodically related to each other or to the large signal LO or clock. Thus, you can make the tone frequencies very close to each other without penalty, which allows efficient computation of intermodulation distortion of even very narrow band circuits.

The fourth analysis that SpectreRF adds to the Spectre circuit simulator is the envelope-following analysis. This analysis computes the envelope response of a circuit. The simulator automatically determines the clock period by looking through all the sources with the specified name. Envelope-following analysis is most efficient for circuits where the modulation bandwidth is orders of magnitude lower than the clock frequency. This is typically the case, for example, in circuits where the clock is the only fast varying signal and other input signals have a spectrum whose frequency range is orders of magnitude lower than the clock frequency. For another example, the down conversion of two closely placed frequencies can also generate a slow-varying modulation envelope. The analysis generates two types of output files, a voltage versus time (td) file, and an amplitude/phase versus time (fd) file for each specified harmonic of the clock fundamental.

In summary, with periodic small-signal analyses, you apply a small signal at a frequency that might not be harmonically related (noncommensurate) to the periodic response of the undriven system, the clock. This small signal is assumed to be small enough so that the circuit is unaffected by its presence.

With PDISTO, you can apply one or two additional signals at frequencies not harmonically related to the large signal, and these signals can be large enough to drive the circuit to behave nonlinearly.

For complex nonlinear circuits, hand calculation of noise or transfer function is virtually impossible. Without SpectreRF, these circuits must be breadboarded to determine their

Introducing the Spectre Circuit Simulator

performances. The SpectreRF simulator eliminates unnecessary breadboarding, saving time.

Mixed-Signal Simulation

You can use the Spectre circuit simulator coupled with the Verilog®-XL simulator in the Cadence analog design environment to simulate mixed analog and digital circuits efficiently. This mixed-signal simulation solution can easily handle complex designs with tens of thousands of transistors and tens of thousands of gates. The digital Verilog data can come from the digital designer as either an RTL block or gates out of synthesis.

Environments

The Spectre circuit simulator is fully integrated into the Cadence[®] design framework II for the Cadence analog design environment and also into the Cadence analog workbench design system. You can also use the Spectre circuit simulator by itself with several different output format options.

Assura interactive verification, Dracula® distributed multi-CPU option, and Assura hierarchical physical verification produce a netlist that can be read into the Spectre circuit simulator. However, only interactive verification when used with the Cadence analog design environment automatically attaches the stimulus file. All other situations require a stimulus file as well as device models.

Spectre Command Options

This chapter lists the options you can use with the spectre command and gives a brief description of each. It also discusses the following topics:

- <u>Default Values</u> on page 24
- <u>Default Parameter Values</u> on page 24

The spectre command takes the following syntax at the command line:

spectre <options> <inputfile>

Note: The Spectre[®] circuit simulator reads default values for all the command line arguments marked with a dagger (†) from the UNIX environment variable <code>%S_DEFAULTS</code>. If you do not

-help	Lists command options and available components and analyses. You can use $-h$ as an abbreviation of $-help$.
-help <name></name>	Gives a synopsis of the device or analysis $name$. If $name$ is all, the synopses for all components and analyses are given. You can use $-h$ as an abbreviation of $-help$.
-helpsort <name></name>	Gives a synopsis of the device or analysis name and sorts all the parameters by name. You can use -hs as an abbreviation of -helpsort.
-helpfull <name></name>	Gives a full synopsis of the component or analysis name, including parameter types and range limits. You can use -hf as an abbreviation of -helpfull.
-helpsortfull <name></name>	Gives a full synopsis of component or analysis name, including parameter types and range limits. Sorts all parameters by name. You can use -hsf as an abbreviation of -helpsortfull.

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-param†	Does not read the file containing the suggested parameter range limits. You can use -p as an abbreviation of -param.
+param <file>†</file>	Reads $file$ for the suggested parameter range limits. You can use $+p$ as an abbreviation of $+param$.
-log†	Does not copy all messages to a file. You can use - 1 as an abbreviation of -log.
+log <file>t</file>	Copies all messages to $file$. You can use +1 as an abbreviation of +log.
=log <file>t</file>	Sends all messages to file. You can use =1 as an abbreviation of =log.
-raw < <i>raw</i> >†	Puts results in a file or directory named raw . In raw , %C is replaced by a circuit name. You can use $-r$ as an abbreviation of $-raw$.
-format <fmt>†</fmt>	Produces raw data in the format fmt. You can use -f as an abbreviation of -format. Possible values for fmt are nutbin, nutascii, wsfbin, wsfascii, psfbin, psfascii, or awb.
+checkpoint†	Turns on the checkpoint capability. You can use +cp as an abbreviation of +checkpoint.
-checkpoint†	Turns off the checkpoint capability. You can use - cp as an abbreviation of -checkpoint.
-recover†	Does not restart the simulation, even if a checkpoint file exists. You can use -rec as an abbreviation of -recover.
+recover†	Restarts the simulation from a checkpoint file, if it exists. You can use +rec as an abbreviation of +recover.
-cols < <i>N</i> >†	Sets screen width in characters to N . You can use – c as an abbreviation of –cols. If not set, the Spectre simulator determines the screen width automatically.

Spectre Command Options

-env <env> Calls the Spectre simulator from the env

simulation environment. Possible values for *env* are artist2, artist4, awb, edge, opus, or

solo.

-%X In quoted strings within the netlist, replaces %X with

nothing where *x* is any uppercase or lowercase

letter.

+%X <string>† In quoted strings within the netlist, replaces %X with

string, where x is an uppercase or owercase letter. You can modify the string by using the x

operators.

+error† Prints error messages.

-error† Does not print error messages.

+warn† Prints warning messages.

-warn† Does not print warning messages.

+note Prints notices.

-note Does not print notices.

+info† Prints informational messages.

-info† Does not print informational messages.

+debug† Prints debugging messages.

-debug† Does not print debugging messages.

-slave <cmd> Starts the attached simulator using the command

cmd.

-slvhost <hostname> Runs the attached simulator on machine

hostname. Defaults to local machine.

-V Prints version information.

-W Prints subversion information.

-alias <name>† Gives name to the license manager as the name of

the simulator.

-E† Runs the C preprocessor on an input file. In SPICE

mode, the first line in the file must be a comment.

 $-D < x > \uparrow$ Defines string x and runs the C preprocessor.

Spectre Command Options

-D <x=y>†</x=y>	Defines string x to be y and runs the C preprocessor.
-U <x>†</x>	Undefines string \boldsymbol{x} and runs the C preprocessor.
-I <dir>†</dir>	Runs the C preprocessor and searches the directory dir for include files.
-spp†	Do not run the Spice netlist reader on the input file.
+spp†	Run the Spice netlist reader on the input file. Use +spp -sppbin on the command line option to read other spp binaries.
-sppbin file†	Specify the path to nondefault spp binary. Default provided.
+sensdata <file></file>	Sends the sensitivity analyses data to file.
-interactive	Run in the noninteractive mode, that is, process the input file and then return. You can use -inter as an abbreviation of -interactive.
+interactive	Run in the default interactive mode. You can use +inter as an abbreviation of +interactive.
+interactive=type	Run in the interactive mode of the type specified. You can use +inter as an abbreviation of +interactive. Possible values for type are skill or mpsc.
+mpssession=sessionName	The sessionName for an interactive session using multiprocess SKILL (MPS). This option is necessary for +interactive=mpsc and implies +interactive=mpsc.
+mpshost=sessionHost	The sessionHost for an interactive session using MPS.

specify an input file, the Spectr simulatorreads from standard input. When +/- pairs of spectre command options are available, the default is the first value given in the previous list. For further information about the percent code options, +% and -%, see Chapter 11, "Managing Files," in the Spectre Circuit Simulator User Guide.

Note: To remain consistent with the C preprocessor, there is no space between the preprocessor flags (D, U, I) and their arguments. The C preprocessor is available on UNIX

Spectre Command Options

systems only and requires that the first line of the file (the SPICE title line) begin with a comment character (* or //).

Default Values

The Spectre simulator reads default values for all the command line arguments marked with a dagger (†) from the UNIX environment variable <code>%S_DEFAULTS</code>. The name of the simulator as called replaces <code>%S</code>. Typically, this name is <code>spectre</code>, and the Spectre simulator looks for <code>spectre_DEFAULTS</code>. However, the name can be different if you move the executable to a file with a different name or if you call the Spectre simulator through a symbolic or hard link with a different name. This feature lets you set different default values for each name you use to call the Spectre simulator.

If the variable <code>%S_DEFAULTS</code> does not exist, <code>SPECTRE_DEFAULTS</code> is used instead. The command line arguments always override any specifications from the <code>options</code> statement in the circuit file. The <code>options</code> statement specifications, in turn, override any specifications in the environment variable.

Default Parameter Values

Many Spectre parameters have default values, and sometimes you will need to know them so you can determine whether they are acceptable for your simulation. You can find the default values for component, analysis, and control statement parameters by consulting the documentation for the statement in Spectre online help (spectre -h). Values given for parameters in the online help are the default values.

The following examples show you some defaults for different types of parameters from the Spectre online help:

nf=1.0Forward emission coefficient

etchc=etch mNarrowing due to etching for capacitances

homotopy=allMethod used when there is no convergence on initial attempt of DC analysis; possible values are none, gmin, source' dptran, ptran, or all

rawfile="%C:r.raw"

Output raw data filename

Spectre Command Options

In this example, the default values for nf, etchc, homotopy, and rawfile are a real number (1.0), the value of a different parameter (etch), an enumerated type (all), and a character string with a percent code and a colon modifier that gives Spectre instructions for creating the output filename ("%C:r.raw").

For more information about percent codes and colon modifiers, see <u>"Description of Spectre Predefined Percent Codes,"</u> <u>"Customizing Percent Codes,"</u> and <u>"Creating Filenames from Parts of Input Filenames"</u> in the <u>Spectre Circuit Simulator User Guide</u>.

Component Statements Part 1

This chapter discusses the following topics:

- Analog-to-Logic Converter (a2d) on page 28
- B3SOI-PD Transistor (b3soipd) on page 28
- Bipolar Junction Transistor (bjt) on page 49
- Lateral PNP Transistor (bjt301) on page 60
- <u>Lateral PNP Transistor (bit500)</u> on page 67
- Vertical NPN/PNP Transistor (bjt503) on page 77
- Vertical NPN/PNP Transistor (bit504) on page 87
- BSIM1 Field Effect Transistor (bsim1) on page 104
- BSIM2 Field Effect Transistor (bsim2) on page 123
- BSIM3 MOS Transistor (bsim3) on page 147
- BSIM3v3 MOS Transistor (bsim3v3) on page 160
- BSIM4 MOS Transistor (bsim4) on page 178
- BTA SOI Transistor (btasoi) on page 202
- Two Terminal Capacitor (capacitor) on page 220
- <u>Linear Current Controlled Current Source (cccs)</u> on page 224
- Linear Current Controlled Voltage Source (ccvs) on page 225
- <u>Circuit Reduced Order Model (cktrom)</u> on page 226
- Magnetic Core with Hysteresis (core) on page 227
- Logic-to-Analog Converter (d2a) on page 231
- Delay Line (delay) on page 233

Component Statements Part 1

- <u>Diode Level 500 (dio500)</u> on page 233
- <u>Junction Diode (diode)</u> on page 237
- EKV MOSFET Transistor (ekv) on page 243
- Ratiometric Fourier Analyzer (fourier) on page 256
- GaAs MESFET (gaas) on page 259

The rest of the component statements are in Chapter 4, "Component Statements Part 2."

To examine the equations used for some of these components, consult the <u>Spectre Circuit</u> <u>Simulator Device Model Equations</u> manual.

Component Statements Part 1

Analog-to-Logic Converter (a2d)

Description

The analog-to-logic converter transfers analog waveforms to a logic simulator.

This device is not supported within altergroup.

To examine the equations used for this component, consult the <u>Spectre Circuit Simulator</u> <u>Device Model Equations</u> manual.

Sample Instance Statement

```
da99 (cmp_out 0) a2d dest="99991" vl=0 vh=5 timex=200u
// 99991 is a digital net in the verilog netlist.
```

Instance Definition

```
Name p n a2d parameter=value ...
```

Instance Parameters

- 1 destThe foreign simulator name for the destination of the signal.
- 2 nestlev=0Number of nesting levels to ignore in the hierarchical name. This should be used skip over extra levels that do not exist in the co-simulator.
- 3 v1=0 vVoltages below this will be logical 0.
- 4 vh=5 vVoltages above this will be logical 1.
- 5 timex=1 sTime signal can linger between v1 and vh before the state becomes X.

B3SOI-PD Transistor (b3soipd)

Description

B3SOI is an SOI model developed by U.C. Berkeley based on bsim3v3. B3SOI devices require that you use a model statement. This is the B3SOI version-2.2 model

Component Statements Part 1

This device is not supported within altergroup.

Instance Definition

Name d g s e [p] [b] [t] ModelName parameter=value ...

Instance Parameters

- 1 w (m) Channel width.
- 2 1 (m) Channel length.
- 3 as (m²) Area of source diffusion.
- 4 ad (m²) Area of drain diffusion.
- 5 ps (m) Perimeter of source diffusion.
- 6 pd (m) Perimeter of drain diffusion.
- 7 nrd (m/m) Number of squares of drain diffusion.
- 8 nrs (m/m) Number of squares of source diffusion.
- 9 nrb (m/m) Number of body squares.
- 10 m=1Multiplicity factor (number of MOSFETs in parallel).
- 11 region=triodeEstimated operating region.

 Possible values are off, triode, sat, or subth.
- 12 rth0 (Ω) Thermal resistance.
- 13 cth0 (F) Thermal capacitance.
- 14 bjtoff=0BJT off flag.
- 15 nbc=0 m/mNumber of body contact isolation edge.
- 16 nseg=1 m/mNumber of segments for channel width partitioning.
- 17 pdbcp=0 mPerimeter length for body contact parasitic at drain.

Component Statements Part 1

- 18 psbcp=0 mPerimeter length for body contact parasitic at source.
- 19 agbcp=0 mGate to body overlap for body contact parasitic.
- 20 aebcp=0 mGate to body overlap for body contact parasitic.
- 21 vbsusr=0.0 vOptional initial value of Vbs for transient.
- 22 tnodeout=0Temperature node flag associated with T node.

Model Definition

model modelName b3soipd parameter=value ...

Model Parameters

Device Type Parameters

- 1 type=nTransistor type.
- Possible values are n or p.
- 2 version=2.2Model version selector.

Threshold Voltage Parameters

- 3 vtho (V)Threshold voltage at zero body bias for long-channel devices. For enhancement-mode devices, vtho > 0 for n-channel and vth < 0 for p-channel. Default value is calculated from other model parameters.
- 4 $k1=0.5 \ \sqrt{V}$ Body-effect coefficient.
- 5 k1w1=0.0 mFirst body effect width dependent parameter.
- 6 k1w2=0.0 mSecond body effect width dependent parameter.
- 7 k2=-0.0186Charge-sharing parameter.
- 8 k3=0Narrow width coefficient.
- 9 k3b=0 1/VNarrow width coefficient.

Component Statements Part 1

- 10 w0=2.5e-6 mNarrow width coefficient.
- 11 nlx=1.74e-7 mLateral nonuniform doping coefficient.
- 12 gamma1 (\sqrt{V}) Body-effect coefficient near the surface.
- 13 gamma2 (\sqrt{V}) Body-effect coefficient in the bulk.
- 14 vbx (V) Threshold voltage transition body voltage.
- 15 vbm=-3 vMaximum applied body voltage.
- 16 dvt0=2.2First coefficient of short-channel effects.
- 17 dvt1=0.53Second coefficient of short-channel effects.
- 18 dvt2=-0.032 1/VBody-bias coefficient of short-channel effects.
- 19 dvt0w=0First coefficient of narrow-width effects.
- 20 dvt1w=5.3e6Second coefficient of narrow-width effects.
- 21 dvt2w=-0.032 1/VBody-bias coefficient of narrow-width effects.
- 22 a0=1Nonuniform depletion width effect coefficient.
- 23 b0=0 mBulk charge coefficient due to narrow width effect.
- 24 b1=0 mBulk charge coefficient due to narrow width effect.
- 25 a1=0No-saturation coefficient.
- 26 a2=1No-saturation coefficient.
- 27 ags=0 F/m^2 VGate-bias dependence of abulk.
- 28 keta=-0.6 1/VBody-bias coefficient for non-uniform depletion width effect.
- 29 ketas=0.0 vSurface Potential adjustment for bulk charge effect.

Process Parameters

30 nsub=6e16 cm⁻³Substrate doping concentration.

Component Statements Part 1

- 31 nch=1.7e17 cm⁻³Peak channel doping concentration.
- 32 ngate (cm⁻³) Poly-gate doping concentration.
- 33 xj=0.15e-6 mSource/drain junction depth.
- 34 lint=0 mLateral diffusion for one side.
- 35 wint=0 mWidth reduction for one side.
- 36 11=0 mLength dependence of delta L.
- 37 lln=1Length exponent of delta L.
- 38 lw=0 mWidth dependence of delta L.
- 39 lwn=1Width exponent of delta L.
- 40 lw1=0 m²Area dependence of delta L.
- 41 wl=0 mLength dependence of delta W.
- 42 wln=1Length exponent of delta W.
- 43 ww=0 mWidth dependence of delta W.
- 44 wwn=1Width exponent of delta W.
- 45 wwl=0 m²Area dependence of delta W.
- 46 dwg=0 m/vGate-bias dependence of channel width.
- 47 dwb=0 m/ \sqrt{v} Body-bias dependence of channel width.
- 48 dwbc=0.0 mWidth offset for body contact isolation edge.
- 49 tox=1e-8 mGate oxide thickness.
- 50 tbox=3e-7 mBuried oxide thickness.
- 51 tsi=1e-7 mSilicon film thickness.
- 52 xt=1.55e-7 mDoping depth.

Component Statements Part 1

- 53 rdsw=100 Ω µmWidth dependence of drain-source resistance.
- 54 prwb=0 $1/\sqrt{v}$ Body-effect coefficient for Rds.
- 55 prwg=0 1/VGate-effect coefficient for Rds.
- 56 wr=1Width offset for parasitic resistance.
- 57 x1=0 mLength variation due to masking and etching.
- 58 xw=0 mWidth variation due to masking and etching.
- 59 binunit=1Bin parameter unit selector. 1 for microns and 2 for meters.

Mobility Parameters

- 60 mobmod=1Mobility model selector.
- 61 u0=670 cm²/V sLow-field surface mobility at tnom. Default is 250 for PMOS.
- 62 vsat=8e4 m/sCarrier saturation velocity at tnom.
- 63 ua=2.25e-9 m/vFirst-oder mobility reduction coefficient.
- **64** ub=5.87e-19 m^2/v^2

Second-oder mobility reduction coefficient.

65 uc=-4.65e-11 m/v^2

Body-bias dependence of mobility. Default is -0.046 and unit is 1/V for mobmod=3.

Output Resistance Parameters

- 66 drout=0.56DIBL effect on output resistance coefficient.
- 67 pclm=1.3Channel length modulation coefficient.
- 68 pdiblc1=0.39First coefficient of drain-induced barrier lowering.
- 69 pdiblc2=8.6e-3Second coefficient of drain-induced barrier lowering.
- 70 pdiblcb=0 1/VBody-effect coefficient for DIBL.

Component Statements Part 1

- 71 pvag=0Gate dependence of Early voltage.
- 72 delta=0.01 VEffective drain voltage smoothing parameter.

Subthreshold Parameters

- 73 cdsc=2.4e-4 F/m²Source/drain and channel coupling capacitance.
- 74 cdscb=0 F/m² VBody-bias dependence of cdsc.
- 75 cdscd=0 F/m² VDrain-bias dependence of cdsc.
- 76 nfactor=1Subthreshold swing coefficient.
- 77 cit=0 FInterface trap parameter for subthreshold swing.
- 78 voff=-0.08 vThreshold voltage offset.
- 79 dsub=drout DIBL effect in subthreshold region.
- 80 eta0=0.08DIBL coefficient subthreshold region.
- 81 etab=-0.07 1/VBody-bias dependence of et0.

Substrate Current Parameters

- 82 alpha0=0 m/vSubstrate current impact ionization coefficient.
- 83 beta0=0 1/VFirst Vds dependent parameter of impact ionization current.
- 84 fbjtii=0.0Fraction of bipolar current affecting the impact ionization.
- 85 beta1=0Second Vds dependent parameter of impact ionization current.
- 86 beta2=0 VThird Vds dependent parameter of impact ionization current.
- 87 vdsatii0=0.9 v Nominal drain saturation voltage at threshold for impact ionization current.
- 88 tii=0Temperature dependent parameter for impact ionization current.
- 89 lii=0Channel length dependent parameter at threshold for impact ionization current.

Component Statements Part 1

- 90 esatii=1e7 V/mSaturation channel electric field for impact ionization current.
- 91 sii0=0.5 1/VFirst Vgs dependent parameter for impact ionization current.
- 92 sii1=0.1 1/vSecond Vgs dependent parameter for impact ionization current.
- 93 sii2=0.0 1/vThird Vgs dependent parameter for impact ionization current.
- 94 siid=0 1/VVds dependent parameter of drain saturation voltage for impact ionization current.

Parasitic Resistance Parameters

- 95 rbsh=0 Ω Extrinsic body contact sheet resistance.
- 96 rsh=0 Ω /sqrSource/drain diffusion sheet resistance.
- 97 rs=0 Ω Source resistance.
- 98 rd=0 Ω Drain resistance.
- 99 rbody=0 FBody resistance.
- 100 rsc=0 Ω Source contact resistance.
- 101 rdc=0 Ω Drain contact resistance.
- 102 rss=0 Ω mScalable source resistance.
- 103 rdd=0 Ω mScalable drain resistance.
- 104 hdif=0 mLength of heavily doped diffusion.
- 105 ldif=0 mLateral diffusion beyond the gate.
- 106 minr=0.1 Ω Minimum source/drain resistance.

Junction Diode Model Parameters

107 dskip=yesUse simple piece-wise linear model for diode currents below 0.1*iabstol. Possible values are no or yes.

Component Statements Part 1

108 imelt=`imaxA' Explosion current.

Overlap Capacitance Parameters

- 109 cgso (F/m) Gate-source overlap capacitance.
- 110 cgdo (F/m) Gate-drain overlap capacitance.
- 111 cgeo=0.0 F/mGate-substrate overlap capacitance.
- 112 cqbo=2 Dwc Cox F/m

Gate-bulk overlap capacitance. The default value is 0 if version=3.0.

- 113 meto=0 mMetal overlap in fringing field.
- 114 cgsl=0 F/mGate-source overlap capacitance in LDD region.
- 115 cgd1=0 F/mGate-drain overlap capacitance in LDD region.
- 116 ckappa=0.6Overlap capacitance fitting parameter.

Junction Capacitance Model Parameters

- 117 cjswq=cjsw F/mZero-bias gate-side junction capacitance density.
- 118 mjswg=0.5Gate-side junction grading coefficient.
- 119 pbswg=0.7 vGate-side junction built-in potential.
- 120 tt=1e-12 sTransit time.
- 121 ndif=1Power coefficient of channel length dependency for diffusion capacitance.
- 122 ldif0=1Power coefficient of channel length dependency for diffusion capacitance.

Charge Model Selection Parameters

- 123 capmod=2Intrinsic charge model.
- 124 dwc=wint mDelta W for capacitance model.

Component Statements Part 1

- 125 delvt=0.0 vThreshold voltage adjustment for C-V.
- 126 fbody=1.0Scaling factor for body charge.
- 127 dlc=lint mDelta L for capacitance model.
- 128 dlcb=lint mLength offset fitting parameter for body charge.
- 129 dlbg=0.0 mLength offset fitting parameter for backgate charge.
- 130 clc=1e-8 mIntrinsic capacitance fitting parameter.
- 131 cle=0.0Intrinsic capacitance fitting parameter.
- 132 cf (F/m) Fringe capacitance parameter.
- 133 vfbcv=-1Flat-band voltage for capmod=0.
- $134 \times part = 0$ Drain/source channel charge partition in saturation for BSIM charge model, use 0.0 for 40/60, 0.5 for 50/50, or 1.0 for 0/100.

Default Instance Parameters

- 135 w=5e-6 mDefault channel width.
- 136 l=5e-6 mDefault channel length.
- 137 as=0 m²Default area of source diffusion.
- 138 ad=0 m²Default area of drain diffusion.
- 139 ps=0 mDefault perimeter of source diffusion.
- 140 pd=0 mDefault perimeter of drain diffusion.
- 141 nrd=0 m/mDefault number of squares of drain diffusion.
- 142 nrs=0 m/mDefault number of squares of source diffusion.
- 143 nrb=0 m/mDefault body squares.

Component Statements Part 1

Temperature Effects Parameters

144 tnom (C) Parameters measurement temperature. Default set by options.

145 tmax=500 CMaximum device temperature above ambient.

146 shmod=0Self-heating selector.

147 tlev=0DC temperature selector.

148 tlevc=0AC temperature selector.

149 eg=1.12452 VEnergy band gap.

150 gap1=7.02e-4 V/CBand gap temperature coefficient.

151 gap2=1108 CBand gap temperature offset.

152 kt1=-0.11 VTemperature coefficient for threshold voltage.

153 kt11=0 v mTemperature coefficient for threshold voltage.

154 kt2=0.022Temperature coefficient for threshold voltage.

155 at=3.3e4 m/sTemperature coefficient for vsat.

156 tcjswg=0 1/KTemperature coefficient of Cjswg.

157 tpbswg=0 V/KTemperature coefficient of Pbswg.

158 ua1=4.31e-9 m/vTemperature coefficient for ua.

159 ub1=-7.61e-18 m^2/v^2

Temperature coefficient for ub.

 $160 \text{ uc1} = -5.5 \text{ e} - 11 \text{ m/v}^2$

Temperature coefficient for uc. Default is -0.056 for mobmod=3.

161 prt=0 Ω Temperature coefficient for Rds.

162 trs=0 1/cTemperature parameter for source resistance.

163 trd=0 1/cTemperature parameter for drain resistance.

Component Statements Part 1

- 164 ute=-1.5Mobility temperature exponent.
- 165 dt1=0First temperature coefficient for tau.
- 166 dt2=0Second temperature coefficient for tau.
- 167 cth0=0 FSelf-heating thermal capacitance.
- 168 rth0=0 Ω Self-heating thermal resistance.
- 169 ntrecf=0Temperature coefficient of Ntrecf.
- 170 ntrecr=0 Temperature coefficient of Ntrecr.
- 171 xbjt=2BJT current temperature exponent.
- 172 xdif=2Diffusion current temperature exponent.
- 173 xrec=20Recombination current temperature exponent.
- 174 xtun=0Tunneling current temperature exponent.

Noise Model Parameters

- 175 noimod=1Noise model selector.
- 176 kf=0 Flicker (1/f) noise coefficient.
- 177 af=1Flicker (1/f) noise exponent.
- 178 ef=1Flicker (1/f) noise frequency exponent.
- 179 noia=1e20Oxide trap density coefficient. Default is 9.9e18 for pmos.
- 180 noib=5e4Oxide trap density coefficient. Default is 2.4e3 for pmos.
- 181 noic=-1.4e-12Oxide trap density coefficient. Default is 1.4e-8 for pmos.
- 182 em=4.1e7 V/mMaximum electric field.

Component Statements Part 1

Auto Model Selector Parameters

- 183 wmax=1 mMaximum channel width for which the model is valid.
- 184 wmin=0 mMinimum channel width for which the model is valid.
- 185 lmax=1 mMaximum channel length for which the model is valid.
- 186 lmin=0 mMinimum channel length for which the model is valid.

Operating Region Warning Control Parameters

- 187 alarm=noneForbidden operating region.
 - Possible values are none, off, triode, sat, subth, or rev.
- 188 imax=1 AMaximum allowable current.
- 189 by j=∞ VJunction reverse breakdown voltage.
- 190 vbox=1e9 tox VOxide breakdown voltage.
- 191 warn=onParameter to turn warnings on and off.

 Possible values are off or on.

SOI Specific Parameters

- 192 vbsa=0 vVbs0t offset voltage.
- 193 delp=0.02Offset constant for limiting Vbseff to Phis.
- 194 kb1=1Backgate coupling coefficient at strong inversion.
- 195 kb3=1Backgate coupling coefficient at subthreshold.
- 196 dybd0=0 VFirst coefficient of short-channel effect on Vbs0t.
- 197 dvbd1=0First coefficient of short-channel effect on Vbs0t.
- 198 abp=1Gate bias coefficient for Xcsat calculation.
- 199 mxc=-0.9A smoothing parameter for Xcsat calculation.

- 200 agid1=0GIDL constant.
- 201 bgidl=0 V/mGIDL exponential coefficient.
- 202 ngidl=1.2 vGIDL Vds enhancement coefficient.
- 203 ntun=10Reverse tunneling non-ideality factor.
- 204 nrecf0=2.0Recombination non-ideality factor at forward bias.
- 205 nrecr0=10 Recombination non-ideality factor at reversed bias.
- 206 vsdfb (F/m) Source/Drain diffusion flatband voltage.
- 207 vsdthSource/Drain diffusion threshold voltage.
- 208 csdmin (F) Source/Drain diffusion bottom minimum capacitance.
- 209 csdesw=0Source/drain sidewall fringing constant.
- 210 aii=0First parameter for critical field.
- 211 bii=0Second parameter for critical field.
- 212 cii=0Gate dependence of critical field.
- 213 dii=-1Body dependence of critical field.
- 214 ndiode=1Diode non-ideality factor.
- 215 asd=0.3Source/Drain diffusion smoothing parameter.
- 216 isbjt=1e-6 ABJT saturation current.
- 217 isdif=0 ADiffusion saturation current.
- 218 isrec=1e-5 ARecombination saturation current.
- 219 istun=0 ATunneling saturation current.
- 220 ln=2e-6 mElectron diffusion length.
- 221 vrec0=0 VVoltage dependent parameter for recombination current.

Component Statements Part 1

- 222 vtun0=0 VVoltage dependent parameter for tunneling current.
- 223 nbjt=1Power coefficient of channel length dependency for bipolar current.
- 224 lbjt0=0.20e-6 mReference channel length for bipolar current.
- 225 vabjt=10 vEarly voltage for bipolar current.
- 226 aely=0 VChannel length dependency of early voltage for bipolar current.
- 227 ahli=0High level injection parameter for bipolar current.
- 228 kbjt1=0 mParasitic bipolor base width.

Gate Tunneling Parameters

- 229 wth0=0.0 µmMinimum width for thermal resistance calculation..
- 230 rhalo=1.0e15 Ω/sqr

Body halo sheet resistance.

- 231 ntox=1.0Body halo sheet resistance.
- 232 toxref=2.5e-9 mTarget oxide thickness.
- 233 ebg=1.2 VEffective bandgap in gate current calculation.
- 234 nevb=3.0 Valence-band electron non-ideality factor.
- 235 alphagb1=0.35First Vox dependent parameter for gate curent in inversion..
- 236 betagb1=0.03Second Vox dependent parameter for gate curent in inversion..
- 237 vgb1=300Third Vox dependent parameter for gate curent in inversion...
- 238 alphagb2=0.43First Vox dependent parameter for gate curent in accumulation..
- 239 betagb2=0.05Second Vox dependent parameter for gate curent in accumulation...
- 240 necb=1.0Conduction-band electron non-ideality factor.
- 241 vgb2=17Third Vox dependent parameter for gate current in accumulation...

Component Statements Part 1

242 toxqm=Tox mEffective oxide thickness considering quantum effects...

243 voxh=5.0 V Limit of Vox in gate current calculation...

244 deltavox=0.005 V Smoothing parameter in the Vox smoothing function...

245 igmod=0Gate current model selector.

Cross-Term Dependent Parameters

246 paramchk=1Model parameter checking selector.

247 noif=1Floating body excess noise ideality factor.

The jmelt parameter is used to aid convergence and prevent numerical overflow. The junction characteristics of the FET are accurately modeled for current (density) up to jmelt. For current density above jmelt, the junction is modeled as a linear resistor and a warning is printed.

Auto Model Selection

Many models need to be characterized for different geometries in order to obtain accurate results for model development. The model selector program automatically searches for a model with the length and width range specified in the instance statement and uses this model in the simulations.

For the auto model selector program to find a specific model, the models to be searched should be grouped together within braces. Such a group is called a model group. An opening brace is required at the end of the line defining each model group. Every model in the group is given a name followed by a colon and the list of parameters. Also, the four geometric parameters lmax, lmin, wmax, and wmin should be given. The selection criteria to choose a model is as follows:

Then for a given instance

Component Statements Part 1

```
M1 1 2 3 4 ModelName w=3 l=1.5
```

the program would search all the models in the model group with the name ModelName and then pick the first model whose geometric range satisfies the selection criteria. In the preceding example, the auto model selector program would choose ModelName.2.

The user must specify both length (I) and width (w) on the device instance line to enable automatic model selection.

Output Parameters

- 1 weff (m) Effective channel width.
- 2 leff (m) Effective channel length.
- 3 rtheff (Ω) Effective thermal resistance.
- 4 Ctheff (F) Effective thermal capacitance.
- 5 rseff (Ω) Effective source resistance.
- 6 rdeff (Ω) Effective drain resistance.

Operating-Point Parameters

1 type=nTransistor type.

Possible values are n or p.

2 region=triodeEstimated operating region.

Possible values are off, triode, sat, or subth.

3 reversedReverse mode indicator.

Possible values are no or yes.

- 4 vgs (V) Gate-source voltage.
- 5 vds (V) Drain-source voltage.
- 6 vbs (V) Bulk-source voltage.
- 7 vbgs (V) Back-Gate-source voltage.

- 8 ids (A) Resistive drain-to-source current.
- 9 ic (A) BJT collector current.
- 10 isgidl (A) Source GIDL current.
- 11 idgidl (A) Drain GIDL current.
- 12 iii (A) Impact ionization current.
- 13 ibd (A) Resistive bulk-to-drain junction current.
- 14 igbt (A) Gate-to-body tunneling current.
- 15 ibs (A) Resistive bulk-to-source junction current.
- 16 vth (V) Threshold voltage.
- 17 vdsat (V) Drain-source saturation voltage.
- 18 gm (S) Common-source transconductance.
- 19 gds (S) Common-source output conductance.
- 20 gmb (S) Body-transconductance.
- 21 gmbg (S)Back-gate-transconductance.
- 22 ueff (cm²/V s) Effective mobility.
- 23 betaeff (A/V^2) Effective beta.
- 24 qg (Coul) Gate charge.
- 25 qd (Coul) Drain charge.
- 26 qs (Coul) Source charge.
- 27 qb (Coul) Body charge.
- 28 qbg (Coul) Back-Gate charge.
- 29 cgg $(F)dQg_dVg$.

- $30 \text{ cgd } (F)dQg_dVd.$
- 31 cgs $(F)dQg_dVs$.
- $32 \text{ cgb } (F)dQg_dVbk.$
- $33 \text{ cdg } (F)dQd_dVg.$
- $34 \text{ cdd } (F)dQd_dVd.$
- $35 \text{ cds } (F)dQd_dVs.$
- $36 \text{ cdb } (F)dQd_dVb.$
- $37 \text{ csg } (F)dQs_dVg.$
- $38 \text{ csd } (F)dQs_dVd.$
- $39 \text{ css } (F)dQs_dVs.$
- 40 csb $(F)dQs_dVb$.
- 41 $cbg (F)dQb_dVg$.
- $42 \text{ cbd } (F)dQb_dVd.$
- 43 cbs $(F)dQb_dVs$.
- 44 cbb $(F)dQb_dVb$.
- 45 id (A) Total resistive drain current.
- 46 is (A) Total resistive source current.
- 47 ib (A) Total resistive bulk current.
- 48 pwr (W) Power at op point.
- 49 gmoverid (1/V) Gm/lds.
- 50 tdev (C) Temperature rise from ambient.

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Component Statements Part 1

Bipolar Junction Transistor (bjt)

Description

The bipolar transistor model is adapted from the integral charge model of Gummel and Poon, and it includes several high bias-level effects. This model defaults to the simpler Ebers-Moll model if certain parameters are left unspecified. This model also includes a substrate junction that connects either to the collector or to the base to model vertical and lateral structures.

This model has the following enhancements over SPICE2G.6:

- 1. Two base resistance models are provided.
- 2. Nonlinear collector resistance is implemented.
- 3. The integral form of the Early voltage effect is available.
- 4. The substrate junction includes both the diode and the capacitor.

This device is supported within altergroups.

To examine the equations used for this component, consult the <u>Spectre Circuit Simulator</u> <u>Device Model Equations</u> manual.

Sample Instance Statement

```
q1 (vcc net3 minus) npn_mod region=fwd area=1 m=1 \,
```

Sample Model Statement

```
model npn_mod bjt type=npn is=10e-13 bf=200 va=58.8 ikf=5.63e-3 rb=700 rbm=86 re=3.2 cje=0.352e-12 pe=0.76 me=0.34 tf=249e-12 cjc=0.34e-12 pc=0.55
```

Instance Definition

```
Name c b e [s] ModelName parameter=value \dots
```

You do not have to specify the substrate terminal. If you do not specify it, the substrate is connected to ground.

Instance Parameters

1 area=1Transistor area factor.

Component Statements Part 1

- 2 m=1Multiplicity factor.
- 3 triseTemperature rise from ambient.
- 4 region=fwdEstimated operating region.

Possible values are off, fwd, rev, sat, or breakdown.

Model Definition

model modelName bjt parameter=value ...

Model Parameters

Structural parameters

1 type=npnTransistor type.

Possible values are npn or pnp.

2 struct=verticalTransistor structure. For pnp default=lateral.

Possible values are vertical or lateral.

Saturation current parameters

- 3 is=1e-16 ASaturation current (*area).
- 4 ise=0 AB-E leakage saturation current. Set to c2*is if not given. (*area).
- 5 isc=0 AB-C leakage saturation current. Set to c4*is if not given. (*area).
- 6 iss=0 ASubstrate leakage saturation current (*area).
- 7 c2=0Forward leakage saturation current coefficient.
- 8 c4=0Reverse leakage saturation current coefficient.

B-C leakage model parameters

- 9 cbo=0 AExtrapolated 0-volt B-C leakage current (*area).
- 10 gbo=0 SSlope of Icbo vs. Vbc above Vbo (*area).

Component Statements Part 1

- 11 vbo=0 vSlope of Icbo vs. Vbc at Vbc=0.
- 12 tcbo=0 1/CTemperature coefficient for cbo.
- 13 tgbo=0 1/cTemperature coefficient for gbo.

Emission coefficient parameters

- 14 nf=1Forward emission coefficient.
- 15 nr=1Reverse emission coefficient.
- 16 ne=1.5B-E leakage emission coefficient.
- 17 nc=2B-C leakage emission coefficient.
- 18 ns=1Substrate junction emission coefficient.

Current gain parameters

- 19 bf=100 A/AForward current gain (beta).
- 20 br=1 A/AReverse current gain (beta).
- 21 ikf=∞ AHigh current corner for forward beta (*area).
- 22 ikr=∞ AHigh current corner for reverse beta (*area).

Early voltage parameters

- 23 vaf=∞ VForward Early voltage.
- 24 var=∞ ∨Reverse Early voltage.
- 25 ke=0 1/VB-E space-charge integral multiplier.
- 26 kc=0 1/VB-C space-charge integral multiplier.

Parasitic resistance parameters

27 rb=0 Ω Zero-bias base resistance (/area).

Component Statements Part 1

- 28 rbm=rb Ω Minimum base resistance for high currents (/area).
- 29 irb=∞ ACurrent at base resistance midpoint (*area).
- 30 rbmod=spiceNonlinear Rb model.

Possible values are spectre or spice.

- 31 rc=0 Ω Collector resistance (/area).
- 32 rcv=0 Ω Variable collector resistance (/area).
- 33 rcm=0 Ω Minimum collector resistance (/area).
- 34 dope=1e15 cm⁻³Collector background doping concentration.
- 35 cex=1Current crowding exponent.
- 36 cco=1 ACurrent crowding normalization constant (*area).
- 37 re=0 Ω Emitter resistance (/area).
- 38 minr=0.1 Ω Minimum parasitic resistance.

Junction capacitance parameters

- 39 cje=0 FB-E zero-bias junction capacitance (*area).
- 40 vje=0.75 vB-E built-in junction potential.
- 41 mje=1/3B-E junction exponent.
- 42 cjc=0 FB-C zero-bias junction capacitance (*area).
- 43 vjc=0.75 vB-C built-in junction potential.
- 44 mjc=1/3B-C junction exponent.
- 45 xcjc=1Fraction of B-C capacitance tied to internal base node.
- 46 xcjc2=1Fraction of B-C capacitance tied to collector and fraction of B-C tied to internal node.
- 47 cjs=0 FB-S zero-bias junction capacitance (*area).

Component Statements Part 1

- 48 vjs=0.75 vB-S built-in junction potential.
- 49 mjs=0B-S junction exponent.
- 50 fc=0.5Junction capacitor forward-bias threshold.
- 51 cbcp=0 FB-C parasitic capacitance.
- 52 cbep=0 FB-E parasitic capacitance.
- 53 ccsp=0 FC-S parasitic capacitance.

Transit time and excess phase parameters

- 54 tf=0 sldeal forward transit time.
- 55 td=0 sIntrinsic base delay time.
- 56 xtf=0Coefficient for bias dependence of tf.
- 57 vtf=∞ vVoltage describing Vbc dependence of tf.
- 58 itf=0 AHigh current parameter for effect on tf (*area).
- 59 tr=0 sldeal reverse transit time.
- 60 ptf=0 °Excess phase at freq = 1.0/(tf*2 pi) Hz.

Temperature effects parameters

- 61 tnom (C) Parameters measurement temperature. Default set by options.
- 62 trise=0 cTemperature rise from ambient.
- **63** eg=1.11 VBand-gap.
- 64 xtb=0Beta temperature exponent.
- 65 xti=3Temperature exponent for effect on is.
- 66 trb1=0 1/CLinear temperature coefficient for the base resistor.

- 67 trb2=0 C⁻²Quadratic temperature coefficient for the base resistor.
- 68 trm1=0 1/CLinear temperature coefficient for the minimum base resistor.
- 69 trm2=0 C⁻²Quadratic temperature coefficient for the minimum base resistor.
- 70 trc1=0 1/CLinear temperature coefficient for the collector resistor.
- 71 trc2=0 C⁻²Quadratic temperature coefficient for the collector resistor.
- 72 tre1=0 1/CLinear temperature coefficient for the emitter resistor.
- 73 tre2=0 C⁻²Quadratic temperature coefficient for the emitter resistor.
- 74 tlev=0DC temperature selector.
- 75 tlevc=0AC temperature selector.
- 76 gap1=7.02e-4 V/CBand-gap temperature coefficient.
- 77 gap2=1108 CBand-gap temperature offset.
- 78 tikf1=0 1/CLinear temperature coefficient for ikf.
- 79 tikf2=0 C^{-2} Quadratic temperature coefficient for ikf.
- 80 tikr1=0 1/CLinear temperature coefficient for ikr.
- 81 tikr2=0 C^{-2} Quadratic temperature coefficient for ikr.
- 82 tirb1=0 1/CLinear temperature coefficient for irb.
- 83 tirb2=0 C^{-2} Quadratic temperature coefficient for irb.
- 84 tis1=0 1/CLinear temperature coefficient for is.
- 85 tis2=0 C^{-2} Quadratic temperature coefficient for is.
- 86 tise1=0 1/CLinear temperature coefficient for ise.
- 87 tise2=0 C^{-2} Quadratic temperature coefficient for ise.
- 88 tisc1=0 1/CLinear temperature coefficient for isc.

- 89 tisc2=0 C⁻²Quadratic temperature coefficient for isc.
- 90 tiss1=0 1/CLinear temperature coefficient for iss.
- 91 tiss2=0 C⁻²Quadratic temperature coefficient for iss.
- 92 tbf1=0 1/CLinear temperature coefficient for bf.
- 93 tbf2=0 C^{-2} Quadratic temperature coefficient for bf.
- 94 tbr1=0 1/CLinear temperature coefficient for br.
- 95 tbr2=0 C⁻²Quadratic temperature coefficient for br.
- 96 tvaf1=0 1/CLinear temperature coefficient for vaf.
- 97 tvaf2=0 C^{-2} Quadratic temperature coefficient for vaf.
- 98 tvar1=0 1/CLinear temperature coefficient for var.
- 99 tvar2=0 C⁻²Quadratic temperature coefficient for var.
- 100 titf1=0 1/CLinear temperature coefficient for itf.
- 101 titf2=0 C⁻²Quadratic temperature coefficient for itf.
- 102 ttf1=0 1/CLinear temperature coefficient for tf.
- 103 ttf2=0 C^{-2} Quadratic temperature coefficient for tf.
- 104 ttr1=0 1/CLinear temperature coefficient for tr.
- 105 ttr2=0 C^{-2} Quadratic temperature coefficient for tr.
- 106 tnf1=0 1/CLinear temperature coefficient for nf.
- 107 tnf2=0 C^{-2} Quadratic temperature coefficient for nf.
- 108 tnr1=0 1/CLinear temperature coefficient for nr.
- 109 tnr2=0 C⁻²Quadratic temperature coefficient for nr.
- 110 tne1=0 1/CLinear temperature coefficient for ne.

- 111 tne2=0 C⁻²Quadratic temperature coefficient for ne.
- 112 tnc1=0 1/CLinear temperature coefficient for nc.
- 113 tnc2=0 C^{-2} Quadratic temperature coefficient for nc.
- 114 tns1=0 1/CLinear temperature coefficient for ns.
- 115 tns2=0 C⁻²Quadratic temperature coefficient for ns.
- 116 tmje1=0 1/CLinear temperature coefficient for mje.
- 117 tmje2=0 C^{-2} Quadratic temperature coefficient for mje.
- 118 tmjc1=0 1/CLinear temperature coefficient for mjc.
- 119 tmjc2=0 C^{-2} Quadratic temperature coefficient for mjc.
- 120 tmjs1=0 1/CLinear temperature coefficient for mjs.
- 121 tmjs2=0 C^{-2} Quadratic temperature coefficient for mjs.
- **122** cte=0 1/CTemperature coefficient for cje.
- 123 ctc=0 1/CTemperature coefficient for cjc.
- 124 cts=0 1/CTemperature coefficient for cjs.
- 125 tvje=0 V/CTemperature coefficient for vje.
- 126 tvjc=0 V/CTemperature coefficient for vjc.
- 127 tvjs=0 V/CTemperature coefficient for vjs.
- 128 tvtf1=0 1/CLinear temperature coefficient for vtf.
- 129 tvtf2=0 C^{-2} Quadratic temperature coefficient for vtf.
- 130 txtf1=0 1/CLinear temperature coefficient for xtf.
- 131 txtf2=0 C^{-2} Quadratic temperature coefficient for xtf.

Component Statements Part 1

Junction diode model control parameters

132 dskip=yesSkip junction calculations if they are reverse-saturated.

Possible values are no or yes.

133 imelt=imax AJunction explosion current (*area).

Operating region warning control parameters

134 bvbe=∞ VB-E breakdown voltage.

135 bvbc=∞ vB-C breakdown voltage.

136 bvce=∞ vC-E breakdown voltage.

137 bvsub=∞ vSubstrate junction breakdown voltage.

138 vbefwd=0.2 VB-E forward voltage.

139 vbcfwd=0.2 vB-C forward voltage.

140 vsubfwd=0.2 vSubstrate junction forward voltage.

141 imax=1e3 AMaximum allowable base current (*area).

142 imax1=imax AMaximum allowable collector current (*area).

143 alarm=noneForbidden operating region.

Possible values are none, off, fwd, rev, or sat.

Noise model parameters

144 kf=0Flicker (1/f) noise coefficient.

145 af=1Flicker (1/f) noise exponent.

146 kb=0Burst noise coefficient.

147 bnoisefc=1Burst noise cutoff frequency.

148 rbnoi=rb Ω Effective base noise resistance.

Component Statements Part 1

Imax and Imelt

The imax parameter aids convergence and prevents numerical overflow. The junction characteristics of the device are accurately modeled for current up to imax. If imax is exceeded during iterations, the linear model is substituted until the current drops below imax or until convergence is achieved. If convergence is achieved with the current exceeding imax, the results are inaccurate, and Spectre prints a warning.

A separate model parameter, imelt, is used as a limit warning for the junction current. This parameter can be set to the maximum current rating of the device. When any component of the junction current exceeds imelt, note that base and collector currents are composed of many exponential terms, Spectre issues a warning and the results become inaccurate. The junction current is linearized above the value of imelt to prevent arithmetic exception, with the exponential term replaced by a linear equation at imelt.

Operating-Point Parameters

- 1 type=npnTransistor type.
 - Possible values are npn or pnp.
- 2 struct=verticalTransistor structure. For pnp default=lateral.

 Possible values are vertical or lateral.
- 3 region=fwdEstimated operating region.
 - Possible values are off, fwd, rev, sat, or breakdown.
- 4 vbe (V) Base-emitter voltage.
- 5 vbc (V)Base-collector voltage.
- 6 vce (V) Collector-emitter voltage.
- 7 vsub (V) Substrate junction voltage.
- 8 ic (A) Resistive collector current.
- 9 ib (A) Resistive base current.
- 10 isub (A) Resistive substrate current.
- 11 pwr (W) Power dissipation.
- 12 betadc (A/A) Ratio of resistive collector current to resistive base current.

Component Statements Part 1

- 13 betaac (A/A) Small-signal common-emitter current gain.
- 14 gm (S) Common-emitter transconductance.
- 15 rpi (Ω) Common-emitter input resistance.
- 16 ro (Ω) Common-emitter output resistance.
- 17 rb (Ω) Parasitic base resistance.
- 18 rc (Ω) Parasitic collector resistance.
- 19 cpi (F) Common-emitter input capacitance.
- 20 cmu (F) Common-base output capacitance.
- 21 cmux (F) External common-base output capacitance.
- 22 csub (F) Substrate capacitance.
- 23 ft (Hz) Unity small-signal current-gain frequency.

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Lateral PNP Transistor (bjt301)

Description

The bjt301 model provides an extensive description of a lateral integrated circuit junction-isolated PNP transistor. It is described in the Philips Bipolar Modelbook (Dec.93) as TPL level 301.

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Component Statements Part 1

In extension to the modelbook description a minimum conductance gmin is inserted between the internal base and internal collector node, between the internal base and the internal emitter node, and between the external base and the substrate node to aid convergence. The value of gmin is set by an options statement, default = 1e-12 S.

The imax parameter is used to aid convergence and to prevent numerical overflow. The junction characteristics of the transistor are accurately modeled for currents up to imax. For currents above imax, the junction is modeled as a linear resistor and a warning is printed.

This device is supported within altergroups.

This device is dynamically loaded from the shared object /vobs/spectre_dev/tools.sun4v/spectre/lib/cmi/2.0.doc/libphilips.so

Sample Instance Statement

q2 (minus net3 vcc) pnp_mod region=fwd area=1 m=1

Sample Model Statement

model pnp_mod bjt301 type=pnp struct=lateral is=1e-14 bf=85 ilf=11e-9 ikf=95e-6 re=3.2 cje=0.352e-12

Instance Definition

Name c b e [s] ModelName parameter=value ...

Instance Parameters

- 1 area=1Area factor.
- 2 mult=1Alias of area factor.
- 3 m=1Multiplicity factor.
- 4 region=fwdEstimated DC operating region, used as a convergence aid.

 Possible values are off, fwd, rev, or sat.

Component Statements Part 1

Model Definition

model modelName bjt301 parameter=value ...

Model Parameters

Structural parameters

- 1 type=pnpTransistor type.
 - Possible values are pnp or pnp1.
- 2 struct=lateralTransistor structure.

Possible values are lateral.

Current parameters

- 3 is=1.0e-15 ASaturation current.
- 4 imax=1.0 AExplosion current.
- 5 bf=100.0 A/Aldeal forward common-emitter current gain (beta).
- 6 ilf=10.0e-9 ALow-level knee-current of forward beta.
- 7 nlf=2.0Emission coefficient of non-ideal forward base current.
- 8 ikf=100.0e-6 AHigh-injection knee-current of forward beta.
- 9 nhf=1.0Basewidening exponent.
- 10 veaf=50.0 vEarly voltage related to collector junction.
- 11 br=10.0 A/Aldeal reverse common-collector current gain (beta).
- 12 ilr=10.0e-9 ALow-level knee-current of reverse beta.
- 13 nlr=2.0Emission coefficient of non-ideal reverse base current.
- 14 ikr=100.0e-6 AHigh-injection knee-current of reverse beta.
- 15 iks=100.0e-6 AHigh-injection current of substrate effect.

Component Statements Part 1

- 16 xcs=1.0Current fraction of c-b-s transistor.
- 17 xes=0.01Current fraction of e-b-s transistor.

Parasitic resistance parameters

- 18 rc=1.0 Ω Collector resistance.
- 19 rbc=10.0 Ω Constant part of base resistance.
- 20 rbv=10.0 Ω Variable part of base resistance.
- 21 re=1.0 Ω Emitter series resistance.

Junction capacitance parameters

- 22 taub=25.0e-9 sForward transit time related to neutral base.
- 23 taune=1.0e-9 sForward transit time related to neutral emitter in neutral e-b region.
- 24 mtau=1.0Coefficient of current dependence of taune.
- 25 cje=100.0e-15 FZero bias emitter-base depletion capacitance.
- 26 vde=0.55 vEmitter-base diffusion voltage.
- 27 pe=0.333Emitter-base grading coefficient.
- 28 taur=100.0e-9 sldeal reverse transit time.
- 29 cjc=200.0e-15 FZero bias collector-base depletion capacitance.
- 30 vdc=0.55 vCollector-base diffusion voltage.
- 31 pc=0.333Collector-base grading coefficient.
- 32 cjs=1.0e-12 FZero bias substrate junction depletion capacitance.
- 33 vds=0.55 vSubstrate junction diffusion voltage.
- 34 ps=0.333Substrate junction grading coefficient.

Component Statements Part 1

- 35 exphi=0.3Excess phase shift.
- 36 fc=0.95Coefficient for forward bias capacitance.

Temperature effects parameters

- 37 tref (C) Reference temperature. Default set by option tnom.
- 38 tnom (C) Alias of tref. Default set by option tnom.
- 39 dta=0.0 KDifference between device temperature and ambient temperature.
- 40 trise=0.0 KAlias of dta.
- 41 ptbf=0.0Power for temperature dependence of bf.
- 42 ptbr=0.0Power for temperature dependence of br.
- 43 ptrc=0.0Power for temperature dependence of rc.
- 44 ptrb=0.0Power for temperature dependence of rbc and rbv.
- 45 vg=1.2 vBand-gap voltage.
- 46 pt=1.2Power for temperature dependence of diffusion coefficient.

Noise model parameters

- 47 kf=0.0Flickernoise coefficient.
- 48 af=1.0Flickernoise exponent.

Output Parameters

- 1 ist (A) Saturation current.
- 2 iole (A) Non-ideal forward base saturation current.
- 3 iolc (A) Non-ideal reverse base saturation current.
- 4 bft (A/A) Ideal forward common-emitter current gain (beta).

Component Statements Part 1

- 5 brt (A/A) Ideal reverse common-collector current gain (beta).
- 6 rct (Ω) Collector resistance.
- 7 rbct (Ω) Constant part of base resistance.
- 8 rbvt (Ω) Variable part of base resistance.
- 9 taubt (s) Forward transit time related to neutral base.
- 10 cjet (F) Zero bias emitter-base depletion capacitance.
- 11 vdet (V) Emitter-base diffusion voltage.
- 12 taurt (s) Ideal reverse transit time.
- 13 cjct (F)Zero bias collector-base depletion capacitance.
- 14 vdct (V) Collector-base diffusion voltage.
- 15 cjst (F)Zero bias substrate junction depletion capacitance.
- 16 vdst (V) Substrate junction diffusion voltage.

Operating-Point Parameters

- 1 ib (A) Base current.
- 2 ic (A) Collector current.
- 3 ie (A) Emitter current.
- 4 isub (A) Substrate current.
- 5 vbe (V) Base-emitter voltage.
- 6 vbc (V)Base-collector voltage.
- 7 vce (V) Collector-emitter voltage.
- 8 vsubj (V) Substrate voltage.
- 9 betadc (A/A) Ratio of DC collector current to DC Base current.

- 10 rb (Ω) Base resistance at operating point.
- 11 rc (Ω) Collector resistance at operating point.
- 12 re (Ω) Emitter resistance at operating point.
- 13 icb (A) Collector-Base current.
- 14 ieb (A) Emitter-Base current.
- 15 icsub (A) Collector-Substrate current.
- 16 iesub (A) Emitter-Substrate current.
- 17 pwr (W) Power.
- 18 gpi (S) Conductance emitter-base junction.
- 19 gmu (S) Conductance collector-base junction.
- 20 gf (S) Forward transconductance.
- 21 gr (S) Reverse transconductance.
- 22 gs (S) Conductance substrate-base junction.
- 23 g3 (S) Transconductance (parasitic PNP) c-b-s transistor.
- 24 g4 (S) Transconductance (parasitic PNP) e-b-s transistor.
- 25 ced (F) Emitter diffusion capacitance.
- 26 ccd (F) Collector diffusion capacitance.
- 27 cet (F) Emitter junction depletion capacitance.
- 28 cct (F) Collector junction depletion capacitance.
- 29 cst (F) Substrate junction depletion capacitance.
- 30 betaac (A/A) Small-signal common-emitter current gain.
- 31 ft (Hz) Unity small-signal current-gain frequency.

Component Statements Part 1

Parameter Index

af M-48	gf OP-20	mtau M-24	struct M-2
area I-1	gmu OP-19	mult I-2	taub M-22
betaac OP-30	gpi OP-18	nhf M-9	taubt 0-9
betadc OP-9	gr OP-21	nlf M-7	taune M-23
bf M-5	gs OP-22	nlr M-13	taur M-28
bft 0-4	ib OP-1	pc M-31	taurt 0-12
br M-11	ic OP-2	pe M-27	tnom M-38
brt 0-5	icb OP-13	ps M-34	tref M-37
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cet OP-27	iesub OP-16	ptrb M-44	vbe OP-5
cjc M-29	ikf M-8	ptrc M-43	vce OP-7
cjct 0-13	ikr M-14	pwr OP-17	vdc M-30
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cjet 0-10	ilf M-6	rbc M-19	vde M-26
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g3 OP-23	kf M-47	re M-21	xes M-17
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Lateral PNP Transistor (bjt500)

Description

The bjt500 model provides an extensive description of a lateral integrated circuit junction-isolated PNP transistor. It is described in the Philips Bipolar Modelbook (Dec.93) as TPL-level-500. Information on how to obtain this document can be found on Source Link by searching for Philips.

Component Statements Part 1

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In extension to the modelbook description a minimum conductance gmin is inserted between the internal base and internal collector node, between the internal base and the internal emitter node, and between the external base and the substrate node to aid convergence. The value of gmin is set by an options statement, default is $gmin = 1.0e-12 \ S$.

The imax parameter is used to aid convergence and to prevent numerical overflow. The junction characteristics of the transistor are accurately modeled for currents up to imax. For currents above imax, the junction is modeled as a linear resistor, and a warning is printed.

This device is supported within altergroups.

This device is dynamically loaded from the shared object /vobs/spectre_dev/tools.sun4v/spectre/lib/cmi/2.0.doc/libphilips.so

Sample Instance Statement

q3 (minus net3 vcc) pnp_mod region=fwd area=1 m=1

Sample Model Statement

model pnp_mod bjt500 type=pnp struct=lateral is=1e-14 bf=85 ik=95e-6 reex=3.2 cje=0.352e-12

Instance Definition

Name c b e [s] ModelName parameter=value ...

Instance Parameters

- 1 area=1Area factor.
- 2 mult=1Alias of area factor.
- 3 m=1Multiplicity factor.
- 4 region=fwdEstimated DC operating region, used as a convergence aid.

 Possible values are off, fwd, rev, or sat.

Component Statements Part 1

Model Definition

model modelName bjt500 parameter=value ...

Model Parameters

Structural parameters

- 1 type=pnpTransistor type.
 - Possible values are pnp or pnp1.
- 2 struct=lateralTransistor structure.

Possible values are lateral.

Current parameters

- 3 is=1.8e-16 ACollector-emitter saturation current.
- 4 imax=1.0 AExplosion current.
- 5 bf=131.0 A/Aldeal forward common-emitter current gain (beta).
- 6 ibf=2.6e-14 ASaturation current of non-ideal forward base current.
- 7 vlf=0.54 vCross-over voltage of non-ideal forward base current.
- 8 ik=1.1e-4 AHigh injection knee current.
- 9 xifv=0.43Vertical fraction of forward current.
- 10 eaf1=20.5 VEarly voltage of the lateral forward current component.
- 11 eafv=75.0 VEarly voltage of the vertical forward current component.
- 12 br=25.0 A/Aldeal reverse common-emitter current gain.
- 13 ibr=1.2e-13 ASaturation current of non-ideal reverse base current.
- 14 vlr=0.48 vCross-over voltage of non-ideal reverse base current.
- 15 xirv=0.43 Vertical fraction of reverse current.

Component Statements Part 1

- 16 earl=13.1 VEarly voltage of the lateral reverse current component.
- 17 earv=104.0 vEarly voltage of the vertical reverse current component.
- 18 xes=2.7e-3Ratio between saturation current of e-b-s transistor and e-b-c transistor.
- 19 xhes=0.7Fraction of substrate current of e-b-s transistor subject to high injection.
- 20 xcs=3.0Ratio between saturation current of c-b-s transistor and c-b-e transistor.
- 21 xhcs=1.0Fraction of substrate current of c-b-s transistor subject to high injection.
- 22 iss=4.0e-13 ASaturation current of substrate-base diode.

Parasitic resistance parameters

- 23 rcex=5.0 Ω External part of the collector resistance.
- 24 rcin=47.0 Ω Internal part of the collector resistance.
- 25 rbcc=10.0 Ω Constant part of the base resistance rbc.
- 26 rbcv=10.0 Ω Variable part of the base resistance rbc.
- 27 rbec=10.0 Ω Constant part of the base resistance rbe.
- 28 rbev=50.0 Ω Variable part of the base resistance rbe.
- 29 reex=27.0 Ω External part of the emitter resistance.
- 30 rein=66.0 Ω Internal part of the emitter resistance.
- 31 rsb=1.0e15 Ω Substrate-base leakage resistance.

Junction capacitance parameters

- 32 tlat=2.4e-9 sLow injection (forward and reverse) transit time of charge stored in the epilayer between emitter and collector.
- 33 tfvr=3.0e-8 sLow injection forward transit time due to charge stored in the epilayer under the emitter.

Component Statements Part 1

- 34 tfn=2.0e-10 sLow injection forward transit time due to charge stored in the emitter and the buried layer under the emitter.
- 35 cje=6.1e-14 FZero-bias emitter-base depletion capacitance.
- 36 vde=0.52 VEmitter-base diffusion voltage.
- 37 pe=0.3Emitter-base grading coefficient.
- 38 trvr=1.0e-9 sLow injection reverse transit time due to charge stored in the epilayer under the collector.
- 39 trn=3.0e-9 sLow injection reverse transit time due to charge stored in the collector and the buried layer under the collector.
- 40 cjc=3.9e-13 FZero-bias collector-base depletion capacitance.
- 41 vdc=0.57 vCollector-base diffusion voltage.
- 42 pc=0.36Collector-base grading coefficient.
- 43 cjs=1.3e-12 FZero-bias substrate-base depletion capacitance.
- 44 vds=0.52 vSubstrate-base diffusion voltage.
- 45 ps=0.35Substrate-base grading coefficient.
- 46 exphiNot used in model bit500.

Temperature effects parameters

- 47 tref (C) Reference temperature. Default set by option thom.
- 48 tnom (C) Alias of tref.
- 49 tr (C) Alias of tref.
- 50 dta=0.0 KDifference between the device temperature and the ambient analysis temperature.
- 51 trise=0.0 KAlias of dta.
- 52 vgeb=1.206 vBandgap voltage of the emitter-base depletion region.

Component Statements Part 1

- 53 vgcb=1.206 vBandgap voltage of the collector-base depletion region.
- 54 vgsb=1.206 vBandgap voltage of the substrate-base depletion region.
- 55 vgb=1.206 VBandgap voltage of the base between emitter and collector.
- 56 vge=1.206 VBandgap voltage of the emitter.
- 57 vgje=1.123 vBandgap voltage recombination emitter-base junction.
- 58 ae=4.48Temperature coefficient of bf.
- 59 spb=2.853Temperature coefficient of the epitaxial base hole mobility.
- 60 snb=2.6Temperature coefficient of the epitaxial base electron mobility.
- 61 snbn=0.3Temperature coefficient of buried layer electron mobility.
- 62 spe=0.73Temperature coefficient of emitter hole mobility.
- 63 spc=0.73Temperature coefficient of collector hole mobility.
- 64 sx=1.0Temperature coefficient of combined minority carrier mobility in emitter and buried layer.

Noise model parameters

- 65 kf=0.0Flickernoise coefficient.
- 66 af=1.0Flickernoise exponent.

Output Parameters

- 1 ist (A) Collector-emitter saturation current.
- 2 bft (A/A) Ideal forward common-emitter current gain (beta).
- 3 ibft (A) Saturation current of non-ideal forward base current.
- 4 ikt (A) High injection knee current.
- 5 eaflt (V) Early voltage of the lateral forward current component.

- 6 eafvt (V) Early voltage of the vertical forward current component.
- 7 brt (A/A) Ideal reverse common-emitter current gain.
- 8 ibrt (A) Saturation current of non-ideal reverse base current.
- 9 earlt (V) Early voltage of the lateral reverse current component.
- 10 earvt (V) Early voltage of the vertical reverse current component.
- 11 isst (A) Saturation current of substrate-base diode.
- 12 rcint (Ω) Internal part of the collector resistance.
- 13 rbcct (Ω) Constant part of the base resistance rbc.
- 14 rbcvt (Ω) Variable part of the base resistance rbc.
- 15 rbect (Ω) Constant part of the base resistance rbe.
- 16 rbevt (Ω) Variable part of the base resistance rbe.
- 17 reint (Ω) Internal part of the emitter resistance.
- 18 tlatt (s) Low injection (forward and reverse) transit time of charge stored in the epilayer between emitter and collector.
- 19 tfvrt (s) Low injection forward transit time due to charge stored in the epilayer under the emitter.
- 20 tfnt (s)Low injection forward transit time due to charge stored in the emitter and the buried layer under the emitter.
- 21 cjet (F)Zero-bias emitter-base depletion capacitance.
- 22 vdet (V) Emitter-base diffusion voltage.
- 23 trvrt (s) Low injection reverse transit time due to charge stored in the epilayer under the collector.
- 24 trnt (s) Low injection reverse transit time due to charge stored in the collector and the buried layer under the collector.

Component Statements Part 1

- 25 cjct (F)Zero-bias collector-base depletion capacitance.
- 26 vdct (V) Collector-base diffusion voltage.
- 27 cjst (F)Zero-bias substrate-base depletion capacitance.
- 28 vdst (V) Substrate-base diffusion voltage.

Operating-Point Parameters

- 1 ic (A) Resistive collector current.
- 2 ib (A) Resistive base current.
- 3 ie (A) Resistive emitter current.
- 4 isub (A) Resistive substrate current.
- 5 iflat (A) Lateral forward current.
- 6 irlat (A) Lateral reverse current.
- 7 ifver (A) Vertical forward current.
- 8 irver (A) Vertical reverse current.
- 9 ire (A) Ideal forward base current.
- 10 ile (A) Non-ideal forward base current.
- 11 ise (A) Forward substrate current.
- 12 irc (A) Ideal reverse base current.
- 13 ilc (A) Non-ideal reverse base current.
- 14 isc (A) Reverse substrate current.
- 15 isf (A) Reverse leakage current of the substrate-base junction.
- 16 ip (A) Main current.
- 17 betadc (A/A) Ratio of DC collector current to DC base current.

- 18 vbc (V) Base-collector voltage.
- 19 vbe (V) Base-emitter voltage.
- 20 vce (V) Collector-emitter voltage.
- 21 vsb (V) Substrate-base voltage.
- 22 rcex (Ω) External part of the collector resistance.
- 23 rcint (Ω) Internal part of the collector resistance.
- 24 reex (Ω) External part of the emitter resistance.
- 25 reint (Ω) Internal part of the emitter resistance.
- 26 rbc (Ω) Base resistance under the collector.
- 27 rbe (Ω) Base resistance under the emitter.
- 28 rsb (Ω)Ohmic leakage across the substrate-base junction.
- 29 pwr (W) Power.
- 30 gfl (S) Forward conductance, lateral path.
- 31 grl (S) Reverse conductance, lateral path.
- 32 gllv (S) Forward conductance, vertical path.
- 33 g12v (S) Collector Early-effect on Ifver.
- 34 g21v (S) Emitter Early-effect on Irver.
- 35 g22v (S) Reverse conductance, vertical path.
- 36 gpiv (S) Conductance emitter-base junction.
- 37 gmuv (S) Conductance collector-base junction.
- 38 gbe (S) Emitter-side: base conductance B1-B.
- 39 gibe (S) Emitter Early-effect on lb1b.

Component Statements Part 1

- 40 gbc (S) Collector-side: base conductance B2-B.
- 41 gibc (S) Collector Early-effect on lb2b.
- 42 gise (S) Transconductance (parasitic PNP) e-b-s transistor.
- 43 gisc (S) Transconductance (parasitic PNP) c-b-s transistor.
- 44 qsb (S) Conductance substrate-base junction.
- 45 cpil (F) Forward diffusion capacitance, lateral path.
- 46 cipil (F) Collector Early-effect on Qflat.
- 47 cpiv (F) Forward total capacitance, vertical path.
- 48 cmul (F) Reverse diffusion capacitance, lateral path.
- 49 cimul (F) Emitter Early-effect on Qrlat.
- 50 cmuv (F) Reverse total capacitance, vertical path.
- 51 csb (F) Total capacitance substrate-base junction.
- 52 irbe (A) Ideal total forward base current.
- 53 irbc (A) Ideal total reverse base current.
- 54 irsb (A) Substrate base leakage resistance current.

Parameter Index

ae M-58	gibc	OP-41	kf M-65	tfnt	0-20
af M-66	gibe	OP-39	m I-3	tfvr	M - 33
area I-1	gisc	OP-43	mult I-2	tfvrt	0-19
betadc OP-17	gise	OP-42	pc M-42	tlat	M - 32

Component Statements Part 1

1-£ M F	OD 25	N 27	+1-++ 0.10
bf M-5	gmuv OP-37	pe M-37	tlatt 0-18
bft 0-2	gpiv OP-36	ps M-45	tnom M-48
br M-12	grl OP-31	pwr OP-29	tr M-49
brt 0-7	gsb OP-44	rbc OP-26	tref M-47
cimul OP-49		rbcc M-25	trise M-51
cipil OP-46	ibf M-6	rbcct 0-13	trn M-39
cjc M-40	ibft 0-3	rbcv M-26	trnt 0-24
cjct 0-25	ibr M-13	rbcvt 0-14	trvr M-38
cje M-35	ibrt 0-8	rbe OP-27	trvrt 0-23
cjet 0-21	ic OP-1	rbec M-27	type M-1
cjs M-43	ie OP-3	rbect 0-15	vbc OP-18
cjst 0-27	iflat OP-5	rbev M-28	vbe OP-19
cmul OP-48	ifver OP-7	rbevt 0-16	vce OP-20
cmuv OP-50	ik M-8	rcex OP-22	vdc M-41
cpil OP-45	ikt O-4	rcex M-23	vdct 0-26
cpiv OP-47	ilc OP-13	rcin M-24	vde M-36
csb OP-51	ile OP-10	rcint 0-12	vdet 0-22
dta M-50	imax M-4	rcint OP-23	vds M-44
eafl M-10	ip OP-16	reex OP-24	vdst 0-28
eaflt 0-5	irbc OP-53	reex M-29	vgb M-55
eafv M-11	irbe OP-52	region I-4	vgcb M-53
eafvt 0-6	irc OP-12	rein M-30	vge M-56
earl M-16	ire OP-9	reint OP-25	vgeb M-52
earlt 0-9	irlat OP-6	reint 0-17	vgje M-57
earv M-17	irsb OP-54	rsb OP-28	vgsb M-54
earvt 0-10	irver OP-8	rsb M-31	vlf M-7
exphi M-46	is M-3	snb M-60	vlr M-14
g11v OP-32	isc OP-14	snbn M-61	vsb OP-21
g12v OP-33	ise OP-11	spb M-59	xcs M-20
g21v OP-34	isf OP-15	spc M-63	xes M-18
g22v OP-35	iss M-22	spe M-62	xhcs M-21
gbc OP-40	isst 0-11	struct M-2	xhes M-19
gbe OP-38	ist 0-1	sx M-64	xifv M-9
gfl OP-30	isub OP-4	tfn M-34	xirv M-15
911 01 30	IBUD OI I	0111 14 51	XIIV 11 IS

Vertical NPN/PNP Transistor (bjt503)

Description

The bjt503 model provides a detailed description of a vertical integrated NPN and PNP transistor. It is described in the Philips Bipolar Modelbook (Dec.95) as TN/TNS and TP/TPS level 503.

Component Statements Part 1

The NPN is also described in Nat.Lab. Unclassified Report Nr. 006/94 as Mextram Bipolar Transistor Model. Information on how to obtain this document can be found on Source Link by searching for Philips.

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In addition to the model description a level parameter is added. Via the level parameter the user can switch between Philips Bipolar Modelbook (Dec.95) and Philips Bipolar Modelbook (Dec.94).

The imax parameter is used to aid convergence and to prevent numerical overflow. The junction characteristics of the transistor are accurately modeled for currents up to imax. For currents above imax, the junction is modeled as a linear resistor and a warning is printed.

The descriptions of the operating point derivatives are given for the NPN type. For the PNP type the terminal voltage in the descriptions has to be exchanged. E.g.:

NPN: gx = dln/dVb2e1

PNP: gx = dln/dVe1b2

This device is supported within altergroups.

This device is dynamically loaded from the shared object /vobs/spectre_dev/tools.sun4v/spectre/lib/cmi/2.0.doc/libphilips.so

Sample Instance Statement

q4 (vcc net3 minus) npn_mod region=fwd m=1 mult=1

Sample Model Statement

model npn_mod bjt503 type=npn level=2 exmod=1 is=1e-14 bf=85 ik=95e-6 rbc=50 cje=0.352e-12

Instance Definition

Name c b e [s] ModelName parameter=value ...

Instance Parameters

1 area=1Area factor.

Component Statements Part 1

- 2 mult=1Alias of area factor.
- 3 m=1Multiplication factor.
- 4 region=fwdEstimated DC operating region, used as a convergence aid. Possible values are off, fwd, rev, or sat.

Model Definition

model modelName bjt503 parameter=value ...

Model Parameters

- 1 type=npnTransistor type.
 - Possible values are npn, npnv, pnp, or pnpv.
- 2 level=2.0Transistor Level. Possible values are 1 (Philips Bipolar Modelbook Dec.94) or 2 (Philips Bipolar Modelbook Dec.95).
- 3 exmod=0Flag for extended modeling of the reverse current gain.
- 4 exphi=0Flag for distributed high frequency effects.
- 5 exavl=1Flag for extended modeling of avalanche currents.
- 6 is=5.0e-17 ACollector-emitter saturation current.
- 7 bf=140.0 A/Aldeal forward current gain.
- 8 xibi=0.0Fraction of ideal base current that belongs to the sidewall.
- 9 ibf=2.0e-14 ASaturation current of the non-ideal forward base current.
- 10 vlf=0.5 vCross-over voltage of the non-ideal forward base current.
- 11 ik=15.0e-3 AHigh-injection knee current.
- 12 bri=16.0 A/Aldeal reverse current gain.
- 13 ibr=8.0e-15 ASaturation current of the non-ideal reverse base current.
- 14 vlr=0.5 vCross-over voltage of the non-ideal reverse base current.

- 15 xext=0.5Part of Iex, Qex, Qtex and Isub that depends on Vbc1.
- 16 qbo=1.2e-12 CoulBase charge at zero bias.
- 17 eta=4.0 Factor of the built-in field of the base.
- 18 avl=50.0Weak avalanche parameter.
- 19 efi=0.7Electric field intercept (with exavl=1).
- 20 ihc=3.0e-3 ACritical current for hot carriers.
- 21 rcc=25.0 Ω Constant part of the collector resistance.
- 22 rcv=750.0 Ω Resistance of the unmodulated epilayer.
- 23 scrcv=1000.0 Ω Space charge resistance of the epilayer.
- 24 sfh=0.6Current spreading factor epilayer.
- 25 rbc=50.0 Ω Constant part of the base resistance.
- 26 rbv=100.0 Ω Variable part of the base resistance at zero bias.
- 27 re=2.0 Ω Emitter series resistance.
- 28 taune=3.0e-10 sMinimum delay time of neutral and emitter charge.
- 29 mtau=1.18Non-ideality factor of the neutral and emitter charge.
- 30 cje=2.5e-13 FZero bias emitter-base depletion capacitance.
- 31 vde=0.9 vEmitter-base diffusion voltage.
- 32 pe=0.33Emitter-base grading coefficient.
- 33 xcje=0.5Fraction of the e-b depletion cap. that belongs to the sidewall.
- 34 cjc=1.3e-13 FZero bias collector-base depletion capacitance.
- 35 vdc=0.6 vCollector-base diffusion voltage.
- 36 pc=0.4Collector-base grading coefficient variable part.

- 37 xp=0.2Constant part of cjc.
- 38 mc=0.5Collector current modulation coefficient.
- 39 xcjc=0.1Fraction of the collector-base depletion cap. under the emitter area.
- 40 tref (C) Reference temperature. Default set by option tnom.
- 41 tnom (C) Alias of tref. Default set by option tnom.
- 42 tr (C) Alias of tref. Default set by option tnom.
- 43 dta=0.0 KDifference of the device temperature to the ambient temperature.
- 44 trise=0.0 KAlias of dta.
- 45 vge=1.01 vBand-gap voltage of the emitter.
- 46 vgb=1.18 vBand-gap voltage of the base.
- 47 vgc=1.205 vBand-gap voltage of the collector.
- 48 vgj=1.1 vBand-gap voltage recombination emitter-base junction.
- 49 vi=0.04 Vlonization voltage base dope.
- 50 na=3.0e17 cm⁻³Maximum base dope concentration.
- 51 er=2.0e-3Temperature coefficient of vlf and vlr.
- 52 ab=1.35Temperature coefficient resistivity base.
- 53 aepi=2.15Temperature coefficient resistivity of the epilayer.
- 54 aex=1.0Temperature coefficient resistivity of the extrinsic base.
- 55 ac=0.4Temperature coefficient resistivity of the buried layer.
- 56 kf=2.0e-16Flickernoise coefficient ideal base current.
- 57 kfn=2.0e-16Flickernoise coefficient non-ideal base current.
- 58 af=1.0Flickernoise exponent.

Component Statements Part 1

- 59 iss=6.0e-16 ABase-substrate saturation current.
- 60 iks=5.0e-6 AKnee current of the substrate.
- 61 cjs=1.0e-12 FZero bias collector-substrate depletion capacitance.
- 62 vds=0.5 vCollector-substrate diffusion voltage.
- 63 ps=0.33Collector-substrate grading coefficient.
- 64 vgs=1.15 vBand-gap voltage of the substrate.
- 65 as=2.15For a closed buried layer: as=ac. For an open buried layer: as=aepi.
- 66 imax=1.0 AExplosion current.

Output Parameters

- 1 ist (A) Collector-Emitter saturation current.
- 2 bft (A/A) Ideal forward current gain.
- 3 ibft (A) Saturation current of the non-ideal forward base current.
- 4 vlft (V) Cross-over voltage of the non-ideal forward base current.
- 5 ikt (A) High-injection knee current.
- 6 ibrt (A) Saturation current of the non-ideal reverse base current.
- 7 vlrt (V) Cross-over voltage of the non-ideal reverse base current.
- 8 qbot (Coul) Base charge at zero bias.
- 9 avltWeak avalanche parameter.
- 10 rcct (Ω) Constant part of the collector resistance.
- 11 rcvt (Ω) Resistance of the unmodulated epilayer.
- 12 rbct (Ω) Constant part of the base resistance.
- 13 rbvt (Ω) Variable part of the base resistance at zero bias.

Component Statements Part 1

- 14 taunet (s) Minimum delay time of neutral and emitter charge.
- 15 mtautNon-ideality factor of the neutral and emitter charge.
- 16 cjet (F) Zero bias emitter-base depletion capacitance.
- 17 vdet (V) Emitter-base diffusion voltage.
- 18 cjct (F)Zero bias collector-base depletion capacitance.
- 19 vdct (V) Collector-base diffusion voltage.
- 20 xptConstant part of cjc.
- 21 isst (A) Base-substrate saturation current.
- 22 ikst (A) Knee current of the substrate.
- 23 cjst (F)Zero bias collector-substrate depletion capacitance.
- 24 vdst (V) Collector-substrate diffusion voltage.

Operating-Point Parameters

- 1 ib (A) Base current.
- 2 ic (A) Collector current.
- 3 ie (A) Emitter current.
- 4 is (A) Substrate current.
- 5 vbe (V) Base-emitter voltage.
- 6 vbc (V) Base-collector voltage.
- 7 vce (V) Collector-emitter voltage.
- 8 vsc (V) Substrate voltage.
- 9 re (Ω) Constant emitter resistance.
- 10 rcc (Ω) Constant collector resistance.

- 11 rbc (Ω) Constant part of base resistance.
- 12 betadc (A/A) DC current gain.
- 13 pwr (W) Power.
- 14 Vb1e1 (V) Internal voltage.
- 15 Vb2e1 (V) Internal voltage.
- 16 Vb2c1 (V) Internal voltage.
- 17 Vb2c2 (V) Internal voltage.
- 18 Vb1b2 (V) Internal voltage.
- 19 Vb1c1 (V) Internal voltage.
- 20 Vbc1 (V) Internal voltage.
- 21 in (A) Main current.
- 22 ic1c2 (A) Variable collector resistance current.
- 23 ib1 (A) Bulk component of ideal base current.
- 24 ibls (A) Sidewall component of ideal base current.
- 25 ib2 (A) Non-ideal base current.
- 26 iavl (A) Weak avalanche current.
- 27 ib1b2 (A) Variable base resistance current.
- 28 ib3 (A) Non-ideal reverse base current.
- 29 iex (A) Internal extrinsic base current.
- 30 isub (A) Internal base-substrate current.
- 31 isf (A) Substrate-collector current.
- 32 xiex (A) External extrinsic base current.

- 33 Xisub (A) External base-substrate current.
- 34 gx (S) dln/dVb2e1.
- 35 gy (S) dln/dVb2c2.
- 36 gz (S)dln/dVb2c1.
- 37 grayy (S)dlc1c2/dVb2c2.
- 38 grcvz (S)dlc1c2/dVb2c1.
- 39 gpi (S) Conductance floor base-emitter junction: dlb1/dVb2e1 + dlb2/dVb2e1.
- 40 sgpi (S) Conductance sidewall base-emitter junction: dlb1S/dVb1e1.
- 41 gmux (S) Dependence avalanche multiplication on internal b-e junction: -dlavl/dVb2e1.
- 42 gmu (S) Dependence avalanche multiplication on internal b-c junction: -dlavl/dVb2c2.
- 43 gmuz (S) Dependence avalanche multiplication on external b-c junction:-dlavl/dVb2c1.
- 44 grbv (S)dlb1b2/dVb1b2.
- 45 grbvx (S) Emitter Early-effect on lb1b2: dlb1b2/dVb2e1.
- 46 grbvy (S) Internal collector Early-effect on lb1b2: dlb1b2/dVb2c2.
- 47 grbvz (S) External collector Early effect on lb1b2: dlb1b2/dVb2c1.
- 48 gmuex (S) Conductance floor extrinsic b-c junction: dlex/dVb1c1 + dlsub/dVb1c1 + dlb3/dVb1c1.
- 49 xgmuex (S) Conductance sidewall extrinsic b-c junction: dXlex/dVbc1 + dXlsub/dVbc1.
- 50 gsub (S) Conductance s-c junction: dlsf/dVsc1.
- 51 gpnp (S) Transconductance floor extrinsic PNP transistor: dlsub/dVb1c1.
- 52 xgpnp (S) Transconductance sidewall extrinsic PNP transistor: dXIsub/dVbc1.
- 53 cbex (F) Capacitance floor b-e junction: dQte/dVb2e1 + dQbe/dVb2e1 + dQn/dVb2e1.

Component Statements Part 1

- 54 cbey (F) Internal collector Early-effect on Qbe: dQbe/dVb2c2.
- 55 cbez (F) External collector Early-effect on Qbe: dQbe/dVb2c1.
- 56 scte (F) Dependence of QteS on internal b-e junction: dQteS/dVb2e1.
- 57 cbcx (F) Emitter Early-effect on Qbc: dQbc/dVb2e1.
- 58 cbcy (F) Capacitance intrinsic b-c junction: dQtc/dVb2c2 + dQbc/dVb2c2 + dQepi/dVb2c2.
- 59 cbcz (F) Collector Early-effect on Qtc: dQtc/dVb2c1 + dQbc/dVb2c1 + dQepi/dVb2c1.
- 60 cb1b2 (F) Capacitance AC current crowding: dQb1b2/dVb1b2 = Cb.
- 61 cb1b2x (F) Dependence of Qb1b2 on internal b-e junction voltage: dQb1b2/dVb2e1.
- 62 cbcex (F) Capacitance floor extrinsic b-c junction: dQtex/dVb1c1 + dQex/dVb1c1.
- 63 xcbcex (F) Capacitance sidewall extrinsic b-c junction: dXQtex/dVbc1 + dXQex/dVbc1.
- 64 cts (F) Capacitance s-c junction: dQtex/dVb1c1 + dQex/dVb1c1.

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Vertical NPN/PNP Transistor (bjt504)

Description

The bjt504 model provides a detailed description of a vertical integrated NPN and PNP transistor. It is described in the Philips Bipolar Modelbook (Dec.95) as TN/TNS and TP/TPS level 504.

The NPN is also described in Nat.Lab. Unclassified Report Nr. 006/94 as Mextram Bipolar Transistor Model. Information on how to obtain this document can be found on Source Link by searching for Philips.

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Component Statements Part 1

In addition to the model description a level parameter is added. Via the level parameter the user can switch between Philips Bipolar Modelbook (Dec.95) and Philips Bipolar Modelbook (Dec.94).

The imax parameter is used to aid convergence and to prevent numerical overflow. The junction characteristics of the transistor are accurately modeled for currents up to imax. For currents above imax, the junction is modeled as a linear resistor and a warning is printed.

The descriptions of the operating point derivatives are given for the NPN type. For the PNP type the terminal voltage in the descriptions has to be exchanged. E.g.:

NPN: gx = dln/dVb2e1

PNP: gx = dln/dVe1b2

This device is supported within altergroups.

This device is dynamically loaded from the shared object /vobs/spectre_dev/tools.sun4v/spectre/lib/cmi/2.0.doc/libphilips.so

Instance Definition

Name C B E [S] ModelName parameter=value ...

Instance Parameters

- 1 level=xLEVEL.
- 2 mult=XMULT.
- 3 tref=XTREF.
- 4 dta=xDTA.
- 5 exmod=XEXMOD.
- 6 exphi=XEXPHI.
- 7 exavl=XEXAVL.
- 8 is=XIS.
- 9 ik=xIK.

- 10 ver=xVER.
- 11 vef=XVEF.
- 12 bf = xBF.
- 13 ibf=xIBF.
- 14 mlf=xMLF.
- 15 xibi=XXIBI.
- 16 bri=xBRI.
- 17 ibr=xIBR.
- 18 vlr=xVLR.
- 19 xext=XXEXT.
- 20 wavl=XWAVL.
- 21 vavl=XVAVL.
- 22 sfh=xSFH.
- 23 re=XRE.
- 24 rbc=xRBC.
- 25 rbv=XRBV.
- 26 rcc=XRCC.
- 27 rcv=XRCV.
- 28 scrcv=XSCRCV.
- 29 ihc=XIHC.
- 30 axi=XAXI.
- 31 cje=xCJE.

- 32 vde=XVDE.
- 33 pe=XPE.
- 34 xcje=XXCJE.
- 35 cbeo=XCBEO.
- 36 cjc=XCJC.
- 37 vdc=XVDC.
- 38 pc=XPC.
- 39 xp=xXP.
- 40 mc=xMC.
- 41 xcjc=XXCJC.
- 42 cbco=xCBCO.
- 43 mtau=XMTAU.
- 44 taue=xTAUE.
- 45 taub=xTAUB.
- 46 tepi=XTEPI.
- 47 taur=xTAUR.
- 48 deg=xDEG.
- 49 xrec=XXREC.
- 50 aqbo=XAQBO.
- 51 ae=XAE.
- 52 ab=XAB.
- 53 aepi=XAEPI.

Component Statements Part 1

- 54 aex=XAEX.
- 55 ac=XAC.
- 56 dvgbf=XDVGBF.
- 57 dvgbr=XDVGBR.
- 58 vgb=XVGB.
- 59 vgc=XVGC.
- 60 vgj=XVGJ.
- 61 dvgte=XDVGTE.
- 62 af=XAF.
- **63** kf=x**KF**.
- 64 kfn=xKFN.
- 65 iss=XISS.
- 66 iks=XIKS.
- 67 cjs=XCJS.
- 68 vds=XVDS.
- 69 ps=XPS.
- 70 vgs=XVGS.
- 71 as=XAS.

Model Definition

model modelName bjt504 parameter=value ...

Component Statements Part 1

Model Parameters

- 1 type=npnTransistor type.
 - Possible values are npn or pnp.
- 2 level=NULLLEVEL.
- 3 mult=NULLMULT.
- 4 tref=NULLTREF.
- 5 dta=NULLDTA.
- 6 exmod=NULLEXMOD.
- 7 exphi=NULLEXPHI.
- 8 exavl=NULLEXAVL.
- 9 is=NULLIS.
- 10 ik=NULLIK.
- 11 ver=NULLVER.
- 12 vef=NULLVEF.
- 13 bf=NULLBF.
- 14 ibf=NULLIBF.
- 15 mlf=NULLMLF.
- 16 xibi=NULLXIBI.
- 17 bri=NULLBRI.
- 18 ibr=NULLIBR.
- 19 vlr=NULLVLR.
- 20 xext=NULLXEXT.

- 21 wavl=NULLWAVL.
- 22 vavl=NULLVAVL.
- 23 sfh=NULLSFH.
- 24 re=NULLRE.
- 25 rbc=NULLRBC.
- 26 rbv=NULLRBV.
- 27 rcc=NULLRCC.
- 28 rcv=NULLRCV.
- 29 scrcv=NULLSCRCV.
- 30 ihc=NULLIHC.
- 31 axi=NULLAXI.
- 32 cje=NULLCJE.
- 33 vde=NULLVDE.
- 34 pe=NULLPE.
- 35 xcje=NULLXCJE.
- 36 cbeo=NULLCBEO.
- 37 cjc=NULLCJC.
- 38 vdc=NULLVDC.
- 39 pc=NULLPC.
- 40 xp=NULLXP.
- 41 mc=NULLMC.
- 42 xcjc=NULLXCJC.

- 43 cbco=NULLCBCO.
- 44 mtau=NULLMTAU.
- 45 taue=NULLTAUE.
- 46 taub=NULLTAUB.
- 47 tepi=NULLTEPI.
- 48 taur=NULLTAUR.
- 49 deg=NULLDEG.
- 50 xrec=NULLXREC.
- 51 aqbo=NULLAQBO.
- 52 ae=NULLAE.
- 53 ab=NULLAB.
- 54 aepi=NULLAEPI.
- 55 aex=NULLAEX.
- 56 ac=NULLAC.
- 57 dvgbf=NULLDVGBF.
- 58 dvgbr=NULLDVGBR.
- 59 vgb=NULLVGB.
- 60 vgc=NULLVGC.
- 61 vgj=NULLVGJ.
- 62 dvgte=NULLDVGTE.
- 63 af=NULLAF.
- 64 kf=NULLKF.

Component Statements Part 1

65	kfn=NULLKFN	
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Operating-Point Parameters

- 1 level=XLEVEL.
- 2 mult=xMULT.
- 3 tref=XTREF.
- 4 dta=XDTA.
- 5 exmod=XEXMOD.
- 6 exphi=xEXPHI.
- 7 exavl=XEXAVL.
- 8 is=XIS.
- 9 ik=xIK.
- 10 ver=XVER.
- 11 vef=XVEF.
- 12 bf = xBF.
- 13 ibf=xIBF.

- 14 mlf=xMLF.
- 15 xibi=XXIBI.
- 16 bri=xBRI.
- 17 ibr=xIBR.
- 18 vlr=xVLR.
- 19 xext=XXEXT.
- 20 wavl=XWAVL.
- 21 vavl=xVAVL.
- 22 sfh=xSFH.
- 23 re=xRE.
- 24 rbc=xRBC.
- 25 rbv=xRBV.
- 26 rcc=XRCC.
- 27 rcv=XRCV.
- 28 scrcv=XSCRCV.
- 29 ihc=XIHC.
- 30 axi=XAXI.
- 31 cje=XCJE.
- 32 vde=XVDE.
- 33 pe=XPE.
- 34 xcje=XXCJE.
- 35 cbeo=XCBEO.

- 36 cjc=XCJC.
- 37 vdc=xVDC.
- 38 pc=xPC.
- 39 xp=XXP.
- 40 mc=xMC.
- 41 xcjc=XXCJC.
- 42 cbco=XCBCO.
- 43 mtau=XMTAU.
- 44 taue=XTAUE.
- 45 taub=xTAUB.
- 46 tepi=XTEPI.
- 47 taur=xTAUR.
- 48 deg=XDEG.
- 49 xrec=XXREC.
- 50 aqbo=XAQBO.
- **51** ae=X**AE**.
- 52 ab=XAB.
- 53 aepi=XAEPI.
- 54 aex=XAEX.
- 55 ac=XAC.
- 56 dvgbf=XDVGBF.
- 57 dvgbr=xDVGBR.

58	vqb=XVGB.
\circ	vgb-zvob.

62 af=
$$XAF$$
.

- 72 Vb2e1Vb2e1.
- 73 Vb2c2Vb2c2.
- 74 Vb2c1Vb2c1.
- 75 Vb1c1Vb1c1.
- 76 VeleVele.
- 77 Inln.
- 78 Ic1c2lc1c2.
- 79 Ib1b2lb1b2.

Component Statements Part 1

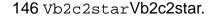
80	Ib1 lb1 .
81	SIb1Slb1.
82	Ib2 lb2 .
83	Ib3 lb3 .
84	Iex lex .
85	XIexXlex.
86	Iavl lavl .
87	IREIRE.
88	IRBCIRBC.
89	IRCCIRCC.
90	Qe Qe .
91	QteQte.
92	SQte SQte .
93	QbeQbe.
94	QbcQbc.
95	QtcQtc.
96	Qepi Qepi .
97	Qb1b2 Qb1b2 .
98	QtexQtex.
99	XQtexXQtex.
10) QexQex.

101 XQexXQex.

102 gxgx.
103 gygy.
104 gzgz.
105 SgpiSgpi.
106 gpixgpix.
107 gpiygpiy.
108 gpizgpiz.
109 gmuxgmux.
110 gmuygmuy.
111 gmuzgmuz.
112 gmuexgmuex.
113 XgmuexXgmuex.
114 gravygravy.
115 gravzgravz.
116 rbvrbv.
117 grbvxgrbvx.
118 grbvy grbvy .
119 grbvz grbvz .
120 RERE.
121 RBCRBC.
122 RCCRCC.
123 SCbeSCbe.

124 CbexCbex.	
125 CbeyCbey.	
126 CbezCbez.	
127 CbcxCbcx.	
128 CbcyCbcy.	
129 CbczCbcz.	
130 CbcexCbcex.	
131 XCbcexXCbcex.	
132 Cb1b2 Cb1b2 .	
133 Cb1b2xCb1b2x.	
134 Cb1b2y Cb1b2y .	
135 Cb1b2zCb1b2z.	
136 gm gm .	
137 betabeta.	
138 goutgout.	
139 gmu gmu .	
140 RB RB .	
141 CbeCbe.	
142 CbcCbc.	
143 fTfT.	
144 Iqslqs.	
145 XiWepiXiWepi.	

Component Statements Part 1



147 PdissPdiss.

148 TKTK.

149 Isublsub.

150 XIsubXIsub.

151 Isflsf.

152 QtsQts.

153 gSgS.

154 XgSXgS.

155 gSfgSf.

156 CtsCts.

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Ic1c2 OP-78	cbco I-42	is OP-8	vavl OP-21
Iex OP-84	cbco OP-42	is M-9	vdc M-38
In OP-77	cbeo I-35	iss I-65	vdc I-37
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Isf OP-151	cbeo M-36	iss OP-65	vde OP-32
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Qb1b2 OP-97	cjc OP-36	kf I-63	vds 0P-68
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Qbe OP-93	cje I-31	kfn OP-64	vds M-69
Qe OP-90	cje OP-31	kfn M-65	vef I-11
Qepi OP-96	cjs OP-67	level OP-1	vef M-12
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SCbe OP-123	dvgbf OP-56	mtau M-44	vgc OP-59
SIb1 OP-81	dvgbf M-57	mtau I-43	vgj I-60
SQte OP-92	dvgbr M-58	mult M-3	
Sgpi OP-105	dvgbr I-57	mult OP-2	vgj OP-60
TK OP-148	dvgbr OP-57	mult I-2	vgs I-70
Vb1c1 OP-75	dvgte M-62	pc OP-38	vgs OP-70
Vb2c1 OP-74	dvgte OP-61	pc M-39	vgs M-71
Vb2c2 OP-73	dvgte I-61	pc I-38	vlr OP-18
Vb2c2star OP-146	exavl M-8	pe M-34	vlr I-18
Vb2e1 OP-72	exavl I-7	pe OP-33	vlr M-19
Vele OP-76	exavl OP-7	pe I-33	wavl I-20
XCbcex OP-131	exmod M-6	ps M-70	wavl M-21
XIex OP-85	exmod I-5	ps OP-69	wavl OP-20
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XQex OP-101	exphi I-6	rbc I-24	xcjc OP-41
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ac I-55	gmuy OP-110	rcv I-27	xibi I-15
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aepi M-54	gpiz OP-108	re OP-23	xrec OP-49
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BSIM1 Field Effect Transistor (bsim1)

Description

BSIM1 is a semiempirical MOSFET model developed at the University of California, Berkeley. All the model parameters are extracted directly from physical devices. Three charge models are available. In SPICE mode, you can refer to BSIM1 as MOS level 4 or BSIM level 1. BSIM1 transistors require that you use a model statement.

This device is supported within altergroups.

To examine the equations used for this component, consult the <u>Spectre Circuit Simulator</u> <u>Device Model Equations</u> manual.

Sample Instance Statement

```
m1 (1 2 0 0) nchmod l=5u w=10u as=40u ad=40u pd=28u ps=28u m=1
```

Sample Model Statement

model nchmod bsim1 vfb0=-0.5 lvfb=0.5 wvfb=0.3 phi0=0.8 eta0=0.056 k1=0.5 muz=454 eg=0.99 gap1=5.5e-04 trs=1e-3 trd=1e-3 xpart=0.5 rs=10 rd=10

Instance Definition

```
Name d g s b ModelName parameter=value ...
```

Component Statements Part 1

Instance Parameters

- 1 w (m) Channel width.
- 2 1 (m) Channel length.
- 3 as (m²) Area of source diffusion.
- 4 ad (m²) Area of drain diffusion.
- 5 ps (m) Perimeter of source diffusion.
- 6 pd (m) Perimeter of drain diffusion.
- 7 nrd (m/m) Number of squares of drain diffusion.
- 8 nrs (m/m) Number of squares of source diffusion.
- 9 1d (m) Drain diffusion length.
- 10 ls (m) Source diffusion length.
- 11 m=1Multiplicity factor (number of MOSFETs in parallel).
- 12 region=triodeEstimated operating region.

Possible values are off, triode, sat, subth, or breakdown.

- 13 trise (C) Temperature rise from ambient.
- 14 degradation=noHot-electron degradation flag.

 Possible values are no or yes.

Model Definition

model modelName bsim1 parameter=value ...

Model Parameters

Device Type Parameters

1 type=nTransistor type.

Possible values are n or p.

Component Statements Part 1

Threshold Voltage parameters

- 2 vfb0=-0.8 VFlat-band voltage.
- 3 lvfb=0 V µmLength dependence of vfb.
- 4 wvfb=0 V μmWidth dependence of vfb.
- 5 pvfb=0 V μmWidth-length dependence of vfb.
- 6 phi0=0.75 VSurface potential.
- 7 lphi=0 V μmLength dependence of phi.
- 8 wphi=0 V µmWidth dependence of phi.
- 9 pphi=0 V μmWidth-length dependence of phi.
- 10 k1=0.7 \sqrt{V} Body-effect coefficient.
- 11 $1k1=0 \ \sqrt{V} \ \mu mLength dependence of k1.$
- 12 wk1=0 \sqrt{V} µmWidth dependence of k1.
- 13 pk1=0 \sqrt{V} µmWidth-length dependence of k1.
- 14 k2=0Charge-sharing parameter.
- 15 1k2=0 µmLength dependence of k2.
- 16 wk2=0 µmWidth dependence of k2.
- 17 pk2=0 μmWidth-length dependence of k2.
- 18 eta0=0Drain-induced barrier-lowering coefficient.
- 19 leta=0 μmLength dependence of eta.
- 20 weta=0 μmWidth dependence of eta.
- 21 peta=0 µmWidth-length dependence of eta.
- 22 x2e=0 1/VBody-bias dependence of eta.

Component Statements Part 1

- 23 1x2e=0 $\mu m/V$ Length dependence of x2e.
- 24 wx2e=0 μ m/VWidth dependence of x2e.
- 25 px2e=0 µm/VWidth-length dependence of x2e.
- 26 x3e=0 1/VDrain-bias dependence of eta.
- 27 1x3e=0 $\mu m/V$ Length dependence of x3e.
- 28 wx3e=0 μ m/VWidth dependence of x3e.
- 29 px3e=0 μ m/VWidth-length dependence of x3e.

Mobility Parameters

- 30 muz=400 cm²/V sLow-field mobility.
- 31 lmuz=0 cm²/V sLength dependence of muz.
- 32 wmuz=0 cm^2/V sWidth dependence of muz.
- 33 pmuz=0 cm^2/V sWidth-length dependence of muz.
- 34 x2mz=0 cm^2/V^2 sBody-bias dependence of muz.
- 35 $1 \times 2 \text{mz} = 0$ cm² $\mu \text{m/V}^2$ s Length dependence of $\times 2 \text{mz}$.
- 36 wx2mz=0 cm 2 μ m/V 2 s Width dependence of x2mz.
- 37 px2mz=0 cm 2 μ m/V 2 s Width-length dependence of x2mz.
- 38 mus=450 cm^2/V sMobility in the saturation region.
- 39 lmus=0 cm 2 $\mu\text{m/V}$ s Length dependence of mus.
- 40 wmus=0 cm 2 μ m/V s Width dependence of mus.

Component Statements Part 1

41 pmus=0 cm 2 μ m/V s Width-length dependence of mus.

42 x2ms=0 cm^2/V^2 sBody-bias dependence of mus.

- 43 1x2ms=0 cm^2 $\mu m/V^2$ s Length dependence of x2ms.
- 44 wx2ms=0 cm 2 μ m/V 2 s Width dependence of x2ms.
- 45 px2ms=0 cm 2 µm/V 2 s Width-length dependence of x2ms.
- 46 x3ms=0 cm^2/V^2 sDrain-bias dependence of mus.
- 47 1x3ms=0 cm^2 $\mu m/V^2$ s Length dependence of x3ms.
- 48 wx3ms=0 cm² μ m/V² s Width dependence of x3ms.
- 49 px3ms=0 cm² μ m/V² s Width-length dependence of x3ms.

Mobility Modulation Parameters

- 50 u00=0 1/vGate voltage dependence of mobility.
- 51 lu0=0 μ m/VLength dependence of u0.
- 52 $wu0=0 \mu m/VWidth dependence of u0$.
- 53 $pu0=0 \mu m/VWidth-length$ dependence of u0.
- 54 x2u0=0 1/ V^2 Body-bias dependence of u0.
- 55 1x2u0=0 $\mu m/V^2$ Length dependence of x2u0.
- 56 wx2u0=0 μ m/V²Width dependence of x2u0.
- 57 px2u0=0 $\mu m/V^2$ Width-length dependence of x2u0.

Component Statements Part 1

Velocity Saturation Parameters

- 58 u10=0 1/VVelocity saturation coefficient.
- 59 $lu1=0 \mu m/V$ Length dependence of u1.
- 60 $wu1=0 \mu m/VWidth$ dependence of u1.
- 61 pu1=0 µm/VWidth-length dependence of u1.
- 62 x2u1=0 1/ V^2 Body-bias dependence of u1.
- 63 1x2u1=0 $\mu m/V^2$ Length dependence of x2u1.
- 64 wx2u1=0 $\mu m/V^2$ Width dependence of x2u1.
- 65 px2u1=0 μ m/V²Width-length dependence of x2u1.
- 66 x3u1=0 1/ V^2 Drain-bias dependence of u1.
- 67 $1x3u1=0 \mu m/V^2$ Length dependence of x3u1.
- 68 wx3u1=0 μ m/V²Width dependence of x3u1.
- 69 px3u1=0 μ m/V²Width-length dependence of x3u1.

Subthreshold Parameters

- 70 n0=0Subthreshold swing parameter.
- 71 ln0=0 µmLength dependence of subthreshold swing parameter.
- 72 wn0=0 μmWidth dependence of subthreshold swing parameter.
- 73 pn0=0 µmWidth-length dependence of subthreshold swing parameter.
- 74 nb=0 \sqrt{v} Body-bias dependence of n0.
- 75 lnb=0 \sqrt{V} µmLength dependence of nb.
- 76 wnb=0 \sqrt{V} µmWidth dependence of nb.
- 77 pnb=0 \sqrt{V} µmWidth-length dependence of nb.

Component Statements Part 1

- 78 nd=0 1/VDrain-bias dependence of n0.
- 79 lnd=0 µm/VLength dependence of nd.
- 80 wnd=0 μ m/VWidth dependence of nd.
- 81 pnd=0 µm/VWidth-length dependence of nd.
- 82 subthmod=2Subthreshold model selector.

Impact Ionization Parameters

- 83 ai0=0 1/VHot-electron effect on Rout parameter.
- 84 lai0=0 μ m/VLength dependence of ai0.
- 85 wai0=0 μ m/VWidth dependence of ai0.
- 86 pai0=0 μ m/VWidth-length dependence of ai0.
- 87 bi0=0 VHot-electron effect on Rout exponent.
- 88 lbi0=0 V μmLength dependence of bi0.
- 89 wbi0=0 V µmWidth dependence of bi0.
- 90 pbi0=0 V µmWidth-length dependence of bi0.

Length and Width Modulation Parameters

- 91 dl0=0 μmLateral diffusion.
- 92 dw0=0 µmField oxide encroachment.
- 93 lref=∞ mReference channel length.
- 94 wref=∞ mReference channel width.
- 95 xw=0 mWidth variation due to masking and etching.
- 96 x1=0 mLength variation due to masking and etching.

Component Statements Part 1

Temperature Effects Parameters

- 97 temp (C) Parameters measurement temperature. Default set by options.
- 98 trise=0 CTemperature rise from ambient.
- 99 tempmod=432Temperature model selector.
- 100 version=432 Version selector.
- 101 uto=0 CMobility temperature offset.
- 102 ute=-1.5Mobility temperature exponent.
- 103 tlev=0DC temperature selector.
- 104 tlevc=0AC temperature selector.
- **105** eg=1.12452 VEnergy band gap.
- 106 qap1=7.02e-4 V/C^2

Band gap temperature coefficient.

- 107 gap2=1108 KBand gap temperature offset.
- 108 trs=0 1/CTemperature coefficient for source resistance.
- 109 trd=0 1/cTemperature coefficient for drain resistance.
- 110 xti=3Saturation current temperature exponent.

Overlap Capacitance Parameters

- 111 cgso=0 F/mGate-source overlap capacitance.
- 112 cgdo=0 F/mGate-drain overlap capacitance.
- 113 cgbo=0 F/mGate-bulk overlap capacitance.
- 114 meto=0 mMetal overlap in fringing field.

Component Statements Part 1

Charge Model Selection Parameters

- 115 capmod=bsimIntrinsic charge model.
 - Possible values are none, meyer, yang, or bsim.
- 116 xpart=1Drain/source channel charge partition in saturation for BSIM charge model, use 0.0 for 40/60, 0.5 for 50/50, or 1.0 for 0/100.
- 117 xqc=0 Drain/source channel charge partition in saturation for charge models, e.g. use 0.4 for 40/60, 0.5 for 50/50, or 0 for 0/100.

Parasitic Resistance Parameters

- 118 rs=0 Ω Source resistance.
- 119 rd=0 Ω Drain resistance.
- 120 rsh=0 Ω /sqrSource/drain diffusion sheet resistance.
- 121 rsc=0 Ω Source contact resistance.
- 122 rdc=0 Ω Drain contact resistance.
- 123 rss=0 Ω mScalable source resistance.
- 124 rdd=0 Ω mScalable drain resistance.
- 125 minr=0.1 Ω Minimum source/drain resistance.
- 126 hdif=0 mLength of heavily doped diffusion.
- 127 ldif=0 mLateral diffusion beyond the gate.
- 128 lgcs=0 mGate-to-contact length of source side.
- 129 lgcd=0 mGate-to-contact length of drain side.
- 130 sc=∞ mSpacing between contacts.

Junction Diode Parameters

131 js (A/m^2) Bulk junction reverse saturation current density.

Component Statements Part 1

- 132 is=1e-14 ABulk junction reverse saturation current.
- 133 n=1Junction emission coefficient.
- 134 imelt=`imaxA' Explosion current, diode is linearized beyond this current to aid convergence.
- 135 jmelt=\jmaxA/m'²

Explosion current density, diode is linearized beyond this current to aid convergence.

136 dskip=yesUse simple piece-wise linear model for diode currents below 0.1*iabstol. Possible values are no or yes.

Junction Capacitance Model Parameters

- 137 cbs=0 FBulk-source zero-bias junction capacitance.
- 138 cbd=0 FBulk-drain zero-bias junction capacitance.
- 139 cj=0 F/m²Zero-bias junction bottom capacitance density.
- 140 mj=1/2Bulk junction bottom grading coefficient.
- 141 pb=0.8 VBulk junction potential.
- 142 fc=0.5Forward-bias depletion capacitance threshold.
- 143 cjsw=0 F/mZero-bias junction sidewall capacitance density.
- 144 mjsw=1/3Bulk junction sidewall grading coefficient.
- 145 pbsw=0.8 vSide-wall junction potential.
- 146 fcsw=0.5Side-wall forward-bias depletion capacitance threshold.

Operating Region Warning Control Parameters

- 147 alarm=noneForbidden operating region.
 - Possible values are none, off, triode, sat, subth, or rev.
- 148 imax=1 AMaximum current, currents above this limit generate a warning.

Component Statements Part 1

149 jmax=1e8 A/m²Maximum current density, currents above this limit generate a warning.

150 bvj=∞ vJunction reverse breakdown voltage.

151 vbox=1e9 tox vOxide breakdown voltage.

Process and Power Supply Parameters

152 tox=4e-8 mGate oxide thickness.

153 vdd=5 vDrain voltage at which parameters are extracted.

Default Device Parameters

154 w=3e-6 mChannel width.

155 l=3e-6 mChannel length.

156 as=0 m²Area of source diffusion.

157 ad=0 m²Area of drain diffusion.

158 ps=0 mPerimeter of source diffusion.

159 pd=0 mPerimeter of drain diffusion.

160 nrd=0 m/mNumber of squares of drain diffusion.

161 nrs=0 m/mNumber of squares of source diffusion.

162 ldd=0 mDrain diffusion length.

163 lds=0 mSource diffusion length.

Noise Model Parameters

164 noisemod=1Noise model selector.

165 kf=0Flicker (1/f) noise coefficient.

166 af=1Flicker (1/f) noise exponent.

Component Statements Part 1

- 167 ef=1Flicker (1/f) noise frequency exponent.
- 168 wnoi=le-5 mChannel width at which noise parameters were extracted.

Auto Model Selector Parameters

- 169 wmax=1.0 mMaximum channel width for which the model is valid.
- 170 wmin=0.0 mMinimum channel width for which the model is valid.
- 171 lmax=1.0 mMaximum channel length for which the model is valid.
- 172 lmin=0.0 mMinimum channel length for which the model is valid.

Degradation Parameters

- 173 degramod=spectreDegradation model selector.

 Possible values are spectre or bert.
- 174 degradation=noHot-electron degradation flag.

 Possible values are no or yes.
- 175 dvthc=1 vDegradation coefficient for threshold voltage.
- 176 dvthe=1Degradation exponent for threshold voltage.
- 177 duoc=1 SDegradation coefficient for transconductance.
- 178 duoe=1 Degradation exponent for transconductance.
- 179 crivth=0.1 VMaximum allowable threshold voltage shift.
- 180 criuo=10%Maximum allowable normalized mobility change.
- 181 crigm=10%Maximum allowable normalized transconductance change.
- 182 criids=10%Maximum allowable normalized drain current change.
- 183 wnom=5e-6 mNominal device width in degradation calculation.
- 184 lnom=1e-6 mNominal device length in degradation calculation.

Component Statements Part 1

- 185 vbsn=0 VSubstrate voltage in degradation calculation.
- 186 vdsni=0.1 vDrain voltage in Ids degradation calculation.
- 187 vgsni=5 vGate voltage in Ids degradation calculation.
- 188 vdsng=0.1 vDrain voltage in Gm degradation calculation.
- 189 vgsng=5 vGate voltage in Gm degradation calculation.

Spectre Stress Parameters

- 190 esat=1.1e7 V/mCritical field in Vdsat calculation.
- 191 esatg=2.5e6 1/mGate voltage dependence of esat.
- 192 vpg=-0.25Gate voltage modifier.
- 193 vpb=-0.13Gate voltage modifier.
- 194 subc1=2.24e-5Substrate current coefficient.
- 195 subc2=-0.1e-5 1/VSubstrate current coefficient.
- 196 sube=6.4Substrate current exponent.
- 197 strc=1Stress coefficient.
- 198 stre=1Stress exponent.

BERT Stress Parameters

- 199 h0=1Aging coefficient.
- 200 hgd=0 1/VBias dependence of h0.
- 201 m0=1Aging exponent.
- 202 mgd=0 1/VBias dependence of m0.
- 203 ecrit0=1.1e5 V/cmCritical electric field.

Component Statements Part 1

- 204 lecrit0=0 μ m V/cmLength dependence of ecrit0.
- 205 wecrit0=0 µm V/cmWidth dependence of ecrit0.
- 206 ecritg=0 1/cmGate voltage dependence of ecrit0.
- 207 lecritg=0 µm/cmLength dependence of ecritg.
- 208 wecritg=0 µm/cmWidth dependence of ecritg.
- 209 ecritb=0 1/cmSubstrate voltage dependence of ecrit0.
- 210 lecritb=0 μ m/cmLength dependence of ecritb.
- 211 we critb=0 μ m/cmWidth dependence of ecritb.
- 212 1c0=1Substrate current coefficient.
- 213 11c0=0 µmLength dependence of 1c0.
- 214 wlc0=0 μ mWidth dependence of lc0.
- 215 lc1=1Substrate current coefficient.
- 216 llc1=0 µmLength dependence of lc1.
- 217 wlc1=0 µmWidth dependence of lc1.
- 218 1c2=1Substrate current coefficient.
- 219 11c2=0 µmLength dependence of 1c2.
- 220 wlc2=0 µmWidth dependence of lc2.
- 221 1c3=1Substrate current coefficient.
- 222 11c3=0 µmLength dependence of 1c3.
- 223 wlc3=0 µmWidth dependence of lc3.
- 224 1c4=1Substrate current coefficient.
- 225 11c4=0 µmLength dependence of 1c4.

Component Statements Part 1

226 wlc4=0 µmWidth dependence of lc4.

227 1c5=1Substrate current coefficient.

228 11c5=0 µmLength dependence of 1c5.

229 wlc5=0 µmWidth dependence of lc5.

230 1c6=1Substrate current coefficient.

231 llc6=0 µmLength dependence of lc6.

232 wlc6=0 µmWidth dependence of lc6.

233 1c7=1Substrate current coefficient.

234 11c7=0 μmLength dependence of 1c7.

235 wlc7=0 μ mWidth dependence of lc7.

Imax and Imelt

The imax parameter aids convergence and prevents numerical overflow. The junction characteristics of the device are accurately modeled for current up to imax. If imax is exceeded during iterations, the linear model is substituted until the current drops below imax or until convergence is achieved. If convergence is achieved with the current exceeding imax, the results are inaccurate, and Spectre prints a warning.

A separate model parameter, imelt, is used as a limit warning for the junction current. This parameter can be set to the maximum current rating of the device. When any component of the junction current exceeds imelt, note that base and collector currents are composed of many exponential terms, Spectre issues a warning and the results become inaccurate. The junction current is linearized above the value of imelt to prevent arithmetic exception, with the exponential term replaced by a linear equation at imelt.

Both of these parameters have current density counterparts, jmax and jmelt, that you can specify if you want the absolute current values to depend on the device area.

Auto Model Selection

Many models need to be characterized for different geometries in order to obtain accurate results for model development. The model selector program automatically searches for a

Component Statements Part 1

model with the length and width range specified in the instance statement and uses this model in the simulations.

For the auto model selector program to find a specific model, the models to be searched should be grouped together within braces. Such a group is called a model group. An opening brace is required at the end of the line defining each model group. Every model in the group is given a name followed by a colon and the list of parameters. Also, the four geometric parameters lmax, lmin, wmax, and wmin should be given. The selection criteria to choose a model is as follows:

Then for a given instance

```
M1 1 2 3 4 ModelName w=3 1=1.5
```

the program would search all the models in the model group with the name ModelName and then pick the first model whose geometric range satisfies the selection criteria. In the preceding example, the auto model selector program would choose ModelName.2.

The user must specify both length (I) and width (w) on the device instance line to enable automatic model selection.

Output Parameters

- 1 weff (m) Effective channel width.
- 2 leff (m) Effective channel length.
- 3 rseff (Ω) Effective source resistance.
- 4 rdeff (Ω) Effective drain resistance.
- 5 aseff (m²) Effective area of source diffusion.
- 6 $adeff(m^2)$ Effective area of drain diffusion.
- 7 pseff (m) Effective perimeter of source diffusion.

Component Statements Part 1

- 8 pdeff (m) Effective perimeter of source diffusion.
- 9 isseff (A) Effective source-bulk junction reverse saturation current.
- 10 isdeff (A) Effective drain-bulk junction reverse saturation current.
- 11 cbseff (F) Effective zero-bias source-bulk junction capacitance.
- 12 cbdeff (F) Effective zero-bias drain-bulk junction capacitance.
- 13 vto (V) Effective zero-bias threshold voltage.
- 14 vfb (V) Effective flat-band voltage.
- 15 phi (V) Effective surface potential.
- 16 k1 (\sqrt{V}) Effective body-effect coefficient.
- 17 k2Effective charge-sharing parameter.
- 18 etaEffective DIBL coefficient.

Operating-Point Parameters

1 type=nTransistor type.

Possible values are n or p.

- 2 region=triodeEstimated operating region.
 - Possible values are off, triode, sat, subth, or breakdown.
- 3 degradation=noHot-electron degradation flag.

Possible values are no or yes.

4 reversedReverse mode indicator.

Possible values are no or yes.

- 5 ids (A) Resistive drain-to-source current.
- 6 vgs (V) Gate-source voltage.
- 7 vds (V) Drain-source voltage.
- 8 vbs (V) Bulk-source voltage.

Component Statements Part 1

- 9 vth (V)Threshold voltage.
- 10 vdsat (V) Drain-source saturation voltage.
- 11 betaeff (A/V²) Effective beta.
- 12 gm (S) Common-source transconductance.
- 13 gds (S) Common-source output conductance.
- 14 gmbs (S)Body-transconductance.
- 15 cbd (F) Drain-bulk junction capacitance.
- 16 cbs (F) Source-bulk junction capacitance.
- 17 cgs (F) Gate-source capacitance.
- 18 cgd (F) Gate-drain capacitance.
- 19 cgb (F) Gate-bulk capacitance.
- 20 ron (Ω) ON-resistance.
- 21 id (A) Resistive drain current.
- 22 ibulk (A) Resistive bulk current.
- 23 pwr (W) Power at op point.
- 24 gmoverid (1/V) Gm/lds.
- 25 isub (A) Substrate current.
- 26 stressHot-electron stress.
- 27 age (s) Device age.
- 28 he vdsat (V)hot electron vdsat.

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ai0 M-83	k2 0-17	nrs I-8	vds OP-7
alarm M-147	kf M-165	pai0 M-86	vdsat OP-10
as I-3	1 M-155	pb M-141	vdsng M-188
as M-156	1 I-2	pbi0 M-90	vdsni M-186
aseff O-5	lai0 M-84	pbsw M-145	version M-100
betaeff OP-11	lbi0 M-88	pd M-159	vfb 0-14
bi0 M-87	1c0 M-212	pd I-6	vfb0 M-2
bvj M-150	1c1 M-215	pdeff O-8	vgs OP-6
capmod M-115	lc2 M-218	peta M-21	vgsng M-189
cbd OP-15	lc3 M-221	phi 0-15	vgsni M-187
cbd M-138	1c4 M-224	phi0 M-6	vpb M-193
cbdeff 0-12	lc5 M-227	pk1 M-13	vpg M-192
cbs M-137	lc6 M-230	pk2 M-17	vth OP-9
cbs OP-16	1c7 M-233	pmus M-41	vto 0-13
cbseff 0-11	ld I-9	pmuz M-33	w I-1
cgb OP-19	ldd M-162	pn0 M-73	w M-154
cgbo M-113	ldif M-127	pnb M-77	wai0 M-85
cgd OP-18	lds M-163	pnd M-81	wbi0 M-89
cgdo M-112	lecrit0 M-204	pphi M-9	wecrit0 M-205
cgs OP-17	lecritb M-210	ps M-158	wecritb M-211
cgso M-111	lecritg M-207	ps I-5	wecritg M-208
cj M-139	leff O-2	pseff 0-7	weff O-1
cjsw M-143	leta M-19	pu0 M-53	weta M-20
crigm M-181	lgcd M-129	pu1 M-61	wk1 M-12
criids M-182	lgcs M-128	pvfb M-5	wk2 M-16
criuo M-180	lk1 M-11	pwr OP-23	wlc0 M-214
crivth M-179	lk2 M-15	px2e M-25	wlc1 M-217
degradation OP-3	llc0 M-213	px2ms M-45	wlc2 M-220
degradation I-14	llc1 M-216	px2mz M-37	wlc3 M-223
degradation M-174		px2u0 M-57	wlc4 M-226
degramod M-173	llc3 M-222	px2u1 M-65	wlc5 M-229
d10 M-91	llc4 M-225	px3e M-29	wlc6 M-232

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dskip M-136	llc5 M-228	px3ms M-4	wlc7 M-235
duoc M-177	llc6 M-231	px3u1 M-69	wmax M-169
duoe M-178	11c7 M-234	rd M-119	wmin M-170
dvthc M-175	lmax M-171	rdc M-122	wmus M-40
dvthe M-176	lmin M-172	rdd M-124	wmuz M-32
dw0 M-92	lmus M-39	rdeff O-4	wn0 M-72
ecrit0 M-203	lmuz M-31	region OP-2	wnb M-76
ecritb M-209	ln0 M-71	region I-12	wnd M-80
ecritg M-206	lnb M-75	reversed OP-4	wnoi M-168
ef M-167	lnd M-79	ron OP-20	wnom M-183
eg M-105	lnom M-184	rs M-118	wphi M-8
esat M-190	lphi M-7	rsc M-121	wref M-94
esatg M-191	lref M-93	rseff O-3	wu0 M-52
eta 0-18	ls I-10	rsh M-120	wu1 M-60
eta0 M-18	lu0 M-51	rss M-123	wvfb M-4
fc M-142	lu1 M-59	sc M-130	wx2e M-24
fcsw M-146	lvfb M-3	strc M-197	wx2ms M-44
gap1 M-106	lx2e M-23	stre M-198	wx2mz M-36
gap2 M-107	1x2ms M-43	stress OP-26	wx2u0 M-56
gds OP-13	lx2mz M-35	subc1 M-194	wx2u1 M-64
gm OP-12	lx2u0 M-55	subc2 M-195	wx3e M-28
gmbs OP-14	lx2u1 M-63	sube M-196	wx3ms M-48
gmoverid OP-24	1x3e M-27	subthmod M-82	wx3u1 M-68
h0 M-199	1x3ms M-47	temp M-97	x2e M-22
hdif M-126	lx3u1 M-67	tempmod M-99	x2ms M-42
he_vdsat OP-28	m I-11	tlev M-103	x2mz M-34
hgd M-200	m0 M-201	tlevc M-104	x2u0 M-54
ibulk OP-22	meto M-114	tox M-152	x2u1 M-62
id OP-21	mgd M-202	trd M-109	x3e M-26
ids OP-5	minr M-125	trise M-98	x3ms M-46
imax M-148	mj M-140	trise I-13	x3u1 M-66
imelt M-134	mjsw M-144	trs M-108	xl M-96
is M-132	mus M-38	type OP-1	xpart M-116
isdeff 0-10	muz M-30	type M-1	xqc M-117
isseff 0-9	n M-133	u00 M-50	xti M-110
isub OP-25	n0 M-70	u10 M-58	xw M-95
jmax M-149	nb M-74	ute M-102	

BSIM2 Field Effect Transistor (bsim2)

Description

BSIM2 is a semiempirical MOSFET model developed at the University of California, Berkeley. All the model parameters are extracted directly from physical devices. Both the drain current

Component Statements Part 1

and output resistance are accurately modeled. Three charge models are available. In SPICE mode, you can refer to BSIM2 as MOS level 5 or BSIM level 2. BSIM2 transistors require that you use a model statement.

This device is supported within altergroups.

To examine the equations used for this component, consult the <u>Spectre Circuit Simulator</u> <u>Device Model Equations</u> manual.

Sample Instance Statement

```
m2 (0 2 1 1) pchmod 1=5u w=10u as=40u ad=40u pd=28u ps=28u m=1
```

Sample Model Statement

```
model pchmod bsim2 type=p vfb0=-0.5 lvfb=0.5 wvfb=0.3 phi0=0.8 eta0=0.056 k1=0.5 eg=0.99 gap1=5.5e-04 trs=1e-3 trd=1e-3 xpart=0.5 rs=10 rd=10
```

Instance Definition

```
Name d g s b ModelName parameter=value ...
```

Instance Parameters

- 1 w (m) Channel width.
- 2 1 (m) Channel length.
- 3 as (m²) Area of source diffusion.
- 4 ad (m²) Area of drain diffusion.
- 5 ps (m) Perimeter of source diffusion.
- 6 pd (m) Perimeter of drain diffusion.
- 7 nrd (m/m) Number of squares of drain diffusion.
- 8 nrs (m/m) Number of squares of source diffusion.
- 9 ld (m) Drain diffusion length.
- 10 ls (m) Source diffusion length.

Component Statements Part 1

- 11 m=1Multiplicity factor (number of MOSFETs in parallel).
- 12 region=triodeEstimated operating region.

Possible values are off, triode, sat, subth, or breakdown.

- 13 trise (C) Temperature rise from ambient.
- 14 degradation=noHot-electron degradation flag.

 Possible values are no or yes.

Model Definition

model modelName bsim2 parameter=value ...

Model Parameters

Device Type Parameters

1 type=nTransistor type.

Possible values are n or p.

Threshold Voltage Parameters

- 2 vfb0=-0.8 vFlat-band voltage.
- 3 lvfb=0 V µmLength dependence of vfb.
- 4 wvfb=0 V μmWidth dependence of vfb.
- 5 pvfb=0 V μmWidth-length dependence of vfb.
- 6 phi0=0.75 vSurface potential.
- 7 lphi=0 V μmLength dependence of phi.
- 8 wphi=0 V µmWidth dependence of phi.
- 9 pphi=0 V µmWidth-length dependence of phi.
- 10 k1=0.7 \sqrt{V} Body-effect coefficient.
- 11 $1k1=0 \ \sqrt{V} \ \mu mLength dependence of k1.$

Component Statements Part 1

- 12 wk1=0 \sqrt{V} µmWidth dependence of k1.
- 13 pk1=0 \sqrt{V} µmWidth-length dependence of k1.
- 14 k2=0Charge-sharing parameter.
- 15 1k2=0 µmLength dependence of k2.
- 16 wk2=0 µmWidth dependence of k2.
- 17 pk2=0 μmWidth-length dependence of k2.
- 18 eta0=0Drain-induced barrier-lowering coefficient.
- 19 leta0=0 μmLength dependence of eta0.
- 20 weta0=0 µmWidth dependence of eta0.
- 21 peta0=0 µmWidth-length dependence of eta0.
- 22 etab=0 1/VBody-bias dependence of eta0.
- 23 letab=0 µm/VLength dependence of etab.
- 24 wetab=0 µm/VWidth dependence of etab.
- 25 petab=0 μ m/VWidth-length dependence of etab.

Mobility Parameters

- 26 mu0=400 cm²/V sLow-field mobility.
- 27 lmu0=0 cm²/V sLength dependence of mu0.
- 28 wmu0=0 cm^2/V sWidth dependence of mu0.
- 29 pmu0=0 cm^2/V sWidth-length dependence of mu0.
- 30 mu0b=0 cm^2/V^2 sBody-bias dependence of muz.
- 31 lmu0b=0 cm² μ m/V² s Length dependence of x2mz.

Component Statements Part 1

- 32 wmu0b=0 cm 2 μ m/V 2 s Width dependence of x2mz.
- 33 pmu0b=0 cm 2 μ m/V 2 s Width-length dependence of x2mz.
- 34 mus0=450 cm^2/V sMobility in the saturation region.
- 35 lmus0=0 cm 2 μ m/V s Length dependence of mus0.
- 36 wmus0=0 cm 2 μ m/V s Width dependence of mus0.
- 37 pmus0=0 cm 2 μ m/V s Width-length dependence of mus0.
- 38 musb=0 cm^2/V^2 sBody-bias dependence of mus0.
- 39 lmusb=0 cm 2 $\mu\text{m/V}^2$ s
- 40 wmusb=0 cm 2 $\mu\text{m/V}^2$ s Length dependence of mus0.
- 41 pmusb=0 cm 2 μ m/V 2 s Length dependence of mus0.
- 42 mu20=1Empirical channel length modulation parameter.
- 43 1mu20=0 $\mu mLength$ dependence of mu20.
- 44 wmu20=0 μ mWidth dependence of mu20.
- 45 pmu20=0 μ mWidth-length dependence of mu20.
- 46 mu2b=0 1/VBody-bias dependence of mu20.
- 47 1mu2b=0 $\mu m/V$ Length dependence of mu2b.
- 48 wmu2b=0 μ m/VWidth dependence of mu2b.
- 49 pmu2b=0 μ m/VWidth-length dependence of mu2b.

Component Statements Part 1

- 50 mu2g=0 1/VGate-bias dependence of mu20.
- 51 $lmu2g=0 \mu m/V$ Length dependence of mu2g.
- 52 wmu2g=0 μm/VWidth dependence of mu2g.
- 53 pmu2g=0 µm/VWidth-length dependence of mu2g.
- 54 mu30=5 cm $^2/V^2$ sEmpirical output resistance parameter.
- 55 1mu30=0 cm^2 μ m/ V^2 s Length dependence of mu30.
- 56 wmu30=0 cm 2 μ m/V 2 s Width dependence of mu30.
- 57 pmu30=0 cm 2 μ m/V 2 s Width-length dependence of mu30.
- 58 mu3b=0 cm^2/V^3 sBody-bias dependence of mu30.
- 59 lmu3b=0 cm 2 μ m/V 3 s Length dependence of mu3b.
- 60 wmu3b=0 cm 2 μ m/V 3 s Width dependence of mu3b.
- 61 pmu3b=0 cm 2 μ m/V 3 s Width-length dependence of mu3b.
- 62 mu3g=0 cm^2/V^3 sGate-bias dependence of mu30.
- 63 lmu3g=0 cm 2 μ m/V 3 s Length dependence of mu3g.
- 64 wmu3g=0 cm 2 μ m/V 3 s Width dependence of mu3g.
- 65 pmu3g=0 cm 2 µm/V 3 s Width-length dependence of mu3g.
- 66 mu40=0 cm^2/V^3 sEmpirical output resistance parameter.

Component Statements Part 1

 $67 \text{ lmu}40=0 \text{ cm}^2 \text{ } \mu\text{m}/\text{V}^3 \text{ s}$

Length dependence of mu40.

 $68 \text{ wmu}40=0 \text{ cm}^2 \text{ } \mu\text{m}/\text{V}^3 \text{ s}$

Width dependence of mu40.

 $69 \text{ pmu}40=0 \text{ cm}^2 \mu\text{m/V}^3 \text{ s}$

Width-length dependence of mu40.

70 mu4b=0 cm^2/V^3 sEmpirical output resistance parameter.

71 lmu4b=0 $cm^2 \mu m/V^3$ s

Length dependence of mu4b.

 $72 \text{ wmu4b=0 cm}^2 \text{ } \mu\text{m/V}^3 \text{ s}$

Width dependence of mu4b.

 $73 \text{ pmu4b=0 cm}^2 \text{ } \mu\text{m/V}^3 \text{ s}$

Width-length dependence of mu4b.

74 mu4g=0 cm^2/V^3 sGate-bias dependence of mu4g.

75 $lmu4g=0 cm^2 \mu m/V^3 s$

Length dependence of mu4g.

 $76 \text{ wmu4g=0 cm}^2 \text{ } \mu\text{m/V}^3 \text{ s}$

Width dependence of mu4q.

77 pmu4g=0 cm 2 μ m/V 3 s

Width-length dependence of mu4g.

Mobility Modulation Parameters

78 ua0=0 1/VGate voltage dependence of mobility.

79 lua0=0 μ m/VLength dependence of ua0.

80 wua0=0 μ m/VWidth dependence of ua0.

81 $pua0=0 \mu m/VWidth$ -length dependence of ua0.

82 $uab=0 1/V^2$ Body-bias dependence of ua.

Component Statements Part 1

- 83 luab=0 μ m/V²Length dependence of uab.
- 84 wuab=0 μ m/V²Width dependence of uab.
- 85 puab=0 μ m/V²Width-length dependence of uab.
- 86 ub0=0 1/V²Second-order effect of gate voltage dependence of mobility.
- 87 $lub0=0 \mu m/V^2$ Length dependence of ub0.
- 88 wub0=0 $\mu m/V^2$ Width dependence of ub0.
- 89 pub0=0 μ m/V²Width-length dependence of ub0.
- 90 ubb=0 1/V³Body-bias dependence of ub.
- 91 lubb=0 μ m/V³Length dependence of ubb.
- 92 wubb=0 $\mu m/V^3$ Width dependence of ubb.
- 93 pubb=0 μ m/V³Width-length dependence of ubb.

Velocity Saturation Parameters

- 94 u10=0 1/VVelocity saturation coefficient.
- 95 $lu10=0 \mu m/V$ Length dependence of u1.
- 96 wu10=0 µm/VWidth dependence of u1.
- 97 pu10=0 $\mu\text{m/VWidth-length}$ dependence of u1.
- 98 u1b=0 1/V²Body-bias dependence of u1.
- 99 lu1b=0 μ m/V²Length dependence of u1b.
- 100 wulb=0 μ m/V²Width dependence of ulb.
- 101 pulb=0 μ m/V²Width-length dependence of ulb.
- 102 u1d=0 $1/V^2$ Drain-bias dependence of u1.
- 103 lu1d=0 μ m/V²Length dependence of u1d.

Component Statements Part 1

- 104 wuld=0 μ m/ V^2 Width dependence of uld.
- 105 puld=0 μ m/V²Width-length dependence of uld.

Subthreshold Parameters

- 106 n0=0 Subthreshold swing parameter.
- 107 ln0=0 μmLength dependence of subthreshold swing parameter.
- 108 wn0=0 μmWidth dependence of subthreshold swing parameter.
- 109 pn0=0 µmWidth-length dependence of subthreshold swing parameter.
- 110 nb=0 \sqrt{V} Body-bias dependence of n0.
- 111 lnb=0 \sqrt{V} µmLength dependence of nb.
- 112 wnb=0 \sqrt{V} µmWidth dependence of nb.
- 113 pnb=0 \sqrt{V} µmWidth-length dependence of nb.
- 114 nd=0 1/VDrain-bias dependence of n0.
- 115 $lnd=0 \mu m/V$ Length dependence of nd.
- 116 wnd=0 µm/VWidth dependence of nd.
- 117 pnd=0 µm/VWidth-length dependence of nd.
- 118 vof0=1 vThreshold voltage offset in the subthreshold region.
- 119 lvof0=0 V µmLength dependence of vof.
- 120 wvof0=0 V µmWidth dependence of vof.
- 121 pvof0=0 V µmWidth-length dependence of vof.
- 122 vofb=0Body-bias dependence of vof0.
- 123 lvofb=0 μmLength dependence of vofb.
- 124 wvofb=0 µmWidth dependence of vofb.

Component Statements Part 1

- 125 pvofb=0 µmWidth-length dependence of vofb.
- 126 vofd=0Drain-bias dependence of vof0.
- 127 lvofd=0 µmLength dependence of vofd.
- 128 wvofd=0 μ mWidth dependence of vofd.
- 129 pvofd=0 μmWidth-length dependence of vofd.
- 130 subthmod=2Subthreshold model selector.

Impact Ionization Parameters

- 131 ai0=0 1/VHot-electron effect on Rout parameter.
- 132 lai0=0 μ m/VLength dependence of ai0.
- 133 wai0=0 μ m/VWidth dependence of ai0.
- 134 pai0=0 µm/VWidth-length dependence of ai0.
- 135 aib=0 $1/V^2$ Body-bias dependence of ai0.
- 136 laib=0 μ m/V²Length dependence of aib.
- 137 waib=0 $\mu m/V^2$ Width dependence of aib.
- 138 paib=0 $\mu m/V^2$ Width-length dependence of aib.
- 139 bi0=0 VHot-electron effect on Rout exponent.
- 140 lbi0=0 V μmLength dependence of bi0.
- 141 wbi0=0 V µmWidth dependence of bi0.
- 142 pbi0=0 V µmWidth-length dependence of bi0.
- 143 bib=0Body-bias dependence of bi0.
- 144 lbib=0 µmLength dependence of bib.
- 145 wbib=0 µmWidth dependence of bib.

Component Statements Part 1

146 pbib=0 µmWidth-length dependence of bib.

Transition Region Bound Parameters

- 147 vghigh=0.2 VUpper bound of the transition region.
- 148 lvghigh=0 V µmLength dependence of Vghigh.
- 149 wvghigh=0 V µmWidth dependence of Vghigh.
- 150 pvghigh=0 V μmWidth-length dependence of Vghigh.
- 151 vglow=-0.15 VLower bound of the transition region.
- 152 lvglow=0 V µmLength dependence of Vglow.
- 153 wvglow=0 V µmWidth dependence of Vglow.
- 154 pvglow=0 V μmWidth-length dependence of Vglow.

Length and Width Modulation Parameters

- 155 d10=0 μmLateral diffusion.
- 156 dw0=0 µmField oxide encroachment.
- 157 lref=∞ mReference channel length.
- 158 wref=∞ mReference channel width.
- 159 xw=0 mWidth variation due to masking and etching.
- 160 x1=0 mLength variation due to masking and etching.

Temperature Effects Parameters

- 161 temp (C) Parameters measurement temperature. Default set by options.
- 162 trise=0 CTemperature rise from ambient.
- 163 tempmod=432Temperature model selector.

Component Statements Part 1

164 version=432 Version selector.

165 uto=0 CMobility temperature offset.

166 ute=-1.5Mobility temperature exponent.

167 tlev=0DC temperature selector.

168 tlevc=0AC temperature selector.

169 ptc=0 V/CSurface potential temperature coefficient.

170 eg=1.12452 VEnergy band gap.

171 qap1=7.02e-4 V/C^2

Band gap temperature coefficient.

172 gap2=1108 KBand gap temperature offset.

173 trs=0 1/CTemperature coefficient for source resistance.

174 trd=0 1/CTemperature coefficient for drain resistance.

175 xti=3Saturation current temperature exponent.

Overlap Capacitance Parameters

176 cgso=0 F/mGate-source overlap capacitance.

177 cgdo=0 F/mGate-drain overlap capacitance.

178 cgbo=0 F/mGate-bulk overlap capacitance.

179 meto=0 mMetal overlap in fringing field.

Charge Model Selection Parameters

180 capmod=bsimIntrinsic charge model.

Possible values are none, meyer, yang, or bsim.

181 xpart=1Drain/source channel charge partition in saturation for BSIM charge model, use 0.0 for 40/60, 0.5 for 50/50, or 1.0 for 0/100.

Component Statements Part 1

 $182 \times qc = 0$ Drain/source channel charge partition in saturation for charge models, e.g. use 0.4 for 40/60, 0.5 for 50/50, or 0 for 0/100.

Parasitic Resistance Parameters

- 183 rs=0 Ω Source resistance.
- 184 rd=0 Ω Drain resistance.
- 185 rsh=0 Ω /sqrSource/drain diffusion sheet resistance.
- 186 rsc=0 Ω Source contact resistance.
- 187 rdc=0 Ω Drain contact resistance.
- 188 rss=0 Ω mScalable source resistance.
- 189 rdd=0 Ω mScalable drain resistance.
- 190 minr=0.1 Ω Minimum source/drain resistance.
- 191 hdif=0 mLength of heavily doped diffusion.
- 192 ldif=0 mLateral diffusion beyond the gate.
- 193 lgcs=0 mGate-to-contact length of source side.
- 194 lgcd=0 mGate-to-contact length of drain side.
- 195 sc=∞ mSpacing between contacts.

Junction Diode Parameters

- 196 js (A/m^2) Bulk junction reverse saturation current density.
- 197 is=1e-14 ABulk junction reverse saturation current.
- 198 n=1Junction emission coefficient.
- 199 dskip=yesUse simple piece-wise linear model for diode currents below 0.1*iabstol. Possible values are no or yes.

Component Statements Part 1

200 imelt=`imaxA' Explosion current, diode is linearized beyond this current to aid convergence.

201 jmelt=\jmaxA/m'²

Explosion current density, diode is linearized beyond this current to aid convergence.

Operating Region Warning Control Parameters

202 alarm=noneForbidden operating region.

Possible values are none, off, triode, sat, subth, or rev.

203 imax=1 AMaximum current, currents above this limit generate a warning.

204 jmax=1e8 A/m²Maximum current density, currents above this limit generate a warning.

205 bvj=∞ VJunction reverse breakdown voltage.

206 vbox=1e9 tox vOxide breakdown voltage.

Junction Capacitance Model Parameters

207 cbs=0 FBulk-source zero-bias junction capacitance.

208 cbd=0 FBulk-drain zero-bias junction capacitance.

209 cj=0 F/m²Zero-bias junction bottom capacitance density.

210 mj=1/2Bulk junction bottom grading coefficient.

211 pb=0.8 VBulk junction potential.

212 fc=0.5Forward-bias depletion capacitance threshold.

213 cjsw=0 F/mZero-bias junction sidewall capacitance density.

214 mjsw=1/3Bulk junction sidewall grading coefficient.

215 pbsw=0.8 vSide-wall junction potential.

216 fcsw=0.5Side-wall forward-bias depletion capacitance threshold.

Component Statements Part 1

Process and Power Supply Parameters

- 217 tox=4e-8 mGate oxide thickness.
- 218 vdd=5 VDrain voltage at which parameters are extracted.
- 219 vgg=5 vGate voltage at which parameters are extracted.
- 220 vbb=-5 vBody voltage at which parameters are extracted.

Default Device Parameters

- 221 w=3e-6 mChannel width.
- 222 1=3e-6 mChannel length.
- 223 as=0 m²Area of source diffusion.
- 224 ad=0 m²Area of drain diffusion.
- 225 ps=0 mPerimeter of source diffusion.
- 226 pd=0 mPerimeter of drain diffusion.
- 227 nrd=0 m/mNumber of squares of drain diffusion.
- 228 nrs=0 m/mNumber of squares of source diffusion.
- 229 ldd=0 mDrain diffusion length.
- 230 lds=0 mSource diffusion length.

Noise Model Parameters

- 231 noisemod=1Noise model selector.
- 232 kf=0Flicker (1/f) noise coefficient.
- 233 af=1Flicker (1/f) noise exponent.
- 234 ef=1Flicker (1/f) noise frequency exponent.

Component Statements Part 1

235 wnoi=1e-5 mChannel width at which noise parameters were extracted.

Auto Model Selector Parameters

- 236 wmax=1.0 mMaximum channel width for which the model is valid.
- 237 wmin=0.0 mMinimum channel width for which the model is valid.
- 238 lmax=1.0 mMaximum channel length for which the model is valid.
- 239 lmin=0.0 mMinimum channel length for which the model is valid.

Degradation Parameters

- 240 degramod=spectreDegradation model selector.

 Possible values are spectre or bert.
- 241 degradation=noHot-electron degradation flag.

 Possible values are no or yes.
- 242 dvthc=1 vDegradation coefficient for threshold voltage.
- 243 dvthe=1Degradation exponent for threshold voltage.
- 244 duoc=1 SDegradation coefficient for transconductance.
- 245 duoe=1 Degradation exponent for transconductance.
- 246 crivth=0.1 vMaximum allowable threshold voltage shift.
- 247 criuo=10%Maximum allowable normalized mobility change.
- 248 crigm=10%Maximum allowable normalized transconductance change.
- 249 criids=10%Maximum allowable normalized drain current change.
- 250 wnom=5e-6 mNominal device width in degradation calculation.
- 251 lnom=1e-6 mNominal device length in degradation calculation.
- 252 vbsn=0 vSubstrate voltage in degradation calculation.

Component Statements Part 1

- 253 vdsni=0.1 vDrain voltage in Ids degradation calculation.
- 254 vgsni=5 vGate voltage in Ids degradation calculation.
- 255 vdsng=0.1 VDrain voltage in Gm degradation calculation.
- 256 vgsng=5 vGate voltage in Gm degradation calculation.

Spectre Stress Parameters

- 257 esat=1.1e7 V/mCritical field in Vdsat calculation.
- 258 esatg=2.5e6 1/mGate voltage dependence of esat.
- 259 vpg=-0.25Gate voltage modifier.
- 260 vpb=-0.13Gate voltage modifier.
- 261 subc1=2.24e-5Substrate current coefficient.
- 262 subc2=-0.1e-5 1/VSubstrate current coefficient.
- 263 sube=6.4Substrate current exponent.
- 264 strc=1Stress coefficient.
- 265 stre=1Stress exponent.

BERT Stress Parameters

- 266 h0=1Aging coefficient.
- 267 hgd=0 1/VBias dependence of h0.
- 268 m0=1Aging exponent.
- 269 mgd=0 1/VBias dependence of m0.
- 270 ecrit0=1.1e5 V/cmCritical electric field.
- 271 lecrit0=0 μm V/cmLength dependence of ecrit0.

Component Statements Part 1

- 272 wecrit0=0 μ m V/cmWidth dependence of ecrit0.
- 273 ecritg=0 1/cmGate voltage dependence of ecrit0.
- 274 lecritg=0 μm/cmLength dependence of ecritg.
- 275 wecritg=0 μm/cmWidth dependence of ecritg.
- 276 ecritb=0 1/cmSubstrate voltage dependence of ecrit0.
- 277 lecritb=0 μm/cmLength dependence of ecritb.
- 278 wecritb=0 μ m/cmWidth dependence of ecritb.
- 279 1c0=1Substrate current coefficient.
- 280 11c0=0 µmLength dependence of 1c0.
- 281 wlc0=0 µmWidth dependence of lc0.
- 282 lc1=1Substrate current coefficient.
- 283 llc1=0 µmLength dependence of lc1.
- 284 wlc1=0 µmWidth dependence of lc1.
- 285 1c2=1Substrate current coefficient.
- 286 11c2=0 µmLength dependence of 1c2.
- 287 wlc2=0 µmWidth dependence of lc2.
- 288 1c3=1Substrate current coefficient.
- 289 llc3=0 μ mLength dependence of lc3.
- 290 wlc3=0 µmWidth dependence of lc3.
- 291 lc4=1Substrate current coefficient.
- 292 llc4=0 μ mLength dependence of lc4.
- 293 wlc4=0 µmWidth dependence of lc4.

Component Statements Part 1

294 1c5=1Substrate current coefficient.

295 11c5=0 µmLength dependence of 1c5.

296 wlc5=0 μmWidth dependence of lc5.

297 1c6=1Substrate current coefficient.

298 11c6=0 µmLength dependence of 1c6.

299 wlc6=0 µmWidth dependence of lc6.

300 1c7=1Substrate current coefficient.

301 llc7=0 µmLength dependence of lc7.

302 wlc7=0 μ mWidth dependence of lc7.

Imax and Imelt

The imax parameter aids convergence and prevents numerical overflow. The junction characteristics of the device are accurately modeled for current up to imax. If imax is exceeded during iterations, the linear model is substituted until the current drops below imax or until convergence is achieved. If convergence is achieved with the current exceeding imax, the results are inaccurate, and Spectre prints a warning.

A separate model parameter, imelt, is used as a limit warning for the junction current. This parameter can be set to the maximum current rating of the device. When any component of the junction current exceeds imelt, note that base and collector currents are composed of many exponential terms, Spectre issues a warning and the results become inaccurate. The junction current is linearized above the value of imelt to prevent arithmetic exception, with the exponential term replaced by a linear equation at imelt.

Both of these parameters have current density counterparts, jmax and jmelt, that you can specify if you want the absolute current values to depend on the device area.

Auto Model Selection

Many models need to be characterized for different geometries in order to obtain accurate results for model development. The model selector program automatically searches for a model with the length and width range specified in the instance statement and uses this model in the simulations.

Component Statements Part 1

For the auto model selector program to find a specific model, the models to be searched should be grouped together within braces. Such a group is called a model group. An opening brace is required at the end of the line defining each model group. Every model in the group is given a name followed by a colon and the list of parameters. Also, the four geometric parameters lmax, lmin, wmax, and wmin should be given. The selection criteria to choose a model is as follows:

the program would search all the models in the model group with the name ModelName and then pick the first model whose geometric range satisfies the selection criteria. In the preceding example, the auto model selector program would choose ModelName.2.

The user must specify both length (I) and width (w) on the device instance line to enable automatic model selection.

Output Parameters

1 weff (m) Effective channel width.

M1 1 2 3 4 ModelName w=3 l=1.5

- 2 leff (m) Effective channel length.
- 3 rseff (Ω) Effective source resistance.
- 4 rdeff (Ω) Effective drain resistance.
- 5 aseff (m²) Effective area of source diffusion.
- 6 adeff (m²) Effective area of drain diffusion.
- 7 pseff (m) Effective perimeter of source diffusion.
- 8 pdeff (m) Effective perimeter of source diffusion.

Component Statements Part 1

- 9 isseff (A) Effective source-bulk junction reverse saturation current.
- 10 isdeff (A) Effective drain-bulk junction reverse saturation current.
- 11 cbseff (F) Effective zero-bias source-bulk junction capacitance.
- 12 cbdeff (F) Effective zero-bias drain-bulk junction capacitance.
- 13 vto (V) Effective zero-bias threshold voltage.
- 14 vfb (V) Effective flat-band voltage.
- 15 phi (V) Effective surface potential.
- 16 k1 (\sqrt{V}) Effective body-effect coefficient.
- 17 k2Effective charge-sharing parameter.
- 18 etaEffective DIBL coefficient.

Operating-Point Parameters

- 1 type=nTransistor type.
- Possible values are n or p.
- 2 region=triodeEstimated operating region.
 - Possible values are off, triode, sat, subth, or breakdown.
- 3 degradation=noHot-electron degradation flag.
 - Possible values are no or yes.
- 4 reversedReverse mode indicator.
 - Possible values are no or yes.
- 5 ids (A) Resistive drain-to-source current.
- 6 vgs (V) Gate-source voltage.
- 7 vds (V) Drain-source voltage.
- 8 vbs (V) Bulk-source voltage.
- 9 vth (V)Threshold voltage.

Component Statements Part 1

- 10 vdsat (V) Drain-source saturation voltage.
- 11 betaeff (A/V^2) Effective beta.
- 12 gm (S) Common-source transconductance.
- 13 gds (S) Common-source output conductance.
- 14 gmbs (S) Body-transconductance.
- 15 cbd (F) Drain-bulk junction capacitance.
- 16 cbs (F) Source-bulk junction capacitance.
- 17 cgs (F) Gate-source capacitance.
- 18 cgd (F) Gate-drain capacitance.
- 19 cgb (F) Gate-bulk capacitance.
- 20 ron (Ω) ON-resistance.
- 21 id (A) Resistive drain current.
- 22 ibulk (A) Resistive bulk current.
- 23 pwr (W) Power at op point.
- 24 gmoverid (1/V) Gm/lds.
- 25 isub (A) Substrate current.
- 26 stressHot-electron stress.
- 27 age (s) Device age.
- 28 he_vdsat (V)hot electron vdsat.

Parameter Index

In the following index, I refers to instance parameters, M refers to the model parameters section, O refers to the output parameters section, and OP refers to the operating point parameters section. The number indicates where to look in the appropriate section to find the

Component Statements Part 1

description for that parameter. For example, a reference of M-35 means the 35th model parameter.

ad M-224	lc1 M-282	nrs I-8	ute M-166
ad I-4	lc2 M-285	nrs M-228	uto M-165
adeff 0-6	lc3 M-288	pai0 M-134	vbb M-220
af M-233	lc4 M-291	paib M-138	vbox M-206
age OP-27	1c5 M-294	pb M-211	vbs OP-8
ai0 M-131	1c6 M-297	pbi0 M-142	vbsn M-252
aib M-135	1c7 M-300	pbib M-146	vdd M-218
alarm M-202	ld I-9	pbsw M-215	vds OP-7
as I-3	ldd M-229	pd I-6	vdsat OP-10
as M-223	ldif M-192	pd M-226	vdsng M-255
aseff 0-5	lds M-230	pdeff 0-8	vdsni M-253
betaeff OP-11	lecrit0 M-271	peta0 M-21	version M-164
bi0 M-139	lecritb M-277	petab M-25	vfb 0-14
bib M-143	lecritg M-274	phi 0-15	vfb0 M-2
bvj M-205	leff O-2	phi0 M-6	vgg M-219
capmod M-180	leta0 M-19	pk1 M-13	vghigh M-147
cbd OP-15	letab M-23	pk2 M-17	vglow M-151
cbd M-208	lgcd M-194	pmu0 M-29	vgs OP-6
cbdeff 0-12	lgcs M-193	pmu0b M-33	vgsng M-256
cbs OP-16	lk1 M-11	pmu20 M-45	vgsni M-254
cbs M-207	lk2 M-15	pmu2b M-49	vof0 M-118
cbseff 0-11	llc0 M-280	pmu2g M-53	vofb M-122
cgb OP-19	llc1 M-283	pmu30 M-57	vofd M-126
cgbo M-178	llc2 M-286	pmu3b M-61	vpb M-260
cgd OP-18	llc3 M-289	pmu3g M-65	vpg M-259
cgdo M-177	llc4 M-292	pmu40 M-69	vth OP-9
cgs OP-17	llc5 M-295	pmu4b M-73	vto 0-13
cgso M-176	llc6 M-298	pmu4g M-77	w M-221
cj M-209	llc7 M-301	pmus0 M-37	w I-1
cjsw M-213	lmax M-238	pmusb M-41	wai0 M-133
crigm M-248	lmin M-239	pn0 M-109	waib M-137
criids M-249	lmu0 M-27	pnb M-113	wbi0 M-141
criuo M-247	lmu0b M-31	pnd M-117	wbib M-145
crivth M-246	lmu20 M-43	pphi M-9	wecrit0 M-272
degradation OP-3	lmu2b M-47	ps I-5	wecritb M-278
-	lmu2g M-51	ps M-225	wecritg M-275
degradation I-14	lmu30 M-55	pseff 0-7	weff O-1
degramod M-240	lmu3b M-59	ptc M-169	weta0 M-20
dl0 M-155	lmu3g M-63	pu10 M-97	wetab M-24
dskip M-199	lmu40 M-67	pulb M-101	wk1 M-12
duoc M-244	lmu4b M-71	puld M-105	wk2 M-16
duoe M-245	lmu4g M-75	pua0 M-81	wlc0 M-281
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dvthc M-242	lmus0 M-35	puab M-85	wlc1 M-284
dvthe M-243	lmusb M-39	pub0 M-89	wlc2 M-287
dw0 M-156	ln0 M-107	pubb M-93	wlc3 M-290
ecrit0 M-270	lnb M-111	pvfb M-5	wlc4 M-293
ecritb M-276	lnd M-115	pvghigh M-150	
ecritg M-273	lnom M-251	pvglow M-154	wlc6 M-299
ef M-234	lphi M-7	pvof0 M-121	wlc7 M-302
eg M-170	lref M-157	pvofb M-125	wmax M-236
esat M-257	ls I-10	pvofd M-129	wmin M-237
esatg M-258	lu10 M-95	pwr OP-23	wmu0 M-28
eta 0-18	lu1b M-99	rd M-184	wmu0b M-32
eta0 M-18	luld M-103	rdc M-187	wmu20 M-44
etab M-22	lua0 M-79	rdd M-189	wmu2b M-48
fc M-212	luab M-83	rdeff O-4	wmu2g M-52
fcsw M-216	lub0 M-87	region OP-2	wmu30 M-56
gap1 M-171	lubb M-91	region I-12	wmu3b M-60
gap2 M-172	lvfb M-3	reversed OP-4	wmu3g M-64
gds OP-13	lvghigh M-148	ron OP-20	wmu40 M-68
gm OP-12	lvglow M-152	rs M-183	wmu4b M-72
gmbs OP-14	lvof0 M-119	rsc M-186	wmu4g M-76
gmoverid OP-24	lvofb M-123	rseff 0-3	wmus0 M-36
h0 M-266	lvofd M-127	rsh M-185	wmusb M-40
hdif M-191	m I-11	rss M-188	wn0 M-108
he_vdsat OP-28	m0 M-268	sc M-195	wnb M-112
hgd M-267	meto M-179	strc M-264	wnd M-116
ibulk OP-22	mgd M-269	stre M-265	wnoi M-235
id OP-21	minr M-190	stress OP-26	wnom M-250
ids OP-5	mj M-210	subcl M-261	wphi M-8
imax M-203	mjsw M-214	subc2 M-262	wref M-158
imelt M-200	mu0 M-26	sube M-263	wu10 M-96
is M-197	mu0b M-30	subthmod M-130	wulb M-100
isdeff 0-10	mu20 M-42	temp M-161	wuld M-104
isseff 0-9	mu2b M-46	tempmod M-163	wua0 M-80
isub OP-25	mu2g M-50	tlev M-167	wuab M-84
jmax M-204	mu30 M-54	tlevc M-168	wub0 M-88
jmelt M-201	mu3b M-58	tox M-217	wubb M-92
js M-196	mu3g M-62	trd M-174	wvfb M-4
k1 M-10	mu40 M-66	trise M-162	wvghigh M-149
k1 0-16	mu4b M-70	trise I-13	wvglow M-153
k2 M-14	mu4g M-74	trs M-173	wvof0 M-120
k2 0-17	mus0 M-34	type M-1	wvofb M-124
kf M-232	musb M-38	type OP-1	wvofd M-128
1 M-222	n M-198	u10 M-94	xl M-160
1 I-2	n0 M-106	ulb M-98	xpart M-181
lai0 M-132	nb M-110	uld M-102	xqc M-182
laib M-136	nd M-114	ua0 M-78	xti M-175
lbi0 M-140	noisemod M-231	uab M-82	xw M-159

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Component Statements Part 1

lbib	M - 144	nrd	I-7	ub0	M-86
lc0	M - 279	nrd	M - 227	ubb	M - 90

BSIM3 MOS Transistor (bsim3)

Description

This is the BSIM3 version-2 (BSIM3v2) model. The BSIM3v2 model is a physically-based, predictive, and computationally efficient model developed at the University of California, Berkeley. It is suitable for both digital and analog applications. In SPICE mode, refer to BSIM3 as MOS level 10. BSIM3 transistors require that you use a model statement.

This device is supported within altergroups.

To examine the equations used for this component, consult the <u>Spectre Circuit Simulator</u> <u>Device Model Equations</u> manual.

Sample Instance Statement

m3 (1 2 0 0) nchmod l=1.5u w=100u as=450p ad=450p pd=209u ps=209u nrd=207m nrs=207m m=1

Sample Model Statement

model nchmod bsim3 vtho=5.94e-01 phi=0.69 k1=0.72 k2=0 w0=1.3e-07 tox=5.9e-09 rdsw=80 uo=499 xj=2e-07 vsat=600e+04 at=3.4e+04 a0=0.8 cdsc=1.4e-03 nfactor=1.03

Instance Definition

```
Name d g s b ModelName parameter=value ...
```

Instance Parameters

- 1 w (m) Channel width.
- 2 1 (m) Channel length.
- 3 as (m^2) Area of source diffusion.
- 4 ad (m²) Area of drain diffusion.
- 5 ps (m) Perimeter of source diffusion.

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Component Statements Part 1

- 6 pd (m) Perimeter of drain diffusion.
- 7 nrd (m/m) Number of squares of drain diffusion.
- 8 nrs (m/m) Number of squares of source diffusion.
- 9 m=1Multiplicity factor (number of MOSFETs in parallel).
- 10 region=triodeEstimated operating region.

Possible values are off, triode, sat, subth, or breakdown.

11 triseTemperature rise from ambient.

Model Definition

model modelName bsim3 parameter=value ...

Model Parameters

Device Type Parameters

1 type=nTransistor type.

Possible values are n or p.

Threshold Voltage Parameters

- 2 vtho=0 vThreshold voltage at zero body bias.
- 3 phi=0.7 vSurface potential at strong inversion.
- 4 k1=0.53 \sqrt{V} Body-effect coefficient.
- 5 k2=-0.0186Charge-sharing parameter.
- 6 k3=80Narrow width coefficient.
- 7 k3b=0 1/VNarrow width coefficient.
- 8 w0=2.5e-6 mNarrow width coefficient.
- 9 nlx=1.74e-7 mLateral nonuniform doping coefficient.

Component Statements Part 1

- 10 gamma1=0 \sqrt{V} Body-effect coefficient near the surface.
- 11 gamma2=0 \sqrt{V} Body-effect coefficient in the bulk.
- 12 theta=0.02 1/VDrain-induced barrier lowering coefficient.
- 13 eta=0.3 1/VEffective drain voltage coefficient.
- 14 lit1 (m) Depth of current path.
- 15 vfb (V) Flat-band voltage.
- 16 vbx (V) Threshold voltage transition body voltage.
- 17 vbi (V) Substrate junction built-in potential.
- 18 vbm=-5 vMaximum applied body voltage.
- 19 dvt0=2.2First coefficient of short-channel effects.
- 20 dvt1=0.53Second coefficient of short-channel effects.
- 21 dvt2=-0.032 1/VBody-bias coefficient of short-channel effects.
- 22 a0=1 for nmos and 4.4 for pmos

 Nonuniform depletion width effect coefficient.
- 23 al=0 for nmos, 0.23 for pmos

 No-saturation coefficient.
- 24 a2=1 for nmos, 0.08 for pmos

 No-saturation coefficient.
- 25 keta=-0.047 1/VBody-bias coefficient for non-uniform depletion width effect.

Process Parameters

- 26 nsub=2e15 cm⁻³Substrate doping concentration.
- 27 npeak=1.7e17 cm⁻³ Peak channel doping concentration.
- 28 ngate (cm⁻³) Poly-gate doping concentration.

Component Statements Part 1

- 29 xj=0.15e-6 mSource/drain junction depth.
- 30 d1=0 mLateral diffusion for one side.
- 31 dw=0 mWidth reduction for one side.
- 32 tox=1.5e-8 mGate oxide thickness.
- 33 vdd=5 vMaximum drain voltage.
- 34 xt=1.55e-7 mDoping depth.
- 35 1dd=0 mTotal length of lightly doped drain region.
- 36 rds0=0 Ω Total drain-source resistance.
- 37 rdsw=0 Ω µmWidth dependence of drain-source resistance.

Mobility Parameters

- 38 uo=670 cm²/V sLow-field surface mobility at tnom. Default is 250 for PMOS.
- 39 vsat=9.58e4 m/sCarrier saturation velocity at tnom.
- 40 ua=2.25e-9 m/vFirst-order mobility reduction coefficient.
- **41** ub=5.87e-19 m^2/v^2

Second-order mobility reduction coefficient.

- 42 uc=0.0465 1/VBody-bias dependence of mobility.
- 43 uc0=0Mobility coefficient.

Output Resistance Parameters

- 44 satmod=2Saturation model selector.
- 45 bulkmod=1Bulk-charge effect model selector.
- 46 drout=0.56DIBL effect on output resistance coefficient.
- 47 alpha=1.9Reference voltage multiplication factor.

Component Statements Part 1

- 48 em=4.1e7 V/mMaximum electric field.
- 49 pclm=1.3Channel length modulation coefficient.
- 50 pdibl1=0.39First coefficient of drain-induced barrier lowering.
- 51 pdibl2=8.6e-3Second coefficient of drain-induced barrier lowering.
- 52 pscbe1=4.24e8 V/mFirst coefficient of substrate current body effect.
- 53 pscbe2=1e-5 m/vSecond coefficient of substrate current body effect.
- 54 pvag=0Gate dependence of Early voltage.

Subthreshold Parameters

- 55 subthmod=2Subthreshold model selector.
- 56 vghigh=0.12 vUpper bound of transition region.
- 57 vglow=-0.12 VLower bound of transition region.
- 58 cdsc=2.4e-4 F/m²Source/drain and channel coupling capacitance.
- 59 cdscb=0 F/m² VBody-bias dependence of cdsc.
- 60 nfactor=1Subthreshold swing coefficient.
- 61 cit=0 FInterface trap parameter for subthreshold swing.
- 62 voff=-0.11 vThreshold voltage offset.
- 63 dsub=drout DIBL effect in subthreshold region.
- 64 eta0=0.08DIBL coefficient subthreshold region.
- 65 etab=-0.07 1/VBody-bias dependence of et0.

Parasitic Resistance Parameters

66 rsh=0 Ω /sqrSource/drain diffusion sheet resistance.

Component Statements Part 1

- 67 rs=0 Ω Source resistance.
- 68 rd=0 Ω Drain resistance.
- 69 lgcs=0 mGate-to-contact length of source side.
- 70 lgcd=0 mGate-to-contact length of drain side.
- 71 rsc=0 Ω Source contact resistance.
- 72 rdc=0 Ω Drain contact resistance.
- 73 rss=0 Ω mScalable source resistance.
- 74 rdd=0 Ω mScalable drain resistance.
- 75 sc=∞ mSpacing between contacts.
- 76 ldif=0 mLateral diffusion beyond the gate.
- 77 hdif=0 mLength of heavily doped diffusion.
- 78 minr=0.1 Ω Minimum source/drain resistance.

Junction Diode Model Parameters

- 79 js (A/m²) Bulk junction reverse saturation current density.
- 80 is=1e-14 ABulk junction reverse saturation current.
- 81 n=1Junction emission coefficient.
- 82 dskip=yesUse simple piece-wise linear model for diode currents below 0.1*iabstol. Possible values are no or yes.
- 83 imelt=`imaxA' Explosion current.
- 84 jmelt=\jmaxA/m'²

Explosion current density.

Component Statements Part 1

Overlap Capacitance Parameters

- 85 cgso (F/m) Gate-source overlap capacitance.
- 86 cgdo (F/m) Gate-drain overlap capacitance.
- 87 cgbo (F/m) Gate-bulk overlap capacitance.
- 88 meto=0 mMetal overlap in fringing field.

Junction Capacitance Model Parameters

- 89 cbs=0 FBulk-source zero-bias junction capacitance.
- 90 cbd=0 FBulk-drain zero-bias junction capacitance.
- 91 cj=5e-4 F/m²Zero-bias junction bottom capacitance density.
- 92 mj=1/2Bulk junction bottom grading coefficient.
- 93 pb=0.8 vBulk junction built-in potential.
- 94 fc=0.5Forward-bias depletion capacitance threshold.
- 95 cjsw=5e-10 F/mZero-bias junction sidewall capacitance density.
- 96 mjsw=1/3Bulk junction sidewall grading coefficient.
- 97 pbsw=0.8 vSide-wall junction built-in potential.
- 98 fcsw=0.5Side-wall forward-bias depletion capacitance threshold.

Charge Model Selection Parameters

- 99 capmod=yangIntrinsic charge model.
 - Possible values are none, meyer, yang, or bsim.
- $100 \, \text{xpart} = 1 \, \text{Drain/source}$ channel charge partition in saturation for BSIM charge model, use 0.0 for 40/60, 0.5 for 50/50, or 1.0 for 0/100.
- 101 \times qc=0Drain/source channel charge partition in saturation for charge models, e.g. use 0.4 for 40/60, 0.5 for 50/50, 0 for 0/100.

Component Statements Part 1

Default Instance Parameters

- 102 w=5e-6 mDefault channel width.
- 103 l=5e-6 mDefault channel length.
- 104 as=0 m²Default area of source diffusion.
- 105 ad=0 m²Default area of drain diffusion.
- 106 ps=0 mDefault perimeter of source diffusion.
- 107 pd=0 mDefault perimeter of drain diffusion.
- 108 nrd=0 m/mDefault number of squares of drain diffusion.
- 109 nrs=0 m/mDefault number of squares of source diffusion.

Temperature Effects Parameters

- 110 tnom (C) Parameters measurement temperature. Default set by options.
- 111 trise=0 CTemperature rise from ambient.
- 112 tlev=0DC temperature selector.
- 113 tlevc=0AC temperature selector.
- **114** eg=1.12452 VEnergy band gap.
- 115 gap1=7.02e-4 V/CBand gap temperature coefficient.
- 116 gap2=1108 CBand gap temperature offset.
- 117 kt1=-0.11 VTemperature coefficient for threshold voltage.
- 118 kt1l=-1.86e-7 v mTemperature coefficient for threshold voltage.
- 119 kt2=0.022Temperature coefficient for threshold voltage.
- 120 at=3.3e4 m/sTemperature coefficient for vsat.
- 121 ua1=4.31e-9 m/vTemperature coefficient for ua.

Component Statements Part 1

122 ub1=-7.61e-18 m^2/v^2

Temperature coefficient for ub.

123 uc1=-0.056 1/VTemperature coefficient for uc.

124 trs=0 1/CTemperature parameter for source resistance.

125 trd=0 1/cTemperature parameter for drain resistance.

126 ute=-1.5Mobility temperature exponent.

127 xti=3Saturation current temperature exponent.

128 ptc=0 V/CSurface potential temperature coefficient.

129 tov=0 V/CThreshold voltage temperature coefficient.

130 pta=0 V/CJunction potential temperature coefficient.

131 ptp=0 V/CSidewall junction potential temperature coefficient.

132 cta=0 1/CJunction capacitance temperature coefficient.

133 ctp=0 1/cSidewall junction capacitance temperature coefficient.

Noise Model Parameters

134 noisemod=1Noise model selector.

135 kf=0 Flicker (1/f) noise coefficient.

136 af=1Flicker (1/f) noise exponent.

137 ef=1Flicker (1/f) noise frequency exponent.

138 wnoi=le-5 mChannel width at which noise parameters were extracted.

139 a=1e16 for nmos and 9.9e14 for pmos

Oxide trap density coefficient.

140 b=5e4 for nmos and 2.4e3 for pmos

Oxide trap density coefficient.

Component Statements Part 1

141 c=-1.4e-8 for nmos and 1.4e-8 for pmos Oxide trap density coefficient.

Operating Region Warning Control Parameters

- 142 alarm=noneForbidden operating region.
 - Possible values are none, off, triode, sat, subth, or rev.
- 143 imax=1 AMaximum allowable current.
- 144 jmax=1e8 A/m²Maximum allowable current density.
- 145 by j=∞ VJunction reverse breakdown voltage.
- 146 vbox=1e9 tox VOxide breakdown voltage.
- 147 maxvp=1.12 VMaximum allowable voltage across the gate poly layer.

Auto Model Selector Parameters

- 148 wmax=1.0 mMaximum channel width for which the model is valid.
- 149 wmin=0.0 mMinimum channel width for which the model is valid.
- 150 lmax=1.0 mMaximum channel length for which the model is valid.
- 151 lmin=0.0 mMinimum channel length for which the model is valid.

Imax and Imelt

The imax parameter aids convergence and prevents numerical overflow. The junction characteristics of the device are accurately modeled for current up to imax. If imax is exceeded during iterations, the linear model is substituted until the current drops below imax or until convergence is achieved. If convergence is achieved with the current exceeding imax, the results are inaccurate, and Spectre prints a warning.

A separate model parameter, imelt, is used as a limit warning for the junction current. This parameter can be set to the maximum current rating of the device. When any component of the junction current exceeds imelt, note that base and collector currents are composed of many exponential terms, Spectre issues a warning and the results become inaccurate. The junction current is linearized above the value of imelt to prevent arithmetic exception, with the exponential term replaced by a linear equation at imelt.

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Component Statements Part 1

Both of these parameters have current density counterparts, jmax and jmelt, that you can specify if you want the absolute current values to depend on the device area.

Auto Model Selection

Many models need to be characterized for different geometries in order to obtain accurate results for model development. The model selector program automatically searches for a model with the length and width range specified in the instance statement and uses this model in the simulations.

For the auto model selector program to find a specific model, the models to be searched should be grouped together within braces. Such a group is called a model group. An opening brace is required at the end of the line defining each model group. Every model in the group is given a name followed by a colon and the list of parameters. Also, the four geometric parameters lmax, lmin, wmax, and wmin should be given. The selection criteria to choose a model is as follows:

Then for a given instance

```
M1 1 2 3 4 ModelName w=3 1=1.5
```

the program would search all the models in the model group with the name ModelName and then pick the first model whose geometric range satisfies the selection criteria. In the preceding example, the auto model selector program would choose ModelName.2.

The user must specify both length (I) and width (w) on the device instance line to enable automatic model selection.

Output Parameters

- 1 weff (m) Effective channel width.
- 2 leff (m) Effective channel length.
- 3 rseff (Ω) Effective source resistance.

Component Statements Part 1

4 rdeff (Ω) Effective drain resistance.

Operating-Point Parameters

- 1 type=nTransistor type.
- Possible values are n or p.
- 2 region=triodeEstimated operating region.

Possible values are off, triode, sat, subth, or breakdown.

3 reversedReverse mode indicator.

Possible values are no or yes.

- 4 ids (A) Resistive drain-to-source current.
- 5 vgs (V) Gate-source voltage.
- 6 vds (V) Drain-source voltage.
- 7 vbs (V) Bulk-source voltage.
- 8 vth (V)Threshold voltage.
- 9 vdsat (V) Drain-source saturation voltage.
- 10 gm (S) Common-source transconductance.
- 11 gds (S) Common-source output conductance.
- 12 gmbs (S) Body-transconductance.
- 13 betaeff (A/V^2) Effective beta.
- 14 cbd (F) Drain-bulk junction capacitance.
- 15 cbs (F) Source-bulk junction capacitance.
- 16 cgs (F) Gate-source capacitance.
- 17 cgd (F) Gate-drain capacitance.
- 18 cgb (F) Gate-bulk capacitance.

Component Statements Part 1

- 19 ron (Ω) On-resistance.
- 20 id (A) Resistive drain current.
- 21 ibulk (A) Resistive bulk current.
- 22 pwr (W) Power at op point.
- 23 gmoverid (1/V) Gm/lds.

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BSIM3v3 MOS Transistor (bsim3v3)

Description

BSIM3v3 is the version-3 of bsim3 model. The versions supported are 3.1, 3.2, 3.21, 3.22, 3.23 and 3.24. It uses single-piece equations for all regions to improve the smoothness of the model characteristics. BSIM3v3 also allows the binning option like the approach used in bsim1 and bsim2. This option is provided for people who want to achieve the highest accuracy of the model. The binning equation is given by

$$P = P0 + PI / Leff + Pw / Weff + Pp / (Leff * Weff)$$

Only the P0 parameters are listed. PI, Pw, and Pw are not shown but can be recognized. The names of PI, Pw, and Pp are identical to that of P0 but with a prefix of I, w, and p, respectively. BSIM3v3 transistors require that you use a model statement.

For more information on this model, please consult the University of California at Berkeley BSIM3 home page at

http://www-device.eecs.berkeley.edu/~bsim3/index.html

Component Statements Part 1

This device is supported within altergroups.

To examine the equations used for this component, consult the <u>Spectre Circuit Simulator</u> <u>Device Model Equations</u> manual.

Sample Instance Statement

m4 (0 2 1 1) pchmod w=2u 1=0.8u as=250p ad=250p pd=168p ps=168p m=1

Sample Model Statement

model pchmod bsim3v3 type=p mobmod=1 capmod=2 version=3.1 tox=9e-5 cdsc=1e-3 cdscb=-4.36889e-4 cdscd=0 cit=0 nfactor=1.79 xj=1.5e-7 vsat=1.5737e5 at=1e5 a0=1.2522809 ags=0.2912413 a1=1.01222e-4 a2=0.996841 keta=0 nch=4.06263e17 ngate=7.6e19 k1=0.823562

Instance Definition

Name d g s b ModelName parameter=value ...

Instance Parameters

- 1 w (m) Channel width.
- 2 1 (m) Channel length.
- 3 as (m²) Area of source diffusion.
- 4 ad (m²) Area of drain diffusion.
- 5 ps (m) Perimeter of source diffusion.
- 6 pd (m) Perimeter of drain diffusion.
- 7 nrd (m/m) Number of squares of drain diffusion.
- 8 nrs (m/m) Number of squares of source diffusion.
- 9 m=1Multiplicity factor (number of MOSFETs in parallel).
- 10 region=triodeEstimated operating region.

Possible values are off, triode, sat, subth, or breakdown.

11 ngsmodNQS flag.

Component Statements Part 1

12 triseTemperature rise from ambient.

Model Definition

model modelName bsim3v3 parameter=value ...

Model Parameters

Device Type Parameters

1 type=nTransistor type.

Possible values are n or p.

Threshold Voltage Parameters

- 2 vtho (V) Threshold voltage at zero body bias for long-channel devices. For enhancement-mode devices, vtho > 0 for n-channel and vth < 0 for p-channel. Default value is calculated from other model parameters.
- 3 vfb=-1Flat-band voltage.
- 4 $k1=0.5 \ \sqrt{V}$ Body-effect coefficient.
- 5 k2=-0.0186Charge-sharing parameter.
- 6 k3=80Narrow width coefficient.
- 7 k3b=0 1/VNarrow width coefficient.
- 8 w0=2.5e-6 mNarrow width coefficient.
- 9 nlx=1.74e-7 mLateral nonuniform doping coefficient.
- 10 gamma1 (\sqrt{V}) Body-effect coefficient near the surface.
- 11 gamma2 (\sqrt{V}) Body-effect coefficient in the bulk.
- 12 vbx (V) Threshold voltage transition body voltage.
- 13 vbm=-3 vMaximum applied body voltage.

Component Statements Part 1

- 14 dvt0=2.2First coefficient of short-channel effects.
- 15 dvt1=0.53Second coefficient of short-channel effects.
- 16 dvt2=-0.032 1/VBody-bias coefficient of short-channel effects.
- 17 dvt0w=0First coefficient of narrow-width effects.
- 18 dvt1w=5.3e6Second coefficient of narrow-width effects.
- 19 dvt2w=-0.032 1/VBody-bias coefficient of narrow-width effects.
- 20 a0=1Nonuniform depletion width effect coefficient.
- 21 b0=0 mBulk charge coefficient due to narrow width effect.
- 22 b1=0 mBulk charge coefficient due to narrow width effect.
- 23 a1=0No-saturation coefficient.
- 24 a2=1No-saturation coefficient.
- 25 ags=0 F/m² VGate-bias dependence of Abulk.
- 26 keta=-0.047 1/VBody-bias coefficient for non-uniform depletion width effect.

Process Parameters

- 27 nsub=6e16 cm⁻³Substrate doping concentration.
- 28 nch=1.7e17 cm⁻³Peak channel doping concentration.
- 29 $ngate=\infty cm^{-3}$

Poly-gate doping concentration.

- 30 xj=0.15e-6 mSource/drain junction depth.
- 31 lint=0 mLateral diffusion for one side.
- 32 wint=0 mWidth reduction for one side.
- 33 11=0 mLength dependence of delta L.

Component Statements Part 1

- 34 lln=1Length exponent of delta L.
- 35 lw=0 mWidth dependence of delta L.
- 36 lwn=1Width exponent of delta L.
- 37 lwl=0 m²Area dependence of delta L.
- 38 w1=0 mLength dependence of delta W.
- 39 wln=1Length exponent of delta W.
- 40 ww=0 mWidth dependence of delta W.
- 41 wwn=1Width exponent of delta W.
- 42 ww1=0 m²Area dependence of delta W.
- 43 dwg=0 m/vGate-bias dependence of channel width.
- 44 dwb=0 m/ \sqrt{v} Body-bias dependence of channel width.
- 45 tox=1.5e-8 mGate oxide thickness.
- 46 toxm=tox mTox at which parameters were extracted.
- 47 xt=1.55e-7 mDoping depth.
- 48 rdsw=0 Ω µmWidth dependence of drain-source resistance.
- 49 prwb=0 $1/\sqrt{v}$ Body-effect coefficient for Rds.
- 50 prwg=0 1/VGate-effect coefficient for Rds.
- 51 wr=1Width offset for parasitic resistance.
- 52 binunit=1Bin parameter unit selector. 1 for microns and 2 for meters.

Mobility Parameters

53 mobmod=1Mobility model selector.

Component Statements Part 1

- 54 u0=670 cm²/V sLow-field surface mobility at tnom. Default is 250 for PMOS Mobility can also be specified in M2/Vs..
- 55 vsat=8e4 m/sCarrier saturation velocity at tnom.
- 56 ua=2.25e-9 m/vFirst-order mobility reduction coefficient.
- **57** ub=5.87e-19 m^2/v^2

Second-order mobility reduction coefficient.

58 uc=-4.65e-11 m/v^2

Body-bias dependence of mobility. Default is -0.046 and unit is 1/V for mobmod=3.

Output Resistance Parameters

- 59 drout=0.56DIBL effect on output resistance coefficient.
- 60 pclm=1.3Channel length modulation coefficient.
- 61 pdiblc1=0.39First coefficient of drain-induced barrier lowering.
- 62 pdiblc2=8.6e-3Second coefficient of drain-induced barrier lowering.
- 63 pdiblcb=0 1/VBody-effect coefficient for DIBL.
- 64 pscbe1=4.24e8 V/mFirst coefficient of substrate current body effect.
- 65 pscbe2=1e-5 m/vSecond coefficient of substrate current body effect.
- 66 pvag=0Gate dependence of Early voltage.
- 67 delta=0.01 vEffective drain voltage smoothing parameter.

Subthreshold Parameters

- 68 cdsc=2.4e-4 F/m²Source/drain and channel coupling capacitance.
- 69 cdscb=0 F/m^2 VBody-bias dependence of cdsc.
- 70 cdscd=0 F/m² VDrain-bias dependence of cdsc.

Component Statements Part 1

- 71 nfactor=1Subthreshold swing coefficient.
- 72 cit=0 FInterface trap parameter for subthreshold swing.
- 73 voff=-0.08 vThreshold voltage offset.
- 74 dsub=drout DIBL effect in subthreshold region.
- 75 eta0=0.08DIBL coefficient subthreshold region.
- 76 etab=-0.07 1/VBody-bias dependence of et0.

Substrate Current Parameters

- 77 alpha0=0 m/vSubstrate current impact ionization coefficient.
- 78 alpha1=0 1/VSubstrate current impact ionization coefficient.
- 79 beta0=30 1/VSubstrate current impact ionization exponent.

Parasitic Resistance Parameters

- 80 rsh=0 Ω/sqr Source/drain diffusion sheet resistance.
- 81 rs=0 Ω Source resistance.
- 82 rd=0 Ω Drain resistance.
- 83 lgcs=0 mGate-to-contact length of source side.
- 84 lgcd=0 mGate-to-contact length of drain side.
- 85 rsc=0 Ω Source contact resistance.
- 86 rdc=0 Ω Drain contact resistance.
- 87 rss=0 Ω mScalable source resistance.
- 88 rdd=0 Ω mScalable drain resistance.
- 89 sc=∞ mSpacing between contacts.

Component Statements Part 1

- 90 ldif=0 mLateral diffusion beyond the gate.
- 91 hdif=0 mLength of heavily doped diffusion.
- 92 minr=0.1 Ω Minimum source/drain resistance.

Junction Diode Model Parameters

- 93 js (A/m²) Bulk junction reverse saturation current density.
- 94 jsw=0 A/mSidewall junction reverse saturation current density.
- 95 is=1e-14 ABulk junction reverse saturation current.
- 96 n=1Junction emission coefficient.
- 97 dskip=yesUse simple piece-wise linear model for diode currents below 0.1*iabstol. Possible values are no or yes.
- 98 imelt=\imaxA'Explosion current.
- 99 jmelt='jmaxA/m'²

Explosion current density.

Overlap Capacitance Parameters

- 100 cgso (F/m) Gate-source overlap capacitance.
- 101 cgdo (F/m) Gate-drain overlap capacitance.
- 102 cgbo=2 Dwc Cox F/m

Gate-bulk overlap capacitance. The default value is 0 if version=3.0.

- 103 meto=0 mMetal overlap in fringing field.
- 104 cgs1=0 F/mGate-source overlap capacitance in LDD region.
- 105 cgdl=0 F/mGate-drain overlap capacitance in LDD region.
- 106 ckappa=0.6Overlap capacitance fitting parameter.

Component Statements Part 1

Junction Capacitance Model Parameters

- 107 cbs=0 FBulk-source zero-bias junction capacitance.
- 108 cbd=0 FBulk-drain zero-bias junction capacitance.
- 109 cj=5e-4 F/m²Zero-bias junction bottom capacitance density.
- 110 mj=1/2Bulk junction bottom grading coefficient.
- 111 pb=1 VBulk junction built-in potential.
- 112 fc=0.5Forward-bias depletion capacitance threshold.
- 113 cjsw=5e-10 F/mZero-bias junction sidewall capacitance density.
- 114 mjsw=0.33Bulk junction sidewall grading coefficient.
- 115 pbsw=1 vSide-wall junction built-in potential.
- 116 cjswg=cjsw F/mZero-bias gate-side junction capacitance density.
- 117 mjswg=mjswGate-side junction grading coefficient.
- 118 pbswg=pbsw VGate-side junction built-in potential.
- 119 fcsw=0.5Side-wall forward-bias depletion capacitance threshold.

Charge Model Selection Parameters

- 120 capmod=2Intrinsic charge model.
- 121 ngsmod=0Non-quasi static model selector. Set to 1 to turn on ngs.
- 122 dwc=wint mDelta W for capacitance model.
- 123 dlc=lint mDelta L for capacitance model.
- 124 clc=1e-7 mIntrinsic capacitance fitting parameter.
- 125 cle=0.6Intrinsic capacitance fitting parameter.
- 126 cf (F/m) Fringe capacitance parameter.

Component Statements Part 1

- 127 elm=5Elmore constant of the channel.
- 128 vfbcv=-1Flat-band voltage for capmod=0.
- 129 acde=1 1/VCV parameter.
- 130 moin=15 1/VCV parameter.
- 131 noff=1Transition parameter.
- 132 voffcv=0Transition parameter.
- $133 \times part = 0$ Drain/source channel charge partition in saturation for BSIM charge model, use 0.0 for 40/60, 0.5 for 50/50, or 1.0 for 0/100.
- 134 llc=ll mLength dependence of delta L for CV.
- 135 lwc=lw mWidth dependence of delta L for CV.
- 136 lwlc=lwl m²Area dependence of delta L for CV.
- 137 wlc=wl mLength dependence of delta W for CV.
- 138 wwc=ww mWidth dependence of delta W for CV.
- 139 wwlc=wwl m²Area dependence of delta W for CV.

Default for Instance Parameters

- 140 w=5e-6 mDefault channel width.
- 141 1=5e-6 mDefault channel length.
- 142 as=0 m²Default area of source diffusion.
- 143 ad=0 m²Default area of drain diffusion.
- 144 ps=0 mDefault perimeter of source diffusion.
- 145 pd=0 mDefault perimeter of drain diffusion.
- 146 nrd=0 m/mDefault number of squares of drain diffusion.

Component Statements Part 1

147 nrs=0 m/mDefault number of squares of source diffusion.

148 version=3.1Model version selector. The available versions are 3.1, 3.2, 3.21, 3.22, 3.23 and 3.24.

149 paramchk=1Model parameter checking selector.

150 fullreinit=0Model parameter full reinit selector.

Temperature Effects Parameters

151 tnom (C) Parameters measurement temperature. Default set by options.

152 trise=0 CTemperature rise from ambient.

153 tlev=0DC temperature selector.

154 tlevc=0AC temperature selector.

155 eq=1.12452 VEnergy band gap.

156 gap1=7.02e-4 V/CBand gap temperature coefficient.

157 gap2=1108 CBand gap temperature offset.

158 diomod=1Backward compatibility diode flag.

159 kt1=-0.11 VTemperature coefficient for threshold voltage.

160 kt11=0 v mTemperature coefficient for threshold voltage.

161 kt2=0.022Temperature coefficient for threshold voltage.

162 at=3.3e4 m/sTemperature coefficient for vsat.

163 ual=4.31e-9 m/vTemperature coefficient for ua.

164 ub1=-7.61e-18 m^2/v^2

Temperature coefficient for ub.

165 uc1=-5.5e-11 m/v^2

Temperature coefficient for uc. Default is -0.056 for mobmod=3.

Component Statements Part 1

- 166 prt=0 Ω Temperature coefficient for Rds.
- 167 trs=0 1/cTemperature parameter for source resistance.
- 168 trd=0 1/cTemperature parameter for drain resistance.
- 169 ute=-1.5Mobility temperature exponent.
- 170 xti=3Saturation current temperature exponent.
- 171 pta=0 V/CJunction potential temperature coefficient.
- 172 tpb=0 V/CTemperature coefficient for pb.
- 173 ptp=0 V/CSidewall junction potential temperature coefficient.
- 174 tpbsw=0 V/CTemperature coefficient for pbsw.
- 175 tpbswg=0 V/CTemperature coefficient for pbswg.
- 176 cta=0 1/CJunction capacitance temperature coefficient.
- 177 tcj=0 1/cTemperature coefficient for cj.
- 178 ctp=0 1/cSidewall junction capacitance temperature coefficient.
- 179 tcjsw=0 1/cTemperature coefficient for cjsw.
- 180 tcjswg=0 1/cTemperature coefficient for cjswg.

Noise Model Parameters

- 181 noimod=1Noise model selector.
- 182 kf=0 Flicker (1/f) noise coefficient.
- 183 af=1Flicker (1/f) noise exponent.
- 184 ef=1Flicker (1/f) noise frequency exponent.
- 185 noia=1e20Oxide trap density coefficient. Default is 9.9e18 for pmos.
- 186 noib=5e4Oxide trap density coefficient. Default is 2.4e3 for pmos.

Component Statements Part 1

- 187 noic=-1.4e-12Oxide trap density coefficient. Default is 1.4e-8 for pmos.
- 188 noid=2e14flicker noise subthreshold-above threshold transition coefficient.
- 189 wnoi=le-5 mChannel width at which noise parameters were extracted.
- 190 em=4.1e7 V/mMaximum electric field.
- 191 flkmod=0Flicker noise model (0 for lds based model, 1 for gm based model).
- 192 gamma=2.0/3.0Thermal noise coefficient.

Auto Model Selector Parameters

- 193 wmax=1 mMaximum channel width for which the model is valid.
- 194 wmin=0 mMinimum channel width for which the model is valid.
- 195 lmax=1 mMaximum channel length for which the model is valid.
- 196 lmin=0 mMinimum channel length for which the model is valid.

Operating Region Warning Control Parameters

- 197 alarm=noneForbidden operating region.
 - Possible values are none, off, triode, sat, subth, or rev.
- 198 imax=1 AMaximum allowable current.
- 199 jmax=1e8 A/m²Maximum allowable current density.
- 200 by j=∞ VJunction reverse breakdown voltage.
- 201 vbox=1e9 tox vOxide breakdown voltage.
- 202 warn=onParameter to turn warnings on and off.

 Possible values are off or on.

Length Dependent Parameters

203 x1=0 mLength variation due to masking and etching.

Component Statements Part 1

Width dependent parameters

204 xw=0 mWidth variation due to masking and etching.

DC-Mismatch Dependent Parameters

205 mvtwl=0.0 v mThreshold mismatch area dependence.

206 mvtwl2=0.0 v m^1.5

Threshold mismatch area square dependence.

207 mvt0=0.0 VThreshold mismatch intercept.

208 mbew1=0.0 mBeta mismatch area dependence.

209 mbe 0 = 0 . 0 Beta mismatch intercept.

Imax and Imelt

The imax parameter aids convergence and prevents numerical overflow. The junction characteristics of the device are accurately modeled for current up to imax. If imax is exceeded during iterations, the linear model is substituted until the current drops below imax or until convergence is achieved. If convergence is achieved with the current exceeding imax, the results are inaccurate, and Spectre prints a warning.

A separate model parameter, imelt, is used as a limit warning for the junction current. This parameter can be set to the maximum current rating of the device. When any component of the junction current exceeds imelt, note that base and collector currents are composed of many exponential terms, Spectre issues a warning and the results become inaccurate. The junction current is linearized above the value of imelt to prevent arithmetic exception, with the exponential term replaced by a linear equation at imelt.

Both of these parameters have current density counterparts, jmax and jmelt, that you can specify if you want the absolute current values to depend on the device area.

Auto Model Selection

Many models need to be characterized for different geometries in order to obtain accurate results for model development. The model selector program automatically searches for a model with the length and width range specified in the instance statement and uses this model in the simulations.

Component Statements Part 1

For the auto model selector program to find a specific model, the models to be searched should be grouped together within braces. Such a group is called a model group. An opening brace is required at the end of the line defining each model group. Every model in the group is given a name followed by a colon and the list of parameters. Also, the four geometric parameters lmax, lmin, wmax, and wmin should be given. The selection criteria to choose a model is as follows:

the program would search all the models in the model group with the name ModelName and then pick the first model whose geometric range satisfies the selection criteria. In the preceding example, the auto model selector program would choose ModelName.2.

The user must specify both length (I) and width (w) on the device instance line to enable automatic model selection.

Output Parameters

- 1 weff (m) Effective channel width.
- 2 leff (m) Effective channel length.
- 3 rseff (Ω) Effective source resistance.
- 4 rdeff (Ω) Effective drain resistance.

Operating-Point Parameters

1 type=nTransistor type.

Possible values are n or p.

2 region=triodeEstimated operating region.

Possible values are off, triode, sat, subth, or breakdown.

Component Statements Part 1

3 reversedReverse mode indicator.

Possible values are no or yes.

- 4 ids (A) Resistive drain-to-source current.
- 5 vgs (V) Gate-source voltage.
- 6 vds (V) Drain-source voltage.
- 7 vbs (V) Bulk-source voltage.
- 8 vth (V)Threshold voltage.
- 9 vdsat (V) Drain-source saturation voltage.
- 10 gm (S) Common-source transconductance.
- 11 gds (S) Common-source output conductance.
- 12 gmbs (S) Body-transconductance.
- 13 betaeff (A/V^2) Effective beta.
- 14 cjd (F) Drain-bulk junction capacitance.
- 15 cjs (F) Source-bulk junction capacitance.
- 16 $cgg(F)dQg_dVg$.
- $17 \text{ cgd } (F)dQg_dVd.$
- 18 cgs $(F)dQg_dVs$.
- 19 cgb $(F)dQg_dVbk$.
- $20 \text{ cdg } (F)dQd_dVg.$
- 21 cdd (F) dQd_dVd .
- $22 \text{ cds } (F)dQd_dVs.$
- 23 $cdb (F)dQd_dVb$.

Component Statements Part 1

 $24 \text{ csg } (F)dQs_dVg.$

25 csd (F)dQs_dVd.

26 css (F)dQs_dVs.

 $27 \text{ csb } (F)dQs_dVb.$

 $28 \text{ cbg } (F)dQb_dVg.$

 $29 \text{ cbd } (F)dQb_dVd.$

 $30 \text{ cbs } (F)dQb_dVs.$

31 $cbb (F)dQb_dVb$.

32 ron (Ω) On-resistance.

33 id (A) Resistive drain current.

34 ibulk (A) Resistive bulk current.

35 pwr (W) Power at op point.

36 gmoverid (1/V)Gm/lds.

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a2 M-24	dvt1w M-18	minr M-92	tlev M-153
acde M-129	dvt2 M-16	mj M-110	tlevc M-154
ad I-4	dvt2w M-19	mjsw M-114	tnom M-151
ad M-143	dwb M-44	mjswg M-117	tox M-45
af M-183	dwc M-122	mobmod M-53	toxm M-46
ags M-25	dwa M-43	moin M-130	tpb M-172

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Component Statements Part 1

alarm M-197	ef M-184	mvt0 M-207	tpbsw M-174
alpha0 M-77	eg M-155	mvtwl M-205	tpbswg M-175
alpha1 M-78	elm M-127	mvtwl2 M-206	trd M-168
as I-3	em M-190	n M-96	trise M-152
as M-142	eta0 M-75	nch M-28	trise I-12
	etab M-76	nfactor M-71	
b0 M-21	fc M-112	ngate M-29	type M-1
b1 M-22	fcsw M-119	nlx M-9	type OP-1
beta0 M-79	flkmod M-191	noff M-131	u0 M-54
betaeff OP-13	fullreinit M-150	noia M-185	ua M-56
binunit M-52	gamma M-192	noib M-186	ual M-163
bvj M-200	gamma1 M-10	noic M-187	ub M-57
capmod M-120	gamma2 M-11	noid M-188	ub1 M-164
	-		
cbb OP-31	gap1 M-156	noimod M-181	uc M-58
cbd M-108	gap2 M-157	nqsmod I-11	uc1 M-165
cbd OP-29	gds OP-11	nqsmod M-121	ute M-169
cbg OP-28	gm OP-10	nrd I-7	vbm M-13
cbs OP-30	gmbs OP-12	nrd M-146	vbox M-201
cbs M-107	gmoverid OP-36	nrs M-147	vbs OP-7
cdb OP-23	hdif M-91	nrs I-8	vbx M-12
cdd OP-21			vds OP-6
cdg OP-20	id OP-33	paramchk M-149	vdsat OP-9
cds OP-22	ids OP-4	pb M-111	version M-148
cdsc M-68	imax M-198	pbsw M-115	vfb M-3
cdscb M-69	imelt M-98	pbswg M-118	vfbcv M-128
cdscd M-70	is M-95	pclm M-60	vgs OP-5
cf M-126	jmax M-199	pd M-145	voff M-73
cgb OP-19	jmelt M-99	pd I-6	voffcv M-132
	-	-	
cgbo M-102	js M-93	pdiblc1 M-61	
cgd OP-17	jsw M-94	pdiblc2 M-62	vth OP-8
cgdl M-105	k1 M-4	pdiblcb M-63	vtho M-2
cgdo M-101	k2 M-5	prt M-166	w = M-140
cgg OP-16	k3 M-6	prwb M-49	w I-1
cgs OP-18	k3b M-7	prwg M-50	w0 M-8
cgsl M-104	keta M-26	ps M-144	warn M-202
cgso M-100	kf M-182	ps I-5	weff O-1
		-	
cit M-72	kt1 M-159	pscbel M-64	wint M-32
cj M-109	kt1l M-160	pscbe2 M-65	wl M-38
cjd OP-14	kt2 M-161	pta M-171	wlc M-137
cjs OP-15	l M-141	ptp M-173	wln M-39
cjsw M-113	1 I-2	pvag M-66	wmax M-193
cjswg M-116	ldif M-90	pwr OP-35	wmin M-194
ckappa M-106	leff O-2	rd M-82	wnoi M-189
clc M-124	lgcd M-84	rdc M-86	wr M-51
cle M-125	lgcs M-83	rdd M-88	ww M-40
csb OP-27	lint M-31	rdeff 0-4	wwc M-138
csd OP-25	11 M-33	rdsw M-48	wwl M-42

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Component Statements Part 1

csg OP-24	llc M-134	region OP-2	wwlc M-139
css OP-26	lln M-34	region I-10	wwn M-41
cta M-176	lmax M-195	reversed OP-3	xj M-30
ctp M-178	lmin M-196	ron OP-32	xl M-203
delta M-67	lw M-35	rs M-81	xpart M-133
diomod M-158	lwc M-135	rsc M-85	xt M-47
dlc M-123	lwl M-37	rseff O-3	xti M-170
drout M-59	lwlc M-136	rsh M-80	xw M-204
dskip M-97	lwn M-36	rss M-87	
dsub M-74	m I-9	sc M-89	
dvt0 M-14	mbe0 M-209	tcj M-177	

BSIM4 MOS Transistor (bsim4)

Description

BSIM4 is the version-4.20 of bsim model. It uses single-piece equations for all regions to improve the smoothness of the model characteristics. BSIM4 also allows the binning option like the approach used in bsim3 This option is provided for people who want to achieve the highest accuracy of the model. The binning equation is given by

$$P = P0 + PI / Leff + Pw / Weff + Pp / (Leff * Weff)$$

Only the P0 parameters are listed. PI, Pw, and Pw are not shown but can be recognized. The names of PI, Pw, and Pp are identical to that of P0 but with a prefix of I, w, and p, respectively. BSIM4 transistors require that you use a model statement.

For more information on this model, please consult the University of California at Berkeley BSIM4 home page at

http://www-device.eecs.berkeley.edu/~bsim3/bsim4.html

This device is supported within altergroups.

Sample Instance Statement

```
m4 (0 2 1 1) pchmod w=2u 1=0.8u as=250p ad=250p pd=168p ps=168p m=1
```

Sample Model Statement

model pchmod bsim4 type=p mobmod=0 capmod=2 version=4.20 toxe=3e-9 cdsc=2.58e-4 cdscb=0 cdscd=6.1e-8 cit=0 nfactor=1.1 xj=9e-8 vfb=0.76vsat=9.2e4 at=3.3e4 a0=1.1 ags=1.0e-20 a1=0 ngate=9e19 vth0=-0.42a1=0 a2=1 delta=0.014 pvag=1e-20 pclm=6.28e-4 pdits=0.2 pdits1=2.3e6pditsd=0.23 fprout=0.2 pdiblcb=3.4e-8 pdiblc1=0.81

Component Statements Part 1

drout=0.56pdiblc2=9.84e-6 pscbe1=8.14e8 pscbe2=9.58e-07 lint=5e-9 wint=5e-9dmcg=5e-6 dmci=5e-6 dmdg=5e-6 dmcgt=6e-7 dwj=4.5e-8 rsh=6cgso=7.43e-10 cgdo=7.43e-10 cgbo=2.56e-11 cgsl=1e-14 cgdl=1e-14ckappas=0.5 ckappad=0.5 noff=0.9 voffcv=0.02 acde=1 moin=15 xpart=0kt1l=0 kt2=2.2e-2 lpe0=5.75e-8 lpeb=2.3e-10 dvt0=2.89 dvt1=0.53dvt2=-3.2e-2 dvt0w=0 dvt1w=0 dvt2w=0 dvtp0=7.32e-7 dvtp1=0.12dsub=0.058 eta0=0.001 u0=4.19e-2 ua=8.7e-16 ub=3.06e-18 k1=0.33uc=4.6e-13 ute=-1.5 ual=4.31e-9 ubl=7.61e-18 ucl=-5.6e-11 k2=-1.87e-2rdsw=369.4 rdw=184.7 rsw=184.7 prwg=3.22e-8 prwb=6.8e-11 wr=1rdswmin=0 rdwmin=0 rswmin=0 prt=0 b0=-1e-20 k3=80 k3b=0 w0=2.5e-6b1=0 keta=-0.047 alpha0=7.4e-2 alpha1=0.005 beta0=30

Name d g s b ModelName parameter=value ...

Instance Parameters

- 1 w (m) Channel width.
- 2 1 (m) Channel length.
- 3 as (m²) Area of source diffusion.
- 4 ad (m²) Area of drain diffusion.
- 5 ps (m) Perimeter of source diffusion.
- 6 pd (m) Perimeter of drain diffusion.
- 7 nrd (m/m) Number of squares of drain diffusion.
- 8 nrs (m/m) Number of squares of source diffusion.
- 9 m=1Multiplicity factor (number of MOSFETs in parallel).
- 10 region=triodeEstimated operating region.

 Possible values are off, triode, sat, subth, or breakdown.
- 11 trngsmodTransient NQS flag.
- 12 acngsmodAC NQS flag.
- 13 triseTemperature rise from ambient.
- 14 rgatemodRgate flag.

Component Statements Part 1

- 15 rbodymodRbody flag.
- 16 geomodGeometry flag.
- 17 rgeomod Diffusion resistance and contact model flag.
- 18 rbpb (Ω) Resistance connected between bNode and bNode.
- 19 rbpd (Ω) Resistance connected between bNode and dbNode.
- 20 rbps (Ω) Resistance connected between bNode and sbNode.
- 21 rbdb (Ω) Resistance connected between dbNode and bNode.
- 22 rbsb (Ω) Resistance connected between sbNode and bNode.
- 23 nfNumber of device fingers.
- 24 minMinimum number of device fingers.

Model Definition

model modelName bsim4 parameter=value ...

Model Parameters

Device Type Parameters

1 type=nTransistor type.

Possible values are n or p.

Threshold Voltage Parameters

- 2 vtho (V)Threshold voltage at zero body bias for long-channel devices. For enhancement-mode devices, vtho > 0 for n-channel and vth < 0 for p-channel. Default value is calculated from other model parameters.
- 3 vfb=-1 vFlat-band voltage.
- 4 phin=0 vNon-uniform vertical doping effect on surface potential.

Component Statements Part 1

- 5 k1=0.53 \sqrt{V} Body-effect coefficient.
- 6 k2=-0.0186Charge-sharing parameter.
- 7 k3=80Narrow width coefficient.
- 8 k3b=0 1/VNarrow width coefficient.
- 9 w0=2.5e-6 mNarrow width coefficient.
- 10 lpe0=1.74e-7 mLateral non-uniform doping at Vbs=0.
- 11 lpeb=0Lateral non-uniform doping effect on K1.
- 12 gamma1 (\sqrt{V}) Body-effect coefficient near the surface.
- 13 gamma2 (\sqrt{V}) Body-effect coefficient in the bulk.
- 14 vbx (V) Threshold voltage transition body voltage.
- 15 vbm=-3 vMaximum applied body voltage.
- 16 dvt0=2.2First coefficient of short-channel effects.
- 17 dvt1=0.53Second coefficient of short-channel effects.
- 18 dvt2=-0.032 1/VBody-bias coefficient of short-channel effects.
- 19 dvtp0=0 mFirst Coef. of drain-induced Vth shift for long-channel pocket devices.
- 20 dvtp1=0 1/vSecond Coef. of drain-induced Vth shift for long-channel pocket devices.
- 21 dvt0w=0First coefficient of narrow-width effects.
- 22 dvt1w=5.3e6 1/mSecond coefficient of narrow-width effects.
- 23 dvt2w=-0.032 1/VBody-bias coefficient of narrow-width effects.
- 24 a0=1Nonuniform depletion width effect coefficient.
- 25 b0=0 mBulk charge coefficient due to narrow width effect.
- 26 b1=0 mBulk charge coefficient due to narrow width effect.

Component Statements Part 1

- 27 a1=0No-saturation coefficient.
- 28 a2=1No-saturation coefficient.
- 29 ags=0 F/m² VGate-bias dependence of Abulk.
- 30 keta=-0.047 1/VBody-bias coefficient for non-uniform depletion width effect.

Process Parameters

- 31 epsrox=3.9Gate dielectric constant.
- 32 toxe=3.0e-9 mElectrical gate oxide thickness.
- 33 toxp=toxe mElectrical gate oxide thickness.
- 34 dtox=0.0 mDifference between electrical and physical gate oxide thickness.
- 35 ndep=1.7e17 cm⁻³Channel doping concentration.
- 36 nsd=1.0e20 cm⁻³Source-drain doping concentration.
- 37 nsub=6e16 cm⁻³Substrate doping concentration.
- 38 ngate=0 cm⁻³Poly-gate doping concentration.
- 39 xj=0.15e-6 mSource/drain junction depth.
- 40 lint=0 mLateral diffusion for one side.
- 41 wint=0 mWidth reduction for one side.
- 42 11=0Length dependence of delta L.
- 43 lln=1Length exponent of delta L.
- 44 lw=0Width dependence of delta L.
- 45 lwn=1Width exponent of delta L.
- 46 lwl=0Area dependence of delta L.
- 47 w1=0Length dependence of delta W.

Component Statements Part 1

- 48 wln=1Length exponent of delta W.
- 49 ww=0Width dependence of delta W.
- 50 wwn=1Width exponent of delta W.
- 51 wwl=0Area dependence of delta W.
- 52 dwg=0 m/vGate-bias dependence of channel width.
- 53 dwb=0 m/ \sqrt{v} Body-bias dependence of channel width.
- 54 toxm=toxe mToxe at which parameters were extracted.
- 55 xt=1.55e-7 mDoping depth.
- 56 binunit=1Bin parameter unit selector. 1 for microns and 2 for meters.

Bias-Dependent RDS Parameters

- 57 rdsmod=1bias-dependent D/S model selector.
- 58 rdsw=200Zero bias LDD resistance per unit width for RDSMOD=0...
- 59 rdswmin=0LDD resistance per unit width at high Vgs and zero Vbs for RDSMOD=0.
- 60 rdw=100Zero bias LDD resistance per unit width for RDSMOD=1...
- 61 rdwmin=0LDD resistance per unit width at high Vgs and zero Vbs for RDSMOD=1.
- 62 rsw=100Zero bias LDD resistance per unit width for RDSMOD=1...
- 63 rswmin=0LDD resistance per unit width at high Vgs and zero Vbs for RDSMOD=1.
- 64 prwb=0 $1/\sqrt{v}$ Body-effect coefficient for Rds.
- 65 prwq=1 1/VGate-effect coefficient for Rds.
- 66 wr=1Width offset for parasitic resistance.

Component Statements Part 1

Mobility Parameters

- 67 mobmod=0 Mobility model selector.
- 68 u0=670 cm²/V sLow-field surface mobility at tnom. Default is 250 for PMOS.
- 69 vsat=8e4 m/sCarrier saturation velocity at tnom.
- 70 ua=1.0e-9 m/vFirst-order mobility reduction coefficient. Default is 1.0e-15 if Mobmod = 2.
- **71** ub=1.0e-19 m^2/v^2

Second-order mobility reduction coefficient.

72 uc=-4.65e-11 m/ v^2

Body-bias dependence of mobility. Default is -0.0465 and unit is 1/V for mobmod=1.

73 eu=1.67Exponent for mobility degradation of mobmod=2. Default is 1.0 for Pmos.

Output Resistance Parameters

- 74 drout=0.56DIBL effect on output resistance coefficient.
- 75 fprout=0.0 V/\sqrt{m}

Effect of pocket implant on Rout degradation.

- 76 pclm=1.3Channel length modulation coefficient.
- 77 pdiblc1=0.39First coefficient of drain-induced barrier lowering.
- 78 pdiblc2=8.6e-3Second coefficient of drain-induced barrier lowering.
- 79 pdiblcb=0 1/VBody-effect coefficient for DIBL.
- 80 pscbe1=4.24e8 V/mFirst coefficient of substrate current body effect.
- 81 pscbe2=1e-5 m/vSecond coefficient of substrate current body effect.
- 82 pvag=0Gate dependence of Early voltage.
- 83 delta=0.01 vEffective drain voltage smoothing parameter.

Component Statements Part 1

- 84 pdits=0.0 1/VEffect of pocket implant on Rout degradation.
- 85 pdits1=0.0 1/mChannel-length of drain-induced Vth shift on Rout.
- 86 pditsd=0.0 1/VChannel-length of drain-induced Vth shift on Rout.

Subthreshold Parameters

- 87 cdsc=2.4e-4 F/m²Source/drain and channel coupling capacitance.
- 88 cdscb=0 F/m² VBody-bias dependence of cdsc.
- 89 cdscd=0 F/m² VDrain-bias dependence of cdsc.
- 90 nfactor=1Subthreshold swing coefficient.
- 91 cit=0 F/m²Interface trap parameter for subthreshold swing.
- 92 voff=-0.08 vThreshold voltage offset.
- 93 voffl=0.0 vChannel-length dependence of Voff..
- 94 minv=0Vgsteff fitting parameter for moderate inversion condition...
- 95 dsub=drout DIBL effect in subthreshold region.
- 96 eta0=0.08DIBL coefficient subthreshold region.
- 97 etab=-0.07 1/VBody-bias dependence of et0.

Substrate Current Parameters

- 98 alpha0=0 m/vSubstrate current impact ionization coefficient.
- 99 alpha1=0 1/VSubstrate current impact ionization coefficient.
- 100 beta0=30 1/VSubstrate current impact ionization exponent.

Parasitic Resistance Parameters

101 rgatemodRgate flag.

Component Statements Part 1

- 102 rsh=0 Ω/sqr Source/drain diffusion sheet resistance.
- 103 rshg=0.1 Ω /sqrGate electrode diffusion sheet resistance.
- 104 dmcg=0 mDistance from S/D contact center to the gate edge.
- 105 dmci=dmcg mDistance from S/D contact center to the isolation edge in the channel-length direction.
- 106 dmdg=0 mDistance from S/D contact center to the gate edge.
- 107 dmcgt=0 mDMCG of test structures.
- 108 dwj=DwcOffset of the S/D junction width.
- 109 xgw=0 mDistance from the gate contact to the channel edge.
- 110 xql=0 mOffset of the gate length due to variations in patterning.
- 111 ngcon=1 Number of gate contacts.
- 112 nf=1Number of device fingers.
- 113 minMinimum number of device fingers.
- 114 permod=1Perimeter model selector.
- 115 geomodGeometry flag.
- 116 rgeomod Diffusion resistance and contact model flag.
- 117 xw=0 mWidth variation due to masking and etching.
- 118 x1=0 mLength variation due to masking and etching.
- 119 minr=0.001 Ω Minimum source/drain resistance.

Gate-Induced Drain Leakage Parameters

- 120 agidl=0 $1/\Omega$ Pre-exponential coefficient for GIDL.
- 121 bgidl=2.3e9 vExponential coefficient for GIDL.

Component Statements Part 1

122 cgidl=0.5 V³Exponential coefficient for GIDL.

123 egidl=0.8 VFitting parameter for band bending for GIDL.

Gate Tunneling Parameters

124 igcmod=0Gate-to-channel tunneling model selector.

125 igbmod=1Gate-to-substrate tunneling model selector.

126 aigbacc=0.43 $\sqrt{F/g}$ s/m

Parameter for Igb in accumulation.

127 bigbacc=0.054 $\sqrt{F/g}$ /sm

Parameter for Igb in accumulation.

128 cigbacc=0.075 1/VParameter for lgb in accumulation.

129 nigbacc=1Parameter for lgb in accumulation.

130 aigbinv=0.35 $\sqrt{F/g}$ s/m

Parameter for Igb in inversion.

131 bigbinv=0.03 $\sqrt{F/g}$ /sm

Parameter for Igb in inversion.

132 cigbinv=0.006 1/VParameter for lgb in inversion.

133 eigbinv=1.1 vParameter for lgb in inversion.

134 nigbinv=3Parameter for lgb in inversion.

135 aigc=0.054 $\sqrt{F/g}$ s/m

Parameter for Igcs and Igcd. Default value for Pmos is 0.31.

136 bigc=0.054 $\sqrt{F/g}$ /sm

Parameter for Igcs and Igcd. Default value for Pmos is 0.024.

137 cigc=0.075 1/VParameter for Igcs and Igcd. Default value for Pmos is 0.03.

138 aigsd=0.43 $\sqrt{F/g}$ s/m

Parameter for Igs and Igd. Default value for Pmos is 0.31.

Component Statements Part 1

- 139 bigsd=0.054 $\sqrt{F/g}$ /sm
 - Parameter for Igs and Igd. Default value for Pmos is 0.024.
- 140 cigsd=0.075 1/VParameter for Igs and Igd. Default value for Pmos is 0.03.
- 141 dlciq=Lint mSource/drain overlap length for lgs and lgd.
- 142 nigc=1.0Source/drain overlap length for lgs and lgd.
- 143 poxedge=1.0 Factor for the gate oxide thickness in source/drain overlap regions.
- 144 pigcd=1.0Vds dependence of Igcs and Igcd.
- 145 ntox=1.0 Exponent for the gate oxide ratio.
- 146 toxref=3.0e-9 mNominal gate oxide thickness for gate dielectric tunneling current model only.

Junction Diode Model Parameters

- 147 diomod=1Diode model selector.
- 148 js=1.0e-4 A/m²Bottom junction reverse saturation current density..
- 149 jss=1.0e-4 A/m²Bottom junction reverse saturation current density..
- 150 jsd=Jss A/m²Bottom junction reverse saturation current density..
- 151 jsws=0 A/mlsolation-edge sidewall reverse saturation current density..
- 152 jswd=Jsws A/mlsolation-edge sidewall reverse saturation current density..
- 153 jswgs=0 A/mGate-edge sidewall reverse saturation current density..
- 154 jswgd=Jswgs A/mGate-edge sidewall reverse saturation current density.
- 155 is=1e-14 ABulk junction reverse saturation current.
- 156 n=1Junction emission coefficient.
- 157 njs=1Bulk-Source junction emission coefficient.
- 158 njd=NjsBulk-Source junction emission coefficient.

Component Statements Part 1

- 159 dskip=yesUse simple piece-wise linear model for diode currents below 0.1*iabstol. Possible values are no or yes.
- 160 imelt=`imaxA' Explosion current.
- 161 jmelt=\jmaxA/m'²

Explosion current density.

- 162 ijthsrev=0.1 ALimiting current in reverse bias region.
- 163 ijthdrev=Ijthsrev A

Limiting current in reverse bias region.

- 164 ijthsfwd=0.1 ALimiting current in forward bias region.
- 165 ijthdfwd=Ijthsfwd A

Limiting current in forward bias region.

- 166 xjbvs=1.0Limiting current in forward bias region.
- 167 xjbvd=xjbvsLimiting current in forward bias region.

Overlap Capacitance Parameters

- 168 cgso (F/m) Non LDD region source-gate overlap capacitance per unit channel width.
- 169 cgdo (F/m) Non LDD region drain-gate overlap capacitance per unit channel width.
- 170 cqbo=2 Dwc Coxe F/m

Non LDD region drain-gate overlap capacitance per unit channel width..

- 171 meto=0 mMetal overlap in fringing field.
- 172 cgs1=0 F/mOverlap capacitance between gate and lightly-doped source region.
- 173 cgdl=Cgdl F/mOverlap capacitance between gate and lightly-doped drain region.
- 174 ckappas=0.6 VCoefficient of bias-dependent overlap capacitance for the source side.
- 175 ckappad=Ckappas VCoefficient of bias-dependent overlap capacitance for the source side.

Component Statements Part 1

Junction Capacitance Model Parameters

- 176 cj=5e-4 F/m²Zero-bias junction bottom capacitance density.
- 177 cjs=5e-4 F/m²Zero bias bottom junction capacitance per unit area..
- 178 cjd=5e-4 F/m²Zero bias bottom junction capacitance per unit area..
- 179 mj=1/2Bulk junction bottom grading coefficient.
- 180 mjs=1/2Bulk junction bottom grading coefficient.
- 181 mjd=MjsBulk junction bottom grading coefficient.
- 182 pb=1 VBottom junction built-in potential.
- 183 pbs=1 vBottom junction built-in potential.
- 184 pbd=pbs VBottom junction built-in potential.
- 185 fc=0.5Forward-bias depletion capacitance threshold.
- 186 cjsw=5e-10 F/mZero-bias junction sidewall capacitance density.
- 187 cjsws=5e-10 F/mZero-bias junction sidewall capacitance density.
- 188 cjswd=Cjsws F/mZero-bias junction sidewall capacitance density.
- 189 mjsw=0.33lsolation-edge sidewall junction capacitance grading coefficient..
- 190 mjsws=0.33lsolation-edge sidewall junction capacitance grading coefficient..
- 191 mjswd=MjswsIsolation-edge sidewall junction capacitance grading coefficient...
- 192 pbsw=1 VIsolation-edge sidewall junction built-in potential.
- 193 pbsws=1 Vlsolation-edge sidewall junction built-in potential.
- 194 pbswd=pbsws VIsolation-edge sidewall junction built-in potential.
- 195 cjswg=cjswg F/mZero-bias gate-side junction capacitance density.
- 196 cjswgs=cjsws F/mZero-bias gate-side junction capacitance density.

Component Statements Part 1

- 197 cjswgd=cjswgs F/mZero-bias gate-side junction capacitance density.
- 198 mjswg=mjswGate-edge sidewall junction grading coefficient.
- 199 mjswgs=mjswsGate-edge sidewall junction grading coefficient.
- 200 mjswgd=mjswsGate-edge sidewall junction grading coefficient.
- 201 pbswg=pbsw VGate-edge sidewall junction built-in potential.
- 202 pbswgs=pbsws VGate-edge sidewall junction built-in potential.
- 203 pbswgd=pbsws vGate-edge sidewall junction built-in potential.
- 204 fcsw=0.5Side-wall forward-bias depletion capacitance threshold.
- 205 bvs=10.0 vBreakdown voltage.
- 206 bvd=Bvs VBreakdown voltage.

Charge Model Selection Parameters

- 207 capmod=2Intrinsic charge model.
- 208 trngsmod=0Transient Non-quasi static model selector. Set to 1 to turn on ngs.
- 209 acngsmod=0Ac Non-quasi static model selector. Set to 1 to turn on ngs.
- 210 dwc=wint mDelta W for capacitance model.
- 211 dlc=Lint mDelta L for capacitance model.
- 212 clc=1e-7 mConstant term for the short channel model..
- 213 cle=0.6Intrinsic capacitance fitting parameter.
- 214 cf (F/m) Coefficient of bias-dependent overlap capacitance for the source side.
- 215 vfbcv=-1Flat-band voltage for capmod=0.
- 216 acde=1 m/vExponential coefficient for charge thickness in CAPMOD=2 for accumulation and depletion regions.

Component Statements Part 1

- 217 moin=15 1/VExponential coefficient for charge thickness for accumulation and depletion regions.
- 218 noff=1Transition parameter.
- 219 voffcv=0 vCV parameter in VgsteffCV for weak to strong inversion...
- 220 xpart=0Charge partition number. Use 0.0 for 40/60, 0.5 for 50/50, or 1.0 for 0/100.
- 221 llc=llLength dependence of delta L for CV.
- 222 lwc=lwWidth dependence of delta L for CV.
- 223 lwlc=lwlArea dependence of delta L for CV.
- 224 wlc=wlLength dependence of delta W for CV.
- 225 wwc=wwWidth dependence of delta W for CV.
- 226 wwlc=wwlArea dependence of delta W for CV.

Default for Instance Parameters

- 227 w=5e-6 mDefault channel width.
- 228 1=5e-6 mDefault channel length.
- 229 as=0 m²Default area of source diffusion.
- 230 ad=0 m²Default area of drain diffusion.
- 231 ps=0 mDefault perimeter of source diffusion.
- 232 pd=0 mDefault perimeter of drain diffusion.
- 233 nrd=0 m/mDefault number of squares of drain diffusion.
- 234 nrs=0 m/mDefault number of squares of source diffusion.
- 235 version=4.20 Model version selector.
- 236 level=14Model level selector for spice compatibility.

Component Statements Part 1

237 paramchk=1Model parameter checking selector.

238 fullreinit=0Model parameter full reinit selector.

Temperature Effects Parameters

239 tnom (C) Parameters measurement temperature. Default set by options.

240 trise=0 CTemperature rise from ambient.

241 tlev=0DC temperature selector.

242 tlevc=0AC temperature selector.

243 eg=1.12452 VEnergy band gap.

244 gap1=7.02e-4 V/CBand gap temperature coefficient.

245 gap2=1108 CBand gap temperature offset.

246 kt1=-0.11 vTemperature coefficient for threshold voltage.

247 kt11=0 v mTemperature coefficient for threshold voltage.

248 kt2=0.022Temperature coefficient for threshold voltage.

249 at=3.3e4 m/sTemperature coefficient for vsat.

250 ua1=4.31e-9 m/vTemperature coefficient for ua.

251 ub1=-7.61e-18 m^2/v^2

Temperature coefficient for ub.

252 uc1=-5.5e-11 m/v^2

Temperature coefficient for uc. Default is -0.056 for mobmod=3.

253 prt=0 Ω mTemperature coefficient for Rds.

254 ute=-1.5Mobility temperature exponent.

255 xti=3Saturation current temperature exponent.

256 xtis=3Bulk-Source junction saturation current temperature exponent.

Component Statements Part 1

- 257 xtid=3Bulk-Source junction saturation current temperature exponent.
- 258 pta=0 V/CTemperature coefficient for pb.
- 259 tpb=0 V/CTemperature coefficient for pb.
- 260 ptp=0 V/CTemperature coefficient for pbsw.
- 261 tpbsw=0 V/CTemperature coefficient for pbsw.
- 262 tpbswg=0 V/CTemperature coefficient for pbswg.
- 263 cta=0 1/CTemperature coefficient for cj.
- 264 tcj=0 1/cTemperature coefficient for cj.
- 265 ctp=0 1/CTemperature coefficient for cjsw.
- 266 tcjsw=0 1/CTemperature coefficient for cjsw.
- 267 tcjswq=0 1/cTemperature coefficient for cjswq.

Noise Model Parameters

- 268 fnoimod=1Flicker noise model selector.
- 269 tnoimod=0Thermal noise model selector.
- 270 kf=0Flicker noise exponent.
- 271 af=1Flicker noise exponent.
- 272 ef=1Flicker noise frequency exponent.
- 273 noia=6.25e41Flicker noise parameter B. Default is 6.188e40 for pmos.
- 274 noib=3.125e26Flicker noise parameter C. Default is 1.5e25 for pmos.
- 275 noic=8.75e9Flicker noise parameter C.
- 276 wnoi=1e-5 mChannel width at which noise parameters were extracted.
- 277 em=4.1e7 V/mSaturation field.

Component Statements Part 1

- 278 flkmodFlicker Noise Model.
- 279 ntnoi=1Noise factor for short-channel devices for TNOIMOD=0 only.
- 280 tnoia=1.5Coefficient of channel-length dependence of total channel thermal noise.
- 281 tnoib=3.5Coefficient of channel-length dependence of total channel thermal noise.

Substrate Network Parameters

- 282 rbodymodRbody flag.
- 283 xrcrg1=12Parameter for distributed channel-resistance effect for both intrinsic-input resistance and charge-deficit NQS models.
- 284 xrcrg2=1Parameter to account for the excess channel diffusion resistance for both intrinsic-input resistance and charge-deficit NQS models.
- 285 rbpb (Ω) Resistance connected between bNode and bNode .
- 286 rbpd (Ω) Resistance connected between bNode and dbNode.
- 287 rbps (Ω) Resistance connected between bNode and sbNode.
- 288 rbdb (Ω) Resistance connected between dbNode and bNode.
- 289 rbsb (Ω) Resistance connected between sbNode and bNode.
- 290 gbmin=1.0e-12 $1/\Omega$

Conductance in parallel with each of the five substrate resistances to avoid potential numerical instability due to unreasonably too large a substrate resistance.

Auto Model Selector Parameters

- 291 wmax=1 mMaximum channel width for which the model is valid.
- 292 wmin=0 mMinimum channel width for which the model is valid.
- 293 lmax=1 mMaximum channel length for which the model is valid.
- 294 lmin=0 mMinimum channel length for which the model is valid.

Component Statements Part 1

Operating Region Warning Control Parameters

295 alarm=noneForbidden operating region.

Possible values are none, off, triode, sat, subth, or rev.

296 imax=1 AMaximum allowable current.

297 jmax=1e8 A/m²Maximum allowable current density.

298 bvj=∞ VJunction reverse breakdown voltage.

299 vbox=1e9 toxe VOxide breakdown voltage.

300 warn=onParameter to turn warnings on and off.

Possible values are off or on.

DC-Mismatch Dependent Parameters

301 mvtwl=0.0 v mThreshold mismatch area dependence.

302 mvtwl2=0.0 v m^1.5

Threshold mismatch area square dependence.

303 mvt0=0.0 VThreshold mismatch intercept.

304 mbewl=0.0 mBeta mismatch area dependence.

305 mbe0=0.0Beta mismatch intercept.

Imax and Imelt

The imax parameter aids convergence and prevents numerical overflow. The junction characteristics of the device are accurately modeled for current up to imax. If imax is exceeded during iterations, the linear model is substituted until the current drops below imax or until convergence is achieved. If convergence is achieved with the current exceeding imax, the results are inaccurate, and Spectre prints a warning.

A separate model parameter, imelt, is used as a limit warning for the junction current. This parameter can be set to the maximum current rating of the device. When any component of the junction current exceeds imelt, note that base and collector currents are composed of many exponential terms, Spectre issues a warning and the results become inaccurate. The junction current is linearized above the value of imelt to prevent arithmetic exception, with the exponential term replaced by a linear equation at imelt.

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Both of these parameters have current density counterparts, jmax and jmelt, that you can specify if you want the absolute current values to depend on the device area.

Auto Model Selection

Many models need to be characterized for different geometries in order to obtain accurate results for model development. The model selector program automatically searches for a model with the length and width range specified in the instance statement and uses this model in the simulations.

For the auto model selector program to find a specific model, the models to be searched should be grouped together within braces. Such a group is called a model group. An opening brace is required at the end of the line defining each model group. Every model in the group is given a name followed by a colon and the list of parameters. Also, the four geometric parameters lmax, lmin, wmax, and wmin should be given. The selection criteria to choose a model is as follows:

Then for a given instance

```
M1 1 2 3 4 ModelName w=3 1=1.5
```

the program would search all the models in the model group with the name ModelName and then pick the first model whose geometric range satisfies the selection criteria. In the preceding example, the auto model selector program would choose ModelName.2.

The user must specify both length (I) and width (w) on the device instance line to enable automatic model selection.

Output Parameters

- 1 weff (m) Effective channel width.
- 2 leff (m) Effective channel length.
- 3 rgbi (Ω) Gate bias-independent resistance.

Component Statements Part 1

Operating-Point Parameters

1 type=nTransistor type.

Possible values are n or p.

2 region=triodeEstimated operating region.

Possible values are off, triode, sat, subth, or breakdown.

3 reversedReverse mode indicator.

Possible values are no or yes.

- 4 ids (A) Resistive drain-to-source current.
- 5 vgs (V) Gate-source voltage.
- 6 vds (V) Drain-source voltage.
- 7 vbs (V) Bulk-source voltage.
- 8 vth (V)Threshold voltage.
- 9 vdsat (V) Drain-source saturation voltage.
- 10 gm (S) Common-source transconductance.
- 11 gds (S) Common-source output conductance.
- 12 gmbs (S) Body-transconductance.
- 13 betaeff (A/V^2) Effective beta.
- 14 cjd (F) Drain-bulk junction capacitance.
- 15 cjs (F) Source-bulk junction capacitance.
- 16 $cgg(F)dQg_dVg$.
- 17 cqd (F) dQq_dVd .
- 18 cgs $(F)dQg_dVs$.
- 19 cgb $(F)dQg_dVbk$.

Component Statements Part 1

- $20 \text{ cdg } (F)dQd_dVg.$
- 21 cdd (F) dQd_dVd .
- 22 $cds (F)dQd_dVs$.
- 23 $cdb (F)dQd_dVb$.
- 24 csg (F)dQs_dVg.
- $25 \text{ csd } (F)dQs_dVd.$
- $26 \text{ css } (F)dQs_dVs.$
- 27 csb $(F)dQs_dVb$.
- 28 cbg $(F)dQb_dVg$.
- 29 cbd (F) dQb_dVd .
- $30 \text{ cbs } (F)dQb_dVs.$
- 31 $cbb (F) dQb_dVb$.
- 32 ron (Ω) On-resistance.
- 33 id (A) Resistive drain current.
- 34 ibulk (A) Resistive bulk current.
- 35 pwr (W) Power at op point.
- 36 gmoverid (1/V)Gm/lds.
- 37 rdeff (Ω) Effective drain resistance.
- 38 rseff (Ω) Effective source resistance.
- 39 rgbd (Ω) Gate bias-dependent resistance.
- 40 igidl (A) Gate-to-body tunneling current.
- 41 igd (A) Gate-to-drain tunneling current.

Component Statements Part 1

- 42 igs (A) Gate-to-source tunneling current.
- 43 igb (A) Gate-to-bulk tunneling current.
- 44 igcs (A) Gate-to-channel (source side) tunneling current.
- 45 igcd (A) Gate-to-channel (drain side) tunneling current.
- 46 gbs (S) bulk-source diode conductance.
- 47 gbd (S) bulk-drain diode conductance.

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BTA SOI Transistor (btasoi)

Description

BTASOI is an SOI model developed by BTA Technology based on bsim3v3. It is a new, simple and compact SOI model that can accommodate both the fully-depleted, FD and partially-depleted, PD modes, adopting the transition voltage, Vtr, for the definition of body condition. It can also simulate the special characteristics of SOI devices such as kink effect and reduction of saturation current due to self-heating. Simulation results with this model are in excellent agreement with the experimental data for 0.25um SIMOX technology. BTASOI devices require that you use a model statement.

If you want to get more information about this model, please contact BTA Technology at http://www.btat.com

This device is supported within altergroups.

Component Statements Part 1

Sample Instance Statement

m5 (1 2 0 0) nchmod l=1.5u w=100u as=450p ad=450p pd=209u ps=209u m=1

Sample Model Statement

model nchmod btasoi type=n b3v3mod=no version=3.1 vtho=0.62 k1=0.672 k2=0.038 nlx=1.14e-7 dvt0=4.1 a0=1.08 nch=2.65e17 u0=4.01e-2 a1=0 a2=1 ags=9.8e-4 vsat=1.77e5

Instance Definition

Name d g s [bg] [b] ModelName parameter=value ...

Instance Parameters

- 1 w (m) Channel width.
- 2 1 (m) Channel length.
- 3 as (m^2) Area of source diffusion.
- 4 ad (m²) Area of drain diffusion.
- 5 ps (m) Perimeter of source diffusion.
- 6 pd (m) Perimeter of drain diffusion.
- 7 nrd (m/m) Number of squares of drain diffusion.
- 8 nrs (m/m) Number of squares of source diffusion.
- 9 m=1Multiplicity factor (number of MOSFETs in parallel).
- 10 region=triodeEstimated operating region.

Possible values are off, triode, sat, or subth.

- 11 triseTemperature rise from ambient.
- 12 rbody (Ω) Body resistance.

Model Definition

model modelName btasoi parameter=value ...

Component Statements Part 1

Model Parameters

Device Type Parameters

- 1 type=nTransistor type.
- Possible values are n or p.
- 2 b3v3mod=noB3v3 compatible flag.

 Possible values are no or yes.
- 3 version=3.1Model version selector.
- 4 btasoiver=1.0BTASOI Model version selector.

Threshold Voltage Parameters

- 5 vtho (V) Threshold voltage at zero body bias for long-channel devices. For enhancement-mode devices, vtho > 0 for n-channel and vth < 0 for p-channel. Default value is calculated from other model parameters.
- 6 k1=0.5 \sqrt{V} Body-effect coefficient.
- 7 k2=-0.0186Charge-sharing parameter.
- 8 k3=80Narrow width coefficient.
- 9 k3b=0 1/VNarrow width coefficient.
- 10 w0=2.5e-6 mNarrow width coefficient.
- 11 nlx=1.74e-7 mLateral nonuniform doping coefficient.
- 12 gamma1 (\sqrt{V}) Body-effect coefficient near the surface.
- 13 gamma2 (\sqrt{V}) Body-effect coefficient in the bulk.
- 14 vbx (V) Threshold voltage transition body voltage.
- 15 vbm=-3 vMaximum applied body voltage.
- 16 dvt0=2.2First coefficient of short-channel effects.

Component Statements Part 1

- 17 dvt1=0.53Second coefficient of short-channel effects.
- 18 dvt2=-0.032 1/VBody-bias coefficient of short-channel effects.
- 19 dvt0w=0First coefficient of narrow-width effects.
- 20 dvt1w=5.3e6Second coefficient of narrow-width effects.
- 21 dvt2w=-0.032 1/VBody-bias coefficient of narrow-width effects.
- 22 a0=1Nonuniform depletion width effect coefficient.
- 23 b0=0 mBulk charge coefficient due to narrow width effect.
- 24 b1=0 mBulk charge coefficient due to narrow width effect.
- 25 a1=0No-saturation coefficient.
- 26 a2=1No-saturation coefficient.
- 27 ags=0 F/m² VGate-bias dependence of Abulk.
- 28 keta=-0.047 1/VBody-bias coefficient for non-uniform depletion width effect.

Process Parameters

- 29 nsub=6e16 cm⁻³Substrate doping concentration.
- 30 nch=1.7e17 cm⁻³Peak channel doping concentration.
- 31 ngate (cm⁻³) Poly-gate doping concentration.
- 32 xj=0.15e-6 mSource/drain junction depth.
- 33 lint=0 mLateral diffusion for one side.
- 34 wint=0 mWidth reduction for one side.
- 35 11=0 mLength dependence of delta L.
- 36 lln=1Length exponent of delta L.
- 37 lw=0 mWidth dependence of delta L.

Component Statements Part 1

- 38 lwn=1Width exponent of delta L.
- 39 lwl=0 m²Area dependence of delta L.
- 40 w1=0 mLength dependence of delta W.
- 41 wln=1Length exponent of delta W.
- 42 ww=0 mWidth dependence of delta W.
- 43 wwn=1Width exponent of delta W.
- 44 ww1=0 m²Area dependence of delta W.
- 45 dwg=0 m/vGate-bias dependence of channel width.
- 46 dwb=0 m/ \sqrt{v} Body-bias dependence of channel width.
- 47 tox=1.5e-8 mGate oxide thickness.
- 48 tbox=4e-7 mBuried oxide thickness.
- 49 tsi=8e-8 mSilicon film thickness.
- 50 xt=1.55e-7 mDoping depth.
- 51 rdsw=0 Ω µmWidth dependence of drain-source resistance.
- 52 prwb=0 $1/\sqrt{v}$ Body-effect coefficient for Rds.
- 53 prwg=0 1/VGate-effect coefficient for Rds.
- 54 wr=1Width offset for parasitic resistance.
- 55 x1=0 mLength variation due to masking and etching.
- 56 xw=0 mWidth variation due to masking and etching.
- 57 binunit=1Bin parameter unit selector. 1 for microns and 2 for meters.

Mobility Parameters

58 mobmod=1Mobility model selector.

Component Statements Part 1

- 59 $u0=670 \text{ cm}^2/\text{V}$ sLow-field surface mobility at tnom. Default is 250 for PMOS.
- 60 vsat=8e4 m/sCarrier saturation velocity at tnom.
- 61 ua=2.25e-9 m/vFirst-order mobility reduction coefficient.
- 62 ub=5.87e-19 m^2/v^2

Second-order mobility reduction coefficient.

63 uc=-4.65e-11 m/v^2

Body-bias dependence of mobility. Default is -0.046 and unit is 1/V for mobmod=3.

Output Resistance Parameters

- 64 drout=0.56DIBL effect on output resistance coefficient.
- 65 pclm=1.3Channel length modulation coefficient.
- 66 pdiblc1=0.39First coefficient of drain-induced barrier lowering.
- 67 pdiblc2=8.6e-3Second coefficient of drain-induced barrier lowering.
- 68 pdiblcb=0 1/VBody-effect coefficient for DIBL.
- 69 pscbe1=4.24e8 V/mFirst coefficient of substrate current body effect.
- 70 pscbe2=1e-5 m/vSecond coefficient of substrate current body effect.
- 71 pvag=0Gate dependence of Early voltage.
- 72 delta=0.01 vEffective drain voltage smoothing parameter.

Subthreshold Parameters

- 73 cdsc=2.4e-4 F/m²Source/drain and channel coupling capacitance.
- 74 cdscb=0 F/m² VBody-bias dependence of cdsc.
- 75 cdscd=0 F/m² VDrain-bias dependence of cdsc.
- 76 nfactor=1Subthreshold swing coefficient.

Component Statements Part 1

- 77 cit=0 FInterface trap parameter for subthreshold swing.
- 78 voff=-0.08 vThreshold voltage offset.
- 79 dsub=drout DIBL effect in subthreshold region.
- 80 eta0=0.08DIBL coefficient subthreshold region.
- 81 etab=-0.07 1/VBody-bias dependence of et0.

Substrate Current Parameters

- 82 alpha0=0 m/vSubstrate current impact ionization coefficient.
- 83 beta0=30 1/VSubstrate current impact ionization exponent.

Parasitic Resistance Parameters

- 84 rsh=0 Ω /sqrSource/drain diffusion sheet resistance.
- 85 rs=0 Ω Source resistance.
- 86 rd=0 Ω Drain resistance.
- 87 rsc=0 Ω Source contact resistance.
- 88 rdc=0 Ω Drain contact resistance.
- 89 rss=0 Ω mScalable source resistance.
- 90 rdd=0 Ω mScalable drain resistance.
- 91 hdif=0 mLength of heavily doped diffusion.
- 92 ldif=0 mLateral diffusion beyond the gate.
- 93 minr=0.1 ΩMinimum source/drain resistance.

Junction Diode Model Parameters

94 js (A/m^2) Bulk junction reverse saturation current density.

Component Statements Part 1

- 95 jsw=0 A/mSidewall junction reverse saturation current density.
- 96 is=1e-14 ABulk junction reverse saturation current.
- 97 n=1Junction emission coefficient.
- 98 dskip=yesUse simple piecewise linear model for diode currents below 0.1*iabstol. Possible values are no or yes.
- 99 imelt=`imaxA' Explosion current.
- 100 imelt1=imax A/mExplosion current density for is1.
- 101 imelt2=imax A/mExplosion current density for is2.
- 102 imelt3=imax A/mExplosion current density for is3.

Overlap Capacitance Parameters

- 103 cgso (F/m) Gate-source overlap capacitance.
- 104 cgdo (F/m) Gate-drain overlap capacitance.
- 105 cgbo = 2 Dwc Cox F/m

Gate-bulk overlap capacitance. The default value is 0 if version=3.0.

- 106 meto=0 mMetal overlap in fringing field.
- 107 cgs1=0 F/mGate-source overlap capacitance in LDD region.
- 108 cgdl=0 F/mGate-drain overlap capacitance in LDD region.
- 109 ckappa=0.6Overlap capacitance fitting parameter.

Junction Capacitance Model Parameters

- 110 cbs=0 FBulk-source zero-bias junction capacitance.
- 111 cbd=0 FBulk-drain zero-bias junction capacitance.
- 112 cj=5e-4 F/m^2 Zero-bias junction bottom capacitance density.

Component Statements Part 1

- 113 mj=1/2Bulk junction bottom grading coefficient.
- 114 pb=1 VBulk junction built-in potential.
- 115 fc=0.5Forward-bias depletion capacitance threshold.
- 116 cjsw=5e-10 F/mZero-bias junction sidewall capacitance density.
- 117 mjsw=0.33Bulk junction sidewall grading coefficient.
- 118 pbsw=1 VSide-wall junction built-in potential.
- 119 cjswg=cjsw F/mZero-bias gate-side junction capacitance density.
- 120 mjswg=mjswGate-side junction grading coefficient.
- 121 pbswg=pbsw VGate-side junction built-in potential.
- 122 fcsw=fcSide-wall forward-bias depletion capacitance threshold.
- 123 tau=0 sTransit time.

Charge Model Selection Parameters

- 124 capmod=2Intrinsic charge model.
- 125 dwc=wint mDelta W for capacitance model.
- 126 dlc=lint mDelta L for capacitance model.
- 127 clc=1e-7 mIntrinsic capacitance fitting parameter.
- 128 cle=0.6Intrinsic capacitance fitting parameter.
- 129 cf (F/m) Fringe capacitance parameter.
- 130 vfbcv=-1Flat-band voltage for capmod=0.
- $131 \times part = 0$ Drain/source channel charge partition in saturation for BSIM charge model, use 0.0 for 40/60, 0.5 for 50/50, or 1.0 for 0/100.

Component Statements Part 1

Default Instance Parameters

- 132 w=5e-6 mDefault channel width.
- 133 1=5e-6 mDefault channel length.
- 134 as=0 m²Default area of source diffusion.
- 135 ad=0 m²Default area of drain diffusion.
- 136 ps=0 mDefault perimeter of source diffusion.
- 137 pd=0 mDefault perimeter of drain diffusion.
- 138 nrd=0 m/mDefault number of squares of drain diffusion.
- 139 nrs=0 m/mDefault number of squares of source diffusion.

Temperature Effects Parameters

- 140 tnom (C) Parameters measurement temperature. Default set by options.
- 141 tmax=500 CMaximum device temperature above ambient.
- 142 trise=0 CTemperature rise from ambient.
- 143 selft=0Self heating option.
- 144 tlev=0DC temperature selector.
- 145 tlevc=0AC temperature selector.
- **146** eg=1.12452 VEnergy band gap.
- 147 gap1=7.02e-4 V/CBand gap temperature coefficient.
- 148 gap2=1108 CBand gap temperature offset.
- 149 kt1=-0.11 VTemperature coefficient for threshold voltage.
- 150 kt11=0 v mTemperature coefficient for threshold voltage.
- 151 kt2=0.022Temperature coefficient for threshold voltage.

Component Statements Part 1

152 at=3.3e4 m/sTemperature coefficient for vsat.

153 ua1=4.31e-9 m/vTemperature coefficient for ua.

154 ub1=-7.61e-18 m^2/v^2

Temperature coefficient for ub.

155 uc1=-5.5e-11 m/v^2

Temperature coefficient for uc. Default is -0.056 for mobmod=3.

156 prt=0 Ω Temperature coefficient for Rds.

157 trs=0 1/CTemperature parameter for source resistance.

158 trd=0 1/cTemperature parameter for drain resistance.

159 ute=-1.5Mobility temperature exponent.

160 dt1=0First temperature coefficient for tau.

161 dt2=0Second temperature coefficient for tau.

162 xti=3Saturation current temperature exponent.

163 xti1=3Saturation current temperature exponent.

164 xti2=xti1Saturation current temperature exponent.

165 xti3=xti1Saturation current temperature exponent.

166 ptc=0 V/CSurface potential temperature coefficient.

167 pta=0 V/CJunction potential temperature coefficient.

168 ptp=0 V/CSidewall junction potential temperature coefficient.

169 cta=0 1/CJunction capacitance temperature coefficient.

170 ctp=0 1/cSidewall junction capacitance temperature coefficient.

Noise Model Parameters

171 noimod=1Noise model selector.

Component Statements Part 1

- 172 kf=0Flicker (1/f) noise coefficient.
- 173 af=1Flicker (1/f) noise exponent.
- 174 ef=1Flicker (1/f) noise frequency exponent.
- 175 noia=1e20Oxide trap density coefficient. Default is 9.9e18 for pmos.
- 176 noib=5e4Oxide trap density coefficient. Default is 2.4e3 for pmos.
- 177 noic=-1.4e-120xide trap density coefficient. Default is 1.4e-8 for pmos.
- 178 em=4.1e7 V/mMaximum electric field.

Auto Model Selector Parameters

- 179 wmax=1 mMaximum channel width for which the model is valid.
- 180 wmin=0 mMinimum channel width for which the model is valid.
- 181 lmax=1 mMaximum channel length for which the model is valid.
- 182 lmin=0 mMinimum channel length for which the model is valid.

Operating Region Warning Control Parameters

- 183 alarm=noneForbidden operating region.
 - Possible values are none, off, triode, sat, subth, or rev.
- 184 imax=1 AMaximum allowable current.
- 185 by j=∞ VJunction reverse breakdown voltage.
- 186 vbox=1e9 tox vOxide breakdown voltage.
- 187 warn=onParameter to turn warnings on and off.

 Possible values are off or on.

SOI Specific Parameters

188 vbtho=10 vBack-gate threshold voltage.

Component Statements Part 1

- 189 vtr0=0.3 VLong-channel transition body voltage at Vds=0.
- 190 knk=0.01Vtr smoothing factor.
- 191 dice=0 Drain-induced charge-sharing parameter.
- 192 dvtrd=0 VVtr dependence on Vds.
- 193 dvtrg=1 VVtr dependence on Vgs.
- 194 dvtrbg=1.0Smoothing factor for back-gate bias.
- 195 a 0 bg = 0 Back-gate saturation region coefficient.
- 196 dbg=1Diode fully depletion adjustment factor.
- 197 dvtr=1.0Diode back-gate dependence factor.
- 198 vbgf=0.0Flat-band voltage for back-gate.
- 199 rth0=0 Ω Self-heating thermal resistance.
- 200 cth0=1 FSelf-heating thermal capacitance.
- 201 11=0 Vgs dependence of characteristic length.
- 202 aii=0 First parameter for critical field.
- 203 bii=0 Second parameter for critical field.
- 204 cii=0Gate dependence of critical field.
- 205 dii=0Body dependence of critical field.
- 206 ndiode=1Diode non-ideality factor.
- 207 nt=1Reverse tunneling non-ideality factor.
- 208 is1=1e-16 AFirst diode parameter.
- 209 is 2=0 ASecond diode parameter.
- 210 is3=0 ATunneling diode parameter.

Component Statements Part 1

```
211 ed1=2e-6 mElectron diffusion length.
```

212 kb=0 mParasitic bipolor base width.

213 delacc=0.02 vCapacitance smoothing parameter in accumulation region.

214 delr=0.01 VVbs smoothing parameter for C-V.

215 dqsq=8e-3 VVtr smoothing parameter for C-V.

216 a0cv=0.1A0 for C-V calculation.

217 qgvd0=1Cgd fitting parameter.

LThe jmelt parameter is used to aid convergence and prevent numerical overflow. The junction characteristics of the FET are accurately modeled for current (density) up to jmelt. For current density above jmelt, the junction is modeled as a linear resistor and a warning is printed.

Auto Model Selection

Many models need to be characterized for different geometries in order to obtain accurate results for model development. The model selector program automatically searches for a model with the length and width range specified in the instance statement and uses this model in the simulations.

For the auto model selector program to find a specific model, the models to be searched should be grouped together within braces. Such a group is called a model group. An opening brace is required at the end of the line defining each model group. Every model in the group is given a name followed by a colon and the list of parameters. Also, the four geometric parameters lmax, lmin, wmax, and wmin should be given. The selection criteria to choose a model is as follows:

```
lmin <= inst_length < lmax and wmin <= inst_width < wmax</pre>
```

Example

Then for a given instance

```
M1 1 2 3 4 ModelName w=3 1=1.5
```

Component Statements Part 1

the program would search all the models in the model group with the name ModelName and then pick the first model whose geometric range satisfies the selection criteria. In the preceding example, the auto model selector program would choose ModelName.2.

The user must specify both length (I) and width (w) on the device instance line to enable automatic model selection.

Output Parameters

- 1 weff (m) Effective channel width.
- 2 leff (m) Effective channel length.
- 3 rtheff (Ω) Effective thermal resistance.
- 4 Ctheff (F) Effective thermal capacitance.
- 5 rseff (Ω) Effective source resistance.
- 6 rdeff (Ω) Effective drain resistance.

Operating-Point Parameters

- 1 type=nTransistor type.
- Possible values are n or p.
- 2 region=triodeEstimated operating region.
 - Possible values are off, triode, sat, or subth.
- 3 reversedReverse mode indicator.
 - Possible values are no or yes.
- 4 vgs (V) Gate-source voltage.
- 5 vds (V) Drain-source voltage.
- 6 vbs (V)Bulk-source voltage.
- 7 ids (A) Resistive drain-to-source current.
- 8 isub (A) Resistive substrate current.

Component Statements Part 1

- 9 ibd (A) Resistive bulk-to-drain junction current.
- 10 ibs (A) Resistive bulk-to-source junction current.
- 11 vth (V) Threshold voltage.
- 12 vdsat (V) Drain-source saturation voltage.
- 13 gm (S) Common-source transconductance.
- 14 gds (S) Common-source output conductance.
- 15 gmbs (S) Body-transconductance.
- 16 ueff $(cm^2/V s)$ Effective mobility.
- 17 betaeff (A/V^2) Effective beta.
- 18 cjd (F) Drain-bulk junction capacitance.
- 19 cjs (F) Source-bulk junction capacitance.
- 20 cgg (F)dQg_dVg.
- $21 \text{ cgd } (\text{F}) dQg_dVd.$
- $22 \text{ cgs (F)} dQg_dVs.$
- $23 \text{ cgb } (\text{F})dQg_dVbk$.
- $24 \text{ cdg } (F)dQd_dVg.$
- $25 \text{ cdd } (F)dQd_dVd.$
- $26 \text{ cds } (F)dQd_dVs.$
- $27 \text{ cdb } (\texttt{F}) \, dQd_dVb.$
- 28 csg (F) dQs_dVg .
- $29 \text{ csd } (F)dQs_dVd.$
- $30 \text{ css } (F)dQs_dVs.$

Component Statements Part 1

31 csb $(F)dQs_dVb$.

 $32 \text{ cbg } (F)dQb_dVg.$

33 cbd (F) dQb_dVd .

 $34 \text{ cbs } (F)dQb_dVs.$

 $35 \text{ cbb } (F)dQb_dVb.$

36 ron (Ω) On-resistance.

37 id (A) Total resistive drain current.

38 is (A) Total resistive source current.

39 ib (A) Total resistive bulk current.

40 pwr (W) Power at op point.

41 gmoverid (1/V) Gm/lds.

42 tdev (C) Temperature rise from ambient.

Parameter Index

Ctheff 0-4	dice M-191	11 M-201	rss M-89
a0 M-22	dii M-205	ldif M-92	rth0 M-199
a0bg M-195	dlc M-126	leff O-2	rtheff O-3
a0cv M-216	dqsq M-215	lint M-33	selft M-143
a1 M-25	drout M-64	11 M-35	tau M-123
a2 M-26	dskip M-98	lln M-36	tbox M-48
ad I-4	dsub M-79	lmax M-181	tdev OP-42
ad M-135	dt1 M-160	lmin M-182	tlev M-144
af M-173	dt2 M-161	lw M-37	tlevc M-145
ags M-27	dvt0 M-16	lwl M-39	tmax M-141

Component Statements Part 1

	7		
aii M-202	dvt0w M-19	lwn M-38	tnom M-140
alarm M-183	dvt1 M-17	m I-9	tox M-47
alpha0 M-82	dvt1w M-20	meto M-106	trd M-158
as I-3	dvt2 M-18	minr M-93	trise M-142
as M-134	dvt2w M-21	mj M-113	trise I-11
at M-152	dvtr M-197	mjsw M-117	trs M-157
b0 M-23	dvtrbg M-194	mjswg M-120	tsi M-49
b1 M-24			
b3v3mod M-2	dvtrg M-193	n M-97	type M-1
beta0 M-83	dwb M-46	nch M-30	u0 M-59
betaeff OP-17	dwc M-125	ndiode M-206	ua M-61
bii M-203	dwg M-45	nfactor M-76	ua1 M-153
binunit M-57	edl M-211	ngate M-31	ub M-62
btasoiver M-4	ef M-174	nlx M-11	ub1 M-154
bvj M-185	eg M-146	noia M-175	uc M-63
capmod M-124	em M-178	noib M-176	uc1 M-155
-	eta0 M-80	noic M-177	ueff OP-16
cbd M-111	etab M-81	noimod M-171	ute M-159
cbd OP-33	fc M-115	nrd I-7	vbgf M-198
cbg OP-32	fcsw M-122	nrd M-138	vbm M-15
cbs M-110	gamma1 M-12	nrs M-139	vbox M-186
cbs OP-34	gamma2 M-13	nrs I-8	vbs OP-6
cdb OP-27	gap1 M-147	nsub M-29	vbtho M-188
cdd OP-25	gap2 M-148	nt M-207	vbx M-14
cdg OP-24	gds OP-14	pb M-114	vds OP-5
cds OP-26	gm OP-13	pbsw M-118	vds of 3
	_		
cdsc M-73	gmbs OP-15	pbswg M-121	
cdscb M-74	gmoverid OP-41	pclm M-65	vfbcv M-130
cdscd M-75	hdif M-91	pd M-137	vgs OP-4
cf M-129	ib OP-39	pd I-6	voff M-78
cgb OP-23	ibd OP-9	pdiblc1 M-66	vsat M-60
cgbo M-105	ibs OP-10	pdiblc2 M-67	vth OP-11
cgd OP-21	id OP-37	pdiblcb M-68	vtho M-5
cgdl M-108	ids OP-7	prt M-156	vtr0 M-189
cgdo M-104	imax M-184	prwb M-52	w M-132
	imelt M-99		_
cgs OP-22	imelt1 M-100	ps M-136	w0 M-10
cgsl M-107	imelt2 M-101	ps I-5	warn M-187
cgso M-103	imelt3 M-102	pscbel M-69	weff O-1
cii M-204	is M-96	pscbe2 M-70	wint M-34
cit M-77	is OP-38	pta M-167	wl M-40
сj M-112	is1 M-208	ptc M-166	wln M-41
cjd OP-18	is2 M-209	ptp M-168	wmax M-179
cjs OP-19	is3 M-210	pvag M-71	wmin M-180
cjsw M-116	isub OP-8	pwr OP-40	wr M-54
		_	
cjswg M-119	js M-94	qgvd0 M-217	ww M-42
ckappa M-109	jsw M-95	rbody I-12	wwl M-44

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Component Statements Part 1

clc M-127	k1 M-6	rd M-86	wwn M-43
cle M-128	k2 M-7	rdc M-88	xj M-32
csb OP-31	k3 M-8	rdd M-90	xl M-55
csd OP-29	k3b M-9	rdeff 0-6	xpart M-131
csg OP-28	kb M-212	rdsw M-51	xt M-50
css OP-30	keta M-28	region OP-2	xti M-162
cta M-169	kf M-172	region I-10	xti1 M-163
cth0 M-200	knk M-190	reversed OP-3	xti2 M-164
ctp M-170	kt1 M-149	ron OP-36	xti3 M-165
dbg M-196	kt1l M-150	rs M-85	xw M-56
delacc M-213	kt2 M-151	rsc M-87	
delr M-214	1 M-133	rseff O-5	
delta M-72	l I-2	rsh M-84	

Two Terminal Capacitor (capacitor)

Description

You can assign the capacitance or let Spectre compute it from the physical length and width of the capacitor. In either case, the capacitance can be a function of temperature or applied voltage.

This device is supported within altergroups.

If the C(inst) is not given,

$$C(inst) = C(model)$$

if C(model) is given, and

$$C(inst) = Ci^*(L - 2^*etch)^*(W - 2^*etch) + 2^*Cisw^*(W + L - 4^*etch)$$

if C(model) is not given.

If the polynomial coefficients vector (coeffs=[c1 c2 ...]) is specified, the capacitor is nonlinear and the capacitance is

$$C(V) = dQ(V) / dV$$

= $C(inst)*(1 + c1*V + c2*V^2 + ...)$

or

$$Q(V) = C(inst)^*V^*(1 + 1/2*c1*V + 1/3*c2*V^2 + ...)$$

Component Statements Part 1

where ck is the kth entry in the coefficient vector.

The value of the capacitor as a function of the temperature is given by:

$$C(T) = C(tnom)^*[1 + tc1^*(T - tnom) + tc2^*(T - tnom)^2].$$

where

if trise(inst) is given, and

$$T = trise(model) + temp$$

if trise(inst) is not given.

Sample Instance Statement

Without model:

With model:

Sample Model Statement

model proc_cap capacitor c=2u tc1=1.2e-8 tnom=25 w=4u l=4u cjsw=2.4e-10

Instance Definition

```
Name 1 2 ModelName parameter=value ...
Name 1 2 capacitor parameter=value ...
```

Instance Parameters

- 1 c (F) Capacitance.
- 2 w (m) Capacitor width.
- 3 1 (m) Capacitor length.
- 4 m=1Multiplicity factor.

Component Statements Part 1

- 5 scale=1Scale factor.
- 6 trise (C) Temperature rise from ambient.
- 7 tcl (1/C)Linear temperature coefficient.
- 8 tc2 (C⁻²) Quadratic temperature coefficient.
- 9 ic (V) Initial condition.

The instance parameter scale, if specified, overrides the value given by the option parameter scale. The w and 1 parameters are scaled by the resulting scale, and the option parameter scalem. The values of w and 1 printed by Spectre are those given in the input file, and these values might not have the correct units if the scaling factors are not unity. The actual capacitor dimensions are stored in the output parameters. You can obtain these dimensions with the info statement.

Model Definition

model modelName capacitor parameter=value ...

Model Parameters

- 1 c=0 FDefault capacitance.
- 2 tc1=0 1/CLinear temperature coefficient.
- 3 tc2=0 C^{-2} Quadratic temperature coefficient.
- 4 trise=0 cDefault trise value for instance.
- 5 tnom (C) Parameters measurement temperature. Default set by options.
- 6 w=0 mDefault capacitor width.
- 7 1=0 mDefault capacitor length.
- 8 etch=0 mNarrowing due to side etching.
- 9 cj=0 F/m²Bottom capacitance density.
- 10 cjsw=0 F/mSidewall capacitance.

Component Statements Part 1

- 11 scalec=1Capacitance scaling factor.
- 12 coeffs=[...] Vector of polynomial capacitance coefficients.
- 13 rforce=1 Ω Resistance used when forcing initial conditions.

Output Parameters

- 1 leff (m) Effective capacitor length.
- 2 weff (m) Effective capacitor width.
- 3 ceff (F) Effective capacitance.

Operating-Point Parameters

1 cap (F) Capacitance at operating point.

Parameter Index

c I-1	etch M-8	scale I-5	trise M-4
c M-1	ic I-9	scalec M-11	trise I-6
cap OP-1	l I-3	tc1 M-2	w I-2
ceff O-3	1 M-7	tc1 I-7	w M-6
cj M-9	leff O-1	tc2 I-8	weff O-2
cjsw M-10	m I-4	tc2 M-3	
coeffs M-12	rforce M-13	tnom M-5	

Component Statements Part 1

Linear Current Controlled Current Source (cccs)

Description

A current-controlled source senses the current with a probe device. A valid probe is a component instance in the circuit that naturally computes current. For example, probes can be voltage sources (independent or controlled), inductors, transmission lines, microstrip lines, N-ports, and transformers. If the probe device computes more than one current (such as transmission lines, microstrip lines, and N-ports), the index of the probe port through which the controlling current flows needs to be specified. Positive current exits the source node and enters the sink node of the controlled source.

This device is supported within altergroups.

Sample Instance Statement

vcs (pos gnd) cccs gain=2.5 probe=vl m=1 //Note that vl is an instance of a voltage source

Instance Definition

Name sink src cccs parameter=value ...

Instance Parameters

- 1 gain=0 A/ACurrent gain.
- 2 m=1Multiplicity factor.
- 3 probe Device through which the controlling current flows.
- 4 port=0Index of the probe port through which the controlling current flows.

Operating-Point Parameters

- 1 i (A) Input current.
- 2 v (V) Output voltage.
- 3 pwr (W) Power dissipation.

Component Statements Part 1

Linear Current Controlled Voltage Source (ccvs)

Description

A current-controlled source senses the current with a probe device. A valid probe is a component instance in the circuit that naturally computes current. For example, probes can be voltage sources (independent or controlled), inductors, transmission lines, microstrip lines, N-ports, and transformers. If the probe device computes more than one current (such as transmission lines, microstrip lines, and N-ports), the index of the probe port through which the controlling current flows needs to be specified. Current through the controlled voltage source is calculated and is defined to be positive if it flows from the positive terminal, through the source, to the negative terminal.

This device is supported within altergroups.

Sample Instance Statement

vvs (pos gnd) ccvs rm=1 probe=vl m=1 $\,$ //Note that vl is an instance of a voltage source

Instance Definition

Name p n ccvs parameter=value ...

Instance Parameters

- 1 rm=0 Ω Transresistance.
- 2 probe Device through which the controlling current flows.
- 3 port=0Index of the probe port through which the controlling current flows.
- 4 m=1Multiplicity factor.

Operating-Point Parameters

- 1 i (A) Output current.
- 2 v (V) Output voltage.
- 3 pwr (W) Power dissipation.

Component Statements Part 1

Circuit Reduced Order Model (cktrom)

Description

The circuit reduced order model is described by a set of partial differential equations in the form of:

$$x = Ax + Bu$$
 (1)

$$y = Cx + Du$$
 (2)

where Eqn.(1) is the state equation, Eqn.(2) is the output equation, A is nxn matrix, B is nxm, C is mxn, and D is an mxm matrix. x is a vector of state variables. Input u is a vector of voltages at all the ports and output y is a vector of electric current at all the ports. The number of inputs is always equal to the number of outputs. The order of the terminals in the input must be consistent with the matrix equations. In the input file, the matrices A, B, C and D are in the form of long vectors with row order.

This device is not supported within altergroup.

Sample Instance Statement

Instance Definition

```
Name sink0 src0 [sink1] [src1] [sink2] [src2] [sink3] [src3] ... cktrom parameter=value ...
```

Instance Parameters

1 m=1Multiplicity factor.

Component Statements Part 1

2 a=[...]Coefficient matrix A of state equations.

3 b=[...] Coefficient Matrix B of state equations.

4 c=[...]Coefficient matrix C of output equations.

5 d=[...]Coefficient matrix D of output equations.

Operating-Point Parameters

1 i=[...] APort currents.

2 v=[...] vPort voltages.

3 pwr (W) Power dissipation.

Parameter Index

a I-2 c I-4 i OP-1 pwr OP-3 b I-3 d I-5 m I-1 v OP-2

Magnetic Core with Hysteresis (core)

Description

This component models the magnetic hysteresis, with air gap, frequency, and temperature effects. The model is based on the AWB model for magnetic cores and windings. The user has to specify the cores material and geometric parameters to model the hysteresis.

The material parameters to specify are the Br, Bm and Hc of the core. The geometric parameters are the area, magnetic path length and the air gap of the core.

You can specify the magnetic path length in one of the following ways:

Component Statements Part 1

- Give the length directly in cm.
- Or give the outer and inner diameter of the core.

Cores without terminals represent complete magnetic loops. Cores with terminals are fragments that you can use as building blocks to build models of complicated core structures. For example, you can use the following set of core fragments to model an \mathbb{E} core:

```
e1p
        elm winding turns=80 core=C1
W3a e2p
        e2c
             winding turns=80 core=C3
W3b e2c
        e2m winding turns=80 core=C3
             permalloy area=1 len=2
C1 m1
        0
C2 m1
        0
             permalloy area=2 len=2
C3
   m1
             permalloy area=1 len=2
model permalloy core ...
```

There are three parallel core fragments representing each of the three fingers on the E. One 80 turn winding is connected to core fragment C1. A center-tapped 160 turn winding (implemented as a pair of windings) are wrapped around core fragment C3. Node m1 is a magnetic node whose value is in magnetomotive force and flow is flux.

You can calculate the frequency and temperature dependency of the core model by specifying the frequency loss parameters and the temperature effects parameters. You can make all the core parameters vary in temperature, including the permeability, saturation flux, and core loss. For frequency losses, a static model refers to a value that you type in for frequency. This model does not adjust the shape of the B-H loop in response to power dissipation or rate of rise of the applied currents and voltages during transient analysis.

This device is not supported within altergroup.

The hysteresis is modeled by different regions whose equations are:

```
phi = phir + (phis - phir) F/( F + Ha) for region number 1
phi = phis * ( F - Fc)/(F - Hb) for region number 2
where
    phi = flux density
    F = magnetomotive force
    phir = residual flux density
    phis = Saturated flux density
    Fc = Coercive magnetic force
```

Component Statements Part 1

Ha and Hb = shape parameters.

Sample Instance Statement

```
c1 (1 0) core_mod area=1.2 len=8.1 id=0.55 gap=0.25
```

Sample Model Statement

model core_mod core len=7.7 area=0.85 br=1e3 bm=5e3 hc_t1=0.2 p1_f1=2.08 f1=10e3 p2_f2=50 f2=100K bflux=1e3 density=4.75

Instance Definition

```
Name ... ModelName parameter=value ...
```

Instance Parameters

- 1 area (cm²) Effective magnetic cross-sectional area of core.
- 2 len (cm) Effective length of magnetic path.
- 3 id (cm) Inner diameter of toroidal core.
- 4 od (cm) Outer diameter of toroidal core.
- 5 gap (cm) Gap length.
- 6 m=1Multiplicity factor.

Model Definition

```
model modelName core parameter=value ...
```

Model Parameters

- 1 br=1 gaussResidual flux density.
- 2 bm=1 gaussSaturation flux density.
- 3 hc=1 oerstedsCoercive magnetizing force (value of H where B equals 0).
- 4 area=1 cm²Effective magnetic cross-sectional area of core.

Component Statements Part 1

- 5 len=1 cmEffective length of magnetic path.
- 6 id (cm) Inner diameter of toroidal core.
- 7 od (cm) Outer diameter of toroidal core.
- 8 gap=0.0 cmGap length.

Initial Conditions

9 b0 (gauss) Initial condition for core.

Frequency Loss Parameters

- 10 freq (Hz) Core operating frequency.
- 11 pl_f1 (W/Kg) Core power loss at frequency f1.
- 12 f1 (Hz) Reference frequency for power loss.
- 13 p2_f2 (W/Kg) Core power loss at frequency f2.
- 14 f2 (Hz) Reference frequency for power loss.
- 15 bflux (gauss) Reference flux density.
- 16 density (g/cm³) Core density.

Temperature Effects Parameters

- 17 temp (C) Core operating temperature.
- 18 bm_t1 (gauss) Saturated flux density Bm at T1.
- 19 br_t1 (gauss) Residual flux density Br at T1.
- 20 hc_t1 (oersteds) Coercive force Hc at T1.
- 21 t1 (C) Reference temperature.

Component Statements Part 1

Operating-Point Parameters

- 1 b (gauss) Flux density of the core.
- 2 h (oersteds) Magnetic field strength.

Parameter Index

area I-1	br_t1 M-19	hc M-3	od I-4
area M-4	density M-16	hc_t1 M-20	p1_f1 M-11
b OP-1	f1 M-12	id I-3	p2_f2 M-13
b0 M-9	f2 M-14	id M-6	t1 M-21
bflux M-15	freq M-10	len M-5	temp M-17
bm M-2	gap I-5	len I-2	
bm_t1 M-18	gap M-8	m I-6	
br M-1	h OP-2	od $M-7$	

Logic-to-Analog Converter (d2a)

Description

The logic-to-analog converter converts a binary signal from a logic simulator to an analog waveform.

This device is not supported within altergroup.

Sample Instance Statement

d2a_1 (net1 net2) d2a src="99991" val0=0 val1=2.5 valx=1.25 rise=200p fal1=200p m=2 //99991 is an analog net

Instance Definition

```
Name p n d2a parameter=value ...
```

Component Statements Part 1

Instance Parameters

- 1 srcThe foreign simulators name for the source of the analog signal.
- 2 nestlev=0Number of nesting levels to ignore in the hierarchical name. This should be used skip over extra levels that do not exist in the co-simulator.
- 3 val0=0 VFinal value for logical 0.
- 4 val1=5 vFinal value for logical 1.
- 5 valx (V) Final value for logical X.
- 6 valz (V) Final value for logical Z.
- 7 rise=1ns sTime for transition from val0 to val1.
- 8 fall=1ns sTime for transition from val1 to val0.
- 9 ron=100 Ω Output resistance when in active state.
- 10 m=1Multiplicity factor.

Parameter Index

fall I-	8	rise	I-7	val0	I-3	valz	I-6
m I-10		ron	I-9	val1	I-4		
nestlev	I-2	src	I-1	valx	I-5		

Component Statements Part 1

Delay Line (delay)

Description

The delay line model is a four terminal device with zero output impedance and infinite input impedance. The output between nodes p and n is the input voltage between nodes p and n delayed by the time delay td and scaled by gain.

This device is not supported within altergroup.

Sample Instance Statement

```
dl1(outp outn cntrlp cntrln) delay td=10n gain=1.5
```

Instance Definition

```
Name p n ps ns delay parameter=value ...
```

Instance Parameters

- 1 td=0.0 sTime delay.
- 2 gain=1Gain parameter.
- 3 m=1Multiplicity factor.

Operating-Point Parameters

1 v (V)Output voltage.

Diode Level 500 (dio500)

Description

The dio500 model provides a detailed description of the diode currents in forward and reverse biased Si-diodes. It is described in the Philips Bipolar Modelbook (Dec.93) as Diode level 500. Information on how to obtain this document can be found on Source Link by searching for Philips.

Component Statements Part 1

(c) Philips Electronics N.V. 1994

In extension to the modelbook description a minimum conductance gmin is inserted between the diode nodes to aid convergence. The value of gmin is set by an options statement, default is $gmin = 1.0e-12 \ S$.

The imax parameter is used to aid convergence and to prevent numerical overflow. The junction characteristics of the diode are accurately modeled for currents up to imax. For currents above imax, the junction is modeled as a linear resistor, and a warning is printed.

This device is supported within altergroups.

This device is dynamically loaded from the shared object /vobs/spectre_dev/tools.sun4v/spectre/lib/cmi/2.0.doc/libphilips.so

Sample Instance Statement

d1 (pnode 0) phdiode area=2

Sample Model Statement

model phdiode dio500 is=3.5e-12 rs=26.3 n=2.7 imax=1e20 vlc=1.8 vbr=9.63 cj=2.65e-11 dta=12.88 tau=7.5e-10 tnom=25

Instance Definition

Name a k ModelName parameter=value ...

Instance Parameters

- 1 area=1.0Multiplication factor.
- 2 multAlias of area factor.
- 3 m=1.0Multiplicity factor.
- 4 region=fwdEstimated DC operating region, used as a convergence aid. Possible values are fwd, rev or brk.

Component Statements Part 1

Model Definition

model modelName dio500 parameter=value ...

Model Parameters

- 1 is=7.13e-13 ASaturation current.
- 2 n=1.044Junction emission coefficient.
- 3 vlc=0.0 vVoltage dependence at low forward currents.
- 4 vbr=7.459 vBreakdown voltage.
- 5 emvbr=1.36e+06 V/cm

Electric field at breakdown.

6 csrh = 7.44 e - 07 A/cm

Shockley-Read-Hall generation.

- 7 cbbt=3.255 A/VBand to band tunneling.
- 8 ctat=3.31e-06 A/cm

Trap assisted tunneling.

- 9 rs=0.0 Ω Series resistance.
- 10 tau=500.0e-12 sTransit time.
- 11 cj=7.0e-12 FZero-bias depletion capacitance.
- 12 vd=0.9 vDiffusion voltage.
- 13 p=0.4Grading coefficient.
- 14 tref (C) Reference temperature. Default set by option tnom.
- 15 tnom (C) Alias of tref.
- 16 tr (C) Alias of tref.
- 17 vg=1.206 vBandgap voltage.

Component Statements Part 1

- 18 ptrs=0.0Power for temperature dependence of rs.
- 19 kf=0.0Flickernoise coefficient.
- 20 af=1.0Flickernoise exponent.
- 21 dta=0.0 KDifference between device temperature and ambient temperature.
- 22 trise (K) Alias of dta.
- 23 imax=1.0 AExplosion current.

Operating-Point Parameters

- 1 vak (V) Diode voltage, measured from anode to cathode (including rs).
- 2 id (A) Total resistive diode current.
- 3 qd (Coul) Diffusion charge.
- 4 qt (Coul) Depletion charge.
- 5 rst (Ω) Series resistance (temperature updated).
- 6 rl (Ω) AC linearized resistance.
- 7 cl (F) AC linearized capacitance.
- 8 pwr (W) Power dissipation.

Parameter Index

af	M - 20	id OP-2	pwr	OP-8	tr	M - 16
area	I-1	imax M-23	qd	OP-3	tref	M - 14
cbbt	M-7	is M-1	qt	OP-4	trise	e M-22

Component Statements Part 1

cj M-11	kf M-19	region I-4	vak	OP-1
cl OP-7	m I-3	rl OP-6	vbr	M-4
csrh M-6	mult I-2	rs M-9	vd	M-12
ctat M-8	n M-2	rst OP-5	vg	M-17
dta M-21	p M-13	tau M-10	vlc	M-3
emvbr M-5	ptrs M-18	tnom M-15		

Junction Diode (diode)

Description

The junction diode model includes nonlinear junction capacitance and reverse breakdown.

This device is supported within altergroups.

To examine the equations used for this component, consult the <u>Spectre Circuit Simulator</u> <u>Device Model Equations</u> manual.

Sample Instance Statement

```
d0 (dp dn) pdiode l=3e-4 w=2.5e-4 area=1
```

Sample Model Statement

model pdiode diode is=1.8e-5 rs=1.43 n=1.22 nz=2.31 gleak=6.2e-5 rsw=10 isw=6.1e-10 ibv=0.95e-3 tgs=2 ik=1.2e7 fc=0.5 cj=1.43e-3 pb=0.967 mj=0.337 cjsw=2.76e-9 vjsw=0.94 jmax=1e20

Instance Definition

```
Name a c ModelName parameter=value ...
```

In forward operation, the voltage on the anode (a) is more positive than the voltage on the cathode (c).

Instance Parameters

- 1 areaJunction area factor.
- 2 perimJunction perimeter factor.
- 3 l=1e-6 mDrawn length of junction.

Component Statements Part 1

- 4 w=1e-6 mDrawn width of junction.
- 5 m=1Multiplicity factor.
- 6 scale=1Scale factor.
- 7 region=onEstimated operating region.

Possible values are off, on or breakdown.

8 trise (C) Temperature rise from ambient.

The instance parameter scale, if specified, overrides the value given by the option parameter scale. If the model parameter allow_scaling is set to yes then, the area, perim, 1 and w parameters are scaled by scale. By default allow_scaling is set to no and no scaling of geometry parameters will occur. The values of area, perim, 1 and w printed out by spectre are those given in the input, and these values might not have the correct units if the scaling factors are not unity.

Model Definition

model modelName diode parameter=value ...

Model Parameters

Model selector parameters

1 level=1Model selector. 1 = junction and 2 = Fowler-Nordheim.

Process parameters

- 2 etch=0 mNarrowing due to etching per side.
- 3 etchl=etch mLength reduction due to etching per side.

Junction diode parameters

- 4 js=1e-14 ASaturation current (*area).
- 5 jsw=0 ASidewall saturation current (*perim).
- 6 n=1Emission coefficient.

Component Statements Part 1

- 7 ns=1Sidewall emission coefficient.
- 8 ik=∞ AHigh-level injection knee current (*area).
- 9 ikp=ik AHigh-level injection knee current for sidewall (*area).
- 10 area=1Junction area factor.
- 11 perim=0Junction perimeter factor.
- 12 allow_scaling=noAllow scale option and instance scale parameter to affect diode instance geometry parameters.

 Possible values are no or yes.

Capacitive parameters

- 13 tt=0 sTransit time.
- 14 cd=0 FLinear capacitance (*area).
- 15 cjo=0 FZero-bias junction capacitance (*area).
- 16 vj=1 vJunction potential.
- 17 m=0.5Grading coefficient.
- 18 cjsw=0 FZero-bias sidewall junction capacitance (*perim).
- 19 vjsw=1 vSidewall junction potential.
- 20 mjsw=0.33Sidewall grading coefficient.
- 21 fc=0.5Forward-bias depletion capacitance threshold.

Breakdown parameters

- 22 bv=∞ ∨Reverse breakdown voltage. Note: bv=0 is not the same as bv=infinity.
- 23 ibv=0.001 ACurrent at breakdown voltage (*area).
- 24 nz=1Emission coefficient for Zener diode.

Component Statements Part 1

25 bv j=∞ VVoltage at which junction breakdown warning is issued.

Parasitic resistance parameters

- 26 rs=0 Ω Series resistance (/area).
- 27 rsw=0 Ω Sidewall series resistance (/perim).
- 28 gleak=0 sBottom junction leakage conductance (*area).
- 29 gleaksw=0 sSidewall junction leakage conductance (*perim).
- 30 minr=0.1 Ω Minimum series resistance.

Temperature effects parameters

- 31 tlev=0DC temperature selector.
- 32 tlevc=0AC temperature selector.
- 33 eg=1.124481 vBand gap. Note: when not specified, the default value is temperature dependent. It is 1.124481 at temp=27C.
- 34 gap1=7.02e-4 V/CBand gap temperature coefficient.
- 35 gap2=1108 CBand gap temperature offset.
- 36 xti=3Saturation current temperature exponent.
- 37 tbv1=0 1/CLinear temperature coefficient for bv.
- 38 tbv2=0 C^{-2} Quadratic temperature coefficient for bv.
- 39 tnom (C) Parameters measurement temperature. Default set by options.
- 40 trise=0 cTemperature rise from ambient.
- 41 trs=0 1/CLinear temperature coefficient for parasitic resistance.
- 42 trs2=0 C⁻²Quadratic temperature coefficient for parasitic resistance.
- 43 tgs=0 1/cLinear temperature coefficient for leakage conductance.

Component Statements Part 1

- 44 tgs2=0 C⁻²Quadratic temperature coefficient for leakage conductance.
- 45 cta=0 1/CJunction capacitance temperature coefficient.
- 46 ctp=0 1/cSidewall junction capacitance temperature coefficient.
- 47 pta=0 V/CJunction potential temperature coefficient.
- 48 ptp=0 V/CSidewall junction potential temperature coefficient.

Junction diode model control parameters

- 49 jmelt=jmax AExplosion current (*area).
- 50 jmax=1 AMaximum allowable current (*area).
- 51 dskip=yesUse simple piece-wise linear model for diode currents below 0.1*iabstol. Possible values are no or yes.

Fowler-Nordheim diode parameters

- 52 if=1e-10 A/V^nfForward Fowler-Nordheim current coefficient (*area).
- 53 ir=if A/V^nrReverse Fowler-Nordheim current coefficient (*area).
- 54 ecrf=2.55e10 V/mForward critical field.
- 55 ecrr=ecrf V/mReverse critical field.
- 56 nf=2Forward voltage power.
- 57 nr=nfReverse voltage power.
- 58 tox=1e-8 mThickness of insulating layer.

Noise model parameters

- 59 kf=0Flicker noise (1/f) coefficient.
- 60 af=1Flicker noise (1/f) exponent.

Component Statements Part 1

Both of these parameters have current density counterparts, jmax and jmelt, that you can specify if you want the absolute current values to depend on the device area.

Operating-Point Parameters

- 1 region=onEstimated operating region.

 Possible values are off, on or breakdown.
- 2 v (V) Extrinsic diode voltage.
- 3 i (A) Resistive diode current.
- 4 pwr (W) Power dissipation.
- 5 res (Ω) Resistance of intrinsic diode.
- 6 cap (F) Junction capacitance.
- 7 resp (Ω) Resistance of intrinsic sidewall diode.
- 8 capp (F) Sidewall junction capacitance.

Parameter Index

af M-60	fc M-21	m I-5	scale I-6
allow_scaling M-12	gap1 M-34	minr M-30	tbv1 M-37
area I-1	gap2 M-35	mjsw M-20	tbv2 M-38
area M-10	gleak M-28	n M-6	tgs M-43
bv M-22	gleaksw M-29	nf M-56	tgs2 M-44
bvj M-25	i OP-3	nr M-57	tlev M-31
cap OP-6	ibv M-23	ns M-7	tlevc M-32
capp OP-8	if M-52	nz M-24	tnom M-39
cd M-14	ik M-8	perim M-11	tox M-58
cjo M-15	ikp M-9	perim I-2	trise I-8
cjsw M-18	ir M-53	pta M-47	trise M-40
cta M-45	jmax M-50	ptp M-48	trs M-41

Component Statements Part 1

ctp M-46	jmelt M-49	pwr OP-4	trs2 M-42
dskip M-51	js M-4	region OP-1	tt M-13
ecrf M-54	jsw M−5	region I-7	v OP-2
ecrr M-55	kf M-59	res OP-5	vj M-16
eg M-33	1 1-3	resp OP-7	vjsw M-19
etch M-2	level M-1	rs M-26	w I-4
etchl M-3	m M-17	rsw M-27	xti M-36

EKV MOSFET Transistor (ekv)

Description

The EPFL-EKV mosfet model was developed by Electronics Laboratories, Swiss Federal Institute of Technology (EPFL), Switzerland. The detailed description of the model and equations can be found in the <u>Spectre Circuit Simulator Device Model Equations</u> manual. EKV transistors require that you use a model statement.

This device is supported within altergroups.

Sample Instance Statement

mn1 (dn gn sn 0) ekvnmos w=1.5u l=1u ad=2.6p as=2.6p pd=6.6p ps=6.6p nrd=1.54 nrs=1.54

Sample Model Statement

model ekvnmos ekv type=n update=2.6 xqc=0.4 cox=3.4e-3 xj=0.145e-6 vto=0.6 gamma=0.71 phi=0.967 kp=155e-6 e0=88e6 iba=200e6 ibb=350e6 tnom=25 tcv=1.55e-3 bex=-1.45 kf=1e-27 af=1 hdif=0.94e-6 rsh=512 jsw=1.5e-10

Instance Definition

Name d g s b ModelName parameter=value \dots

Instance Parameters

- 1 w (m) Channel width.
- 2 1 (m) Channel length.
- 3 as (m^2) Area of source diffusion.
- 4 ad (m^2) Area of drain diffusion.

Component Statements Part 1

- 5 ps (m) Perimeter of source diffusion.
- 6 pd (m) Perimeter of drain diffusion.
- 7 nrd (m/m) Number of squares of drain diffusion.
- 8 nrs (m/m) Number of squares of source diffusion.
- 9 rdc (Ω) Drain contact resistance.
- 10 rsc (Ω) Source contact resistance.
- 11 m=1Multiplicity factor (number of MOSFETs in parallel).
- 12 ns=1Series Multiplicity factor (number of MOSFETs in series).
- 13 region=triodeEstimated operating region.

 Possible values are off, triode, sat, or subth.
- 14 triseTemperature rise from ambient.

Model Definition

model modelName ekv parameter=value ...

Model Parameters

Device type parameters

1 type=nTransistor type.

Possible values are n or p.

Process parameters

- 2 tox=2e-8 mGate oxide thickness.
- 3 cox=7e-4 F/m²Gate oxide capacitance. (Overrides Tox).
- 4 xj=1.0e-7 mMetallurgical junction depth.
- 5 dw=0 mChannel Width Correction.

Component Statements Part 1

- 6 dl=0 mChannel Length Correction.
- 7 nfs=0 cm⁻²Fast surface state density.
- $8 \text{ nsub=} 1.13 \text{e} 16 \text{ cm}^{-3}$

Channel doping concentration.

Drain current model parameters

- 9 vto=0.5 vThreshold voltage at zero body bias.
- 10 gamma=1.0 √v Body-effect parameter.
- 11 phi=0.7 vSurface potential at strong inversion.
- 12 kp=5.0e-5 A/V^2 Transconductance parameter.
- 13 e0=1.0e12 V/mVertical Critical Field.
- 14 ucrit=2.0e6 V/cmLongitudinal Critical field for mobility degradation.
- 15 theta=0.0 1/VMobility reduction coefficient.
- 16 uo (cm²/V s) Carrier surface mobility.
- 17 vmax (m/s) Carrier saturation velocity.
- 18 vfb (V) Flat-band voltage.
- 19 lambda=0.5Channel length modulation parameter.
- 20 weta=0.25Narrow Channel Effect Coefficient.
- 21 leta=0.1Short Channel Effect Coefficient.
- 22 xw=0 mWidth variation due to masking and etching.
- 23 x1=0 mLength variation due to masking and etching.
- 24 meto=0 mMetal overlap in fringing field.

Component Statements Part 1

Impact ionization parameters

- 25 iba=0 1/mFirst Impact Ionization Coefficient.
- 26 ibb=3.0e8 V/mSecond Impact Ionization Coefficient.
- 27 ibc=0Third Impact Ionization Coefficient.
- 28 ibn=1.0Saturation velocity factor for impact ionization.

Reverse Short Channel parameters

- 29 q0=0 A s/m²Reverse short channel peak charge density.
- 30 1k=2.9e-7 mReverse short channel characteristic length.

Charge model selection parameters

31 xqc=0.0Drain/source channel charge partition in saturation for charge models, e.g. use 0.4 for 40/60, 0.5 for 50/50, 0 for 0/100.

Junction diode model parameters

- 32 is=1e-14 ABulk junction reverse saturation current.
- 33 js (A/m^2) Bulk junction reverse saturation current density.
- 34 jsw=0 A/mBulk junction reverse saturation sidewall current density.
- 35 n=1Junction emission coefficient.
- 36 dskip=yesUse simple piece-wise linear model for diode currents below 0.1*iabstol. Possible values are no or yes.
- 37 imelt=`imaxA' Explosion current, diode is linearized beyond this current to aid convergence.

Junction capacitance model parameters

38 cbd=0 FBulk-drain zero-bias p-n capacitance.

Component Statements Part 1

- 39 cbs=0 FBulk-source zero-bias p-n capacitance.
- 40 cj=0 F/m²Zero-bias junction bottom capacitance density.
- 41 cjsw=0 F/mZero-bias junction sidewall capacitance density.
- 42 mj=0.5Bulk junction bottom grading coefficient.
- 43 mjsw=0.33Bulk junction sidewall grading coefficient.
- 44 cjswg=0 F/mGate-side zero-bias junction sidewall capacitance density.
- 45 mjswg=0.33Gate-side bulk junction sidewall grading coefficient.
- 46 pbswg=0.8 vGate-side junction built-in potential.
- 47 fc=0.5Forward-bias capacitance coefficient.
- 48 pb=0.8 VBulk p-n bottom contact potential.
- 49 pbsw=0.8 vSide-wall contact potential.
- 50 tt=0.0 VBulk p-n transit time.
- 51 fcsw=0.5Side-wall forward-bias depletion capacitance threshold.

Overlap capacitance parameters

- 52 cgso=0 F/mGate-source overlap capacitance.
- 53 cgdo=0 F/mGate-drain overlap capacitance.
- 54 cgbo=0 F/mGate-bulk overlap capacitance.

Parasitic resistance parameters

- 55 rs=0 Ω Source resistance.
- 56 rd=0 Ω Drain resistance.
- 57 rsh=0 Ω /sqrSource/drain diffusion sheet resistance.

Component Statements Part 1

- 58 rss=0 Ω mScalable source resistance.
- 59 rdd=0 Ω mScalable drain resistance.
- 60 rsc=0 Ω Source contact resistance.
- 61 rdc=0 Ω Drain contact resistance.
- 62 minr=0.1 Ω Minimum source/drain resistance.
- 63 ldif=0 mLateral diffusion beyond the gate.
- 64 hdif=0 mLength of heavily doped diffusion.

Short distance matching parameters

- 65 avto=0 V mArea related threshold voltage mismatch parameter.
- 66 akp=0 mArea related gain mismatch parameter.
- 67 agamma=0 √V m

Area related body effect mismatch parameter.

Operating region warning control parameters

- 68 alarm=noneForbidden operating region.
 - Possible values are none, off, triode, sat, subth, or rev.
- 69 imax=1 AMaximum current, currents above this limit generate a warning.
- 70 jmax=1e8 A/m²Maximum current density, currents above this limit generate a warning.
- 71 vbox=1e9 tox VOxide breakdown voltage.
- 72 bvj=∞ vJunction reverse breakdown voltage.

Temperature effects parameters

- 73 tnom (C) Parameters measurement temperature. Default set by options.
- 74 trise=0 CTemperature rise from ambient.

Component Statements Part 1

- 75 tcv=1.0e-3 V/CThreshold voltage temperature coefficient.
- 76 bex=-1.5Mobility temperature exponent.
- 77 ucex=0.8Longitudinal critical field temp. exponent.
- 78 ibbt=9.0e-4 1/CTemperature coefficient for IBB.
- 79 xti=3Saturation current temperature exponent.
- 80 tlev=0DC temperature selector.
- 81 tlevc=0AC temperature selector.
- **82** eg=1.12452 VEnergy band gap.
- 83 gap1=7.02e-4 V/CBand gap temperature coefficient.
- 84 gap2=1108 CBand gap temperature offset.
- 85 tr1=0.6First source-drain resistance temperature coefficient.
- 86 tr2=0.6Second source-drain resistance temperature coefficient.
- 87 ptc=0 V/CSurface potential temperature coefficient.
- 88 pta=0 V/CJunction potential temperature coefficient.
- 89 ptp=0 V/CSidewall junction potential temperature coefficient.
- 90 cta=0 1/CJunction capacitance temperature coefficient.
- 91 ctp=0 1/cSidewall junction capacitance temperature coefficient.

Default instance parameters

- 92 w=3e-6 mDefault channel width.
- 93 1=3e-6 mDefault channel length.
- 94 as=0 m²Default area of source diffusion.
- 95 ad=0 m²Default area of drain diffusion.

Component Statements Part 1

- 96 ps=0 mDefault perimeter of source diffusion.
- 97 pd=0 mDefault perimeter of drain diffusion.
- 98 nrd=0 m/mDefault number of squares of drain diffusion.
- 99 nrs=0 m/mDefault number of squares of source diffusion.

Noise model parameters

- 100 noisemod=1Noise model selector.
- 101 kf=0Flicker (1/f) noise coefficient.
- 102 af=1Flicker (1/f) noise exponent.
- 103 ef=1Flicker (1/f) noise frequency exponent.

Model selection parameters

- 104 ngs=0Nonquasi-static flag.
- 105 satlim=exp(4) Ratio defining saturation limit.
- 106 ekvint=0.0Interpolation function selector.
- 107 scalem=1.0Model scaling factor.
- 108 update=2.6Model version selector.

Auto Model Selector parameters

- 109 wmax=1.0 mMaximum channel width for which the model is valid.
- 110 wmin=0.0 mMinimum channel width for which the model is valid.
- 111 lmax=1.0 mMaximum channel length for which the model is valid.
- 112 lmin=0.0 mMinimum channel length for which the model is valid.

Component Statements Part 1

Imax and Imelt

The imax parameter aids convergence and prevents numerical overflow. The junction characteristics of the device are accurately modeled for current up to imax. If imax is exceeded during iterations, the linear model is substituted until the current drops below imax or until convergence is achieved. If convergence is achieved with the current exceeding imax, the results are inaccurate, and Spectre prints a warning.

A separate model parameter, imelt, is used as a limit warning for the junction current. This parameter can be set to the maximum current rating of the device. When any component of the junction current exceeds imelt, note that base and collector currents are composed of many exponential terms, Spectre issues a warning and the results become inaccurate. The junction current is linearized above the value of imelt to prevent arithmetic exception, with the exponential term replaced by a linear equation at imelt.

Both of these parameters have current density counterparts, jmax and jmelt, that you can specify if you want the absolute current values to depend on the device area.

Auto Model Selection

Many models need to be characterized for different geometries in order to obtain accurate results for model development. The model selector program automatically searches for a model with the length and width range specified in the instance statement and uses this model in the simulations.

For the auto model selector program to find a specific model, the models to be searched should be grouped together within braces. Such a group is called a model group. An opening brace is required at the end of the line defining each model group. Every model in the group is given a name followed by a colon and the list of parameters. Also, the four geometric parameters lmax, lmin, wmax, and wmin should be given. The selection criteria to choose a model is as follows:

Then for a given instance

```
M1 1 2 3 4 ModelName w=3 l=1.5
```

Component Statements Part 1

the program would search all the models in the model group with the name ModelName and then pick the first model whose geometric range satisfies the selection criteria. In the preceding example, the auto model selector program would choose ModelName.2.

The user must specify both length (I) and width (w) on the device instance line to enable automatic model selection.

Output Parameters

- 1 weff (m) Effective channel width.
- 2 leff (m) Effective channel length.
- 3 rseff (Ω) Effective source resistance.
- 4 rdeff (Ω) Effective drain resistance.

Operating-Point Parameters

- 1 type=nTransistor type.
- Possible values are n or p.
- 2 region=triodeEstimated operating region.
 - Possible values are off, triode, sat, or subth.
- 3 reversedReverse mode indicator.
 - Possible values are no or yes.
- 4 ids (A) Resistive drain-to-source current.
- 5 vgs (V) Gate-source voltage.
- 6 vds (V) Drain-source voltage.
- 7 vbs (V) Bulk-source voltage.
- 8 vp (V) Pinchoff voltage.
- 9 vth (V)Threshold voltage.
- 10 vdss (V) Drain-source saturation voltage.

Component Statements Part 1

- 11 gm (S) Common-source transconductance.
- 12 gds (S) Common-source output conductance.
- 13 gmbs (S) Body-transconductance.
- 14 nfacSlope factor.
- 15 if (A) Forward current.
- 16 ir (A) Reverse current.
- 17 irprime (A) Reverse current.
- 18 isub (A) Substrate Current.
- 19 ibd (A) Bulk-drain junction current.
- 20 ibs (A) Bulk-source junction current.
- 21 pwr (W) Power at op point.
- 22 gmoverid (1/V)Gm/Ids.
- 23 gamma (\sqrt{V}) Body-effect parameter.
- 24 cjd (F) Drain-bulk junction capacitance.
- 25 cjs (F) Source-bulk junction capacitance.
- 26 cgg (F) Gate-gate capacitance.
- 27 cgd (F) Gate-drain capacitance.
- 28 cgs (F) Gate-source capacitance.
- 29 cgb (F) Gate-bulk capacitance.
- 30 cdg (F) Drain-gate capacitance.
- 31 cdd (F) Drain-drain capacitance.
- 32 cds (F) Drain-source capacitance.

Component Statements Part 1

- 33 cdb (F) Drain-bulk capacitance.
- 34 csg (F) Source-gate capacitance.
- 35 csd (F) Source-drain capacitance.
- 36 css (F) Source-source capacitance.
- 37 csb (F) Source-bulk capacitance.
- 38 cbg (F) Bulk-gate capacitance.
- 39 cbd (F) Bulk-drain capacitance.
- 40 cbs (F) Bulk-source capacitance.
- 41 cbb (F) Bulk-bulk capacitance.
- 42 vm (V) Early voltage.
- 43 vovrdr (V) Overdrive voltage.
- 44 tau (s) NQS time constant.
- 45 tau0 (s) Intrinsic time constant.
- 46 ron (Ω) On-resistance.

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ad M-95	eg M-82	minr M-62	scalem M-107
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dskip M-36	lmax M-111	rseff 0-3	xqc M-31
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Component Statements Part 1

Ratiometric Fourier Analyzer (fourier)

Description

The ratiometric Fourier analyzer measures the Fourier coefficients of two different signals at a specified fundamental frequency without loading the circuit. The algorithm used is based on the Fourier integral rather than the discrete Fourier transform and therefore is not subject to aliasing. Even on broad-band signals, it computes a small number of Fourier coefficients accurately and efficiently. Therefore, this Fourier analyzer is suitable on clocked sinusoids generated by sigma-delta converters, pulse-width modulators, digital-to-analog converters, sample-and-holds, and switched-capacitor filters as well as on the traditional low-distortion sinusoids produced by amplifiers or filters.

The analyzer is active only during a transient analysis. For each signal, the analyzer prints the magnitude and phase of the harmonics along with the total harmonic distortion at the end of the transient analysis. The total harmonic distortion is found by summing the power in all of the computed harmonics except DC and the fundamental. Consequently, the distortion is not accurate if you request an insufficient number of harmonics The Fourier analyzer also prints the ratio the spectrum of the first signal to the fundamental of the second, so you can use the analyzer to compute large signal gains and immittances directly.

If you are concerned about accuracy, perform an additional Fourier transform on a pure sinusoid generated by an independent source. Because both transforms use the same time points, the relative errors measured with the known pure sinusoid are representative of the errors in the other transforms. In practice, this second Fourier transform is performed on the reference signal. To increase the accuracy of the Fourier transform, use the points parameter to increase the number of points. Tightening reltol and setting errpreset=conservative are two other measures to consider.

The accuracy of the magnitude and phase for each harmonic is independent of the number of harmonics computed. Thus, increasing the number of harmonics (while keeping points constant) does not change the magnitude and phase of the low order harmonics, but it does improve the accuracy of the total harmonic distortion computation. However, if you do not specify points, you can increase accuracy by requesting more harmonics, which creates more points.

The large number of points required for accurate results is not a result of aliasing. Many points are needed because a quadratic polynomial interpolates the waveform between the time-points. If you use too few time-points the polynomials deviate slightly from the true waveform between time-points and all of the computed Fourier coefficients are slightly in error. The algorithm that computes the Fourier integral does accept unevenly spaced time-points, but because it uses quadratic interpolation, it is usually more accurate using time-steps that are small and nearly evenly spaced.

Component Statements Part 1

This device is not supported within altergroup.

Sample Instance Statement

four1 (1 0) fourmod harms=50

Sample Model Statement

model fourmod fourier fund=900M points=2500 order=2

Instance Definition

Name [p] [n] [pr] [nr] ModelName parameter=value ...

Name [p] [n] [pr] [nr] fourier parameter=value ...

The signal between terminals p and n is the test or numerator signal. The signal between terminals pr and nr is the reference or denominator signal. Fourier analysis is performed on terminal currents by specifying the term or refterm parameters. If both term and p or n are specified, then the terminal current becomes the numerator and the node voltages become the denominator. By mixing voltages and currents, it is possible to compute large signal immittances.

Instance Parameters

- 1 fund (Hz) Fundamental frequency.
- 2 points=20 maxharm

Minimum number of time points.

- 3 active=yesWhether Fourier analysis should be performed or skipped. Possible values are no or yes.
- 4 order=2Order of interpolation.
- 5 termTerminal used to measure current for test (numerator) channel.
- 6 reftermTerminal used to measure current for reference (denominator) channel.
- 7 harmsvec=[...] Array of desired harmonics for test (numerator) channel.

Component Statements Part 1

- 8 harms=9Number of harmonics for test (numerator) channel, if an array is not given. The harmonics start from firstharm and go up to firstharm + harms 1.
- 9 refharmsvec=[...] Array of desired harmonics for reference (denominator) channel.
- 10 refharms=9Number of harmonics for reference (denominator) channel, if an array is not given. The harmonics start from reffirstharm and go up to reffirstharm + harms 1.
- 11 scale=1Scale factor for ratioed results.
- 12 firstharm=1First harmonic computed for test (numerator) channel.
- 13 reffirstharm=1First harmonic computed for reference (denominator) channel.
- 14 normharm=1Normalizing harmonic for test (numerator) channel.
- 15 refnormharm=1Normalizing harmonic for reference (denominator) channel.
- 16 where=logfileWhere Fourier results should be printed.

 Possible values are screen, logfile or both.

Model Definition

model modelName fourier parameter=value ...

Model Parameters

- 1 fund (Hz) Fundamental frequency.
- 2 points=20 maxharm

Minimum number of time points.

- 3 harms=9Desired number of harmonics.
- 4 active=yesWhether Fourier analysis should be performed or skipped. Possible values are no or yes.
- 5 order=2Order of interpolation.
- 6 firstharm=1First harmonic computed for test (numerator) channel.

Component Statements Part 1

7 reffirstharm=1First harmonic computed for reference (denominator) channel.

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fund M-1	order I-4	refharmsvec I-9	

GaAs MESFET (gaas)

Description

The GaAs MESFET model was derived from the model by H. Statz and others at Raytheon. This model is completely symmetric and is modified slightly to make it charge conserving. GaAs MESFET instances require that you use a model statement.

This device is supported within altergroups.

There are some convergence problems with this model because of Cgs going to zero beyond pinchoff. The problems occur when the gate is driven from an inductive source, and there is no other capacitance at the gate. To prevent these problems, avoid setting Cgd to zero and add sidewall capacitance to the gate-source and gate-drain junctions. A good estimate for these capacitors is $C = pi^*epsilon^*w/2$ where w is the gate width in microns and epsilon = 0.116 fF/micron.

To examine the equations used for this component, consult the <u>Spectre Circuit Simulator</u> <u>Device Model Equations</u> manual.

Sample Instance Statement

```
m1 (1 2 0) nmes area=1 m=2
```

Component Statements Part 1

Sample Model Statement

model nmes gaas type=n vto=-2 beta=0.06 lambda=0 b=0.25 rs=3.65 alpha=1.9 rd=1.98 is=1.1e-9 n=1.28 fc=0.5 cgs=0.365e-12

Instance Definition

Name d g s ModelName parameter=value ...

Instance Parameters

- 1 area=1Junction area factor.
- 2 m=1Multiplicity factor.
- 3 region=fwdEstimated operating region.

Possible values are off, triode, sat, subth, or breakdown.

Model Definition

model modelName gaas parameter=value ...

Model Parameters

Device type parameters

1 type=nTransistor type.

Possible values are n or p.

Drain current parameters

- 2 vto=-2 vPinch-off voltage.
- 3 beta=0.0001 A/V²Transconductance parameter.
- 4 lambda=0 1/VChannel length modulation parameter.
- 5 b=0.3 1/VDoping tail extending parameter.
- 6 alpha=2 1/VSaturation voltage parameter.

Component Statements Part 1

Parasitic resistance parameters

- 7 rd=0 Ω Drain resistance (/area).
- 8 rs=0 Ω Source resistance (/area).
- 9 rg=0 Ω Gate resistance (/area).
- 10 minr=0.1 Ω Minimum source/drain/gate resistance.

Junction diode model parameters

- 11 is=1e-14 AGate saturation current (*area).
- 12 n=1Emission coefficient for the gate junction.
- 13 imelt=\imaxA' Explosion current (*area).
- 14 dskip=yesUse simple piece-wise linear model for diode currents below 0.1*iabstol. Possible values are no or yes.

Junction capacitance model parameters

- 15 capmod=2Charge model selector.
- 16 cgs=0 FGate-source zero-bias junction capacitance (*area).
- 17 cgd=0 FGate-drain zero-bias junction capacitance (*area).
- 18 pb=1 vGate junction potential.
- 19 fc=0.5Junction capacitor forward-bias threshold.
- 20 delta=0.2 vGate capacitance pinch-off transition width.

Temperature effects parameters

- 21 tnom (C) Parameters measurement temperature. Default set by options.
- 22 trise=0 cTemperature rise from ambient.
- 23 xti=3Temperature exponent for effect on is.

Component Statements Part 1

Operating region warning control parameters

24 alarm=noneForbidden operating region.

Possible values are none, off, triode, sat, subth, or rev.

25 imax=1 AMaximum allowable current (*area).

26 bvj=∞ vJunction reverse breakdown voltage.

Noise model parameters

27 kf=0Flicker noise (1/f) coefficient.

28 af=1Flicker noise (1/f) exponent.

Imax and Imelt

The imax parameter aids convergence and prevents numerical overflow. The junction characteristics of the device are accurately modeled for current up to imax. If imax is exceeded during iterations, the linear model is substituted until the current drops below imax or until convergence is achieved. If convergence is achieved with the current exceeding imax, the results are inaccurate, and Spectre prints a warning.

A separate model parameter, imelt, is used as a limit warning for the junction current. This parameter can be set to the maximum current rating of the device. When any component of the junction current exceeds imelt, note that base and collector currents are composed of many exponential terms, Spectre issues a warning and the results become inaccurate. The junction current is linearized above the value of imelt to prevent arithmetic exception, with the exponential term replaced by a linear equation at imelt.

The by parameter detects the junction breakdown only. The breakdown currents of the junctions are not modeled.

Operating-Point Parameters

1 type=nTransistor type.

Possible values are n or p.

2 region=fwdEstimated operating region.

Possible values are off, triode, sat, subth, or breakdown.

3 ids (A) Resistive drain current.

Component Statements Part 1

- 4 vth (V)Threshold voltage.
- 5 vgs (V) Gate-source voltage.
- 6 vds (V) Drain-source voltage.
- 7 vdsat (V) Drain saturation voltage.
- 8 gm (S) Common-source transconductance.
- 9 gds (S) Common-source output conductance.
- 10 cgs (F) Gate-source capacitance.
- 11 cgd (F) Gate-drain capacitance.
- 12 ig (A) Resistive gate current.
- 13 pwr (W) Power at operating point.

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- n <u>z-Domain Linear Current Controlled Current Source (zcccs)</u> on page 540
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Component Statements Part 2

Hetero-Junction Bipolar Transistor (hbt)

Description

The HBT (Hetero-junction Bipolar Transistor) model was developed by UCSD as part of the ARPA High Speed Circuit Design Program. The model has four external electrical nodes, one thermal node, and up to nine internals depending on the complexity of the model users specified. Detailed description of the model and equations and be found in the Spectre Circuit Simulator Device Model Equations manual.

This device is supported within altergroups.

Sample Instance Statement

```
q7 (net5 net2 0) hbtmod m=1 top=25
```

Sample Model Statement

model hbtmod hbt type=npn bf=500 br=1000 xtb=-2.4 xti=0 xcjc=0.83 mje=0.34 fc=0.5 eg=1.2 ise=5.5e-15 vjc=0.84 vaf=40 cjc=5.1e-15

Instance Definition

```
Name c b e [t] [s] ModelName parameter=value ...
```

It is not necessary to specify the substrate and thermal terminal. If left unspecified, the substrate node is connected to ground while the thermal node is fixed to the ambient temperature. However, you must specify the thermal node if you specify the substrate node.

Instance Parameters

- 1 area=1Transistor area factor.
- 2 m=1Multiplicity factor.
- 3 top (C) Average device operating temperature.
- 4 region=fwdEstimated operating region.

 Possible values are off, fwd, rev, or sat.

Component Statements Part 2

Model Definition

model modelName hbt parameter=value ...

Model Parameters

Structural Parameters

1 type=npnTransistor type.

Possible values are npn or pnp.

Saturation Current Parameters

- 2 is=1e-25 ASaturation value for forward collector current (*area).
- 3 ise=1e-25 ASaturation value for nonideal base current. (*area).
- 4 isex=1e-25 ASaturation current for emitter leakage diode (*area).
- 5 isc=1e-20 ASaturation value for intrinsic BC junction current. (*area).
- 6 iscx=1e-20 ASaturation value for extrinsic B-C junction current (*area).
- 7 ics=1e-30 ASaturation value for C-S junction current (*area).

Emission Coefficient Parameters

- 8 nf=1Forward collector current ideality factor.
- 9 nr=1Reverse ideality factor.
- 10 ne=2Nonideal base forward current ideality factor.
- 11 nex=2ldeality factor for emitter leakage diode.
- 12 nc=2Intrinsic B-C junction ideality factor.
- 13 ncx=2ldeality factor for extrinsic B-C junction.
- 14 ncs=2ldeality factor for C-S junction.

Component Statements Part 2

Current Gain Parameters

- 15 bf=1000 A/AForward ideal current gain (beta).
- 16 br=1000 A/AReverse ideal current gain.
- 17 isa=1e10 ACollector E-B barrier limiting current (*area).
- 18 na=2Collector E-B barrier ideality factor.
- 19 isb=1e10 ACollector B-C barrier limiting current (*area).
- 20 nb=2Collector B-C barrier ideality factor.
- 21 ik=1e10 AKnee current for dc high-level injection effect (*area).

Early Voltage Parameters

- 22 vaf=500 VForward Early voltage.
- 23 var=500 VReverse Early voltage.

Breakdown Voltage Parameters

- 24 bkdn=noFlag denoting B-C breakdown should be included. Possible values are no or yes.
- 25 bvc=50 ACollector-base breakdown voltage BVcbo.
- 26 nbc=8Exponent for B-C multiplication factor versus voltage.
- 27 fa=0.9Factor for specification of avalanche voltage.
- 28 imax=1 AMaximum allowable base current (*area).
- 29 imelt=10 AExplosion current (*area).

Parasitic Resistance Parameters

- 30 rbi=0 Ω Intrinsic base resistance (/area).
- 31 rbx=0 Ω Extrinsic base resistance (/area).

Component Statements Part 2

- 32 rci=0 Ω Intrinsic collector resistance (/area).
- 33 rcx=0 Ω Extrinsic collector resistance (/area).
- 34 re=0 Ω Emitter resistance (/area).
- 35 rex=0 Ω Extrinsic emitter leakage diode series resistance (/area).

Junction Capacitance Parameters

- 36 cje=0 FB-E depletion capacitance at zero bias (*area).
- 37 vje=1.6 vB-E built-in potential for Cj.
- 38 mje=0.5Exponent for voltage variation of B-E Cj.
- 39 cemin=0 FMinimum B-E capacitance (*area).
- 40 fce=0.8Factor for start of high bias B-E Cj approximation.
- 41 cjc=0 Fintrinsic B-C depletion capacitance at zero bias (*area).
- 42 vjc=1.4 VIntrinsic B-C built-in potential for Cj.
- 43 mjc=0.33Exponent for voltage variation of Intrinsic B-C Cj.
- 44 ccmin=0 FMinimum B-C capacitance (*area).
- 45 fc=0.8Factor for start of high bias B-C Cj approximation.
- 46 cjcx=0 FExtrinsic B-C depletion capacitance at zero bias (*area).
- 47 vjcx=1.4 vExtrinsic B-C built-in potential for Cj.
- 48 mjcx=0.33B-C junction exponent.
- 49 cxmin=0 FMinimum extrinsic B-C capacitance (*area).
- 50 xcjc=0Fraction of B-C capacitance tied to external base node.
- 51 cjs=0 FB-S depletion capacitance at zero bias (*area).
- 52 vjs=1.4 vB-S built-in potential for Cj.

Component Statements Part 2

53 mjs=0.5Exponent for voltage variation of C-S Cj.

Transit Time and Excess Phase Parameters

- 54 tfb=0 sBase transit time.
- 55 tbexs=0Excess B-E hererojunction transit time.
- 56 tbcxs=0Excess B-C hererojunction transit time.
- 57 tfc0=0 sCollector forward transit time.
- 58 icrit0=1e3 ACritical current for intrinsic Cj variation.
- 59 itc=0 ACharacteristic current for Tfc.
- 60 itc2=0 ACharacteristic current for Tfc.
- 61 vtc=1e3 vCharacteristic voltage for Tfc.
- 62 tkrk=0 sForward transit time for Kirk effect.
- 63 vkrk=1e3 vCharacteristic voltage for Kirk effect.
- 64 ikrk=1e3 ACharacteristic voltage for Kirk effect.
- 65 tr=0 sReverse charge storage time for intrinsic B-C junction.
- 66 trx=0 sReverse charge storage time for extrinsic B-C junction.
- 67 fex=0 sFactor to determine excess phase.

Temperature Effects Parameters

- 68 selft=noFlag denoting self-heating.

 Possible values are no or yes.
- 69 tnom (C) Parameters measurement temperature. Default set by options.
- 70 top=27 CAverage device operating temperature.
- 71 rth=0 Ω Thermal resistance of device.

Component Statements Part 2

- 72 cth=0 FThermal capacitance of device.
- 73 xti=2Exponent for is temperature dependence.
- 74 xtb=2Exponent for beta temperature dependence.
- 75 tne=0Coefficient for ne temperature dependence.
- 76 tnc=0Coefficient for nc temperature dependence.
- 77 tnex=0Coefficient for nex temperature dependence.
- 78 eae=0 VActivation energy for isa temperature dependence.
- 79 eac=0 vActivation energy for isb temperature dependence.
- 80 eaa=0 VActivation energy for ise temperature dependence.
- 81 eab=0 VActivation energy for isc temperature dependence.
- 82 eax=0 VActivation energy for isex temperature dependence.
- 83 xre=0Exponent for re temperature dependence.
- 84 xrex=0Exponent for rex temperature dependence.
- 85 xrb=0Exponent for rb temperature dependence.
- 86 xrc=0Exponent for rc temperature dependence.
- 87 tvje=0 V/CCoefficient for vje temperature dependence.
- 88 tvjc=0 V/CCoefficient for vjc temperature dependence.
- 89 tvjcx=0 V/CCoefficient for vjcx temperature dependence.
- 90 tvjs=0 V/CCoefficient for vjs temperature dependence.
- 91 xtitc=0Exponent for itc temperature dependence.
- 92 xtitc2=0Exponent for itc2 temperature dependence.
- 93 xttf=0Exponent for tf temperature dependence.

Component Statements Part 2

- 94 xttkrk=0Exponent for tkrk temperature exponent.
- 95 xtvkrk=0Exponent for vkrk temperature dependence.
- 96 xtikrk=0Exponent for ikrk temperature dependence.
- 97 xrt=0Exponent for rth temperature dependence.
- 98 eg=1.5 VActivation energy for is temperature dependence.
- 99 dtmax=1000 CMaximum expected temperature rise above heat sink.

Noise Model Parameters

- 100 kfn=0Flicker (1/f) noise coefficient.
- 101 afn=1Flicker (1/f) noise exponent.
- 102 bfn=1Flicker noise frequency exponent.

Imax and Imelt

The imax parameter aids convergence and prevents numerical overflow. The junction characteristics of the device are accurately modeled for current up to imax. If imax is exceeded during iterations, the linear model is substituted until the current drops below imax or until convergence is achieved. If convergence is achieved with the current exceeding imax, the results are inaccurate, and Spectre prints a warning.

A separate model parameter, imelt, is used as a limit warning for the junction current. This parameter can be set to the maximum current rating of the device. When any component of the junction current exceeds imelt, note that base and collector currents are composed of many exponential terms, Spectre issues a warning and the results become inaccurate. The junction current is linearized above the value of imelt to prevent arithmetic exception, with the exponential term replaced by a linear equation at imelt.

Operating-Point Parameters

- 1 type=npnTransistor type.
 - Possible values are npn or pnp.
- 2 region=fwdEstimated operating region.

Possible values are off, fwd, rev, or sat.

Component Statements Part 2

- 3 vbe (V) Base-emitter voltage.
- 4 vbc (V) Base-collector voltage.
- 5 vce (V) Collector-emitter voltage.
- 6 vcs (V) XC-substrate voltage.
- 7 temp (C) Device temperature.
- 8 ith (A) Thermal source.
- 9 ice (A) Intrinsic B-C current.
- 10 ibe (A) Intrinsic B-E current.
- 11 ics (A) C-S junction current.
- 12 ibei (A) B-E junction current.
- 13 ibci (A)B-C junction current.
- 14 ibex (A) XB-E junction current.
- 15 ibcx (A) XB-C junction current.
- 16 ibk (A) Breakdown current.
- 17 dice_dvbe (S)Intrinsic dlce/dVbe.
- 18 dice_dvbc (S)Intrinsic dlce_dVbc.
- 19 dibe_dvbe (S)Intrinsic dlbe_dVbe.
- 20 dibe_dvbc (S)Intrinsic dlbe_dVbc.
- 21 dqbe_dvbe (F)Intrinsic dQbe_dVbe.
- 22 dqbe_dvbc (F)Intrinsic dQbe_dVbc.
- 23 dqbc_dvbe (F)Intrinsic dQbc_dVbe.
- 24 dqbc_dvbc (F)Intrinsic dQbc_dVbc.

Component Statements Part 2

- 25 cbcx (F) XB-C junction capacitance.
- 26 cbcxx (F) EXTB-C junction capacitance.
- 27 ccs (F) Substrate junction capacitance.

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br M-16	ibe OP-10	ne M-10	vaf M-22
bvc M-25	ibei OP-12	nex M-11	var M-23
cbcx OP-25	ibex OP-14	nf M-8	vbc OP-4
cbcxx OP-26	ibk OP-16	nr M-9	vbe OP-3
ccmin M-44	ice OP-9	rbi M-30	vce OP-5
ccs OP-27	icrit0 M-58	rbx M-31	vcs OP-6
cemin M-39	ics M-7	rci M-32	vjc M-42
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cjcx M-46	ik M-21	re M-34	vje M-37
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dqbc_dvbc OP-24	ise M-3	tfb M-54	xrt M-97
dqbc_dvbe OP-23	isex M-4	tfc0 M-57	xtb M-74
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dqbe_dvbe OP-21	itc2 M-60	tnc M-76	xtikrk M-96
dtmax M-99	ith OP-8	tne M-75	xtitc M-91
eaa M-80	kfn M-100	tnex M-77	xtitc2 M-92
eab M-81	m I-2	tnom M-69	xttf M-93
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Component Statements Part 2

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HV MOS Transistor (hvmos)

Description

HV (High-Voltage) MOS transistor model is a deep submicron, high-voltage MOSFET model. It is based on the BSIM3v3 version 3.1. Major enhancements include current-crowding effect at high gate bias, asymmetric source-drain structure, mobility reduction, transconductance reduction under high Vgs at saturation region, forward and reverse mode, self-heating, and more flexible gate-dependent output characteristics. HVMOS can be used for high voltage IC design applications such as Flash memory with asymmetric LDD structures, LCD drivers, CCD, E2PROM and LDMOS applications.

Like BSIM3v3, the HVMOS transistor model also allows the binning option to achieve even higher accuracy. The binning equation is given by

```
P = PO + Pl / Leff + Pw / Weff + Pp / (Leff * Weff)
```

Only the P0 parameters are listed. PI, Pw, and Pp are not shown but can be recognized. The names of PI, Pw, and Pp are identical to that of P0 but with a prefix of I, w, and p, respectively. HVMOS transistors require that you use a model statement.

This device is supported within altergroups.

Sample Instance Statement

```
m1 (1 2 0 0) hvnmos w=1.5u l=1u ad=2.6p as=2.6p pd=6.6p ps=6.6p nrd=1.54 nrs=1.54
```

Sample Model Statement

```
model hvnmos hvmos vtho=0.53 w0=2.14e-6 nlx=1.8e-7 nch=2.3e18 xj=0.22e-6 kl=0.48 k2=-0.02 drout=1.1 rsh=10 cgso=2.4e-10 cgdo=2.4e-10
```

Instance Definition

```
Name d g s b ModelName parameter=value ...
```

Component Statements Part 2

Instance Parameters

- 1 w (m) Channel width.
- 2 1 (m) Channel length.
- 3 as (m²) Area of source diffusion.
- 4 ad (m²) Area of drain diffusion.
- 5 ps (m) Perimeter of source diffusion.
- 6 pd (m) Perimeter of drain diffusion.
- 7 nrd (m/m) Number of squares of drain diffusion.
- 8 nrs (m/m) Number of squares of source diffusion.
- 9 ld (m) Length of drain diffusion region.
- 10 ls (m) Length of source diffusion region.
- 11 m=1Multiplicity factor (number of MOSFETs in parallel).
- 12 region=triodeEstimated operating region.

 Possible values are off, triode, sat, or subth.
- 13 triseTemperature rise from ambient.

Model Definition

model modelName hvmos parameter=value ...

Model Parameters

Device Type Parameters

1 type=nTransistor type.

Possible values are n or p.

Component Statements Part 2

Threshold Voltage Parameters

- 2 vtho (V) Threshold voltage at zero body bias for long-channel devices. For enhancement-mode devices, vtho > 0 for n-channel and vtho < 0 for p-channel.
- 3 $k1=0.5 \ \sqrt{V}$ Body-effect coefficient.
- 4 k2=-0.0186Charge-sharing parameter.
- 5 k3=80Narrow width coefficient.
- 6 k3b=0 1/VNarrow width coefficient.
- 7 w0=2.5e-6 mNarrow width coefficient.
- 8 nlx=1.74e-7 mLateral nonuniform doping coefficient.
- 9 dvt0=2.2First coefficient of short-channel effects.
- 10 dvt1=0.53Second coefficient of short-channel effects.
- 11 dvt2=-0.032 1/VBody-bias coefficient of short-channel effects.
- 12 a0f=1Forward nonuniform depletion width effect coefficient.
- 13 a0r=a0fReverse nonuniform depletion width effect coefficient.
- 14 b0=0 mBulk charge coefficient due to narrow width effect.
- 15 b1=0 mBulk charge coefficient due to narrow width effect.
- 16 a1=0No-saturation coefficient.
- 17 a2=1No-saturation coefficient.
- 18 ags=0 F/m² VGate-bias dependence of Abulk.
- 19 ketaf=-0.047 1/VBody-bias coefficient for non-uniform depletion width effect.
- 20 ketar=ketaf 1/VReverse body-bias coefficient for non-uniform depletion width effect.

Component Statements Part 2

Process Parameters

- 21 nch=1.7e17 cm⁻³Peak channel doping concentration.
- 22 xj=0.15e-6 mSource/drain junction depth.
- 23 lint=0 mLateral diffusion for one side.
- 24 wint=0 mWidth reduction for one side.
- 25 11=0 mLength dependence of delta L.
- 26 lln=1Length exponent of delta L.
- 27 lw=0 mWidth dependence of delta L.
- 28 lwn=1Width exponent of delta L.
- 29 lwl=0 m²Area dependence of delta L.
- 30 lmin=0 mThe minimum channel length for which the model is still valid.
- 31 lmax=1 mThe maximum channel length for which the model is still valid.
- 32 wl=0 mLength dependence of delta W.
- 33 wln=1Length exponent of delta W.
- 34 ww=0 mWidth dependence of delta W.
- 35 wwn=1Width exponent of delta W.
- 36 wwl=0 m²Area dependence of delta W.
- 37 wmin=0 mThe minimum channel width for which the model is still valid.
- 38 wmax=1 mThe maximum channel width for which the model is still valid.
- 39 dwg=0 m/vGate-bias dependence of channel width.
- 40 dwb=0 m/ \sqrt{v} Body-bias dependence of channel width.
- 41 tox=1.5e-8 mGate oxide thickness.

Component Statements Part 2

- 42 rd0=0 Ω Fixed drain resistance.
- 43 rs0=0 Ω Fixed source resistance.
- 44 rdw=0 Ω μm Width dependence of drain resistance.
- 45 rsw=0 Ω µmWidth dependence of source resistance.
- 46 prwb=0 $1/\sqrt{v}$ Body-effect coefficient for Rds.
- 47 prwg=0 $1/\sqrt{v}$ Gate-effect coefficient for Rds.
- 48 wr=1Width offset for parasitic resistance.
- 49 binunit=2Bin parameter unit selector. 1 for microns and 2 for meters.

Mobility Parameters

- 50 mobmod=1Mobility model selector.
- 51 u0f=670 cm²/V sForward low-field surface mobility at tnom. Default is 250 for PMOS.
- 52 u0r=u0f cm²/V sReverse low-field surface mobility at tnom.
- 53 vsatf=8e4 m/sForward carrier saturation velocity at tnom.
- 54 dvsatf=0 m/sForward gate-bias dependence of saturation velocity.
- 55 dvsatbf=0 m/sForward body-bias dependence of saturation velocity.
- 56 vsatr=vsatf m/sReverse carrier saturation velocity at tnom.
- 57 dvsatr=dvsatf m/sReverse gate-bias dependence of saturation velocity.
- 58 dvsatbr=dvsatbf m/s

Reverse body-bias dependence of saturation velocity.

- 59 uaf=2.25e-9 m/vForward first-order mobility reduction coefficient.
- 60 ubf=5.87e-19 m^2/v^2

Forward second-order mobility reduction coefficient.

Component Statements Part 2

- 61 ucf=-4.65e-11 m/v^2
 - Forward body-bias dependence of mobility. Default is -0.046 and unit is 1/V for mobmod=3.
- 62 udf=0 m/v²Forward source-resistance dependence of mobility.
- 63 uar=uaf m/vReverse first-order mobility reduction coefficient.
- 64 ubr=ubf m²/v²Reverse second-order mobility reduction coefficient.
- 65 ucr=ucf m/v²Reverse body-bias dependence of mobility.
- 66 udr=udf m/v²Reverse source-resistance dependence of mobility.

Output Resistance Parameters

- 67 drout=0.56DIBL effect on output resistance coefficient.
- 68 pclmf=1.3Forward channel length modulation coefficient.
- 69 pclmr=pclmfReverse channel length modulation coefficient.
- 70 pdiblc1f=0.39Forward first coefficient of drain-induced barrier lowering.
- 71 pdiblc1r=pdiblc1f

Reverse first coefficient of drain-induced barrier lowering.

- 72 pdiblc2f=8.6e-3Forward second coefficient of drain-induced barrier lowering.
- 73 pdiblc2r=pdiblc2f

Reverse second coefficient of drain-induced barrier lowering.

- 74 pdiblcbf=0 1/VBody-effect coefficient for DIBL.
- **75** pdiblcbr=pdiblcbf 1/V

Reverse body-effect coefficient for DIBL.

76 pscbe1f=4.24e8 V/m

First coefficient of substrate current body effect.

- 77 pscbe2f=1e-5 m/vSecond coefficient of substrate current body effect.
- 78 pscbeg=0 V/mThird coefficient of substrate current body effect.

Component Statements Part 2

- 79 pscbelr=pscbelf V/m
 - Reverse first coefficient of substrate current body effect.
- 80 pscbe2r=pscbe2f m/v
 - Reverse second coefficient of substrate current body effect.
- 81 pclmgf=0Forward gate dependence of Vaclm.
- 82 pclmgr=pclmgfReverse gate dependence of Vaclm.
- 83 pclmbf=0Forward body dependence of Vaclm.
- 84 pclmbr=pclmbfReverse body dependence of Vaclm.
- 85 pdiblgf=0Forward gate dependence of Vadibl.
- 86 pdiblgr=pdiblgfReverse gate dependence of Vadibl.
- 87 delta=0.01 VEffective drain voltage smoothing parameter.

Subthreshold Parameters

- 88 cdsc=2.4e-4 F/m²Source/drain and channel coupling capacitance.
- 89 cdscb=0 F/m² VBody-bias dependence of cdsc.
- 90 cdscd=0 F/m² VDrain-bias dependence of cdsc.
- 91 nfactor=1Subthreshold swing coefficient.
- 92 cit=0 FInterface trap parameter for subthreshold swing.
- 93 voff=-0.08 vThreshold voltage offset.
- 94 dsub=drout DIBL effect in subthreshold region.
- 95 eta0f=0.08DIBL coefficient subthreshold region.
- 96 etabf=-0.07 1/VBody-bias dependence of et0.
- 97 eta0r=eta0fReverse DIBL coefficient subthreshold region.
- 98 etabr=etabf 1/VBody-bias dependence of eta0r.

Component Statements Part 2

Substrate current parameters

- 99 alpha0=0 m/vSubstrate current impact ionization coefficient.
- 100 beta0=30 1/VSubstrate current impact ionization exponent.

Parasitic Resistance Parameters

- 101 rsh=0 Ω/sqr Source/drain diffusion sheet resistance.
- 102 rs=0 Ω Source resistance.
- 103 rd=0 Ω Drain resistance.
- 104 lgcs=0 mGate-to-contact length of source side.
- 105 lgcd=0 mGate-to-contact length of drain side.
- 106 rsc=0 Ω Source contact resistance.
- 107 rdc=0 Ω Drain contact resistance.
- 108 rss=0 Ω mScalable source resistance.
- 109 rdd=0 Ω mScalable drain resistance.
- 110 sc=∞ mSpacing between contacts.
- 111 ldif=0 mLateral diffusion beyond the gate.
- 112 hdif=0 mLength of heavily doped diffusion.
- 113 minr=0.1 Ω Minimum source/drain resistance.

Junction Diode Model Parameters

- 114 js (A/m²) Bulk junction reverse saturation current density.
- 115 is=1e-14 ABulk junction reverse saturation current.
- 116 n=1Junction emission coefficient.

Component Statements Part 2

- 117 dskip=yesUse simple piece-wise linear model for diode currents below 0.1*iabstol. Possible values are no or yes.
- 118 imelt=`imaxA' Explosion current.
- 119 jmelt=\jmaxA/m'²

Explosion current density.

Overlap Capacitance Parameters

- 120 cgso (F/m) Gate-source overlap capacitance.
- 121 cgdo (F/m) Gate-drain overlap capacitance.
- 122 cgbo (F/m) Gate-bulk overlap capacitance.
- 123 meto=0 mMetal overlap in fringing field.
- 124 cgs1=0 F/mGate-source overlap capacitance in LDD region.
- 125 cgdl=0 F/mGate-drain overlap capacitance in LDD region.
- 126 ckappa=0.6Overlap capacitance fitting parameter.
- 127 deltaacc=0.1 vCapacitance smoothing parameter.

Junction Capacitance Model Parameters

- 128 cbs=0 FBulk-source zero-bias junction capacitance.
- 129 cbd=0 FBulk-drain zero-bias junction capacitance.
- 130 cj=5e-4 F/m²Zero-bias junction bottom capacitance density.
- 131 mj=1/2Bulk junction bottom grading coefficient.
- 132 pb=0.8 VBulk junction built-in potential.
- 133 fc=0.5Forward-bias depletion capacitance threshold.
- 134 cjsw=5e-10 F/mZero-bias junction sidewall capacitance density.

Component Statements Part 2

- 135 mjsw=1/3Bulk junction sidewall grading coefficient.
- 136 pbsw=0.8 vSide-wall junction built-in potential.
- 137 fcsw=0.5Side-wall forward-bias depletion capacitance threshold.

Charge Model Selection Parameters

- 138 capmod=2Intrinsic charge model.
- 139 ngsmod=0Non-quasi static model selector. Set to 1 to turn on ngs.
- 140 dwc=wint mDelta W for capacitance model.
- 141 dlc=lint mDelta L for capacitance model.
- 142 clc=1e-7 mIntrinsic capacitance fitting parameter.
- 143 cle=0.6Intrinsic capacitance fitting parameter.
- 144 cf (F/m) Fringe capacitance parameter.
- 145 a0cvf=a0fA0 for C-V calculation.
- 146 a0cvr=a0rReverse A0 for C-V calculation.
- 147 ggvd0f=1Cgd fitting parameter.
- 148 ggvd0r=ggvd0fReverse Cgd fitting parameter.
- 149 elm=5Elmore constant of the channel.
- $150 \times part = 0$ Drain/source channel charge partition in saturation for BSIM charge model, use 0.0 for 40/60, 0.5 for 50/50, or 1.0 for 0/100.

Default Instance Parameters

- 151 w=5e-6 mDefault channel width.
- 152 1=5e-6 mDefault channel length.
- 153 as=0 m²Default area of source diffusion.

Component Statements Part 2

- 154 ad=0 m²Default area of drain diffusion.
- 155 ps=0 mDefault perimeter of source diffusion.
- 156 pd=0 mDefault perimeter of drain diffusion.
- 157 nrd=0 m/mDefault number of squares of drain diffusion.
- 158 nrs=0 m/mDefault number of squares of source diffusion.
- 159 xw=0 mWidth variation due to masking and etching.
- 160 x1=0 mLength variation due to masking and etching.

Temperature Effects Parameters

- 161 tnom (C) Parameters measurement temperature. Default set by options.
- 162 trise=0 CTemperature rise from ambient.
- 163 tlev=0DC temperature selector.
- 164 tlevc=0AC temperature selector.
- **165** eg=1.12452 VEnergy band gap.
- 166 gap1=7.02e-4 V/CBand gap temperature coefficient.
- 167 gap2=1108 CBand gap temperature offset.
- 168 kt1=-0.11 VTemperature coefficient for threshold voltage.
- 169 kt11=0 v mTemperature coefficient for threshold voltage.
- 170 kt2=0.022Temperature coefficient for threshold voltage.
- 171 atf=3.3e4 m/sTemperature coefficient for vsatf.
- 172 atr=atf m/sTemperature coefficient for vsatr.
- 173 at1f=0 m/sTemperature coefficient for dvsatf.
- 174 atlr=atlf m/sTemperature coefficient for dvsatr.

Component Statements Part 2

175 ualf=4.31e-9 m/vTemperature coefficient for uaf.

176 ublf=-7.61e-18 m^2/v^2

Temperature coefficient for ubf.

177 uclf=-5.5e-11 m/v^2

Temperature coefficient for ucf. Default is -0.056 for mobmod=3.

178 udlf=0 m/v²Temperature coefficient for udf.

179 ualr=ualf m/vTemperature coefficient for uar.

180 ublr=ublf m^2/v^2 Temperature coefficient for ubr.

181 uclr=uclf m/v²Temperature coefficient for ucr.

182 udlr=0 m/v²Temperature coefficient for udr.

183 rth=0 Ω Self-heating thermal resistance.

184 rthg=0 1/vGate-effect coefficient for Rth.

185 rthb=0 $1/\sqrt{v}$ Body-effect coefficient for Rth.

186 prt=0 Ω Temperature coefficient for Rds.

187 trs=0 1/CTemperature parameter for source resistance.

188 trd=0 1/cTemperature parameter for drain resistance.

189 ute=-1.5Mobility temperature exponent.

190 xti=3Saturation current temperature exponent.

191 ptc=0 V/CSurface potential temperature coefficient.

192 tcv=0 V/CThreshold voltage temperature coefficient.

193 pta=0 V/CJunction potential temperature coefficient.

194 ptp=0 V/CSidewall junction potential temperature coefficient.

195 cta=0 1/CJunction capacitance temperature coefficient.

Component Statements Part 2

196 ctp=0 1/cSidewall junction capacitance temperature coefficient.

Noise Model Parameters

197 noimod=1Noise model selector.

198 kf=0Flicker (1/f) noise coefficient.

199 af=1Flicker (1/f) noise exponent.

200 ef=1Flicker (1/f) noise frequency exponent.

201 noia=1e20Oxide trap density coefficient. Default is 9.9e18 for pmos.

202 noib=5e4Oxide trap density coefficient. Default is 2.4e3 for pmos.

203 noic=-1.4e-8Oxide trap density coefficient. Default is 1.4e-8 for pmos.

Operating Region Warning Control Parameters

204 alarm=noneForbidden operating region.

Possible values are none, off, triode, sat, subth, or rev.

205 imax=1 AMaximum allowable current.

206 jmax=1e8 A/m²Maximum allowable current density.

207 by j=∞ VJunction reverse breakdown voltage.

208 vbox=1e9 tox vOxide breakdown voltage.

Cross-Term Dependent Parameters

The imax(jmax) parameter is used to aid convergence and prevent numerical overflow. The junction characteristics of the FET are accurately modeled for current (density) up to imax(jmax). For currents (density) above imax(jmax), the junction is modeled as a linear resistor and a warning is printed.

Output Parameters

1 weff (m) Effective channel width.

Component Statements Part 2

- 2 leff (m) Effective channel length.
- 3 rseff (Ω) Effective source resistance.
- 4 rdeff (Ω) Effective drain resistance.

Operating-Point Parameters

1 type=nTransistor type.

Possible values are n or p.

2 region=triodeEstimated operating region.

Possible values are off, triode, sat, or subth.

3 reversedReverse mode indicator.

Possible values are no or yes.

- 4 ids (A) Resistive drain-to-source current.
- 5 vgs (V) Gate-source voltage.
- 6 vds (V) Drain-source voltage.
- 7 vbs (V) Bulk-source voltage.
- 8 vth (V)Threshold voltage.
- 9 vdsat (V) Drain-source saturation voltage.
- 10 gm (S) Common-source transconductance.
- 11 gds (S) Common-source output conductance.
- 12 gmbs (S) Body-transconductance.
- 13 betaeff (A/V^2) Effective beta.
- 14 cjd (F) Drain-bulk junction capacitance.
- 15 cjs (F) Source-bulk junction capacitance.
- 16 cgg (F) Cgg.

Component Statements Part 2

- 17 cgd (F) Cgd.
- 18 cgs (F) Cgs.
- 19 cgb (F) Cgb.
- 20 cdg (F) Cdg.
- 21 cdd (F) Cdd.
- 22 cds (F) Cds.
- 23 cdb (F) Cdb.
- 24 csg (F) Csg.
- 25 csd (F) Csd.
- 26 css (F)Css.
- 27 csb (F) Csb.
- 28 cbg (F)Cbg.
- 29 cbd (F) Cbd.
- 30 cbs (F) Cbs.
- 31 cbb (F) Cbb.
- 32 ron (Ω) On-resistance.
- 33 id (A) Resistive drain current.
- 34 ibulk (A) Resistive bulk current.
- 35 pwr (W) Power at op point.
- 36 gmoverid (1/V) Gm/lds.

Component Statements Part 2

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0 5 7 145	11' 24 110	' 121	25. 4.5
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a0cvr M-146	dsub M-94	mjsw M-135	rth M-183
a0f M-12	dvsatbf M-55	mobmod M-50	rthb M-185
a0r M-13	dvsatbr M-58	n M-116	rthg M-184
a1 M-16	dvsatf M-54	nch M-21	sc M-110
a2 M-17	dvsatr M-57	nfactor M-91	tcv M-192
ad I-4	dvt0 M-9	nlx M-8	tlev M-163
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atr M-172	etabf M-96	pbsw M-136	u0r M-52
b0 M-14	etabr M-98	pclmbf M-83	ualf M-175
b1 M-15	fc M-133	pclmbr M-84	ualr M-179
beta0 M-100	fcsw M-137	pclmf M-68	uaf M-59
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bvj M-207	gds OP-11	pclmr M-69	ub1r M-180
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cbb OP-31	gmbs OP-12	pd M-156	ubr M-64
cbd OP-29	gmoverid OP-36	pdiblc1f M-70	uclf M-177
cbd M-129	hdif M-112	pdiblc1r M-71	uclr M-181
cbg OP-28	ibulk OP-34	pdiblc2f M-72	ucf M-61
cbs OP-30	id OP-33	pdiblc2r M-73	ucr M-65
cbs M-128	ids OP-4	pdiblcbf M-74	udlf M-178
cdb OP-23	imax M-205	pdiblcbr M-75	udlr M-182
cdd OP-21	imelt M-118	pdiblgf M-85	udf M-62
cdg OP-20	is M-115	pdiblgr M-86	udr M-66
cds OP-22	jmax M-206	prt M-186	ute M-189
cdsc M-88	jmelt M-119	prwb M-46	vbox M-208
	•	_	
cdscb M-89	js M-114	prwg M-47	vbs OP-7

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Component Statements Part 2

cdscd M-90	k1 M-3	ps M-155	vds OP-6
cf M-144	k2 M-4	ps I-5	vdsat OP-9
cgb OP-19	k3 M-5	pscbelf M-76	vgs OP-5
cgbo M-122	k3b M-6	pscbelr M-79	voff M-93
cgd OP-17	ketaf M-19	pscbe2f M-77	vsatf M-53
cgdl M-125	ketar M-20	pscbe2r M-80	vsatr M-56
cgdo M-121	kf M-198	pscbeg M-78	vth OP-8
cgg OP-16	kt1 M-168	pta M-193	vtho M-2
cgs OP-18	kt1l M-169	ptc M-191	w I-1
cgsl M-124	kt2 M-170	ptp M-194	w M-151
cgso M-120	1 I-2	pwr OP-35	$w0 \qquad M-7$
cit M-92	1 M-152	qgvd0f M-147	weff O-1
cj M-130	ld I-9	qgvd0r M-148	wint M-24
cjd OP-14	ldif M-111	rd M-103	wl M-32
cjs OP-15	leff O-2	rd0 M-42	wln M-33
cjsw M-134	lgcd M-105	rdc M-107	wmax M-38
ckappa M-126	lgcs M-104	rdd M-109	wmin M-37
clc M-142	lint M-23	rdeff O-4	wr M-48
cle M-143	11 M-25	rdw M-44	ww M-34
csb OP-27	lln M-26	region I-12	wwl M-36
csd OP-25	lmax M-31	region OP-2	wwn M-35
csg OP-24	lmin M-30	reversed OP-3	xj M-22
css OP-26	ls I-10	ron OP-32	xl M-160
cta M-195	lw M-27	rs M-102	xpart M-150
ctp M-196	lwl M-29	rs0 M-43	xti M-190
delta M-87	lwn M-28	rsc M-106	xw M-159
deltaacc M-127	m I-11	rseff O-3	
dlc M-141	meto M-123	rsh M-101	
drout M-67	minr M-113	rss M-108	

Two Terminal Inductor (inductor)

Description

The inductance of this component can be a function of temperature or branch current. If you do not specify the inductance in the instance statement, it is taken from the model.

This device is supported within altergroups.

If the polynomial coefficients vector (coeffs=[c1 c2 ...]) is specified, the inductor is nonlinear and the inductance is

$$L(I) = L(inst) * (1 + c1 * I + c2 * I^2 + ...).$$

Component Statements Part 2

The branch flux as a function of current is

```
Flux(I) = L(inst) * I * (1 + 1/2 * c1 * I + 1/3 * c2 * I^2 + ...) where ck is the kth entry in the coefficient vector.
```

The value of the inductor as a function of the temperature is given by:

```
L(T) = L(tnom) * [1 + tc1 * (T - tnom) + tc2 * (T - tnom)^2].

whereT = trise(inst) + temp

if trise(inst) is given,

otherwise

T = trise(model) + temp
```

Sample Instance Statement

Without model:

```
133 (0 net29) inductor l=10e-9 r=1 m=1
With model:
133 (0 net29) ind l=10e-9 r=1 m=1
```

Sample Model Statement

```
model ind inductor l=6e-9 r=1 tc1=1e-12 tc2=1e-12 tnom=25
```

Instance Definition

```
Name 1 2 ModelName parameter=value ...
Name 1 2 inductor parameter=value ...
```

Instance Parameters

- 1 l (H)Inductance.
- 2 r (Ω) Resistance.
- 3 m=1Multiplicity factor.
- 4 triseTemperature rise from ambient.

Component Statements Part 2

- 5 ic (A) Initial condition.
- 6 isnoisy=yesShould inductor resistance generate noise.

 Possible values are no or yes.

Model Definition

model modelName inductor parameter=value ...

Model Parameters

- 1 1=0 нDefault inductance.
- 2 r=0 Ω Default resistance.
- 3 tc1=0 1/CLinear temperature coefficient.
- 4 tc2=0 C⁻²Quadratic temperature coefficient.
- 5 trise=0 cDefault trise value for instance.
- 6 tnom (C) Parameters measurement temperature. Default set by options.
- 7 rforce=le9 Ω^2 Resistance used when forcing nodesets and initial conditions.
- 8 coeffs=[...] Vector of polynomial inductance coefficients.
- 9 scalei=1Inductance scaling factor.

Noise Model Parameters

- 10 kf=0Flicker (1/f) noise coefficient.
- 11 af=2Flicker (1/f) noise exponent.

Output Parameters

1 indeff (H) Effective inductance.

Component Statements Part 2

Operating-Point Parameters

- 1 ind (H) Inductance at operating point.
- 2 i (A) Current at operating point.

Parameter Index

af M-11	indeff O-1	m I-3	tc1 M-3
coeffs M-8	isnoisy I-6	r M-2	tc2 M-4
i OP-2	kf M-10	r I-2	tnom M-6
ic I-5	1 M-1	rforce M-7	trise I-4
ind OP-1	l I-1	scalei M-9	trise M-5

Interconnect Capacitance (intcap)

Description

Intcap is a model for the calculation of the interconnect capacitance, which takes into account the local layer composition and the tracks spacing width. It is described in the Philips MOST Modelbook (Dec.96) as INTCAP model.

(c) Philips Electronics N.V. 1993,1996

The model is extended by the device parameters lxbelps, lxbelin and lxbelins, according to a specification by H.Okel (I&A Hamburg).

This device is supported within altergroups.

This device is dynamically loaded from the shared object /vobs/spectre_dev/tools.sun4v/spectre/lib/cmi/2.0.doc/libphilips.so

Component Statements Part 2

Sample Instance Statement

intc (net9 net12) intconcap m=1 ael=2.5e-15 ain=2e-15 aps=1.8e-15

Sample Model Statement

model intconcap intcap cbps=1.5e-13 cebpsm=0.9e-15 cebpsi=0.83e-15 cbin=1.45e-13 cbins=1.4e-13

Instance Definition

Name n1 n2 ModelName parameter=value ...

Instance Parameters

- 1 m=1Multiplicity factor.
- 2 ael=0.0 m²The common area of EL track of the reference electrode.
- 3 ain=0.0 m²The common area of IN track of the reference electrode.
- 4 ains=0.0 m²The common area of INS track of the reference electrode.
- 5 aps=0.0 m²The common area of PS track of the reference electrode.
- 6 lbel=0.0 mThe sum of periphery length of EL-segments common to node n2 downwards.
- 7 lbin=0.0 mThe sum of periphery length of IN-segments to node n2 downwards.
- 8 lbins=0.0 mThe sum of periphery length of INS-segments common to node n2 downwards.
- 9 lbps=0.0 mThe sum of periphery length of PS-segments common to node n2 downwards.
- 10 lfbel=0.0 mThe sum of periphery length-factor products EL downwards.
- 11 lfbin=0.0 mThe sum of periphery length-factor products IN downwards.
- 12 lfbins=0.0 mThe sum of periphery length-factor products INS downwards.

Component Statements Part 2

- 13 lfbps=0.0 mThe sum of periphery length-factor products PS downwards.
- 14 lftel=0.0 mThe sum of periphery length-factor products EL upwards.
- 15 lftin=0.0 mThe sum of periphery length-factor products IN upwards.
- 16 lftins=0.0 mThe sum of periphery length-factor products INS upwards.
- 17 lftps=0.0 mThe sum of periphery length-factor products PS upwards.
- 18 ltel=0.0 mThe sum of periphery length of EL-segments common to node n2 upwards.
- 19 ltin=0.0 mThe sum of periphery length of IN-segments common to node n2 upwards.
- 20 ltins=0.0 mThe sum of periphery length of INS-segments common to node n2 upwards.
- 21 ltps=0.0 mThe sum of periphery length of PS-segments common to node n2 upwards.
- 22 ldsel=0.0 mThe sum of Li/Si quotients for EL tracks.
- 23 ldsin=0.0 mThe sum of Li/Si quotients for IN tracks.
- 24 ldsins=0.0 mThe sum of Li/Si quotients for INS tracks.
- 25 ldsps=0.0 mThe sum of Li/Si quotients for PS tracks.
- 26 lxbinps=0.0 mThe sum of Li/Si quotients for an IN track in parallel with an PS track.
- 27 lxbinsin=0.0 mThe sum of Li/Si quotients for an INS track in parallel with an IN track.
- 28 lxbinsps=0.0 mThe sum of Li/Si quotients for an INS track in parallel with an PS track.
- 29 lxbelps=0.0 mThe sum of Li/Si quotients for an EL track in parallel with an PS track.
- 30 lxbelin=0.0 mThe sum of Li/Si quotients for an EL track in parallel with an IN track.
- 31 lxbelins=0.0 mThe sum of Li/Si quotients for an EL track in parallel with an INS track.

The Spectre option scale, default value is 1.0, scales the geometric

parameters. The actual areas (parameters starting with letter a) are equal

axxx * scale ^ 2

Component Statements Part 2

The actual lengths (parameters starting with letter 1) are equal lxxx * scale

Model Definition

model modelName intcap parameter=value ...

Model Parameters

- 1 cbps=0.0 F/m²Bottom capacitance, PS to node n2.
- 2 cebpsm=0.0 F/mEdge to bottom capacitance (PS), 1.0um spacing.
- 3 cebpsi=0.0 F/mEdge to bottom capacitance (PS), single track.
- 4 cetpsm=0.0 F/mEdge to top capacitance (PS), 1.0um spacing.
- 5 cetpsi=0.0 F/mEdge to top capacitance (PS), single track.
- 6 cbin=0.0 F/m²Bottom capacitance, IN to node n2.
- 7 cebinm=0.0 F/mEdge to bottom capacitance (IN), 1.0um spacing.
- 8 cebini=0.0 F/mEdge to bottom capacitance (IN), single track.
- 9 cetinm=0.0 F/mEdge to top capacitance (IN), 1.0um spacing.
- 10 cetini=0.0 F/mEdge to top capacitance (IN), single track.
- 11 cbins=0.0 F/m^2 Bottom capacitance, INS to node n2.
- 12 cebinsm=0.0 F/mEdge to bottom capacitance (INS), 1.0um spacing.
- 13 cebinsi=0.0 F/mEdge to bottom capacitance (INS), single track.
- 14 cetinsm=0.0 F/mEdge to top capacitance (INS), 1.0um spacing.
- 15 cetinsi=0.0 F/mEdge to top capacitance (INS), single track.
- 16 cbel=0.0 F/m^2 Bottom capacitance, EL to node n2.

Component Statements Part 2

- 17 cebelm=0.0 F/mEdge to bottom capacitance (EL), 1.0um spacing.
- 18 cebeli=0.0 F/mEdge to bottom capacitance (EL), single track.
- 19 cetelm=0.0 F/mEdge to top capacitance (EL), 1.0um spacing.
- 20 ceteli=0.0 F/mEdge to top capacitance (EL), single track.
- 21 cecps=0.0 F/mLateral capacitance (PS), 1.0um spacing.
- 22 cecin=0.0 F/mLateral capacitance (IN), 1.0um spacing.
- 23 cecins=0.0 F/mLateral capacitance (INS), 1.0um spacing.
- 24 cecel=0.0 F/mLateral capacitance (EL), 1.0um spacing.

Output Parameters

1 cap (F) Total Capacitance.

Parameter Index

ael I-2	cebinsm M-12	cetpsm M-4	lftin I-15
ain I-3	cebpsi M-3	lbel I-6	lftins I-16
ains I-4	cebpsm M-2	lbin I-7	lftps I-17
aps I-5	cecel M-24	lbins I-8	ltel I-18
cap 0-1	cecin M-22	lbps I-9	ltin I-19
cbel M-16	cecins M-23	ldsel I-22	ltins I-20
cbin M-6	cecps M-21	ldsin I-23	ltps I-21
cbins M-11	ceteli M-20	ldsins I-24	lxbelin I-30
cbps M-1	cetelm M-19	ldsps I-25	lxbelins I-31
cebeli M-18	cetini M-10	lfbel I-10	lxbelps I-29
cebelm M-17	cetinm M-9	lfbin I-11	lxbinps I-26
cebini M-8	cetinsi M-15	lfbins I-12	lxbinsin I-27
cebinm M-7	cetinsm M-14	lfbps I-13	lxbinsps I-28
cebinsi M-13	cetpsi M-5	lftel I-14	m I-1

Component Statements Part 2

Current Probe (iprobe)

Description

Current through the probe is computed and is defined to be positive if it flows from the input node, through the probe, to the output node. The current variable is given the name of the iprobe instance, so you cannot create an iprobe with the same name as a circuit node.

This device is not supported within altergroup.

Sample Instance Statement

```
ip (1 0) iprobe
```

Instance Definition

Name in out iprobe

Independent Current Source (isource)

Description

The value of the DC current as a function of the temperature is given by:

```
I(T) = I(tnom) * [1 + tc1 * (T - tnom) + tc2 * (T - tnom)^2].
```

Sample Instance Statement

i1 (in 0) isource dc=0 type=pulse delay=10n val0=0 val1=500u period=500n rise=1n fall=1n width=250n

Instance Definition

```
Name sink src isource parameter=value ...
```

Positive current exits the source node and enters the sink node.

Instance Parameters

1 dc=0 ADC value.

Component Statements Part 2

General Waveform Parameters

- 2 type=dcWaveform type.
 - Possible values are dc, pulse, pwl, sine, or exp.
- 3 fundnameName of the fundamental frequency. Must be specified if the source is active during a poisto analysis or it is the active clock during an envlp analysis.
- 4 delay=0 sWaveform delay time.

Pulse Waveform Parameters

- 5 val0=0 AZero value used in pulse and exponential waveforms.
- 6 val1=1 AOne value used in pulse and exponential waveforms.
- 7 period=∞ sPeriod of waveform.
- 8 rise (s) Rise time for pulse waveform (time for transition from val0 to val1).
- 9 fall (s) Fall time for pulse waveform (time for transition from val1 to val0).
- 10 width=∞ sPulse width (duration of vall).

PWL Waveform Parameters

- 11 fileName of file containing waveform.
- 12 wave=[...] Vector of time/value pairs that defines waveform.
- 13 offset=0 ADC offset for the PWL waveform.
- 14 scale=1Scale factor for the PWL waveform.
- 15 stretch=1Scale factor for time given for the PWL waveform.
- 16 allbrkptsAll the points in the PWL waveform are breakpoints if set to yes. Default is yes if the number of points is less than 20.

 Possible values are no or yes.
- 17 pwlperiod (s)Period of the periodic PWL waveform.

Component Statements Part 2

18 twidth=pwlperiod/1000 s

Transition width used when making PWL waveforms periodic.

Sinusoidal Waveform Parameters

- 19 sinedc=dc ADC level for sinusoidal waveforms.
- 20 ampl=1 APeak amplitude of sinusoidal waveform.
- 21 freq=0 HzFrequency of sinusoidal waveform.
- 22 sinephase=0 °Phase of sinusoid when t=delay.
- 23 ampl2=1 APeak amplitude of second sinusoidal waveform.
- 24 freq2=0 HzFrequency of second sinusoidal waveform.
- 25 sinephase2=0 °Phase of second sinusoid when t=delay.
- 26 fundname2Name of the fundamental frequency associated with freq2. Must be specified if freq2 is used in a pdisto analysis.
- 27 fmmodindex=0FM index of modulation for sinusoidal waveform.
- 28 fmmodfreq=0 HzFM modulation frequency for sinusoidal waveform.
- 29 ammodindex=0AM index of modulation for sinusoidal waveform.
- 30 ammodfreg=0 HzAM modulation frequency for sinusoidal waveform.
- 31 ammodphase=0 °AM phase of modulation for sinusoidal waveform.
- 32 damp=0 1/sDamping factor for sinusoidal waveform.

Exponential Waveform Parameters

- 33 td1=0 sRise start time for exponential wave.
- 34 taul (s) Rise time constant for exponential wave.
- 35 td2 (s) Fall start time for exponential wave.

Component Statements Part 2

36 tau2 (s) Fall time constant for exponential wave.

Noise Parameters

- 37 noisefileName of file containing excess spot noise data in the form of frequency-noise pairs.
- 38 noisevec=[...] A²/HzExcess spot noise as a function of frequency in the form of frequency-noise pairs.

Small Signal Parameters

- 39 mag=0 ASmall signal current.
- 40 phase=0 °Small signal phase.
- 41 xfmag=1 A/ATransfer function analysis magnitude.
- 42 pacmag=0 APeriodic AC analysis magnitude.
- 43 pacphase=0 °Periodic AC analysis phase.

Multiplication Factor Parameters

44 m=1Multiplicity factor.

Temperature Effects Parameters

- 45 tc1=0 1/CFirst order temperature coefficient.
- 46 tc2=0 C⁻²Second order temperature coefficient.
- 47 tnom=27 CParameter measurement temperature. Default set by options.

If you do not specify the DC value, it is assumed to be the time=0 value of the waveform.

In DC analyses, the only active parameters are dc, m, and the temperature coefficient parameters. In AC analyses, the only active parameters are m, mag and phase. In transient analyses, all parameters are active except the small signal parameters and the noise parameters. The type parameter selects which type of waveform is generated. You may

Component Statements Part 2

specify parameters for more than one waveform type, and use the alter statement to change the waveform type between analyses.

A vector of time-value pairs describes the piecewise linear waveform. As an alternative, you can read the waveform from a file. In this case, you give time-value pairs one pair per line with a space or tab between the time and the value.

If you set allbrkpts to yes, you force the simulator to place time points at each point specified in a PWL waveform during a transient analysis. This can be very expensive for waveforms with many points. If you set allbrkpts to no, Spectre inspects the waveform, looking for abrupt changes, and forces time points only at those changes.

The PWL waveform is periodic if you specify <code>pwlperiod</code>. If the value of the waveform specified is not exactly the same at both its beginning its end, then you must provide a nonzero value <code>twidth</code>. Before repeating, the waveform changes linearly in an interval of <code>twidth</code> from its value at (<code>period-twidth</code>) to its value at the beginning of the waveform. Thus <code>twidth</code> must always be less than <code>period</code>.

You can give the excess noise of the source as a file or specify it with a vector of frequencynoise pairs. For a file, give the frequency-noise pairs one pair per line with a space or tab between the frequency and noise values.

Operating-Point Parameters

- 1 i (A) Current through the source.
- 2 v (V) Voltage across the source.
- 3 pwr (W) Power dissipation.

Parameter Index

allbrkpts	I-16	freq I-21	phase I-40	td1 I-33
ammodfreq	I-30	freq2 I-24	pwlperiod I-17	td2 I-35
${\tt ammodindex}$	I-29	fundname I-3	pwr OP-3	tnom I-47
ammodphase	T-31	fundname2 T-26	rise T-8	twidth T-18

Component Statements Part 2

ampl	I-20	i OP-1	scale I-14	type I-2
ampl2	I-23	m I-44	sinedc I-19	v OP-2
damp	I-32	mag I-39	sinephase I-22	val0 I-5
dc I	-1	noisefile I-37	sinephase2 I-25	val1 I-6
delay	I-4	noisevec I-38	stretch I-15	wave I-12
fall	I-9	offset I-13	tau1 I-34	width I-10
file	I-11	pacmag I-42	tau2 I-36	xfmag I-41
fmmodf	req I-28	pacphase I-43	tc1 I-45	
fmmodi	ndex I-27	period I-7	tc2 I-46	

Junction Field Effect Transistor (jfet)

Description

The JFET model is derived from the FET model of Shichman and Hodges. JFETs require that you use a model statement.

This device is supported within altergroups.

Sample Instance Statement

```
jf1 (net1 net2 0) jmod area=1
```

Sample Model Statement

model jmod jfet beta=9e-5 lambda=0 type=n vt0=-18.7 rd=10 rs=10 cgs=1.3e-13 pb=0.65

Instance Definition

```
Name d g s [b] ModelName parameter=value ...
```

You do not have to specify the back gate terminal when you use the four-terminal model. If left unspecified, the substrate is connected to ground.

Instance Parameters

- 1 area=1Junction area factor.
- 2 m=1Multiplicity factor.
- 3 region=triodeEstimated operating region.

Possible values are off, triode, sat, subth, or breakdown.

Component Statements Part 2

Model Definition

model modelName jfet parameter=value ...

Model Parameters

Device Type Parameters

1 type=nTransistor type.

Possible values are n or p.

Drain Current Model Parameters

- 2 level=1Drain current model level selector.
- 3 vto=-2 vPinchoff voltage.
- 4 beta=0.0001 A/V²Transconductance parameter.
- 5 lambda=0 1/VChannel length modulation parameter.
- 6 lambda1=0 1/VGate dependence of channel length modulation parameter.
- 7 np=2Power-law exponent.
- 8 alpha=2Triode-to-saturation transition parameter.
- 9 io=0 ASubthreshold current parameter.
- 10 ns=1Subthreshold swing parameter.
- 11 ai=0 1/VImpact ionization current coefficient.
- 12 bi=0 VImpact ionization current exponent.

Four Terminal Threshold Voltage Parameters

- 13 vtop=0.6 vBack gate to channel junction potential.
- 14 vtos=1.2 vThreshold voltage slope.
- 15 vtoe=0.33Threshold voltage exponent.

Component Statements Part 2

16 vtoc=-3.3 vThreshold voltage constant.

Parasitic Resistance Parameters

- 17 rd=0 Ω Drain resistance (/area).
- 18 rs=0 Ω Source resistance (/area).
- 19 rg=0 Ω Gate resistance (/area).
- 20 rb=0 Ω Back gate resistance (/area).
- 21 minr=0.1 Ω Minimum source/drain/gate resistance.

Junction Diode Model Parameters

- 22 is=1e-14 AGate saturation current (*area).
- 23 n=1Emission coefficient for G-D and G-S junctions.
- 24 imelt=\imaxA'Explosion current (*area).
- 25 dskip=yesUse simple piece-wise linear model for diode currents below 0.1*iabstol. Possible values are no or yes.

Junction Capacitance Model Parameters

- 26 tt=0 sTransit time.
- 27 cgs=0 FGate-source zero-bias junction capacitance (*area).
- 28 cgd=0 FGate-drain zero-bias junction capacitance (*area).
- 29 mj=1/2Junction grading coefficient.
- 30 pb=1 vGate-junction potential.
- 31 fc=0.5Junction capacitor forward-bias threshold.

Component Statements Part 2

Four Terminal Junction Parameters

- 32 isb=1e-14 ABack gate-saturation current (*area).
- 33 nb=1Emission coefficient for back gate-junctions.
- 34 cgbs=0 FBack gate-source zero-bias junction capacitance (*area).
- 35 cgbd=0 FBack gate-drain zero-bias junction capacitance (*area).
- 36 mjb=1/2Back gate-junction grading coefficient.
- 37 pbb=1 vBack gate-junction potential.

Temperature Effect Parameters

- 38 tnom (C) Parameters measurement temperature. Default set by options.
- 39 trise=0 CTemperature rise from ambient.
- 40 xti=3Temperature exponent for effect on is.
- 41 tlev=0DC temperature selector.
- 42 tlevc=0AC temperature selector.
- **43** eg=1.12452 v**Energy band gap**.
- 44 gap1=7.02e-4 V/CBand gap temperature coefficient.
- 45 gap2=1108 CBand gap temperature offset.
- 46 tcv=0 1/cThreshold voltage temperature coefficient.
- 47 bto=0 cTransconductance parameter temperature offset.
- 48 bte=0Transconductance parameter temperature exponent.
- 49 lto=0 CChannel length modulation parameters temperature offset.
- 50 lte=0Channel length modulation parameters temperature exponent.
- 51 tc1=0 1/CLinear temperature coefficient for parasitic resistors.

Component Statements Part 2

52 tc2=0 C^{-2} Quadratic temperature coefficient for parasitic resistors.

Operating Region Warning Control Parameters

- 53 alarm=noneForbidden operating region.
 - Possible values are none, off, triode, sat, subth, or rev.
- 54 imax=1 AMaximum allowable current (*area).
- 55 by j=∞ VJunction reverse breakdown voltage.

Noise Parameters

- 56 kf=0Flicker noise (1/f) coefficient.
- 57 af=1Flicker noise (1/f) exponent.
- 58 kfd=0Flicker noise (1/f) coefficient for gate diodes.
- 59 afg=1Flicker noise (1/f) exponent for gate diodes.

Imax and Imelt

The imax parameter aids convergence and prevents numerical overflow. The junction characteristics of the device are accurately modeled for current up to imax. If imax is exceeded during iterations, the linear model is substituted until the current drops below imax or until convergence is achieved. If convergence is achieved with the current exceeding imax, the results are inaccurate, and Spectre prints a warning.

A separate model parameter, imelt, is used as a limit warning for the junction current. This parameter can be set to the maximum current rating of the device. When any component of the junction current exceeds imelt, note that base and collector currents are composed of many exponential terms, Spectre issues a warning and the results become inaccurate. The junction current is linearized above the value of imelt to prevent arithmetic exception, with the exponential term replaced by a linear equation at imelt.

The by parameter is used to detect the junction breakdown only. The breakdown currents of the junctions are not modeled.

Component Statements Part 2

Operating-Point Parameters

1 type=nTransistor type.

Possible values are n or p.

2 region=triodeEstimated operating region.

Possible values are off, triode, sat, subth, or breakdown.

- 3 ids (A) Resistive drain current.
- 4 vgs (V) Gate-source voltage.
- 5 vds (V) Drain-source voltage.
- 6 vth (V)Threshold at op point.
- 7 vdsat (V) Drain saturation voltage.
- 8 qm (S) Common-source transconductance.
- 9 gds (S) Common-source output conductance.
- 10 cgs (F) Gate-source capacitance.
- 11 cgd (F) Gate-drain capacitance.
- 12 ig (A) Resistive gate current.
- 13 pwr (W) Power at op point.
- 14 qd (V) Threshold at op point.
- 15 qg (V) Threshold at op point.
- 16 qs (V) Threshold at op point.
- 17 qb (V) Threshold at op point.

Parameter Index

In the following index, $\ \ \square$ refers to instance parameters, $\ \ \square$ refers to the model parameters section, $\ \square$ refers to the output parameters section, and $\ \square$ refers to the operating point parameters section. The number indicates where to look in the appropriate section to find the

Component Statements Part 2

description for that parameter. For example, a reference of M-35 means the 35th model parameter.

af M-57	gap1 M-44	mj M-29	tc2 M-52
afg M-59	gap2 M-45	mjb M-36	tcv M-46
ai M-11	gds OP-9	n M-23	tlev M-41
alarm M-53	gm OP-8	nb M-33	tlevc M-42
alpha M-8	ids OP-3	np M-7	tnom M-38
area I-1	ig OP-12	ns M-10	trise M-39
beta M-4	imax M-54	pb M-30	tt M-26
bi M-12	imelt M-24	pbb M-37	type M-1
bte M-48	io M-9	pwr OP-13	type OP-1
bto M-47	is M-22	qb OP-17	vds OP-5
bvj M-55	isb M-32	qd OP-14	vdsat OP-7
cgbd M-35	kf M-56	qg OP-15	vgs OP-4
cgbs M-34	kfd M-58	qs OP-16	vth OP-6
cgd OP-11	lambda M-5	rb M-20	vto M-3
cgd M-28	lambdal M-6	rd M-17	vtoc M-16
cgs M-27	level M-2	region OP-2	vtoe M-15
cgs OP-10	lte M-50	region I-3	vtop M-13
dskip M-25	lto M-49	rg M-19	vtos M-14
eg M-43	m I-2	rs M-18	xti M-40
fc M-31	minr M-21	tc1 M-51	

Junction Capacitor (juncap)

Description

The juncap model is intended to describe the behavior of the diodes that are formed by the source, drain or well-to-bulk junctions in MOS devices. It is described in the Philips MOST Modelbook (Dec.93) as JUNCAP model. Information on how to obtain this document can be found on Source Link by searching for Philips.

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In extension to the modelbook description a minimum conductance gmin is inserted between the juncap nodes, to aid convergence. The value of gmin is set by an options statement, default = 1e-12 S.

The imax parameter is used to aid convergence and to prevent numerical overflow. The junction characteristics of the junction capacitor are accurately modeled for currents up to

Component Statements Part 2

imax. For currents above imax, the junction is modeled as a linear resistor and a warning is printed.

This device is supported within altergroups.

This device is dynamically loaded from the shared object /vobs/spectre_dev/tools.sun4v/spectre/lib/cmi/2.0.doc/libphilips.so

Sample Instance Statement

c2 (1 2) capmod ab=7e-12 lg=5e-6 region=rev

Sample Model Statement

model capmod juncap type=n cjbr=0.2 cjgr=0.2 cjsr=0.2 tref=25 jsgbr=2e-3 jsdbr=0.28e-3 jsggr=1e-5 jsdgr=0.33e-6 vdsr=0.8 vdgr=0.8 vdbr=0.8

Instance Definition

Name n [b] ModelName parameter=value ...

Instance Parameters

1 ab=1.0 $scale^2 m^2$

Diffusion area. Scale set by option scale.

- 2 ls=1.0 scale mLength of the sidewall of the diffusion area ab which is not under the gate. Scale set by option scale.
- 3 lg=1.0 scale mLength of the sidewall of the diffusion area ab which is under the gate. Scale set by option scale.
- 4 m=1.0Multiplicity factor.
- 5 region=revEstimated DC operating region, used as a convergence aid.
 Possible values are fwd or rev.

Model Definition

model modelName juncap parameter=value ...

Component Statements Part 2

Model Parameters

Structural parameters

1 type=nType of the juncap device.

Possible values are n or p.

- 2 vb (V) Not used for juncap model.
- 3 by (V) Alias of vb.
- 4 levelNot used for juncap model.

Current parameters

5 jsgbr=1.0e-3 A/m^2

Bottom saturation-current density due to electron-hole generation at reference voltage.

6 jsdbr=1.0e-3 A/m^2

Bottom saturation-current density due to diffusion from back contact.

- 7 jsgsr=1.0e-3 A/mSidewall saturation-current density due to electron-hole generation at reference voltage.
- 8 jsdsr=1.0e-3 A/mSidewall saturation-current density due to diffusion from back contact.
- 9 jsggr=1.0e-3 A/mGate edge saturation-current density due to electron-hole generation at reference voltage.
- 10 jsdgr=1.0e-3 A/mGate edge saturation-current density due to diffusion from back contact.
- 11 imax=1.0 AExplosion current.

Temperature effects parameters

12 dta=0.0 KTemperature offset of the juncap element with respect to ambient temperature.

Component Statements Part 2

- 13 trise=0.0 KAlias of dta.
- 14 tr (C) Temperature at which the parameters have been determined. Default set by option tnom.
- 15 tref (C) Alias of tr. Default set by option tnom.
- 16 tnom (C) Alias of tr. Default set by option tnom.

Junction capacitance parameters

- 17 cjbr=1.0e-12 F/m²
 Bottom junction capacitance at reference voltage.
- 18 cjsr=1.0e-12 F/mSidewall junction capacitance at reference voltage.
- 19 cjgr=1.0e-12 F/mGate edge junction capacitance at reference voltage.

Emission coefficient parameters

- 20 nb=1.0Emission coefficient of the bottom forward current.
- 21 ns=1.0Emission coefficient of the sidewall forward current.
- 22 ng=1.0Emission coefficient of the gate-edge forward current.

Voltage parameters

- 23 vr=0.0 vVoltage at which parameters have been determined.
- 24 vdbr=1.0 vDiffusion voltage of the bottom junction at reference temperature.
- 25 vdsr=1.0 vDiffusion voltage of the sidewall junction at reference temperature.
- 26 vdgr=1.0 vDiffusion voltage of the gate edge junction at reference temperature.

Grading coefficient parameters

- 27 pb=0.4Bottom-junction grading coefficient.
- 28 ps=0.4Sidewall-junction grading coefficient.

Component Statements Part 2

29 pg=0.4Gate edge-junction grading coefficient.

Output Parameters

- 1 cjb (F) Capacitance of bottom area ab.
- 2 cjs (F) Capacitance of locos-edge 1s.
- 3 cjg (F) Capacitance of gate-edge lg.
- 4 isdb (A) Diffusion saturation-current of bottom area ab.
- 5 isds (A) Diffusion saturation-current of locos-edge 1s.
- 6 isdg (A) Diffusion saturation-current of gate-edge lg.
- 7 isgb (A) Generation saturation-current of bottom area ab.
- 8 isgs (A) Generation saturation-current of locos-edge 1s.
- 9 isgg (A) Generation saturation-current of gate-edge lg.
- 10 vdb (V) Diffusion voltage of bottom area ab.
- 11 vds (V) Diffusion voltage of locos-edge 1s.
- 12 vdg (V) Diffusion voltage of gate-edge lg.

Operating-Point Parameters

- 1 \vee (\vee) Diode bias voltage (\vee = \vee va \vee k).
- 2 i (A) Total resistive current from anode to cathode (i = ia = -ik).
- 3 gm (S) Total differential conductance.
- 4 q (Coul) Total junction charge (q = qa = -qk).
- 5 c (F) Total capacitance.
- 6 pwr (W) Power.

Component Statements Part 2

Parameter Index

ab I-1	isdb	0-4	lg I-3	tr M-14
bv M-3	isdg	0-6	ls I-2	tref M-15
c OP-5	isds	0-5	m I-4	trise M-13
cjb 0-1	isgb	0-7	nb M-20	type M-1
cjbr M-17	isgg	0-9	ng M-22	v OP-1
cjg 0-3	isgs	0-8	ns M-21	vb M-2
cjgr M-19	jsdbr	M-6	pb M-27	vdb 0-10
cjs 0-2	jsdgr	M-10	pg M-29	vdbr M-24
cjsr M-18	jsdsr	M-8	ps M-28	vdg 0-12
dta M-12	jsgbr	M-5	pwr OP-6	vdgr M-26
gm OP-3	jsggr	M-9	q OP-4	vds 0-11
i OP-2	jsgsr	M-7	region I-5	vdsr M-25
imax M-11	level	M-4	tnom M-16	vr M-23

MISN Field Effect Transistor (misnan)

Description

The MISN model is formulated in terms of solutions for the boundary surface potentials of the channel and has the inherent property of continuous modeling. It is an inhouse MOSFET model of NORTEL. The MISN model requires a model statement.

This device is not supported within altergroup.

This device is dynamically loaded from the shared object /vobs/spectre_dev/tools.sun4v/spectre/lib/cmi/2.0.doc/libnortel.so

Sample Instance Statement

mn1 (1 2 0 0) nch w=1.5u l=1u ad=2.6p as=2.6p pd=6.6p ps=6.6p

Component Statements Part 2

Sample Model Statement

model nch misnan type=n cox=4.4e-6 dop=2e17 phi=-0.43 xj=0.23 scrat=1.4 mu=400 rws=250 is=0.98e-13 cjgo=2e-13 noimdl=1

Instance Definition

Name d g s b ModelName parameter=value ...

Instance Parameters

- 1 w=1e-5 mChannel width.
- 2 1=3e-6 mChannel length.
- 3 as=3e-11 m²Area of source diffusion.
- 4 ad=3e-11 m²Area of drain diffusion.
- 5 ps=2.6e-5 mPerimeter of source diffusion.
- 6 pd=2.6e-5 mPerimeter of drain diffusion.
- 7 m=1Multiplicity factor (number of MOSFETs in parallel).
- 8 region=triodeEstimated DC operating region, used as a convergence aid.

 Possible values are off, triode, sat, or subthresh.

Model Definition

model modelName misnan parameter=value ...

Model Parameters

Intrinsic MOS parameters

1 type=nTransistor gender.

Possible values are n or p.

Component Statements Part 2

 $2 \cos 4.309e - 7 F/cm^2$

Gate oxide cap per unit area.

 $3 \text{ dop=1.665e17 cm}^{-3}$

Substrate doping. Default = 2.58e17 for pmos.

- 4 phi=-0.55 vGate Fermi potential.
- $5 \text{ qss} = -5.078e 8 \text{ Coul/cm}^2$

Effective gate oxide charge per unit area. Default = 1.05e-8 for pmos.

6 dopldd=3.2e17 cm^{-3}

LDD region doping concentration. Default = 3.2e19 for pmos.

Geometry parameters

- 7 lvar=0 µmGate length correction.
- 8 wvar=0 µmGate width correction.
- 9 dls=0.0273 μmSideway diffusion length of source region. Default = 0.037 for pmos.
- 10 dld=0.0273 μmSideway diffusion length of drain region. Default = 0.037 for pmos.
- 11 d1=0.07 μ mSideways diffusion length of S/D regions. Default = 0.04 for pmos.
- 12 dw=0.032 μmElectrical channel width correction. Default = 0.018 for pmos.

Threshold voltage parameters

- 13 $xj=0.24 \mu m$ Source/drain-to-substrate junction depth. Default = 0.31 for pmos.
- 14 scrat=1.5Short channel threshold voltage ratio. Default = 0.7 for pmos.
- 15 scind=1.45Short channel threshold voltage index. Default = 1.42 for pmos.
- 16 ncrat=0.17Narrow channel threshold voltage ratio. Default = 0.095 for pmos.
- 17 athp=7.5Factor controlling peak magnitude effect. Default = 3.5 for pmos.

Component Statements Part 2

- 18 athl=2e4 1/cmFactor controlling channel length dependence effect. Default = 4e4 for pmos.
- 19 athb=-1.7e-3Factor controlling substrate bias dependence effect. Default = -6e-3.

Mobility parameters

- 20 mu=577 cm²/V sLow-field carrier mobility. Default = 120 for pmos.
- 21 mutxp=1.72Temperature coefficient for the carrier mobility. Default = 1.01 for pmos.
- 22 kg=1.4e-7 cm/VGate field factor. Default = 1.685e-7.
- 23 v0=3.21e7 cm/sScattering limited velocity. Default = 2.45e7.
- 24 v0txp=-6.3Temp coefficient for scattering limited velocity. Default = -5 for pmos.
- 25 find=1.25Field mobility index factor. Default = 1.9 for pmos.
- 26 gfc=9.1e-10Gate voltage dependence of enhanced gate-field scattering. Default = 1.05e-10 for pmos.
- 27 gfcm=3e-5Drain voltage dependence of enhanced gate-field scattering. Default = 2.3e-3 for pmos.
- 28 gfmb=1.45e-3Factor controlling substrate bias dependence of enhanced gate-field scattering. Default 3.3e-3 for pmos.
- 29 csf=1.06e-11Drain voltage dependence of coulombic scattering. Default = 1.35e-12 for pmos.
- 30 csfb=1.61e-3Body voltage dependence of coulombic scattering. Default = 8.5e-3 for pmos.

Saturation parameters

- 31 dprat=15Drain region/channel doping ration. Default = 2 for pmos.
- 32 satpr=0.2Saturation region shaping factor. Default = 1.0 for pmos.
- 33 sbdr=0.3535534Primary parameter controlling the onset of saturation.

Component Statements Part 2

34 sadr=5Secondary parameter controlling the onset of saturation.

Capacitance parameters

35 sccf=0.25Inner fringing factor for the N+ S/D.

Extrinsic parameters

- 36 rws=480 Ω µmSource series resistance. Default = 1180 for pmos.
- 37 rwd=480 Ω µmDrain series resistance. Default = 1180 for pmos.
- 38 rsd=-1 Ω µmDrain/source series resistance. Negative value for asymmetrical devices.
- 39 rgsh=0 Ω µmGate series resistance.
- 40 wtgf=0.28 μmWidth of transition from gate to field oxide under poly.
- 41 cpts=5.7e-9 F/cm²

Poly-to-substrate capacitance per unit area.

- 42 cgfrs=1e-12 F/cmGate-source overlap fringing field capacitance.
- 43 cgfrd=1e-12 F/cmGate-drain overlap fringing field capacitance.
- 44 cgfr=1.36e-12 F/cm

Gate overlap fringing field capacitance.

Junction parameters

45 is=1.02e-12 A/cm^2

Sat current per unit area of S/D region-injection component. Default = 9.21e-13 for pmos.

- 46 isg=1e-20 A/cmSat current per unit length of gate oxide periphery-injection component. Default = 1.17e-20.
- 47 isf=1e-20 A/cmSat current per unit length of field oxide periphery-injection component. Default = 1.17e-20.

Component Statements Part 2

- 48 iq=1.31e-10 A/cm^2
- Sat current per unit area of S/D region-generation component. Default = 8.27e-10.
- 49 igg=6.99e-14 A/cmSat current per unit length of gate oxide periphery-generation/recombination component. Default = 6.47e-14.
- 50 igf=6.99e-14 A/cmSat current per unit length of field oxide periphery-generation/recombination component. Default = 6.47e-14.
- $51 \text{ cjo} = 9.39e 8 \text{ F/cm}^2$

Zero bias junction capacitance per unit area. Default = 1.273e-7 for pmos.

- 52 ena=0.387Junction capacitance coefficient for the area component. Default = 0.472 for pmos.
- 53 cjgo=2.085e-12 F/cm

Zero bias junction cap per unit length of gate oxide periphery. Default = 1.864e-12 for pmos.

- 64 eng=0.322 Junction cap coefficient for gate oxide periphery component. Default = 0.334 for pmos.
- 55 cjfo=3.037e-12 F/cm

Zero bias junction cap per unit length of field oxide periphery. Default = 3.077e-12 for pmos.

56 enf=0.322Junction cap coefficient for field oxide periphery component. Default = 0.334 for pmos.

Noise parameters

- 57 noimdl=1Noise model selector.
- 58 nt=1.6e10 cm $^{-2}$ Surface trap density. Default = 4e9 for pmos.
- 59 nttx=-4Surface trap density temperature coefficient.
- 60 fidx=0.85Flicker noise frequency coefficient.
- 61 beta=1Thermal noise proportional constant.

Component Statements Part 2

- 62 sgma=3e-16Capture cross section. Default = 3e-15 for pmos.
- 63 xtau=1e-81/E depth.
- 64 wbar=1Barrier height for tunneling. Default = 4 for pmos.
- 65 dept=3e-7Depth of trap distribution.

Operating-Point Parameters

- 1 vgs (V) Gate-source voltage.
- 2 vds (V) Drain-source voltage.
- 3 vbs (V) Bulk-source voltage.
- 4 id (A) Drain current.
- 5 vth (V) Threshold voltage.
- 6 vdsat (V) Drain-source saturation voltage.
- 7 gm (S) Common-source transconductance.
- 8 gd (S) Common-source output conductance.
- 9 gs (S) Body-transconductance.
- 10 gmb (S) Body transconductance.
- 11 gjs (S) Drain-bulk junction conductance.
- 12 ibs (A) Drain-bulk junction current.
- 13 gjd (S) Source-bulk junction conductance.
- 14 ibd (A) Source-bulk junction current.
- 15 qgg (Coul) Gate charge.
- 16 qss (Coul) Source charge.
- 17 gdd (Coul) Drain charge.

Component Statements Part 2

18 qbb (Coul) Bulk charge.

19 cgg (F) Cgg.

20 cgs (F) Cgs.

21 cgd (F) Cgd.

22 cgb (F) Cgb.

23 csg (F)Csg.

24 css (F) Css.

25 csd (F) Csd.

26 csb (F) Csb.

27 cdg (F) Cdg.

28 cds (F) Cds.

29 cdd (F) Cdd.

30 cdb (F) Cdb.

31 cbg (F) Cbg.

32 cbs (F)Cbs.

33 cbd (F) Cbd.

34 cbb (F)Cbb.

Parameter Index

Component Statements Part 2

description for that parameter. For example, a reference of M-35 means the 35th model parameter.

ad	I-4	csd OP-25	ibd OP-14	region I-8
as	I-3	csf M-29	ibs OP-12	rgsh M-39
athb	M-19	csfb M-30	id OP-4	rsd M-38
athl	M-18	csg OP-23	ig M-48	rwd M-37
athp	M-17	css OP-24	igf M-50	rws M-36
beta	M-61	dept M-65	igg M-49	sadr M-34
cbb	OP-34	dl M-11	is M-45	satpr M-32
cbd	OP-33	dld M-10	isf M-47	sbdr M-33
cbg	OP-31	dls M-9	isg M-46	sccf M-35
cbs	OP-32	dop M-3	kg M-22	scind M-15
cdb	OP-30	dopldd M-6	l I-2	scrat M-14
cdd	OP-29	dprat M-31	lvar M-7	sgma M-62
cdg	OP-27	dw M-12	m I-7	type M-1
cds	OP-28	ena M-52	mu M-20	v0 M-23
cgb	OP-22	enf M-56	mutxp M-21	v0txp M-24
cgd	OP-21	eng M-54	ncrat M-16	vbs OP-3
cgfr	M - 44	fidx M-60	noimdl M-57	vds OP-2
cgfrd	M - 43	find M-25	nt M-58	vdsat OP-6
cgfrs	M - 42	gd OP-8	nttx M-59	vgs OP-1
cgg	OP-19	gfc M-26	pd I-6	vth OP-5
cgs	OP-20	gfcm M-27	phi M-4	w I-1
cjfo	M-55	gfmb M-28	ps I-5	wbar M-64
cjgo	M-53	gjd OP-13	qbb OP-18	wtgf M-40
cjo	M-51	gjs OP-11	qdd OP-17	wvar M-8
cox	M-2	gm OP-7	qgg OP-15	xj M-13
cpts	M - 41	gmb OP-10	qss M-5	xtau M-63
csb	OP-26	gs OP-9	qss OP-16	

MOS Level-0 Transistor (mos0)

Description

The MOS0 model is a simplified MOS level-1 model. The MOS0 DC drain current model is different from the Shichman and Hodges model because body effects are not modeled. The intrinsic MOS gate capacitances are replaced by the following linear overlap capacitances:

Gate to source/drain (capmod = overlap)

Gate to bulk (capmod = bulk)

Component Statements Part 2

Gate, source, and drain to ground (capmod = gnd)

MOS0 is usually used as a MOS switch. This model recognizes all the MOS and BSIM instance parameters but only uses 1 and w, ignoring all other parameters. MOS0 transistors require that you use a model statement.

This device is not supported within altergroup.

Sample Instance Statement

mp1 (0 1 2 2) pchmod0 1=2u w=30u ad=120p as=75p pd=36u ps=6u

Sample Model Statement

model pchmod0 mos0 type=p vto=-0.683 tox=0.21e-7 ld=0.45e-6 tnom=27

Instance Definition

Name d g s b ModelName parameter=value ...

Instance Parameters

- 1 w (m) Channel width.
- 2 1 (m) Channel length.
- 3 m=1Multiplicity factor (number of MOSFETs in parallel).

Model Definition

model modelName mos0 parameter=value ...

Model Parameters

Device Type Parameters

1 type=nTransistor type.

Possible values are n or p.

Drain Current Model Parameters

2 vto=0 vThreshold voltage at zero body bias.

Component Statements Part 2

3 kp=2.0718e-5 A/V^2

Transconductance parameter.

- 4 lambda=0.02 1/VChannel length modulation parameter.
- 5 tox=1e-7 mGate oxide thickness.
- 6 1d=0 mLateral diffusion.
- 7 wd=0 mField-oxide encroachment.

Charge Model Selection Parameters

8 capmod=gndIntrinsic charge model.

Possible values are none, overlap, bulk, or gnd.

Temperature Parameters

- 9 tnom (C) Parameters measurement temperature. Default set by options.
- 10 trise=0 cTemperature rise from ambient.

Default Device Parameters

- 11 w=3e-6 mDefault channel width.
- 12 1=3e-6 mDefault channel length.

Operating-Point Parameters

1 type=nTransistor type.

Possible values are n or p.

- 2 id (A) Resistive drain current.
- 3 vgs (V) Gate-source voltage.
- 4 vds (V) Drain-source voltage.
- 5 vbs (V) Bulk-source voltage.

Component Statements Part 2

- 6 vth (V)Threshold voltage.
- 7 vdsat (V) Drain-source saturation voltage.
- 8 gm (S) Common-source transconductance.
- 9 gds (S) Common-source output conductance.
- 10 cgs (F) Gate-source capacitance.
- 11 cgd (F) Gate-drain capacitance.
- 12 cgate (F) Gate-Ground capacitance.
- 13 ron (Ω) On-resistance.
- 14 pwr (W) Power at op point.

Parameter Index

capm	od M-8	l I-2	tox M-5	vth	OP-6
cgat	e OP-12	1 M-12	trise M-10	vto	M-2
cgd	OP-11	lambda M-4	type OP-1	W	M-11
cgs	OP-10	ld M-6	type M-1	W	I-1
gds	OP-9	m I-3	vbs OP-5	wd	M-7
gm	OP-8	pwr OP-14	vds OP-4		
id	OP-2	ron OP-13	vdsat OP-7		
kp	M-3	tnom M-9	vgs OP-3		

Component Statements Part 2

MOS Level-1 Transistor (mos1)

Description

The MOS1 model is derived from the FET model of Shichman and Hodges. The velocity saturation and the mobility variation effects can also be incorporated into MOS1. Three charge models are available. MOS1 transistors require that you use a model statement.

This device is supported within altergroups.

Sample Instance Statement

nch1 (1 2 0 0) nchmod1 l=2u w=15u ad=60p as=37.5p pd=23u ps=6u

Sample Model Statement

model nchmod1 mos1 vto=0.78 gamma=0.56 kp=0.8675e-4 tox=0.21e-7 nsub=0.21e17 ld=0.55e-6 capmod=yang vmax=4e5 theta=0.19 cbs=11e-15 cbd=10e-15 lambda=0.1

Instance Definition

Name d g s b ModelName parameter=value ...

Instance Parameters

- 1 w (m) Channel width.
- 2 1 (m) Channel length.
- 3 as (m^2) Area of source diffusion.
- 4 ad (m²) Area of drain diffusion.
- 5 ps (m) Perimeter of source diffusion.
- 6 pd (m) Perimeter of drain diffusion.
- 7 nrd (m/m) Number of squares of drain diffusion.
- 8 nrs (m/m) Number of squares of source diffusion.
- 9 ld (m) Length of drain diffusion region.

Component Statements Part 2

- 10 ls (m) Length of source diffusion region.
- 11 m=1Multiplicity factor (number of MOSFETs in parallel).
- 12 region=triodeEstimated operating region.

Possible values are off, triode, sat, subth, or breakdown.

- 13 triseTemperature rise from ambient.
- 14 degradation=noHot-electron degradation flag.

 Possible values are no or yes.

Model Definition

model modelName mos1 parameter=value ...

Model Parameters

Device Type Parameters

1 type=nTransistor type.

Possible values are n or p.

Drain Current Model Parameters

- 2 vto=0 vThreshold voltage at zero body bias.
- $3 \text{ kp}=2.0718e-5 \text{ A/V}^2$

Transconductance parameter.

- 4 lambda=0 1/VChannel length modulation parameter.
- 5 phi=0.7 vSurface potential at strong inversion.
- 6 gamma=0 \sqrt{V} Body-effect parameter.
- 7 uo=600 cm²/V sCarrier surface mobility.
- 8 vmax=∞ m/sCarrier saturation velocity.
- 9 theta=0 1/VMobility modulation coefficient.

Component Statements Part 2

Process Parameters

- 10 $nsub=1.13e16 cm^{-3}$
- Channel doping concentration.
- 11 nss=0 cm⁻²Surface state density.
- 12 nfs=0 cm⁻²Fast surface state density.
- 13 tpg=+1Type of gate (+1 = opposite of substate, -1 = same as substate, 0 = aluminum).
- 14 ld=0 mLateral diffusion.
- 15 wd=0 mField-oxide encroachment.
- 16 xw=0 mWidth variation due to masking and etching.
- 17 x1=0 mLength variation due to masking and etching.
- 18 tox=1e-7 mGate oxide thickness.

Impact Ionization Parameters

- 19 ai0=0 1/VImpact ionization current coefficient.
- 20 lai0=0 μ m/VLength sensitivity of ai0.
- 21 wai0=0 µm/VWidth sensitivity of ai0.
- 22 bi0=0 VImpact ionization current exponent.
- 23 lbi0=0 μm VLength sensitivity of bi0.
- 24 wbi0=0 μm vWidth sensitivity of bi0.

Overlap Capacitance Parameters

- 25 cgso=0 F/mGate-source overlap capacitance.
- 26 cgdo=0 F/mGate-drain overlap capacitance.
- 27 cgbo=0 F/mGate-bulk overlap capacitance.

Component Statements Part 2

28 meto=0 mMetal overlap in fringing field.

Charge Model Selection Parameters

- 29 capmod=bsimIntrinsic charge model.

 Possible values are none, meyer, yang, or bsim.
- 30 xpart=1Drain/source channel charge partition in saturation for BSIM charge model, use
- 31 xqc=0Drain/source channel charge partition in saturation for charge models, e.g. use 0.4 for 40/60, 0.5 for 50/50, 0 for 0/100.

0.0 for 40/60, 0.5 for 50/50, or 1.0 for 0/100.

Parasitic Resistance Parameters

- 32 rs=0 Ω Source resistance.
- 33 rd=0 Ω Drain resistance.
- 34 rss=0 Ω mScalable source resistance.
- 35 rdd=0 Ω mScalable drain resistance.
- 36 rsh=0 Ω/sqr Source/drain diffusion sheet resistance.
- 37 rsc=0 Ω Source contact resistance.
- 38 rdc=0 Ω Drain contact resistance.
- 39 minr=0.1 Ω Minimum source/drain resistance.
- 40 ldif=0 mLateral diffusion beyond the gate.
- 41 hdif=0 mLength of heavily doped diffusion.
- 42 lgcs=0 mGate-to-contact length of source side.
- 43 lgcd=0 mGate-to-contact length of drain side.
- 44 sc=∞ mSpacing between contacts.

Component Statements Part 2

Junction Diode Model Parameters

- 45 js (A/m²) Bulk junction reverse saturation current density.
- 46 is=1e-14 ABulk junction reverse saturation current.
- 47 n=1Junction emission coefficient.
- 48 dskip=yesUse simple piece-wise linear model for diode currents below 0.1*iabstol. Possible values are no or yes.
- 49 imelt=`imaxA' Explosion current, diode is linearized beyond this current to aid convergence.
- 50 jmelt=`jmaxA/m'²

Explosion current density, diode is linearized beyond this current to aid convergence.

Junction Capacitance Model Parameters

- 51 cbs=0 FBulk-source zero-bias junction capacitance.
- 52 cbd=0 FBulk-drain zero-bias junction capacitance.
- 53 cj=0 F/ m^2 Zero-bias junction bottom capacitance density.
- 54 mj=1/2Bulk junction bottom grading coefficient.
- 55 pb=0.8 vBulk junction built-in potential.
- 56 fc=0.5Forward-bias depletion capacitance threshold.
- 57 cjsw=0 F/mZero-bias junction sidewall capacitance density.
- 58 mjsw=1/3Bulk junction sidewall grading coefficient.
- 59 pbsw=0.8 vSide-wall junction built-in potential.
- 60 fcsw=0.5Side-wall forward-bias depletion capacitance threshold.

Component Statements Part 2

Operating Region Warning Control Parameters

- 61 alarm=noneForbidden operating region.
 - Possible values are none, off, triode, sat, subth, or rev.
- 62 imax=1 AMaximum current, currents above this limit generate a warning.
- 63 jmax=1e8 A/m²Maximum current density, currents above this limit generate a warning.
- 64 bvj=∞ VJunction reverse breakdown voltage.
- 65 vbox=1e9 tox vOxide breakdown voltage.

Temperature Effects Parameters

- 66 tnom (C) Parameters measurement temperature. Default set by options.
- 67 trise=0 CTemperature rise from ambient.
- 68 uto=0 CMobility temperature offset.
- 69 ute=-1.5Mobility temperature exponent.
- 70 tlev=0DC temperature selector.
- 71 tlevc=0AC temperature selector.
- **72** eg=1.12452 VEnergy band gap.
- 73 gap1=7.02e-4 V/CBand gap temperature coefficient.
- 74 gap2=1108 CBand gap temperature offset.
- 75 flex=0Temperature exponent for ucrit.
- 76 lamex=0 1/CTemperature parameter for lambda and kappa.
- 77 trs=0 1/cTemperature parameter for source resistance.
- 78 trd=0 1/cTemperature parameter for drain resistance.
- 79 xti=3Saturation current temperature exponent.

Component Statements Part 2

- 80 ptc=0 V/CSurface potential temperature coefficient.
- 81 tcv=0 V/CThreshold voltage temperature coefficient.
- 82 pta=0 V/CJunction potential temperature coefficient.
- 83 ptp=0 V/CSidewall junction potential temperature coefficient.
- 84 cta=0 1/CJunction capacitance temperature coefficient.
- 85 ctp=0 1/cSidewall junction capacitance temperature coefficient.

Default Instance Parameters

- 86 w=3e-6 mDefault channel width.
- 87 1=3e-6 mDefault channel length.
- 88 as=0 m²Default area of source diffusion.
- 89 ad=0 m²Default area of drain diffusion.
- 90 ps=0 mDefault perimeter of source diffusion.
- 91 pd=0 mDefault perimeter of drain diffusion.
- 92 nrd=0 m/mDefault number of squares of drain diffusion.
- 93 nrs=0 m/mDefault number of squares of source diffusion.
- 94 1dd=0 mDefault length of drain diffusion region.
- 95 lds=0 mDefault length of source diffusion region.

Noise Model Parameters

- 96 noisemod=1Noise model selector.
- 97 kf=0Flicker (1/f) noise coefficient.
- 98 af=1Flicker (1/f) noise exponent.

Component Statements Part 2

- 99 ef=1Flicker (1/f) noise frequency exponent.
- 100 wnoi=le-5 mChannel width at which noise parameters were extracted.

Auto Model Selector Parameters

- 101 wmax=1.0 mMaximum channel width for which the model is valid.
- 102 wmin=0.0 mMinimum channel width for which the model is valid.
- 103 lmax=1.0 mMaximum channel length for which the model is valid.
- 104 lmin=0.0 mMinimum channel length for which the model is valid.

Degradation Parameters

- 105 degramod=spectreDegradation model selector.

 Possible values are spectre or bert.
- 106 degradation=noHot-electron degradation flag.

 Possible values are no or yes.
- 107 dvthc=1 vDegradation coefficient for threshold voltage.
- 108 dvthe=1Degradation exponent for threshold voltage.
- 109 duoc=1 SDegradation coefficient for transconductance.
- 110 duoe=1 Degradation exponent for transconductance.
- 111 crivth=0.1 VMaximum allowable threshold voltage shift.
- 112 criuo=10%Maximum allowable normalized mobility change.
- 113 crigm=10%Maximum allowable normalized transconductance change.
- 114 criids=10%Maximum allowable normalized drain current change.
- 115 wnom=5e-6 mNominal device width in degradation calculation.
- 116 lnom=le-6 mNominal device length in degradation calculation.

Component Statements Part 2

- 117 vbsn=0 vSubstrate voltage in degradation calculation.
- 118 vdsni=0.1 vDrain voltage in Ids degradation calculation.
- 119 vgsni=5 vGate voltage in Ids degradation calculation.
- 120 vdsng=0.1 VDrain voltage in Gm degradation calculation.
- 121 vgsng=5 vGate voltage in Gm degradation calculation.

Spectre Stress Parameters

- 122 esat=1.1e7 V/mCritical field in Vdsat calculation.
- 123 esatg=2.5e6 1/mGate voltage dependence of esat.
- 124 vpg=-0.25Gate voltage modifier.
- 125 vpb=-0.13Gate voltage modifier.
- 126 subc1=2.24e-5Substrate current coefficient.
- 127 subc2=-0.1e-5 1/VSubstrate current coefficient.
- 128 sube=6.4Substrate current exponent.
- 129 strc=1Stress coefficient.
- 130 stre=1Stress exponent.

BERT Stress Parameters

- 131 h0=1Aging coefficient.
- 132 hgd=0 1/VBias dependence of h0.
- 133 m0=1Aging exponent.
- 134 mgd=0 1/VBias dependence of m0.
- 135 ecrit0=1.1e5 V/cmCritical electric field.

Component Statements Part 2

- 136 lecrit0=0 μ m V/cmLength dependence of ecrit0.
- 137 wecrit0=0 μ m V/cmWidth dependence of ecrit0.
- 138 ecritg=0 1/cmGate voltage dependence of ecrit0.
- 139 lecritg=0 μm/cmLength dependence of ecritg.
- 140 wecritg=0 μm/cmWidth dependence of ecritg.
- 141 ecritb=0 1/cmSubstrate voltage dependence of ecrit0.
- 142 lecritb=0 µm/cmLength dependence of ecritb.
- 143 we critb=0 μ m/cmWidth dependence of ecritb.
- 144 lc0=1Substrate current coefficient.
- 145 llc0=0 µmLength dependence of lc0.
- 146 wlc0=0 μ mWidth dependence of lc0.
- 147 lc1=1Substrate current coefficient.
- 148 llc1=0 µmLength dependence of lc1.
- 149 wlc1=0 µmWidth dependence of lc1.
- 150 1c2=1Substrate current coefficient.
- 151 llc2=0 µmLength dependence of lc2.
- **152** wlc2=0 μmWidth dependence of lc2.
- 153 1c3=1Substrate current coefficient.
- 154 llc3=0 µmLength dependence of lc3.
- 155 wlc3=0 µmWidth dependence of lc3.
- 156 1c4=1Substrate current coefficient.
- 157 11c4=0 μmLength dependence of 1c4.

Component Statements Part 2

158 wlc4=0 µmWidth dependence of lc4.

159 1c5=1Substrate current coefficient.

160 11c5=0 µmLength dependence of 1c5.

161 wlc5=0 μmWidth dependence of lc5.

162 1c6=1Substrate current coefficient.

163 llc6=0 µmLength dependence of lc6.

164 wlc6=0 μ mWidth dependence of lc6.

165 lc7=1Substrate current coefficient.

166 llc7=0 μ mLength dependence of lc7.

167 wlc7=0 μ mWidth dependence of lc7.

Imax and Imelt

The imax parameter aids convergence and prevents numerical overflow. The junction characteristics of the device are accurately modeled for current up to imax. If imax is exceeded during iterations, the linear model is substituted until the current drops below imax or until convergence is achieved. If convergence is achieved with the current exceeding imax, the results are inaccurate, and Spectre prints a warning.

A separate model parameter, imelt, is used as a limit warning for the junction current. This parameter can be set to the maximum current rating of the device. When any component of the junction current exceeds imelt, note that base and collector currents are composed of many exponential terms, Spectre issues a warning and the results become inaccurate. The junction current is linearized above the value of imelt to prevent arithmetic exception, with the exponential term replaced by a linear equation at imelt.

Both of these parameters have current density counterparts, jmax and jmelt, that you can specify if you want the absolute current values to depend on the device area.

Auto Model Selection

Many models need to be characterized for different geometries in order to obtain accurate results for model development. The model selector program automatically searches for a

Component Statements Part 2

model with the length and width range specified in the instance statement and uses this model in the simulations.

For the auto model selector program to find a specific model, the models to be searched should be grouped together within braces. Such a group is called a model group. An opening brace is required at the end of the line defining each model group. Every model in the group is given a name followed by a colon and the list of parameters. Also, the four geometric parameters lmax, lmin, wmax, and wmin should be given. The selection criteria to choose a model is as follows:

Then for a given instance

```
M1 1 2 3 4 ModelName w=3 1=1.5
```

the program would search all the models in the model group with the name ModelName and then pick the first model whose geometric range satisfies the selection criteria. In the preceding example, the auto model selector program would choose ModelName.2.

The user must specify both length (I) and width (w) on the device instance line to enable automatic model selection.

Output Parameters

- 1 weff (m) Effective channel width.
- 2 leff (m) Effective channel length.
- 3 rseff (Ω) Effective source resistance.
- 4 rdeff (Ω) Effective drain resistance.
- 5 aseff (m²) Effective area of source diffusion.
- 6 $adeff(m^2)$ Effective area of drain diffusion.
- 7 pseff (m) Effective perimeter of source diffusion.

Component Statements Part 2

- 8 pdeff (m) Effective perimeter of source diffusion.
- 9 isseff (A) Effective source-bulk junction reverse saturation current.
- 10 isdeff (A) Effective drain-bulk junction reverse saturation current.
- 11 cbseff (F) Effective zero-bias source-bulk junction capacitance.
- 12 cbdeff (F) Effective zero-bias drain-bulk junction capacitance.

Operating-Point Parameters

- 1 type=nTransistor type.
- Possible values are n or p.
- 2 region=triodeEstimated operating region.
 - Possible values are off, triode, sat, subth, or breakdown.
- 3 degradation=noHot-electron degradation flag.
 - Possible values are no or yes.
- 4 reversedReverse mode indicator.
 - Possible values are no or yes.
- 5 ids (A) Resistive drain-to-source current.
- 6 vgs (V) Gate-source voltage.
- 7 vds (V) Drain-source voltage.
- 8 vbs (V) Bulk-source voltage.
- 9 vth (V)Threshold voltage.
- 10 vdsat (V) Drain-source saturation voltage.
- 11 gm (S) Common-source transconductance.
- 12 gds (S) Common-source output conductance.
- 13 gmbs (S) Body-transconductance.
- 14 gameff (\sqrt{V}) Effective body effect coefficient.

Component Statements Part 2

15 betaeff (A/V^2) Effective beta.

16 cbd (F) Drain-bulk junction capacitance.

17 cbs (F) Source-bulk junction capacitance.

18 cgs (F) Gate-source capacitance.

19 cgd (F) Gate-drain capacitance.

20 cgb (F) Gate-bulk capacitance.

21 ron (Ω) On-resistance.

22 id (A) Resistive drain current.

23 ibulk (A) Resistive bulk current.

24 pwr (W) Power at op point.

25 gmoverid (1/V)Gm/Ids.

26 isub (A) Substrate current.

27 stressHot-electron stress.

28 age (s) Device age.

29 he_vdsat (V) Hot Electron Vdsat.

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Compact MOS-Transistor Distortion Model (mos1000)

Description

The mos10.00 model is an experimental model based on the thesis of Ronald van Langevelde: "A compact MOSFET Model for Distortion Analysis in Analog Circuit Design", Technische Universiteit Eindhoven, 1998.

Note: In noise analysis, mos10.00 instances will not generate any contribution, since there are no noise sources included (yet) in the mos10.00 model.

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In extension to the description a minimum conductance gmin is inserted between the drain and source node, to aid convergence. The value of gmin is set by an options statement, default = 1e-12 S.

This device is supported within altergroups.

This device is dynamically loaded from the shared object

/vobs/spectre_dev/tools.sun4v/spectre/lib/cmi/2.0.doc/libphilips.so

Instance Definition

```
Name d g s [b] ModelName parameter=value ...
```

Instance Parameters

- 1 w=1.0 scale mDrawn channel width in the lay-out. Scale set by option scale.
- 2 1=1.0 scale mDrawn channel length in the lay-out. Scale set by option scale.
- 3 mult=1Number of devices in parallel.
- 4 area=1Alias of mult.

Component Statements Part 2

- 5 region=triodeEstimated DC operating region, used as a convergence aid.

 Possible values are off, triode, sat, or subth.
- 6 m=1Multiplicity factor.

Model Definition

model modelName mos1000 parameter=value ...

Model Parameters

Device type parameters

1 type=nTransistor gender.

Possible values are n or p.

Geometry Parameters

- 2 ler=1.0e-6 mEffective channel length of the reference transistor.
- 3 wer=1e-6 mEffective channel width of the reference transistor.
- 4 lvar=0.0 mDifference between the actual and the programmed poly-silicon gate length.
- 5 lap=45.0e-9 mEffective channel length reduction per side.
- 6 wvar=-5.0e-9 mDifference between the actual and the programmed field-oxide opening.
- 7 wot=50.0e-9 mEffective channel width reduction per side.

Threshold-Voltage Parameters

- 8 vfbr=-518.9e-03 VFlat-band voltage for reference transistor.
- 9 stvfb=-1.2e-03 V/K

Coefficient of temperature dependence of vfb.

10 slvfb=24.0e-09 V m

Coefficient of length dependence of vfb.

Component Statements Part 2

11 $sl2vfb=-1.1e-15 \ V \ m^2$

Second coefficient of length dependence of vfb.

12 swvfb=4.400e-09 V m

Coefficient of the width dependency of vfb.

13 kor=368.0e-03 \sqrt{V}

Body effect coefficient for the reference transistor.

14 slko= $-8.240e-09 \sqrt{V}$ m

Coefficient of the length dependence of ko.

15 sl2ko=-2.260e-15 \sqrt{V} m²

Second coefficient of the length dependence of ko.

16 swko=5.86e-09 \sqrt{V} m

Coefficient of the width dependence of ko.

17 phibr=0.6 vSurface potential at strong inversion.

Channel-Current Parameters

18 betsq=370.9e-06 A/V^2

Gain factor for an infinite square transistor.

19 etabet=1.6Exponent of the temperature dependence of the gain factor.

20 thesrr=16.10e-3 $1/V^2$

Mobility degradation parameter due to surface roughness scattering.

21 stthesr=0.0 $1/(V^2 K)$

Coefficient of the temperature dependence of thesr.

22 swthesr=0.0 $1/(V^2 m)$

Coefficient of the width dependence of thesr.

23 thephr=0.055 1/VMobility degradation parameter due to phonon scattering.

24 sttheph=0.0 1/(V K)

Coefficient of the temperature dependence of ${\tt theph}.$

Component Statements Part 2

25 swtheph=0.0 1/(V m)

Coefficient of the width dependence of theph.

- 26 etamobr=1.6Effective field parameter for dependence on depletion charge.
- 27 swetamob=0.0 1/mCoefficient of the width dependence of etamobr.
- 28 thersq=0.155 1/VCoefficient of gate voltage independent part of series resistance.
- 29 swther=0.0 1/(V m)

Coefficient of the width dependence of ther.

- 30 ther1=0.0 VNumerator of gate voltage independent part of series resistance.
- 31 ther2=1.0 VDenominator of gate voltage independent part of series resistance.
- 32 thenr=0.480 1/VVelocity saturation parameter due to optical phonon scattering.
- 33 stthen=0.0 1/(V K)

Coefficient of the temperature dependence of then.

34 swthen=0.0 1/(V m)

Coefficient of the width dependence of then.

- 35 thepr=0.0 1/VVelocity saturation parameter due to acoustic phonon scattering.
- 36 stthep=0.0 1/(V K)

Coefficient of the temperature dependence of thep.

37 swthep=0.0 1/(V m)

Coefficient of the width dependence of thep.

- 38 gthep=1.0Velocity saturation factor due to acoustic phonon scattering.
- 39 thethr=3.227e-3 $1/V^3$

Coefficient of self-heating.

40 sltheth=2.460e-9 $1/(V^3 m)$

Coefficient of the length dependence of theth.

41 swtheth=0.0 $1/(V^3 m)$

Coefficient of the width dependence of theth.

Component Statements Part 2

Sub-threshold parameters

42 sdiblo=2.030e-03 $1/\sqrt{V}$

Drain-induced barrier lowering parameter.

- 43 sdiblexp=1.340Exponent of the length dependence of sdibl.
- 44 dphi=0.800 vParameter for short-channel subtreshold behaviour.

Saturation Parameters

45 ssfsq=6.250e-03 $1/\sqrt{V}$

Static feedback parameter.

46 swssf=0.0 1/(\sqrt{V} m)

Coefficient of the width dependence of ssf.

- 47 alpsq=0.010 mCharacteristic length parameter for channel length modulation.
- 48 swalp=0.0 mCoefficient of the width dependence of alp.
- 49 vp=0.075 vCharacteristic voltage of channel-length modulation.

Smoothing Parameters

- 50 mexpo=0.093Smoothing factor.
- 51 mexpl=0.065Coefficient of the length dependence of mexp.

Weak-Avalanche Parameters

- 52 alr=6Factor of the weak-avalanche current.
- 53 sta1=0.0 1/KCoefficient of the temperature dependence of a1.
- 54 sla1=1.30e-6 mCoefficient of the length dependence of a1.
- 55 swa1=3.0e-06 mCoefficient of the width dependence of a1.
- 56 a2r=38.0 VExponent of the weak-avalanche current.
- 57 sla2=1.00e-06 V mCoefficient of the length dependence of a2.

Component Statements Part 2

- 58 swa2=2.00e-06 V mCoefficient of the width dependence of a2.
- 59 a3r=0.650 Factor of the drain-source voltage above which weak-avalanche occurs.
- 60 sla3=-550.0e-06 mCoefficient of the length dependence of a3.
- 61 swa3=0.0 mCoefficient of the width dependence of a3.

Charge Parameters

- 62 tox=4.5e-09 mThickness of the oxide layer.
- 63 col=320e-12 F/mGate overlap capacitance per unit channel width.

Temperature Parameters

- 64 tr (C) Reference temperature. Default set by option tnom.
- 65 tref (C) Alias of tr. Default set by option tnom.
- 66 tnom (C) Alias of tr. Default set by option tnom.
- 67 dta=0.0 KTemperature offset of the device.
- 68 trise=0.0 KAlias of dta.

Output Parameters

- 1 le (m) Effective channel length.
- 2 we (m) Effective channel width.
- 3 vfb (V) Flat-band voltage.
- 4 ko (\sqrt{V}) Body effect coefficient.
- 5 phib (V) Surface potential at strong inversion.
- 6 bet (A/V^2) Gain factor.
- 7 these $(1/V^2)$ Mobility degradation parameter due to surface roughness scattering.

Component Statements Part 2

- 8 theph (1/V) Mobility degradation parameter due to phonon scattering.
- 9 etamobEffective field parameter for dependence on depletion charge.
- 10 ther (1/V) Coefficient of gate voltage independent part of series resistance.
- 11 ther1 (V) Numerator of gate voltage independent part of series resistance.
- 12 ther2 (V) Denominator of gate voltage independent part of series resistance.
- 13 then (1/V) Velocity saturation parameter due to optical phonon scattering.
- 14 thep (1/V) Velocity saturation parameter due to acoustic phonon scattering.
- 15 gthepVelocity saturation factor due to acoustic phonon scattering.
- 16 theth $(1/V^3)$ Coefficient of self-heating.
- 17 sdibl $(1/\sqrt{V})$ Drain-induced barrier lowering parameter.
- 18 dphi (V) Parameter for short-channel subtreshold behaviour.
- 19 ssf $(1/\sqrt{V})$ Static feedback parameter.
- 20 alp (m) Characteristic length parameter for channel length modulation.
- 21 vp (V) Characteristic voltage of channel-length modulation.
- 22 mexpSmoothing factor.
- 23 phit (V) Thermal voltage.
- 24 al Factor of the weak-avalanche current.
- 25 a2 (V) Exponent of the weak-avalanche current.
- 26 a3Factor of the drain-source voltage above which weak-avalanche occurs.
- 27 COX (F) Gate-to-channel capacitance (* mult).
- 28 cgdo (F) Gate-drain overlap capacitance (* mult).
- 29 cgso (F) Gate-source overlap capacitance (* mult).

Component Statements Part 2

Operating-Point Parameters

- 1 ide (A) Resistive drain current.
- 2 ige (A) Resistive gate current.
- 3 ise (A) Resistive source current.
- 4 ibe (A) Resistive bulk current.
- 5 vds (V) Drain-source voltage.
- 6 vgs (V) Gate-source voltage.
- 7 vsb (V) Source-bulk voltage.
- 8 ids (A) Resistive drain current.
- 9 idb (A) Resistive drain-bulk current.
- 10 isb (A) Resistive source-bulk current.
- 11 iavl (A) Substrate current.
- 12 pwr (W) Power.
- 13 vto (V) Threshold voltage at zero back-bias.
- **14** vts (V)Vts.
- 15 vgt (V) Effective gate drive including backbias and drain effects.
- 16 vdss (V) Saturation voltage at actual bias.
- 17 vsat (V) Saturation limit.
- 18 gm (S) Transconductance (d ids / d vgs).
- 19 gmb (S) Bulk transconductance (d ids / d vbs).
- 20 gds (S) Output conductance (d ids / d vds).
- 21 cdd (F) Capacitance (d qd / d vd).

Component Statements Part 2

- 22 cdg (F) Capacitance (- d qd / d vg).
- 23 cds (F) Capacitance (- d qd / d vs).
- 24 cdb (F) Capacitance (- d qd / d vb).
- 25 cgd (F) Capacitance (- d qg / d vd).
- 26 cgg (F) Capacitance (d qg / d vg).
- 27 cgs (F) Capacitance (- d qg / d vs).
- 28 cgb (F) Capacitance (- d qg / d vb).
- 29 csd (F) Capacitance (-d qs/d vd).
- 30 csg (F) Capacitance (-d qs/d vg).
- 31 css (F) Capacitance (d qs / d vs).
- 32 csb (F) Capacitance (- d qs / d vb).
- 33 cbd (F) Capacitance (- d qb / d vd).
- 34 cbg (F) Capacitance (- d qb / d vg).
- 35 cbs (F) Capacitance (- d qb / d vs).
- 36 cbb (F) Capacitance (d qb / d vb).
- 37 uTransistor gain (gm/gds).
- 38 rout (Ω) Small signal output resistance (1/gds).
- 39 vearly (V) Equivalent Early voltage (|id|/gds).
- 40 keff (\sqrt{V}) Describes body effect at actual bias.
- 41 beff (S/V) Effective beta at actual bias in the simple MOS model (2*|ids|/vgt2^2).
- 42 fug (Hz) Unity gain frequency at actual bias (gm/(2*pi*cin)).

Component Statements Part 2

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alr M-52	fug OP-42	sl2vfb M-11	ther1 0-11
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a2r M-56	gm OP-18	sla2 M-57	ther2 M-31
a3 0-26	gmb OP-19	sla3 M-60	thersq M-28
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cdb OP-24	ko 0-4	swa1 M-55	vds OP-5
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csb OP-32	phib O-5	swtheth M-41	vts OP-14
csd OP-29	phibr M-17	swvfb M-12	w I-1
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Component Statements Part 2

Compact MOS-Transistor Distortion Model (mos1100)

Description

The mos1100 model is based on the thesis of Ronald van Langevelde: "A compact MOSFET Model for Distortion Analysis in Analog Circuit Design", Technische Universiteit Eindhoven, 1998.

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In extension to the description a minimum conductance gmin is inserted between the drain and source node, to aid convergence. The value of gmin is set by an options statement, default = 1e-12 S.

This device is supported within altergroups.

This device is dynamically loaded from the shared object

/vobs/spectre_dev/tools.sun4v/spectre/lib/cmi/2.0.doc/libphilips.so

Instance Definition

Name d g s [b] ModelName parameter=value ...

Instance Parameters

- 1 w=1.0 scale mDrawn channel width in the layout. Scale set by option scale...
- 2 1=1.0 scale mDrawn channel length in the layout. Scale set by option scale...
- 3 mult=1Number of devices in parallel.
- 4 area=1Alias of mult.
- 5 region=triodeEstimated DC operating region, used as a convergence aid.

 Possible values are off, triode, sat, or subth.
- 6 m=1Multiplicity factor.

Model Definition

model modelName mos1100 parameter=value ...

Component Statements Part 2

Model Parameters

Device Type Parameters

1 type=nTransistor gender.

Possible values are n or p.

Geometry Parameters

- 2 ler=1.0e-6 mEffective channel length of the reference transistor.
- 3 wer=1e-5 mEffective channel width of the reference transistor.
- 4 lvar=0.0 mDifference between the actual and the programmed poly-silicon gate length.
- 5 lap=4.0e-8 mEffective channel length reduction per side.
- 6 wvar=0.0 mDifference between the actual and the programmed field-oxide opening.
- 7 wot=0.0 mEffective channel width reduction per side.

Threshold-Voltage Parameters

- 8 vfbr=-1.050 vFlat-band voltage for reference transistor.
- 9 stvfb=0.5e-03 V/KCoefficient of temperature dependence of vfb.
- 10 kor=0.5 \sqrt{V} Body effect coefficient for the reference transistor.
- 11 slko=0.0 \sqrt{V} m

Coefficient of the length dependence of ko.

12 sl2ko=0.0 \sqrt{V} m²

Second coefficient of the length dependence of ko.

13 swko=0.0 \sqrt{V} m

Coefficient of the width dependence of ko.

- 14 phibr=0.95 vSurface potential at strong inversion.
- 15 slphib=0.0 VmCoefficient of the length dependence of phib.

Component Statements Part 2

- 16 sl2phib=0.0 Vm2Second coefficient of the length dependence of phib.
- 17 swphib=0.0 Vm²Coefficient of the width dependence of phib.

Channel-Current Parameters

- 18 fbet1=0.0Relative mobility decrease due to first lateral profile.
- 19 lp1=0.8e-6Characteristic length of first lateral profile.
- 20 lp2=0.8e-6Characteristic length of second lateral profile.
- 21 fbet2=0.0Relative mobility decrease due to second lateral profile.
- 22 betsq=370.9e-06 A/V^2 Gain factor for an infinite square transistor.
- 23 etabet=1.3Exponent of the temperature dependence of the gain factor.
- 24 thesrr=0.4 1/VCoefficient of the mobility reduction due to surface roughness scattering.
- 25 swthesr=0.0 mCoefficient of the width dependence of thesr.
- 26 thephr=1.29e-2 1/V Coefficient of the mobility reduction due to phonon scattering.
- 27 swtheph=0.0 mCoefficient of the width dependence of theph.
- 28 etaph=1.75Exponent of the temperature dependence of theph.
- 29 etamobr=1.4Effective field parameter for dependence on depletion/inversion charge.
- 30 stetamob=0.0 1/KCoefficient of the temperature dependence of etamob.
- 31 swetamob=0.0 mCoefficient of the width dependence of etamob.
- 32 nur=1.0Exponent of the field dependence of the mobility model minus 1.
- 33 nuexp=5.25Exponent of the temperature dependence of parameter nu.
- 34 therr=0.155 1/VCoefficient of the series resistance.

Component Statements Part 2

- 35 swther=0.0 mCoefficient of the width dependence of ther.
- 36 etar=0.95Exponent of the temperature dependence of ther.
- 37 thesatr=0.5 1/VVelocity saturation parameter due to optical/acoustic phonon scattering.
- 38 etasat=1.04 1/VExponent of the temperature dependence of thesat.
- 39 swthesat=0.0 mCoefficient of the width dependence of thesat.
- 40 slthesat=1.0Coefficient of length dependence of thesat.
- 41 thesatexp=1.0Exponent of length dependence of thesat.

Drain-Feedback Parameters

- 42 thethr=1e-3 1/V³Coefficient of self-heating.
- 43 thethexp=1.0Exponent of the length dependence of theth.
- 44 ssfr=6.25e-3 $1/\sqrt{V}$

Static feedback parameter.

- 45 swssf=0.0 mCoefficient of the width dependence of ssf.
- 46 slssf=1.0e-6 mCoefficient of the length dependence of ssf.
- 47 alpr=0.010 Factor of the channel length modulation.
- 48 swalp=0.0 mCoefficient of the width dependence of alp.
- 49 slalp=1.0 mCoefficient of the length dependence of alp.
- 50 alpexp=1.0Exponent of the length dependence of alp.
- 51 vp=5.0e-2 vCharacteristic voltage of channel-length modulation.

Sub-Threshold Parameters

52 sdiblo=2e-03 $1/\sqrt{V}$

Drain-induced barrier lowering parameter.

Component Statements Part 2

- 53 sdiblexp=1.35Exponent of the length dependence of sdibl.
- 54 mor=0.0Parameter for short-channel subtreshold slope.
- 55 moexp=1.34Exponent of the length dependence of mo.

Smoothing Parameter

56 lmin=1.5e-7 mMinimum effective channel length in technology, used for calculation of smoothing factor m.

Weak-Avalanche Parameters

- 57 alr=6Factor of the weak-avalanche current.
- 58 sla1=0.0 mCoefficient of the length dependence of a1.
- 59 swa1=0.0 mCoefficient of the width dependence of a1.
- 60 sta1=0.0 1/KCoefficient of the temperature dependence of a1.
- 61 a2r=38.0 VExponent of the weak-avalanche current.
- 62 sla2=0.0 V mCoefficient of the length dependence of a2.
- 63 swa2=0.0 V mCoefficient of the width dependence of a2.
- 64 a3r=1.0Factor of the drain-source voltage above which weak-avalanche occurs.
- 65 sla3=0.0 mCoefficient of the length dependence of a3.
- 66 swa3=0.0 mCoefficient of the width dependence of a3.

Gate Current Parameters

- 67 iginvr=0.0 A/V²Gain factor for intrinsic gate tunnelling current in inversion.
- 68 igaccr=0.0 A/V²Gain factor for intrinsic gate tunnelling current in accumulation.
- 69 igovr=0.0 A/V²Gain factor for Source/Drain overlap gate tunnelling current.

Component Statements Part 2

Charge parameters

70 tox=3.2e-09 mThickness of the oxide layer.

71 col=3.2e-10 F/mGate overlap capacitance per unit channel width.

Noise Parameters

72 ntr=1.656e-20 JCoefficient of the thermal noise.

73 nfar=1.573e22 $1/(Vm^4)$

First coefficient of the flicker noise.

74 nfbr= $4.752e8 \ 1/(Vm^2)$

Second coefficient of the flicker noise.

75 nfcr=0.0 1/VThird coefficient of the flicker noise.

Temperature Parameters

76 tr (C) Reference temperature. Default set by option tnom.

77 tref (C) Alias of tr. Default set by option tnom.

78 tnom (C) Alias of tr. Default set by option tnom.

79 dta=0.0 KTemperature offset of the device.

80 trise=0.0 KAlias of dta.

Other Parameters

81 kpinv=0.0 $1/\sqrt{V}$

Inverse of body-effect factor of the poly-silicon gate.

82 ther1=0.0 VNumerator of gate voltage dependent part of series resistance.

83 ther2=1.0 VDenominator of gate voltage dependent part of series resistance.

84 vp=5.0e-2 vCharacteristic voltage of channel-length modulation.

85 binv=48.0 vProbability factor for intrinsic gate tunnelling current in inversion.

Component Statements Part 2

- 86 bacc=48.0 vProbability factor for intrinsic gate tunnelling current in accumulation.
- 87 vfbov=0.0 vFlat-band voltage for the Source/Drain overlap extensions.
- 88 kov=2.5 \sqrt{V} Body-effect factor for the Source/Drain overlap extensions.
- 89 gatenoise=0.0Flag for in/exclusion of induced gate thermal noise.

Output Parameters

- 1 vto (V) Zero-bias threshold voltage.
- 2 le (m) Effective channel length.
- 3 we (m) Effective channel width.
- 4 ko (\sqrt{V}) Body-effect factor.
- 5 phib (V) Surface potential at the onset of strong inversion.
- 6 bet (A/V^2) Gain factor.
- 7 thesr (1/V) Mobility degradation parameter due to surface roughness scattering.
- 8 theph (1/V) Mobility degradation parameter due to phonon scattering.
- 9 etamobEffective field parameter for dependence on depletion charge.
- 10 nuExponent of field dependence of mobility model.
- 11 ther (1/V) Coefficient of series resistance.
- 12 thesat (1/V) Velocity saturation parameter due to optical/acoustic phonon scattering.
- 13 theth $(1/V^3)$ Coefficient of self-heating.
- 14 sdibl (1/ \sqrt{V}) Drain-induced barrier lowering parameter.
- 15 moParameter for (short-channel) subtreshold slope.
- 16 ssf $(1/\sqrt{V})$ Static-feedback parameter.
- 17 alpFactor of channel length modulation.

Component Statements Part 2

- 18 mexpSmoothing factor.
- 19 a1Factor of the weak-avalanche current.
- 20 a2 (V) Exponent of the weak-avalanche current.
- 21 a3Factor of the drain-source voltage above which weak-avalanche occurs.
- 22 iginv (A/V²) Gain factor for intrinsic gate tunnelling current in inversion.
- 23 igacc (A/V²) Gain factor for intrinsic gate tunnelling current in accumulation.
- 24 igov (A/V²) Gain factor for Source/Drain overlap tunnelling current.
- 25 COX (F) Oxide capacitance for the intrinsic channel (* mult).
- 26 cgdo (F) Oxide capacitance for the gate-drain overlap (* mult).
- 27 cgso (F) Oxide capacitance for the gate-source overlap (* mult).
- 28 nt (J) Thermal noise coefficient.
- 29 nfa (1/(Vm⁴)) First coefficient of the flicker noise.
- 30 nfb $(1/(Vm^2))$ Second coefficient of the flicker noise.
- 31 nfc (1/V) Third coefficient of the flicker noise.
- 32 tox (m) Thickness of gate oxide layer.

Operating-Point Parameters

- 1 nfcr=0.0 1/VThird coefficient of the flicker noise.
- 2 ide (A) Resistive drain current.
- 3 ige (A) Resistive gate current.
- 4 ise (A) Resistive source current.
- 5 ibe (A) Resistive bulk current.
- 6 isb (A) Resistive source-bulk current.

Component Statements Part 2

- 7 idb (A) Resistive drain-bulk current.
- 8 pwr (W) Power.
- 9 ids (A) Drain current, excl. avalanche and tunnel currents.
- 10 iavl (A) Substrate current due to weak-avalanche.
- 11 igs (A) Gate-to-source current due to direct tunnelling.
- 12 igd (A) Gate-to-drain current due to direct tunnelling.
- 13 igb (A) Gate-to-bulk current due to direct tunnelling.
- 14 vds (V) Drain-source voltage.
- 15 vgs (V) Gate-source voltage.
- 16 vsb (V) Source-bulk voltage.
- 17 vts (V) Threshold voltage including back-bias effects.
- 18 vth (V) Threshold voltage including back-bias and drain-bias effects.
- 19 vgt (V) Effective gate drive voltage including back-bias and drain voltage effects.
- 20 vdss (V) Drain saturation voltage at actual bias.
- 21 vsat (V) Saturation limit.
- 22 gm (S) Transconductance (d ids / d vgs).
- 23 gmb (S) Substrate-transconductance (d ids / d vbs).
- 24 gds (S) Output conductance (d ids / d vds).
- 25 cdd (F) Capacitance (d qd / d vd).
- 26 cdg (F) Capacitance (- d qd / d vg).
- 27 cds (F) Capacitance (- d qd / d vs).
- 28 cdb (F) Capacitance (- d qd / d vb).

Component Statements Part 2

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29 cgd (F) Capacitance (- d qg / d vd).
30 cgg (F) Capacitance (d qg / d vg).
31 cgs (F) Capacitance (- d qg / d vs).
32 cgb (F) Capacitance (- d qg / d vb).
33 csd (F) Capacitance (-d qs/d vd).
34 csg (F) Capacitance (- d qs / d vg).
35 css (F) Capacitance (d qs / d vs).
36 csb (F) Capacitance (-d qs/d vb).
37 cbd (F) Capacitance (- d qb / d vd).
38 cbg (F) Capacitance (- d qb / d vg).
39 cbs (F) Capacitance (- d qb / d vs).
40 cbb (F) Capacitance (d qb / d vb).
41 uTransistor gain (gm/gds).
42 rout (\Omega) Small-signal output resistance (1/gds).
43 yearly (V) Equivalent Early voltage (|id|/gds).
44 keff (\sqrt{V}) Body effect parameter.
45 beff (A/V^2) Gain factor.
46 fug (Hz) Unity gain frequency at actual bias (gm/(2*pi*cin)).
47 sqrtsfw (V/\sqrt{Hz})
                           Input-referred RMS white noise voltage density.
48 sqrtsff (V/\sqrt{Hz})
                           Input-referred RMS white noise voltage density at 1 kHz.
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49 fknee (Hz) Cross-over frequency above which white noise is dominant.

Component Statements Part 2

Parameter Index

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a2r M-61	gds OP-24	nfcr M-75	theph 0-8
a3 0-21	gm OP-22	nfcr OP-1	thephr M-26
a3r M-64	qmb OP-23	nt 0-28	ther 0-11
alp 0-17	iavl OP-10	ntr M-72	ther1 M-82
alpexp M-50	ibe OP-5	nu 0-10	ther2 M-83
alpr M-47	idb OP-7	nuexp M-33	therr M-34
area I-4	ide OP-2	nur M-32	thesat 0-12
bacc M-86	ids OP-9	phib 0-5	thesatexp M-41
beff OP-45	igacc 0-23	phibr M-14	thesatr M-37
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cbb OP-40	ige OP-3	sdibl 0-14	thethexp M-43
cbd OP-37	iginv 0-22	sdiblexp M-53	thethr M-42
cbg OP-38	iginvr M-67	sdiblo M-52	tnom M-78
cbs OP-39	igov 0-24	sl2ko M-12	tox 0-32
cdb OP-28	igovr M-69	sl2phib M-16	tox M-70
cdd OP-25	igs OP-11	sla1 M-58	tr M-76
cdg OP-26	isb OP-6	sla2 M-62	tref M-77
cds OP-27	ise OP-4	sla3 M-65	trise M-80
cgb OP-32	keff OP-44	slalp M-49	type M-1
cgd OP-29	ko 0-4	slko M-11	u OP-41
cgdo 0-26	kor M-10	slphib M-15	vds OP-14
cgg OP-30	kov M-88	slssf M-46	vdss OP-20
cgs OP-31	kpinv M-81	slthesat M-40	vearly OP-43
cgso 0-27	1 I-2	sqrtsff OP-48	vfbov M-87
col M-71	lap M-5	sqrtsfw OP-47	vfbr M-8
cox 0-25	le 0-2	ssf 0-16	vgs OP-15
csb OP-36	ler M-2	ssfr M-44	vgt OP-19
csd OP-33	lmin M-56	stal M-60	vp M-84
csg OP-34	lp1 M-19	stetamob M-30	vp M-51
css OP-35	lp2 M-20	stvfb M-9	vsat OP-21
dta M-79	lvar M-4	swa1 M-59	vsb OP-16
etabet M-23	m I-6	swa2 M-63	vth OP-18

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Component Statements Part 2

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etaph M-28	moexp M-55	swetamob M-31	w I-1
etar M-36	mor M-54	swko M-13	we 0-3
etasat M-38	mult I-3	swphib M-17	wer M-3
fbet1 M-18	nfa 0-29	swssf M-45	wot M-7
fbet2 M-21	nfar M-73	swtheph M-27	wvar M-6

MOS Level-15 Transistor (mos15)

Description

The MOS15 model is the AMS level 15 model which is the modified Berkeley SPICE level-2 model with the DC model replaced by that of AMS. It is an analytical one-dimensional model that incorporates most of the second-order small-size effects. A smoother version of the level-15 model (with continuous Gds at Vdsat) was also developed. Three charge models are available. MOS15 transistors require the use of a model statement.

This device is not supported within altergroup.

This device is dynamically loaded from the shared object

/vobs/spectre dev/tools.sun4v/spectre/lib/cmi/2.0.doc/libstmodels.so

Instance Definition

Name d g s b ModelName parameter=value ...

Instance Parameters

- 1 w (m) Channel width.
- 2 1 (m) Channel length.
- 3 as (m²) Area of source diffusion.
- 4 ad (m²) Area of drain diffusion.
- 5 ps (m) Perimeter of source diffusion.
- 6 pd (m) Perimeter of drain diffusion.

Component Statements Part 2

- 7 nrd (m/m) Number of squares of drain diffusion.
- 8 nrs (m/m) Number of squares of source diffusion.
- 9 ld (m) Length of drain diffusion region.
- 10 ls (m) Length of source diffusion region.
- 11 m=1Multiplicity factor (number of MOSFETs in parallel).
- 12 region=triodeEstimated operating region.

 Possible values are off, triode, sat, or subth.
- 13 triseTemperature rise from ambient.

Model Definition

model modelName mos15 parameter=value ...

Model Parameters

Device Type Parameters

1 type=nTransistor type.

Possible values are n or p.

Drain Current Model Parameters

- 2 vto=0 vThreshold voltage at zero body bias.
- $3 \text{ kp}=2.0718e-5 \text{ A/V}^2$

Transconductance parameter.

- 4 lambda=0 1/VChannel length modulation parameter.
- 5 phi=0.7 vSurface potential at strong inversion.
- 6 gamma=0 \sqrt{V} Body-effect parameter.
- 7 uo=600 cm²/V sCarrier surface mobility.
- 8 vmax=∞ m/sCarrier saturation velocity.

Component Statements Part 2

- 9 ucrit=0 V/cmCritical field for mobility degradation.
- 10 uexp=0Critical field exponent for mobility degradation.
- 11 utra=0 1/VTransverse field for mobility.
- 12 neff=1Total channel charge coefficient.
- 13 delta=0Width effect on threshold voltage.

Process Parameters

- 14 nsub=1.13e16 cm^{-3}
- Channel doping concentration.
- 15 nss=0 cm⁻²Surface state density.
- 16 nfs=0 cm⁻²Fast surface state density.
- 17 tpg=+1Type of gate (+1 = opposite of substate, -1 = same as substate, 0 = aluminum).
- 18 tox=1e-7 mGate oxide thickness.
- 19 1d=0 mLateral diffusion.
- 20 wd=0 mField-oxide encroachment.
- 21 xw=0 mWidth variation due to masking and etching.
- 22 x1=0 mLength variation due to masking and etching.
- 23 xj=0 mSource/drain junction depth.

Impact Ionization Parameters

- 24 ai0=0 1/VImpact ionization current coefficient.
- 25 lai0=0 μ m/VLength sensitivity of ai0.
- 26 wai0=0 μ m/VWidth sensitivity of ai0.
- 27 bi0=0 VImpact ionization current exponent.

Component Statements Part 2

- 28 lbi0=0 μm VLength sensitivity of bi0.
- 29 wbi0=0 µm vWidth sensitivity of bi0.

Overlap Capacitance Parameters

- 30 cgso=0 F/mGate-source overlap capacitance.
- 31 cgdo=0 F/mGate-drain overlap capacitance.
- 32 cgbo=0 F/mGate-bulk overlap capacitance.
- 33 meto=0 mMetal overlap in fringing field.

Charge Model Selection Parameters

- 34 capmod=bsimIntrinsic charge model.
 - Possible values are none, meyer, yang, or bsim.
- 35 xpart=1Drain/source channel charge partition in saturation for BSIM charge model, use 0.0 for 40/60, 0.5 for 50/50, or 1.0 for 0/100.
- 36 xqc=0 Drain/source channel charge partition in saturation for charge models, e.g. use 0.4 for 40/60, 0.5 for 50/50, 0 for 0/100.

Parasitic Resistance Parameters

- 37 rs=0 Ω Source resistance.
- 38 rd=0 Ω Drain resistance.
- 39 rsh=0 Ω/sqr Source/drain diffusion sheet resistance.
- 40 rss=0 Ω mScalable source resistance.
- 41 rdd=0 Ω mScalable drain resistance.
- 42 rsc=0 Ω Source contact resistance.
- 43 rdc=0 Ω Drain contact resistance.
- 44 minr=0.1 Ω Minimum source/drain resistance.

Component Statements Part 2

- 45 ldif=0 mLateral diffusion beyond the gate.
- 46 hdif=0 mLength of heavily doped diffusion.
- 47 lgcs=0 mGate-to-contact length of source side.
- 48 lgcd=0 mGate-to-contact length of drain side.
- 49 sc=∞ mSpacing between contacts.

Junction Diode Model Parameters

- 50 js (A/m²) Bulk junction reverse saturation current density.
- 51 is=1e-14 ABulk junction reverse saturation current.
- 52 n=1Junction emission coefficient.
- 53 dskip=yesUse simple piece-wise linear model for diode currents below 0.1*iabstol. Possible values are no or yes.
- 54 imax=1 AExplosion current.
- 55 jmax=1e8 A/m²Explosion current density.

Junction Capacitance Model Parameters

- 56 cbs=0 FBulk-source zero-bias junction capacitance.
- 57 cbd=0 FBulk-drain zero-bias junction capacitance.
- 58 cj=0 F/m²Zero-bias junction bottom capacitance density.
- 59 mj=1/2Bulk junction bottom grading coefficient.
- 60 pb=0.8 VBulk junction built-in potential.
- 61 fc=0.5Forward-bias depletion capacitance threshold.
- 62 cjsw=0 F/mZero-bias junction sidewall capacitance density.
- 63 mjsw=1/3Bulk junction sidewall grading coefficient.

Component Statements Part 2

- 64 pbsw=0.8 vSide-wall junction built-in potential.
- 65 fcsw=0.5Side-wall forward-bias depletion capacitance threshold.

Operating Region Warning Control Parameters

- 66 alarm=noneForbidden operating region.
 - Possible values are none, off, triode, sat, subth, or rev.
- 67 by j=∞ VJunction reverse breakdown voltage.

Temperature Effects Parameters

- 68 tnom (C) Parameters measurement temperature. Default set by options.
- 69 trise=0 CTemperature rise from ambient.
- 70 uto=0 CMobility temperature offset.
- 71 ute=-1.5Mobility temperature exponent.
- 72 tlev=0DC temperature selector.
- 73 tlevc=0AC temperature selector.
- **74** eg=1.12452 VEnergy band gap.
- 75 gap1=7.02e-4 V/CBand gap temperature coefficient.
- 76 gap2=1108 CBand gap temperature offset.
- 77 flex=0Temperature exponent for ucrit.
- 78 lamex=0 1/CTemperature parameter for lambda and kappa.
- 79 trs=0 1/CTemperature parameter for source resistance.
- 80 trd=0 1/cTemperature parameter for drain resistance.
- 81 xti=3Saturation current temperature exponent.
- 82 ptc=0 V/CSurface potential temperature coefficient.

Component Statements Part 2

- 83 tcv=0 V/CThreshold voltage temperature coefficient.
- 84 pta=0 V/CJunction potential temperature coefficient.
- 85 ptp=0 V/CSidewall junction potential temperature coefficient.
- 86 cta=0 1/cJunction capacitance temperature coefficient.
- 87 ctp=0 1/cSidewall junction capacitance temperature coefficient.

Default Instance Parameters

- 88 w=3e-6 mDefault channel width.
- 89 1=3e-6 mDefault channel length.
- 90 as=0 m²Default area of source diffusion.
- 91 ad=0 m²Default area of drain diffusion.
- 92 ps=0 mDefault perimeter of source diffusion.
- 93 pd=0 mDefault perimeter of drain diffusion.
- 94 nrd=0 m/mDefault number of squares of drain diffusion.
- 95 nrs=0 m/mDefault number of squares of source diffusion.
- 96 ldd=0 mDefault length of drain diffusion region.
- 97 lds=0 mDefault length of source diffusion region.

Noise Model Parameters

- 98 kf=0Flicker (1/f) noise coefficient.
- 99 af=1Flicker (1/f) noise exponent.
- 100 ef=1Flicker (1/f) noise frequency exponent.
- 101 noisemod=1Noise model selector.

Component Statements Part 2

The imax(jmax) parameter is used to aid convergence and prevent numerical overflow. The junction characteristics of the FET are accurately modeled for current (density) up to imax(jmax). For currents (density) above imax(jmax), the junction is modeled as a linear resistor and a warning is printed.

Output Parameters

- 1 weff (m) Effective channel width.
- 2 leff (m) Effective channel length.
- 3 rseff (Ω) Effective source resistance.
- 4 rdeff (Ω) Effective drain resistance.

Operating-Point Parameters

1 type=nTransistor type.

Possible values are n or p.

2 region=triodeEstimated operating region.

Possible values are off, triode, sat, or subth.

3 reversedReverse mode indicator.

Possible values are no or yes.

- 4 id (A) Resistive drain current.
- 5 vgs (V) Gate-source voltage.
- 6 vds (V) Drain-source voltage.
- 7 vbs (V) Bulk-source voltage.
- 8 vth (V)Threshold voltage.
- 9 vdsat (V) Drain-source saturation voltage.
- 10 gm (S) Common-source transconductance.
- 11 gds (S) Common-source output conductance.

Component Statements Part 2

- 12 gmbs (S) Body-transconductance.
- 13 gameff (\sqrt{V}) Effective body effect coefficient.
- 14 betaeff (A/V²) Effective beta.
- 15 cbd (F) Drain-bulk junction capacitance.
- 16 cbs (F) Source-bulk junction capacitance.
- 17 cgs (F) Gate-source capacitance.
- 18 cgd (F) Gate-drain capacitance.
- 19 cgb (F) Gate-bulk capacitance.
- 20 ron (Ω) On-resistance.
- 21 ib (A) Resistive bulk current.
- 22 pwr (W) Power at op point.

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ad M-91	gap2 M-76	nfs M-16	tlevc M-73
ad I-4	gds OP-11	noisemod M-101	tnom M-68
af M-99	gm OP-10	nrd M-94	tox M-18
ai0 M-24	gmbs OP-12	nrd I-7	tpg M-17
alarm M-66	hdif M-46	nrs M-95	trd M-80
as I-3	ib OP-21	nrs I-8	trise I-13
as M-90	id OP-4	nss M-15	trise M-69
betaeff OP-14	imax M-54	nsub M-14	trs M-79
bi0 M-27	is M-51	pb M-60	type M-1
bvj M-67	jmax M-55	pbsw M-64	type OP-1
capmod M-34	js M-50	pd I-6	ucrit M-9
cbd M-57	kf M-98	pd M-93	uexp M-10

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Component Statements Part 2

cbd OP-15	kp M-3	phi M-5	uo M-7
cbs OP-16	1 I-2	ps I-5	ute M-71
cbs M-56	1 M-89	ps M-92	uto M-70
cgb OP-19	lai0 M-25	pta M-84	utra M-11
cgbo M-32	lambda M-4	ptc M-82	vbs OP-7
cgd OP-18	lamex M-78	ptp M-85	vds OP-6
cgdo M-31	lbi0 M-28	pwr OP-22	vdsat OP-9
cgs OP-17	ld I-9	rd M-38	vgs OP-5
cgso M-30	ld M-19	rdc M-43	vmax M-8
сј М-58	ldd M-96	rdd M-41	vth OP-8
cjsw M-62	ldif M-45	rdeff O-4	vto M-2
cta M-86	lds M-97	region I-12	w M-88
ctp M-87	leff O-2	region OP-2	w I-1
delta M-13	lgcd M-48	reversed OP-3	wai0 M-26
dskip M-53	lgcs M-47	ron OP-20	wbi0 M-29
ef M-100	ls I-10	rs M-37	wd M-20
eg M-74	m I-11	rsc M-42	weff O-1
flex M-77	meto M-33	rseff O-3	xj M-23
fc M-61	minr M-44	rsh M-39	x1 M-22
fcsw M-65	mj M-59	rss M-40	xpart M-35
gameff OP-13	mjsw M-63	sc M-49	xqc M-36
gamma M-6	n M-52	tcv M-83	xti M-81
gap1 M-75	neff M-12	tlev M-72	xw M-21

MOS Level-2 Transistor (mos2)

Description

The MOS2 model is the level-2 model from Berkeley SPICE. The MOS2 model is an analytical, one-dimensional model that incorporates most of the second-order small-size effects. A smoother version of the level-2 model (with continuous Gds at Vdsat) is also available. Three charge models are available. MOS2 transistors require that you use a model statement.

This device is supported within altergroups.

Sample Instance Statement

mn2 (1 2 0 0) nch2 w=10u ad=20p as=20p ps=24u pd=24u

Sample Model Statement

model nch2 mos2 type=n vto=0.66 lambda=0.018 gamma=0.6 nsub=0.213e16 kp=0.978e-4 tpg=-1 vmax=6e4 ucrit=1e7 utra=0.1 uexp=0.2 is=0

Component Statements Part 2

Instance Definition

Name d g s b ModelName parameter=value ...

Instance Parameters

- 1 w (m) Channel width.
- 2 1 (m) Channel length.
- 3 as (m²) Area of source diffusion.
- 4 ad (m²) Area of drain diffusion.
- 5 ps (m) Perimeter of source diffusion.
- 6 pd (m) Perimeter of drain diffusion.
- 7 nrd (m/m) Number of squares of drain diffusion.
- 8 nrs (m/m) Number of squares of source diffusion.
- 9 ld (m) Length of drain diffusion region.
- 10 ls (m) Length of source diffusion region.
- 11 m=1Multiplicity factor (number of MOSFETs in parallel).
- 12 region=triodeEstimated operating region.

Possible values are off, triode, sat, subth, or breakdown.

- 13 triseTemperature rise from ambient.
- 14 degradation=noHot-electron degradation flag.

 Possible values are no or yes.

Model Definition

model modelName mos2 parameter=value ...

Component Statements Part 2

Model Parameters

Device Type Parameters

1 type=nTransistor type.

Possible values are n or p.

Drain Current Model Parameters

- 2 vto=0 vThreshold voltage at zero body bias.
- $3 \text{ kp}=2.0718e-5 \text{ A/V}^2$

Transconductance parameter.

- 4 lambda=0 1/VChannel length modulation parameter.
- 5 phi=0.7 VSurface potential at strong inversion.
- 6 gamma=0 \sqrt{V} Body-effect parameter.
- 7 uo=600 cm²/V sCarrier surface mobility.
- 8 vmax=∞ m/sCarrier saturation velocity.
- 9 ucrit=0 V/cmCritical field for mobility degradation.
- 10 uexp=0Critical field exponent for mobility degradation.
- 11 utra=0 1/VTransverse field for mobility.
- 12 neff=1Total channel charge coefficient.
- 13 delta=0Width effect on threshold voltage.
- 14 smooth=yesDrain current smoothing flag.

 Possible values are no or yes.

Process Parameters

15 $nsub=1.13e16 cm^{-3}$

Channel doping concentration.

Component Statements Part 2

- 16 nss=0 cm⁻²Surface state density.
- 17 nfs=0 cm⁻²Fast surface state density.
- 18 tpg=+1Type of gate (+1 = opposite of substate, -1 = same as substate, 0 = aluminum).
- 19 tox=1e-7 mGate oxide thickness.
- 20 1d=0 mLateral diffusion.
- 21 wd=0 mField-oxide encroachment.
- 22 xw=0 mWidth variation due to masking and etching.
- 23 x1=0 mLength variation due to masking and etching.
- 24 xj=0 mSource/drain junction depth.

Impact Ionization Parameters

- 25 ai0=0 1/VImpact ionization current coefficient.
- 26 lai0=0 μ m/VLength sensitivity of ai0.
- 27 wai0=0 μ m/VWidth sensitivity of ai0.
- 28 bi0=0 VImpact ionization current exponent.
- 29 1bi0=0 μm VLength sensitivity of bi0.
- 30 wbi0=0 μ m VWidth sensitivity of bi0.

Overlap Capacitance Parameters

- 31 cgso=0 F/mGate-source overlap capacitance.
- 32 cgdo=0 F/mGate-drain overlap capacitance.
- 33 cgbo=0 F/mGate-bulk overlap capacitance.
- 34 meto=0 mMetal overlap in fringing field.

Component Statements Part 2

Charge Model Selection Parameters

- 35 capmod=bsimIntrinsic charge model.

 Possible values are none, meyer, yang, or bsim.
- 36 xpart=1Drain/source channel charge partition in saturation for BSIM charge model, use 0.0 for 40/60, 0.5 for 50/50, or 1.0 for 0/100.
- 37 xqc=0 Drain/source channel charge partition in saturation for charge models, e.g. use 0.4 for 40/60, 0.5 for 50/50, 0 for 0/100.

Parasitic Resistance Parameters

- 38 rs=0 Ω Source resistance.
- 39 rd=0 Ω Drain resistance.
- 40 rsh=0 Ω /sqrSource/drain diffusion sheet resistance.
- 41 rss=0 Ω mScalable source resistance.
- 42 rdd=0 Ω mScalable drain resistance.
- 43 rsc=0 Ω Source contact resistance.
- 44 rdc=0 Ω Drain contact resistance.
- 45 minr=0.1 Ω Minimum source/drain resistance.
- 46 ldif=0 mLateral diffusion beyond the gate.
- 47 hdif=0 mLength of heavily doped diffusion.
- 48 lgcs=0 mGate-to-contact length of source side.
- 49 lgcd=0 mGate-to-contact length of drain side.
- 50 sc=∞ mSpacing between contacts.

Junction Diode Model Parameters

51 js (A/m^2) Bulk junction reverse saturation current density.

Component Statements Part 2

- 52 is=1e-14 ABulk junction reverse saturation current.
- 53 n=1Junction emission coefficient.
- 54 dskip=yesUse simple piece-wise linear model for diode currents below 0.1*iabstol. Possible values are no or yes.
- 55 imelt=`imaxA' Explosion current, diode is linearized beyond this current to aid convergence.
- 56 jmelt=`jmaxA/m'²

Explosion current density, diode is linearized beyond this current to aid convergence.

Junction Capacitance Model Parameters

- 57 cbs=0 FBulk-source zero-bias junction capacitance.
- 58 cbd=0 FBulk-drain zero-bias junction capacitance.
- 59 cj=0 F/m²Zero-bias junction bottom capacitance density.
- 60 mj=1/2Bulk junction bottom grading coefficient.
- 61 pb=0.8 VBulk junction built-in potential.
- 62 fc=0.5Forward-bias depletion capacitance threshold.
- 63 cjsw=0 F/mZero-bias junction sidewall capacitance density.
- 64 mjsw=1/3Bulk junction sidewall grading coefficient.
- 65 pbsw=0.8 vSide-wall junction built-in potential.
- 66 fcsw=0.5Side-wall forward-bias depletion capacitance threshold.

Operating Region Warning Control Parameters

- 67 alarm=noneForbidden operating region.
 - Possible values are none, off, triode, sat, subth, or rev.
- 68 imax=1 AMaximum current, currents above this limit generate a warning.

Component Statements Part 2

- 69 jmax=1e8 A/m²Maximum current density, currents above this limit generate a warning.
- 70 bv j=∞ vJunction reverse breakdown voltage.
- 71 vbox=1e9 tox vOxide breakdown voltage.

Temperature Effects Parameters

- 72 tnom (C) Parameters measurement temperature. Default set by options.
- 73 trise=0 CTemperature rise from ambient.
- 74 uto=0 CMobility temperature offset.
- 75 ute=-1.5Mobility temperature exponent.
- 76 tlev=0DC temperature selector.
- 77 tlevc=0AC temperature selector.
- 78 eg=1.12452 VEnergy band gap.
- 79 gap1=7.02e-4 V/CBand gap temperature coefficient.
- 80 gap2=1108 CBand gap temperature offset.
- 81 flex=0Temperature exponent for ucrit.
- 82 lamex=0 1/CTemperature parameter for lambda and kappa.
- 83 trs=0 1/CTemperature parameter for source resistance.
- 84 trd=0 1/cTemperature parameter for drain resistance.
- 85 xti=3Saturation current temperature exponent.
- 86 ptc=0 V/CSurface potential temperature coefficient.
- 87 tcv=0 V/CThreshold voltage temperature coefficient.
- 88 pta=0 V/CJunction potential temperature coefficient.
- 89 ptp=0 V/CSidewall junction potential temperature coefficient.

Component Statements Part 2

- 90 cta=0 1/CJunction capacitance temperature coefficient.
- 91 ctp=0 1/cSidewall junction capacitance temperature coefficient.

Default Instance Parameters

- 92 w=3e-6 mDefault channel width.
- 93 1=3e-6 mDefault channel length.
- 94 as=0 m²Default area of source diffusion.
- 95 ad=0 m²Default area of drain diffusion.
- 96 ps=0 mDefault perimeter of source diffusion.
- 97 pd=0 mDefault perimeter of drain diffusion.
- 98 nrd=0 m/mDefault number of squares of drain diffusion.
- 99 nrs=0 m/mDefault number of squares of source diffusion.
- 100 ldd=0 mDefault length of drain diffusion region.
- 101 lds=0 mDefault length of source diffusion region.

Noise Model Parameters

- 102 noisemod=1 Noise model selector.
- 103 kf=0 Flicker (1/f) noise coefficient.
- 104 af=1Flicker (1/f) noise exponent.
- 105 ef=1Flicker (1/f) noise frequency exponent.
- 106 wnoi=le-5 mChannel width at which noise parameters were extracted.

Auto Model Selector Parameters

107 wmax=1.0 mMaximum channel width for which the model is valid.

Component Statements Part 2

- 108 wmin=0.0 mMinimum channel width for which the model is valid.
- 109 lmax=1.0 mMaximum channel length for which the model is valid.
- 110 lmin=0.0 mMinimum channel length for which the model is valid.

Degradation Parameters

- 111 degramod=spectreDegradation model selector.

 Possible values are spectre or bert.
- 112 degradation=noHot-electron degradation flag.

 Possible values are no or yes.
- 113 dvthc=1 VDegradation coefficient for threshold voltage.
- 114 dvthe=1Degradation exponent for threshold voltage.
- 115 duoc=1 SDegradation coefficient for transconductance.
- 116 duoe=1 Degradation exponent for transconductance.
- 117 crivth=0.1 VMaximum allowable threshold voltage shift.
- 118 criuo=10%Maximum allowable normalized mobility change.
- 119 crigm=10%Maximum allowable normalized transconductance change.
- 120 criids=10%Maximum allowable normalized drain current change.
- 121 wnom=5e-6 mNominal device width in degradation calculation.
- 122 lnom=le-6 mNominal device length in degradation calculation.
- 123 vbsn=0 vSubstrate voltage in degradation calculation.
- 124 vdsni=0.1 vDrain voltage in Ids degradation calculation.
- 125 vgsni=5 vGate voltage in Ids degradation calculation.
- 126 vdsng=0.1 vDrain voltage in Gm degradation calculation.
- 127 vgsng=5 vGate voltage in Gm degradation calculation.

Component Statements Part 2

Spectre Stress Parameters

- 128 esat=1.1e7 V/mCritical field in Vdsat calculation.
- 129 esatg=2.5e6 1/mGate voltage dependence of esat.
- 130 vpg=-0.25Gate voltage modifier.
- 131 vpb=-0.13Gate voltage modifier.
- 132 subc1=2.24e-5Substrate current coefficient.
- 133 subc2=-0.1e-5 1/VSubstrate current coefficient.
- 134 sube=6.4Substrate current exponent.
- 135 strc=1Stress coefficient.
- 136 stre=1Stress exponent.

BERT Stress Parameters

- 137 h0=1Aging coefficient.
- 138 hgd=0 1/VBias dependence of h0.
- 139 m0=1Aging exponent.
- 140 mgd=0 1/VBias dependence of m0.
- 141 ecrit0=1.1e5 V/cmCritical electric field.
- 142 lecrit0=0 μ m V/cmLength dependence of ecrit0.
- 143 wecrit0=0 µm V/cmWidth dependence of ecrit0.
- 144 ecritg=0 1/cmGate voltage dependence of ecrit0.
- 145 lecritg=0 μm/cmLength dependence of ecritg.
- 146 wecritg=0 µm/cmWidth dependence of ecritg.
- 147 ecritb=0 1/cmSubstrate voltage dependence of ecrit0.

Component Statements Part 2

- 148 lecritb=0 μ m/cmLength dependence of ecritb.
- 149 wecritb=0 µm/cmWidth dependence of ecritb.
- 150 lc0=1Substrate current coefficient.
- 151 llc0=0 μmLength dependence of lc0.
- 152 wlc0=0 µmWidth dependence of lc0.
- 153 lc1=1Substrate current coefficient.
- 154 llc1=0 μ mLength dependence of lc1.
- 155 wlc1=0 µmWidth dependence of lc1.
- 156 lc2=1Substrate current coefficient.
- 157 llc2=0 µmLength dependence of lc2.
- 158 wlc2=0 µmWidth dependence of lc2.
- 159 1c3=1Substrate current coefficient.
- 160 llc3=0 µmLength dependence of lc3.
- 161 wlc3=0 μmWidth dependence of lc3.
- 162 lc4=1Substrate current coefficient.
- 163 llc4=0 µmLength dependence of lc4.
- 164 wlc4=0 µmWidth dependence of lc4.
- 165 lc5=1Substrate current coefficient.
- 166 llc5=0 µmLength dependence of lc5.
- 167 wlc5=0 μ mWidth dependence of lc5.
- 168 lc6=1Substrate current coefficient.
- 169 11c6=0 µmLength dependence of 1c6.

Component Statements Part 2

170 wlc6=0 µmWidth dependence of lc6.

171 1c7=1Substrate current coefficient.

172 llc7=0 µmLength dependence of lc7.

173 wlc7=0 μ mWidth dependence of lc7.

Imax and Imelt

The imax parameter aids convergence and prevents numerical overflow. The junction characteristics of the device are accurately modeled for current up to imax. If imax is exceeded during iterations, the linear model is substituted until the current drops below imax or until convergence is achieved. If convergence is achieved with the current exceeding imax, the results are inaccurate, and Spectre prints a warning.

A separate model parameter, imelt, is used as a limit warning for the junction current. This parameter can be set to the maximum current rating of the device. When any component of the junction current exceeds imelt, note that base and collector currents are composed of many exponential terms, Spectre issues a warning and the results become inaccurate. The junction current is linearized above the value of imelt to prevent arithmetic exception, with the exponential term replaced by a linear equation at imelt.

Both of these parameters have current density counterparts, jmax and jmelt, that you can specify if you want the absolute current values to depend on the device area.

Auto Model Selection

Many models need to be characterized for different geometries in order to obtain accurate results for model development. The model selector program automatically searches for a model with the length and width range specified in the instance statement and uses this model in the simulations.

For the auto model selector program to find a specific model, the models to be searched should be grouped together within braces. Such a group is called a model group. An opening brace is required at the end of the line defining each model group. Every model in the group is given a name followed by a colon and the list of parameters. Also, the four geometric parameters lmax, lmin, wmax, and wmin should be given. The selection criteria to choose a model is as follows:

lmin <= inst_length < lmax and wmin <= inst_width < wmax</pre>

Example

Component Statements Part 2

Then for a given instance

```
M1 1 2 3 4 ModelName w=3 1=1.5
```

the program would search all the models in the model group with the name ModelName and then pick the first model whose geometric range satisfies the selection criteria. In the preceding example, the auto model selector program would choose ModelName.2.

The user must specify both length (I) and width (w) on the device instance line to enable automatic model selection.

Output Parameters

- 1 weff (m) Effective channel width.
- 2 leff (m) Effective channel length.
- 3 rseff (Ω) Effective source resistance.
- 4 rdeff (Ω) Effective drain resistance.
- 5 aseff (m²) Effective area of source diffusion.
- 6 adeff (m²) Effective area of drain diffusion.
- 7 pseff (m) Effective perimeter of source diffusion.
- 8 pdeff (m) Effective perimeter of source diffusion.
- 9 isseff (A) Effective source-bulk junction reverse saturation current.
- 10 isdeff (A) Effective drain-bulk junction reverse saturation current.
- 11 cbseff (F) Effective zero-bias source-bulk junction capacitance.
- 12 cbdeff (F) Effective zero-bias drain-bulk junction capacitance.

Component Statements Part 2

Operating-Point Parameters

1 type=nTransistor type.

Possible values are n or p.

2 region=triodeEstimated operating region.

Possible values are off, triode, sat, subth, or breakdown.

3 degradation=noHot-electron degradation flag.

Possible values are no or yes.

4 reversedReverse mode indicator.

Possible values are no or yes.

- 5 ids (A) Resistive drain-to-source current.
- 6 vgs (V) Gate-source voltage.
- 7 vds (V) Drain-source voltage.
- 8 vbs (V) Bulk-source voltage.
- 9 vth (V)Threshold voltage.
- 10 vdsat (V) Drain-source saturation voltage.
- 11 gm (S) Common-source transconductance.
- 12 gds (S) Common-source output conductance.
- 13 gmbs (S) Body-transconductance.
- 14 gameff (\sqrt{V}) Effective body effect coefficient.
- 15 betaeff (A/V^2) Effective beta.
- 16 cbd (F) Drain-bulk junction capacitance.
- 17 cbs (F) Source-bulk junction capacitance.
- 18 cgs (F) Gate-source capacitance.
- 19 cgd (F) Gate-drain capacitance.

Component Statements Part 2

- 20 cgb (F) Gate-bulk capacitance.
- 21 ron (Ω) On-resistance.
- 22 id (A) Resistive drain current.
- 23 ibulk (A) Resistive bulk current.
- 24 pwr (W) Power at op point.
- 25 gmoverid (1/V)Gm/Ids.
- 26 isub (A) Substrate current.
- 27 stressHot-electron stress.
- 28 age (s) Device age.
- 29 he_vdsat (V) Hot Electron Vdsat.

Parameter Index

ad I-4	gap2 M-80	lmin M-110	tnom M-72
ad M-95	gds OP-12	lnom M-122	tox $M-19$
adeff 0-6	gm OP-11	ls I-10	tpg M-18
af M-104	gmbs OP-13	m I-11	trd M-84
age OP-28	gmoverid OP-25	m0 M-139	trise I-13
ai0 M-25	h0 M-137	meto M-34	trise M-73
alarm M-67	hdif M-47	mgd M-140	trs M-83
as I-3	he_vdsat OP-29	minr M-45	type M-1
as M-94	hgd M-138	mj M-60	type OP-1
aseff O-5	ibulk OP-23	mjsw M-64	ucrit M-9
betaeff OP-15	id OP-22	n M-53	uexp M-10
bi0 M-28	ids OP-5	neff M-12	uo M-7
bvj M-70	imax M-68	nfs M-17	ute M-75
capmod M-35	imelt M-55	noisemod M-102	uto M-74
cbd OP-16	is M-52	nrd M-98	utra M-11

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Component Statements Part 2

cbd M-58	isdeff 0-10	nrd I-7	vbox M-71
cbdeff 0-12	isseff 0-9	nrs I-8	vbs OP-8
cbs OP-17	isub OP-26	nrs M-99	vbsn M-123
cbs M-57	jmax M-69	nss M-16	vds OP-7
cbseff 0-11	jmelt M-56	nsub M-15	vdsat OP-10
cgb OP-20	js M-51	pb M-61	vdsng M-126
cgbo M-33	kf M-103	pbsw M-65	vdsni M-124
cgd OP-19	kp M-3	pd I-6	vgs OP-6
cgdo M-32	1 I-2	pd M-97	vgsng M-127
cgs OP-18	1 M-93	pdeff O-8	vgsni M-125
cgso M-31	lai0 M-26	phi M-5	vmax M-8
cj M-59	lambda M-4	ps I-5	vpb M-131
cjsw M-63	lamex M-82	ps M-96	vpg M-130
crigm M-119	lbi0 M-29	pseff 0-7	vth OP-9
criids M-120	lc0 M-150	pta M-88	vto M-2
criuo M-118	lc1 M-153	ptc M-86	w M-92
crivth M-117	lc2 M-156	ptp M-89	w I-1
cta M-90	lc3 M-159	pwr OP-24	wai0 M-27
ctp M-91	lc4 M-162	rd M-39	wbi0 M-30
degradation M-112		rdc M-44	wd M-21
degradation OP-3	lc6 M-168	rdd M-42	wecrit0 M-143
degradation I-14	lc7 M-171	rdeff 0-4	wecritb M-149
degramod M-111	ld M-20	region OP-2	wecritg M-146
delta M-13	ld I-9	region I-12	weff O-1
dskip M-54	ldd M-100	reversed OP-4	wlc0 M-152
duoc M-115	ldif M-46	ron OP-21	wlc1 M-155
duoe M-116	lds M-101	rs M-38	wlc2 M-158
dvthc M-113	lecrit0 M-142	rsc M-43	wlc3 M-161
dvthe M-114	lecritb M-148	rseff 0-3	wlc4 M-164
ecrit0 M-141	lecritg M-145	rsh M-40	wlc5 M-167
ecritb M-147	leff 0-2	rss M-41	wlc6 M-170
ecritg M-144	lgcd M-49	sc M-50	wlc7 M-173
ef M-105	lgcs M-48	smooth M-14	wmax M-107
eg M-78	llc0 M-151	strc M-135	wmin M-108
esat M-128	llc1 M-154	stre M-136	wnoi M-106
esatg M-129	llc2 M-157	stress OP-27	wnom M-121
flex M-81	llc3 M-160	subc1 M-132	xj M-24
fc M-62	llc4 M-163	subc2 M-133	xl M-23
fcsw M-66	llc5 M-166	sube M-134	xpart M-36
gameff OP-14	llc6 M-169	tcv M-87	xqc M-37
gamma M-6	llc7 M-172	tlev M-76	xti M-85
gap1 M-79	lmax M-109	tlevc M-77	xw M 2

Component Statements Part 2

MOS Level-3 Transistor (mos3)

Description

The MOS3 model is the level-3 model from Berkeley SPICE, and is a semi-empirical model. Three charge models are available. MOS3 transistors require that you use a model statement.

This device is supported within altergroups.

Sample Instance Statement

```
mp3 (0 1 2 2) pchmos3 1=2u w=30u ad=120p as=75p pd=36u ps=6u
```

Sample Model Statement

Instance Definition

```
Name d g s b ModelName parameter=value ...
```

Instance Parameters

- 1 w (m) Channel width.
- 2 1 (m) Channel length.
- 3 as (m^2) Area of source diffusion.
- 4 ad (m²) Area of drain diffusion.
- 5 ps (m) Perimeter of source diffusion.
- 6 pd (m) Perimeter of drain diffusion.
- 7 nrd (m/m) Number of squares of drain diffusion.
- 8 nrs (m/m) Number of squares of source diffusion.
- 9 ld (m) Length of drain diffusion region.

Component Statements Part 2

- 10 ls (m) Length of source diffusion region.
- 11 m=1Multiplicity factor (number of MOSFETs in parallel).
- 12 region=triodeEstimated operating region.

Possible values are off, triode, sat, subth, or breakdown.

- 13 triseTemperature rise from ambient.
- 14 degradation=noHot-electron degradation flag.

 Possible values are no or yes.

Model Definition

model modelName mos3 parameter=value ...

Model Parameters

Device Type Parameters

1 type=nTransistor type.

Possible values are n or p.

Drain Current Model Parameters

- 2 vto=0 vThreshold voltage at zero body bias.
- $3 \text{ kp}=2.0718e-5 \text{ A/V}^2$

Transconductance parameter.

- 4 theta=0 1/VMobility modulation coefficient.
- 5 phi=0.7 vSurface potential at strong inversion.
- 6 gamma=0 √V Body-effect parameter.
- 7 uo=600 cm²/V sCarrier surface mobility.
- 8 vmax=∞ m/sCarrier saturation velocity.
- 9 eta=0 1/VStatic feedback coefficient.

Component Statements Part 2

- 10 kappa=0.2Saturation field factor.
- 11 delta=0Width effect on threshold voltage.

Process Parameters

- 12 nsub=1.13e16 cm^{-3}
- Channel doping concentration.
- 13 nss=0 cm⁻²Surface state density.
- 14 nfs=0 cm⁻²Fast surface state density.
- 15 tpg=+1Type of gate (+1 = opposite of substate, -1 = same as substate, 0 = aluminum).
- 16 tox=1e-7 mGate oxide thickness.
- 17 ld=0 mLateral diffusion.
- 18 wd=0 mField-oxide encroachment.
- 19 xw=0 mWidth variation due to masking and etching.
- 20 x1=0 mLength variation due to masking and etching.
- 21 xj=0 mSource/drain junction depth.

Impact Ionization Parameters

- 22 ai0=0 1/VImpact ionization current coefficient.
- 23 lai0=0 μ m/VLength sensitivity of ai0.
- 24 wai0=0 μ m/VWidth sensitivity of ai0.
- 25 bi0=0 VImpact ionization current exponent.
- 26 lbi0=0 μm VLength sensitivity of bi0.
- 27 wbi0=0 μm vWidth sensitivity of bi0.

Component Statements Part 2

Overlap Capacitance Parameters

- 28 cgso=0 F/mGate-source overlap capacitance.
- 29 cgdo=0 F/mGate-drain overlap capacitance.
- 30 cgbo=0 F/mGate-bulk overlap capacitance.
- 31 meto=0 mMetal overlap in fringing field.

Charge Model Selection Parameters

- 32 capmod=bsimIntrinsic charge model.
 - Possible values are none, meyer, yang, or bsim.
- 33 xpart=1Drain/source channel charge partition in saturation for BSIM charge model, use 0.0 for 40/60, 0.5 for 50/50, or 1.0 for 0/100.
- 34 xqc=0 Drain/source channel charge partition in saturation for charge models, e.g. use 0.4 for 40/60, 0.5 for 50/50, 0 for 0/100.

Parasitic Resistance Parameters

- 35 rs=0 Ω Source resistance.
- 36 rd=0 Ω Drain resistance.
- 37 rsh=0 Ω/sqr Source/drain diffusion sheet resistance.
- 38 rss=0 Ω mScalable source resistance.
- 39 rdd=0 Ω mScalable drain resistance.
- 40 rsc=0 Ω Source contact resistance.
- 41 rdc=0 Ω Drain contact resistance.
- 42 minr=0.1 Ω Minimum source/drain resistance.
- 43 ldif=0 mLateral diffusion beyond the gate.
- 44 hdif=0 mLength of heavily doped diffusion.

Component Statements Part 2

- 45 lgcs=0 mGate-to-contact length of source side.
- 46 lgcd=0 mGate-to-contact length of drain side.
- 47 sc=∞ mSpacing between contacts.

Junction Diode Model Parameters

- 48 js (A/m^2) Bulk junction reverse saturation current density.
- 49 is=1e-14 ABulk junction reverse saturation current.
- 50 n=1Junction emission coefficient.
- 51 dskip=yesUse simple piece-wise linear model for diode currents below 0.1*iabstol. Possible values are no or yes.
- 52 imelt=`imaxA' Explosion current, diode is linearized beyond this current to aid convergence.
- 53 jmelt=`jmaxA/m'²

Explosion current density, diode is linearized beyond this current to aid convergence.

Junction Capacitance Model Parameters

- 54 cbs=0 FBulk-source zero-bias junction capacitance.
- 55 cbd=0 FBulk-drain zero-bias junction capacitance.
- 56 cj=0 F/m²Zero-bias junction bottom capacitance density.
- 57 mj=1/2Bulk junction bottom grading coefficient.
- 58 pb=0.8 VBulk junction built-in potential.
- 59 fc=0.5Forward-bias depletion capacitance threshold.
- 60 cjsw=0 F/mZero-bias junction sidewall capacitance density.
- 61 mjsw=1/3Bulk junction sidewall grading coefficient.

Component Statements Part 2

- 62 pbsw=0.8 vSide-wall junction built-in potential.
- 63 fcsw=0.5Side-wall forward-bias depletion capacitance threshold.

Operating Region Warning Control Parameters

- 64 alarm=noneForbidden operating region.
 - Possible values are none, off, triode, sat, subth, or rev.
- 65 imax=1 AMaximum current, currents above this limit generate a warning.
- 66 jmax=1e8 A/m²Maximum current density, currents above this limit generate a warning.
- 67 bvj=∞ VJunction reverse breakdown voltage.
- 68 vbox=1e9 tox vOxide breakdown voltage.

Temperature Effects Parameters

- 69 tnom (C) Parameters measurement temperature. Default set by options.
- 70 trise=0 cTemperature rise from ambient.
- 71 uto=0 CMobility temperature offset.
- 72 ute=-1.5Mobility temperature exponent.
- 73 tlev=0DC temperature selector.
- 74 tlevc=0AC temperature selector.
- **75** eg=1.12452 V**Energy band gap.**
- 76 gap1=7.02e-4 V/CBand gap temperature coefficient.
- 77 gap2=1108 CBand gap temperature offset.
- 78 flex=0Temperature exponent for ucrit.
- 79 lamex=0 1/CTemperature parameter for lambda and kappa.
- 80 trs=0 1/CTemperature parameter for source resistance.

Component Statements Part 2

- 81 trd=0 1/cTemperature parameter for drain resistance.
- 82 xti=3Saturation current temperature exponent.
- 83 ptc=0 V/CSurface potential temperature coefficient.
- 84 tcv=0 V/CThreshold voltage temperature coefficient.
- 85 pta=0 V/CJunction potential temperature coefficient.
- 86 ptp=0 V/CSidewall junction potential temperature coefficient.
- 87 cta=0 1/CJunction capacitance temperature coefficient.
- 88 ctp=0 1/cSidewall junction capacitance temperature coefficient.

Default Instance Parameters

- 89 w=3e-6 mDefault channel width.
- 90 1=3e-6 mDefault channel length.
- 91 as=0 m²Default area of source diffusion.
- 92 ad=0 m²Default area of drain diffusion.
- 93 ps=0 mDefault perimeter of source diffusion.
- 94 pd=0 mDefault perimeter of drain diffusion.
- 95 nrd=0 m/mDefault number of squares of drain diffusion.
- 96 nrs=0 m/mDefault number of squares of source diffusion.
- 97 ldd=0 mDefault length of drain diffusion region.
- 98 lds=0 mDefault length of source diffusion region.

Noise Model Parameters

99 noisemod=1Noise model selector.

Component Statements Part 2

- 100 kf=0 Flicker (1/f) noise coefficient.
- 101 af=1Flicker (1/f) noise exponent.
- 102 ef=1Flicker (1/f) noise frequency exponent.
- 103 wnoi=le-5 mChannel width at which noise parameters were extracted.

Auto Model Selector Parameters

- 104 wmax=1.0 mMaximum channel width for which the model is valid.
- 105 wmin=0.0 mMinimum channel width for which the model is valid.
- 106 lmax=1.0 mMaximum channel length for which the model is valid.
- 107 lmin=0.0 mMinimum channel length for which the model is valid.

Degradation Parameters

- 108 degramod=spectreDegradation model selector.

 Possible values are spectre or bert.
- 109 degradation=noHot-electron degradation flag.

 Possible values are no or yes.
- 110 dvthc=1 VDegradation coefficient for threshold voltage.
- 111 dvthe=1Degradation exponent for threshold voltage.
- 112 duoc=1 SDegradation coefficient for transconductance.
- 113 duoe=1 Degradation exponent for transconductance.
- 114 crivth=0.1 VMaximum allowable threshold voltage shift.
- 115 criuo=10%Maximum allowable normalized mobility change.
- 116 crigm=10%Maximum allowable normalized transconductance change.
- 117 criids=10%Maximum allowable normalized drain current change.

Component Statements Part 2

- 118 wnom=5e-6 mNominal device width in degradation calculation.
- 119 lnom=1e-6 mNominal device length in degradation calculation.
- 120 vbsn=0 VSubstrate voltage in degradation calculation.
- 121 vdsni=0.1 vDrain voltage in Ids degradation calculation.
- 122 vgsni=5 vGate voltage in Ids degradation calculation.
- 123 vdsng=0.1 VDrain voltage in Gm degradation calculation.
- 124 vgsng=5 VGate voltage in Gm degradation calculation.

Spectre Stress Parameters

- 125 esat=1.1e7 V/mCritical field in Vdsat calculation.
- 126 esatg=2.5e6 1/mGate voltage dependence of esat.
- 127 vpg=-0.25Gate voltage modifier.
- 128 vpb=-0.13Gate voltage modifier.
- 129 subc1=2.24e-5Substrate current coefficient.
- 130 subc2=-0.1e-5 1/VSubstrate current coefficient.
- 131 sube=6.4Substrate current exponent.
- 132 strc=1Stress coefficient.
- 133 stre=1Stress exponent.

BERT Stress Parameters

- 134 h0=1Aging coefficient.
- 135 hgd=0 1/VBias dependence of h0.
- 136 m0=1Aging exponent.

Component Statements Part 2

- 137 mgd=0 1/VBias dependence of m0.
- 138 ecrit0=1.1e5 V/cmCritical electric field.
- 139 lecrit0=0 µm V/cmLength dependence of ecrit0.
- 140 wecrit0=0 μ m V/cmWidth dependence of ecrit0.
- 141 ecritg=0 1/cmGate voltage dependence of ecrit0.
- 142 lecritg=0 µm/cmLength dependence of ecritg.
- 143 we critg=0 μ m/cmWidth dependence of ecritg.
- 144 ecritb=0 1/cmSubstrate voltage dependence of ecrit0.
- 145 lecritb=0 µm/cmLength dependence of ecritb.
- 146 we critb=0 μ m/cmWidth dependence of ecritb.
- 147 lc0=1Substrate current coefficient.
- 148 llc0=0 µmLength dependence of lc0.
- 149 wlc0=0 µmWidth dependence of lc0.
- 150 lc1=1Substrate current coefficient.
- 151 llc1=0 µmLength dependence of lc1.
- 152 wlc1=0 µmWidth dependence of lc1.
- 153 lc2=1Substrate current coefficient.
- 154 llc2=0 µmLength dependence of lc2.
- 155 wlc2=0 µmWidth dependence of lc2.
- 156 1c3=1Substrate current coefficient.
- 157 llc3=0 µmLength dependence of lc3.
- 158 wlc3=0 µmWidth dependence of lc3.

Component Statements Part 2

```
159 1c4=1Substrate current coefficient.
```

160 llc4=0 µmLength dependence of lc4.

161 wlc4=0 µmWidth dependence of lc4.

162 1c5=1Substrate current coefficient.

163 llc5=0 μmLength dependence of lc5.

164 wlc5=0 µmWidth dependence of lc5.

165 1c6=1Substrate current coefficient.

166 llc6=0 µmLength dependence of lc6.

167 wlc6=0 μ mWidth dependence of lc6.

168 1c7=1Substrate current coefficient.

169 llc7=0 µmLength dependence of lc7.

170 wlc7=0 μmWidth dependence of lc7.

Imax and Imelt

The imax parameter aids convergence and prevents numerical overflow. The junction characteristics of the device are accurately modeled for current up to imax. If imax is exceeded during iterations, the linear model is substituted until the current drops below imax or until convergence is achieved. If convergence is achieved with the current exceeding imax, the results are inaccurate, and Spectre prints a warning.

A separate model parameter, imelt, is used as a limit warning for the junction current. This parameter can be set to the maximum current rating of the device. When any component of the junction current exceeds imelt, note that base and collector currents are composed of many exponential terms, Spectre issues a warning and the results become inaccurate. The junction current is linearized above the value of imelt to prevent arithmetic exception, with the exponential term replaced by a linear equation at imelt.

Both of these parameters have current density counterparts, jmax and jmelt, that you can specify if you want the absolute current values to depend on the device area.

Component Statements Part 2

Auto Model Selection

Many models need to be characterized for different geometries in order to obtain accurate results for model development. The model selector program automatically searches for a model with the length and width range specified in the instance statement and uses this model in the simulations.

For the auto model selector program to find a specific model, the models to be searched should be grouped together within braces. Such a group is called a model group. An opening brace is required at the end of the line defining each model group. Every model in the group is given a name followed by a colon and the list of parameters. Also, the four geometric parameters lmax, lmin, wmax, and wmin should be given. The selection criteria to choose a model is as follows:

lmin <= inst_length < lmax and wmin <= inst_width < wmax</pre>

Example

Then for a given instance

```
M1 1 2 3 4 ModelName w=3 1=1.5
```

the program would search all the models in the model group with the name ModelName and then pick the first model whose geometric range satisfies the selection criteria. In the preceding example, the auto model selector program would choose ModelName.2.

The user must specify both length (I) and width (w) on the device instance line to enable automatic model selection.

Output Parameters

- 1 weff (m) Effective channel width.
- 2 leff (m) Effective channel length.
- 3 rseff (Ω) Effective source resistance.
- 4 rdeff (Ω) Effective drain resistance.

Component Statements Part 2

- 5 aseff (m^2) Effective area of source diffusion.
- 6 adeff (m²) Effective area of drain diffusion.
- 7 pseff (m) Effective perimeter of source diffusion.
- 8 pdeff (m) Effective perimeter of source diffusion.
- 9 isseff (A) Effective source-bulk junction reverse saturation current.
- 10 isdeff (A) Effective drain-bulk junction reverse saturation current.
- 11 cbseff (F) Effective zero-bias source-bulk junction capacitance.
- 12 cbdeff (F) Effective zero-bias drain-bulk junction capacitance.

Operating-Point Parameters

1 type=nTransistor type.

Possible values are n or p.

2 region=triodeEstimated operating region.

Possible values are off, triode, sat, subth, or breakdown.

3 degradation=noHot-electron degradation flag.

Possible values are no or yes.

4 reversed Reverse mode indicator.

Possible values are no or yes.

- 5 ids (A) Resistive drain-to-source current.
- 6 vgs (V) Gate-source voltage.
- 7 vds (V) Drain-source voltage.
- 8 vbs (V) Bulk-source voltage.
- 9 vth (V)Threshold voltage.
- 10 vdsat (V) Drain-source saturation voltage.
- 11 gm (S) Common-source transconductance.

Component Statements Part 2

- 12 gds (S) Common-source output conductance.
- 13 gmbs (S) Body-transconductance.
- 14 gameff (\sqrt{V}) Effective body effect coefficient.
- 15 betaeff (A/V^2) Effective beta.
- 16 cbd (F) Drain-bulk junction capacitance.
- 17 cbs (F) Source-bulk junction capacitance.
- 18 cgs (F) Gate-source capacitance.
- 19 cgd (F) Gate-drain capacitance.
- 20 cgb (F) Gate-bulk capacitance.
- 21 ron (Ω) On-resistance.
- 22 id (A) Resistive drain current.
- 23 ibulk (A) Resistive bulk current.
- 24 pwr (W) Power at op point.
- 25 gmoverid (1/V)Gm/Ids.
- 26 isub (A) Substrate current.
- 27 stressHot-electron stress.
- 28 age (s) Device age.
- 29 he_vdsat (V) Hot Electron Vdsat.

Parameter Index

In the following index, I refers to instance parameters, M refers to the model parameters section, O refers to the output parameters section, and OP refers to the operating point parameters section. The number indicates where to look in the appropriate section to find the

Component Statements Part 2

description for that parameter. For example, a reference of M-35 means the 35th model parameter.

ad M-92	gap1 M-76	lmax M-106	tnom M-69
ad I-4	gap2 M-77	lmin M-107	tox M-16
adeff 0-6	gds OP-12	lnom M-119	tpg M-15
af M-101	gm OP-11	ls I-10	trd M-81
age OP-28	gmbs OP-13	m I-11	trise I-13
ai0 M-22	gmoverid OP-25	m0 M-136	trise M-70
alarm M-64	h0 M-134	meto M-31	trs M-80
as I-3	hdif M-44	mgd M-137	type OP-1
as M-91	he_vdsat OP-29	minr M-42	type M-1
aseff 0-5	hgd M-135	mj M-57	uo M-7
betaeff OP-15	ibulk OP-23	mjsw M-61	ute M-72
bi0 M-25	id OP-22	n M-50	uto M-71
bvj M-67	ids OP-5	nfs M-14	vbox M-68
capmod M-32	imax M-65	noisemod M-99	vbs OP-8
cbd M-55	imelt M-52	nrd M-95	vbsn M-120
cbd OP-16	is M-49	nrd I-7	vds OP-7
cbdeff 0-12	isdeff 0-10	nrs I-8	vdsat OP-10
cbs OP-17	isseff 0-9	nrs M-96	vdsng M-123
cbs M-54	isub OP-26	nss M-13	vdsni M-121
cbseff 0-11	jmax M-66	nsub M-12	vgs OP-6
cgb OP-20	jmelt M-53	pb M-58	vgsng M-124
cgbo M-30	js M-48	pbsw M-62	vgsni M-122
cgd OP-19	kappa M-10	pd I-6	vmax M-8
cgdo M-29	kf M-100	pd M-94	vpb M-128
cgs OP-18	kp M-3	pdeff 0-8	vpg M-127
cgso M-28	1 M-90	phi M-5	vth OP-9
cj M-56	1 I-2	ps I-5	vto M-2
cjsw M-60	lai0 M-23	ps M-93	w M-89
crigm M-116	lamex M-79	pseff 0-7	w I-1
criids M-117	lbi0 M-26	pta M-85	wai0 M-24
criuo M-115	1c0 M-147	ptc M-83	wai0 M 24 wbi0 M-27
crivth M-114	lc1 M-150	ptp M-86	wd M-18
cta M-87	lc2 M-153		wa M-18 wecrit0 M-140
	lc3 M-156	pwr OP-24 rd M-36	wecrito M-140 wecritb M-146
ctp M-88 degradation M-109			
		rdc M-41 rdd M-39	3
-	lc5 M-162		
degradation I-14	lc6 M-165	rdeff 0-4	wlc0 M-149
degramod M-108	lc7 M-168	region I-12	wlc1 M-152
delta M-11	ld M-17	region OP-2	wlc2 M-155
dskip M-51	ld I-9	reversed OP-4	wlc3 M-158
duoc M-112	1dd M-97	ron OP-21	wlc4 M-161
duoe M-113	ldif M-43	rs M-35	wlc5 M-164

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dvthc M-110	lds M-98	rsc M-40	wlc6 M-167
dvthe M-111	lecrit0 M-139	rseff O-3	wlc7 M-170
ecrit0 M-138	lecritb M-145	rsh M-37	wmax M-104
ecritb M-144	lecritg M-142	rss M-38	wmin M-105
ecritg M-141	leff O-2	sc M-47	wnoi M-103
ef M-102	lgcd M-46	strc M-132	wnom M-118
eg M-75	lgcs M-45	stre M-133	xj M-21
esat M-125	llc0 M-148	stress OP-27	x1 M-20
esatg M-126	llc1 M-151	subc1 M-129	xpart M-33
eta M-9	llc2 M-154	subc2 M-130	xqc M-34
flex M-78	llc3 M-157	sube M-131	xti M-82
fc M-59	llc4 M-160	tcv M-84	xw M-19
fcsw M-63	llc5 M-163	theta M-4	
gameff OP-14	llc6 M-166	tlev M-73	
gamma M-6	llc7 M-169	tlevc M-74	

Long Channel JFET/MOSFET Model (mos30)

Description

This long channel JFET/MOSFET model is specially developed to describe the drift region of LDMOS, EPMOS and VDMOS devices. It is described in the Philips MOST Modelbook (Dec.95) as MOS model, level 30 (Used for DMOS). Information on how to obtain this document can be found on Source Link by searching for Philips.

Note: In noise analysis, mos30 instances will not generate any contribution, since there are no noise sources included in the mos30 model.

Warning: Dont use this model. It is obsolete.

Mos30 will be removed from spectre in the next release.

(c) Philips Electronics N.V. 1993, 1994, 1996

This device is supported within altergroups.

This device is dynamically loaded from the shared object

/vobs/spectre_dev/tools.sun4v/spectre/lib/cmi/2.0.doc/libphilips.so

Sample Instance Statement

mn30 (1 2 0 0) nchmod area=2 mult=1

Component Statements Part 2

Sample Model Statement

model nchmod mos30 type=n tox=1.1e-5 ron=150 rsat=500 psat=2 vsat=1 vsub=0.59
cgate=1.65e-12 csub=1.1e-9 tref=25

Instance Definition

Name d g s [b] ModelName parameter=value ...

Instance Parameters

- 1 mult=1Number of devices in parallel.
- 2 area=1Alias of mult.
- 3 region=triodeEstimated DC operating region, used as a convergence aid.

 Possible values are off, triode, sat, or subth.
- 4 m=1Multiplicity factor.

Model Definition

model modelName mos30 parameter=value ...

Model Parameters

- 1 type=nTransistor gender.
 - Possible values are n or p.
- 2 ron=1.0 Ω Ohmic resistance at zero bias.
- 3 rsat=1.0 Ω Space charge resistance at zero bias.
- 4 vsat=10.0 vCritical drain-source voltage for hot carriers.
- 5 psat=1.0 Velocity saturation coefficient.
- 6 vp=-1.0 vPinch off voltage at zero gate and substrate voltages.
- 7 tox=-1.0 cmGate oxide thickness.
- 8 dch=1.0e15 cm⁻³Doping level channel.

Component Statements Part 2

- 9 dsub=1.0e15 cm⁻³Doping level substrate.
- 10 vsub=0.6 vSubstrate diffusion voltage.
- 11 vgap=1.2 vBandgap voltage channel.
- 12 cgate=0.0 FGate capacitance at zero bias.
- 13 csub=0.0 FSubstrate capacitance at zero bias.
- 14 tausc=0.0 sSpace charge transit time of the channel.
- 15 ach=0.0Temperature coefficient resistivity of the channel.
- 16 kf=0.0Flickernoise coefficient.
- 17 af=1.0Flickernoise exponent.
- 18 tr (C) Reference temperature. Default set by option tnom.
- 19 tref (C) Alias of tr. Default set by option tnom.
- 20 tnom (C) Alias of tr. Default set by option tnom.
- 21 dta=0.0 KTemperature offset of the device.
- 22 trise=0.0 KAlias of dta.

Output Parameters

- 1 ront (Ω) Ohmic resistance at zero bias.
- 2 rsat (Ω) Space charge resistance at zero bias.
- 3 vsatt (V) Critical drain-source voltage for hot carriers.
- 4 vsubt (V) Substrate diffusion voltage.
- 5 cgate (F) Gate capacitance at zero bias.
- 6 csubt (F) Substrate capacitance at zero bias.

Component Statements Part 2

Operating-Point Parameters

- 1 pwr (W) Power.
- 2 ids (A) Total current including velocity saturation.
- 3 qb (Coul) Substrate charge.
- 4 qg (Coul) Gate charge.
- 5 qds (Coul) Space charge in the channel.
- 6 gdsd (S) Conductance (d ids / d vd).
- 7 gdsg (S) Conductance (d ids / d vg).
- 8 gdss (S) Conductance (d ids / d vs).
- 9 gdsb (S) Conductance (d ids / d vb).
- 10 cbd (F) Capacitance (d qb / d vd).
- 11 cbg (F) Capacitance (d qb / d vg).
- 12 cbs (F) Capacitance (d qb / d vs).
- 13 cbb (F) Capacitance (d qb / d vb).
- 14 cgd (F) Capacitance (d qg / d vd).
- 15 cgg (F) Capacitance (d qg / d vg).
- 16 cgs (F) Capacitance (d qg / d vs).
- 17 cgb (F) Capacitance (d qg/d vb).
- 18 cdsd (F) Capacitance (d qds / d vd).
- 19 cdsg (F) Capacitance (d qds / d vg).
- 20 cdss (F) Capacitance (d qds / d vs).
- 21 cdsb (F) Capacitance (d qds / d vb).

Component Statements Part 2

Parameter Index

ach M-15	cgd OP-14	m I-4	tox M-7
af M-17	cgg OP-15	mult I-1	tr M-18
area I-2	cgs OP-16	psat M-5	tref M-19
cbb OP-13	csub M-13	pwr OP-1	trise M-22
cbd OP-10	csubt 0-6	qb OP-3	type M-1
cbg OP-11	dch M-8	qds OP-5	vgap M-11
cbs OP-12	dsub M-9	qg OP-4	vp M-6
cdsb OP-21	dta M-21	region I-3	vsat M-4
cdsd OP-18	gdsb OP-9	ron M-2	vsatt 0-3
cdsg OP-19	gdsd OP-6	ront O-1	vsub M-10
cdss OP-20	gdsg OP-7	rsat 0-2	vsubt 0-4
cgate 0-5	gdss OP-8	rsat M-3	
cgate M-12	ids OP-2	tausc M-14	
cgb OP-17	kf M-16	tnom M-20	

Long Channel JFET/MOSFET Model (mos3002)

Description

This long channel JFET/MOSFET model is specially developed to describe the drift region of LDMOS, EPMOS and VDMOS devices. It is described in the Philips MOST Modelbook (Dec.98) as MOS model, level 3002 (Used for DMOS). Information on how to obtain this document can be found on Source Link by searching for Philips.

Note: In noise analysis, mos3002 instances will not generate any contribution, since there are no noise sources included in the mos3002 model.

(c) Philips Electronics N.V. 1993, 1994, 1996, 1998

This device is supported within altergroups.

This device is dynamically loaded from the shared object

/vobs/spectre_dev/tools.sun4v/spectre/lib/cmi/2.0.doc/libphilips.so

Component Statements Part 2

Sample Instance Statement

mn3 (1 2 0 0) nch3002 area=1 m=2

Sample Model Statement

Instance Definition

Name d g s [b] ModelName parameter=value ...

Instance Parameters

- 1 mult=1Number of devices in parallel.
- 2 area=1Alias of mult.
- 3 region=triodeEstimated DC operating region, used as a convergence aid.

 Possible values are off, triode, sat, or subth.
- 4 m=1Multiplicity factor.

Model Definition

model modelName mos3002 parameter=value ...

Model Parameters

- 1 type=nTransistor gender.
 - Possible values are n or p.
- 2 ron=1.0 Ω Ohmic resistance at zero bias.
- 3 rsat=1.0 Ω Space charge resistance at zero bias.
- 4 vsat=10.0 vCritical drain-source voltage for hot carriers.
- 5 psat=1.0 Velocity saturation coefficient.
- 6 vp=-1.0 vPinch off voltage at zero gate and substrate voltages.

Component Statements Part 2

- 7 tox=-1.0 cmGate oxide thickness.
- 8 dch=1.0e15 cm⁻³Doping level channel.
- 9 dsub=1.0e15 cm⁻³Doping level substrate.
- 10 vsub=0.6 vSubstrate diffusion voltage.
- 11 vgap=1.2 vBandgap voltage channel.
- 12 cgate=0.0 FGate capacitance at zero bias.
- 13 csub=0.0 FSubstrate capacitance at zero bias.
- 14 tausc=0.0 sSpace charge transit time of the channel.
- 15 ach=0.0Temperature coefficient resistivity of the channel.
- 16 kf=0.0Flickernoise coefficient.
- 17 af=1.0Flickernoise exponent.
- 18 tr (C) Reference temperature. Default set by option tnom.
- 19 tref (C) Alias of tr. Default set by option thom.
- 20 tnom (C) Alias of tr. Default set by option tnom.
- 21 dta=0.0 KTemperature offset of the device.
- 22 trise=0.0 KAlias of dta.

Output Parameters

- 1 ront (Ω) Ohmic resistance at zero bias.
- 2 rsat (Ω) Space charge resistance at zero bias.
- 3 vsatt (V) Critical drain-source voltage for hot carriers.
- 4 vsubt (V) Substrate diffusion voltage.
- 5 cgate (F) Gate capacitance at zero bias.

Component Statements Part 2

6 csubt (F) Substrate capacitance at zero bias.

Operating-Point Parameters

- 1 pwr (W) Power.
- 2 ids (A) Total current including velocity saturation.
- 3 qb (Coul) Substrate charge.
- 4 qg (Coul) Gate charge.
- 5 qds (Coul) Space charge in the channel.
- 6 gdsd (S) Conductance (d ids / d vd).
- 7 gdsg (S) Conductance (d ids / d vg).
- 8 gdss (S) Conductance (d ids / d vs).
- 9 gdsb (S) Conductance (d ids / d vb).
- 10 cbd (F) Capacitance (d qb / d vd).
- 11 cbg (F) Capacitance (d qb / d vg).
- 12 cbs (F) Capacitance (d qb / d vs).
- 13 cbb (F) Capacitance (d qb / d vb).
- 14 cgd (F) Capacitance (d qg / d vd).
- 15 cgg (F) Capacitance (d qg / d vg).
- 16 cgs (F) Capacitance (d qg / d vs).
- 17 cgb (F) Capacitance (d qg / d vb).
- 18 cdsd (F) Capacitance (d qds / d vd).
- 19 cdsq (F) Capacitance (d qds / d vq).
- 20 cdss (F) Capacitance (d qds / d vs).

Component Statements Part 2

21 cdsb (F) Capacitance (d qds / d vb).

Parameter Index

ach	M-15	cgd OP-14	m I-4	tox M-7
af	M-17	cgg OP-15	mult I-1	tr M-18
area	I-2	cgs OP-16	psat M-5	tref M-19
cbb	OP-13	csub M-13	pwr OP-1	trise M-22
cbd	OP-10	csubt 0-6	qb OP-3	type M-1
cbg	OP-11	dch M-8	qds OP-5	vgap M-11
cbs	OP-12	dsub M-9	qg OP-4	vp M-6
cdsb	OP-21	dta M-21	region I-3	vsat M-4
cdsd	OP-18	gdsb OP-9	ron M-2	vsatt 0-3
cdsg	OP-19	gdsd OP-6	ront 0-1	vsub M-10
cdss	OP-20	gdsg OP-7	rsat 0-2	vsubt 0-4
cgate	0-5	gdss OP-8	rsat M-3	
cgate	M-12	ids OP-2	tausc M-14	
cgb	OP-17	kf M-16	tnom M-20	

Long Channel JFET/MOSFET Model (mos3100)

Description

This long channel JFET/MOSFET model is special developed to describe the drift region of LDMOS, EPMOS and VDMOS devices. It is described in the Philips MOST Modelbook (Dec.98) as MOS model, level 3002 (Used for DMOS). Information on how to obtain this document can be found on Source Link by searching for Philips.

Note: In noise analysis, mos3100 instances will not generate any contribution, since there are no noise sources included in the mos3100 model.

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This device is supported within altergroups.

Component Statements Part 2

This device is dynamically loaded from the shared object

/vobs/spectre_dev/tools.sun4v/spectre/lib/cmi/2.0.doc/libphilips.so

Instance Definition

Name d g s [b] ModelName parameter=value ...

Instance Parameters

- 1 mult=1Number of devices in parallel.
- 2 area=1Alias of mult.
- 3 region=triodeEstimated DC operating region, used as a convergence aid.

 Possible values are off, triode, sat, or subth.
- 4 m=1Multiplicity factor.

Model Definition

model modelName mos3100 parameter=value ...

Model Parameters

- 1 type=nTransistor gender.
 - Possible values are n or p.
- 2 ron=1.0 Ω Ohmic resistance at zero bias.
- 3 rsat=1.0 Ω Space charge resistance at zero bias.
- 4 vsat=10.0 vCritical drain-source voltage for hot carriers.
- 5 psat=1.0 Velocity saturation coefficient.
- 6 vp=-1.0 vPinch off voltage at zero gate and substrate voltages.
- 7 tox=-1.0 mGate oxide thickness.
- 8 dch=1.0e21 m⁻³Doping level channel.
- 9 dsub=1.0e21 m⁻³Doping level substrate.

Component Statements Part 2

- 10 vsub=0.6 vSubstrate diffusion voltage.
- 11 vgap=1.2 vBandgap voltage channel.
- 12 cgate=0.0 FGate capacitance at zero bias.
- 13 csub=0.0 FSubstrate capacitance at zero bias.
- 14 tausc=0.0 sSpace charge transit time of the channel.
- 15 ach=0.0Temperature coefficient resistivity of the channel.
- 16 tr (C) Reference temperature. Default set by option tnom.
- 17 tref (C) Alias of tr. Default set by option tnom.
- 18 tnom (C) Alias of tr. Default set by option tnom.
- 19 dta=0.0 KTemperature offset of the device.
- 20 trise=0.0 KAlias of dta.

Output Parameters

- 1 ront (Ω) Ohmic resistance at zero bias.
- 2 rsat (Ω) Space charge resistance at zero bias.
- 3 vsatt (V) Critical drain-source voltage for hot carriers.
- 4 vsubt (V) Substrate diffusion voltage.
- 5 cgate (F) Gate capacitance at zero bias.
- 6 csubt (F) Substrate capacitance at zero bias.

Operating-Point Parameters

- 1 pwr (W) Power.
- 2 ids (A) Total current including velocity saturation.

Component Statements Part 2

3 qb (Coul) Substrate charge. qg (Coul) Gate charge. qds (Coul) Space charge in the channel. gdsd (S) Conductance (d ids / d vd). 7 gdsg (S) Conductance (d ids / d vg). gdss (S) Conductance (d ids / d vs). gdsb (S) Conductance (d ids / d vb). 10 cbd (F) Capacitance (d qb / d vd). 11 cbg (F) Capacitance (d qb / d vg). 12 cbs (F) Capacitance (d qb / d vs). 13 cbb (F) Capacitance (d qb / d vb). 14 cgd (F) Capacitance (d qg / d vd). 15 cgg (F) Capacitance (d qg / d vg). 16 cgs (F) Capacitance (d qg / d vs). 17 cgb (F) Capacitance (d qg / d vb). 18 cdsd (F) Capacitance (d qds / d vd). 19 cdsg (F) Capacitance (d qds / d vg). 20 cdss (F) Capacitance (d qds / d vs).

21 cdsb (F) Capacitance (d qds / d vb).

Parameter Index

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Component Statements Part 2

description for that parameter. For example, a reference of M-35 means the 35th model parameter.

ach	M-15	cgd OP-14	m I-4	tnom M-18
area	I-2	cgg OP-15	mult I-1	tox M-7
cbb	OP-13	cgs OP-16	psat M-5	tr M-16
cbd	OP-10	csub M-13	pwr OP-1	tref M-17
cbg	OP-11	csubt 0-6	qb OP-3	trise M-20
cbs	OP-12	dch M-8	qds OP-5	type M-1
cdsb	OP-21	dsub M-9	qg OP-4	vgap M-11
cdsd	OP-18	dta M-19	region I-3	vp M-6
cdsg	OP-19	gdsb OP-9	ron M-2	vsat M-4
cdss	OP-20	gdsd OP-6	ront 0-1	vsatt 0-3
cgate	0-5	gdsg OP-7	rsat 0-2	vsub M-10
cgate	M-12	gdss OP-8	rsat M-3	vsubt 0-4
cgb	OP-17	ids OP-2	tausc M-14	

Silicon On Isolator JFET Model (mos40)

Description

This long channel JFET/MOSFET model is special developed to describe the drift region of LDMOS, EPMOS and VDMOS devices. It is described in the Philips MOST Modelbook (Dec.98) as MOS model, level 3002 (Used for DMOS). Information on how to obtain this document can be found on Source Link by searching for Philips.

Note: In noise analysis, mos40 instances will not generate any contribution, since there are no noise sources included in the mos40 model.

(c) Philips Electronics N.V. 1993, 1994, 1996, 1998

This device is supported within altergroups.

This device is dynamically loaded from the shared object

/vobs/spectre_dev/tools.sun4v/spectre/lib/cmi/2.0.doc/libphilips.so

Instance Definition

Name d g s [b] ModelName parameter=value ...

Component Statements Part 2

Instance Parameters

- 1 mult=1Number of devices in parallel.
- 2 area=1Alias of mult.
- 3 region=triodeEstimated DC operating region, used as a convergence aid.

 Possible values are off, triode, sat, or subth.
- 4 m=1Multiplicity factor.

Model Definition

model modelName mos40 parameter=value ...

Model Parameters

- 1 type=nTransistor gender.
 - Possible values are n or p.
- 2 ron=1.0 Ω Ohmic resistance at zero bias.
- 3 rsat=1.0 Ω Space charge resistance at zero bias.
- 4 vsat=10.0 vCritical drain-source voltage for hot carriers.
- 5 psat=1.0 Velocity saturation coefficient.
- 6 vp=-1.0 vPinch off voltage at zero gate and substrate voltages.
- 7 tox=-1.0 mGate oxide thickness.
- 8 dch=1.0e21 m⁻³Doping level channel.
- 9 tbox=-1.0 m^{-3} Box thicknes.
- 10 cbox=0.0 m⁻³Wafer capacitance.
- 11 cgate=0.0 FGate capacitance at zero bias.
- 12 tausc=0.0 sSpace charge transit time of the channel.
- 13 ach=0.0Temperature coefficient resistivity of the channel.

Component Statements Part 2

- 14 tr (C) Reference temperature. Default set by option tnom.
- 15 tref (C) Alias of tr. Default set by option tnom.
- 16 tnom (C) Alias of tr. Default set by option tnom.
- 17 dta=0.0 KTemperature offset of the device.
- 18 trise=0.0 KAlias of dta.

Output Parameters

- 1 ront (Ω) Ohmic resistance at zero bias.
- 2 rsat (Ω) Space charge resistance at zero bias.
- 3 vsatt (V) Critical drain-source voltage for hot carriers.
- 4 vbox (V) Box voltage.
- 5 cgate (F) Gate capacitance at zero bias.

Operating-Point Parameters

- 1 pwr (W) Power.
- 2 ids (A) Total current including velocity saturation.
- 3 qb (Coul) Substrate charge.
- 4 qg (Coul) Gate charge.
- 5 qds (Coul) Space charge in the channel.
- 6 gdsd (S) Conductance (d ids / d vd).
- 7 gdsg (S) Conductance (d ids / d vg).
- 8 gdss (S) Conductance (d ids / d vs).
- 9 gdsb (S) Conductance (d ids / d vb).

Component Statements Part 2

```
10 cbd (F) Capacitance (d qb / d vd).
```

Parameter Index

ach	M-13	cgate	M-11	m I-4	tausc M-12
area	I-2	cgb	OP-17	mult I-1	tbox M-9
cbb	OP-13	cgd	OP-14	psat M-5	tnom M-16
cbd	OP-10	cgg	OP-15	pwr OP-1	tox M-7
cbg	OP-11	cgs	OP-16	qb OP-3	tr M-14
cbox	M-10	dch	M-8	qds OP-5	tref M-15
cbs	OP-12	dta	M-17	qg OP-4	trise M-18
cdsb	OP-21	gdsb	OP-9	region I-3	type M-1
cdsd	OP-18	gdsd	OP-6	ron M-2	vbox 0-4
cdsg	OP-19	gdsg	OP-7	ront 0-1	vp M-6

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Component Statements Part 2

cdss	OP-20	gdss	OP-8	rsat	0-2	vsat	M-4
cgate	0-5	ids	OP-2	rsat	M-3	vsatt	0-3

Compact MOS-Transistor Model (mos705)

Description

The mos705 model is a compact MOS-transistor model, intended for the simulation of circuit behavior with emphasis on analog applications. It is described in the Philips MOST Modelbook (Dec.93) as MOS model, level 705.

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In extension to the modelbook description a minimum conductance gmin is inserted between the drain and source node, to aid convergence. The value of gmin is set by an options statement, default = 1e-12 S.

This device is supported within altergroups.

This device is dynamically loaded from the shared object

/vobs/spectre dev/tools.sun4v/spectre/lib/cmi/2.0.doc/libphilips.so

Sample Instance Statement

```
mn1 (1 2 0 0) mna7 ln=120e-6 wn=12e-6
```

Sample Model Statement

model mna7 mos705 type=n vtn=0.853 betan=77e-6 tox=15e-9 vfb=-850e-3 tref=25 subthn=3 phi=0.645 lap=100e-9 gkn=-350e-9 thln=0.15 th2n=0.046 th3n=0.1 fnoise=1e-10

Instance Definition

Name d g s [b] ModelName parameter=value ...

Instance Parameters

1 wn=1.0 scale mDrawn channel width in the lay-out of the actual transistor. Scale set by option scale.

Component Statements Part 2

- 2 ln=1.0 scale mDrawn channel length in the lay-out of the actual transistor. Scale set by option scale.
- 3 w=1.0 scale mAlias for wn.
- 4 l=1.0 scale mAlias for ln.
- 5 mult=1Number of devices in parallel.
- 6 area=1Alias of mult.
- 7 region=triodeEstimated DC operating region, used as a convergence aid.

 Possible values are off, triode, sat, or subth.
- 8 m=1Multiplicity factor.

Model Definition

model modelName mos705 parameter=value ...

Model Parameters

- 1 type=nTransistor gender.
 - Possible values are n or p.
- 2 vtn=0 vThreshold voltage of the reference transistor at the reference temperature.
- 3 kon=0 \sqrt{V} Ko of the reference transistor.
- 4 kn=100m \sqrt{V} K of the reference transistor.
- 5 vsbxn=0 vvsbx of the reference transistor.
- 6 delvx=0 VDvsbx of the reference transistor.
- 7 thln=0 1/VThel of the reference transistor.
- 8 th2n=0 $1/\sqrt{V}$ The2 of the reference transistor.
- 9 th3n=0 1/VThe3 of the reference transistor at the reference temperature.
- 10 gamman=0Gam of the reference transistor.

Component Statements Part 2

- 11 shiftn=0 V^(1-n)Sh of the reference transistor.
- 12 nn=0N of the reference transistor.
- 13 pn=0 1/VP of the reference transistor.
- 14 ava=0A of the reference transistor.
- 15 avb=1 VB of the reference transistor.
- 16 avc=0C of the reference transistor.
- 17 wref=100u mEffective width of the reference transistor.
- 18 wtol=0 mDifference between drawn and effective gate width.
- 19 dvtn=0 V mNarrow-width factor of the threshold voltage at vsbref.
- 20 dkon=0 \sqrt{v} mNarrow-width factor of ko.
- 21 dkn=0 \sqrt{v} mNarrow-width factor of k.
- 22 dvsbxn=0 V mNarrow-width factor of vsbx.
- 23 ddelvx=0 VmNarrow-width factor of dvsbx.
- 24 betan=20u A/V²Gain factor of a infinite-square transistor at the reference temperature.
- 25 dthln=0 m/VNarrow-width factor of thel.
- 26 dth2n=0 m/ \sqrt{V} Narrow-width factor of the2.
- 27 dth3n=0 m/VNarrow-width factor of the3.
- 28 dgamn=0 mNarrow-width factor of gam.
- 29 dava=0 mNarrow-width factor of a.
- 30 davb=0 V mNarrow-width factor of b.
- 31 davc=0 mNarrow-width factor of c.
- 32 lref=100u mEffective length of the reference transistor.

Component Statements Part 2

- 33 ltol=0 mDifference between drawn and actual gate polysilicon length.
- 34 gvtn=0 V mShort-channel factor of the threshold voltage at vsbref.
- 35 gkon=0 \sqrt{V} mShort-channel factor of ko.
- 36 gkn=0 \sqrt{V} mShort-channel factor of k.
- 37 gvsbxn=0 V mShort-channel factor of vsbx.
- 38 gdelvx=0 V mShort-channel factor of dvsbx.
- 39 gthln=0 m/VShort-channel factor of thel.
- 40 gth2n=0 m/ \sqrt{V} Short-channel factor of the2.
- 41 gth3n=0 m/VShort-channel factor of the3.
- 42 ggamn=0 mShort-channel factor of gam.
- 43 gshift=0 $V^{(1-n)}$ m^2 Short-channel factor of sh.
- 44 gnn=0 mShort-channel factor of n.
- 45 gpn=0 m/VShort-channel factor of p.
- 46 gava=0 mShort-channel factor of a.
- 47 gavb=0 V mShort-channel factor of b.
- 48 gavc=0 mShort-channel factor of c.
- 49 lap=0 mHalf of the effective channel-length reduction due to lateral diffusion.
- 50 vsbref=0 vSource to bulk reference voltage for parameter determination.
- 51 phi=600m VDiffusion potential at the reference temperature.
- 52 tcvt=-1m V/KTemperature coefficient of vto.
- 53 tbetan=1.5Power temperature coefficient of bet.

Component Statements Part 2

- 54 tth3n=0 1/(V K) Temperature coefficient of the3.
- 55 tgth3n=0 m/(V K)Temperature coefficient of the length dependence of the3.
- 56 m=1.0 Subthreshold-slope factor at reference back bias and at the reference temperature.
- 57 subthn=0Weak-inversion factor.
- 58 vtr=0 vDepletion-MOS-transistor-transition voltage.
- 59 ratio=0Depletion-MOS-transistor-gain ratio.
- 60 vfb=0 vFlat-band voltage.
- 61 tox=100n mGate-oxide thickness.
- 62 col=0 F/mGate/drain or gate/source overlap capacitance per unit length.
- 63 fnoise=0 m² V²Flicker-noise factor.
- 64 thouse=0Thermal-noise factor.

Temperature parameters

- 65 tr (C) Reference temperature. Default set by option tnom.
- 66 tref (C) Alias of tr. Default set by option tnom.
- 67 tnom (C) Alias of tr. Default set by option tnom.
- 68 dta=0 KDeviation between the temperature of the transistor and the temperature of the circuit.
- 69 trise=0 KAlias of dta.

Output Parameters

- 1 weff (V) Effective channel width of the actual transistor.
- 2 leff (V) Effective channel length of the actual transistor.
- 3 twophif (V) Diffusion potential.

Component Statements Part 2

- 4 bet (A/V^2) Gain factor of the transistor.
- 5 k (\sqrt{V}) Body-effect factor.
- 6 ko (\sqrt{V}) Initial body-effect factor for dual k approach.
- 7 vsbx (V) Transition voltage for dual k approach.
- 8 dvsbx (V) Transition-voltage range for dual K approach.
- 9 vto (V)Threshold voltage.
- 10 von (V) Onset voltage of the superthreshold region.
- 11 the1 (1/V) Gate-bias-controlled transverse-field mobility reduction factor.
- 12 the2 $(1/\sqrt{V})$ Back-bias-controlled transverse-field mobility reduction factor.
- 13 the3 (1/V) Lateral-field mobility reduction factor (velocity saturation).
- 14 gamStatic-drain-feedback factor.
- 15 sh $(V^{(1-n)})$ Threshold-voltage-shift factor.
- 16 nThreshold-voltage-shift exponent.
- 17 p (1/V) Back-bias-shift factor.
- 18 me (\sqrt{V}) Auxiliary parameter for subthreshold-slope factor.
- 19 aWeak-avalanche multiplier.
- 20 b (V) Weak-avalanche exponent factor.
- 21 cSaturation-voltage reduction factor.
- 22 cox (F) Gate capacitance.
- 23 cgso (F) Gate/source-overlap capacitance.
- 24 cgdo (F) Gate/drain-overlap capacitance.
- 25 vtre (V) Depletion MOS transistor transition voltage.

Component Statements Part 2

- 26 ratioDepletion MOS transistor gain ratio.
- 27 vfbe (V) Flat band voltage.
- 28 vtemp (V) kT/q at actual device temperature.
- 29 gnoise (V²) Coefficient of the flicker noise for the actual transistor.
- 30 unoise (J) Coefficient of the thermal noise for the actual transistor.

Operating-Point Parameters

- 1 ide (A) Drain current.
- 2 ige (A) Gate current.
- 3 ise (A) Source current.
- 4 ibe (A) Bulk current.
- 5 vds (V) Drain-source voltage.
- 6 vgs (V) Gate-source voltage.
- 7 vsb (V) Source-bulk voltage.
- 8 ids (A) Drain-source current.
- 9 idb (A) Drain-bulk current.
- 10 isb (A) Source-bulk current.
- 11 pwr (W) Power.
- 12 vts (V) Vto including back-bias effects.
- 13 vgt (V) Effective gate drive including back-bias and drain effects.
- 14 vdss (V) Saturation voltage at actual bias.
- 15 gm (S) Transconductance (d ids / d vgs).
- 16 gmb (S) Bulk transconductance (d ids / d vbs).

Component Statements Part 2

17 gds (S) Output conductance (d ids / d vds). 18 cdd (F) Capacitance (d qd / d vd). 19 cdg (F) Capacitance (- d qd / d vg). 20 cds (F) Capacitance (- d qd / d vs). 21 cdb (F) Capacitance (- d qd / d vb). 22 cgd (F) Capacitance (- d qg / d vd). 23 cgg (F) Capacitance (d qg / d vg). 24 cgs (F) Capacitance (- d qg / d vs). 25 cgb (F) Capacitance (- d qg / d vb). 26 csd (F) Capacitance (-d qs/d vd). 27 csq (F) Capacitance (-d qs/d vq). 28 css (F) Capacitance (d qs / d vs). 29 csb (F) Capacitance (- d qs / d vb). 30 cbd (F) Capacitance (- d qb / d vd). 31 cbg (F) Capacitance (- d qb / d vg). 32 cbs (F) Capacitance (- d qb / d vs). 33 cbb (F) Capacitance (d qb / d vb). 34 uTransistor gain (gm/gds). 35 rout (Ω) Small signal output resistance (1/gds). 36 yearly (V) Equivalent Early voltage (|Id|/gds). 37 keff (\sqrt{V}) Describes body effect at actual bias. 38 beff (S/V) Effective beta at actual bias in the simple MOS model.

Component Statements Part 2

```
39 fug (Hz) Unity gain frequency at actual bias (gm/(2*pi*cox)).
```

```
40 sqrtsfw (V/\sqrt{Hz})
```

Input-referred RMS white noise voltage (sqrt(sth)/gm).

41 sqrtsff (V/\sqrt{Hz})

Input-referred RMS 1/f noise voltage at 1kHz (sqrt(gnoise/1000)).

42 fknee (Hz) Cross-over frequency above which white noise is dominant.

Parameter Index

a 0-19	dta M-68	k 0-5	the3 0-13
area I-6	dth1n M-25	keff OP-37	tnoise M-64
ava M-14	dth2n M-26	kn M-4	tnom M-67
avb M-15	dth3n M-27	ko 0-6	tox M-61
avc M-16	dvsbx 0-8	kon M-3	tr M-65
b 0-20	dvsbxn M-22	l I-4	tref M-66
beff OP-38	dvtn M-19	lap M-49	trise M-69
bet 0-4	fknee OP-42	leff O-2	tth3n M-54
betan M-24	fnoise M-63	ln I-2	twophif O-3
c 0-21	fug OP-39	lref M-32	type M-1
cbb OP-33	gam 0-14	ltol M-33	u OP-34
cbd OP-30	gamman M-10	m M-56	unoise 0-30
cbg OP-31	gava M-46	m I-8	vds OP-5
cbs OP-32	gavb M-47	me O-18	vdss OP-14
cdb OP-21	gavc M-48	mult I-5	vearly OP-36
cdd OP-18	gdelvx M-38	n 0-16	vfb M-60
cdg OP-19	gds OP-17	nn M-12	vfbe 0-27
cds OP-20	ggamn M-42	p 0-17	vgs OP-6
cgb OP-25	gkn M-36	phi M-51	vgt OP-13
cgd OP-22	gkon M-35	pn M-13	von 0-10
cgdo 0-24	gm OP-15	pwr OP-11	vsb OP-7
cgg OP-23	gmb OP-16	ratio M-59	vsbref M-50
cgs OP-24	gnn M-44	ratio 0-26	vsbx 0-7
cgso 0-23	gnoise 0-29	region I-7	vsbxn M-5

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Component Statements Part 2

col	M-62	gpn M-45	rout OP-35	vtemp 0-28
cox	0-22	gshift M-43	sh 0-15	vtn M-2
csb	OP-29	gth1n M-39	shiftn M-11	vto 0-9
csd	OP-26	gth2n M-40	sqrtsff OP-41	vtr M-58
csg	OP-27	gth3n M-41	sqrtsfw OP-40	vtre 0-25
CSS	OP-28	gvsbxn M-37	subthn M-57	vts OP-12
dava	M-29	gvtn M-34	tbetan M-53	w I-3
davb	M - 30	ibe OP-4	tcvt M-52	weff O-1
davc	M - 31	idb OP-9	tgth3n M-55	wn I-1
ddelv	x M-23	ide OP-1	th1n M-7	wref M-17
delvx	М-б	ids OP-8	th2n M-8	wtol M-18
dgamn	M - 28	ige OP-2	th3n M-9	
dkn	M-21	isb OP-10	the1 0-11	
dkon	M - 20	ise OP-3	the2 0-12	

Compact MOS-Transistor Model (mos902)

Description

The mos902 model is a compact MOS-transistor model, intended for the simulation of circuit behavior with emphasis on analog applications. It is described in the Philips MOST Modelbook (Feb.98) as MOS model, level 902. Information on how to obtain this document can be found on Source Link by searching for Philips.

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In extension to the modelbook description a minimum conductance <code>gmin</code> is inserted between the drain and source node, to aid convergence. The value of <code>gmin</code> is set by an options statement, default = 1e-12 S.

This device is supported within altergroups.

This device is dynamically loaded from the shared object

/vobs/spectre_dev/tools.sun4v/spectre/lib/cmi/2.0.doc/libphilips.so

Sample Instance Statement

```
mp1 (0 1 2 2) mos9pch w=10u l=2u area=1.5
```

Sample Model Statement

model mos9pch mos902 ler=0.93e-6 wer=20e-6 tref=27 vtor=1.11 kr=0.54 phibr=0.66 vsbxr=100 the1r=0.19 slk=-0.215e-6 swk=98e-9 swthe3=7.8e-9

Component Statements Part 2

Instance Definition

Name d g s [b] ModelName parameter=value ...

Instance Parameters

- 1 w=1.0 scale mDrawn channel width in the lay-out. Scale set by option scale.
- 2 1=1.0 scale mDrawn channel length in the lay-out. Scale set by option scale.
- 3 mult=1Number of devices in parallel.
- 4 area=1Alias of mult.
- 5 region=triodeEstimated DC operating region, used as a convergence aid.

 Possible values are off, triode, sat, or subth.
- 6 m=1Multiplicity factor.

Model Definition

model modelName mos902 parameter=value ...

Model Parameters

Device Type Parameters

1 type=nTransistor gender.

Possible values are n or p.

Geometry Parameters

- 2 ler=2.5e-6 mEffective channel length of the reference transistor.
- 3 wer=25e-6 mEffective channel width of the reference transistor.
- 4 lvar=0.3e-6 mDifference between the actual and the programmed poly-silicon gate length.
- 5 lap=0.1e-6 mEffective channel length reduction per side.

Component Statements Part 2

- 6 wvar=3e-6 mDifference between the actual and the programmed field-oxide opening.
- 7 wot=1e-6 mEffective channel width reduction per side.
- 8 wdog=0 mCharacteristic drawn gate width, below which dogboning appears.

Threshold-Voltage Parameters

- 9 vtor=0.8 vThreshold voltage at zero back-bias.
- 10 stvto=0.01 V/KCoefficient of the temperature dependence of vto.
- 11 slvto=0.5e-6 V mCoefficient of the length dependence of vto.
- 12 sl2vto=0 V m²Second coefficient of the length dependence of vto.
- 13 swvto=5e-6 V mCoefficient of the width dependence of vto.
- 14 kor=0.5 \sqrt{V} Low-backbias body factor.
- 15 slko=1e-6 \sqrt{V} m

Coefficient of the length dependence of ko.

16 swko=10e-6 \sqrt{V} m

Coefficient of the width dependence of ko.

- 17 kr=0.1 \sqrt{V} High-backbias body factor.
- 18 slk=0.5e-6 \sqrt{V} m

Coefficient of the length dependence of k.

19 swk=5e-6 \sqrt{V} m

Coefficient of the width dependence of k.

- 20 phibr=0.65 vSurface potential at strong inversion.
- 21 vsbxr=0.9 vTransition voltage for the dual-k-factor model.
- 22 slvsbx=0.5e-6 V mCoefficient of the length dependence of vsbx.
- 23 swvsbx=5e-6 V mCoefficient of the width dependence of vsbx.

Component Statements Part 2

Channel-Current Parameters

24 betsq=0.1e-3 A/V^2

Gain factor for an infinite square transistor.

- 25 etabet=0.5Exponent of the temperature dependence of the gain factor.
- 26 the1r=0.05 1/VCoefficient of the mobility reduction due to the gate-induced field.
- 27 stthelr=3e-3 1/(V K)

Coefficient of the temperature dependence of the1.

- 28 slthe1r=50e-9 m/VCoefficient of the length dependence of the1.
- 29 stlthe1=5e-9 m/(V K)

Coefficient of the temperature dependence of slthe1.

- 30 swthe1=1e-6 m/VCoefficient of the width dependence of the1.
- 31 fthe1=0Coefficient describing the width dependence of the1 for w < wdog.
- 32 the2r=17e-3 $1/\sqrt{V}$

Coefficient of the mobility reduction due to the back-bias.

33 stthe2r=0.1e-3 $1/(\sqrt{V})$ K)

Coefficient of the temperature dependence of the 2.

34 slthe2r=5e-9 m/\sqrt{V}

Coefficient of the length dependence of the 2.

35 stlthe2=0.5e-9 m/(\sqrt{V} K)

Coefficient of the temperature dependence of slthe2.

36 swthe2=0.1e-6 m/ \sqrt{V}

Coefficient of the width dependence of the2.

- 37 the 3r = 37e 3 1/V Coefficient of the mobility reduction due to the lateral field.
- 38 stthe3r=0.1e-3 1/(V K)

Coefficient of the temperature dependence of the 3.

39 slthe3r=5e-9 m/VCoefficient of the length dependence of the3.

Component Statements Part 2

40 stlthe3=0.5e-9 m/(V K)

Coefficient of the temperature dependence of slthe3.

41 swthe3=0.1e-6 m/VCoefficient of the width dependence of the3.

Drain-Feedback Parameters

42 gam1r=40e-3 V^(1-etads)

Coefficient for the drain induced threshold shift for large gate drive.

43 slgam1=0.1e-6 V^(1-etads) m

Coefficient of the length dependence of gam1.

44 swgam1=1e-6 V^(1-etads) m

Coefficient of the width dependence of gam1.

- 45 etadsr=0.6Exponent of the vds dependence of gam1.
- 46 alpr=4e-3Factor of the channel-length modulation.
- 47 etaalp=0.5Exponent of the length dependence of alp.
- 48 slalp=0.14e-3 m^etaalp

Coefficient of the length dependence of alp.

- 49 swalp=0.1e-6 mCoefficient of the width dependence of alp.
- 50 vpr=0.25 vCharacteristic voltage of the channel-length modulation.

Sub-threshold Parameters

- 51 gamoor=1.1e-3Coefficient for the drain induced threshold shift at zero gate drive.
- $52 \text{ slgamoo}=10e-15 \text{ m}^2$

Coefficient of the length dependence of gamoo.

- 53 etagamr=2Exponent of the back-bias dependence of gamo.
- 54 mor=0.3Factor for the subthreshold slope.
- 55 stmo=0.01 1/KCoefficient of the temperature dependence of mo.

Component Statements Part 2

- 56 slmo=1.4e-3 \sqrt{m}
- Coefficient of the length dependence of mo.
- 57 etamr=2Exponent of the back-bias dependence of m.
- 58 zet1r=0.7Weak-inversion correction factor.
- 59 etazet=0.5Exponent of the length dependence of zet1.
- 60 slzet1=0.14e-6 m^etazet
 - Coefficient of the length dependence of zet1.
- 61 vsbtr=99 VLimiting voltage of the vsb dependence of m and gamo.
- 62 slvsbt=10e-6 V mCoefficient of the length dependence of vsbt.

Weak-Avalanche Parameters

- 63 alr=22Factor of the weak-avalanche current.
- 64 sta1=0.1 1/KCoefficient of the temperature dependence of a1.
- 65 sla1=10e-6 mCoefficient of the length dependence of a1.
- 66 swa1=0.1e-3 mCoefficient of the width dependence of a1.
- 67 a2r=33 VExponent of the weak-avalanche current.
- 68 sla2=10e-6 V mCoefficient of the length dependence of a2.
- 69 swa2=0.1e-3 V mCoefficient of the width dependence of a2.
- 70 a3r=0.6Factor of the drain-source voltage above which weak-avalanche occurs.
- 71 sla3=1e-6 mCoefficient of the length dependence of a3.
- 72 swa3=10e-6 mCoefficient of the width dependence of a3.

Charge Parameters

73 tox=20e-9 mThickness of the oxide layer.

Component Statements Part 2

74 col=50e-12 F/mGate overlap capacitance per unit channel width.

Noise Parameters

- 75 ntr=21e-21 JCoefficient of the thermal noise.
- 76 nfr=16e-12 V²Coefficient of the flicker noise.

Temperature Parameters

- 77 tr (C) Reference temperature. Default set by option tnom.
- 78 tref (C) Alias of tr. Default set by option tnom.
- 79 tnom (C) Alias of tr. Default set by option tnom.
- 80 dta=0 KTemperature offset of the device.
- 81 trise=0 KAlias of dta.

Output Parameters

- 1 le (m) Effective channel length.
- 2 we (m) Effective channel width.
- 3 vto (V) Threshold voltage at zero back-bias.
- 4 ko (\sqrt{V}) Low-backbias body factor.
- 5 k (\sqrt{V}) High-backbias body factor.
- 6 phib (V) Surface potential at strong inversion.
- 7 vsbx (V) Transition voltage for the dual-k-factor model.
- 8 bet (A/V^2) Gain factor (* mult).
- 9 the1 (1/V) Coefficient of the mobility reduction due to the gate-induced field.
- 10 the2 $(1/\sqrt{V})$ Coefficient of the mobility reduction due to the back-bias.

Component Statements Part 2

- 11 the3 (1/V) Coefficient of the mobility reduction due to the lateral field.
- 12 gam1 (V^(1-etads)) Coefficient for the drain induced threshold shift for large gate drive.
- 13 etads Exponent of the vds dependence of gam1.
- 14 alpFactor of the channel-length modulation.
- 15 vp (V) Characteristic voltage of the channel-length modulation.
- 16 gamooCoefficient for the drain induced threshold shift at zero gate drive.
- 17 etagamExponent of the back-bias dependence of gamo.
- 18 moFactor for the subthreshold slope.
- 19 etamExponent of the back-bias dependence of m.
- 20 phit (V) Thermal voltage.
- 21 zet1Weak-inversion correction factor.
- 22 vsbt (V) Limiting voltage of the vsb dependence of m and gamo.
- 23 al Factor of the weak-avalanche current.
- 24 a2 (V) Exponent of the weak-avalanche current.
- 25 a3Factor of the drain-source voltage above which weak-avalanche occurs.
- 26 COX (F) Gate-to-channel capacitance (* mult).
- 27 cgdo (F) Gate-drain overlap capacitance (* mult).
- 28 cgso (F) Gate-source overlap capacitance (* mult).
- 29 nt (J) Coefficient of the thermal noise.
- 30 nf (V^2) Coefficient of the flicker noise (/ mult).

Component Statements Part 2

Operating-Point Parameters

- 1 ide (A) Resistive drain current.
- 2 ige (A) Resistive gate current.
- 3 ise (A) Resistive source current.
- 4 ibe (A) Resistive bulk current.
- 5 vds (V) Drain-source voltage.
- 6 vgs (V) Gate-source voltage.
- 7 vsb (V) Source-bulk voltage.
- 8 ids (A) Resistive drain-source current.
- 9 idb (A) Resistive drain-bulk current.
- 10 isb (A) Resistive source-bulk current.
- 11 iavl (A) Substrate current.
- 12 pwr (W) Power.
- 13 vt1 (V) Vto including backbias effects.
- 14 vgt2 (V) Effective gate drive including backbias and drain effects.
- 15 vdss1 (V) Saturation voltage at actual bias.
- 16 vsat (V) Saturation limit.
- 17 gm (S) Transconductance (d ids / d vgs).
- 18 gmb (S) Bulk transconductance (d ids / d vbs).
- 19 gds (S) Output conductance (d ids / d vds).
- 20 cdd (F) Capacitance (d qd / d vd).
- 21 cdg (F) Capacitance (- d qd / d vg).

Component Statements Part 2

```
22 cds (F) Capacitance (- d qd / d vs).
23 cdb (F) Capacitance (-d qd/d vb).
24 cgd (F) Capacitance (- d qg / d vd).
25 cgg (F) Capacitance (d qg / d vg).
26 cgs (F) Capacitance (- d qg / d vs).
27 cgb (F) Capacitance (- d qg / d vb).
28 csd (F) Capacitance (-d qs/d vd).
29 csg (F) Capacitance (- d qs / d vg).
30 css (F) Capacitance (d qs / d vs).
31 csb (F) Capacitance (-d qs/d vb).
32 cbd (F) Capacitance (- d qb / d vd).
33 cbg (F) Capacitance (- d qb / d vg).
34 cbs (F) Capacitance (- d qb / d vs).
35 cbb (F) Capacitance (d qb / d vb).
36 uTransistor gain (gm/gds).
37 rout (\Omega) Small signal output resistance (1/gds).
38 vearly (V) Equivalent Early voltage (|id|/gds).
39 keff (\sqrt{V}) Describes body effect at actual bias.
40 beff (S/V) Effective beta at actual bias in the simple MOS model (2*|ids|/vgt2^2).
41 fug (Hz) Unity gain frequency at actual bias (gm/(2*pi*cin)).
42 sqrtsfw (V/√Hz )
```

Input-referred RMS white noise voltage (sqrt(sth)/gm).

Component Statements Part 2

43 sqrtsff (V/\sqrt{Hz})

Input-referred RMS 1/f noise voltage at 1kHz (sqrt(nf/1000)).

44 fknee (Hz) Cross-over frequency above which white noise is dominant.

Parameter Index

a1 0-23	etazet M-59	region I-5	swvto M-13
alr M-63	fknee OP-44	rout OP-37	the1 0-9
a2 0-24	fthe1 M-31	sl2vto M-12	the1r M-26
a2r M-67	fug OP-41	sla1 M-65	the2 0-10
a3 0-25	gam1 0-12	sla2 M-68	the2r M-32
a3r M-70	gam1r M-42	sla3 M-71	the3 0-11
alp 0-14	gamoo 0-16	slalp M-48	the3r M-37
alpr M-46	gamoor M-51	slgam1 M-43	tnom M-79
area I-4	gds OP-19	slgamoo M-52	tox M-73
beff OP-40	gm OP-17	slk M-18	tr M-77
bet 0-8	gmb OP-18	slko M-15	tref M-78
betsq M-24	iavl OP-11	slmo M-56	trise M-81
cbb OP-35	ibe OP-4	slthe1r M-28	type M-1
cbd OP-32	idb OP-9	slthe2r M-34	u OP-36
cbg OP-33	ide OP-1	slthe3r M-39	vds OP-5
cbs OP-34	ids OP-8	slvsbt M-62	vdss1 OP-15
cdb OP-23	ige OP-2	slvsbx M-22	vearly OP-38
cdd OP-20	isb OP-10	slvto M-11	vgs OP-6
cdg OP-21	ise OP-3	slzet1 M-60	vgt2 OP-14
cds OP-22	k 0-5	sqrtsff OP-43	vp 0-15
cgb OP-27	keff OP-39	sqrtsfw OP-42	vpr M-50
cgd OP-24	ko 0-4	stal M-64	vsat OP-16
cgdo 0-27	kor M-14	stlthe1 M-29	vsb OP-7
cgg OP-25	kr M-17	stlthe2 M-35	vsbt 0-22
cgs OP-26	1 I-2	stlthe3 M-40	vsbtr M-61
cgso 0-28	lap M-5	stmo M-55	vsbx 0-7
col M-74	le 0-1	stthe1r M-27	vsbxr M-21
cox 0-26	ler M-2	stthe2r M-33	vt1 OP-13
csb OP-31	lvar M-4	stthe3r M-38	vto 0-3
csd OP-28	m I-6	stvto M-10	vtor M-9
csg OP-29	mo O-18	swal M-66	w I-1

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Component Statements Part 2

css OP-30	mor M-54	swa2 M-69	wdog M-8
dta M-80	mult I-3	swa3 M-72	we 0-2
etaalp M-47	nf O-30	swalp M-49	wer M-3
etabet M-25	nfr M-76	swgam1 M-44	wot M-7
etads 0-13	nt 0-29	swk M-19	wvar M-6
etadsr M-45	ntr M-75	swko M-16	zet1 0-21
etagam 0-17	phib 0-6	swthe1 M-30	zet1r M-58
etagamr M-53	phibr M-20	swthe2 M-36	
etam 0-19	phit O-20	swthe3 M-41	
etamr M-57	pwr OP-12	swvsbx M-23	

Compact MOS-Transistor Model (mos903)

Description

The mos903 model is a compact MOS-transistor model, intended for the simulation of circuit behavior with emphasis on analog applications. It is described in the Philips MOST Modelbook (Jun.98) as MOS model, level 903. Information on how to obtain this document can be found on Source Link by searching for Philips.

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In extension to the modelbook description a minimum conductance gmin is inserted between the drain and source node, to aid convergence. The value of gmin is set by an options statement, default = 1e-12 S.

This device is supported within altergroups.

This device is dynamically loaded from the shared object

/vobs/spectre_dev/tools.sun4v/spectre/lib/cmi/2.0.doc/libphilips.so

Sample Instance Statement

```
m 1 (1 2 0 0) mos9nch w=0.35e-6 l=0.35e-6
```

Sample Model Statement

```
model mos9nch mos903 ler=3.5e-7 wer=1e-5 lvar=0 lap=2.2e-8 wvar=0 wot=3e-8 vtor=0.76 thelr=0.67 stthelr=-1.76e-3 etaalp=0 slalp=0 alpr=0.01
```

Instance Definition

```
Name d g s [b] ModelName parameter=value ...
```

Component Statements Part 2

Instance Parameters

- 1 w=1.0 scale mDrawn channel width in the lay-out. Scale set by option scale.
- 2 1=1.0 scale mDrawn channel length in the lay-out. Scale set by option scale.
- 3 mult=1Number of devices in parallel.
- 4 area=1Alias of mult.
- 5 region=triodeEstimated DC operating region, used as a convergence aid.

 Possible values are off, triode, sat, or subth.
- 6 m=1Multiplicity factor.

Model Definition

model modelName mos903 parameter=value ...

Model Parameters

Device Type Parameters

1 type=nTransistor gender.

Possible values are n or p.

Geometry Parameters

- 2 ler=2.5e-6 mEffective channel length of the reference transistor.
- 3 wer=25e-6 mEffective channel width of the reference transistor.
- 4 lvar=0.3e-6 mDifference between the actual and the programmed poly-silicon gate length.
- 5 lap=0.1e-6 mEffective channel length reduction per side.
- 6 wvar=3e-6 mDifference between the actual and the programmed field-oxide opening.
- 7 wot=1e-6 mEffective channel width reduction per side.

Component Statements Part 2

Threshold-Voltage Parameters

8 vtor=0.8 vThreshold voltage at zero back-bias.

9 stvto=0.01 V/KCoefficient of the temperature dependence of vto.

10 slvto=0.5e-6 V mCoefficient of the length dependence of vto.

11 sl2vto=0 V m^2 Second coefficient of the length dependence of vto.

12 swvto=5e-6 V mCoefficient of the width dependence of vto.

13 kor=0.5 \sqrt{V} Low-backbias body factor.

14 slko=1e-6 \sqrt{V} m

Coefficient of the length dependence of ko.

15 swko=10e-6 \sqrt{V} m

Coefficient of the width dependence of ko.

16 kr=0.1 \sqrt{V} High-backbias body factor.

17 slk=0.5e-6 \sqrt{V} m

Coefficient of the length dependence of k.

18 swk=5e-6 \sqrt{V} m

Coefficient of the width dependence of k.

19 phibr=0.65 vSurface potential at strong inversion.

20 vsbxr=0.9 vTransition voltage for the dual-k-factor model.

21 slvsbx=0.5e-6 V mCoefficient of the length dependence of vsbx.

22 swvsbx=5e-6 V mCoefficient of the width dependence of vsbx.

Channel-Current Parameters

23 betsq=0.1e-3 A/V^2

Gain factor for an infinite square transistor.

24 etabet=0.5Exponent of the temperature dependence of the gain factor.

Component Statements Part 2

25 the1r=0.05 1/VCoefficient of the mobility reduction due to the gate-induced field.

26 stthe1r=3e-3 1/(V K)

Coefficient of the temperature dependence of the1.

- 27 slthe1r=50e-9 m/VCoefficient of the length dependence of the1.
- 28 stlthe1=5e-9 m/(V K)

Coefficient of the temperature dependence of slthe1.

- 29 swthe1=1e-6 m/VCoefficient of the width dependence of the1.
- 30 wdog=0 mCharacteristic drawn gate width, below which dogboning appears.
- 31 fthe1=0Coefficient describing the width dependence of the1 for w < wdog.
- 32 the2r=17e-3 $1/\sqrt{V}$

Coefficient of the mobility reduction due to the back-bias.

33 stthe2r=0.1e-3 $1/(\sqrt{V})$ K)

Coefficient of the temperature dependence of the 2.

34 slthe2r=5e-9 m/ \sqrt{V}

Coefficient of the length dependence of the 2.

35 stlthe2=0.5e-9 m/(\sqrt{V} K)

Coefficient of the temperature dependence of slthe2.

36 swthe2=0.1e-6 m/ \sqrt{V}

Coefficient of the width dependence of the 2.

- 37 the3r=37e-3 1/VCoefficient of the mobility reduction due to the lateral field.
- 38 stthe3r=0.1e-3 1/(V K)

Coefficient of the temperature dependence of the 3.

- 39 slthe3r=5e-9 m/VCoefficient of the length dependence of the3.
- 40 stlthe3=0.5e-9 m/(V K)

Coefficient of the temperature dependence of slthe3.

41 swthe3=0.1e-6 m/VCoefficient of the width dependence of the3.

Component Statements Part 2

Drain-Feedback Parameters

42 gamlr=40e-3 V^(1-etads)

Coefficient for the drain induced threshold shift for large gate drive.

43 slgam1=0.1e-6 V^(1-etads) m

Coefficient of the length dependence of gam1.

44 swgam1=1e-6 $V^{(1-etads)}$ m

Coefficient of the width dependence of gam1.

- 45 etadsr=0.6Exponent of the vds dependence of gam1.
- 46 alpr=4e-3Factor of the channel-length modulation.
- 47 etaalp=0.5Exponent of the length dependence of alp.
- 48 slalp=0.14e-3 m^etaalp

Coefficient of the length dependence of alp.

- 49 swalp=0.1e-6 mCoefficient of the width dependence of alp.
- 50 vpr=0.25 vCharacteristic voltage of the channel-length modulation.

Sub-Threshold Parameters

- 51 gamoor=1.1e-3Coefficient for the drain induced threshold shift at zero gate drive.
- $52 \text{ slgamoo}=10e-15 \text{ m}^2$

Coefficient of the length dependence of gamoo.

- 53 etagamr=2Exponent of the back-bias dependence of gamo.
- 54 mor=0.3Factor for the subthreshold slope.
- 55 stmo=0.01 1/KCoefficient of the temperature dependence of mo.
- 56 slmo=1.4e-3 \sqrt{m}

Coefficient of the length dependence of mo.

57 etamr=2Exponent of the back-bias dependence of m.

Component Statements Part 2

- 58 zet1r=0.7Weak-inversion correction factor.
- 59 etazet=0.5Exponent of the length dependence of zet1.
- 60 slzet1=0.14e-6 m^etazet

 Coefficient of the length dependence of zet1.
- 61 vsbtr=99 vLimiting voltage of the vsb dependence of m and gamo.
- 62 slvsbt=10e-6 V mCoefficient of the length dependence of vsbt.

Weak-Avalanche Parameters

- 63 alr=22Factor of the weak-avalanche current.
- 64 sta1=0.1 1/KCoefficient of the temperature dependence of a1.
- 65 sla1=10e-6 mCoefficient of the length dependence of a1.
- 66 swa1=0.1e-3 mCoefficient of the width dependence of a1.
- 67 a2r=33 VExponent of the weak-avalanche current.
- 68 sla2=10e-6 V mCoefficient of the length dependence of a2.
- 69 swa2=0.1e-3 V mCoefficient of the width dependence of a2.
- 70 a3r=0.6Factor of the drain-source voltage above which weak-avalanche occurs.
- 71 sla3=1e-6 mCoefficient of the length dependence of a3.
- 72 swa3=10e-6 mCoefficient of the width dependence of a3.

Charge Parameters

- 73 tox=20e-9 mThickness of the oxide layer.
- 74 col=50e-12 F/mGate overlap capacitance per unit channel width.

Noise Parameters

75 ntr=21e-21 JCoefficient of the thermal noise.

Component Statements Part 2

- 76 nfmod=0.0Switch that selects either old or new flicker noise model.
- 77 nfr=16e-12 V^2 Flicker noise coefficient of the reference transistor (for nfmod =1).
- 78 nfar=7.15e+22 $1/(V m^4)$

First coefficient of the flicker noise coefficient of the reference transistor (for nfmod=1).

79 nfbr=2.16e+7 $1/(V m^2)$

Second coefficient of the flicker noise coefficient of the reference transistor (for nfmod=1).

80 nfcr=0.0 1/VThird coefficient of the flicker noise coefficient of the reference transistor (for nfmod=1).

Temperature Parameters

- 81 tr (C) Reference temperature. Default set by option tnom.
- 82 tref (C) Alias of tr. Default set by option tnom.
- 83 tnom (C) Alias of tr. Default set by option tnom.
- 84 dta=0 KTemperature offset of the device.
- 85 trise=0 KAlias of dta.

Other Parameters

86 th3mod=1Flag for theta3 clipping.

Output Parameters

- 1 le (m) Effective channel length.
- 2 we (m) Effective channel width.
- 3 vto (V) Threshold voltage at zero back-bias.
- 4 ko (\sqrt{V}) Low-backbias body factor.

Component Statements Part 2

- 5 k (\sqrt{V}) High-backbias body factor.
- 6 phib (V) Surface potential at strong inversion.
- 7 vsbx (V) Transition voltage for the dual-k-factor model.
- 8 bet (A/V^2) Gain factor (* mult).
- 9 the1 (1/V) Coefficient of the mobility reduction due to the gate-induced field.
- 10 the2 $(1/\sqrt{V})$ Coefficient of the mobility reduction due to the back-bias.
- 11 the3 (1/V) Coefficient of the mobility reduction due to the lateral field.
- 12 gam1 (V^(1-etads)) Coefficient for the drain induced threshold shift for large gate drive.
- 13 etads Exponent of the vds dependence of gam1.
- 14 alpFactor of the channel-length modulation.
- 15 vp (V) Characteristic voltage of the channel-length modulation.
- 16 gamooCoefficient for the drain induced threshold shift at zero gate drive.
- 17 etagamExponent of the back-bias dependence of gamo.
- 18 moFactor for the subthreshold slope.
- 19 etamExponent of the back-bias dependence of m.
- 20 phit (V) Thermal voltage.
- 21 zet1Weak-inversion correction factor.
- 22 vsbt (V) Limiting voltage of the vsb dependence of m and gamo.
- 23 alFactor of the weak-avalanche current.
- 24 a2 (V) Exponent of the weak-avalanche current.
- 25 a3Factor of the drain-source voltage above which weak-avalanche occurs.

Component Statements Part 2

- 26 cox (F) Gate-to-channel capacitance (* mult).
- 27 cgdo (F) Gate-drain overlap capacitance (* mult).
- 28 cgso (F) Gate-source overlap capacitance (* mult).
- 29 nt (J) Coefficient of the thermal noise.
- 30 nf (V^2) Coefficient of the flicker noise (/ mult) (nfmod = 0).
- 31 nfa $(1/(V m^4))$ First coefficient of the flickernoise of the actual transistor (nfmod = 1).
- 32 nfb $(1/(V m^2))$ Second coefficient of the flickernoise of the actual transistor (nfmod = 1).
- 33 nfc (1/V) Second coefficient of the flickernoise of the actual transistor (nfmod = 1).
- 34 tox (m) Thickness of gate oxide layer.

Operating-Point Parameters

- 1 ide (A) Resistive drain current.
- 2 ige (A) Resistive gate current.
- 3 ise (A) Resistive source current.
- 4 ibe (A) Resistive bulk current.
- 5 vds (V) Drain-source voltage.
- 6 vgs (V) Gate-source voltage.
- 7 vsb (V) Source-bulk voltage.
- 8 ids (A) Resistive drain-source current.
- 9 idb (A) Resistive drain-bulk current.
- 10 isb (A) Resistive source-bulk current.
- 11 iavl (A) Substrate current.

Component Statements Part 2

- 12 pwr (W) Power.
- 13 vt1 (V) Vto including backbias effects.
- 14 vgt2 (V) Effective gate drive including backbias and drain effects.
- 15 vdss1 (V) Saturation voltage at actual bias.
- 16 vsat (V) Saturation limit.
- 17 gm (S) Transconductance (d ids / d vgs).
- 18 gmb (S) Bulk transconductance (d ids / d vbs).
- 19 gds (S) Output conductance (d ids / d vds).
- 20 cdd (F) Capacitance (d qd / d vd).
- 21 cdg (F) Capacitance (- d qd / d vg).
- 22 cds (F) Capacitance (-d qd/d vs).
- 23 cdb (F) Capacitance (- d qd / d vb).
- 24 cgd (F) Capacitance (- d qg / d vd).
- 25 cgg (F) Capacitance (d qg / d vg).
- 26 cgs (F) Capacitance (- d qg / d vs).
- 27 cgb (F) Capacitance (- d qg / d vb).
- 28 csd (F) Capacitance (-d qs/d vd).
- 29 csg (F) Capacitance (- d qs / d vg).
- 30 css (F) Capacitance (d qs / d vs).
- 31 csb (F) Capacitance (- d qs / d vb).
- 32 cbd (F) Capacitance (- d qb / d vd).
- 33 cbg (F) Capacitance (- d qb / d vg).

Component Statements Part 2

```
34 cbs (F) Capacitance (- d qb / d vs).
```

- 35 cbb (F) Capacitance (d qb / d vb).
- 36 uTransistor gain (gm/gds).
- 37 rout (Ω) Small signal output resistance (1/gds).
- 38 vearly (V) Equivalent Early voltage (|id|/gds).
- 39 keff (\sqrt{V}) Describes body effect at actual bias.
- 40 beff (S/V) Effective beta at actual bias in the simple MOS model (2*|ids|/vgt2^2).
- 41 fug (Hz) Unity gain frequency at actual bias (gm/(2*pi*cin)).
- 42 sqrtsfw (V/\sqrt{Hz})

Input-referred RMS white noise voltage (sqrt(sth)/gm).

43 sqrtsff (V/\sqrt{Hz})

Input-referred RMS 1/f noise voltage at 1kHz (sqrt(nf/1000)).

44 fknee (Hz) Cross-over frequency above which white noise is dominant.

Parameter Index

a1	0-23	fthe1 M-31	phibr M-19	swvsbx M-22
alr	M-63	fug OP-41	phit O-20	swvto M-12
a2	0-24	gam1 0-12	pwr OP-12	th3mod M-86
a2r	M-67	gamlr M-42	region I-5	the1 0-9
a3	0-25	gamoo 0-16	rout OP-37	the1r M-25
a3r	M - 70	gamoor M-51	sl2vto M-11	the2 0-10
alp	0-14	gds OP-19	sla1 M-65	the2r M-32
alpr	M-46	gm OP-17	sla2 M-68	the3 0-11
area	I-4	gmb OP-18	sla3 M-71	the3r M-37
beff	OP-40	iavl OP-11	slalp M-48	tnom M-83

Component Statements Part 2

bet 0-8	ibe OP-4	slgam1 M-43	tox M-73
betsq M-23	idb OP-9	slgamoo M-52	tox 0-34
cbb OP-35	ide OP-1	slk M-17	tr M-81
cbd OP-32	ids OP-8	slko M-14	tref M-82
cbg OP-33	ige OP-2	slmo M-56	trise M-85
cbs OP-34	isb OP-10	slthe1r M-27	type M-1
cdb OP-23	ise OP-3	slthe2r M-34	u OP-36
cdd OP-20	k 0-5	slthe3r M-39	vds OP-5
cdg OP-21	keff OP-39	slvsbt M-62	vdss1 OP-15
cds OP-22	ko 0-4	slvsbx M-21	vearly OP-38
cgb OP-27	kor M-13	slvto M-10	vgs OP-6
cgd OP-24	kr M-16	slzet1 M-60	vgt2 OP-14
cgdo 0-27	1 I-2	sqrtsff OP-43	vp 0-15
cgg OP-25	lap M-5	sqrtsfw OP-42	vpr M-50
cgs OP-26	le 0-1	stal M-64	vsat OP-16
cgso 0-28	ler M-2	stlthe1 M-28	vsb OP-7
col M-74	lvar M-4	stlthe2 M-35	vsbt 0-22
cox 0-26	m I-6	stlthe3 M-40	vsbtr M-61
csb OP-31	mo O-18	stmo M-55	vsbx 0-7
csd OP-28	mor M-54	stthe1r M-26	vsbxr M-20
csg OP-29	mult I-3	stthe2r M-33	vt1 OP-13
css OP-30	nf O-30	stthe3r M-38	vto 0-3
dta M-84	nfa 0-31	stvto M-9	vtor M-8
etaalp M-47	nfar M-78	swa1 M-66	w I-1
etabet M-24	nfb O-32	swa2 M-69	wdog M-30
etads 0-13	nfbr M-79	swa3 M-72	we 0-2
etadsr M-45	nfc O-33	swalp M-49	wer M-3
etagam 0-17	nfcr M-80	swgam1 M-44	wot M-7
etagamr M-53	nfmod M-76	swk M-18	wvar M-6
etam 0-19	nfr M-77	swko M-15	zet1 0-21
etamr M-57	nt 0-29	swthel M-29	zet1r M-58
etazet M-59	ntr M-75	swthe2 M-36	
fknee OP-44	phib 0-6	swthe3 M-41	

Microstrip Line (msline)

Description

This is a microstrip line based on the equations of Hammerstad and Jensen. The model contains a thickness correction to the width and frequency dependent permittivity and characteristic impedance. The dispersion equations are those of Kirschning and Jansen.

This device is supported within altergroups.

Component Statements Part 2

Sample Instance Statement

```
tl1 (in 0 out 0) msline l=0.15 w=0.01 h=0.01
```

Instance Definition

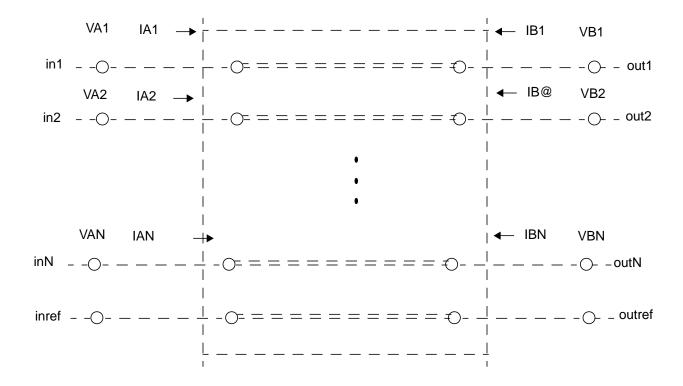
```
Name t1 b1 t2 b2 msline parameter=value ...
```

Instance Parameters

- 1 1=0 mLength.
- 2 w (m) Width.
- 3 h (m) Substrate height.
- 4 t=0 mConductor thickness.
- 5 eps=1Substrate permittivity relative to a vacuum.
- 6 m=1Multiplicity factor.
- 7 fmax=10e9 HzMaximum signal frequency.

Multi-Conductor Transmission Line (mtline)

Description



A multi-conductor transmission line (mtline) is characterized by constant RLGC matrices or frequency dependent RLGC data. An mtline can have as many conductors as there are as described in the input, however, there must be at least two conductors with one conductor used as reference to define terminal voltages. The reference conductor can be ground. The order of the conductors is the same as the order of the data in the input.

All of the conductors are assumed to have the same length, the input to mtline are conductor length, per-unit-length resistance (R), inductance (L), conductance (G), and capacitance (C) matrices. Because these matrices are generally symmetric, either full matrix description or lower half matrix description can be used. For example, to describe the resistance matrix of a four conductor mtline:

[50 10 1]

Component Statements Part 2

The following two model descriptions are equivalent:

model line mtline

- + r=[50 10 1
- + 10 50 10
- + 1 10 50]

+ ...

model line mtline

- + r = [50]
- + 10 50
- + 1 10 50]

+ ...

Frequency dependent RLGC matrices are described in a data file through model parameter file. The frequency axis can be scaled with the scale parameter. The frequencies in the data file are then multiplied by scale before the simulator uses them. The default scale factor is unity. An example data file is listed below:

; Comments: rl.dat

FORMAT FREQ: R1:1 R2:1 R2:2

L1:1 L2:1 L2:2

0.001e+9: 4.444 0.000383 4.444

4.565 0.3545 4.565

0.010e+9: 4.447 0.003834 4.447

4.565 0.3545 4.565

0.100e+9 4.476 0.03834 4.476

Component Statements Part 2

```
4.565 0.3545 4.565

1.000e+9 4.762 0.3834 4.762
3.103 0.2357 3.103

10.00e+9 13.96 1.082 13.96
2.718 0.2058 2.718

100.0e+9 56.88 3.294 56.88
2.531 0.1866 2.531
```

Constant matrix is the first choice of input if both the constant matrix and tabular data are provided. If only one frequency point is provided in the file, the RLGC matrices are treated as constant matrices.

Rational fitting is used to build a stable model for each mtline instance. The fitting procedure can take a long time for complicated data, the reduced order model (ROM) file option romdatfile is used to store and re-use the model in subsequent simulations.

Maximum signal frequency fmax is used to determine the relevant range of rational fitting. The inverse of trise in input signal can be used as an estimation of fmax.

This device is not supported within altergroup.

Sample Instance Statement

Sample Model Statement

```
model mtmodel mtline
+ r=[ 0.3
+     0.0 0.3 ]
+ c=[ 0.35p
+     -0.03p 0.35p ]
model mtmodel mtline
+ r=[ 0.3 0.0
```

Component Statements Part 2

```
+ 0.0 0.3 ]
+ c=[ 0.35p -0.03p
+ -0.03p 0.35p ]
model mtmodel mtline
+ c=[ 0.35p
+ -0.03p 0.35p ]
+ file="rl.data" scale=1
```

Instance Definition

```
Name in1 out1 in2 out2 ... ModelName parameter=value ...
Name in1 out1 in2 out2 ... mtline parameter=value ...
```

The last two terminals will be used as refin and refout respectively.

Instance Parameters

- 1 len=0.01 mPhysical length of line.
- 2 m=1Multiplicity factor.
- 3 r=[...] Ω/m Resistance matrix per unit length.
- 4 l=[...] H/mInductance matrix per unit length.
- 5 g=[...] S/mConductor matrix per unit length.
- 6 c=[...] F/mCapacitance matrix per unit length.
- 7 rskin=[...] Ω /mSkin effect resistance matrix per unit length.
- 8 gdloss=[...] S/mDielectric loss conductance matrix per unit length.
- 9 fileRLGC data file that contains the frequency dependent RLGC data.
- 10 freqscale=1Frequency scale factor for frequency dependent RLGC data.
- 11 romdatfile="rom.dat"

File that contains the time-domain reduced order model (ROM).

Model Definition

```
model modelName mtline parameter=value ...
```

Component Statements Part 2

Model Parameters

RLGC Data Parameters

- 1 r=[...] $\Omega/mResistance matrix per unit length.$
- 2 l=[...] H/mlnductance matrix per unit length.
- 3 g=[...] S/mConductor matrix per unit length.
- 4 c=[...] F/mCapacitance matrix per unit length.
- 5 rskin=[...] Ω /mSkin effect resistance matrix per unit length.
- 6 gdloss=[...] S/mDielectric loss conductance matrix per unit length.
- 7 fileRLGC data file that contains the frequency dependent RLGC data.
- 8 freqscale=1Frequency scale factor for frequency dependent RLGC data.

Rational Fitting Parameters

- 9 fmax=1e9 HzMaximum signal frequency used to determine the relevant range of rational fitting.
- 10 resolution=moderate

Frequency sampling resolution.

Possible values are conservative, moderate or liberal.

Note: Spectre uses rational fitting algorithm to build a stable model that approximates the desired transmission line characteristics. The accuracy of the mtline model is solely dependent on how well the rational approximation is over frequency range [0, fmax].

Model parameter resolution controls the accuracy of the rational approximation. Tighter resolution control uses higher order rational fitting, which generally results in a more accurate model. However, a higher order model also increases simulation time and tends to be unstable. For most transmission line applications, moderate resolution is sufficient to guarantee accuracy and stability.

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Component Statements Part 2

Modeling Frequency Dependent Effects

One can model the frequency dependent RLGC matrices by providing the data file using model parameter file. One should always try to provide accurate and sufficient data to describe the frequency dependent RLGC matrices.

In addition, the following simplified equation can be used to model skin effect with the constant RLGC matrices

$$R(f) = r + sqrt(f) * (1 + j) * rskin,$$

and the following equation can be used to model dielectric loss with the constant RLGC matrices

$$G(f) = g + f / sqrt(1 + 4 * (f / fmax)^2) * gdloss,$$

where f stands for frequency.

Parameter Index

c M-4	freqscale I-10	1 I-4	romdatfile	I-11
c I-6	g I-5	len I-1	rskin M-5	
file I-9	g M-3	m I-2	rskin I-7	
file M-7	gdloss I-8	r I-3		
fmax M-9	gdloss M-6	r M-1		
freqscale M-	8 1 M-2	resolution M-10		

Mutual Inductor (mutual_inductor)

Description

The mutual inductor couples two previously specified inductors. There is no limit to the number of inductors that you can couple or to the number of couplings to a particular inductor, but you must specify separate mutual inductor statements for each coupling. Using the dot convention, place a dot on the first terminal of each inductor.

Component Statements Part 2

This device is not supported within altergroup.

The mutual inductor modifies the constitutive equations of two isolated inductors to

```
v1 = L11*di1/dt + M*di2/dt

v2 = M*di1/dt + L22*di2/dt
```

where the mutual inductance, M, is computed from the coupling coefficient, k, using k = |M|/sqrt(L11*L22).

Sample Instance Statement with Two Inductors

```
11 (1 0) inductor
12 (2 0) inductor
ml1 mutual_inductor coupling=1 ind1=11 ind2=12
```

Instance Definition

Name mutual_inductor parameter=value ...

Instance Parameters

- 1 coupling=0Coupling coefficient.
- 2 ind1Inductor to be coupled.
- 3 ind2Inductor to be coupled.

Node Capacitance (nodcap)

Description

The nodcap model is generally used to model voltage dependent capacitances and currents of the source and drain diodes of MOS transistors and the capacitances of related interconnection areas and sidewalls (IN and PS regions). It is described in the Philips MOST Modelbook (Dec.93) as NODCAP model.

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Component Statements Part 2

In extension to the modelbook description a minimum conductance gmin is inserted between the nodcap nodes, to aid convergence. The value of gmin is set by an options statement, default = 1e-12 S.

The imax parameter is used to aid convergence and to prevent numerical overflow. The junction characteristics of the node capacitor are accurately modeled for currents up to imax. For currents above imax, the junction is modeled as a linear resistor and a warning is printed.

This device is supported within altergroups.

This device is dynamically loaded from the shared object

/vobs/spectre_dev/tools.sun4v/spectre/lib/cmi/2.0.doc/libphilips.so

Sample Instance Statement

n14 (outc vcc) pcapmod ad=191.13e-6 pdg=70e-6 pdcs=75

Sample Model Statement

model pcapmod nodcap type=p js=10e-6 pt=2 cjr=0.6e-3 vdr=750e-3 tref=27 pmr=0.4 vr=0 kpers=4.9e-6 cox=1.77e-3

Instance Definition

Name nn [ns] ModelName parameter=value ...

Instance Parameters

- 1 m=1.0Multiplicity factor.
- 2 region=revEstimated DC operating region, used as a convergence aid. Possible values are fwd, rev or brk.
- 3 cf=0.0 FFixed capacitance.
- 4 ad=0.0 $scale^2 m^2$

Diffusion area (source or drain). Scale set by option scale.

- 5 pdcs=0.0 scale mLength of the side-wall of the diffusion area AD which is not under the gate. Scale set by option scale.
- 6 pdg=0.0 scale mLength of the side-wall of the diffusion area AD which is under the gate. Scale set by option scale.

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Component Statements Part 2

$$7 \text{ ain=0.0 scale}^2 \text{ m}^2$$

Area of metal interconnection over thick oxide. Scale set by option scale.

 $8 \text{ ag=0.0 scale}^2 \text{ m}^2$

Area metal or poly-Si over thin oxide. Scale set by option scale.

9 aps=0.0 $scale^2 m^2$

Area metal of poly-Si over thick oxide. Scale set by option scale.

- 10 pin=0.0 scale mLength of the side-wall of AIN. Scale set by option scale.
- 11 pps=0.0 scale mLength of the side-wall of APS. Scale set by option scale.

Model Definition

model modelName nodcap parameter=value ...

Model Parameters

1 type=nType of the nodcap device.

Possible values are n or p.

- 2 kpjs=0.0 mConversion factor of the sidewall length and the gate edge length to its equivalent area for the saturation current.
- 3 n=1.0Emission coefficient.
- 4 bv=∞ ∨Reverse break-down voltage.
- 5 imax=1.0 AExplosion current.
- 6 pt=2.0Temperature coefficient of the saturation current.
- 7 vr=0.0 vVoltage at which CJR is specified.
- 8 fc=0.5Forward-bias non-ideal junction capacitance coefficient.
- 9 pmr=0.5Grading coefficient.
- 10 kpers=0.0 mConversion factor of the sidewall length to its equivalent area for the junction capacitance.

Component Statements Part 2

- 11 kperg=0.0 mConversion factor of the gate edge length to its equivalent area for the junction capacitance.
- 12 cin=0.0 F/m²Specific capacitance of the (interconnection) metal to the substrate.
- 13 $\cos = 0.0$ F/m²Specific capacitance of poly-silicon or aluminum to the substrate over thin oxide.
- 14 cps=0.0 F/m²Specific capacitance of poly-silicon to the substrate over thick oxide.
- 15 cins=0.0 F/mIN-side-wall capacitance.
- 16 cpss=0.0 F/mPS-side-wall capacitance.
- 17 dta=0.0 KTemperature offset of the device with respect to TEMP.
- 18 trise (K) Alias of dta.
- 19 tref=27.0 CTemperature at which the parameters are specified. Default set by option tnom.
- 20 thom (C) Alias of tref.
- 21 tr (C) Alias of tref.
- 22 js=100u A/m²Saturation current density.
- 23 cjr=0.0 F/m²Specific junction capacitance at Vd = VR.
- 24 vdr=0.8 vDiffusion voltage.

Output Parameters

- 1 jst (A/m^2) Saturation current density (temperature updated).
- 2 cjrt (F/m^2) Specific junction capacitance at Vd = VR (temperature updated).
- 3 vdrt (V) Diffusion voltage (temperature updated).
- 1 io (A) Saturation current (temperature updated).

Component Statements Part 2

Operating-Point Parameters

- 1 region=revEstimated DC operating region, used as a convergence aid. Possible values are fwd, rev or brk.
- 2 vsub (V) Voltage across the node-capacitance, which is measured from NS (substrate or N-well) to NN (source or drain). Vsub is usually negative.
- 3 isub (A) Resistive leakage current.
- 4 cap (F) Junction capacitance.
- 5 q (Coul) Junction charge.
- 6 gm (S) Total differential conductance.
- 7 c0 (F) Constant part of the junction capacitance.
- 8 pwr (W) Power.

Parameter Index

ad	I-4	cox M-13	kpers M-10	region OP-1
ag	I-8	cps M-14	kpjs M-2	region I-2
ain	I-7	cpss M-16	m I-1	tnom M-20
aps	I-9	dta M-17	n M-3	tr M-21
bv	M-4	fc M-8	pdcs I-5	tref M-19
c0	OP-7	gm OP-6	pdg I-6	trise M-18
cap	OP-4	i0 O-1	pin I-10	type M-1
cf	I-3	imax M-5	pmr M-9	vdr M-24
cin	M-12	isub OP-3	pps I-11	vdrt 0-3
cins	M-15	js M−22	pt M-6	vr M-7
cjr	M-23	jst 0-1	pwr OP-8	vsub OP-2
cjrt	0-2	kperg M-11	q OP-5	

Component Statements Part 2

Set Node Quantities (node)

Description

Quantities are used to hold information about particular types of signals, such as their units, absolute tolerances, and maximum allowed change per Newton iteration. Use the quantity statement to create new quantities or to redefine properties of an existing quantity. Use this statement to set the quantities for a particular node.

For example, to indicate that the node net1 is used for thermal signals, the following node statement could be used.

i17 (net1) node value=Temp flow=Pwr

Temp and Pwr are predefined quantities.

This device is not supported within altergroup.

Sample Instance Statement

nodel (1 2 3) node value="T" flow="W" strength=override //Must define T and W with quantity statement.

Instance Definition

Name 1 [2] ... node parameter=value ...

Instance Parameters

- 1 value Value quantity.
- 2 flowFlow quantity.
- 3 strength=override

Quantity strength.

Possible values are indifferent, suggest, insist, or override.

Component Statements Part 2

Linear N Port (nport)

Description

An N-port takes its characteristics from an S-parameter data file. An N-port can have as many ports as there are in the N-port described in the S-parameter data file. Each pair of terminals in the nport instance statement represents one port. Because there is no limit to the number of ports, there is no limit to the number of terminals. However, the terminals must be given in pairs and there must be at least one pair. The order of the pairs is the same as the order of the ports in the data file. Any missing ports should be skipped.

The S-parameter data file specifies the characteristics of the N-port. You can scale the frequency axis with the scale parameter. The frequencies in the data file are then multiplied by scale before the simulator uses them. The default scale factor is unity. S-parameters can be in one of the following formats: real-imag, mag-deg, mag-rad, db-deg, and db-rad.

If interp=spline is specified, the data is interpolated and extrapolated by using cubic splines on the data in polar form. A simple algorithm removes 2 pi jumps in the phase data. Frequency points where the data is measured must therefore be close enough to avoid an excessive number of jumps. Unfortunately, noisy phase data can cause unnecessary warning messages.

If interp=rational is specified, the data is interpolated and extrapolated using a rational function fit to the data. The degree of rational interpolation is automatically selected based on the values of abserr and relerr, unless ratorder is given, in which case relerr and abserr are ignored in selecting the order of the rational function interpolation. It is usually better to allow the simulator to automatically select the rational interpolation order.

If the S-parameter data contains noise, abserr and relerr should be set so that the fitting procedure can ignore the noise, for example, by setting abserr above the noise floor and/or relaxing relerr as necessary.

Because the fitting procedure can take a long time for complicated data, the reduced order model (ROM) file option is available to store and re-use the rational interpolation function in subsequent simulations.

It is not practical to rely on extrapolated data.

This device is not supported within altergroup.

Sample Instance Statement

x1 (a1 0 b1 0 b3 0) ndata file="sparam2.data"

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Sample Model Statement

```
model ndata nport file="sparam.data" scale=1
```

Instance Definition

```
Name t1 b1 [t2] [b2] ... ModelName parameter=value ...
Name t1 b1 [t2] [b2] ... nport parameter=value ...
```

Terminals must be given in pairs.

Instance Parameters

- 1 m=1Multiplicity factor.
- 2 fileS-parameter data file name.
- 3 scale=1Frequency scale factor.
- 4 interp=splineMethod to interpolate s-parameter data.

 Possible values are spline or rational.

Spline Interpolation Parameters

5 usewindow=yesUse smooth data windowing function. The use of window improves timedomain amplitude resolution, set this parameter to no for better high-frequency resolution. Possible values are no or yes.

Rational Interpolation Parameters

- 6 relerr=0.01Maximum relative allowed tolerance for rational interpolation errors.

 Deviations of the nport model from supplied s-parameter data of relative magnitude less than relerr are generally ignored.
- 7 abserr=1e-4Maximum absolute allowed tolerance for rational interpolation errors.

 Deviations of the nport model from supplied s-parameter data of absolute magnitude less than abserr are generally ignored.
- 8 romdatfileFile used for storing time-domain reduced order model (ROM).
- 9 ratorderOrder of rational function to use in fitting the s-parameter data. If this argument is given, relerr and abserr are ignored in selecting the order of

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the rational function interpolation. If ratorder is not specified then the program will attempt to select an order of rational interpolation that satisfies the criteria implied by abserr and relerr.

Noise Parameters

- 10 trise (C) Temperature rise from ambient.
- 11 thermalnoise=yesThermal noise.

Possible values are no or yes.

Model Definition

model modelName nport parameter=value ...

Model Parameters

- 1 fileS-parameter data file name.
- 2 scale=1Frequency scale factor.
- 3 usewindow=yesUse smooth data windowing function. The use of window improves timedomain amplitude resolution, set this parameter to no for better high-frequency resolution. Possible values are no or yes.
- 4 trise=0 CDefault temperature rise from ambient.
- 5 thermalnoise=yesThermalnoise.

Possible values are no or yes.

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description for that parameter. For example, a reference of M-35 means the 35th model parameter.

abserr	I-7	m I-1		scale	I-3		trise	I-10)
file I-	-2	ratorder	I-9	scale	M-2		trise	M-4	
file M-	-1	relerr I-	6	thermal	noise	I-11	usewind	WC	I-5
interp	I-4	romdatfile	I-8	therma	lnoise	M-5	usewind	WC	M-3

Parameter Value Tester (paramtest)

Description

The parameter value tester tests the values of its parameters and prints a message if they satisfy the testers criteria. The tester therefore allows you to check the ranges of subcircuit parameters. If you specify more than one test, the message is printed if any test passes. The message is also printed if no tests are specified.

This device is not supported within altergroup.

Sample Instance Statement

tooShort paramtest errorif=(1 < 0.2um) message="W of device is less than 0.2um"

Instance Definition

Name paramtest parameter=value ...

Instance Parameters

- 1 printifMessage is printed if this value is nonzero.
- 2 warnifMessage is printed as a warning if this value is nonzero.
- 3 errorifMessage is printed as an error and program quits if this value is nonzero.
- 4 messageText of message.
- 5 severity=statusMessage severity (use if printing message without test).

 Possible values are debug, status, warning, error, or fatal.

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Polynomial Current Controlled Current Source (pcccs)

Description

A vector of coefficients specifies the polynomial function that defines the relationship between the output current and the controlling currents. You must specify at least one coefficient.

This device is not supported within altergroup.

For a polynomial in M variables a1, a2, ... am, the polynomial function F(a0,a1,...,am) is given by

```
F = c0 + c1 * a1 + c2 * a2 + ...
+ c(m+1) * a1^2 + c(m+2) * a1 * a2 + ...
+ c(2m+1) * a2^2 + c(2m+2) * a2 * a3 + ...
```

where the cs are coefficients of the polynomial terms.

Sample Instance Statement

```
vpc (net1 0) pcccs probes=[vb vc ve vlp vpn] coeffs=[0 8.8e6 -8.8e6 9e6 8e6 -9e6]
```

Instance Definition

Name sink src pcccs parameter=value ...

Instance Parameters

- 1 coeffs=[...] Polynomial coefficients. At least one must be given.
- 2 probes=[...] Devices through which the controlling currents flow.
- 3 ports=[...] Indice of the probe ports through which the controlling currents flow.
- 4 gain=1Gain Parameter.
- 5 m=1Multiplicity factor.

Operating-Point Parameters

1 i (A) Output current.

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2 v (V) Output voltage.

3 pwr (W) Power dissipation.

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Polynomial Current Controlled Voltage Source (pccvs)

Description

The polynomial function defining the relationship between the output voltage and the controlling currents is specified by a vector of coefficients. At least one coefficient must always be specified. Current through the voltage source is calculated and is defined to be positive if it flows from the positive terminal, through the source, to the negative terminal.

This device is not supported within altergroup.

For a polynomial in M variables a1, a2, ... am, the polynomial function F(a0,a1,...,am) is given by

```
F = c0 + c1 * a1 + c2 * a2 + ...
+ c(m+1) * a1^2 + c(m+2) * a1 * a2 + ...
+ c(2m+1) * a2^2 + c(2m+2) * a2 * a3 + ...
```

where the cs are coefficients of the polynomial terms.

Sample Instance Statement

```
ixy (net1 0) pccvs coeffs=[0 1 0 1] probes=[vin1 vin2] gain=2
```

Component Statements Part 2

Instance Definition

Name p n pccvs parameter=value ...

Instance Parameters

- 1 coeffs=[...] Polynomial coefficients. At least one must be given.
- 2 probes=[...] Devices through which the controlling currents flow.
- 3 ports=[...] Indice of the probe ports through which the controlling currents flow.
- 4 gain=1Gain Parameter.
- 5 m=1Multiplicity factor.

Operating-Point Parameters

- 1 i (A) Output current.
- 2 v (V) Output voltage.
- 3 pwr (W) Power dissipation.

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Physical Resistor (phy_res)

Description

A physical resistor consists of a linear resistor (tied between t1 and t2) and two diodes (tied between t1-t0 and t2-t0). The diodes are junction diodes. Under normal operation, the two diodes are reverse biased, but the parameter subtype can reverse the direction of the diodes. If you do not specify t0, ground is assumed. The instance parameters always override model parameters. If you do not specify the instance resistance value, it is calculated from the model parameters.

This device is supported within altergroups.

If R(inst) is not given and R(model) is given,

$$R(inst) = R(model).$$

Otherwise.

$$R(inst) = Rsh * (L - 2 * etchl) / (W - 2 * etch).$$

If the polynomial coefficients vector (coeffs=[c1 c2 ...]) is specified, the nonlinear resistance is

$$R(V) = dV / dI$$

= $R(inst) / (1 + c1 * V + c2 * V^2 + ...)$
where
 $V = V(t1) - V(t2)$

Here V is the controlling voltage across the resistor. It is also the controlling voltage when the model parameter polyarg is set to diff. In this form, the physical resistor is symmetric with respect to V(t1) and V(t2). The branch current as a function of the applied voltage is given by

$$I(V) = (V / R(inst)) * (1 + 1/2 * c1 * V + 1/3 * c2 * V^2 + ...)$$

where ck is the kth entry in the coefficient vector.

If the model parameter polyarg is set to sum, then the controlling voltage is defined as

$$Vsum = ((V(t1) - V(t0)) + (V(t2) - V(t0)))/2$$

Here, Vsum is the controlling voltage between the resistor and the substrate, t0. In this case, the device becomes asymmetric with respect to V(t1) and V(t2). The branch current as a function of the applied voltage for this case is given by

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$$I(V) = (V / R(inst)) * (1 + c1 * Vsum + c2 * Vsum^2 + ...)$$

The large-signal conductance is given by

$$G(V) = I/V = (1 + c1 * Vsum + c2 * Vsum^2 + ...) / R(inst)$$

Since the device is asymmetrical, the small-signal conductance is not very meaningful.

The resistance as a function of temperature is given by:

If you do not specify the junction leakage current (is) and js is specified, the leakage current is calculated from js and the device dimensions.

$$is = js * 0.5 * (L - 2 * etchl) * (W - 2 * etch)$$

If you specify the instance capacitance or the linear model capacitance, linear capacitors are used between t1-t0 and t2-t0. Otherwise, nonlinear junction capacitors are used and the zero-bias capacitance values are calculated from the model parameters.

If C(inst) is not given and C(model) is given,

$$C(inst) = C(model).$$

otherwise.

Otherwise,

If the capacitance is nonlinear, the temperature model for the junction capacitance is used. Otherwise, the following equation is used.

$$C(T) = C(tnom) * [1 + tc1c * (T - tnom) + tc2c * (T - tnom)^2].$$

Sample Instance Statement

```
res1 (net9 vcc) resphy l=1e-3 w=2e-6
```

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Sample Model Statement

model resphy phy_res rsh=85 tc1=1.53e-3 tc2=4.67e-7 etch=0 cj=1.33e-3 cjsw=3.15e-10 tc1c=9.26e-4

Instance Definition

Name 1 2 [0] ModelName parameter=value ...

Instance Parameters

- 1 r (Ω) Resistance.
- 2 c (F) Linear capacitance.
- 3 1 (m) Line length.
- 4 w (m) Line width.
- 5 region=normalEstimated operating region.

 Possible values are normal or breakdown.
- 6 tc1=0 1/CLinear temperature coefficient of resistor.
- 7 tc2=0 C^{-2} Quadratic temperature coefficient of resistor.
- 8 tclc=0 1/CLinear temperature coefficient of linear capacitor.
- 9 tc2c=0 C⁻²Quadratic temperature coefficient of linear capacitor.
- 10 trise (C) Temperature rise from ambient.
- 11 m=1Multiplicity factor.

The w and 1 parameters are scaled by the option parameters scale and scalem. The values of w and 1 printed by Spectre are those given in the input file. These values may not have the correct units if the scaling factors are not unity. The actual effective resistor dimensions are stored in the output parameters. You can obtain these dimensions with the info statement. You can delete the diodes from the device by either setting is=0 or subtype=poly. You can also set both mj and mjsw to zero to make the capacitance linear but still calculated from the device geometry. If subtype=poly, the linear capacitors will always be used irrespective of the values of mj and mjsw.

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Model Definition

model modelName phy_res parameter=value ...

Model Parameters

Substrate Type Parameters

1 subtype=pSubstrate type.

Possible values are n, p or poly.

Resistance Parameters

- 2 $r=\infty$ Ω Default resistance.
- 3 rsh= $\infty \Omega$ /sqr

Sheet resistance.

- 4 minr=0.1 Ω Minimum resistance.
- 5 coeffs=[...] Vector of polynomial conductance coefficients.
- 6 polyarg=diffPolynomial model argument type.

 Possible values are sum or diff.

Temperature Effects Parameters

- 7 tc1=0 1/CLinear temperature coefficient of resistor.
- 8 tc2=0 C^{-2} Quadratic temperature coefficient of resistor.
- 9 tc1c=0 C^{-2} Linear temperature coefficient of linear capacitor.
- 10 tc2c=0 C^{-2} Quadratic temperature coefficient of linear capacitor.
- 11 tnom (C) Parameters measurement temperature. Default set by options.
- 12 trise=0 CTemperature rise from ambient.

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Junction Diode Model Parameters

- 13 is (A) Saturation current.
- 14 js=0 A/m²Saturation current density.
- 15 n=1Emission coefficient.
- 16 eg=1.11 vBand gap.
- 17 xti=3Saturation current temperature exponent.
- 18 imelt=`imaxA' Explosion current, diode is linearized beyond this current to aid convergence.
- 19 jmelt=`jmeltA/m'²

Explosion current density, diode is linearized beyond this current to aid convergence.

- 20 imax=1 AMaximum current, currents above this limit generate a warning.
- 21 jmax=1e8 A/m²Maximum current density, currents above this limit generate a warning.
- 22 dskip=yesUse simple piece-wise linear model for diode currents below 0.1*iabstol. Possible values are no or yes.
- 23 by j=∞ VJunction reverse breakdown voltage.

Junction Capacitance Model Parameters

- 24 c=0 FDefault linear capacitance.
- 25 cj=0 F/ m^2 Zero-bias junction bottom capacitance density.
- 26 cjsw=0 F/mZero-bias junction sidewall capacitance density.
- 27 mj=1/2Junction bottom grading coefficient.
- 28 mjsw=1/3Junction sidewall grading coefficient.
- 29 pb=0.8 VJunction bottom built-in potential.
- 30 pbsw=0.8 VJunction sidewall built-in potential.

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- 31 fc=0.5Junction bottom capacitor forward-bias threshold.
- 32 fcsw=0.5Junction sidewall capacitor forward-bias threshold.
- 33 tt=0 sTransit time.

Device Size Parameters

- 34 1=∞ mDefault line length.
- 35 w=1e-6 mDefault line width.
- 36 etch=0 mNarrowing due to etching.
- 37 etch1=0 mLength reduction due to etching.
- 38 etchc=etch mNarrowing due to etching for capacitances.
- 39 etchlc=etchl mLength reduction due to etching for capacitances.
- 40 scaler=1Resistance scaling factor.
- 41 scalec=1Capacitance scaling factor.

Noise Model Parameters

- 42 kf=0Flicker (1/f) noise coefficient.
- 43 af=1Flicker (1/f) noise exponent.
- 44 wdexp=1Flicker (1/f) noise W exponent.
- 45 ldexp=1Flicker (1/f) noise L exponent.
- 46 weexp=0Flicker (1/f) noise W effective exponent.
- 47 leexp=0Flicker (1/f) noise L effective exponent.
- 48 fexp=1Flicker (1/f) noise frequency exponent.

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Output Parameters

- 1 leff (m) Effective line length.
- 2 weff (m) Effective line width.
- 3 iseff (A) Effective saturation current.
- 4 reff (Ω) Effective resistance.
- 5 ceff (F) Effective zero-bias capacitance.

Operating-Point Parameters

- 1 subtype=pSubstrate type.
 - Possible values are n, p or poly.
- 2 region=normalEstimated operating region.
 - Possible values are normal or breakdown.
- 3 i (A) Current through the resistor.
- 4 capd1 (F) Capacitance at the positive node.
- 5 capd2 (F) Capacitance at the negative node.
- 6 id1 (A) Current between nodes t1 and t0.
- 7 id2 (A) Current between nodes t2 and t0.
- 8 res (Ω) Resistance between nodes t1 and t2.
- 9 resd1 (Ω) Resistance between nodes t1 and t0.
- 10 resd2 (Ω) Resistance between nodes t2 and t0.
- 11 pwr (W) Power at op point.

Parameter Index

In the following index, I refers to instance parameters, M refers to the model parameters section, O refers to the output parameters section, and OP refers to the operating point

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parameters section. The number indicates where to look in the appropriate section to find the description for that parameter. For example, a reference of M-35 means the 35th model parameter.

af M-43	i OP-3	mjsw M-28	tc1 I-6
bvj M-23	idl OP-6	n M-15	tc1 M-7
c I-2	id2 OP-7	pb M-29	tc1c I-8
c M-24	imax M-20	pbsw M-30	tc1c M-9
capd1 OP-4	imelt M-18	polyarg M-6	tc2 I-7
capd2 OP-5	is M-13	pwr OP-11	tc2 M-8
ceff 0-5	iseff O-3	r I-1	tc2c I-9
cj M-25	jmax M-21	r M-2	tc2c M-10
cjsw M-26	jmelt M-19	reff O-4	tnom M-11
coeffs M-5	js M-14	region I-5	trise I-10
dskip M-22	kf M-42	region OP-2	trise M-12
eg M-16	1 M-34	res OP-8	tt M-33
etch M-36	1 1-3	resd1 OP-9	w = I - 4
etchc M-38	ldexp M-45	resd2 OP-10	w M-35
etchl M-37	leexp M-47	rsh M-3	wdexp M-44
etchlc M-39	leff O-1	scalec M-41	weexp M-46
fc M-31	m I-11	scaler M-40	weff O-2
fcsw M-32	minr M-4	subtype M-1	xti M-17
fexp M-48	mj M-27	subtype OP-1	

Independent Resistive Source (port)

Description

A port is a resistive source that is tied between pos and neg. It is equivalent to a voltage source in series with a resistor, and the reference resistance of the port is the value of the resistor. The DC value given for the port voltage specifies the DC voltage across the port when it is terminated in its reference resistance (in other words, the DC voltage of the internal voltage source is double the user specified DC value, dc). The same is true for the values for the transient, AC and PAC signals of the port. However, the amplitude of the sine wave in the transient and PAC analyses can alternatively be specified as the power in dBm delivered by the port when terminated with the reference resistance.

While generally useful as a stimulus in high frequency circuits, the port has three unique capabilities. First, it acts to define the ports of the circuit to the S-parameter analysis. Second, it has an intrinsic noise source, and so allows the noise analysis to directly compute the noise figure of the circuit. And finally, it is the only source for which the amplitude can be specified in terms of power.

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This device is not supported within altergroup.

The value of the DC voltage as a function of the temperature is given by:

$$V(T) = V * [1 + tc1 * (T - tnom) + tc2 * (T - tnom)^2]$$

Sample Instance Statement

p20 (2 0) port num=2 r=50 type=pulse period=1e-9 rise=1e-10 fall=1e-10 val1=1 width=0.5n mag=1

Instance Definition

Name p n port parameter=value ...

Instance Parameters

1 dc=0 VDC value.

General Waveform parameters

2 type=dcWaveform type.

Possible values are dc, pulse, pwl, sine, or exp.

- 3 fundnameName of the fundamental frequency. Must be specified if the source is active during a poisto analysis or it is the active clock during an envlp analysis.
- 4 delay=0 sWaveform delay time.

Pulse Waveform Parameters

- 5 val0=0 vZero value used in pulse and exponential waveforms.
- 6 val1=1 vOne value used in pulse and exponential waveforms.
- 7 period=∞ sPeriod of waveform.
- 8 rise (s) Rise time for pulse waveform (time for transition from val0 to val1).
- 9 fall (s) Fall time for pulse waveform (time for transition from val1 to val0).
- 10 width=∞ sPulse width (duration of vall).

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PWL Waveform Parameters

- 11 fileName of file containing waveform.
- 12 wave=[...] Vector of time/value pairs that defines waveform.
- 13 offset=0 VDC offset for the PWL waveform.
- 14 scale=1Scale factor for the PWL waveform.
- 15 stretch=1Scale factor for time given for the PWL waveform.
- 16 allbrkptsAll the points in the PWL waveform are breakpoints if set to yes. Default is yes if the number of points is less than 20.

 Possible values are no or yes.
- 17 pwlperiod (s) Period of the periodic PWL waveform.
- 18 twidth=pwlperiod/1000 s

 Transition width used when making PWL waveforms periodic.

Sinusoidal Waveform Parameters

- 19 sinedc=dc VDC level for sinusoidal waveforms.
- 20 ampl=1 VPeak amplitude of sinusoidal waveform.
- 21 dbm (dBm) Amplitude of sinusoidal waveform in dBm (alternative to amp1).
- 22 freq=0 HzFrequency of sinusoidal waveform.
- 23 sinephase=0 °Phase of sinusoid when t=delay.
- 24 ampl2=1 VPeak amplitude of second sinusoidal waveform.
- 25 dbm2 (dBm) Amplitude of second sinusoidal waveform in dBm (alternative to amp12).
- 26 freq2=0 HzFrequency of second sinusoidal waveform.
- 27 sinephase2=0 °Phase of second sinusoid when t=delay.
- 28 fundname2Name of the fundamental frequency associated with freq2. Must be specified if freq2 is used in a pdisto analysis.

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- 29 fmmodindex=0FM index of modulation for sinusoidal waveform.
- 30 fmmodfreg=0 HzFM modulation frequency for sinusoidal waveform.
- 31 ammodindex=0AM index of modulation for sinusoidal waveform.
- 32 ammodfreq=0 HzAM modulation frequency for sinusoidal waveform.
- 33 ammodphase=0 °AM phase of modulation for sinusoidal waveform.
- 34 damp=0 1/sDamping factor for sinusoidal waveform.

Exponential Waveform Parameters

- 35 td1=0 sRise start time for exponential wave.
- 36 taul (s) Rise time constant for exponential wave.
- 37 td2 (s) Fall start time for exponential wave.
- 38 tau2 (s) Fall time constant for exponential wave.

Noise Parameters

- 39 noisefileName of file containing excess spot noise data in the form of frequency-noise pairs.
- 40 noisevec=[...] V^2/Hz Excess spot noise as a function of frequency in the form of frequency-noise pairs.
- 41 noisetemp (C) Noise temperature of port. If not specified, the noise temperature is taken to be the actual temperature of the port.

Port Parameters

- 42 r=50 Ω Reference resistance.
- 43 numPort number.
- 44 m=1Multiplicity factor.

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Small signal parameters

- 45 mag=0 VSmall signal voltage.
- 46 phase=0 °Small signal phase.
- 47 xfmag=1 V/VTransfer function analysis magnitude.
- 48 pacmag=0 vPeriodic AC analysis magnitude.
- 49 pacdbm (dBm) Periodic AC analysis magnitude in dBm (alternative to pacmag).
- 50 pacphase=0 °Periodic AC analysis phase.

Temperature Effects Parameters

- 51 tc1=0 1/CFirst order temperature coefficient.
- 52 tc2=0 C^{-2} Second order temperature coefficient.
- 53 tnom (C) Parameters measurement temperature. Default set by options.

If you do not specify the DC value, it is assumed to be the time=0 value of the waveform.

In DC analyses, the only active parameters are dc, m, and the temperature coefficient parameters. In AC analyses, the only active parameters are m, mag and phase. In transient analyses, all parameters are active except the small signal parameters and the noise parameters. The type parameter selects which type of waveform is generated. You may specify parameters for more than one waveform type, and use the alter statement to change the waveform type between analyses.

A vector of time-value pairs describes the piecewise linear waveform. As an alternative, you can read the waveform from a file. In this case, you give time-value pairs one pair per line with a space or tab between the time and the value.

If you set allbrkpts to yes, you force the simulator to place time points at each point specified in a PWL waveform during a transient analysis. This can be very expensive for waveforms with many points. If you set allbrkpts to no, Spectre inspects the waveform, looking for abrupt changes, and forces time points only at those changes.

The PWL waveform is periodic if you specify pwlperiod. If the value of the waveform specified is not exactly the same at both its beginning its end, then you must provide a nonzero value twidth. Before repeating, the waveform changes linearly in an interval of

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twidth from its value at (period - twidth) to its value at the beginning of the waveform. Thus twidth must always be less than period.

You can give the excess noise of the source as a file or specify it with a vector of frequencynoise pairs. For a file, give the frequency-noise pairs one pair per line with a space or tab between the frequency and noise values.

When computing the noise figure of a circuit driven at its input by a port, the noise temperature (noisetemp) of the port should be set to 16.85C (290K) in order to match the standard IEEE definition of noise figure. In addition, all other sources of noise in the port (noisefile and noisevec) should be disabled. If a noiseless port is desired, set the noise temperature to absolute zero or below, and do not specify a noise file or noise vector.

Parameter Index

allbrkpts I-16	fmmodindex I-29	pacphase I-50	tc2 I-52
ammodfreq I-32	freq I-22	period I-7	td1 I-35
ammodindex I-31	freq2 I-26	phase I-46	td2 I-37
ammodphase I-33	fundname I-3	pwlperiod I-17	tnom I-53
ampl I-20	fundname2 I-28	r I-42	twidth I-18
ampl2 I-24	$m \hspace{1.5cm} \text{I} - 44$	rise I-8	type I-2
damp I-34	mag I-45	scale I-14	val0 I-5
dbm I-21	noisefile I-39	sinedc I-19	vall I-6
dbm2 I-25	noisetemp I-41	sinephase I-23	wave I-12
dc I-1	noisevec I-40	sinephase2 I-27	width I-10
delay I-4	num I-43	stretch I-15	xfmag I-47
fall I-9	offset I-13	tau1 I-36	
file I-11	pacdbm I-49	tau2 I-38	
fmmodfreq I-30	pacmag I-48	tc1 I-51	

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Polynomial Voltage Controlled Current Source (pvccs)

Description

A vector of coefficients specifies the polynomial function that defines the relationship between the output current and the controlling voltages. You must specify at least one coefficient. Current exits the source node and enters the sink node.

This device is not supported within altergroup.

For a polynomial in M variables a1, a2, ... am, the polynomial function F(a0,a1,...,am) is given by

```
F = c0 + c1 * a1 + c2 * a2 + ...
+ c(m+1) * a1^2 + c(m+2) * a1 * a2 + ...
+ c(2m+1) * a2^2 + c(2m+2) * a2 * a3 + ...
```

where the cs are coefficients of the polynomial terms.

Sample Instance Statement

```
v2 (net1 0 net2 0) pvccs coeffs=[0 -2e-3 - 10e-3] gain=2 m=1
```

Instance Definition

```
Name sink src psl nsl ... pvccs parameter=value ...
```

Instance Parameters

- 1 coeffs=[...] Polynomial coefficients. At least one must be given.
- 2 gain=1Gain Parameter.
- 3 m=1Multiplicity factor.

Operating-Point Parameters

- 1 i (A) Output current.
- 2 v (V)Output voltage.

Component Statements Part 2

3 pwr (W) Power dissipation.

Polynomial Voltage Controlled Voltage Source (pvcvs)

Description

A vector of coefficients specifies the polynomial function that defines the relationship between the output voltage and the controlling voltages. You must specify at least one coefficient. Current through the voltage source is calculated and is defined to be positive if it flows from the positive terminal, through the source, to the negative terminal.

This device is not supported within altergroup.

For a polynomial in M variables a1, a2, ... am, the polynomial function F(a0,a1,...,am) is given by

```
F = c0 + c1 * a1 + c2 * a2 + ...
+ c(m+1) * a1^2 + c(m+2) * a1 * a2 + ...
+ c(2m+1) * a2^2 + c(2m+2) * a2 * a3 + ...
```

where the cs are coefficients of the polynomial terms.

Sample Instance Statement

```
v1 (p 0 c1 0) pvcvs coeffs=[0 0 0 0.1 1 1] gain=1
```

Instance Definition

```
Name p n psl nsl ... pvcvs parameter=value ...
```

Instance Parameters

- 1 coeffs=[...] Polynomial coefficients. At least one must be given.
- 2 gain=1Gain Parameter.
- 3 m=1Multiplicity factor.

Component Statements Part 2

Operating-Point Parameters

```
1 i (A) Output current.
```

2 v (V) Output voltage.

3 pwr (W) Power dissipation.

Quantity Information (quantity)

Description

Quantities are used to hold information about particular types of signals, such as their units, absolute tolerances, and maximum allowed change per Newton iteration. Two predefined quantities are voltage and current. A node indicates the type of its signals by keeping pointers to quantities, thus an electrical node points to the voltage quantity for its value, and to the current for its residue. Since many electrical nodes point to the same quantities, changing an attribute on the quantity, such as the absolute tolerance, changes it for many nodes. Use this statement to create new quantities or to redefine properties of an existing quantity. Use the node statement to set the quantities for a particular node.

The predefined quantities are as follows:

I: Electrical current in Amperes.

Units = A

Absolute tolerance = 1 pA

Huge value = 4..036 MA

Blowup value = 1 GA

MMF: Magnetomotive force in Ampere-Turns.

Units = A*turn

Absolute tolerance = 1 pA*turn

Huge value = 4..036 MA*turn

Blowup value = 1 GA*turn

Pwr: Power in Watts.

Component Statements Part 2

Units = W

Absolute tolerance = 1 nW

Huge value = 4..036 MW

Blowup value = 1 GW

Temp: Temperatures in Celsius.

Units = C

Absolute tolerance = 100 uC

Huge value = 4..036 MC

Blowup value = 1 GC

U: Unitless signals scaled to unity.

Absolute tolerance = 1e-06

Huge value = 4..036e + 06

Blowup value = 1e+09

V: Electomotive force in Volts.

Units = V

Absolute tolerance = 1 uV

Maximum change = 300 mV if limit=delta

Huge value = 1 kV

Blowup value = 1 GV

Wb: Magnetic flux in Webers.

Units = Wb

Absolute tolerance = 1 nWb

Huge value = 4..036 MWb

Blowup value = 1 GWb

This device is not supported within altergroup.

Component Statements Part 2

Sample Instance Statement

voltageQ quantity name="V" abstol=3u maxdelta=500m huge=10K blowup=1G

Instance Definition

Name quantity parameter=value ...

Instance Parameters

- 1 nameName.
- 2 description Description of quantity.
- 3 unitsUnits.

Newton Parameters

- 4 abstolAbsolute tolerance.
- 5 maxdelta=∞

Maximum change allowed on a Newton iteration when limit=delta.

- 6 huge=4..036e+06Maximum change allowed on a Newton iteration otherwise.
- 7 blowup=1e+09lf a signal exceeds this value, the simulation will terminate with an error. It is assumed that the circuit is unstable and is blowing up.

Diffusion Resistor Model (rdiff)

Description

The rdiff model is a diffusion resistor model, which accurately models the temperature, applied bias and back-bias dependencies of NWell, N+, and P+ resistors. It is described in the paper MODEL FOR DIFFUSION RESISTORS (NWell, N+, P+) USED IN CMOS IC DESIGNS by M.J.B.Bolt, FASELEC Process Development Group, PDG-93029, Modified 3rd May 1995.

Some extensions to that description are applied:

Component Statements Part 2

Appropriate model and instance parameter default values are used.

No clipping of parameters is performed. Parameter values are checked for validity. If invalid parameter values occur, the job is aborted with an error message.

For exact inverse behavior of the model in case of Vh less than VI, the setting of Vbl=abs(Vb-VI) is replaced by Vbl=min(abs(Vb-Vh),abs(Vb-VI)). Additionally, the direction of Ih is inverted in this case.

Note: In noise analysis, rdiff instances will not generate any contribution, since there are no noise sources included in the rdiff model.

(c) Philips Electronics N.V. 1993, 1995

This device is supported within altergroups.

This device is dynamically loaded from the shared object

/vobs/spectre dev/tools.sun4v/spectre/lib/cmi/2.0.doc/libphilips.so

Sample Instance Statement

r2 (1 2 0) rdsn l=9u w=2u nb=0 m=1

Sample Model Statement

model rdsn rdiff level=1 tr=27 dta=0 rshr=2.5e3 wtol=0.22u rint=3.5u swvp=13.4u
power=2 tcr1=1.5e-3 tcr2=1e-5 vpr=40

Instance Definition

Name h l [b] ModelName parameter=value ...

Instance Parameters

- 1 l=1.0 scale mDrawn length of resistor. Must be greater than zero. Scale set by option scale.
- 2 w=1.0 scale mDrawn width of resistor. Must be greater than zero. Scale set by option scale.
- 3 nb=0.0Number of bends in the resistor. Must be greater or equal zero.
- 4 m=1.0Multiplicity factor. Must be greater than zero.

Component Statements Part 2

Model Definition

model modelName rdiff parameter=value ...

Model Parameters

- 1 level=1.0Level of this model. Must be 1.
- 2 tr (C) Reference temperature. Default set by option tnom.
- 3 tref (C) Alias of tr. Default set by option tnom.
- 4 tnom (C) Alias of tr. Default set by option tnom.
- 5 dta=0 KTemperature offset of the device.
- 6 trise=0 KAlias of dta.
- 7 rshr=1.0e+3 Ω /sqr

Sheet resistance at reference temperature. Must be greater than zero.

- 8 wtol=0.0 mOffset between the drawn and effective resistor width.
- 9 tcr1=0.0 1/KLinear temperature coefficient of the resistor.
- 10 tcr2=0.0 1/K²Quadratic temperature coefficient of the resistor.
- 11 vpr=100.0 vReference Pinch-off voltage.
- 12 swvp=0.0 V/mCoefficient of the width dependence of vp.
- 13 power=1.5Voltage exponent. Must be greater than zero.
- 14 vdr=1.0 vDiffusion voltage at reference temperature.
- 15 rint=0.0 Ω mInterface resistance at reference temperature.
- 16 tcrint1=0.0 1/KLinear temperature coefficient of the interface resistor.

Output Parameters

1 vd (V) Diffusion voltage. Must be greater than zero.

Component Statements Part 2

- 2 rsh (Ω/sqr) Sheet resistance. Must be greater than zero.
- 3 vp (V) Pinch-off voltage. Must be greater than zero.
- 4 r0 (Ω) Zero bias resistance. Must be greater than zero.

Operating-Point Parameters

- 1 vhl (V) Absolute value of the applied bias across the resistor.
- 2 vbl (V) Absolute value of the back-bias across the resistor.
- 3 ih (A) DC current into the resistor.
- 4 r (Ω) Actual resistance value.
- 5 pwr (W) Power.

Parameter Index

dta M-5	r OP-4	tcrint1 M-16	vhl OP-1
ih OP-3	r0 O-4	tnom M-4	vp 0-3
l I-1	rint M-15	tr M-2	vpr M-11
level M-1	rsh 0-2	tref M-3	w I-2
m I-4	rshr M-7	trise M-6	wtol M-8
nb I-3	swvp M-12	vbl OP-2	
power M-13	tcr1 M-9	vd 0-1	
pwr OP-5	tcr2 M-10	vdr M-14	

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Four Terminal Relay (relay)

Description

The four-terminal relay is a voltage controlled relay tied between terminals t1 and t2. The voltage between terminals ps and ns controls the relay resistance. The relay resistance varies nonlinearly between ropen and rclosed, the open relay resistance and closed relay resistance, respectively. These resistance values correspond to control voltages of vt1 and vt2 respectively. The four parameters, vt1, vt2, ropen, and rclosed, can be instance or model parameters.

As an alternative, you can specify the threshold voltage vth and a transition width trans rather than specifying vt1 and vt2. These two parameters are then calculated from vth and trans. If all four parameters are specified, vth and trans override vt1 and vt2. However, vt1 and vt2 values you specify on the instance override any model parameter specifications.

The final model parameter, hysteresis, designates a hysteresis with the on voltage shifted from vth by an amount hysteresis and the off voltage shifted by the same amount in the opposite direction. The direction of shift depends on the sign of trans (or the relative magnitudes of vtl and vtl): if trans is positive, the on voltage shifts by +hysteresis; if trans is negative (implying that the relay is normally on), the on-voltage shifts by -hysteresis.

This device is not supported within altergroup.

Operating conductance is calculated from the instance parameters as follows:

```
When Vc lies between vt1 and vt2,
```

```
G = Gmin + (Gmin - Gmax) * [ 2 * (Vc - vt1)^3 
- 3 * (vt2 - vt1) * (Vc - vt1)^2] / (vt2 - vt1)^3
Otherwise, if vt1 < vt2, then
G = Gmin \quad for Vc < vt1 \text{ and}
G = Gmax \quad for Vc > vt2.
If vt1 > vt2,
G = Gmin \quad for Vc > vt1 \text{ and}
G = Gmax \quad for Vc < vt2.
```

where Gmin = 1 / ropen, Gmax = 1 / rclosed, and Vc = V(ps) - V(ns).

Component Statements Part 2

Sample Instance Statement

```
rel1 (1 2 ps ns) my_relay ropen=1G rclosed=2
```

Sample Model Statement

```
model my_relay relay vt1=2.5 vt2=5 ropen=100M rclosed=0.1
```

Instance Definition

```
Name 1 2 ps ns ModelName parameter=value \dots Name 1 2 ps ns relay parameter=value \dots
```

Instance Parameters

- 1 vt1 (V) Relay resistance is ropen at this voltage.
- 2 vt2=vt1+1.0 vRelay resistance is rclosed at this voltage.
- 3 ropen=∞ Ω

Resistance of a fully open relay.

- 4 rclosed=1.0 Ω Resistance of a fully closed relay.
- 5 m=1.0 Multiplicity factor.
- 6 region=offEstimated operating region.

 Possible values are off or on.

Model Definition

```
model modelName relay parameter=value ...
```

Model Parameters

- 1 vt1 (V) Relay resistance is ropen at this voltage.
- 2 vt2=vt1+1.0 vRelay resistance is rclosed at this voltage.
- 3 ropen=∞ Ω

Resistance of a fully open relay.

4 rclosed=1.0 Ω Resistance of a fully closed relay.

Component Statements Part 2

- 5 hysteresis=0.0 vSwitching Hysteresis.
- 6 vth=0.0 vThreshold Voltage.
- 7 trans=0.0 vSwitch Transition Region Width.

Operating-Point Parameters

- 1 region=offEstimated operating region.

 Possible values are off or on.
- 2 res (Ω) Relay resistance.

Parameter Index

hysteresi	s M-5	region	I-6	ropen	M-3	vt2	I-2
m I-5		region	OP-1	trans	M-7	vt2	M-2
rclosed	I-4	res OP	9-2	vt1 M	1-1	vth	M-6
rclosed	M-4	ropen	I-3	vt1 I	-1		

Two Terminal Resistor (resistor)

Description

You can give the resistance explicitly or allow it to be computed from the physical length and width of the resistor. In either case, the resistance can be a function of temperature or applied voltage.

This device is supported within altergroups.

If R(inst) is not given,

$$R(inst) = R(model)$$

Component Statements Part 2

if R(model) is given, and

$$R(inst) = Rsh * (L - 2 * etchl) / (W - 2 * etch)$$

otherwise.

If the polynomial coefficients vector (coeffs=[c1 c2 ...]) is specified, the resistor is nonlinear. When nonlinform is set to g, the resistance is

$$R(V) = dV / dI$$

= $R(inst) / (1 + c1 * V + c2 * V^2 + ...).$

The branch current as a function of applied voltage is

$$I(V) = (V / R(inst)) * (1 + 1/2 * c1 * V + 1/3 * c2 * V^2 + ...)$$

When nonlinform is set to r, the resistance is

$$R(V) = dV / dI$$

= $R(inst) * (1 + c1 * V + c2 * V^2 + ...).$

where ck is the kth entry in the coefficient vector.

The value of the resistor as a function of the temperature is given by:

$$R(T) = R(tnom) * [1 + tc1 * (T - tnom) + tc2 * (T - tnom)^2]$$

where

T = trise(inst) + temp

if trise(inst) is given, and

T = trise(model) + temp

otherwise.

Sample Instance Statement

Without model:

With model:

Component Statements Part 2

Sample Model Statement

model resmod resistor rsh=150 l=2u w=2u etch=0.05u tc1=0.1 tnom=27 kf=1

Instance Definition

```
Name 1 2 ModelName parameter=value ...
Name 1 2 resistor parameter=value ...
```

Instance Parameters

- 1 r (Ω) Resistance.
- 2 1 (m) Resistor length.
- 3 w (m) Resistor width.
- 4 m=1Multiplicity factor.
- 5 scale=1Scale factor.
- 6 resformUse the resistance form for this instance. Default is yes if r < thresh. Possible values are no or yes.
- 7 tc1=0 1/CLinear temperature coefficient.
- 8 tc2=0 C^{-2} Quadratic temperature coefficient.
- 9 trise (C) Temperature rise from ambient.
- 10 isnoisy=yesShould resistor generate noise.

 Possible values are no or yes.

The instance parameter scale, if specified, overrides the value given by the option parameter scale. The w and 1 parameters are scaled by the resulting scale, and the option parameter scalem. The values of w and 1 printed out by spectre are those given in the input, and these values might not have the correct units if the scaling factors are not unity. The actual effective resistor dimensions are stored in the output parameters. You can obtain these dimensions by using the info statement.

Model Definition

```
model modelName resistor parameter=value ...
```

Component Statements Part 2

Model Parameters

Resistance Parameters

- 1 $r=\infty$ Ω Default resistance.
- 2 rsh= $\infty \Omega$ /sqr

Sheet resistance.

3 thresh=1.0e-3 Ω Resistances smaller than this will use the resistance form, as opposed to the standard conductance form.

Resistor Size Parameters

- 4 1=∞ mDefault resistor length.
- 5 w=1e-6 mDefault resistor width.
- 6 etch=0 mWidth narrowing due to etching per side.
- 7 etch1=0 mLength narrowing due to etching per side.
- 8 scaler=1Resistance scaling factor.

Temperature Effects Parameters

- 9 tc1=0 1/CLinear temperature coefficient.
- 10 tc2=0 C^{-2} Quadratic temperature coefficient.
- 11 tnom (C) Parameters measurement temperature. Default set by options.
- 12 trise=0 cDefault temperature rise from ambient.

Nonlinearity Coefficients

- 13 coeffs=[...] Vector of polynomial conductance coefficients.
- 14 nonlinform=gThe form of the nonlinear resistance.

 Possible values are g or r.

Component Statements Part 2

Noise Model Parameters

- 15 kf=0Flicker (1/f) noise coefficient.
- 16 af=2Flicker (1/f) noise exponent.
- 17 wdexp=1Flicker (1/f) noise W exponent.
- 18 ldexp=1Flicker (1/f) noise L exponent.
- 19 weexp=0Flicker (1/f) noise W effective exponent.
- 20 leexp=0Flicker (1/f) noise L effective exponent.
- 21 fexp=1Flicker (1/f) noise frequency exponent.

DC-Mismatch Model Parameters

- 22 mr=0.0Resistor mismatch dependence.
- 23 mrl=0.0Resistor mismatch length dependence.
- 24 mrlp=0.0Resistor mismatch length power dependence.
- 25 mrw=0.0Resistor mismatch width dependence.
- 26 mrwp=0.0Resistor mismatch width power dependence.
- 27 mrlw1=0.0Resistor mismatch area 1 dependence.
- 28 mrlw1p=0.0Resistor mismatch area 1 power dependence.
- 29 mrlw2=0.0Resistor mismatch area 2 dependence.
- 30 mrlw2p=0.0Resistor mismatch area 2 power dependence.

The instance parameter resform and the model parameter thresh control whether a resistor is formulated in the standard conductance form, or in the resistance form. If the value of the resistor is smaller than thresh, Spectre uses the resistance form; otherwise it uses the conductance form. If resform is set on an instance, it overrides the thresh parameter. The resistance form is appropriate for very small resistances and the conductance form is intended for larger resistances. Using the conductance form for very small resistances or the resistance form for very large resistances can cause convergence problems.

Component Statements Part 2

With the resistance form, the resistance can be zero; with the conductance form, the resistance can be infinite. The resistance form is less efficient than the conductance form. You cannot change the formulation of a resistor once it has been determined. Spectre makes this choice by comparing the initial value of the resistance to thresh.

Modeling AC Resistance

In certain situations, a part of a circuit that is required to calculate the DC operating point needs to be removed during a subsequent AC analysis or visa versa. An example of a situation in which this occurs is when measuring the loop gain of a feedback amplifier. In this case the feedback loop must be removed when computing the AC response of the amplifier. In Spectre, the most accurate method of doing this is to use an ideal switch component (see spectre -h switch), e.g.

```
Vin (pin 0) vsource mag=1
   OA1 (pin nin out) opamp
   Swl (nin out 0) switch position=1 ac_position=2
   LoopGain ac start=1 stop=1MHz
```

Another possibility is that the resistance of an instance changes from one analysis to another. The following subcircuit models a resistance whose value is given by the parameter rac during AC analyses, and rdc for all other analyses.

```
subckt ac_res (a b)
   parameters rdc=1 rac=2
   R1 (a i) resistor r=rdc
   Rac (i b) resistor r=rac-rdc
   Sw (i b) switch position=1 ac_position=0
ends ac res
```

Output Parameters

- 1 leff (m) Effective resistor length.
- 2 weff (m) Effective resistor width.
- 3 reff (Ω) Effective resistance.

Operating-Point Parameters

- 1 v (V) Voltage at operating point.
- 2 i (A) Current through the resistor.

Component Statements Part 2

- 3 res (Ω) Resistance at op point.
- 4 pwr (W) Power dissipation.

Parameter Index

af M-16	leff O-1	pwr OP-4	tc2 I-8
coeffs M-13	m I-4	r M-1	thresh M-3
etch M-6	mr M-22	r I-1	tnom M-11
etchl M-7	mrl M-23	reff O-3	trise I-9
fexp M-21	mrlp M-24	res OP-3	trise M-12
i OP-2	mrlw1 M-27	resform I-6	v OP-1
isnoisy I-10	mrlw1p M-28	rsh M-2	w M-5
kf M-15	mrlw2 M-29	scale I-5	w I-3
1 I-2	mrlw2p M-30	scaler M-8	wdexp M-17
1 M-4	mrw M-25	tc1 M-9	weexp M-19
ldexp M-18	mrwp M-26	tc1 I-7	weff O-2
leexp M-20	nonlinform M-14 t	c2 M-10	

s-Domain Linear Current Controlled Current Source (scccs)

Description

The device output is defined through a transfer function given as a ratio of two polynomials in the complex variable s. Polynomials can be specified in terms of either coefficients or roots. The roots of the numerator are the zeros of the transfer function and the roots of the denominator are the poles.

To specify the polynomial in terms of the coefficients, you enter them as a vector in ascending order of the power of the variable s, starting from the constant term. For example, to specify a denominator of $3s^2 + 4s + 1$, use $denom=[1 \ 4 \ 3]$.

Component Statements Part 2

To specify a polynomial in terms of its roots, you give the roots as a vector of complex frequencies (frequencies should be in radians/second). You must give both the real and imaginary parts of the root, even when the root is real. For the transfer function to be stable, all poles must have negative real values. When specifying a complex root, you should also specify its complex conjugate. However, if you omit the conjugate root, Spectre will supply the missing root and print a warning that a missing root was supplied. The order of the roots is not important. For example, to specify poles of s = -1, s = 4j, s = -4j, s = -2 + 2j, and s = -2 - 2j; use poles= $\begin{bmatrix} -1 & 0 & 0 & 4 & 0 & -4 & -2 & 2 & -2 & -2 \end{bmatrix}$.

Either the numerator or the denominator specification can be omitted. An omitted denominator or numerator is taken to be 1.

The parameter gain is interpreted either as the DC gain or, if the function has zeros or poles at the origin, as a constant factor.

This device is not supported within altergroup.

Sample Instance Statement

```
11 (2 1) inductor l=15
sc1 (1 0) scccs probe=l1 zeros=[0 6 0 -6 2 -8 2 8] poles=[-1 0 0 64 0 -64 -2 8 -2 -8]
```

Instance Definition

```
Name sink src scccs parameter=value ...
```

Instance Parameters

- 1 probeDevice through which the controlling current flows.
- 2 port=0Index of the probe port through which the controlling current flows.
- 3 gain=1Transfer function gain.
- 4 numer=[...] Vector of numerator coefficients.
- 5 denom=[...] Vector of denominator coefficients.
- 6 zeros=[...] Vector of complex zeros.
- 7 poles=[...] Vector of complex poles.
- 8 m=1Multiplicity factor.

Component Statements Part 2

Operating-Point Parameters

1 i (A) Input current.

2 v (V) Output voltage.

3 pwr (W) Power dissipation.

Parameter Index

s-Domain Current Controlled Voltage Source (sccvs)

Description

The device output is defined through a transfer function given as a ratio of two polynomials in the complex variable s. Polynomials can be specified in terms of either coefficients or roots. The roots of the numerator are the zeros of the transfer function and the roots of the denominator are the poles.

To specify the polynomial in terms of the coefficients, you enter them as a vector in ascending order of the power of the variable s, starting from the constant term. For example, to specify a denominator of $3s^2 + 4s + 1$, use denom=[1 4 3].

To specify a polynomial in terms of its roots, you give the roots as a vector of complex frequencies (frequencies should be in radians/second). You must give both the real and imaginary parts of the root, even when the root is real. For the transfer function to be stable, all poles must have negative real values. When specifying a complex root, you should also specify its complex conjugate. However, if you omit the conjugate root, Spectre will supply the missing root and print a warning that a missing root was supplied. The order of the roots is

Component Statements Part 2

not important. For example, to specify poles of s = -1, s = 4j, s = -4j, s = -2 + 2j, and s = -2 - 2j; use poles=[-1 0 0 4 0 -4 -2 2 -2 -2].

Either the numerator or the denominator specification can be omitted. An omitted denominator or numerator is taken to be 1.

The parameter gain is interpreted either as the DC gain or, if the function has zeros or poles at the origin, as a constant factor.

This device is not supported within altergroup.

Sample Instance Statement

```
myv (1 0) vsource type=sine freq=10K
scc1 (2 0) sccvs probe=myv qain=0.5 numer=[2] denom=[5]
```

Instance Definition

```
Name p n sccvs parameter=value ...
```

Instance Parameters

- 1 probeDevice through which the controlling current flows.
- 2 port=0Index of the probe port through which the controlling current flows.
- 3 gain=1Transfer function gain.
- 4 numer=[...] Vector of numerator coefficients.
- 5 denom=[...] Vector of denominator coefficients.
- 6 zeros=[...] Vector of complex zeros.
- 7 poles=[...] Vector of complex poles.
- 8 m=1Multiplicity factor.

Operating-Point Parameters

1 i (A) Output current.

Component Statements Part 2

2 v (V) Output voltage.

3 pwr (W) Power dissipation.

Parameter Index

denom	I-5	m I-8		port	I-2	V	OP-	2
gain	I-3	numer	I-4	probe	I-1	zer	os	I-6
i OP-	-1	poles	I-7	pwr	OP-3			

s-Domain Linear Voltage Controlled Current Source (svccs)

Description

The device output is defined through a transfer function given as a ratio of two polynomials in the complex variable s. Polynomials can be specified in terms of either coefficients or roots. The roots of the numerator are the zeros of the transfer function and the roots of the denominator are the poles.

To specify the polynomial in terms of the coefficients, you enter them as a vector in ascending order of the power of the variable s, starting from the constant term. For example, to specify a denominator of $3s^2 + 4s + 1$, use denom=[1 4 3].

To specify a polynomial in terms of its roots, you give the roots as a vector of complex frequencies (frequencies should be in radians/second). You must give both the real and imaginary parts of the root, even when the root is real. For the transfer function to be stable, all poles must have negative real values. When specifying a complex root, you should also specify its complex conjugate. However, if you omit the conjugate root, Spectre will supply the missing root and print a warning that a missing root was supplied. The order of the roots is not important. For example, to specify poles of s = -1, s = 4j, s = -4j, s = -2 + 2j, and s = -2 - 2j; use $poles=[-1 \ 0 \ 0 \ 4 \ 0 \ -4 \ -2 \ 2 \ -2 \ -2]$.

Component Statements Part 2

Either the numerator or the denominator specification can be omitted. An omitted denominator or numerator is taken to be 1.

The parameter gain is interpreted either as the DC gain or, if the function has zeros or poles at the origin, as a constant factor.

This device is not supported within altergroup.

Sample Instance Statement

```
s2 (1 0 control 0) svccs gain=0.4 numer=[2 3] denom=[4 5 1]
```

Instance Definition

```
Name sink src ps ns svccs parameter=value ...
```

Instance Parameters

- 1 gain=1Transfer function gain.
- 2 numer=[...] Vector of numerator coefficients.
- 3 denom=[...] Vector of denominator coefficients.
- 4 zeros=[...] Vector of complex zeros.
- 5 poles=[...] Vector of complex poles.
- 6 m=1Multiplicity factor.

Operating-Point Parameters

- 1 i (A) Output current.
- 2 v (V) Output voltage.
- 3 pwr (W) Power dissipation.

Parameter Index

In the following index, I refers to instance parameters, M refers to the model parameters section, O refers to the output parameters section, and OP refers to the operating point

Component Statements Part 2

parameters section. The number indicates where to look in the appropriate section to find the description for that parameter. For example, a reference of M-35 means the 35th model parameter.

s-Domain Voltage Controlled Voltage Source (svcvs)

Description

The device output is defined through a transfer function given as a ratio of two polynomials in the complex variable s. Polynomials can be specified in terms of either coefficients or roots. The roots of the numerator are the zeros of the transfer function and the roots of the denominator are the poles.

To specify the polynomial in terms of the coefficients, you enter them as a vector in ascending order of the power of the variable s, starting from the constant term. For example, to specify a denominator of $3s^2 + 4s + 1$, use $denom = [1 \ 4 \ 3]$.

To specify a polynomial in terms of its roots, you give the roots as a vector of complex frequencies (frequencies should be in radians/second). You must give both the real and imaginary parts of the root, even when the root is real. For the transfer function to be stable, all poles must have negative real values. When specifying a complex root, you should also specify its complex conjugate. However, if you omit the conjugate root, Spectre will supply the missing root and print a warning that a missing root was supplied. The order of the roots is not important. For example, to specify poles of s = -1, s = 4j, s = -4j, s = -2 + 2j, and s = -2 - 2j; use $poles=[-1 \ 0 \ 0 \ 4 \ 0 \ -4 \ -2 \ 2 \ -2 \ -2]$.

Either the numerator or the denominator specification can be omitted. An omitted denominator or numerator is taken to be 1.

The parameter gain is interpreted either as the DC gain or, if the function has zeros or poles at the origin, as a constant factor.

This device is not supported within altergroup.

Sample Instance Statement

```
e1 (1 0 control 0) svccs gain=5 poles=[-1 0 1 0] zero=[0 0 1 0]
```

Component Statements Part 2

Instance Definition

Name p n ps ns svcvs parameter=value ...

Instance Parameters

- 1 gain=1Transfer function gain.
- 2 numer=[...] Vector of numerator coefficients.
- 3 denom=[...] Vector of denominator coefficients.
- 4 zeros=[...] Vector of complex zeros.
- 5 poles=[...] Vector of complex poles.
- 6 m=1Multiplicity factor.

Operating-Point Parameters

- 1 i (A) Output current.
- 2 v (V) Output voltage.
- 3 pwr (W) Power dissipation.

Parameter Index

denom	I-3	m	I-6		pwr	OI	2-3
gain I	1-1	nume	er	I-2	v	OP-2	2
i OP-1	_	pole	es	I-5	zero	s	I-4

Component Statements Part 2

Ideal Switch (switch)

Description

Ideal switch is a single-pole multiple-throw switch with infinite off resistance and zero on resistance. The switch is provided to allow you to reconfigure your circuit between analyses. You can only change the switch state between analyses (using the alter statement), not during an analysis.

When the switch is set to position 0 it is open. In other words, no terminal is connected to any other. When the switch is set to position 1, terminal 1 is connected to terminal 0, and all others are unconnected. When the position is set to 2, terminal 2 is connected to terminal 0, etc.

An offset voltage is supported. It is placed in series with the common terminal. The negative side of the source is connected to the common terminal.

The switch can change its position based on which analysis type is being performed using the $xxx_position$ parameters. This feature should be used carefully. Careless use can generate discontinuities that result in convergence problems. Once an analysis specific position has been specified using $xxx_position$, it will always dominate over a position given with the position parameter. To disable an analysis specific position, alter it to its default value of unspecified.

This device is not supported within altergroup.

Sample Instance Statement

```
sw1 (t1 t2 t3) switch dc_position=0 ac_position=1 tran_position=2
```

Instance Definition

```
Name t0 t1 ... switch parameter=value ...
```

Instance Parameters

- 1 position=0Switch position (0, 1, 2, ...).
- 2 dc_positionPosition to which switch is set at start of DC analysis.
- 3 ac_positionPosition to which switch is set at start of AC analysis.
- 4 tran_positionPosition to which switch is set at start of transient analysis.

Component Statements Part 2

- 5 ic_positionPosition to which switch is set at start of IC analysis (precedes transient analysis).
- 6 offset=0Offset voltage in series with common terminal.
- 7 m=1.0Multiplicity factor.

Output Parameters

1 present_position

Current switch position.

Parameter Index

Transmission Line (tline)

Description

Lossy or lossless transmission line.



The lossy transmission line model includes dielectric and conductor loss effects. The conductor loss includes skin effect assuming finite or infinite conductor thickness.

Component Statements Part 2

Only the odd mode is modeled, so only the voltage difference across each port is important. (The absolute voltage of each terminal is not significant.) Also, the current into one node of a port exactly equals the current leaving the other node of the port.

This device is supported within altergroups.

Sample Instance Statement

```
t1 (1 0 2 0) lmodel z0=100
```

Sample Model Statement

```
model lmodel tline f=10M z0=50 alphac=8501 fc=10M dcr=88
```

Instance Definition

```
Name t1 b1 t2 b2 ModelName parameter=value ...
Name t1 b1 t2 b2 tline parameter=value ...
```

Instance Parameters

- 1 $z_0=50$ Ω Characteristic impedance of lossless line.
- 2 td (s) Time delay of a lossless line in seconds, a measure of the electrical length.
- 3 f (Hz) Reference frequency (used in conjunction to the normalized length to specify electrical length of line).
- 4 nl=0.25Normalized electrical length in wavelengths at f of a lossless line.
- 5 vel=1Propagation velocity of the line given as a multiple of c, the speed of light in free space. (vel <= 1).
- 6 len=0 mPhysical length (used with vel to specify electrical length of line).
- 7 m=1Multiplicity factor.

Model Definition

```
model modelName tline parameter=value ...
```

Component Statements Part 2

Model Parameters

- 1 $z_0=50$ Ω Characteristic impedance of lossless line.
- 2 f (Hz) Reference frequency (used in conjunction to the normalized length to specify electrical length of line).
- 3 vel=1Propagation velocity of the line given as a multiple of c, the speed of light in free space. (vel <= 1).

Conductor Loss Parameters

- 4 corner=0 HzCorner frequency for skin effect, frequency where skin depth equals the conductors wall thickness.
- 5 dcr=0 Ω /mDC series resistance per unit length.
- 6 fc (Hz) Conductor loss measurement frequency (use with r, qc, or alphac).
- 7 r=0 Ω/m Conductor (series) resistance per unit length at fc.
- 8 alphac=0 dB/mConductor loss at fc (low loss approximation).
- 9 qc=∞Conductor loss quality factor at fc (low loss approximation).

Dielectric Loss Parameters

- 10 fd (Hz) Dielectric loss measurement frequency (use with qd).
- 11 g=0 S/mDielectric (shunt) conductance per unit length.
- 12 alphad=0 dB/mDielectric loss (low loss approximation).
- 13 qd=∞Dielectric loss quality factor at fd (low loss approximation).

Lossless Case

The lossless transmission line is specified with parameters z0 and td. The device behavior is then:

$$V1(t) - z0*I1(t) = V2(t-td) + z0*I2(t-td)$$

Component Statements Part 2

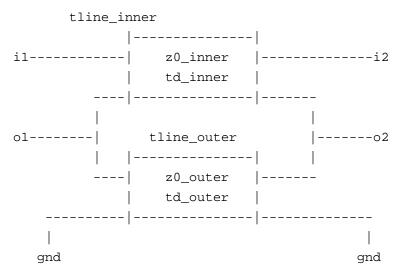
and

$$V2(t) - zO*I2(t) = V1(t-td) + z0*I1(t-td).$$

where t is time and td is the delay. Note, if the device is terminated by a matched impedance of z0 (across t2 and b2), then it becomes an ideal delay. i.e V2(t) = V1(t-td).

To Model Both Even and Odd Modes

Use two lines as shown below:



This model is suitable for a coax where tline_inner models the inner/outer conductor line (or the odd mode) while tline_outer models the outer/ground line (or the even mode). Note that this model is non-symmetric.

Lossy Case

In the frequency-domain the device is modeled by

$$V1(jw) - Z(jw)*I1(jw) = S12(jw)* [V2(jw) + Z(jw)I2(jw)]$$
 and
$$V2(jw) - Z(jw)*I2(jw) = S21(jw)* [V1(jw) + Z(jw)I1(jw)]$$
 where j=sqrt(-1) and w is the angular frequency in radians/s.

The loss coefficient is computed from

$$S21(jw) = S12(jw) = exp(-Gamma(jw)*len)$$

where

Component Statements Part 2

$$Gamma(jw) = sqrt (Zc(jw) * Yd(jw))$$

where Zc represents the per-unit-length series impedance and Yd represents the perunit-length shunt admittance loss (as described below).

The characteristic impedance (Z) is computed from

$$Z(jw) = sqrt(Zc(jw) / Yd(jw)).$$

The time-domain behavior of the lossy transmission line is computed through a recursive convolution algorithm.

The dielectric loss (Yd) is computed from

$$Yd(jw) = G + j^* w/(z0^*c^*vel)$$

where G is the per-unit-length shunt conductance and can be specified in three ways.

$$q = G = g$$
 { when g is given }

q
$$G = 2/z0$$
 * alphad { when alphad is given }

$$G = 2/z0 * fd/(2*qd*c*vel)$$
 { when fd and qd are given }

m where c is the speed of light.

The series impedance (Zc) is computed from

$$Zc(jw) = Zi + j*w*z0/(c*vel).$$

where Zi represents the internal loss. When skin effect is not present then

$$Zi = dcr$$

where dcr is the DC series per-unit-length resistance.

Skin Effect Assuming Finite Thickness

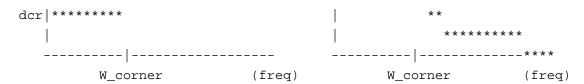
In this case the internal impedance (Zi) is computed from

$$Zi = Ri + j*w*Li$$

where Ri and Li exhibit the following behavior



Component Statements Part 2



The expressions for Ri and Li are

```
when w << W_corner: Ri ~ dcr and Li ~ dcr/(1.5*W_corner)
when w >> W_corner: Ri ~ dcr*sqrt(w/W_corner)
and
Li ~ dcr/(sqrt(w*W_corner))
Otherwise: Ri = dcr * nt * (sinh(2*nt)+sin(2*nt))/(cosh(2*nt)-cos(2*nt))
and
Li = dcr * nt * (sinh(2*nt)-sin(2*nt))/(cosh(2*nt)-cos(2*nt)) / w
where nt=sqrt(w/W_corner) is the normalized thickness
```

The equations can be found in:

Ramo, Whinnery, Van Duzer. Fields and waves in communication electronics. 1965. See Section on "Impedance of thin-walled conductors". Pg 301.

The corner frequency (W_corner) results from skin effect on conductors of finite thickness. As frequency decreases, skin depth increases resulting in more conductor to pass the current, which results in lower loss. However, at the corner frequency, the skin depth equals the radius of the conductor. Decreasing the frequency below that point does not further reduce the loss.

The corner frequency (W_corner) can be specified in two ways.

- q When dcr and corner are given, then
 - W_corner= 2*pi*corner
- q When dcr, r, and fc are given, then

$$W_{corner} = 2*pi*fc* (dcr/r)^2$$

In addition, there are two alternative ways to specify r.

- q r = 2*z0*alphac { when alphac is given }
- q r = 2*z0*fc/(2*qc*c*vel) { when qc is given }

Component Statements Part 2

where c is the speed of light are defined below.

Skin Effect Assuming Infinite Thickness

In this case there is no corner frequency (and no der), and the internal loss (Zi) is computed from

```
Zi= Ri + j*w*Li
where Ri = r*sqrt(w/(2*pi*fc)) and Li = r/sqrt(w*2*pi*fc).
```

Again, r can be specified directly, or using alphac or qc as described above in the case of finite thickness.

Three Ways to Specify vel, td, and len

- n When vel and len are given
 - td = len/(vel*c)
- n When td and vel are given

n When f, nl and vel are given

$$td = nI/f$$

$$len = (nl/f)*vel*c$$

The parameter len is the physical length, c is the speed of light and vel is the propagation velocity as a multiple of c. (Recall that velocity = c/sqrt(relative dielectric constant).) The parameter f is a reference frequency and nl is the normalized electrical length in wavelengths at f.

Parameter Index

alphac M-8 f M-2 m I-7 td I-2

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Component Statements Part 2

alphad M-12	fc M-6	nl I-4	vel M-3
corner M-4	fd M-10	qc M-9	vel I-5
dcr M-5	g M-11	qd M-13	z0 M-1
f I-3	len I-6	r M-7	z0 I-1

GaAs MESFET (tom2)

Description

TOM2 stands for Triquint Own Model version-2. It is an improved GaAs MESFET developed by David H. Smith. The charge model in TOM2 is similar to that of the Statz model and does not conserve charge. Therefore, this model should not be used to simulate circuits that requires charge conservation such as charge-pump circuits. TOM2 GaAs MESFET instances require that you use a model statement.

This device is supported within altergroups.

There are some convergence problems with this model because of Cgs going to zero beyond pinchoff. The problems occur when the gate is driven from an inductive source, and there is no other capacitance at the gate. To prevent these problems, avoid setting Cgd to zero and add side wall capacitance to the gate-source and gate-drain junctions. A good estimate for these capacitors is $C = pi^*epsilon^*w/2$ where w is the gate width in microns and epsilon = 0.116 fF/micron.

Sample Instance Statement

mt1 (2 1 0) tom2mos area=1 region=fwd

Sample Model Statement

model tom2mos tom2 vto=-0.55 alpha=3.9 beta=0.001 gamma=0.075 delta=100 ng=1 rd=550 rs=550 rg=1 is=0.295e-14 n=1.2 cgs=1.4e-15 cgd=2e-16 cds=3e-16

Instance Definition

Name d g s ModelName parameter=value ...

Instance Parameters

- 1 area=1Junction area factor.
- 2 m=1Multiplicity factor.

Component Statements Part 2

3 region=fwdEstimated operating region.

Possible values are off, triode, sat, or subth.

Model Definition

model modelName tom2 parameter=value ...

Model Parameters

Device Type Parameters

1 type=nTransistor type.

Possible values are n or p.

Drain Current Parameters

- 2 vto=-2.5 vThreshold voltage.
- 3 alpha=2 1/VKnee-voltage parameter.
- 4 beta=0.1 A/V^2 Transconductance parameter.
- 5 gamma=0 1/VThreshold shifting parameter.
- 6 delta=0.2 VOutput feedback parameter.
- 7 q=2Power-law parameter.

Subthreshold Parameters

- 8 ng=0Subthreshold slope gate parameter.
- 9 nd=0 1/VSubthreshold slope drain pull parameter.

Parasitic Resistance Parameters

- 10 rd=0 Ω Drain resistance (/area).
- 11 rs=0 Ω Source resistance (/area).

Component Statements Part 2

- 12 rg=0 Ω Gate resistance (/area).
- 13 minr=0.1 Ω Minimum source/drain/gate resistance.

Junction Diode Model Parameters

- 14 is=1e-14 AGate diode saturation current (*area).
- 15 n=1Emission coefficient for the gate junction.
- 16 imelt=\imaxA' Explosion current (*area).
- 17 dskip=yesUse simple piece-wise linear model for diode currents below 0.1*iabstol. Possible values are no or yes.

Junction Capacitance Model Parameters

- 18 capmod=2Charge model selector.
- 19 cgs=0 FGate-source zero-bias junction capacitance (*area).
- 20 cgd=0 FGate-drain zero-bias junction capacitance (*area).
- 21 cds=0 FDrain-to-source capacitance.
- 22 vbi=1 vGate diode built-in potential.
- 23 vmax=0.95Gate diode capacitance limiting voltage.
- 24 vdelta=0.2 vCapacitance transition voltage.
- 25 tau=0 sConduction current delay time.

Temperature Effects Parameters

- 26 tnom (C) Parameters measurement temperature. Default set by options.
- 27 xti=0Temperature exponent for effect on is.
- 28 eg=1.11 VEnergy band gap.
- 29 vtotc=0 V/CTemperature coefficient for vto.

Component Statements Part 2

- 30 vbitc=0 V/CTemperature coefficient for vbi.
- 31 alphatce=0 1/CTemperature coefficient for alpha.
- 32 betatce=0 1/cTemperature coefficient for beta.
- 33 gammatc=0 1/CTemperature coefficient for gamma.
- 34 trs1=0 1/CTemperature parameter for source resistance.
- 35 trd1=0 1/cTemperature parameter for drain resistance.
- 36 trg1=0 1/cTemperature parameter for gate resistance.
- 37 cgdtce=0 1/CDrain junction capacitance temperature coefficient.
- 38 cgstce=0 1/cSource junction capacitance temperature coefficient.

Operating Region Warning Control Parameters

- 39 imax=1 AMaximum allowable current (*area).
- 40 bv j=∞ VJunction reverse breakdown voltage.

Noise Model Parameters

- 41 kf=0Flicker (1/f) noise coefficient.
- 42 af=1Flicker (1/f) noise exponent.
- 43 kfd=0Flicker noise (1/f) coefficient for gate diodes.
- 44 afg=1Flicker noise (1/f) exponent for gate diodes.

The imax parameter aids convergence and prevents numerical overflow. The junction characteristics of the FET are accurately modeled for currents up to imax. For currents above imax, the junction is modeled as a linear resistor and a warning is printed. The by parameter detects the junction breakdown only. The breakdown currents of the junctions are not modeled.

Component Statements Part 2

Operating-Point Parameters

1 type=nTransistor type.

Possible values are n or p.

2 region=fwdEstimated operating region.

Possible values are off, triode, sat, or subth.

- 3 vgs (V) Gate-source voltage.
- 4 vds (V) Drain-source voltage.
- 5 id (A) Drain current.
- 6 ig (A) Gate current.
- 7 ids (A) Drain-to-source current.
- 8 qm (S) Common-source transconductance.
- 9 gds (S) Common-source output conductance.
- 10 vth (V) Threshold voltage.
- 11 cgs (F) Gate-source capacitance.
- 12 cgd (F) Gate-drain capacitance.
- 13 cds (F) Drain-source capacitance.
- 14 pwr (W) Power at op point.

Parameter Index

af	M-42	cgstce	M - 38	m I-2	trs1	M-34
afg	M-44	delta	M-6	minr M-13	type	OP-1

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Component Statements Part 2

alpha M-3	dskip M-17	n M-15	type M-1
alphatce M-31	eg M-28	nd M-9	vbi M-22
area I-1	gamma M-5	ng M-8	vbitc M-30
beta M-4	gammatc M-33	pwr OP-14	vdelta M-24
betatce M-32	gds OP-9	q M-7	vds OP-4
bvj M-40	gm OP-8	rd M-10	vgs OP-3
capmod M-18	id OP-5	region I-3	vmax M-23
cds OP-13	ids OP-7	region OP-2	vth OP-10
cds M-21	ig OP-6	rg M-12	vto M-2
cgd OP-12	imax M-39	rs M-11	vtotc M-29
cgd M-20	imelt M-16	tau M-25	xti M-27
cgdtce M-37	is M-14	tnom M-26	
cgs OP-11	kf M-41	trd1 M-35	
cgs M-19	kfd M-43	trg1 M-36	

Linear Two Winding Ideal Transformer (transformer)

Description

Winding 1 connects terminals t1 and b1, and winding 2 connects t2 and b2. The number of turns on windings 1 and 2 are given by n1 and n2, respectively, and n2 must not be zero. The absolute number of turns of each winding is not important, only the ratio of n1 to n2. Current through winding 1 is computed.

This device is not supported within altergroup.

An ideal transformer is modeled, so it acts as a transformer at DC. Thus

$$\frac{v_1}{v_2} = \frac{t_1}{t_2} = \frac{i_2}{i_1}$$

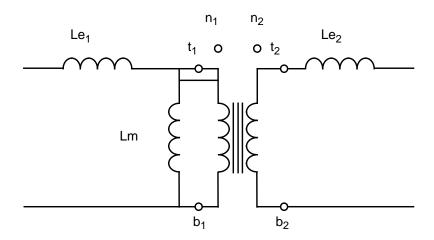
To model a physical transformer with L_1 and L_2 as the inductance of the windings and k as the coupling coefficient, add an inductor $L_m = k L_1$ in parallel with winding 1 and inductors $L_{e1} = L_1 (1 - k)$ and $L_{e2} = L_2 (1 - k)$ in series with windings 1 and 2, respectively. The turns ratio can be computed with

$$\frac{n_1}{n_2} = \sqrt{\frac{L_1}{L_2}}$$

Component Statements Part 2

k can be calculated from the $L_{_1}$ (the inductance of winding 1 with winding 2 open) and $L_{_{\rm S}}$ (the inductance of winding 1 with winding 2 shorted) with

$$k = \sqrt{1 - \frac{L_s}{L_1}}$$



Linear Two-Winding Ideal Transformer

Instance Definition

Name t1 b1 t2 b2 transformer parameter=value ...

Instance Parameters

- 1 n1=1Number of turns on winding 1.
- 2 n2=1Number of turns on winding 2.
- 3 m=1Multiplicity factor.

Component Statements Part 2

VBIC Bipolar Transistor (vbic)

Description

The VBIC model was developed as a replacement for the SPICE G-P model. The model has four electrical terminals, two thermal terminals, and up to nine internal nodes, depending on the model parameters that the user specifies. Detailed description of the model and equations are given in the Spectre Circuit Simulator Device Model Equations manual.

This device is supported within altergroups.

Sample Instance Statement

```
q1 (1 2 0 0 0) vbjt area=1
```

Sample Model Statement

model vbjt vbic type=npn is=2e-16 iben=4.5e-15 isp=1e-15 gamm=1.55e-11 ikf=0.0021 ikr=0.0021 vef=15 ver=7 rbi=35 rbx=7 re=3 rs=15 cje=1.5e-14 tf=15e-12 selft=yes rth=1K

Instance Definition

```
Name c b e [s] [dt] [t1] ModelName parameter=value ...
```

tl node is the local temperature and the \mathtt{dt} node is the rise above the local temperature caused by the thermal power dissipated by the device being modeled by VBIC. Consequently, the \mathtt{tl} node can be connected to a thermal network that models heat flow through the substrate and/or between devices. It is not necessary to specify the substrate and the two thermal terminals. If left unspecified, the substrate and the \mathtt{tl} thermal terminal are connected to ground. But if the self-heating flag is turned on and \mathtt{dt} is not given, an internal node is created for self-heating. You must specify the substrate terminal if you specify \mathtt{dt} and both substrate and \mathtt{dt} must be given if \mathtt{tl} needs to be specified.

Instance Parameters

- 1 area=1 Transistor area factor.
- 2 m=1Multiplicity factor.
- 3 region=fwdEstimated operating region.

Possible values are off, fwd, rev, sat, or breakdown.

Component Statements Part 2

4 triseTemperature rise from ambient.

Model Definition

model modelName vbic parameter=value ...

Model Parameters

Structural Parameters

1 type=npnTransistor type.

Possible values are npn or pnp.

Saturation Current Parameters

- 2 is=1e-16 ATransport saturation current (*area).
- 3 ibei=1e-18 Aldeal B-E saturation current. (*area).
- 4 iben=0 ANonideal B-E saturation current (*area).
- 5 ibci=1e-16 Aldeal B-C saturation current. (*area).
- 6 ibcn=0 ANonideal B-C saturation current (*area).
- 7 isp=0 AParasitic transport saturation current. (*area).
- 8 ibeip=0 Aldeal parasitic B-E saturation current (*area).
- 9 ibenp=0 ANonideal parasitic B-E saturation current (*area).
- 10 ibcip=0 Aldeal parasitic B-C saturation current (*area).
- 11 ibcnp=0 ANonideal parasitic B-C saturation current (*area).
- 12 vo=0 VEpi drift saturation voltage.
- 13 gamm=0 VEpi doping parameter.
- 14 hrcf=1High current RC factor.
- 15 wbe=1Portion of Ibei from Vbei.

Component Statements Part 2

16 wsp=1Portion of Iccp from Vbep.

Emission Coefficient Parameters

- 17 nf=1Forward emission coefficient.
- 18 nr=1Reverse emission coefficient.
- 19 nei=1ldeal B-E emission coefficient.
- 20 nen=2Nonideal B-E emission coefficient.
- 21 nci=1ldeal B-C emission coefficient.
- 22 ncn=2Nonideal B-C emission coefficient.
- 23 nfp=1Parasitic forward emission coefficient.
- 24 ncip=1ldeal parasitic B-C emission coefficient.
- 25 ncnp=2Nonideal parasitic B-C emission coefficient.

Current Gain Parameters

- 26 $ikf=\infty$ AForward knee current (*area).
- 27 ikr=∞ AReverse knee current (*area).
- 28 ikp=∞ AParasitic knee current (*area).

Early Voltage Parameters

- 29 vef=∞ VForward Early voltage.
- 30 ver=∞ vReverse Early voltage.

Breakdown Voltage Parameters

- 31 avc1=0B-C weak avalanche parameter.
- 32 avc2=0B-C weak avalanche parameter.

Component Statements Part 2

Parasitic Resistance Parameters

- 33 rbi=0 Ω Intrinsic base resistance (/area).
- 34 rbx=0 Ω Extrinsic base resistance (/area).
- 35 re=0 Ω Emitter resistance (/area).
- 36 rs=0 Ω Substrate resistance (/area).
- 37 rbp=0 Ω Parasitic base resistance (/area).
- 38 rcx=0 Ω Extrinsic collector resistance (/area).
- 39 rci=0 Ω Intrinsic collector resistance (/area).

Junction Capacitance Parameters

- 40 cje=0 FB-E zero-bias capacitance (*area).
- 41 pe=0.75 VB-E built-in potential.
- 42 me=0.33B-E grading coefficient.
- 43 a je=-0.5B-E capacitance smoothing factor.
- 44 fc=0.9Forward-bias depletion capacitance limit.
- 45 cbeo=0 FExtrinsic B-E overlap capacitance (*area).
- 46 cjc=0 FB-C zero-bias capacitance (*area).
- 47 cjep=0 FB-C extrinsic zero-bias capacitance (*area).
- 48 pc=0.75 VB-C built-in potential.
- 49 mc=0.33B-C grading coefficient.
- 50 ajc=-0.5B-C capacitance smoothing factor.
- 51 cbco=0 FExtrinsic B-C overlap capacitance (*area).
- 52 gco=0 CoulEpi charge parameter.

Component Statements Part 2

- 53 cjcp=0 FS-C zero-bias capacitance (*area).
- 54 ps=0.75 VS-C built-in potential.
- 55 ms=0.33S-C grading coefficient.
- 56 a js=-0.5S-C capacitance smoothing factor.

Transit Time and Excess Phase Parameters

- 57 tf=0 sForward transit time.
- 58 tr=0 sReverse transit time.
- 59 td=0 sForward excess-phase delay time.
- 60 qtf=0Variation of tf with base width modulation.
- 61 xtf=0Coefficient of tf with bias dependence.
- 62 vtf=0Coefficient of tf dependence on Vbc.
- 63 itf=0Coefficient of tf dependence on lc.

Temperature Effects Parameters

- 64 selft=0Flag denoting self-heating.

 Possible values are no or yes.
- 65 tnom (C) Parameters measurement temperature. Default set by options.
- 66 trise=0 CTemperature rise from ambient.
- 67 rth=0 Ω Thermal resistance, must be given for self-heating.
- 68 cth=0 FThermal capacitance.
- 69 xis=3 VTemperature exponent of ls.
- 70 xii=3 vTemperature exponent of Ibei, Ibei, Ibeip, and Ibeip.
- 71 xin=3 vTemperature exponent of Iben, Iben, Ibenp, and Ibenp.

Component Statements Part 2

- 72 tnf=0 vTemperature coefficient of Nf.
- 73 tavc=0 VTemperature coefficient of Avc2.
- 74 ea=1.12 VActivation energy for is.
- 75 eaie=1.12 vActivation energy for Ibei.
- 76 eaic=1.12 vActivation energy for lbci/lbeip.
- 77 eais=1.12 VActivation energy for Ibcip.
- 78 eane=1.12 VActivation energy for Iben.
- 79 eanc=1.12 VActivation energy for Ibcn/Ibenp.
- 80 eans=1.12 VActivation energy for Ibcnp.
- 81 xre=0Temperature exponent of re.
- 82 xrb=0Temperature exponent of rb.
- 83 xrc=0Temperature exponent of rc.
- 84 xrs=0Temperature exponent of rs.
- 85 xvo=0Temperature exponent of vo.
- 86 dtmax=226.85 CMaximum expected device temperature. (500 K).

Noise Model Parameters

- 87 kfn=0B-E flicker (1/f) noise coefficient.
- 88 afn=1B-E flicker (1/f) noise exponent.
- 89 bfn=1B-E flicker (1/f) noise dependence.

Junction Diode Model Control Parameters

90 dskip=yesSkip junction calculations if they are reverse-saturated. Possible values are no or yes.

Component Statements Part 2

91 imelt=10 AExplosion current (*area).

Operating Region Warning Control Parameters

- 92 bvbe=∞ VB-E breakdown voltage.
- 93 bvbc=∞ VB-C breakdown voltage.
- 94 bvce=∞ vC-E breakdown voltage.
- 95 bvsub=∞ vSubstrate junction breakdown voltage.
- 96 vbefwd=0.2 VB-E forward voltage.
- 97 vbcfwd=0.2 vB-C forward voltage.
- 98 vsubfwd=0.2 vSubstrate junction forward voltage.
- 99 imax=1 AMaximum allowable base current (*area).
- 100 imax1=imax AMaximum allowable collector current (*area).
- 101 alarm=noneForbidden operating region.

Possible values are none, off, fwd, rev, or sat.

DC-Mismatch Model Parameters

102 mvt0=0.0 vThreshold mismatch intercept.

Imax and Imelt

The imax parameter aids convergence and prevents numerical overflow. The junction characteristics of the device are accurately modeled for current up to imax. If imax is exceeded during iterations, the linear model is substituted until the current drops below imax or until convergence is achieved. If convergence is achieved with the current exceeding imax, the results are inaccurate, and Spectre prints a warning.

A separate model parameter, imelt, is used as a limit warning for the junction current. This parameter can be set to the maximum current rating of the device. When any component of the junction current exceeds imelt, note that base and collector currents are composed of many exponential terms, Spectre issues a warning and the results become inaccurate. The

Component Statements Part 2

junction current is linearized above the value of imelt to prevent arithmetic exception, with the exponential term replaced by a linear equation at imelt.

Operating-Point Parameters

- 1 type=npnTransistor type.
 - Possible values are npn or pnp.
- 2 region=fwdEstimated operating region.
 - Possible values are off, fwd, rev, sat, or breakdown.
- 3 vbe (V) Base-emitter voltage.
- 4 vbc (V) Base-collector voltage.
- 5 vce (V) Collector-emitter voltage.
- 6 vcs (V) Collector-substrate voltage.
- 7 temp (C) Device temperature.
- 8 ith (A) Thermal source.
- 9 ic (A) Intrinsic DC collector current. (Icc Ibc + Igc).
- 10 ib (A) Intrinsic DC base current. (lbe + lbc lgc).
- 11 icc (A) C-E current.
- 12 ibe (A) Intrinsic B-E junction current.
- 13 ibc (A) Intrinsic B-C junction current.
- 14 ibex (A) BX-E junction current.
- 15 igc (A) Breakdown current.
- 16 iccp (A) Parasitic transistor C-E current.
- 17 ibep (A) Parasitic transistor B-E current.
- 18 ibcp (A) Parasitic transistor B-C current.

Component Statements Part 2

- 19 betadc (A/A) Ratio of external collector current to external base current. (ic_ext/ib_ext).
- 20 gm (S) Intrinsic small-signal transconductance. (gm = dlcc_dVbe + dlcc_dVbc).
- 21 gpi (S) Intrinsic small-signal input conductance. (gpi = dlbe_dVbe).
- 22 go (S) Intrinsic small-signal output conductance. (go = -dlcc_dVbc).
- 23 gmu (S) Intrinsic small-signal Collector-Base conductance. (gmu = dlbc_dVbc).
- 24 cpi (F) Intrinsic small-signal B-E capacitance. Same as cje.
- 25 cmu (F) Intrinsic small signal B-C capacitance. Same as cjc.
- 26 betaac (A/A) Small-signal common-emitter current gain. (gm/gpi).
- 27 ft (Hz) Unity small-signal current-gain frequency.
- 28 dic_dvbe (S)Intrinsic dlc/dVbe.
- 29 dic dvbc (S)Intrinsic dlc dVbc.
- 30 dib_dvbe (S)Intrinsic dlb_dVbe.
- 31 dib_dvbc (S)Intrinsic dlb_dVbc.
- 32 rbi (Ω) Intrinsic base resistance.
- 33 rci (Ω) Intrinsic collector resistance.
- 34 rbp (Ω) Parasitic transistor base resistance.
- 35 cje (F) Intrinsic B-E capacitance.
- 36 cjc (F) Intrinsic B-C capacitance.
- 37 cbex (F)BX-E junction capacitance.
- 38 cbcx (F)B-CX junction capacitance.
- 39 cbep (F) Parasitic B-E junction capacitance.
- 40 cbcp (F) Parasitic B-C junction capacitance.

Component Statements Part 2

41 pwr (W) Power dissipation.

Parameter Index

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ajc M-50	eaie M-75	is M-2	rth M-67
aje M-43	eais M-77	isp M-7	selft M-64
ajs M-56	eanc M-79	itf M-63	tavc M-73
alarm M-101	eane M-78	ith OP-8	td M-59
area I-1	eans M-80	kfn M-87	temp OP-7
avc1 M-31	fc M-44	m I-2	tf M-57
avc2 M-32	ft OP-27	mc M-49	tnf M-72
betaac OP-26	gamm M-13	me M-42	tnom M-65
betadc OP-19	gm OP-20	ms M-55	tr M-58
bfn M-89	gmu OP-23	mvt0 M-102	trise M-66
bvbc M-93	go OP-22z	nci M-21	trise I-4
bvbe M-92	gpi OP-21	ncip M-24	type OP-1
bvce M-94	hrcf M-14	ncn M-22	type M-1
bvsub M-95	ib OP-10	ncnp M-25	vbc OP-4
cbco M-51	ibc OP-13	nei M-19	vbcfwd M-97
cbcp OP-40	ibci M-5	nen M-20	vbe OP-3
cbcx OP-38	ibcip M-10	nf M-17	vbefwd M-96
cbeo M-45	ibcn M-6	nfp M-23	vce OP-5
cbep OP-39	ibcnp M-11	nr M-18	vcs OP-6
cbex OP-37	ibcp OP-18	pc M-48	vef M-29
cjc OP-36	ibe OP-12	pe M-41	ver M-30
cjc M-46	ibei M-3	ps M-54	vo M-12
cjcp M-53	ibeip M-8	pwr OP-41	vsubfwd M-98
cje OP-35	iben M-4	qco M-52	vtf M-62
cje M-40	ibenp M-9	qtf M-60	wbe M-15
cjep M-47	ibep OP-17	rbi M-33	wsp M-16
cmu OP-25	ibex OP-14	rbi OP-32	xii M-70
cpi OP-24	ic OP-9	rbp M-37	xin M-71
cth M-68	icc OP-11	rbp OP-34	xis M-69
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dib_dvbe OP-30	igc OP-15	rci OP-33	xrc M-83
dic_dvbc OP-29	ikf M-26	rci M-39	xre M-81
dic_dvbe OP-28	ikp M-28	rcx M-38	xrs M-84

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Component Statements Part 2

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dtmax	M-86	imax	M - 99	region	OP-2	xvo	M - 85
ea M-	-74	imax1	M = 1.00	region	T-3		

Linear Voltage Controlled Current Source (vccs)

Description

Positive current exits the source node and enters the sink node.

This device is supported within altergroups.

Sample Instance Statement

v1 (1 0 2 3) gm=-1 m=2

Instance Definition

Name sink src ps ns vccs parameter=value ...

Instance Parameters

- 1 gm=0 STransconductance.
- 2 m=1Multiplicity factor.

Operating-Point Parameters

- 1 i (A) Output current.
- 2 v (V) Output voltage.
- 3 pwr (W) Power dissipation.

Component Statements Part 2

Linear Voltage Controlled Voltage Source (vcvs)

Description

Current through the voltage source is calculated and is defined to be positive if it flows from the positive terminal, through the source, to the negative terminal.

This device is supported within altergroups.

Sample Instance Statement

```
el (outl 0 pos neg) vcvs gain=10
```

Instance Definition

```
Name p n ps ns vcvs parameter=value ...
```

Instance Parameters

- 1 gain=0 V/VVoltage gain.
- 2 m=1Multiplicity factor.

Operating-Point Parameters

- 1 i (A) Output current.
- 2 v (V) Output voltage.
- 3 pwr (W) Power dissipation.

Independent Voltage Source (vsource)

Description

Current through the source is computed and is defined to be positive if it flows from the positive node, through the source, to the negative node.

This device is supported within altergroups.

Component Statements Part 2

The value of the DC voltage as a function of the temperature is given by:

$$V(T) = V(tnom) * [1 + tc1 * (T - tnom) + tc2 * (T - tnom)^2]$$

Sample Instance Statement

vpulse1 (1 0) vsource type=pulse val0=0 val1=5 period=100n rise=10n fall=10n width=40n

vpwl1 (1 0) vsource type=pwl wave=[1n 0 1.1n 2 1.5n 0.5 2n 3 5n 5] pwlperiod=5n

Instance Definition

Name p n vsource parameter=value ...

Instance Parameters

1 dc=0 VDC value.

General Waveform Parameters

- 2 type=dcWaveform type.
 - Possible values are dc, pulse, pwl, sine, or exp.
- 3 fundnameName of the fundamental frequency. Must be specified if the source is active during a poisto analysis or it is the active clock during an envlp analysis.
- 4 delay=0 sWaveform delay time.

Pulse Waveform Parameters

- 5 val0=0 vZero value used in pulse and exponential waveforms.
- 6 val1=1 vOne value used in pulse and exponential waveforms.
- 7 period=∞ sPeriod of waveform.
- 8 rise (s) Rise time for pulse waveform (time for transition from val0 to val1).
- 9 fall (s) Fall time for pulse waveform (time for transition from val1 to val0).
- 10 width=∞ sPulse width (duration of vall).

Component Statements Part 2

PWL Waveform Parameters

- 11 fileName of file containing waveform.
- 12 wave=[...] Vector of time/value pairs that defines waveform.
- 13 offset=0 VDC offset for the PWL waveform.
- 14 scale=1Scale factor for the PWL waveform.
- 15 stretch=1Scale factor for time given for the PWL waveform.
- 16 allbrkptsAll the points in the PWL waveform are breakpoints if set to yes. Default is yes if the number of points is less than 20.

 Possible values are no or yes.
- 17 pwlperiod (s) Period of the periodic PWL waveform.
- 18 twidth=pwlperiod/1000 s

 Transition width used when making PWL waveforms periodic.

Sinusoidal Waveform Parameters

- 19 sinedc=dc VDC level for sinusoidal waveforms.
- 20 ampl=1 VPeak amplitude of sinusoidal waveform.
- 21 freq=0 HzFrequency of sinusoidal waveform.
- 22 sinephase=0 °Phase of sinusoid when t=delay.
- 23 ampl2=1 VPeak amplitude of second sinusoidal waveform.
- 24 freq2=0 HzFrequency of second sinusoidal waveform.
- 25 sinephase2=0 °Phase of second sinusoid when t=delay.
- 26 fundname 2 Name of the fundamental frequency associated with freq2. Must be specified if freq2 is used in a poisto analysis.
- 27 fmmodindex=0FM index of modulation for sinusoidal waveform.
- 28 fmmodfreq=0 HzFM modulation frequency for sinusoidal waveform.

Component Statements Part 2

- 29 ammodindex=0AM index of modulation for sinusoidal waveform.
- 30 ammodfreq=0 HzAM modulation frequency for sinusoidal waveform.
- 31 ammodphase=0 °AM phase of modulation for sinusoidal waveform.
- 32 damp=0 1/sDamping factor for sinusoidal waveform.

Exponential Waveform Parameters

- 33 td1=0 sRise start time for exponential wave.
- 34 tau1 (s) Rise time constant for exponential wave.
- 35 td2 (s) Fall start time for exponential wave.
- 36 tau2 (s) Fall time constant for exponential wave.

Noise Parameters

- 37 noisefileName of file containing excess spot noise data in the form of frequency-noise pairs.
- 38 noisevec=[...] V^2/Hz Excess spot noise as a function of frequency in the form of frequency-noise pairs.

Small Signal Parameters

- 39 mag=0 vSmall signal voltage.
- 40 phase=0 °Small signal phase.
- 41 xfmag=1 V/VTransfer function analysis magnitude.
- 42 pacmag=0 vPeriodic AC analysis magnitude.
- 43 pacphase=0 °Periodic AC analysis phase.

Multiplication Factor Parameters

44 m=1Multiplicity factor.

Component Statements Part 2

Temperature Effects Parameters

- 45 tc1=0 1/CFirst order temperature coefficient.
- 46 tc2=0 C^{-2} Second order temperature coefficient.
- 47 tnom=27 CParameter measurement temperature. Default set by options.

If you do not specify the DC value, it is assumed to be the time=0 value of the waveform.

In DC analyses, the only active parameters are dc, m, and the temperature coefficient parameters. In AC analyses, the only active parameters are m, mag and phase. In transient analyses, all parameters are active except the small signal parameters and the noise parameters. The type parameter selects which type of waveform is generated. You may specify parameters for more than one waveform type, and use the alter statement to change the waveform type between analyses.

A vector of time-value pairs describes the piecewise linear waveform. As an alternative, you can read the waveform from a file. In this case, you give time-value pairs one pair per line with a space or tab between the time and the value.

If you set allbrkpts to yes, you force the simulator to place time points at each point specified in a PWL waveform during a transient analysis. This can be very expensive for waveforms with many points. If you set allbrkpts to no, Spectre inspects the waveform, looking for abrupt changes, and forces time points only at those changes.

The PWL waveform is periodic if you specify pwlperiod. If the value of the waveform specified is not exactly the same at both its beginning its end, then you must provide a nonzero value twidth. Before repeating, the waveform changes linearly in an interval of twidth from its value at (period - twidth) to its value at the beginning of the waveform. Thus twidth must always be less than period.

You can give the excess noise of the source as a file or specify it with a vector of frequencynoise pairs. For a file, give the frequency-noise pairs one pair per line with a space or tab between the frequency and noise values.

Operating-Point Parameters

- 1 v (V) Voltage across the source.
- 2 i (A) Current through the source.
- 3 pwr (W) Power dissipation.

Component Statements Part 2

Parameter Index

allbrkpts I-16	freq I-21	phase I-40	td1 I-33
ammodfreq I-30	freq2 I-24	pwlperiod I-17	td2 I-35
ammodindex I-29	fundname I-3	pwr OP-3	tnom I-47
ammodphase I-31	fundname2 I-26	rise I-8	twidth I-18
ampl I-20	i OP-2	scale I-14	type I-2
ampl2 I-23	m I-44	sinedc I-19	v OP-1
damp I-32	mag I-39	sinephase I-22	val0 I-5
dc I-1	noisefile I-37	sinephase2 I-25	val1 I-6
delay I-4	noisevec I-38	stretch I-15	wave I-12
fall I-9	offset I-13	tau1 I-34	width I-10
file I-11	pacmag I-42	tau2 I-36	xfmag I-41
fmmodfreq I-28	pacphase I-43	tc1 I-45	
fmmodindex I-27	period I-7	tc2 I-46	

Winding for Magnetic Core (winding)

Description

This winding is used in conjunction with magnetic cores to model coils and transformers with hysteresis. Each winding must be associated with a single core, though a core may have any number of windings.

Winding connects terminals t1 and b1. Current through the winding is computed.

This device is not supported within altergroup.

Sample Instance Statement

```
c1 (1 0) core_mod area=1.2 len=8.1 id=0.45 id=0.55 gap=0.25
y1 (2 0) winding turn=5 core=c1 resis=1m
```

Instance Definition

```
Name t b winding parameter=value ...
```

Component Statements Part 2

Instance Parameters

- 1 turn=1Number of turns on winding.
- 2 resis (Ω) Resistance of the winding.
- 3 m=1Multiplicity factor.
- 4 coreName of core around which winding is wrapped.

Initial Conditions

5 ic=0.0 Alnitial condition on the winding.

z-Domain Linear Current Controlled Current Source (zcccs)

Description

The output is defined with a transfer function given as the ratio of two polynomials in the complex variable z. Each polynomial can be specified using either its coefficients or its roots. The roots of the numerator are the zeros of the transfer function and the roots of the denominator are the poles.

You may specify polynomials either in the complex variable z or 1/z by setting optional parameter polyarg to z or inversez respectively. By default, it is set to inversez. If you choose to provide the coefficients of a polynomial, enter them as a vector in ascending order of the power of the variable z or 1/z, starting from the constant term. For example, to specify a denominator of $3z^2 + 4z^1 + 1$, use $denom=[1 \ 4 \ 3]$. Or to specify a denominator of $4z^2 + 3z - 2$, use $polyarg=z denom=[2 \ 3 \ 4]$.

To specify transfer function in terms of its zeros and poles in z-plane, give them as vectors of complex numbers. You must always give the real and imaginary portions of the root, even when the root is real. You may give either both roots of a complex-conjugate pair or only one. In the latter case the conjugate complex root will be generated automatically. The order of the roots is not important. For example, to specify poles of z = 1, z = 4j, z = -4j, z = 2 + 2j, and z = 2 - 2j, use poles=[1 0 0 4 0 -4 2 2 2 -2] or, omitting conjugate poles, poles=[1 0 0 4 2 2].

Either the numerator or the denominator specification can be omitted. An omitted denominator or numerator is taken to be 1.

Component Statements Part 2

The parameter gain is interpreted either as the DC gain or, if the function has zeros or poles on the unit circle, as a constant factor.

Transition time (tt) is an optional parameter that at each sampling point forces linear transition of the output to a new value within the specified time range. By default, it is set to one percent of the sampling period.

The sampling delay (td) is another optional parameter, with the default value of 0, that lets you set asynchronous sampling rates.

To use the s to z transformation, set the optional sxz parameter to one of the transformation methods - forward differences, backward differences, or bilinear. When the sxz parameter is specified, the transfer function specification is assumed to be given in the complex variable s and it will be transformed to the complex variable s using the indicated method.

This device is not supported within altergroup.

Sample Instance Statement

```
va (1 0) vsource type=sine freq=10K
z2 (2 0) zcccs probe=va gain=1 ts=4.9e-5 tt=1e-5 polyarg=inservez
numer=[1 -1] denom=[1 0]
```

Instance Definition

```
Name sink src zcccs parameter=value ...
```

Instance Parameters

- 1 probe Device through which the controlling current flows.
- 2 port=0Index of the probe port through which the controlling current flows.
- 3 ts=1 sSampling period.
- 4 td=0 sSampling delay.
- 5 tt=0.01 ts sTransition time.
- 6 gain=1Transfer function gain.
- 7 polyarg=inversezPolynomial argument.
 Possible values are z or inversez.

Component Statements Part 2

8 sxz=nones to z transformation.

Possible values are none, backward, forward, or bilinear.

- 9 numer=[...] Vector of numerator coefficients.
- 10 denom=[...] Vector of denominator coefficients.
- 11 zeros=[...] Vector of complex zeros.
- 12 poles=[...] Vector of complex poles.
- 13 m=1Multiplicity factor.

Operating-Point Parameters

- 1 i (A) Input current.
- 2 v (V) Output voltage.
- 3 pwr (W) Power dissipation.

Parameter Index

denom I-10	numer I-9	probe I-1	ts I-3
gain I-6	poles I-12	pwr OP-3	tt I-5
i OP-1	polyarg I-7	sxz I-8	v OP-2
m I-13	port I-2	td I-4	zeros I-11

Component Statements Part 2

z-Domain Current Controlled Voltage Source (zccvs)

Description

The output is defined with a transfer function given as the ratio of two polynomials in the complex variable z. Each polynomial can be specified using either its coefficients or its roots. The roots of the numerator are the zeros of the transfer function and the roots of the denominator are the poles.

You may specify polynomials either in the complex variable z or 1/z by setting optional parameter polyarg to z or inversez respectively. By default, it is set to inversez. If you choose to provide the coefficients of a polynomial, enter them as a vector in ascending order of the power of the variable z or 1/z, starting from the constant term. For example, to specify a denominator of $3z^2 + 4z^1 + 1$, use $denom = [1 \ 4 \ 3]$. Or to specify a denominator of $4z^2 + 3z - 2$, use $polyarg = z denom = [2 \ 3 \ 4]$.

To specify transfer function in terms of its zeros and poles in z-plane, give them as vectors of complex numbers. You must always give the real and imaginary portions of the root, even when the root is real. You may give either both roots of a complex-conjugate pair or only one. In the latter case the conjugate complex root will be generated automatically. The order of the roots is not important. For example, to specify poles of z = 1, z = 4j, z = -4j, z = 2 + 2j, and z = 2 - 2j, use poles=[1 0 0 4 0 -4 2 2 2 -2] or, omitting conjugate poles, poles=[1 0 0 4 2 2].

Either the numerator or the denominator specification can be omitted. An omitted denominator or numerator is taken to be 1.

The parameter gain is interpreted either as the DC gain or, if the function has zeros or poles on the unit circle, as a constant factor.

Transition time (tt) is an optional parameter that at each sampling point forces linear transition of the output to a new value within the specified time range. By default, it is set to one percent of the sampling period.

The sampling delay (td) is another optional parameter, with the default value of 0, that lets you set asynchronous sampling rates.

To use the s to z transformation, set the optional sxz parameter to one of the transformation methods - forward differences, backward differences, or bilinear. When the sxz parameter is specified, the transfer function specification is assumed to be given in the complex variable s and it will be transformed to the complex variable z using the indicated method.

This device is not supported within altergroup.

Component Statements Part 2

Sample Instance Statement

```
va (1 0) vsource type=sine freq=10K
z2 2 0 zccvs probe=va gain=-2 ts=5e-5 tt=1.1e-5 numer=[1 -1]
```

Instance Definition

```
Name p n zccvs parameter=value ...
```

Instance Parameters

- 1 probeDevice through which the controlling current flows.
- 2 port=0Index of the probe port through which the controlling current flows.
- 3 ts=1 sSampling period.
- 4 td=0 sSampling delay.
- 5 tt=0.01 ts sTransition time.
- 6 gain=1Transfer function gain.
- 7 polyarg=inversezPolynomial argument.

Possible values are z or inversez.

8 sxz=nones to z transformation.

Possible values are none, backward, forward, or bilinear.

- 9 numer=[...] Vector of numerator coefficients.
- 10 denom=[...] Vector of denominator coefficients.
- 11 zeros=[...] Vector of complex zeros.
- 12 poles=[...] Vector of complex poles.
- 13 m=1Multiplicity factor.

Operating-Point Parameters

1 i (A) Output current.

Component Statements Part 2

2 v (V) Output voltage.

3 pwr (W) Power dissipation.

Parameter Index

denom I-	10 numer I-9	probe I-1	ts I-3
gain I-6	poles I-12	pwr OP-3	tt I-5
i OP-1	polyarg I-	-7 sxz I-8	v OP-2
m I-13	port I-2	td I-4	zeros I-11

z-Domain Linear Voltage Controlled Current Source (zvccs)

Description

The output is defined with a transfer function given as the ratio of two polynomials in the complex variable z. Each polynomial can be specified using either its coefficients or its roots. The roots of the numerator are the zeros of the transfer function and the roots of the denominator are the poles.

You may specify polynomials either in the complex variable z or 1/z by setting optional parameter polyarg to z or inversez respectively. By default, it is set to inversez. If you choose to provide the coefficients of a polynomial, enter them as a vector in ascending order of the power of the variable z or 1/z, starting from the constant term. For example, to specify a denominator of $3z^2 + 4z^1 + 1$, use $denom=[1\ 4\ 3]$. Or to specify a denominator of $4z^2 + 3z - 2$, use $polyarg=z denom=[2\ 3\ 4]$.

To specify transfer function in terms of its zeros and poles in z-plane, give them as vectors of complex numbers. You must always give the real and imaginary portions of the root, even when the root is real. You may give either both roots of a complex-conjugate pair or only one. In the latter case the conjugate complex root will be generated automatically. The order of the roots is not important. For example, to specify poles of z = 1, z = 4j, z = -4j, z = 2 + 2j, and z = 2 + 2j.

Component Statements Part 2

```
= 2 - 2j, use poles=[1 0 0 4 0 -4 2 2 2 -2] or, omitting conjugate poles, poles=[1 0 0 4 2 2 ].
```

Either the numerator or the denominator specification can be omitted. An omitted denominator or numerator is taken to be 1.

The parameter gain is interpreted either as the DC gain or, if the function has zeros or poles on the unit circle, as a constant factor.

Transition time (tt) is an optional parameter that at each sampling point forces linear transition of the output to a new value within the specified time range. By default, it is set to one percent of the sampling period.

The sampling delay (td) is another optional parameter, with the default value of 0, that lets you set asynchronous sampling rates.

To use the s to z transformation, set the optional sxz parameter to one of the transformation methods - forward differences, backward differences, or bilinear. When the sxz parameter is specified, the transfer function specification is assumed to be given in the complex variable s and it will be transformed to the complex variable z using the indicated method.

This device is not supported within altergroup.

Sample Instance Statement

```
va (1 0) vsource type=sine freq=10K
z1 (2 0 1 0) zvccs gain=2 ts=4.5e-5 tt=1e-5 zeros=[-1 0] poles=[0 0]
```

Instance Definition

```
Name sink src ps ns zvccs parameter=value ...
```

Instance Parameters

- 1 ts=1 sSampling period.
- 2 td=0 sSampling delay.
- 3 tt=0.01 ts sTransition time.
- 4 gain=1Transfer function gain.
- 5 polyarg=inversezPolynomial argument.

 Possible values are z or inversez.

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Component Statements Part 2

6 sxz=nones to z transformation.

Possible values are none, backward, forward, or bilinear.

- 7 numer=[...] Vector of numerator coefficients.
- 8 denom=[...] Vector of denominator coefficients.
- 9 zeros=[...] Vector of complex zeros.
- 10 poles=[...] Vector of complex poles.
- 11 m=1Multiplicity factor.

Operating-Point Parameters

- 1 i (A) Output current.
- 2 v (V) Output voltage.
- 3 pwr (W) Power dissipation.

Parameter Index

denom I-8	numer I-7	sxz I-6	v OP-2
gain I-4	poles I-10	td I-2	zeros I-9
i OP-1	polyarg I-5	ts I-1	
m I-11	pwr OP-3	tt I-3	

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Component Statements Part 2

z-Domain Voltage Controlled Voltage Source (zvcvs)

Description

The output is defined with a transfer function given as the ratio of two polynomials in the complex variable z. Each polynomial can be specified using either its coefficients or its roots. The roots of the numerator are the zeros of the transfer function and the roots of the denominator are the poles.

You may specify polynomials either in the complex variable z or 1/z by setting optional parameter polyarg to z or inversez respectively. By default, it is set to inversez. If you choose to provide the coefficients of a polynomial, enter them as a vector in ascending order of the power of the variable z or 1/z, starting from the constant term. For example, to specify a denominator of $3z^2 + 4z^1 + 1$, use $denom = [1 \ 4 \ 3]$. Or to specify a denominator of $4z^2 + 3z - 2$, use $polyarg = z denom = [2 \ 3 \ 4]$.

To specify transfer function in terms of its zeros and poles in z-plane, give them as vectors of complex numbers. You must always give the real and imaginary portions of the root, even when the root is real. You may give either both roots of a complex-conjugate pair or only one. In the latter case the conjugate complex root will be generated automatically. The order of the roots is not important. For example, to specify poles of z = 1, z = 4j, z = -4j, z = 2 + 2j, and z = 2 - 2j, use poles=[1 0 0 4 0 -4 2 2 2 -2] or, omitting conjugate poles, poles=[1 0 0 4 2 2].

Either the numerator or the denominator specification can be omitted. An omitted denominator or numerator is taken to be 1.

The parameter gain is interpreted either as the DC gain or, if the function has zeros or poles on the unit circle, as a constant factor.

Transition time (tt) is an optional parameter that at each sampling point forces linear transition of the output to a new value within the specified time range. By default, it is set to one percent of the sampling period.

The sampling delay (td) is another optional parameter, with the default value of 0, that lets you set asynchronous sampling rates.

To use the s to z transformation, set the optional sxz parameter to one of the transformation methods - forward differences, backward differences, or bilinear. When the sxz parameter is specified, the transfer function specification is assumed to be given in the complex variable s and it will be transformed to the complex variable z using the indicated method.

This device is not supported within altergroup.

Component Statements Part 2

Sample Instance Statement

```
va (1 0) vsource type=sine freq=10K
z3 (3 0 1 0) zvcvs gain=-1 ts=4e-5 tt=1e-5 numer=[-1 -1]
```

Instance Definition

```
Name p n ps ns zvcvs parameter=value ...
```

Instance Parameters

- 1 ts=1 sSampling period.
- 2 td=0 sSampling delay.
- 3 tt=0.01 ts sTransition time.
- 4 gain=1Transfer function gain.
- 5 polyarg=inversezPolynomial argument.

Possible values are z or inversez.

6 sxz=nones to z transformation.

Possible values are none, backward, forward, or bilinear.

- 7 numer=[...] Vector of numerator coefficients.
- 8 denom=[...] Vector of denominator coefficients.
- 9 zeros=[...] Vector of complex zeros.
- 10 poles=[...] Vector of complex poles.
- 11 m=1Multiplicity factor.

Operating-Point Parameters

- 1 i (A) Output current.
- 2 v (V) Output voltage.
- 3 pwr (W) Power dissipation.

Component Statements Part 2

Parameter Index

denom I-8	numer I-7	sxz I-6	v OP-2
gain I-4	poles I-10	td I-2	zeros I-9
i OP-1	polyarg I-5	ts I-1	
m I-11	pwr OP-3	tt I-3	

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Analysis Statements

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- DC Analysis (dc) on page 558
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- Quasi-Periodic Steady State Analysis (qpss) on page 649
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- <u>Transfer Function Analysis (xf)</u> on page 685

Analysis Statements

AC Analysis (ac)

Description

The AC analysis linearizes the circuit about the DC operating point and computes the response to a given small sinusoidal stimulus.

Spectre can perform the analysis while sweeping a parameter. The parameter can be frequency, temperature, component instance parameter, component model parameter, or netlist parameter. If changing a parameter affects the DC operating point, the operating point is recomputed on each step. You can sweep the circuit temperature by giving the parameter name as temp with no dev or mod parameter. You can sweep a netlist parameter by giving the parameter name with no dev, or mod parameter. After the analysis has completed, the modified parameter returns to its original value.

Definition

Name ac parameter=value ...

Parameters

1 prevoppoint=no Use operating point computed on the previous analysis. Possible values are no or yes.

Sweep interval parameters

2	start=0	Start sweep limit.
3	stop	Stop sweep limit.
4	center	Center of sweep.
5	span=0	Sweep limit span.
6	step	Step size, linear sweep.
7	lin=50	Number of steps, linear sweep.
8	dec	Points per decade.

Analysis Statements

9 log=50 Number of steps, log sweep.

10 values=[...] Array of sweep values.

Sweep variable parameters

11 dev Device instance whose parameter value is to be swept.

12 mod Model whose parameter value is to be swept.

13 param Name of parameter to sweep.

14 freq (Hz) Frequency when parameter other than frequency is being swept.

State-file parameters

15 readns File that contains estimate of DC solution (nodeset).

Output parameters

16 save Signals to output.

Possible values are all, lvl, allpub, lvlpub, selected, or

none.

17 nestlvl Levels of subcircuits to output.

18 oppoint=no Should operating point information be computed, and if so,

where should it be sent.

Possible values are no, screen, logfile, or rawfile.

Convergence parameters

19 restart=yes Do not use previous DC solution as initial guess.

Possible values are no or yes.

Annotation parameters

20 annotate=sweep Degree of annotation.

Possible values are no, title, sweep, status, or steps.

Analysis Statements

21 stats=no Analysis statistics.

Possible values are no or yes.

22 title Analysis title.

You can specify sweep limits by giving the end points or by providing the center value and the span of the sweep. Steps can be linear or logarithmic, and you can specify the number of steps or the size of each step. You can give a step size parameter (step, lin, log, dec) to determine whether the sweep is linear or logarithmic. If you do not give a step size parameter, the sweep is linear when the ratio of stop to start values is less than 10, and logarithmic when this ratio is 10 or greater. All frequencies are in Hertz.

The small-signal analysis begins by linearizing the circuit about an operating-point. By default this analysis computes the operating-point if it is not known, or recomputes it if any significant component or circuit parameter has changed. However, if a previous analysis computed an operating point, you can set prevoppoint=yes to avoid recomputing it. For example, if you use this option when the previous analysis was a transient analysis, the operating point is the state of the circuit on the final time point.

Parameter Index

In the following index, the number following each parameter name indicates where to find the description of that parameter.

annotate 20	log 9	readns 15	step 6
center 4	mod 12	restart 19	stop 3
dec 8	nestlvl 17	save 16	title 22
dev 11	oppoint 18	span 5	values 10
freq 14	param 13	start 2	
lin 7	prevoppoint 1	stats 21	

Alter a Circuit, Component, or Netlist Parameter (alter)

Description

The alter statement changes the value of any modifiable component or netlist parameter for any analyses that follow. The parameter to be altered can be circuit temperature, a device instance parameter, a device model parameter, a netlist parameter, or a subcircuit parameter for a particular subcircuit instance. You can alter the circuit temperature by giving the parameter name as parametemp with no dev, mod or sub parameter. You can alter a top-

Analysis Statements

level netlist parameter by giving the parameter name with no dev, mod or sub parameter. You can alter a subcircuit parameter for a particular subcircuit instance by specifying the subcircuit instance name with the sub parameter, and the subcircuit parameter name with the parameter. Each alter statement can change only one parameter.

Definition

Name alter parameter=value ...

Parameters

1 mod Device model.

2 dev Device instance.

3 sub Subcircuit instance.

4 param Name of parameter to be altered.

5 value New value for parameter.

6 annotate Degree of annotation.

Possible values are no or title.

Alter Group (altergroup)

Description

The altergroup statement changes the values of any modifiable model, instance or netlist parameter for any analyses that follow. Within an alter group, you can specify model statements, instance statements and parameter statements. These statements should be bound within braces. The opening brace is required at the end of the line defining the alter group. Alter groups cannot be nested or specified within subcircuits. The following statements are not allowed within altergroups (analyses, export, ic, nodeset, paramset, save, and sens).

Within an alter group, each device (instance or model) is first defaulted and then the device parameters are updated. For netlist parameters, the expressions are updated and evaluated.

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For subckt within altergroup, all instances of the subckts are modified during the altergroup. There are strict checks that do not allow changes to topology.

You can include files into the alter group and can use the simulator lang=spice directive. See spectre -h include for more details. A model defined in the netlist, has to have the same model name and primitive type (bsim2, bsim3, bjt) in the alter group. An instance defined in the netlist, has to have the same instance name, terminal connections and primitive type. For model groups you can change the number of models in the group. There is a restriction that you cannot change from a model to a model group and vice versa. See spectre -h bsim3v3 for details on model groups.

Definition

Name altergroup parameter=value ...

Parameters

1 annotate Degree of annotation.

Possible values are no or title.

Example:

```
FastCorner altergroup {
    parameters p2=1 p3=p1+2
    model myres resistor r1=1e3 af=1
    model mybsim bsim3v3 lmax=p1 lmin=3.5e-7
    m1 (n1 n2 n3 n4) mybsim w=0.3u l=1.2u
}
```

The list of public devices supported by altergroup:

tline	vsource	vcvs	vccs
vbic	tom2	resistor	phy_res
msline	mos3	mos2	mos1
jfet	isource	inductor	hvmos
hbt	gaas	ekv	diode
CCVS	cccs	capacitor	btasoi
bsim4	bsim3v3	bsim3	bsim2
bsim1	bjt		

Analysis Statements

The list of public devices not supported by altergroup:

cktrom	zvcvs	zvccs	zccvs
zcccs	winding	transformer	switch
svcvs	svccs	sccvs	scccs
relay	pvcvs	pvccs	port
pccvs	pcccs	nport	mtline
mos0	mutual_inductor	iprobe	delay
d2a	core	b3soipd	a2d

Check Parameter Values (check)

Description

The check analysis checks the values of component parameters to assure they are reasonable. This analysis reduces the cost of data entry errors. Various filters specify which parameters are checked. You can perform checks on input, output, or operating-point parameters. Use this analysis in conjunction with the +param command line argument, which specifies a file that contains component parameter soft limits.

Definition

Name check parameter=value ...

Parameters

1 what=all What parameters should be checked.

Possible values are none, inst, models, input, output, all,

or oppoint.

DC Analysis (dc)

Description

The DC analysis finds the DC operating-point or DC transfer curves of the circuit. To generate transfer curves, specify a parameter and a sweep range. The swept parameter can be circuit temperature, a device instance parameter, a device model parameter, a netlist parameter, or

Analysis Statements

a subcircuit parameter for a particular subcircuit instance. You can sweep the circuit temperature by giving the parameter name as parametemp with no dev, mod or sub parameter. You can sweep a top-level netlist parameter by giving the parameter name with no dev, mod or sub parameter. You can sweep a subcircuit parameter for a particular subcircuit instance by specifying the subcircuit instance name with the sub parameter, and the subcircuit parameter name with the param parameter. After the analysis has completed, the modified parameter returns to its original value.

Definition

Name dc parameter=value ...

Parameters

Sweep interval parameters

1	start=0	Start sweep limit.

2 stop Stop sweep limit.

3 center Center of sweep.

4 span=0 Sweep limit span.

5 step Step size, linear sweep.

6 lin=50 Number of steps, linear sweep.

7 dec Points per decade.

8 log=50 Number of steps, log sweep.

9 values=[...] Array of sweep values.

Sweep variable parameters

10 dev Device instance whose parameter value is to be swept.

11 mod Model whose parameter value is to be swept.

Analysis Statements

12 param Name of parameter to sweep.

State-file parameters

13 force=none What should be used to force values for DC. Uses the values

from the device and node ICs.

Possible values are none, node, dev, or all.

14 readns File that contains estimate of DC solution (nodeset).

15 readforce File that contains force values.

16 write File to which solution at first step in sweep is written.

17 writefinal File to which solution at last step in sweep is written.

Output parameters

18 save Signals to output.

Possible values are all, lvl, allpub, lvlpub, selected, or

none.

19 nestlvl Levels of subcircuits to output.

20 print=no Print node voltages.

Possible values are no or yes.

21 oppoint=no Should operating point information be computed, and if so,

where should it be sent.

Possible values are no, screen, logfile, or rawfile.

22 check=yes Check operating point parameters against soft limits.

Possible values are no or yes.

Convergence parameters

23 homotopy=all Method used when no convergence on initial attempt of DC

analysis.

Possible values are none, gmin, source, dptran, ptran,

arclength, or all.

Analysis Statements

24 restart=yes Do not use previous solution as initial guess.

Possible values are no or yes.

25 maxiters=150 Maximum number of iterations.

26 maxsteps=10000 Maximum number of steps used in homotopy method.

Annotation parameters

27 annotate=sweep Degree of annotation.

Possible values are no, title, sweep, status, or steps.

28 title Analysis title.

You can specify sweep limits by giving the end points or by providing the center value and the span of the sweep. Steps can be linear or logarithmic, and you can specify the number of steps or the size of each step. You can give a step size parameter (step, lin, log, dec) and determine whether the sweep is linear or logarithmic. If you do not give a step size parameter, the sweep is linear when the ratio of stop to start values is less than 10, and logarithmic when this ratio is 10 or greater. If you specify the oppoint parameter, Spectre computes and outputs the linearized model for each nonlinear component.

Nodesets help find the DC or initial transient solution. You can supply them in the circuit description file with nodeset statements, or in a separate file using the readns parameter. When nodesets are given, Spectre computes an initial guess of the solution by performing a DC analysis while forcing the specified values onto nodes by using a voltage source in series with a resistor whose resistance is rforce. Spectre then removes these voltage sources and resistors and computes the true solution from this initial guess.

Nodesets have two important uses. First, if a circuit has two or more solutions, nodesets can bias the simulator towards computing the desired one. Second, they are a convergence aid. By estimating the solution of the largest possible number of nodes, you might be able to eliminate a convergence problem or dramatically speed convergence.

When you simulate the same circuit many times, we suggest that you use both the write and readns parameters and give the same file name to both parameters. The DC analysis then converges quickly even if the circuit has changed somewhat since the last simulation, and the nodeset file is automatically updated.

You may specify values to force for the DC analysis by setting the parameter force. The values used to force signals are specified by using the force file, the ic statement, or the ic parameter on the capacitors and inductors. The force parameter controls the interaction of various methods of setting the force values. The effects of individual settings are:

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force=none: Any initial condition specifiers are ignored.

force=node: The ic statements are used, and the ic parameter on the capacitors and inductors are ignored.

force=dev: The ic parameters on the capacitors and inductors are used, and the ic statements are ignored.

force=all: Both the ic statements and the ic parameters are used, with the ic parameters overriding the ic statements.

If you specify a force file with the readforce parameter, force values read from the file are used, and any ic statements are ignored.

Once you specify the force conditions, Spectre computes the DC analysis with the specified nodes forced to the given value by using a voltage source in series with a resistor whose resistance is rforce (see options).

Parameter Index

In the following index, the number following each parameter name indicates where to find the description of that parameter.

annotate 27	lin 6	param 12	start 1
center 3	log 8	print 20	step 5
check 22	maxiters 25	readforce 15	stop 2
dec 7	maxsteps 26	readns 14	title 28
dev 10	mod 11	restart 24	values 9
force 13	nestlvl 19	save 18	write 16
homotopy 23	oppoint 21	span 4	writefinal 17

DC Device Matching Analysis (dcmatch)

Description

The dcmatch analysis performs DC device mis-matching analysis for a given output. It computes the deviation in the DC operating point of the circuit caused by mismatch in the devices. Users need to specify mismatch parameters in their model cards for each device contributing to the deviation. The analysis uses the device mismatch models to construct equivalent mismatch current sources to all the devices that have mismatch modeled. These current sources will have zero mean and some variance. The variance of the current sources

Analysis Statements

are computed according to mismatch models. It then computes the 3-sigma variance of dc voltages or curents at user specified outputs due to the mismatch current sources. The simulation results displays the devices rank ordered by their contributions to the outputs. In addition, for mosfet devices, it displays threshold voltage mismatch, current factor mismatch, gate voltage mismatch, and drain current mismatch. For bipolar devices, it displays base-emitter junction voltage mismatch. For resistors, it displays resistor mismatches.

The analysis replaces multiple simulation runs by circuit designers for accuracy versus size analysis. It automatically identifies the set of critical matched components during circuit design. For example, when there are matched pairs in the circuit, the contribution of two matched transistors will be equal in magnitude and opposite in sign. Typical usage are to simulate the output offset voltage of operational amplifiers, estimate the variation in bandgap voltages, and predict the accuracy of current steering DACS.

Definition

Name ... dcmatch parameter=value ...

Parameters

1	mth	Relative mismatch contribution threshold value.
2	where=screen	Where DC-Mismatch analysis results should be printed. Possible values are screen, logfile, file, or rawfile.
3	file	File name for results to be printed if where=file is used.

Probe parameters

4 op:	robe Com	pute mismatch at the out	put defined by this con	nponent.
-------	-----------------	--------------------------	-------------------------	----------

Port parameters

5	portv	Voltage across this probe port is output of the analysis.
6	porti	Current through this probe port is output of the analysis.

Analysis Statements

Sweep interval parameters

7 start=0 Start sweep limit.

8 stop Stop sweep limit.

9 center Center of sweep.

10 span=0 Sweep limit span.

11 step Step size, linear sweep.

12 lin=50 Number of steps, linear sweep.

13 dec Points per decade.

14 log=50 Number of steps, log sweep.

15 values=[...] Array of sweep values.

Sweep variable parameters

16 dev Device instance whose parameter value is to be swept.

17 mod Model whose parameter value is to be swept.

18 param Name of parameter to sweep.

State-file parameters

19 readns File that contains estimate of DC solution (nodeset).

Output parameters

20 save Signals to output.

Possible values are all, lvl, allpub, lvlpub, selected, or

none.

21 nestlvl Levels of subcircuits to output.

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22 oppoint=no Should operating point information be computed, and if so,

where should it be sent.

Possible values are no, screen, logfile, or rawfile.

Convergence parameters

23 prevoppoint=no Use operating point computed on the previous analysis.

Possible values are no or yes.

24 restart=yes Do not use previous DC solution as initial guess.

Possible values are no or yes.

Annotation parameters

25 annotate=sweep Degree of annotation.

Possible values are no, title, sweep, status, or steps.

26 stats=no Analysis statistics.

Possible values are no or yes.

27 title Analysis title.

The dcmatch analysis will find a dc operating point first. If the dc analysis fails, then the dcmatch analysis will fail also. The parameter mth is a threshold value relative to maximum contribution. Any device contribution less than (mth * maximum) will not be reported where maximum is the maximum contribution among all the devices of a given type.

Example

```
dcmm1 dcmatch mth=1e-3 oprobe=vd porti=1
dcmm2 dcmatch mth=1e-3 oprobe=r3 portv=1
dcmm3 n1 n2 dcmatch mth=1e-3 where=rawfile stats=yes
dcmm4 n3 0 dcmatch mth=1e-3 where=file file="%C:r.info.what"
sweep1 sweep dev=mp6 param=w start=80e-6 stop=90e-6 step=2e-6 {
dcmm5 dcmatch oprobe=vd mth=1e-3 where=rawfile }
dcmm6 n3 0 dcmatch mth=0.01 dev=x1.mp2 param=w start=15e-6 stop=20e-6 step=1e-6
dcmm7 n3 0 dcmatch mth=0.01 param=temp start=25 stop=100 step=25
```

Note: porti allows users to select a current associated with a specific device given in oprobe as an output. This device, however, has to have its terminal currents as network variables, i.e. the device has to be an inductor, a vsource, a switch, a tline, a controlled voltage source, an iprobe, or other type of device which has current solution. Further, for inductor,

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vsource, switch, controlled voltage source and iprobe, porti can only be set to one, since these devices are two terminal devices (one port); and for tline porti can be set to one or two, since it is a four terminal device (two ports).

Parameter Index

In the following index, the number following each parameter name indicates where to find the description of that parameter.

annotate 25	mod 17	portv 5	stats 26
center 9	mth 1	prevoppoint 23	step 11
dec 13	nestlvl 21	readns 19	stop 8
dev 16	oppoint 22	restart 24	title 27
file 3	oprobe 4	save 20	values 15
lin 12	param 18	span 10	where 2
log 14	porti 6	start 7	

Envelope Following Analysis (envlp)

Description

This analysis computes the envelope response of a circuit. The user specifies the analysis <code>clockname</code>. The simulator automatically determines the clock period by looking through all the sources with the specified name. The envelope response is computed over the interval from <code>start</code> to <code>stop</code>. If the interval is not a multiple of the clock period, it is rounded off to the nearest multiple before the stop time. The initial condition is taken to be the DC steady-state solution if not otherwise given.

Envelope following analysis is most efficient for circuits where the modulation bandwidth is orders of magnitude lower than the clock frequency. This is typically the case, for example, in circuits where the clock is the only fast varying signal and other input signals have a spectrum whose frequency range is orders of magnitude lower than the clock frequency. For another example, the down conversion of two closely placed frequencies can also generate a slow-varying modulation envelope.

The analysis generates two types of output files, a voltage versus time (td) file, and an amplitude/phase versus time (fd) file for each of specified harmonic of the clock fundamental.

Analysis Statements

Definition

Name envlp parameter=value ...

Parameters

Envelope fundamental parameters

1 clockname Name of the clock fundamental.

2 modulationbw (Hz) Modulation bandwidth.

Simulation interval parameters

3 stop (s) Stop time.

4 start=0 s Start time.

5 tstab=0 s Initial stabilization time.

6 outputstart=start s

Output is saved only after this time is reached.

Time-step parameters

7 maxstep (s) Maximum time step for inner transient integration. Default

derived from errpreset.

8 envmaxstep (s) Maximum outer envelope step size. Default derived from

errpreset.

Initial-condition parameters

9 ic=all What should be used to set initial condition.

Possible values are dc, node, dev, or all.

10 skipdc=no If yes, there will be no dc analysis for initial transient.

Possible values are no or yes.

11 readic File that contains initial transient condition.

Analysis Statements

Convergence parameters

12 readns File that contains estimate of initial DC solution.

13 cmin=0 F Minimum capacitance from each node to ground.

State-file parameters

14 write File to which initial transient solution is to be written.

15 writefinal File to which final transient solution is to be written.

16 swapfile Temporary file that holds the matrix information used by

Newton's method. Tells Spectre to use a regular file rather than virtual memory to hold the matrix information. Use this option if

Spectre complains about not having enough memory to

complete this analysis.

Integration method parameters

17 method Integration method. Default derived from errpreset.

Possible values are euler, trap, traponly, gear 2, or

gear2only.

Accuracy parameters

18 errpreset=moderate

Selects a reasonable collection of parameter settings.

Possible values are conservative, moderate or liberal.

19 relref Reference used for the relative convergence criteria. Default

derived from errpreset.

Possible values are pointlocal, alllocal, sigglobal, or

allglobal.

20 Iteratio Ratio used to compute LTE tolerances from Newton tolerance.

Default derived from errpreset.

21 steadyratio Ratio used to compute steady state tolerances from LTE

tolerance. Default derived from errpreset.

Analysis Statements

22 envlteratio Ratio used to compute envelope LTE tolerances. Default derived

from errpreset.

Annotation parameters

23 stats=no Analysis statistics.

Possible values are no or yes.

24 annotate=sweep Degree of annotation.

Possible values are no, title, sweep, status, or steps.

25 title Analysis title.

Output parameters

26 harms=1 Number of clock harmonics to output.

27 harmsvec=[...] Array of desired clock harmonics. Alternate form of harms that

allows selection of specific harmonics.

28 outputtype=both Output type.

Possible values are both, envelope or spectrum.

29 save Signals to output.

Possible values are all, lvl, allpub, lvlpub, selected, or

none.

30 nestlvl Levels of subcircuits to output.

31 compression=no Do data compression on output.

Possible values are no or yes.

32 strobeperiod (s) The output strobe interval (in seconds of envelope following

time). The actual strobe interval is rounded to an integer multiple

of the clock period.

Newton parameters

33 maxiters=5 Maximum number of Newton iterations per transient integration

time step.

34 envmaxiters=3 Maximum number of Newton iterations per envelope step.

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35 restart=yes Do not use previous DC solution as initial guess. Possible values are no or yes.

Circuit age

36 circuitage (Years) Stress Time. Age of the circuit used to simulate hot-electron degradation of MOSFET and BSIM circuits.

The simulator examines all the sources whose name matches the clock name specified in the analysis line by the clockname parameter to determine the clock frequency. If more than one frequencies are found, the least common factor of these frequencies is used as the clock frequency.

The maximum envelope step size is affected by many parameters. It can be directly limited by envmaxstep. It is also limited by modulationbw. The user gives an estimate of the modulation bandwidth. The simulator will put at least eight points within the modulation period.

The harms and harmsvec parameters affect the simulation time in a significant way. The spectrum is calculated for all the specified harmonics for all sampled integration cycles as the envelope following analysis marches on. For each harmonic, a file is generated. The user should refrain from specifying unnecessary harmonics. Typically, harms is set to 1 or 2.

Most parameters of this analysis are inherited from either transient or PSS analysis and their meanings are consistent. However, a few of them need to be clarified. The effect of errpreset on some particular envelope following analysis parameters is shown in the following table.

Parameter defaults as a function of errpreset

errpreset	envmaxstep	steayratio	envlteratio
liberal	Interval/10	1.0	10.0
moderate	Interval/50	0.1	1.0
conservative	Interval/100	0.01	0.1

Its effect on parameters such as reltol, relref, method, maxstep, and lteratio is the same as defined for transient analysis, except for that the transient simulation interval is always a clock period.

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Parameter Index

In the following index, the number following each parameter name indicates where to find the description of that parameter.

annotate 24	harms 26	outputstart 6	stats 23
circuitage 36	harmsvec 27	outputtype 28	steadyratio 21
clockname 1	ic 9	readic 11	stop 3
cmin 13	lteratio 20	readns 12	strobeperiod 32
compression 31	maxiters 33	relref 19	swapfile 16
envlteratio 22	maxstep 7	restart 35	title 25
envmaxiters 34	method 17	save 29	tstab 5
envmaxstep 8	modulationbw 2	skipdc 10	write 14
errpreset 18	nestlvl 30	start 4	writefinal 15

Circuit Information (info)

Description

The circuit information analysis outputs several kinds of information about the circuit and its components. You can use various filters to specify what information is output. You can create a listing of model, instance, temperature-dependent, input, output, and operating point parameters. You can also generate a summary of the minimum and maximum parameter values (by using extremes=yes or only). Finally, you can request that Spectre provide a node-to-terminal map (by using what=terminals) or a terminal-to-node map (by using what=nodes).

The following are brief descriptions of the types of parameters you can request with the info statement:

Input parameters: Parameters that you specify in the netlist, such as the given length of a MOSFET or the saturation current of a bipolar transistor (use what=inst, models, input, or all)

Output parameters: Parameters that are computed by Spectre, such as temperature dependent parameters and the effective length of a MOSFET after scaling (use what=output or all)

Operating-point parameters: Parameters that depend on the actual solution computed (use what=oppoint)

Analysis Statements

Definition

Name info parameter=value ...

Parameters

1 what=oppoint What parameters should be printed.

Possible values are none, inst, models, input, output, nodes, all, terminals, oppoint, captab, or parameters.

2 where=logfile Where parameters should be printed.

Possible values are nowhere, screen, file, logfile, or

rawfile.

3 file="%C:r.info.what"

File name when where=file.

4 save Signals to output.

Possible values are all, lvl, allpub, lvlpub, selected, or

none.

5 nestlvl Levels of subcircuits to output.

6 extremes=yes Print minimum and maximum values.

Possible values are no, yes or only.

7 title Analysis title.

Captab parameters

8 detail=node How detailed should the capacitance table be.

Possible values are node, nodetoground or nodetonode.

9 sort=name How to sort the capacitance table.

Possible values are name or value.

10 threshold=0 F Threshold value for printing capacitances (ignore capacitances

smaller than this value).

Analysis Statements

Parameter Index

In the following index, the number following each parameter name indicates where to find the description of that parameter.

```
detail 8 nestlvl 5 threshold 10 where 2 extremes 6 save 4 title 7 file 3 sort 9 what 1
```

Monte Carlo Analysis (montecarlo)

Description

The montecarlo analysis is a swept analysis with associated child analyses similar to the sweep analysis (see spectre -h sweep.) The Monte Carlo analysis refers to statistics blocks" where statistical distributions and correlations of netlist parameters are specified. (Detailed information on statistics blocks is given below.) For each iteration of the Monte Carlo analysis, new pseudo-random values are generated for the specified netlist parameters (according to their specified distributions) and the list of child analyses are then executed.

"export" statements are associated with the child analysis. These export statements allow scalar calculator expressions to be specified which can be used to measure circuit output or performance values (such as for example the slew-rate of an op-amp). For more details see "spectre -h export". During a Monte Carlo analysis, these export statement values will vary as the netlist parameters vary for each Monte Carlo iteration, and are stored in a scalar data file for post processing. By varying netlist parameters and evaluating export statements, the Monte Carlo analysis becomes a tool that allows you to examine and predict circuit performance variations, which affect yield.

The statistics blocks allow you to specify batch-to-batch (process) and per-instance (mismatch) variations for netlist parameters. These statistically-varying netlist parameters can be referenced by models or instances in the main netlist and may represent IC manufacturing process variation, or component variations for board-level designs for example. The following description gives a simplified example of the Monte Carlo analysis flow:

```
perform nominal run if requested
if any errors in nominal run then stop
foreach Monte Carlo iteration {
  if process variations specified then
    apply "process" variation to parameters
```

Analysis Statements

```
if mismatch variations specified then
  foreach subcircuit instance {
     apply "mismatch" variation to parameters
  }
  foreach child analysis {
    run child analysis
     evaluate any export statements and
     store results in a scalar data file
  }
}
```

Definition

Name montecarlo parameter=value ...

Parameters

Analysis parameters

1	numruns=100	Number of Monte Carlo iterations to perform (not including nominal).
2	seed	Optional starting seed for random number generator.
3	scalarfile	Output file that will contain output scalar data.
4	paramfile	Output file that will contain output scalar data labels.

Saving Process Parameters

_		
5	saveprocessparams	

Whether or not to save scalar data for statistically varying process parameters which are subject to process variation. Possible values are no or yes.

6 processscalarfile

Output file that will contain process parameter scalar data.

7 processparamfile

Output file that will contain process parameter scalar data labels.

Analysis Statements

8 saveprocessvec=[...] Array of statistically varying process parameters (which are

subject to process variation) to save as scalar data in

processscalarfile.

9 firstrun=1 Starting iteration number.

10 variations=process

Level of statistical variation to apply.

Possible values are process, mismatch or all.

Flags

11 donominal=yes Whether or not to perform nominal run.

Possible values are no or yes.

12 appendsd=no Whether or not to append scalar data.

Possible values are no or yes.

13 savefamilyplots=no

Whether or not to save data for family plots. If yes, this could

require a lot of disk space.

Possible values are no or yes.

14 saveprocessparams

Whether or not to save scalar data for statistically varying process parameters which are subject to process variation.

Possible values are no or yes.

Annotation parameters

15 annotate=sweep Degree of annotation.

Possible values are no, title, sweep, or status.

16 title Analysis title.

Detailed Description and Examples

numruns:(default=100)

The number of Monte Carlo iterations to perform. The simulator will perform a loop, running the specified child analyses and evaluating any export statements numruns times.

Analysis Statements

seed:(no default)

seed for the random number generator. By always specifying the same seed, you can reproduce a previous experiment. If you do not specify a seed, then each time you run the analysis, you will get different results i.e. a different stream of pseudo-random numbers will be generated.

scalarfile="filename"

This parameter allows an ASCII file to be specified in which scalar data (results of export expressions that resolve to scalar values) will be written. The data from this file can be read and plotted in histograms by Artist. For each iteration of each Monte Carlo child analyses, Spectre (through Artil) will write a line to this ASCII file which contains scalar data (one scalar expression per column e.g. slewrate or bandwidth.) The default name for this file will be of the form name.mcdata, where name is the name of the Monte Carlo analysis instance. This file contains only the matrix of numeric values. Artist Monte Carlo users will be more familiar with the term "mcdata" file for the scalar file. Additionally, when the Analog Artist Monte Carlo tool is used to generate the spectre netlist file, Spectre will merge the values of the statistically varying process parameters into this file containing the scalar data (results of export expressions). This means that Analog Artist can later read the data, and create scatterplots of the statistically varying process parameters against each other, or against the results of the export expressions. In this way, the user can see correlations between process parameter variations and circuit performances variations. This data merging will take place whenever the scalarfile and processscalarfile (see below) are written in the same directory.

paramfile="filename"

This file contains the titles, sweep variable values and the full expression for each of the columns in the scalarfile. Artist Monte Carlo users will be more familiar with the term "mcparam" file for the paramfile. This file will be created in the psf directory by default, unless you specify some path information in the filename.

processscalarfile="filename"

If saveprocessparams is set to yes, then the process (batch-to-batch) values of all statistically varying parameters are saved to this scalar data file. You can use the saveprocessvec to filter out a subset of parameters in which case Spectre will save only the parameters specified in saveprocessvec to the processscalarfile.) The processscalarfile is equivalent to the scalarfile, except that the data in the scalarfile contains the values of the scalar export statements, whereas the data in the processscalarfile contains the corresponding process parameter values. The default name for this file will be of the form instname.process.mcdata, where instname is the name of the Monte Carlo analysis instance. This file will be created in the psf directory by default, unless you specify some path information in the filename. You can load the processscalar file and processparamfile into the Artist statistical postprocessing

Analysis Statements

environment to plot/verify the process parameter distributions. If you later merge the processparamfile with the data in the scalarfile, you can then plot export scalar values against the corresponding process parameters by loading this merged file into the Artist statistical postprocessing environment.

processparamfile="filename"

This file contains the titles, sweep variable values for each of the columns in the processscalarfile. These titles will be the names of the process parameters.

The processparamfile is equivalent to the paramfile, except that the paramfile contains the name of the export expressions, whereas the processparamfile contains the names of the process parameters. The default name for this file will be of the form instname.process.mcparam, where instname is the name of the Monte Carlo analysis instance. This file will be created in the psf directory by default, unless you specify some path information in the filename.

firstrun:(default=1)

index of first iteration. If the first iteration is specified as some number n greater than one, then the beginning n-1 iterations are "skipped" i.e. the Monte Carlo analysis behaves as if the first n-1 iterations were run, but without actually performing the child analyses for these iterations. The subsequent stream of random numbers generated for the remaining iterations will be the same as if the first n-1 iterations were actually run. By specifying the first iteration number and the same value for seed, you can reproduce a particular run or sequence of runs from a previous experiment (for example to examine an outlier case in more detail.)

variations={process,mismatch,all} (defaults to process).

Whether to apply process (batch-to-batch) variations only, or mismatch (per-instance) variations only, or both together. This assumes that you have specified appropriate statistical distributions in the statistics block. You cannot request that mismatch variations be applied unless you have specified mismatch statistics in the statistics block. You cannot request that process variations be applied unless you have specified process statistics in the statistics block. More details on statistics blocks are given below.

saveprocessvec=[rshsp TOX ...]

If saveprocessparams is specified as yes, then save the process (batch-to-batch) values of only those parameters listed in saveprocessvec in the processparamfile. This acts as a filter so that you do not save all process parameters to the file. If you do not want to filter the list of process parameters, then do not specify this parameter.

donominal={yes,no}(defaults to yes).

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This parameter controls whether or not Spectre should perform a nominal run before starting the main Monte Carlo loop of iterations. If any errors are encountered during the nominal run (e.g. convergence problems, incorrect export expressions, etc.) then Spectre will issue an appropriate error message and immediately abandon the Monte Carlo analysis.

If donominal is set to "no", then Spectre will run the Monte Carlo iterations only, and will not perform a nominal analysis. If any errors are encountered during the Monte Carlo iterations, Spectre will issue a warning and continue with the next iteration of the Monte Carlo loop.

```
appendsd={yes,no}(defaults to no).
```

Specifies whether to append scalar data to an existing scalarfile, or to overwrite the existing scalarfile. This flag applies to both the scalar file and the processscalarfile.

```
savefamilyplots={yes,no}.
```

If "yes", a data file (e.g. psf) is saved for each analysis for each Monte Carlo iteration, in addition to the export scalar results which are saved to the ASCII scalar data file at the end of each iteration. Saving the full data files between runs enables the cloud plotting feature (overlaid waveforms) in Artist. It also enables the user to define/evaluate new calculator measurements after the simulation has been run using the Artist calculator. This feature could result in a huge amount of data being stored to disk, and it is advised that you use this feature with care. If you do decide to use this feature, it is advisable to keep the number of saved quantities to a minimum. If this parameter is set to "no", then data files are overwritten by each Monte Carlo iteration.

```
annotate={no,title,sweep,status}
```

Degree of annotation. Use the maximum value of "status" to print a summary of which runs did not converge or had problems evaluating "export" statements, etc.

Examples

Analysis Statements

```
mc2 montecarlo donominal=no variations=mismatch seed=1234 numruns=200 {
    dcop2 dc
    tran2 tran start=0 stop=lu
    export slewrate=oceanEval("slewRate(v("vout"),10n,t,30n,t,10,90 )")
}
// do both together...
mc3 montecarlo saveprocessparams=yes variations=all numruns=200 {
    dcop3 dc
    tran3 tran start=0 stop=lu
    export slewrate=oceanEval("slewRate(v("vout"),10n,t,30n,t,10,90 )")
}
```

Specifying Parameter Distributions using Statistics Blocks

The "statistics blocks" are used to specify the input statistical variations for a Monte Carlo analysis. A statistics block may contain one or more "process" blocks (which represents batch-to-batch type variations), and/or one or more "mismatch" blocks (which represents on-chip or device mismatch variations), in which the distributions for parameters are specified. Statistics blocks may also contain one or more correlation statements to specify the correlations between specified process parameters, and/or to specify correlated device instances (for example matched pairs). Statistics blocks may also contain a "truncate" statement which may be used for generating truncated distributions. The distributions specified in the process block will be sampled once per Monte Carlo iteration, and are typically used to represent batch-to-batch, or process variations, whereas the distributions specified in the mismatch block are sampled on a per subcircuit instance basis and are typically used to represent device-to-device mismatch for devices on the same chip. In the case where the same parameter is subject to both process and mismatch variations, then the sampled process value becomes the mean for the mismatch random number generator for that particular parameter.

Note: Multiple statistics blocks may exist, in which case they accumulate or overlay. Typically, process variations, mismatch variations and correlations between process parameters will be specified in one statistics block. A second statistics block would be specified where actual device instance correlations are specified (i.e. specification of matched pairs).

Statistics blocks can be specified using combinations of the Spectre keywords statistics, process, mismatch, vary, truncate and correlate. Braces {} are used to delimit blocks.

The following example shows some sample statistics blocks, which are discussed below along with syntax requirements.

```
// define some netlist parameters to represent process parameters
// such as sheet resistance and mismatch factors
parameters rshsp=200 rshpi=5k rshpi std=0.4K xisn=1 xisp=1 xxx=20000 uuu=200
```

Analysis Statements

```
// define statistical variations, to be used
// with a MonteCarlo analysis.
statistics {
   process {
               // process: generate random number once per MC run
        vary rshsp dist=gauss std=12 percent=yes
        vary rshpi dist=gauss std=rshpi_std // rshpi_std is a parameter
        vary xxx dist=lnorm std=12
        vary uuu dist=unif N=10 percent=yes
    mismatch { // mismatch: generate a random number per instance
        vary rshsp dist=qauss std=2
        vary xisn dist=gauss std=0.5
        vary xisp dist=gauss std=0.5
    // some process parameters are correlated
    correlate param=[rshsp rshpi] cc=0.6
    // specify a global distribution truncation factor
    truncate tr=6.0
                      // +/- 6 sigma
// a separate statistics block to specify correlated (i.e. matched) components
// where m1 and m2 are subckt instances.
statistics {
    correlate dev=[m1 m2] param=[xisn xisp] cc=0.8
}
```

Specifying Distributions

Parameter variations are specified using the following syntax:

```
vary PAR_NAME dist=<type> {std=<value> | N=<value>} {percent=yes|no}
```

Three types of parameter distributions are available: gaussian, lognormal and uniform, corresponding to the <type> keywords gauss, lnorm andunif respectively. For both the gauss and the lnorm distributions, you specify a standard deviation using the std keyword.

Gaussian Distribution

For the gaussian distribution, the mean value is taken as the current value of the parameter being varied, giving a distribution denoted by Normal(mean,std). Using the example above, parameter rshpi is varied with a distribution of Normal(5k,0.4k)

Analysis Statements

Lognormal Distribution

The lognormal distribution is denoted by

log(x) = Normal(log(mean), std)

where x is the parameter being specified as having a lognormal distribution.

(NOTE: log() is the natural logarithm function.) For parameter xxx in the example above, the process variation is according to

log(xxx) = Normal(log(20000), 12)

Uniform Distribution

The uniform distribution for parameter x is generated according to

x = unif(mean-N, mean+N)

such that the mean value is the nominal value of the parameter x, and the parameter is varied about the mean with a range of +/- N. The standard deviation is not specified for the uniform distribution, but its value can be calculated from the formula: std=N/sqrt(3).

Values as percentages

The "percent" flag indicates whether the standard deviation std or uniform range N are specified in absolute terms (percent=no) or as a percentage of the mean value (percent=yes). For parameter uuu in the example above, the mean value is 200, and the variation is 200 +/-10%*(200) i.e. 200 +/- 20. For parameter rshsp, the process variation is given by Normal(200, 12%*(200)) i.e. Normal(200, 24). It is not advised that you use the percent=yes with the lognormal distribution.

Process and Mismatch Variations

The statistics specified in a process block are applied at global scope, and the distributions are sampled once per Monte Carlo iteration. The statistics specified in a mismatch block are applied on a per-subcircuit instance basis, and are sampled once per subcircuit instance. If you place model cards and/or device instances in subcircuits, and add a mismatch block to your statistics block you can effectively model device-to-device mismatch for these devices/ models.

Analysis Statements

Correlation Statements

There are two types of correlation statements that you can use: process parameter correlation statements, and instance correlation statements.

Process Parameter Correlation

The syntax of the process parameter correlation statement is:

correlate param=[list of parameters] cc=<value>

This allows you to specify a correlation coefficient between multiple process parameters. You can specify multiple process parameter correlation statements in a statistics block, to build a matrix of process parameter correlations. During a Monte Carlo analysis, process parameter values will be randomly generated according to the specified distributions and correlations.

Mismatch Correlation (Matched Devices)

The syntax of the instance or mismatch correlation statement is:

correlate dev=[list of subcircuit instances] {param=[list of parameters]} cc=<value>

where the device or subcircuit instances to be matched are listed in the list of subcircuit instances, and the list of parameters specifies exactly which parameters with mismatch variations are to be correlated.

The instance mismatch correlation statement is used to specify correlations for particular subcircuit instances. If a subcircuit contains a device, you can effectively use the instance correlation statements to specify that certain devices are correlated (i.e. matched) and give the correlation coefficient. You can optionally specify exactly which parameters are to be correlated by giving a list of parameters (each of which must have had distributions specified for it in a mismatch block), or specify no parameter list, in which case all parameters with mismatch statistics specified are correlated with the given correlation coefficient. The correlation coefficients are specified in the <value> field and must be between +/- 1.0, not including 1.0 or -1.0.

Note: correlation coefficients can be constants or expressions, as can "std" and "N" when specifying distributions.

Truncation Factor

The default truncation factor for gaussian distributions (and for the gaussian distribution underlying the lognormal distribution) is 4.0 sigma. Randomly generated values which are

Analysis Statements

outside the range of mean +/- 4.0 sigma are automatically rejected and regenerated until they fall inside the range. You can change the truncation factor using the "truncate" statement. The syntax is:

```
truncate tr=<value>
```

Note: The value of the truncation factor can be a constant or an expression.

Note: Parameter correlations can be affected by using small truncation factors.

Parameter Index

In the following index, the number following each parameter name indicates where to find the description of that parameter.

```
annotate 15 numruns 1 savefamilyplots 13 scalarfile 3 appendsd 12 paramfile 4 saveprocessparams 5 seed 2 donominal 11 processparamfile 7 saveprocessparams 14 title 16 firstrun 9 processscalarfile 6 saveprocessvec 8 variations 10
```

Noise Analysis (noise)

Description

The noise analysis linearizes the circuit about the operating point and computes the noise spectral density at the output. If you identify an input source, the transfer function and the input-referred noise for an equivalent noise-free network is computed. In addition, if the input source is noisy, then the noise figure is computed.

The noise is computed at the output of the circuit. The output is specified with either a pair of nodes or a probe component. To specify the output of a circuit with a probe, specify it with the oprobe parameter. If the output is voltage (or potential), choose a resistor or a port as the output probe. If the output is current (or flow), choose a vsource or iprobe as the output probe.

If the input-referred noise is desired, specify the input source using the iprobe parameter. Currently, only a vsource, an isource, or a port may be used as an input probe. If the input source is noisy, as is a port, the noise analysis will compute the noise factor (F) and noise figure (NF). To match the IEEE definition of noise figure, the input probe must be a port with no excess noise and its noisetemp must be set to 16.85C (290K). In addition, the output load must be a resistor or port and must be identified as the oprobe.

Analysis Statements

The noise analysis always computes the total noise at the output, which includes contributions from the input source and the output load. The amount of the output noise that is attributable to each noise source in the circuit is also computed and output individually. If the input source is identified, the input-referred noise is computed, which includes the noise from the input source itself. Finally, if the input source is identified and is noisy, the noise factor and noise figure are computed. Thus if

```
No = total output noise

Ns = noise at the output due to the input probe (the source)

NI = noise at the output due to the output probe (the load)

IRN = input referred noise

G = gain of the circuit

F = noise factor

NF = noise figure

then,

IRN = sqrt(No^2 / G^2)

F = (No^2 - NI^2)/Ns^2

NF = 10*log10(F)
```

When the results are output, No is named out, IRN is named in, G is named gain, F is named F, and NF is named NF.

Spectre can perform the analysis while sweeping a parameter. The parameter can be frequency, temperature, component instance parameter, component model parameter, or netlist parameter. If changing a parameter affects the DC operating point, the operating point is recomputed on each step. You can sweep the circuit temperature by giving the parameter name as temp with no dev or mod parameter. You can sweep a netlist parameter by giving the parameter name with no dev, or mod parameter. After the analysis has completed, the modified parameter returns to its original value.

Analysis Statements

Definition

Name [p] [n] noise parameter=value ...

The optional terminals (p and n) specify the output of the circuit. If you do not give the terminals, then you must specify the output with a probe component.

Parameters

1 prevoppoint=no Use operating point computed on the previous analysis.

Possible values are no or yes.

Sweep interval parameters

2 start=0 Start sweep limit.

3 stop Stop sweep limit.

4 center Center of sweep.

5 span=0 Sweep limit span.

6 step Step size, linear sweep.

7 lin=50 Number of steps, linear sweep.

8 dec Points per decade.

9 log=50 Number of steps, log sweep.

10 values=[...] Array of sweep values.

Sweep variable parameters

11 dev Device instance whose parameter value is to be swept.

12 mod Model whose parameter value is to be swept.

13 param Name of parameter to sweep.

14 freq (Hz) Frequency when parameter other than frequency is being swept.

Analysis Statements

Probe parameters

15 oprobe Compute total noise at the output defined by this component.

16 iprobe Input probe. Refer the output noise to this component.

State-file parameters

17 readns File that contains estimate of DC solution (nodeset).

Output parameters

18 save Signals to output.

Possible values are all, lvl, allpub, lvlpub, selected, or

none.

19 nestlvl Levels of subcircuits to output.

20 oppoint=no Should operating point information be computed, and if so,

where should it be sent.

Possible values are no, screen, logfile, or rawfile.

Convergence parameters

21 restart=yes Do not use previous DC solution as initial guess.

Possible values are no or yes.

Annotation parameters

22 annotate=sweep Degree of annotation.

Possible values are no, title, sweep, status, or steps.

23 stats=no Analysis statistics.

Possible values are no or yes.

24 title Analysis title.

You can specify sweep limits by giving the end points or by providing the center value and the span of the sweep. Steps can be linear or logarithmic, and you can specify the number of steps or the size of each step. You can give a step size parameter (step, lin, log, dec) to determine whether the sweep is linear or logarithmic. If you do not give a step size parameter,

Analysis Statements

the sweep is linear when the ratio of stop to start values is less than 10, and logarithmic when this ratio is 10 or greater. All frequencies are in Hertz.

The small-signal analysis begins by linearizing the circuit about an operating-point. By default this analysis computes the operating-point if it is not known, or recomputes it if any significant component or circuit parameter has changed. However, if a previous analysis computed an operating point, you can set prevoppoint=yes to avoid recomputing it. For example, if you use this option when the previous analysis was a transient analysis, the operating point is the state of the circuit on the final time point.

Parameter Index

In the following index, the number following each parameter name indicates where to find the description of that parameter.

annotate 22	lin 7	param 13	start 2
center 4	log 9	prevoppoint 1	stats 23
dec 8	mod 12	readns 17	step 6
dev 11	nestlvl 19	restart 21	stop 3
freq 14	oppoint 20	save 18	title 24
iprobe 16	oprobe 15	span 5	values 10

Immediate Set Options (options)

Description

The immediate set options statement sets or changes various program control options. These options take effect immediately and are set while the circuit is read. For further options, see the individual analyses.

Note: Options that are dependent on netlist parameter values, do not maintain their dependencies on those netlist parameters.

Analysis Statements

Definition

Name options parameter=value ...

Parameters

Tolerance parameters

1 reltol=0.001 Relative convergence criterion.

2 vabstol=1e-06 V Voltage absolute tolerance convergence criterion.

3 iabstol=1e-12 A Current absolute tolerance convergence criterion.

Temperature parameters

4 temp=27 C Temperature.

5 tnom=27 C Default component parameter measurement temperature.

6 tempeffects=all Temperature effect selector.

Possible values are vt, tc or all.

Output parameters

7 save=selected Signals to output.

Possible values are all, lvl, allpub, lvlpub, selected, or

none.

8 $nestlvl=\infty$ Levels of subcircuits to output.

9 subcktprobelvl=0 Level up to which subcircuit terminal current probes are to be set

up.

10 currents=selected

Terminal currents to output. (See important note below about

saving currents by using probes).

Possible values are all, nonlinear or selected.

Analysis Statements

important note below about saving currents by using probes).

Possible values are no or yes.

12 redundant_currents=no

If yes, save both currents through two terminal devices.

Possible values are no or yes.

13 pwr=none Power signals to create.

Possible values are all, subckts, devices, total, or none.

14 saveahdlvars=selected

AHDL variables to output.

Possible values are all or selected.

15 rawfmt=psfbin Output raw data file format.

Possible values are nutbin, nutascii, wsfbin, wsfascii,

psfbin, psfascii, awb, or sst2.

16 rawfile="%C:r.raw"Output raw data file name.

Convergence parameters

17 homotopy=all Method used when no convergence on initial attempt of DC

analysis.

Possible values are none, gmin, source, dptran, ptran,

arclength, or all.

18 limit=dev Limiting algorithms to aid DC convergence.

Possible values are delta, log or dev.

Component parameters

19 scalem=1 Model scaling factor.

20 scale=1 Device instance scaling factor.

21 compatible=spectre

Encourage device equations to be compatible with a foreign

simulator. This option does not affect input syntax.

Possible values are spectre, spice2, spice3, cdsspice,

hspice, or spiceplus.

Analysis Statements

22 approx=no Use approximate models. Difference between approximate and

exact models is generally very small.

Possible values are no or yes.

23 macromodels=no Circuit contains macromodels; sometimes helps performance.

Possible values are no or yes.

Error-checking parameters

24 topcheck=full Check circuit topology for errors.

Possible values are no, min, full, or fixall.

25 ignshorts=no Silently ignore shorted components.

Possible values are no or yes.

26 diagnose=no Print additional information that might help diagnose accuracy

and convergence problems. Possible values are no or yes.

27 opptcheck=yes Check operating point parameters against soft limits.

Possible values are no or yes.

Resistance parameters

28 qmin=1e-12 S Minimum conductance across each nonlinear device.

29 gmin_check=max_v_only

Specifies that effect of gmin should be reported if significant. Possible values are no, max_v_only, max_only, or all.

30 rforce=1 Ω Resistance used when forcing nodesets and node-based initial

conditions.

Quantity parameters

31 value="V" Default value quantity.

32 flow="I" Default flow quantity.

33 quantities=no Print quantities.

Possible values are no, min or full.

Analysis Statements

Annotation parameters

34 audit=detailed	Print time required by various parts of the simulator. Possible values are no, brief, detailed, or full.
35 inventory=detaile	Print summary of components used. Possible values are no, brief or detailed.
36 narrate=yes	Narrate the simulation. Possible values are no or yes.
37 debug=no	Give debugging messages. Possible values are no or yes.
38 info=yes	Give informational messages. Possible values are no or yes.
39 note=yes	Give notice messages. Possible values are no or yes.
40 maxnotes=5	Maximum number of times any notice will be issued per analysis.
41 warn=yes	Give warning messages. Possible values are no or yes.
42 maxwarns=5	Maximum number of times any warning message will be issued per analysis.
43 error=yes	Give error messages. Possible values are no or yes.
44 digits=5	Number of digits used when printing numbers.
45 notation=eng	When printing real numbers to the screen, what notation should be used. Possible values are eng, sci or float.
46 cols=80	Width of screen in characters.
47 title	Circuit title.

Analysis Statements

Matrix parameters

48 pivotdc=no Use numeric pivoting on every iteration of DC analysis.

Possible values are no or yes.

49 pivrel=0.001 Relative pivot threshold.

50 pivabs=0 Absolute pivot threshold.

Miscellaneous parameters

51 ckptclock=1800 s Clock time checkpoint period.

Sensitivity parameters

52 sensfile Output sensitivity data file name.

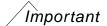
53 sensformat=tabular

Format of sensitivity data.

Possible values are tabular or list.

54 senstype=partial Type of sensitivity being calculated.

Possible values are partial or normalized.



Important note about currents and useprobes options

Adding probes to circuits that are sensitive to numerical noise might affect the solution. In such cases accurate solution may be obtained by reducing reltol.

The following devices will always use probes to save currents (even with useprobes=no): port, delay, switch, hbt, transformer, core, winding, fourier, d2a, a2d, a2ao, a2ai.

Sensitivity Definitions

When senstype is set to partial, the sensitivity being calculated is the partial derivative of a differentiable output variable F with respect to a design parameter p

dF

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D (F w.r.t. p) = --
$$dp$$

This definition is not scale free. When senstype is set to normalized, the sensitivity being calculated is the normalized sensitivity

$$d \ln F p dF p$$

$$S (F w.r.t. p) = ---- = - - - = - D (F w.r.t. p)$$

$$d \ln p F dp F$$

When either F or p takes a zero value, the above normalized definition no longer provides a useful measure, the following two seminormalized sensitivities are used instead:

$$dF \qquad dF$$

$$S (F w.r.t. p) = ----- = p --- = p D (F w.r.t. p) \quad \text{if } F = 0$$

$$d \ln p \quad dp$$

and

When both F and p are zero, the partial sensitivity is used.

Topcheck Parameter

When topcheck=full, a topology check is performed and gmin is inserted between isolated nodes and ground. A heuristic topology check is also performed to find nodes that may be isolated due to the numerical nature of the circuit. For example, nodes isolated by reverse biased diodes in MOSFETS.

Use topcheck=fixall to attach gmin to all types of isolated nodes. Including the ones found by the heuristic topology check.

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Parameter Index

In the following index, the number following each parameter name indicates where to find the description of that parameter.

approx 22	iabstol 3	pivotdc 48	sensformat 53
audit 34	ignshorts 25	pivrel 49	senstype 54
ckptclock 51	info 38	pwr 13	subcktprobelvl 9
cols 46	inventory 35	quantities 33	temp 4
compatible 21	limit 18	rawfile 16	tempeffects 6
currents 10	macromodels 23	rawfmt 15	title 47
debug 37	maxnotes 40	redundant_currents 12	tnom 5
diagnose 26	maxwarns 42	reltol 1	topcheck 24
digits 44	narrate 36	rforce 30	useprobes 11
error 43	nestlvl 8	save 7	vabstol 2
flow 32	notation 45	saveahdlvars 14	value 31
gmin 28	note 39	scale 20	warn 41
gmin_check 29	opptcheck 27	scalem 19	
homotopy 17	pivabs 50	sensfile 52	

Periodic AC Analysis (pac)

Description

The periodic AC (PAC) analysis is used to compute transfer functions for circuits that exhibit frequency translation. Such circuits include mixers, switched-capacitor filters, samplers, phase-locked loops, and the like. It is a small-signal analysis like AC analysis, except the circuit is first linearized about a periodically varying operating point as opposed to a simple DC operating point. Linearizing about a periodically time-varying operating point allows transfer-functions that include frequency translation, whereas simply linearizing about a DC operating point could not because linear time-invariant circuits do not exhibit frequency translation. Also, the frequency of the sinusoidal stimulus is not constrained by the period of the large periodic solution.

Computing the small-signal response of a periodically varying circuit is a two step process. First, the small stimulus is ignored and the periodic steady-state response of the circuit to possibly large periodic stimulus is computed using PSS analysis. As a normal part of the PSS analysis, the periodically time-varying representation of the circuit is computed and saved for later use. The second step is applying the small stimulus to the periodically varying linear representation to compute the small signal response. This is done using the PAC analysis. A

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PAC analysis cannot be used alone, it must follow a PSS analysis. However, any number of periodic small-signal analyses such as PAC, PSP, PXF, PNoise, can follow a PSS analysis.

Unlike other analyses in Spectre, this analysis can only sweep frequency.

Definition

Name pac parameter=value ...

Parameters

Sweep interval parameters

1	start=0	Start sweep limit.
2	stop	Stop sweep limit.
3	center	Center of sweep.
4	span=0	Sweep limit span.
5	step	Step size, linear sweep.
6	lin=50	Number of steps, linear sweep.
7	dec	Points per decade.
8	log=50	Number of steps, log sweep.
9	values=[]	Array of sweep values.
10	sweeptype	Specifies if the sweep frequency range is absolute frequency of input or if it is relative to the port harmonics. Possible values are absolute or relative.
11	relharmnum=1	Harmonic to which relative frequency sweep should be referenced.

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Output parameters

12 sidebands=[...] Array of relevant sidebands for the analysis.

13 maxsideband=0 An alternative to the sidebands array specification, which

automatically generates the array: [-maxsideband ... 0 ...

+maxsideband].

14 fregaxis Specifies whether the results should be output versus the input

frequency, the output frequency, or the absolute value of the output frequency. Default is in for logarithmic frequency sweeps

and absout otherwise.

Possible values are absout, out or in.

15 save Signals to output.

Possible values are all, lvl, allpub, lvlpub, selected, or

none.

16 nestlvl Levels of subcircuits to output.

17 outputperiod=0.0 (no output)

Time-domain output period. The time-domain small-signal response is computed for the period specified, rounded to the

nearest integer multiple of the pss period.

Convergence parameters

18 tolerance=1e-9 Relative tolerance for linear solver.

19 gear order=2 Gear order used for small-signal integration.

20 solver=turbo Solver type.

Possible values are std or turbo.

21 oscsolver=turbo Oscillator solver type.

Possible values are std or turbo.

Annotation parameters

22 annotate=sweep Degree of annotation.

Possible values are no, title, sweep, status, or steps.

Analysis Statements

23 stats=no Analysis statistics.

Possible values are no or yes.

24 title Analysis title.

You can select the set of periodic small-signal output frequencies of interest by setting either the maxsideband or the sidebands parameters. For a given set of n integer numbers representing the sidebands K1, K2, ... Kn, the output frequency at each sideband is computed as f(out)= f(in) + Ki * fund(pss), where f(in) represent the (possibly swept) input frequency, and fund(pss) represents the fundamental frequency used in the corresponding PSS analysis. Thus, when analyzing a down-converting mixer, while sweeping the RF input frequency, the most relevant sideband for IF output is Ki= -1. When simulating an up-converting mixer, while sweeping IF input frequency, the most relevant sideband for RF output is Ki= 1. By setting the maxsideband value to Kmax, all 2 * Kmax + 1 sidebands from -Kmax to +Kmax are generated.

The number of requested sidebands does not change substantially the simulation time. However, the maxacfreq of the corresponding PSS analysis should be set to guarantee that | max{f(out)} | is less than maxacfreq, otherwise the computed solution might be contaminated by aliasing effects. The PAC simulation is not executed for | f(in) | greater than maxacfreq. Diagnostic messages are printed for those extreme cases, indicating how maxacfreq should be set in the PSS analysis. In the majority of the simulations, however, this is not an issue, because maxacfreq is never allowed to be smaller than 40x the PSS fundamental.

With PAC the frequency of the stimulus and of the response are usually different (this is an important way in which PAC differs from AC). The freqaxis parameter is used to specify whether the results should be output versus the input frequency (in), the output frequency (out), or the absolute value of the output frequency (absout).

Unlike AC analysis, PAC analysis can output the time-domain simulation results, by specifying the outputperiod parameter.

You can specify sweep limits by giving the end points or by providing the center value and the span of the sweep. Steps can be linear or logarithmic, and you can specify the number of steps or the size of each step. You can give a step size parameter (step, lin, log, dec) to determine whether the sweep is linear or logarithmic. If you do not give a step size parameter, the sweep is linear when the ratio of stop to start values is less than 10, and logarithmic when this ratio is 10 or greater. Alternatively, you may specify the particular values that the sweep parameter should take using the values parameter. If you give both a specific set of values and a set specified using a sweep range, the two sets are merged and collated before being used. All frequencies are in Hertz.

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Parameter Index

In the following index, the number following each parameter name indicates where to find the description of that parameter.

annotate 22	log 8	save 15	step 5	
center 3	maxsideband 13	sidebands 12	stop 2	
dec 7	nestlvl 16	solver 20	sweeptype	10
freqaxis 14	oscsolver 21	span 4	title 24	
gear_order 19	outputperiod 17	start 1	tolerance	18
lin 6	relharmnum 11	stats 23	values 9	

Periodic Distortion Analysis (pdisto)

Description

Similar to PAC analysis, the periodic distortion (PDISTO) analysis calculates responses of a circuit that exhibits frequency translations. However, instead of having small signal linear behavior, it models the response as having components of a few harmonics of input signal frequencies. This allows computing responses to moderately large input signals. An example is intermodulation distortion with two moderate input signals. PDISTO treats one particular input signal (usually the one that causes the most nonlinearity or the largest response) as the large signal, and the others as moderate signals.

An initial transient analysis is carried out by first suppressing all moderate input signals. Then we run a number of (at least 2) stable iterations with all signals activated, which is followed by shooting Newton method. PDISTO employs the Mixed Frequency Time (MFT) algorithm extended to multiple fundamental frequencies. For details of MFT algorithm, please see Steady-State Methods for Simulating Analog and Microwave Circuits, by K. S. Kundert, J. K. White, and A. Sangiovanni-Vincentelli, Kluwer, Boston, 1990.

Like PSS, PDISTO uses shooting Newton method as its backbone. However, instead of doing a single transient integration, each Newton iteration does a number of transient integrations of one large signal period.

Each of the integrations differs by a phase-shift in each moderate input signal. The number of integrations is determined by the numbers of harmonics of moderate fundamentals specified by the user. Given maxharms=[k1 k2 ... kn], the total number of integrations is (2*k2+1)*(2*k3+1)*...*(2*kn+1). As one consequence, the efficiency of the algorithm depends significantly on the number of harmonics required to model the responses of moderate fundamentals. As another consequence, the number of harmonics of the large fundamental

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does not significantly affect the efficiency of the shooting algorithm. The boundary conditions of a shooting interval are such that the time domain integrations are consistent with a frequency domain transformation with a shift of one large signal period.

PDISTO inherits a majority of PSS parameters. A few new parameters are added. The most important ones are funds and maxharms. They replace PSS parameters, fund (or period) and harms, respectively. The funds parameter accepts a list of names of fundamentals that are present in the sources. These names are specified in the sources by parameter fundname. The first fundamental is considered as the large signal. A few heuristics can be used for picking the large fundamental.

- (1) Pick the one which is not a sinusoidal.
- (2) Pick the one which causes the most nonlinearity.
- (3) Pick the one which causes the largest response.

The maxharms parameter accepts a list of numbers of harmonics that are required to sufficiently model responses due to different fundamentals.

Definition

Name pdisto parameter=value ...

Parameters

Distortion fundamental parameters

1	funds=[]	Array of fundamental frequency names for fundamentals to use
		in analysis.

2 maxharms=[]	Array of number of harmonics of each fundamental to consider
	for each fundamental.

Simulation interval parameters

3	tstab=0.0 s	Extra stabilization time after the onset of periodicity for
		independent sources.

4 tstart=0.0 s Initial transient analysis start time.

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Time-step parameters

5 maxstep (s) Maximum time step. Default derived from errpreset.

6 step=0.001 period s

Minimum time step that would be used solely to maintain the

aesthetics of the results.

Initial-condition parameters

7 ic=all What should be used to set initial condition.

Possible values are dc, node, dev, or all.

8 skipdc=no If yes, there will be no dc analysis for transient.

Possible values are no or yes.

9 readic File that contains initial condition.

Convergence parameters

10 readns File that contains estimate of initial transient solution.

11 cmin=0 F Minimum capacitance from each node to ground.

Output parameters

12 outputtype=time for PSS, freq for PDISTO

Output type.

Possible values are all, time or freq.

13 save Signals to output.

Possible values are all, lvl, allpub, lvlpub, selected, or

none.

14 nestlvl Levels of subcircuits to output.

15 oppoint=no Should operating point information be computed for initial

timestep, and if so, where should it be sent.

Possible values are no, screen, logfile, or rawfile.

16 skipstart=starttime s

The time to start skipping output data.

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17 skipstop=stoptime s

The time to stop skipping output data.

18 skipcount Save only one of every skipcount points.

19 strobeperiod (s) The output strobe interval (in seconds of transient time).

20 strobedelay=0 s The delay (phase shift) between the skipstart time and the first

strobe point.

21 compression=no Do data compression on output.

Possible values are no or yes.

22 saveinit=no If set, the waveforms for the initial transient before steady state

are saved.

Possible values are no or yes.

State-file parameters

23 write File to which initial transient solution (before steady-state) is to

be written.

24 writefinal File to which final transient solution in steady-state is to be

written.

25 swapfile Temporary file that holds steady-state information. Tells Spectre

to use a regular file rather than virtual memory to hold the periodic operating point. Use this option if Spectre complains about not having enough memory to complete this analysis.

Integration method parameters

26 method Integration method. Default derived from errpreset.

Possible values are euler, trap, traponly, gear 2, or

gear2only.

Accuracy parameters

27 errpreset=moderate

Selects a reasonable collection of parameter settings.

Possible values are liberal, moderate or conservative.

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28 relref	Reference used for the relative convergence criteria. Default derived from errpreset. Possible values are pointlocal, alllocal, sigglobal, or allglobal.
29 lteratio	Ratio used to compute LTE tolerances from Newton tolerance. Default derived from errpreset.
30 steadyratio	Ratio used to compute steady state tolerances from LTE tolerance. Default derived from errpreset.
31 maxperiods=20 for	driven PSS, 50 for autonomous PSS Maximum number of simulated periods to reach steady-state.
32 tolerance=1e-4	Relative tolerance for linear solver.
33 finitediff	Options for finite difference method refinement after quasi- periodic shooting method. finitediff is changed from no to samegrid automatically when readqpss and writeqpss are used to re-use QPSS results.

Annotation parameters

34 stats=no	Analysis statistics.
94 StatS-110	สมสมออก อเสมอเนอ.

Possible values are no or yes.

Possible values are no, yes or refine.

35 annotate=sweep Degree of annotation.

Possible values are no, title, sweep, status, or steps.

36 title Analysis title.

Newton parameters

37 maxiters=5 Maximum number of iterations per time step.

38 restart=yes Do not use previous DC solution as initial guess.

Possible values are no or yes.

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Circuit age

39 circuitage (Years) Stress Time. Age of the circuit used to simulate hot-electron degradation of MOSFET and BSIM circuits.

40 writegpss File to which final quasi-periodic steady-state solution is to be

written. Small signal analyses such as qpac, qpxf and qpnoise can read in the steady-state solution from this file directly instead

of running the qpss analysis again.

41 readqpss File from which final quasi-periodic steady-state solution is to be

read. Small signal analyses such as qpac, qpxf and qpnoise can read in the steady-state solution from this file directly instead of

running the qpss analysis again.

Most of PDISTO analysis parameters are inherited from PSS analysis, and their meanings remain essentially unchanged. Two new important parameters are funds and maxharms. They replace and extend the role of fund and harms parameters of PSS analysis. One important difference is that funds accepts a list of fundamental names instead of actual frequencies. The frequencies associated with fundamentals are figured out automatically by the simulator. An important feature is that each input signal can be a composition of more than one sources. However, these sources must have the same fundamental name. For each fundamental name, its fundamental frequency is the greatest common factor of all frequencies associated with the name. Missing or not listing all fundamental names using the parameter funds will result in an amputation of the current simulation. However if maxharms is not given, a warning message will be issued, and the number of harmonics is defaulted to 1 for each of the fundamentals.

The role of some PSS parameters is extended. The parameter maxperiods that controls the maximum number of shooting iterations for PSS analysis also controls the number of the maximum number of shooting iterations for PDISTO analysis.

The tstab parameter controls both the length of the initial transient integration with only the clock tone activated and the number of stable iterations with moderate tones activated. The stable iterations are run before Newton iterations.

The errpreset parameter lets you adjust the simulator parameters to fit your needs quickly. In most cases, it should also be the only parameter you need to adjust. If you want a fast simulation with reasonable accuracy, you may set errpreset to liberal. If have some concern for accuracy, you may set errpreset to moderate. If accuracy is your main interest, you may set errpreset to conservative.

If users dont specify steadyratio, it is always 1.0 - not affected by errpreset. The effect of errpreset on other parameters is shown in the following table.

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Parameter defaults as a function of errpreset

errpreset	reltol	relref	method	Iteratio	maxstep
liberal	1e-3	sigglobal	gear2only	3.5	clock period/80
moderate	1e-4	sigglobal	gear2only	3.5	clock period/100
conservative	1e-5	sigglobal	gear2only	*	clock period/200

^{*:} If user specified reltol <= 1e-5*10.0/3.5, Iteratio=3.5. Otherwise Iteratio=10.0.

The value of reltol can only decrease from its value in the options statement, when reltol in options statement is larger. Spectre sets the value of maxstep so that it is no larger than the value given in the table. Except for reltol and maxstep, errpreset does not change the value of any parameters you have explicitly set. The actual values used for the QPSS analysis are given in the log file.

Parameter Index

In the following index, the number following each parameter name indicates where to find the description of that parameter.

annotate 35	maxiters 37	restart 38	strobeperiod 19
circuitage 39	maxperiods 31	save 13	swapfile 25
cmin 11	maxstep 5	saveinit 22	title 36
compression 21	method 26	skipcount 18	tstab 3
errpreset 27	nestlvl 14	skipdc 8	tstart 4
finitediff 33	oppoint 15	skipstart 16	write 23
funds 1	outputtype 12	skipstop 17	writefinal 24
ic 7	readic 9	stats 34	writeqpss 40
itres 32	readns 10	steadyratio 30	
lteratio 29	readqpss 41	step 6	
maxharms 2	relref 28	strobedelay 20	

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Periodic Noise Analysis (pnoise)

Description

The Periodic Noise, or PNoise analysis is similar to the conventional noise analysis, except that it includes frequency conversion effects. Hence is it useful for predicting the noise behavior of mixers, switched-capacitor filters, and other periodically driven circuits. It is particularly useful for predicting the phase noise of autonomous circuits, such as oscillators.

PNoise analysis linearizes the circuit about the periodic operating point computed in the prerequisite PSS analysis. It is the periodically time-varying nature of the linearized circuit that accounts for the frequency conversion. In addition, the affect of a periodically time-varying bias point on the noise generated by the various components in the circuit is also included.

The time-average of the noise at the output of the circuit is computed in the form of a spectral density versus frequency. The output of the circuit is specified with either a pair of nodes or a probe component. To specify the output of a circuit with a probe, specify it using the oprobe parameter. If the output is voltage (or potential), choose a resistor or a port as the output probe. If the output is current (or flow), choose a vsource or iprobe as the output probe.

If the input-referred noise or noise figure is desired, specify the input source using the iprobe parameter. For input-referred noise, use either a vsource or isource as the input probe; for noise figure, use a port as the probe. Currently, only a vsource, an isource, or a port may be used as an input probe. If the input source is noisy, as is a port, the noise analysis will compute the noise factor (F) and noise figure (NF). To match the IEEE definition of noise figure, the input probe must be a port with no excess noise and its noisetemp must be set to 16.85C (290K). In addition, the output load must be a resistor or port and must be identified as the oprobe.

The reference sideband (refsideband) specifies which conversion gain is used when computing input-referred noise, noise factor, and noise figure. The reference sideband specifies the input frequency relative to the output frequency with:

|f(input)| = |f(out) + refsideband * fund(pss)|

Use refsideband=0 when the input and output of the circuit are at the same frequency (such as with amplifiers and filters). When refsideband differs from 0, the single side-band noise figure is computed.

The noise analysis always computes the total noise at the output, which includes contributions from the input source and the output load. The amount of the output noise that is attributable to each noise source in the circuit is also computed and output individually. If

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the input source is identified (using iprobe) and is a vsource or isource, the input-referred noise is computed, which includes the noise from the input source itself. Finally, if the input source is identified (using iprobe) and is noisy, as is the case with ports, the noise factor and noise figure are computed. Thus if

No = total output noise

Ns = noise at the output due to the input probe (the source)

Nsi = noise at the output due to the image harmonic at the source

Nso = noise at the output due to harmonics other than input at the source

NI = noise at the output due to the output probe (the load)

IRN = input referred noise

G = gain of the circuit

F = noise factor

NF = noise figure

Fdsb = double sideband noise factor

NFdsb = double sideband noise figure

Fieee = IEEE single sideband noise factor

NFieee = IEEE single sideband noise figure

then,

 $IRN = sqrt(No^2/G^2)$

 $F = (No^2 - NI^2)/Ns^2$

NF = 10*log10(F)

 $Fdsb = (No^2 - NI^2)/(Ns^2 + Nsi^2)$

NFdsb = 10*log10(Fdsb)

 $Fieee = (No^2 - NI^2 - Nso^2)/Ns^2$

NFieee = 10*log10(Fieee).

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When the results are output, No is named out, IRN is named in, G is named gain, F, NF, Fdsb, NFdsb, Fieee, and NFieee are named F, NF, Fdsb, NFdsb, Fieee, and NFieee respectively.

Unlike other analyses in Spectre, this analysis can only sweep frequency.

Definition

Name [p] [n] pnoise parameter=value ...

The optional terminals (p and n) specify the output of the circuit. If you do not give the terminals, then you must specify the output with a probe component.

Parameters

Sweep interval parameters

1	start=0	Start sweep limit.
2	stop	Stop sweep limit.
3	center	Center of sweep.
4	span=0	Sweep limit span.
5	step	Step size, linear sweep.
6	lin=50	Number of steps, linear sweep.
7	dec	Points per decade.
8	log=50	Number of steps, log sweep.
9	values=[]	Array of sweep values.
10 sweeptype		Specifies if the sweep frequency range is absolute frequency of input or if it is relative to the port harmonics. Possible values are absolute or relative.
11	relharmnum=1	Harmonic to which relative frequency sweep should be referenced.

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Probe parameters

12 oprobe	Compute total noise at the output defined by this component.
13 iprobe	Refer the output noise to this component.
14 refsideband	Conversion gain associated with this sideband is used when computing input-referred noise or noise figure.

Output parameters

15 noisetype=sources	Specifies if the pnoise analysis should output cross-power densities or noise source information. Possible values are sources, correlations or timedomain.
16 maxsideband=7	Maximum sideband included when computing noise either up- converted or down-converted to the output by the periodic drive signal.

17	sidebands=[]	Array of relevant sidebands for the analysis.
----	--------------	---

18	save	Signals to output.

Possible values are all, lvl, allpub, lvlpub, selected, or

none.

19 nestlvl Levels of subcircuits to output.

20 maxcycles=0 Maximum cycle correlation frequency included when computing

noise either up-converted or down-converted to the output by the

periodic drive signal.

21 cycles=[...] Array of relevant cycle frequencies. Valid only if

noisetype=correlations.

22 noiseskipcount=0 Calculate time-domain noise on only one of every

noiseskipcount time points.

23 noisetimepoints=[...] Additional timepoints for time-domain noise analysis..

24 saveallsidebands=no

Save noise contributors by sideband.

Possible values are no or yes.

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Convergence parameters

25 tolerance=1e-9 Relative tolerance for linear solver.

26 gear_order=2 Gear order used for small-signal integration.

27 solver=turbo Solver type.

Possible values are std or turbo.

28 oscsolver=turbo Oscillator solver type.

Possible values are std or turbo.

Annotation parameters

29 annotate=sweep Degree of annotation.

Possible values are no, title, sweep, status, or steps.

30 stats=no Analysis statistics.

Possible values are no or yes.

31 title Analysis title.

In practice, noise can mix with each of the harmonics of the periodic drive signal applied in the PSS analysis and end up at the output frequency. However, the PNoise analysis only includes the noise that mixes with a finite set of harmonics that are typically specified using the maxsideband parameter, but in special circumstances may be specified with the sidebands parameter. If Ki represents sideband i, then

The maxsideband parameter specifies the maximum |Ki| included in the PNoise calculation. Thus, noise at frequencies less than f(out)-maxsideband*fund(pss) and greater than f(out)+maxsideband*fund(pss) are ignored. If selected sidebands are specified using the sidebands parameter, then only those are included in the calculation. Care should be taken when specifying the sidebands because the results will be in error if you do not include a sideband that contributes significant noise to the output.

The number of requested sidebands does not change substantially the simulation time. However, the maxacfreq of the corresponding PSS analysis should be set to guarantee that |max{f(noise_source)}| is less than maxacfreq, otherwise the computed solution might be contaminated by aliasing effects. The PNoise simulation is not executed for |f(out)| greater than maxacfreq. Diagnostic messages are printed for those extreme cases, indicating which maxacfreq should be set in the PSS analysis. In the majority of the simulations,

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however, this is not an issue, because maxacfreq is never allowed to be smaller than 40x the PSS fundamental.

You can specify sweep limits by giving the end points or by providing the center value and the span of the sweep. Steps can be linear or logarithmic, and you can specify the number of steps or the size of each step. You can give a step size parameter (step, lin, log, dec) to determine whether the sweep is linear or logarithmic. If you do not give a step size parameter, the sweep is linear when the ratio of stop to start values is less than 10, and logarithmic when this ratio is 10 or greater. Alternatively, you may specify the particular values that the sweep parameter should take using the values parameter. If you give both a specific set of values and a set specified using a sweep range, the two sets are merged and collated before being used. All frequencies are in Hertz.

Parameter Index

In the following index, the number following each parameter name indicates where to find the description of that parameter.

annotate 29	maxcycles 20	refsideband 14	stats 30	
center 3	maxsideband 16	relharmnum 11	step 5	
cycles 21	nestlvl 19	save 18	stop 2	
dec 7	noiseskipcount 22	saveallsidebands 24	sweeptype	10
gear_order 26	noisetimepoints 23	sidebands 17	title 31	
iprobe 13	noisetype 15	solver 27	tolerance	25
lin 6	oprobe 12	span 4	values 9	
log 8	oscsolver 28	start 1		

Periodic S-Parameter Analysis (psp)

Description

The periodic SP (psp) analysis is used to compute scattering and noise parameters for n-port circuits that exhibit frequency translation, such as mixers. It is a small-signal analysis like SP analysis, except, as in PAC and PXF, the circuit is first linearized about a periodically varying operating point as opposed to a simple DC operating point. Linearizing about a periodically time-varying operating point allows the computation of S-parameters between circuit ports that convert signals from one frequency band to another. PSP can also calculate noise parameters in frequency-converting circuits. PSP computes noise figure (both single-sideband and double-sideband), input referred noise, equivalent noise parameters, and noise

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correlation matrices. As in PNoise, but unlike SP, the noise features of the PSP analysis include noise folding effects due to the periodically time-varying nature of the circuit.

Computing the n-port S-parameters and noise parameters of a periodically varying circuit is a two step process. First, the small stimulus is ignored and the periodic steady-state response of the circuit to possibly large periodic stimulus is computed using PSS analysis. As a normal part of the PSS analysis, the periodically time-varying representation of the circuit is computed and saved for later use. The second step is applying small-signal excitations to compute the n-port S-parameters and noise parameters. This is done using the PSP analysis. A PSP analysis cannot be used alone, it must follow a PSS analysis. However, any number of periodic small-signal analyses such as PAC, PSP, PXF, PNoise, can follow a single PSS analysis.

Unlike other analyses in Spectre, this analysis can only sweep frequency.

Definition

Name psp parameter=value ...

Parameters

Sweep interval parameters

1	start=0	Start sweep limit.
2	stop	Stop sweep limit.
3	center	Center of sweep.
4	span=0	Sweep limit span.
5	step	Step size, linear sweep.
6	lin=50	Number of steps, linear sweep.
7	dec	Points per decade.
8	log=50	Number of steps, log sweep.
9	values=[]	Array of sweep values.

Analysis Statements

10 sweeptype Specifies if the sweep frequency range is absolute frequency of

input or if it is relative to the port harmonics.

Possible values are absolute or relative.

Port parameters

11 ports=[...] List of active ports. Ports are numbered in the order given. For

purposes of noise figure computation, the input is considered

port 1 and the output is port 2.

12 portharmsvec=[...]List of harmonics active on specified list of ports. Must have a

one-to-one correspondence with the ports vector.

13 harmsvec=[...] List of harmonics, in addition to ones associated with specific

ports by portharmsvec, that are active.

Output parameters

14 freqaxis Specifies whether the results should be output versus the input

frequency, the output frequency, or the absolute value of the

input frequency. Default is in.

Possible values are absin, in or out.

Noise parameters

15 donoise=yes Perform noise analysis. If oprobe is specified as a valid port, this

is set to yes, and a detailed noise output is generated.

Possible values are no or yes.

Probe parameters

16 maxsideband=7 Maximum sideband included when computing noise either up-

converted or down-converted to the output by the periodic drive

signal.

Convergence parameters

17 tolerance=1e-9 Relative tolerance for linear solver.

18 gear_order=2 Gear order used for small-signal integration.

Analysis Statements

19 solver=turbo Solver type.

Possible values are std or turbo.

20 oscsolver=turbo Oscillator solver type.

Possible values are std or turbo.

Annotation parameters

21 annotate=sweep Degree of annotation.

Possible values are no, title, sweep, status, or steps.

22 stats=no Analysis statistics.

Possible values are no or yes.

23 title Analysis title.

To specify the PSP analysis the port and port harmonic relations must be specified. You can select the ports of interest by setting the port parameter and the set of periodic small-signal output frequencies of interest by setting the portharmsvec or the harmsvec parameters. For a given set of n integer numbers representing the harmonics K1, K2, ... Kn, the scattering parameters at each port are computed at the frequencies f(scattered)= f(rel) + Ki * fund(pss), where f(rel) represents the relative frequency of a signal incident on a port, f(scattered) represents the frequency to which the relevant scattering parameter represents the conversion, and fund(pss) represents the fundamental frequency used in the corresponding PSS analysis.

Thus, when analyzing a down-converting mixer, with signal in the upper sideband, and sweeping the RF input frequency, the most relevant harmonic for RF input is Ki= 1 and for IF output Ki= 0. Hence we can associate K2=1 with the IF port and K1=0 with the RF port. S21 will represent the transmission of signal from the RF to IF, and S11 the reflection of signal back to the RF port. If the signal was in the lower sideband, then a choice of K1=-1 would be more appropriate.

Either the portharmsvec or the harmsvec parameters can be used to specify the harmonics of interest. If the portharmsvec is given, the harmonics must be in one-to-one correspondence with the ports, with each harmonic associated with a single port. If harmonics are specified in the optional harmsvec parameter, then all possible frequency-translating scattering parameters associated with the specified harmonics are computed.

With PSP the frequency of the input and of the response are usually different (this is an important way in which PSP differs from SP). Because the PSP computation involves inputs and outputs at frequencies that are relative to multiple harmonics, the freqaxis and sweeptype parameters behave somewhat differently in PSP than in PAC and PXF.

Analysis Statements

The sweeptype parameter controls the way the frequencies in the PSP analysis are swept. Specifying a relative sweep indicates to sweep relative to the analysis harmonics (not the PSS fundamental) and an absolute sweep is a sweep of the absolute input source frequency. For example, with a PSS fundamental of 100MHz, the portharmsvec set to [9 1] to examine a downconverting mixer, sweeptype=relative, and a sweep range of f(rel)=0->50MHz, then S21 would represent the strength of signal transmitted from the input port in the range 900->950MHz to the output port at frequencies 100->150MHz. Using sweeptype=absolute and sweeping the frequency from 900->950MHz would calculate the same quantities, since f(abs)=900->950MHz, and f(rel) = f(abs) - K1 * fund(pss) = 0->50MHz, because K1=9 and fund(pss) = 100MHz.

Usually it is not necessary to sweep frequency in PSP over more than one fundamental PSS period.

The freqaxis parameter is used to specify whether the results should be output versus the scattered frequency at the input port (in), the scattered frequency at the output port (out), or the absolute value of the frequency swept at the input port (absin).

Unlike in PAC/PXF/PNoise, increasing the number of requested ports and harmonics will increase the simulation time substantially.

To insure accurate results in PSP, the maxacfreq of the corresponding PSS analysis should be set to guarantee that | max{f(scattered)} | is less than maxacfreq, otherwise the computed solution might be contaminated by aliasing effects.

PSP analysis also computes noise figures, equivalent noise sources, and noise parameters. The noise computation, which is skipped only when donoise is set to no, requires additional simulation time. If

No = total output noise at frequency f

Ns = noise at the output due to the input probe (the source)

Nsi = noise at the output due to the image harmonic at the source

Nso = noise at the output due to harmonics other than input at the source

NI = noise at the output due to the output probe (the load)

IRN = input referred noise

G = gain of the circuit

F = noise factor (single side band)

Analysis Statements

```
NF = noise figure (single side band)
```

Fdsb = double sideband noise factor

NFdsb = double sideband noise figure

Fieee = IEEE single sideband noise factor

NFieee = IEEE single sideband noise figure

then,

 $IRN = sqrt(No^2/G^2)$

 $F = (No^2 - NI^2)/Ns^2$

NF = 10*log10(F)

 $Fdsb = (No^2 - NI^2)/(Ns^2 + Nsi^2)$

NFdsb = 10*log10(Fdsb)

 $Fieee = (No^2 - NI^2 - Nso^2)/Ns^2$

NFieee = 10*log10(Fieee).

When the results are output, IRN is named in, G is named gain, F, NF, Fdsb, NFdsb, Fieee, and NFieee are named F, NF, Fdsb, NFdsb, Fieee, and NFieee respectively. Note that the gain computed by PSP is the voltage gain from the actual circuit input to the circuit output, not the gain from the internal port voltage source to the output.

To insure accurate noise calculations, the maxsideband or sidebands parameters must be set to include the relevant noise folding effects. maxsideband is only relevant to the noise computation features of PSP.

You can specify sweep limits by giving the end points or by providing the center value and the span of the sweep. Steps can be linear or logarithmic, and you can specify the number of steps or the size of each step. You can give a step size parameter (step, lin, log, dec) to determine whether the sweep is linear or logarithmic. If you do not give a step size parameter, the sweep is linear when the ratio of stop to start values is less than 10, and logarithmic when this ratio is 10 or greater. Alternatively, you may specify the particular values that the sweep parameter should take using the values parameter. If you give both a specific set of values and a set specified using a sweep range, the two sets are merged and collated before being used. All frequencies are in Hertz.

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Periodic Steady-State Analysis (pss)

Description

This analysis computes the periodic steady-state (PSS) response of a circuit, with a simulation time independent of the time-constants of the circuit. Also, it sets the circuits periodic operating point, which can then be used during a periodic time-varying small-signal analysis, such as PAC, PXF, and PNOISE.

PSS analysis is capable of handling both autonomous (non-driven) and driven (non-autonomous) circuits. Autonomous circuits are time-invariant circuits that have time-varying responses. Thus, autonomous circuits generate non-constant waveforms even though they are not driven by a time-varying stimulus. Driven circuits require some time-varying stimulus to generate a time-varying response. The most common example of an autonomous circuit is an oscillator. Common driven circuits include amplifiers, filters, mixers, etc.

With driven circuits the user specifies the analysis period, or its corresponding fundamental frequency fund. The period must be an integer multiple of the period of the drive signal or signals. Autonomous circuits have no drive signal and the actual period of oscillation is not known precisely by the user in advance. Instead, the user specifies an estimate of the oscillation period and PSS analysis computes the precise period along with the periodic solution waveforms.

When applied to autonomous circuits, PSS analysis requires the user to specify a pair of nodes, p and p. In fact this is how PSS analysis determines whether it is being applied to an autonomous or a driven circuit. If the pair of nodes is supplied, PSS assumes the circuit is autonomous; if not, the circuit is assumed to be driven.

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A PSS analysis consists of two phases, an initial transient phase, which allows the circuit to be initialized, and the shooting phase, which is where the periodic steady-state solution is computed. The transient phase consists of three intervals.

The first starts at tstart, which is normally 0, and continues through the onset of periodicity tonset for the independent sources. The onset of periodicity, which is automatically generated, is the minimum time for which all sources are periodic. The second is an optional user specified stabilization interval whose length is tstab. The final interval whose length is period for driven circuits, or 4x period for autonomous circuits has a special use for the autonomous PSS analysis, i.e., the PSS analysis monitors the waveforms in the circuit and develops a better estimate of the oscillation period. Once the initial transient phase is complete, the shooting interval begins. In this phase, the circuit is repeatedly simulated over one period while adjusting the initial condition (and the period when applied to autonomous circuits) to find the periodic steady-state solution.

Typically the process takes three to five such iterations to reach steady-state. Upon completion, if requested by the user, the frequency-domain response is computed. For driven circuits, one can use writepss and readpss to reuse the results in a previous simulation.

Definition

Name [p] [n] pss parameter=value ...

Parameters

Simulation interval parameters

1	period (s)	Steady state analysis period (or its estimate for autonomous circuits).
2	fund (Hz)	Alternative to period specification. Steady state analysis fundamental frequency (or its estimate for autonomous circuits).
3	tstab=0.0 s	Extra stabilization time after the onset of periodicity for independent sources.
4	tstart=0.0 s	Initial transient analysis start time.

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Time-step parameters

5 maxstep (s) Maximum time step. Default derived from errpreset.

6 maxacfreq Maximum frequency requested in a subsequent periodic small-

signal analysis. Default derived from errpreset and harms.

7 step=0.001 period s

Minimum time step that would be used solely to maintain the

aesthetics of the results.

Initial-condition parameters

8 ic=all What should be used to set initial condition.

Possible values are dc, node, dev, or all.

9 skipdc=no If yes, there will be no dc analysis for transient.

Possible values are no or yes.

10 readic File that contains initial condition.

Convergence parameters

11 readns File that contains estimate of initial transient solution.

12 cmin=0 F Minimum capacitance from each node to ground.

Output parameters

13 harms=9 Number of harmonics to output when outputtype=freq or all.

14 harmsvec=[...] Array of desired harmonics. Alternate form of harms that allows

selection of specific harmonics.

15 outputtype=time for PSS, freq for PDISTO

Output type.

Possible values are all, time or freq.

16 save Signals to output.

Possible values are all, lvl, allpub, lvlpub, selected, or

none.

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17	nestlvl	Levels of subcircuits to output.
18	oppoint=no	Should operating point information be computed for initial timestep, and if so, where should it be sent. Possible values are no, screen, logfile, or rawfile.
19	skipstart=startti	me s The time to start skipping output data.
20	skipstop=stoptime	s The time to stop skipping output data.
21	skipcount	Save only one of every skipcount points.
22	strobeperiod (s)	The output strobe interval (in seconds of transient time).
23	strobedelay=0 s	The delay (phase shift) between the skipstart time and the first strobe point.
24	compression=no	Do data compression on output. Possible values are no or yes.
25	saveinit=no	If set, the waveforms for the initial transient before steady state are saved. Possible values are no or $_{\mbox{\scriptsize yes}}.$
Sta	te-file parameters	
26	write	File to which initial transient solution (before steady-state) is to be written.
27	writefinal	File to which final transient solution in steady-state is to be written.
28	swapfile	Temporary file that holds steady-state information. Tells Spectre to use a regular file rather than virtual memory to hold the periodic operating point. Use this option if Spectre complains about not having enough memory to complete this analysis.
29	writepss	File to which the converged steady-state solution is to be written. finitediff is set to yes automatically to improve PSS results.

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30 readpss File from which a previously converged steady-state solution is

to be read. PSS loads the solution and checks the residue of the circuit equations only. The solution is re-used if the residue is satisfying. Otherwise, the solution is re-converged using the

finite difference method.

Integration method parameters

31 method Integration method. Default derived from errpreset.

Possible values are euler, trap, traponly, gear 2, or

gear2only.

Accuracy parameters

32 errpreset=moderate

Selects a reasonable collection of parameter settings.

Possible values are liberal, moderate or conservative.

33 relref Reference used for the relative convergence criteria. Default

derived from errpreset.

Possible values are pointlocal, alllocal, sigglobal, or

allglobal.

34 Iteratio Ratio used to compute LTE tolerances from Newton tolerance.

Default derived from errpreset.

35 steadyratio Ratio used to compute steady state tolerances from LTE

tolerance. Default derived from errpreset.

36 maxperiods=20 for driven PSS, 50 for autonomous PSS

Maximum number of simulated periods to reach steady-state.

37 tolerance=1e-4 Relative tolerance for linear solver.

38 finitediff Options for finite difference method refinement after shooting

method for driven circuits.

Possible values are no, yes or refine.

39 highorder Perform a high-order refinement after low-order convergence.

The Multi-Interval Chebyshev polynomial spectral algorithm will

be used.

Possible values are no or yes.

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40 psaratio=1 Ratio used to compute high-order polynomial spectral accuracy

from Newton tolerance.

41 maxorder=16 The maximum order of the Chebyshev polynomials used in

waveform approximation. Possible values are from 2 to 16.

42 fullpssvec Use the full vector containing solutions at all PSS time steps in

the linear solver. Default derived from the size of the equation

and the property of the PSS time steps.

Possible values are no or yes.

Annotation parameters

43 stats=no Analysis statistics.

Possible values are no or yes.

44 annotate=sweep Degree of annotation.

Possible values are no, title, sweep, status, or steps.

45 title Analysis title.

Newton parameters

46 maxiters=5 Maximum number of iterations per time step.

47 restart=yes Do not use previous DC solution as initial guess.

Possible values are no or yes.

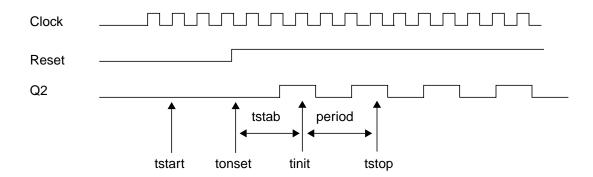
Circuit age

48 circuitage (Years) Stress Time. Age of the circuit used to simulate hot-electron degradation of MOSFET and BSIM circuits.

The initial transient analysis provides a flexible mechanism to direct the circuit to a particular steady-state solution of interest, and to avoid undesired solutions. Another usage of the initial transient simulation is helping convergence by eliminating large but fast decaying modes that

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are present in many circuits. For example, in case of driven circuits, consider the reset signal in the figure below.



In the figure above, the initial transient analysis is executed from tstart to tstop. If initial transient results are relevant, you can output them by setting saveinit to yes. The steady-state results are always computed for the specified period, from tinit to tstop. By default, tstart and tstab are set to zero, while tinit, tonset and tstop are always automatically generated.

It happens in some circuits that the linearity of the relationship between the initial and final state depends on when the shooting interval begins. Conceptually, when the shooting interval begins should not matter, as long as it is after the time when the stimuli have become periodic, because the periodic response repeats endlessly. However in practice, one can improve the convergence by starting at a good point, and degrade the convergence, which slows the analysis, by starting in a bad spot. In general, it is best to try to avoid starting the shooting interval at a point where the circuit is undergoing strong nonlinear behavior. For example, in switch-capacitor filters it is best if tinit falls at the beginning of a clock transition, preferably a transition that follows a relatively long period of settling. If instead tinit occurred during a clock transition or soon after one, then it is likely the opamps would be undergoing slew-rate limiting at the start of the shooting interval, which would act to slow convergence. Switching mixers follow similar rules.

When applying PSS analysis to oscillators, it is necessary to start the oscillator, just as you would if you were simulating the turn-on transient of the oscillator using transient analysis. The Designers Guide to Spice and Spectre [K. S. Kundert, Kluwer Academic Publishers, 1995] describes techniques for starting oscillators in some depth. In summary, there are two techniques for starting oscillators, using initial conditions, or using a brief impulsive stimulus. Initial conditions would be provided for the components of the oscillators resonator. If an impulsive stimulus is used, it should be applied so as to couple strongly into the oscillatory mode of the circuit, and poorly into any other long-lasting modes, such as those associated with bias circuitry. Either way, once the trigger is applied to start the oscillator, it is important to allow the oscillator to run for a while before the shooting methods

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are applied to compute the steady-state result. To do so, specify an additional stabilization interval using the tstab parameter. In practice, an additional stabilization interval often improves convergence.

By default, only the time-domain results are computed. If you specify either harms or harmsvec or set outputtype to freq or all, the frequency-domain results will also be computed. If frequency-domain results are requested, but the desired harmonics are not specified, its default value is 10. The time-domain output waveform generation can be inhibited by setting outputtype to freq.

The accuracy of the results does not depend on the number of harmonics that are requested, only on the accuracy parameters, which are set in the same fashion as in the transient analysis. Besides a few new parameters, like steadyratio and maxacfreq, all the others parameters work in PSS analysis in the exact same fashion as they work on transient analysis.

Several parameters determine the accuracy of the PSS analysis. reltol and abstol control the accuracy of the discretized equation solution. These parameters determine how well charge is conserved and how accurately steady-state or equilibrium points are computed. You can set the integration error, or the errors in the computation of the circuit dynamics (such as time constants), relative to reltol and abstol by setting the lteratio parameter.

The steadyratio parameter adjusts the maximum allowed mismatch in node voltages or current branches from the beginning to the end of the steady-state period. This value is multiplied by the lteratio and reltol to determine the convergence criterion. The relative convergence norm is printed out along with the actual mismatch value at the end of each iteration, thus indicating the progress of the steady-state iteration.

The finitediff parameter allows the use of finite difference (FD) after shooting. Usually this will eliminate the above mismatch in node voltages or current branches. It can also refine the grid of time steps. In some cases, numerical error of the linear solver still introduces a mismatch. One can set steadyratio to a smaller value to activate a tighter tolerance for the iterative linear solver. If finitediff is set to no, FD method is turned off. If it is set to yes, pss applies FD method and trying to improve the beginning small time steps if necessary. If it is set to refine, pss applies FD method and tries to refine the time steps. When the simulation uses 2nd-order method, uniform 2nd order gear is used. finitediff is changed from no to yes automatically when readpss and writepss are used to re-use PSS results

The maxacfreq parameter is used to automatically adjust the maxstep to reduce errors due to aliasing in frequency-domain results. By default, the maxacfreq is set to 4x the frequency of the largest requested harmonic, but is never set to less than 40x the fundamental.

The parameter relref determines how the relative error is treated. The relref options are:

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relref=pointlocal: Compares the relative errors in quantities at each node to that node alone.

relref=alllocal: Compares the relative errors at each node to the largest values found for that node alone for all past time.

relref=sigglobal: Compares relative errors in each of the circuit signals to the maximum for all signals at any previous point in time.

relref=allglobal: Same as relref=sigglobal except that it also compares the residues (KCL error) for each node to the maximum of that nodes past history.

The errpreset parameter lets you adjust the simulator parameters to fit your needs quickly. In most cases, it should also be the only parameter you need to adjust.

Guidelines for using errpreset in driven circuits are as follows. If the circuit contains only one periodic tone and you are only interested in obtaining the periodic operating point, you may set errpreset to liberal, which gives reasonably accurate result and the simulation speed is the fastest. If the circuit contains more than one periodic tone and you are interested in intermodulation results, you may set errpreset to moderate, which gives very accurate result. If you want a very low noise floor in your simulation result and accuracy is your main interest, you may set errpreset to conservative. Multi-interval Chebsyehv (MIC) is activated automatically for moderate and conservative settings, unless you set highorder=no explicitly. MIC falls back to the original method if it encounters convergence difficulty. If you set highorder=yes, MIC will try harder to converge.

The effect of errpreset on other parameters for driven circuits is shown in the following table.

Parameter Defaults and Estimated Numerical Noise Floor in Simulation Result as a Function of errpreset

errpreset	reltol	relref	method	Iteratio	steadyratio	noisefloor
liberal	1e-3	sigglobal	gear2only	3.5	0.001	-70dB
moderate	1e-3	alllocal	gear2only+mic	3.5	0.001	-120dB
conservative	1e-4	alllocal	gear2only+mic	*	0.01	-200dB

^{*:} If user specified reltol <= 1e-4*10.0/3.5, Iteratio=3.5. Otherwise Iteratio=10.0.

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Estimated numerical noise floor is for weakly nonlinear circuit with successful MIC simulation. For linear circuit, the noise floor is even lower and for very nonlinear circuit, you may need to tighten psaratio or increase maxacfreq to achieve this noise floor.

Guidelines for using errpreset in autonomous circuits are as follows. If you want a fast simulation with reasonable accuracy, you may set errpreset to liberal. If have some concern for accuracy, you may set errpreset to moderate. If accuracy is your main interest, you may set errpreset to conservative.

The effect of errpreset on other parameters for autonomous circuits is shown in the following table.

Parameter defaults as a function of errpreset

errpreset	reltol	relref	method	Iteratio	steadyratio	maxstep
liberal	1e-3	sigglobal	traponly	3.5	0.001	period/80
moderate	1e-4	alllocal	gear2only	3.5	0.001	period/200
conservative	1e-5	alllocal	gear2only	*	0.001	period/400

^{*:} If user specified reltol <= 1e-5*10.0/3.5, lteratio=3.5. Otherwise lteratio=10.0.

The value of reltol can only decrease from its value in the options statement, when reltol in options statement is larger. Spectre sets the value of maxstep so that it is no larger than the value given in the table. Except for reltol and maxstep, errpreset does not change the value of any parameters you have explicitly set. The actual values used for the PSS analysis are given in the log file.

If the circuit you are simulating can have infinitely fast transitions (for example, a circuit that contains nodes with no capacitance), Spectre might have convergence problems. To avoid this, you must prevent the circuit from responding instantaneously. You can accomplish this by setting cmin, the minimum capacitance to ground at each node, to a physically reasonable nonzero value. This often significantly improves Spectre convergence.

You may specify the initial condition for the transient analysis by using the ic statement or the ic parameter on the capacitors and inductors. If you do not specify the initial condition, the DC solution is used as the initial condition. The ic parameter on the transient analysis controls the interaction of various methods of setting the initial conditions. The effects of individual settings are:

ic=dc: Any initial condition specifiers are ignored, and the DC solution is used.

Analysis Statements

ic=node: The ic statements are used, and the ic parameter on the capacitors and inductors are ignored.

ic=dev: The ic parameters on the capacitors and inductors are used, and the ic statements are ignored.

ic=all: Both the ic statements and the ic parameters are used, and the ic parameters override the ic statements.

If you specify an initial condition file with the readic parameter, initial conditions from the file are used, and any ic statements are ignored.

Once you specify the initial conditions, Spectre computes the actual initial state of the circuit by performing a DC analysis. During this analysis, Spectre forces the initial conditions on nodes by using a voltage source in series with a resistor whose resistance is rforce (see options).

With the ic statement it is possible to specify an inconsistent initial condition (one that cannot be sustained by the reactive elements). Examples of inconsistent initial conditions include setting the voltage on a node with no path of capacitors to ground or setting the current through a branch that is not an inductor. If you initialize Spectre inconsistently, its solution jumps; that is, it changes instantly at the beginning of the simulation interval. You should avoid such changes if possible because Spectre can have convergence problems while trying to make the jump.

You can skip the DC analysis entirely by using the parameter <code>skipdc</code>. If the DC analysis is skipped, the initial solution will be either trivial, or given in the file you specified by the <code>readic</code> parameter, or, if the <code>readic</code> parameter is not given, the values specified on the ic statements. Device based initial conditions are not used for <code>skipdc</code>. Nodes that you do not specify with the <code>ic</code> file or <code>ic</code> statements will start at zero. You should not use this parameter unless you are generating a nodeset file for circuits that have trouble in the DC solution; it usually takes longer to follow the initial transient spikes that occur when the DC analysis is skipped than it takes to find the real DC solution. The <code>skipdc</code> parameter might also cause convergence problems in the transient analysis.

Nodesets help find the DC or initial transient solution. You can supply them in the circuit description file with nodeset statements, or in a separate file using the readns parameter. When nodesets are given, Spectre computes an initial guess of the solution by performing a DC analysis while forcing the specified values onto nodes by using a voltage source in series with a resistor whose resistance is rforce. Spectre then removes these voltage sources and resistors and computes the true solution from this initial guess.

Nodesets have two important uses. First, if a circuit has two or more solutions, nodesets can bias the simulator towards computing the desired one. Second, they are a convergence aid.

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By estimating the solution of the largest possible number of nodes, you might be able to eliminate a convergence problem or dramatically speed convergence.

When you simulate the same circuit many times, we suggest that you use both the write and readns parameters and give the same file name to both parameters. The DC analysis then converges quickly even if the circuit has changed somewhat since the last simulation, and the nodeset file is automatically updated.

Nodesets and initial conditions have similar implementation but produce different effects. Initial conditions actually define the solution, whereas nodesets only influence it. When you simulate a circuit with a transient analysis, Spectre forms and solves a set of differential equations. However, differential equations have an infinite number of solutions, and a complete set of initial conditions must be specified in order to identify the desired solution. Any initial conditions you do not specify are computed by the simulator to be consistent. The transient waveforms then start from initial conditions. Nodesets are usually used as a convergence aid and do not affect the final results. However, in a circuit with more than one solution, such as a latch, nodesets bias the simulator towards finding the solution closest to the nodeset values.

The method parameter specifies the integration method. The possible settings and their meanings are:

method=euler: Backward-Euler is used exclusively.

method=traponly: Trapezoidal rule is used almost exclusively.

method=trap: Backward-Euler and the trapezoidal rule are used.

method=gear2only: Gears second-order backward-difference method is used almost exclusively.

method=gear2: Backward-Euler and second-order Gear are used.

The trapezoidal rule is usually the most efficient when you want high accuracy. This method can exhibit point-to-point ringing, but you can control this by tightening the error tolerances. For this reason, though, if you choose very loose tolerances to get a quick answer, either backward-Euler or second-order Gear will probably give better results than the trapezoidal rule. Second-order Gear and backward-Euler can make systems appear more stable than they really are. This effect is less pronounced with second-order Gear or when you request high accuracy.

Spectre provides two methods for reducing the number of output data points saved: strobing, based on the simulation time, and skipping time points, which saves only every Nth point.

Analysis Statements

The parameters strobeperiod and strobedelay control the strobing method.strobeperiod sets the interval between points that you want to save, and strobedelay sets the offset within the period relative to skipstart. The simulator forces a time step on each point to be saved, so the data is computed, not interpolated.

The skipping method is controlled by skipcount. If this is set to N, then only every Nth point is saved.

The parameters skipstart and skipstop apply to both data reduction methods. Before skipstart and after skipstop, Spectre saves all computed data.

Parameter Index

In the following index, the number following each parameter name indicates where to find the description of that parameter.

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Periodic Transfer Function Analysis (pxf)

Description

A conventional transfer function analysis computes the transfer function from every source in the circuit to a single output. It differs from a conventional AC analysis in that the AC analysis

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computes the response from a single stimulus to every node in the circuit. The difference between pac and pxf analysis are similar. The Periodic Transfer Function (pxf) analysis computes the transfer functions from any source at any frequency to a single output at a single frequency. Thus, like pac analysis, pxf analysis includes frequency conversion effects.

The pxf analysis directly computes such useful quantities as conversion efficiency (transfer function from input to output at desired frequency), image and sideband rejection (input to output at undesired frequency), and LO feed-through and power supply rejection (undesired input to output at all frequencies).

As with a pac, psp, and pnoise analyses, a pxf analysis must follow a PSS analysis.

Unlike other analyses in Spectre, this analysis can only sweep frequency.

Definition

Name [p] [n] pxf parameter=value ...

The optional terminals (p and n) specify the output of the circuit. If you do not give the terminals, then you must specify the output with a probe component.

Parameters

Sweep interval parameters

1	start=0	Start sweep limit.
2	stop	Stop sweep limit.
3	center	Center of sweep.
4	span=0	Sweep limit span.
5	step	Step size, linear sweep.
6	lin=50	Number of steps, linear sweep.
7	dec	Points per decade.
8	log=50	Number of steps, log sweep.

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9 values=[]	Array of sweep values.
10 sweeptype	Specifies if the sweep frequency range is absolute frequency of input or if it is relative to the port harmonics. Possible values are absolute or relative.
11 relharmnum=1	Harmonic to which relative frequency sweep should be referenced.
Probe parameters	
12 probe	Compute every transfer function to this probe component.
Output parameters	
13 stimuli=sources	Stimuli used for xf analysis. Possible values are sources or nodes_and_terminals.
14 sidebands=[]	Array of relevant sidebands for the analysis.
15 maxsideband=0	An alternative to the sidebands array specification, which automatically generates the array: [-maxsideband 0 +maxsideband].
16 freqaxis	Specifies whether the results should be output versus the input frequency, the output frequency, or the absolute value of the input frequency. Default is out for logarithmic frequency sweeps and absin otherwise. Possible values are absin, in or out.
17 save	Signals to output. Possible values are all, lvl, allpub, lvlpub, selected, or none.
18 nestlvl	Levels of subcircuits to output.
Convergence parameters	
19 tolerance=1e-9	Relative tolerance for linear solver.
20 gear_order=2	Gear order used for small-signal integration.

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21 solver=turbo Solver type.

Possible values are std or turbo.

22 oscsolver=turbo Oscillator solver type.

Possible values are std or turbo.

Annotation parameters

23 annotate=sweep Degree of annotation.

Possible values are no, title, sweep, status, or steps.

24 stats=no Analysis statistics.

Possible values are no or yes.

25 title Analysis title.

The variable of interest at the output can be voltage or current, and its frequency is not constrained by the period of the large periodic solution. While sweeping the selected output frequency, you can select the periodic small-signal input frequencies of interest by setting either the maxsideband or the sidebands parameters. For a given set of n integer numbers representing the sidebands K1, K2, ... Kn, the input signal frequency at each sideband is computed as f(in) = f(out) + Ki * fund(pss), where f(out) represent the (possibly swept) output signal frequency, and fund(pss) represents the fundamental frequency used in the corresponding pss analysis. Thus, when analyzing a down-converting mixer, and sweeping the IF output frequency, Ki= +1 for the RF input represents the first upper-sideband, while Ki= -1 for the RF input represents the first lower-sideband. By setting the maxsideband value to Kmax, all 2 * Kmax + 1 sidebands from -Kmax to +Kmax are be selected.

The number of requested sidebands does not change substantially the simulation time. However, the maxacfreq of the corresponding pss analysis should be set to guarantee that | max{f(in)} | is less than maxacfreq, otherwise the computed solution might be contaminated by aliasing effects. The pxf simulation is not executed for | f(out) | greater than maxacfreq. Diagnostic messages are printed for those extreme cases, indicating how maxacfreq should be set in the pss analysis. In the majority of the simulations, however, this is not an issue, because maxacfreq is never allowed to be smaller than 40x the pss fundamental.

With PXF the frequency of the stimulus and of the response are usually different (this is an important way in which pxf differs from XF). The freqaxis parameter is used to specify whether the results should be output versus the input frequency (in), the output frequency (out), or the absolute value of the input frequency (absin).

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You can specify the output with a pair of nodes or a probe component. Any component with two or more terminals can be a voltage probe. When there are more than two terminals, they are grouped in pairs; and you use the porty parameter to select the appropriate pair of terminals. Alternatively, you can simply specify a voltage to be the output by giving a pair of nodes on the pxf analysis statement.

Any component that naturally computes current as an internal variable can be a current probe. If the probe component computes more than one current, you use the portiparameter to select the appropriate current. It is an error to specify both porty and portiparameter is specified, the probe component provides a reasonable default.

The stimuli parameter specifies what is used for the inputs for the transfer functions. There are two choices. stimuli=sources indicates that the sources present in the circuit should be used. The xfmag parameters provided by the sources may be used to adjust the computed gain to compensate for gains or losses in a test fixture. One can limit the number of sources in hierarchical netlists by using the save and nestlvl parameters. stimuli=nodes_and_terminals indicates that all possible transfer functions should be computed.

This is useful when it is not known in advance which transfer functions are interesting. Transfer functions for nodes are computed assuming that a unit magnitude flow (current) source is connected from the node to ground. Transfer functions for terminals are computed assuming that a unit magnitude value (voltage) source is connected in series with the terminal. By default, the transfer functions from a small set of terminals are computed. If transfer functions from specific terminals are desired, specify the terminals in the save statement. You must use the :probe modifier (for example, Rout:1:probe) or specify useprobes=yes on the options statement. If transfer functions from all terminals are desired, specify currents=all and useprobes=yes on the options statement.

You can specify sweep limits by giving the end points or by providing the center value and the span of the sweep. Steps can be linear or logarithmic, and you can specify the number of steps or the size of each step. You can give a step size parameter (step, lin, log, dec) to determine whether the sweep is linear or logarithmic. If you do not give a step size parameter, the sweep is linear when the ratio of stop to start values is less than 10, and logarithmic when this ratio is 10 or greater. Alternatively, you may specify the particular values that the sweep parameter should take using the values parameter. If you give both a specific set of values and a set specified using a sweep range, the two sets are merged and collated before being used. All frequencies are in Hertz.

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In the following index, the number following each parameter name indicates where to find the description of that parameter.

annotate 23	maxsideband 15	solver 21	sweeptype	10
center 3	nestlvl 18	span 4	title 25	
dec 7	oscsolver 22	start 1	tolerance	19
freqaxis 16	probe 12	stats 24	values 9	
gear_order 20	relharmnum 11	step 5		
lin 6	save 17	stimuli 13		
log 8	sidebands 14	stop 2		

Quasi-Periodic AC Analysis (qpac)

Description

The quasi periodic AC (QPAC) analysis is used to compute transfer functions for circuits that exhibit multitone frequency translation. Such circuits include mixers, switched-capacitor filters, samplers, phase-locked loops, and the like. It is a small-signal analysis like AC analysis, except the circuit is first linearized about a quasiperiodically varying operating point as opposed to a simple DC operating point. Linearizing about a quasiperiodically time-varying operating point allows transfer-functions that include frequency translation, whereas simply linearizing about a DC operating point could not because linear time-invariant circuits do not exhibit frequency translation. Also, the frequency of the sinusoidal stimulus is not constrained by the period of the large periodic solution.

Computing the small-signal response of a quasiperiodically varying circuit is a two step process. First, the small stimulus is ignored and the quasiperiodic steady-state response of the circuit to possibly large periodic stimuli is computed using QPSS analysis. As a normal part of the QPSS analysis, the quasiperiodically time-varying representation of the circuit is computed and saved for later use. The second step is to apply the small stimulus to the periodically varying linear representation to compute the small signal response. This is done using the QPAC analysis.

A QPAC analysis cannot be used alone, it must follow a QPSS analysis. However, any number of quasiperiodic small-signal analyses such as QPAC, QPSP, QPXF, QPNOISE, can follow a QPSS analysis.

Unlike other analyses in Spectre, this analysis can only sweep frequency.

Analysis Statements

Definition

Name qpac parameter=value ...

Parameters

Sweep interval parameters

1	start=0	Start sweep limit.
2	stop	Stop sweep limit.
3	center	Center of sweep.
4	span=0	Sweep limit span.
5	step	Step size, linear sweep.
6	lin=50	Number of steps, linear sweep.
7	dec	Points per decade.
8	log=50	Number of steps, log sweep.
9	values=[]	Array of sweep values.
10	sweeptype	Specifies if the sweep frequency range is absolute frequency of input or if it is relative to the port harmonics. Possible values are absolute or relative.
11	relharmnum=[]	Harmonic to which relative frequency sweep should be referenced.

Output parameters

12 sidevec=[]	Array of relevant sidebands for the analysis.
13 clockmaxharm=0	An alternative to the sidevec array specification, which automatically generates the array: [-clockmaxharm 0 +clockmaxharms][-maxharms(QPSS)[2]0maxharms(QPSS)[2]][].

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14 freqaxis Specifies whether the results should be output versus the input

frequency, the output frequency, or the absolute value of the output frequency. Default is in for logarithmic frequency sweeps

and absout otherwise.

Possible values are absout, out or in.

15 save Signals to output.

Possible values are all, lvl, allpub, lvlpub, selected, or

none.

16 nestlvl Levels of subcircuits to output.

17 outputperiod=0.0 (no output)

Time-domain output period. The time-domain small-signal response is computed for the period specified, rounded to the

nearest integer multiple of the pss period.

Convergence parameters

18 tolerance=1e-9 Relative tolerance for linear solver.

19 gear_order=2 Gear order used for small-signal integration, 1 or 2.

20 solver=turbo Solver type.

Possible values are std or turbo.

Annotation parameters

21 annotate=sweep Degree of annotation.

Possible values are no, title, sweep, status, or steps.

22 stats=no Analysis statistics.

Possible values are no or yes.

23 title Analysis title.

User can select the set of periodic small-signal output frequencies of interest by setting either the clockmaxharm or the sidevec parameters. Sidebands are vectors in QPAC. Assume we have one large tone and one moderate tone in QPSS. A sideband K1 will be represented as [K1_1 K1_2]. Corresponding frequency is

K1_1 * fund(large tone of QPSS) + K1_2 * fund(moderate tone of QPSS)

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We assume that there are L large and moderate tones in QPSS analysis and a given set of n integer vectors representing the sidebands

 $K1 = \{ K1_1,...K1_j..., K1_L \}$, K2, ... Kn. The output frequency at each sideband is computed as

$$f(out) = f(in) + SUM_i = 1_to_L\{Ki_j * fund_i(qpss)\},\$$

where f(in) represents the (possibly swept) input frequency, and fund_j(qpss) represents the fundamental frequency used in the corresponding QPSS analysis. Thus, when analyzing a down-converting mixer, while sweeping the RF input frequency, the most relevant sideband for IF output is { -1, 0} . When simulating an up-converting mixer, while sweeping IF input frequency, the most relevant sideband for RF output is { 1, 0}. User would enter sidevec as a sequence of integer numbers, separated by spaces. The set of vectors {1 1 0} {1 -1 0} {1 1} becomes sidevec=[1 1 0 1 -1 0 1 1 1]. For clockmaxharm, only the large tone - first fundamental will be affected by this entry, all the rest - moderate tones - will be limited by maxharms, specified for a QPSS analysis. Given maxharms=[k1max k2max ... knmax] in QPSS and clockmaxharm=Kmax all (2*Kmax +

1)*(2*k2max+1)*(2*k3max+1)*...*(2*knmax+1) sidebands are generated.

The number of requested sidebands changes substantially the simulation time. In addition, the maxacfreq of the corresponding QPSS analysis should be set to guarantee that | max{f(out)} | is less than maxacfreq, otherwise the computed solution might be contaminated by aliasing effects. The QPAC simulation is not executed for | f(in) | greater than maxacfreq. Diagnostic messages are printed for those extreme cases, indicating how maxacfreq should be set in the QPSS analysis. Usually, however, this is not an issue, because maxacfreq is never allowed to be smaller than 40x the QPSS fundamental.

With QPAC the frequency of the stimulus and of the response are usually different (this is an important way in which QPAC differs from AC). The freqaxis parameter is used to specify whether the results should be output versus the input frequency (in), the output frequency (out), or the absolute value of the output frequency (absout).

Unlike AC analysis, QPAC analysis can output the time-domain simulation results, by specifying the outputperiod parameter.

You can specify sweep limits by giving the end points or by providing the center value and the span of the sweep. Steps can be linear or logarithmic, and you can specify the number of steps or the size of each step. You can give a step size parameter (step, lin, log, dec) to determine whether the sweep is linear or logarithmic. If you do not give a step size parameter, the sweep is linear when the ratio of stop to start values is less than 10, and logarithmic when this ratio is 10 or greater. Alternatively, you may specify the particular values that the sweep parameter should take using the values parameter. If you give both a specific set of values

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and a set specified using a sweep range, the two sets are merged and collated before being used. All frequencies are in Hertz.

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In the following index, the number following each parameter name indicates where to find the description of that parameter.

annotate 21	lin 6	sidevec 12	stop 2	
center 3	log 8	solver 20	sweeptype	10
clockmaxharm 13	nestlvl 16	span 4	title 23	
dec 7	outputperiod 17	start 1	tolerance	18
freqaxis 14	relharmnum 11	stats 22	values 9	
gear_order 19	save 15	step 5		

Quasi-Periodic Noise Analysis (qpnoise)

Description

The Quasi-Periodic Noise, or QPNOISE analysis is similar to the conventional noise analysis, except that it includes frequency conversion and intermodulation effects. Hence is it useful for predicting the noise behavior of mixers, switched-capacitor filters, and other periodically or quasi-periodically driven circuits.

QPNOISE analysis linearizes the circuit about the quasi-periodic operating point computed in the prerequisite QPSS analysis. It is the quasiperiodically time-varying nature of the linearized circuit that accounts for the frequency conversion and intermodulation. In addition, the affect of a quasi-periodically time-varying bias point on the noise generated by the various components in the circuit is also included.

The time-average of the noise at the output of the circuit is computed in the form of a spectral density versus frequency. The output of the circuit is specified with either a pair of nodes or a probe component. To specify the output of a circuit with a probe, specify it using the oprobe parameter. If the output is voltage (or potential), choose a resistor or a port as the output probe. If the output is current (or flow), choose a vsource or iprobe as the output probe.

If the input-referred noise is desired, specify the input source using the iprobe parameter. Currently, only a vsource, an isource, or a port may be used as an input probe. If the input source is noisy, as is a port, the noise analysis will compute the noise factor (F) and noise figure (NF). To match the IEEE definition of noise figure, the input probe must be a port

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with no excess noise and its noisetemp must be set to 16.85C (290K). In addition, the output load must be a resistor or port and must be identified as the oprobe.

The reference sideband (refsideband) specifies which conversion gain is used when computing input-referred noise, noise factor, and noise figure. The reference sideband satisfies:

|f(input)| = |f(out) + refsideband frequency shift|.

The reference sideband option (refsidebandoption) specifies whether to consider the input at the frequency or the input at the individual quasi-periodic sideband specified. Note that Different sidebands can lead to the same frequency.

Sidebands are vectors in QPNOISE. Assume we have one large tone and one moderate tone in QPSS. A sideband Ki will be a vector [Ki_1 Ki_2]. It gives the frequency at

Ki 1 * fund(large tone of QPSS) + Ki 2 * fund(moderate tone of QPSS)

Use refsideband=[0 0 ...] when the input and output of the circuit are at the same frequency (such as with amplifiers and filters).

The noise analysis always computes the total noise at the output, which includes contributions from the input source and the output load. The amount of the output noise that is attributable to each noise source in the circuit is also computed and output individually. If the input source is identified (using iprobe) and is a vsource or isource, the input-referred noise is computed, which includes the noise from the input source itself. Finally, if the input source is identified (using iprobe) and is noisy, as is the case with ports, the noise factor and noise figure are computed. Thus if

No = total output noise

Ns = noise at the output due to the input probe (the source)

Nsi = noise at the output due to the image harmonic at the source

Nso = noise at the output due to harmonics other than input at the source

NI = noise at the output due to the output probe (the load)

IRN = input referred noise

G = gain of the circuit

F = noise factor

NF = noise figure

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Fdsb = double sideband noise factor

NFdsb = double sideband noise figure

Fieee = IEEE single sideband noise factor

NFieee = IEEE single sideband noise figure

then,

 $IRN = sqrt(No^2 / G^2)$

 $F = (No^2 - NI^2)/Ns^2$

NF = 10*log10(F)

 $Fdsb = (No^2 - NI^2)/(Ns^2 + Nsi^2)$

NFdsb = 10*log10(Fdsb)

Fieee = $(No^2 - NI^2 - Nso)/Ns^2$

NFieee = 10*log10(Fieee).

When the results are output, No is named out, IRN is named in, G is named gain, F, NF, Fdsb, NFdsb, Fieee, and NFieee are named F, NF, Fdsb, NFdsb, Fieee, and NFieee respectively.

The computation of gain and IRN in QPNOISE assumes that the circuit under test is impedance-matched to the input source. This can introduce inaccuracy into the gain and IRN computation.

Unlike other analyses in Spectre, this analysis can only sweep frequency.

Definition

Name [p] [n] qpnoise parameter=value ...

The optional terminals (p and n) specify the output of the circuit. If you do not give the terminals, then you must specify the output with a probe component.

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Parameters

Sweep interval parameters

1	start=0	Start sweep limit.
2	stop	Stop sweep limit.
3	center	Center of sweep.
4	span=0	Sweep limit span.
5	step	Step size, linear sweep.
6	lin=50	Number of steps, linear sweep.
7	dec	Points per decade.
8	log=50	Number of steps, log sweep.
9	values=[]	Array of sweep values.
10	sweeptype	Specifies if the sweep frequency range is absolute frequency of input or if it is relative to the port harmonics. Possible values are absolute or relative.
11	relharmnum=[]	Harmonic to which relative frequency sweep should be

Probe parameters

12	oprobe	Compute total noise at the output defined by this component.
13	iprobe	Refer the output noise to this component.
14	refsideband=[]	Conversion gain associated with this sideband is used when computing input-referred noise or noise figure.
15 refsidebandoption=freq		

referenced.

Whether to view the sideband as a specification of a frequency or a specification of an individual sideband.

Possible values are freq or individual.

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Output parameters

16 clockmaxharm=7 Maximum clock harmonics range included when computing

noise either up-converted or down-converted to the output by the

periodic drive signal..

17 sidevec=[...] Array of relevant sidebands for the analysis.

18 save Signals to output.

Possible values are all, lvl, allpub, lvlpub, selected, or

none.

19 nestlvl Levels of subcircuits to output.

20 saveallsidebands=no

Save noise contributors by sideband.

Possible values are no or yes.

Convergence parameters

21 tolerance=1e-9 Relative tolerance for linear solver.

22 gear_order=2 Gear order used for small-signal integration, 1 or 2.

23 solver=turbo Solver type.

Possible values are std or turbo.

Annotation parameters

24 annotate=sweep Degree of annotation.

Possible values are no, title, sweep, status, or steps.

25 stats=no Analysis statistics.

Possible values are no or yes.

26 title Analysis title.

In practice, noise can mix with each of the harmonics of the quasi-periodic drive signal applied in the QPSS analysis and end up at the output frequency. The QPNOISE analysis only includes the noise that mixes with a finite set of harmonics that are specified using the clockmaxharm and sidevec parameters. Sidebands are vectors in quasi-periodic analyses. For one large tone and one moderate tone in QPSS, a sideband K1 will be represented as [K1_1 K1_2]. Corresponding frequency shift is

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K1_1 * fund(large tone of QPSS) + K1_2 * fund(moderate tone of QPSS)

We assume that there are L large and moderate tones in QPSS analysis and a given set of n integer vectors representing the sidebands

$$K1 = \{ K1_1, ..., K1_j, ..., K1_L \},$$

K2, ... Kn.

If Ki represents sideband i, then

The clockmaxharm parameter only affects clock frequency. It can be less or more than maxharms[1] in QPSS.Moderate tones are limited by maxharms specified in QPSS.If selected sidebands are specified using the sidevec parameter, then only those are included in the calculation. Care should be taken when specifying the sidevec or clockmaxharm QPNOISE and maxharms in QPSS. Noise results will be in error if you do not include a sideband that contributes significant noise to the output.

The number of requested sidebands will change substantially the simulation time.

You can specify sweep limits by giving the end points or by providing the center value and the span of the sweep. Steps can be linear or logarithmic, and you can specify the number of steps or the size of each step. You can give a step size parameter (step, lin, log, dec) to determine whether the sweep is linear or logarithmic. If you do not give a step size parameter, the sweep is linear when the ratio of stop to start values is less than 10, and logarithmic when this ratio is 10 or greater. Alternatively, you may specify the particular values that the sweep parameter should take using the values parameter. If you give both a specific set of values and a set specified using a sweep range, the two sets are merged and collated before being used. All frequencies are in Hertz.

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In the following index, the number following each parameter name indicates where to find the description of that parameter.

annotate 24	log 8	saveallsidebands 20	stop 2	
center 3	nestlvl 19	sidevec 17	sweeptype	10
clockmaxharm 16	oprobe 12	solver 23	title 26	
dec 7	refsideband 14	span 4	tolerance	21
gear_order 22	refsidebandoption 15	start 1	values 9	

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iprobe 13 relharmnum 11 stats 25 lin 6 save 18 step 5

Quasi-Periodic S-Parameter Analysis (qpsp)

Description

The quasi periodic SP (QPSP) analysis is used to compute scattering and noise parameters for n-port circuits that exhibit frequency translation. Such circuits include mixers, switched-capacitor filters, samplers, phase-locked loops, and the like. It is a small-signal analysis like SP analysis, except, as in QPAC and QPXF, the circuit is first linearized about a quasiperiodically varying operating point as opposed to a simple DC operating point. Linearizing about a quasiperiodically time-varying operating point allows the computation of S-parameters between circuit ports that convert signals from one frequency band to another. QPSP can also calculate noise parameters in frequency-converting circuits. QPSP computes noise figure (both single-sideband and double-sideband), input referred noise, equivalent noise parameters, and noise correlation matrices. As in QPNOISE, but unlike SP, the noise features of the QPSP analysis include noise folding effects due to the periodically time-varying nature of the circuit.

Computing the n-port S-parameters and noise parameters of a quasiperiodically varying circuit is a two step process. First, the small stimulus is ignored and the quasiperiodic steady-state response of the circuit to possibly large periodic stimulus is computed using QPSS analysis. As a normal part of the QPSS analysis, the quasiperiodically time-varying representation of the circuit is computed and saved for later use. The second step is applying small-signal excitations to compute the n-port S-parameters and noise parameters. This is done using the QPSP analysis. A QPSP analysis cannot be used alone, it must follow a QPSS analysis. However, any number of periodic small-signal analyses such as QPAC, QPSP, QPXF, QPNOISE, can follow a single QPSS analysis.

Unlike other analyses in Spectre, this analysis can only sweep frequency.

Analysis Statements

Definition

Name qpsp parameter=value ...

Parameters

Sweep interval parameters

1	start=0	Start sweep limit.
2	stop	Stop sweep limit.
3	center	Center of sweep.
4	span=0	Sweep limit span.
5	step	Step size, linear sweep.
6	lin=50	Number of steps, linear sweep.
7	dec	Points per decade.
8	log=50	Number of steps, log sweep.
9	values=[]	Array of sweep values.
10 sweeptype		Specifies if the sweep frequency range is absolute frequency of input or if it is relative to the port harmonics. Possible values are absolute or relative.

Port parameters

11 ports=[]	List of active ports. Ports are numbered in the order given. For
	purposes of noise figure computation, the input is considered port 1 and the output is port 2.
	port i and the output is port 2.

12 portharmsvec=[...]List of harmonics active on specified list of ports. Must have a one-to-one correspondence with the ports vector.

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13 harmsvec=[...] List of harmonics combinations, in addition to ones associated

with specific ports by portharmsvec, that are active. Call them

secondary...

Output parameters

14 fregaxis Specifies whether the results should be output versus the input

frequency, the output frequency, or the absolute value of the

input frequency. Default is in.

Possible values are absin, in or out.

Noise parameters

15 donoise=yes Perform noise analysis. If oprobe is specified as a valid port, this

is set to yes, and a detailed noise output is generated.

Possible values are no or yes.

Probe parameters

16 clockmaxharm=7 Maximum clock harmonics range included when computing

noise either up-converted or down-converted to the output by the

periodic drive signal..

Convergence parameters

17 tolerance=1e-9 Relative tolerance for linear solver.

18 gear_order=2 Gear order used for small-signal integration, 1 or 2.

19 solver=turbo Solver type.

Possible values are std or turbo.

Annotation parameters

20 annotate=sweep Degree of annotation.

Possible values are no, title, sweep, status, or steps.

21 stats=no Analysis statistics.

Possible values are no or yes.

22 title Analysis title.

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To specify the QPSP analysis the port and port harmonics combinations must be specified. You can select the ports of interest by setting the port parameter and the set of periodic small-signal output frequencies of interest by setting the portharmsvec or the harmsvec parameters. Sidebands are vectors in QPSP. Assume we have one large tone and one moderate tone in QPSS. A sideband K1 will be represented as [K1_1 K1_2]. Corresponding frequency is

K1_1 * fund(large tone of QPSS) + K1_2 * fund(moderate tone of QPSS)

We assume that there are L (1 large plus L-1 moderate) tones in QPSS analysis and a given set of n integer vectors representing the sidebands

$$K1 = \{ K1_1, ..., K1_j, ..., K1_L \}, K2, ..., Kn.$$

integer numbers representing the harmonics K_1, K_2, ... K_n, the scattering parameters at each port are computed at the frequencies

where f(rel) represents the relative frequency of a signal incident on a port, f(scattered) represents the frequency to which the relevant scattering parameter represents the conversion, and fund_j(qpss) represents the fundamental frequency used in the corresponding QPSS analysis.

Thus, when analyzing a down-converting mixer, with signal in the upper sideband, and sweeping the RF input frequency, the most relevant harmonic for RF input is Ki= $\{1,0\}$ and for IF output Ki= $\{0,0\}$. Hence we can associate K2= $\{1,0\}$ with the IF port and K1= $\{0,0\}$ with the RF port. S21 will represent the transmission of signal from the RF to IF, and S11 the reflection of signal back to the RF port. If the signal was in the lower sideband, then a choice of K1= $\{-1,0\}$ would be more appropriate.

Either the portharmsvec or the harmsvec parameters can be used to specify the harmonics of interest. If portharmsvec is given, the harmonics must be in one-to-one correspondence with the ports, with each harmonic associated with a single port. If harmonics are specified in the optional harmsvec parameter, then all possible frequency-translating scattering parameters associated with the specified harmonics are computed.

With QPSP the frequency of the input and of the response are usually different (this is an important way in which QPSP differs from SP). Because the QPSP computation involves inputs and outputs at frequencies that are relative to multiple harmonics, the freqaxis and sweeptype parameters behave somewhat differently in QPSP than in QPAC and QPXF.

The sweeptype parameter controls the way the frequencies in the QPSP analysis are swept. Specifying a relative sweep indicates to sweep relative to the analysis harmonics (not the QPSS fundamental) and an absolute sweep is a sweep of the absolute input source

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frequency. For example, with a QPSS fundamentals of 1000MHz and 900MHz, the portharmsvec set to $[0\ 1\ 1\ -1]$ to examine a downconverting mixer, sweeptype=relative, and a sweep range of f(rel)=0->50MHz, then S21 would represent the strength of signal transmitted from the input port in the range 900->950MHz to the output port at frequencies 100->150MHz. Using sweeptype=absolute and sweeping the frequency from 900->950MHz would calculate the same quantities, since f(abs)=900->950MHz, and $f(rel)=f(abs)-(K1\ *fund_1(qpss)+K2\ *fund_2(qpss)=0->50MHz$, because K1=0, K2=1 and fund_1(qpss)= 1000MHz, fund f(rel)=f(abs)=

Usually it is not necessary to sweep frequency in QPSP over more than one period of large (clock) fundamental in QPSS.

The freqaxis parameter is used to specify whether the results should be output versus the scattered frequency at the input port (in), the scattered frequency at the output port (out), or the absolute value of the frequency swept at the input port (absin).

An increase in the number of requested ports and harmonics will increase the simulation time substantially.

To insure accurate results in QPSP, the maxacfreq of the corresponding PSS analysis should be set to guarantee that | max{f(scattered)} | is less than maxacfreq, otherwise the computed solution might be contaminated by aliasing effects.

QPSP analysis also computes noise figures, equivalent noise sources, and noise parameters. The noise computation, which is skipped only when donoise is set to no, requires additional simulation time. If

No = total output noise at frequency f

Ns = noise at the output due to the input probe (the source)

Nsi = noise at the output due to the image harmonic at the source

Nso = noise at the output due to harmonics other than input at the source

NI = noise at the output due to the output probe (the load)

IRN = input referred noise

G = gain of the circuit

F = noise factor (single side band)

NF = noise figure (single side band)

Fdsb = double sideband noise factor

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```
NFdsb = double sideband noise figure

Fieee = IEEE single sideband noise factor

NFieee = IEEE single sideband noise figure
```

then.

 $F = (No^2 - NI^2)/Ns^2$ NF = 10*log10(F)

 $Fdsb = (No^2 - NI^2)/(Ns^2 + Nsi^2)$

NFdsb = 10*log10(Fdsb)

 $IRN = sqrt(No^2 / G^2)$

 $Fieee = (No^2 - NI^2 - Nso)/Ns^2$

NFieee = 10*log10(Fieee).

When the results are output, IRN is named in, G is named gain, F, NF, Fdsb, NFdsb, Fieee, and NFieee are named F, NF, Fdsb, NFdsb, Fieee, and NFieee respectively. Note that the gain computed by QPSP is the voltage gain from the actual circuit input to the circuit output, not the gain from the internal port voltage source to the output.

To insure accurate noise calculations, the clockmaxharm parameters must be set to include the relevant noise folding effects. clockmaxharm is only relevant to the noise computation features of QPSP.

You can specify sweep limits by giving the end points or by providing the center value and the span of the sweep. Steps can be linear or logarithmic, and you can specify the number of steps or the size of each step. You can give a step size parameter (step, lin, log, dec) to determine whether the sweep is linear or logarithmic. If you do not give a step size parameter, the sweep is linear when the ratio of stop to start values is less than 10, and logarithmic when this ratio is 10 or greater. Alternatively, you may specify the particular values that the sweep parameter should take using the values parameter. If you give both a specific set of values and a set specified using a sweep range, the two sets are merged and collated before being used. All frequencies are in Hertz.

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Parameter Index

In the following index, the number following each parameter name indicates where to find the description of that parameter.

annotate 20	gear_order 18	solver 19	sweeptype	10
center 3	harmsvec 13	span 4	title 22	
clockmaxharm 16	lin 6	start 1	tolerance	17
dec 7	log 8	stats 21	values 9	
donoise 15	portharmsvec 12	step 5		
fregaxis 14	ports 11	stop 2		

Quasi-Periodic Steady State Analysis (qpss)

Description

Similar to PAC analysis, the periodic distortion (PDISTO) analysis calculates responses of a circuit that exhibits frequency translations. However, instead of having small signal linear behavior, it models the response as having components of a few harmonics of input signal frequencies. This allows computing responses to moderately large input signals. An example is intermodulation distortion with two moderate input signals. PDISTO treats one particular input signal (usually the one that causes the most nonlinearity or the largest response) as the large signal, and the others as moderate signals.

An initial transient analysis is carried out by first suppressing all moderate input signals. Then we run a number of (at least 2) stable iterations with all signals activated, which is followed by shooting Newton method. PDISTO employs the Mixed Frequency Time (MFT) algorithm extended to multiple fundamental frequencies. For details of MFT algorithm, please see Steady-State Methods for Simulating Analog and Microwave Circuits, by K. S. Kundert, J. K. White, and A. Sangiovanni-Vincentelli, Kluwer, Boston, 1990.

Like PSS, PDISTO uses shooting Newton method as its backbone. However, instead of doing a single transient integration, each Newton iteration does a number of transient integrations of one large signal period.

Each of the integrations differs by a phase-shift in each moderate input signal. The number of integrations is determined by the numbers of harmonics of moderate fundamentals specified by the user. Given maxharms=[k1 k2 ... kn], the total number of integrations is (2*k2+1)*(2*k3+1)*...*(2*kn+1). As one consequence, the efficiency of the algorithm depends significantly on the number of harmonics required to model the responses of moderate fundamentals. As another consequence, the number of harmonics of the large fundamental

Analysis Statements

does not significantly affect the efficiency of the shooting algorithm. The boundary conditions of a shooting interval are such that the time domain integrations are consistent with a frequency domain transformation with a shift of one large signal period.

PDISTO inherits a majority of PSS parameters. A few new parameters are added. The most important ones are funds and maxharms. They replace PSS parameters, fund(or period) and harms, respectively. The funds parameter accepts a list of names of fundamentals that are present in the sources. These names are specified in the sources by parameter fundname. The first fundamental is considered as the large signal. A few heuristics can be used for picking the large fundamental.

- (1) Pick the one which is not a sinusoidal.
- (2) Pick the one which causes the most nonlinearity.
- (3) Pick the one which causes the largest response.

The maxharms parameter accepts a list of numbers of harmonics that are required to sufficiently model responses due to different fundamentals.

Definition

Name qpss parameter=value ...

Parameters

Distortion fundamental parameters

1	funds=[]	Array of fundamental frequency names for fundamentals to use
		in analysis.

2 maxharms=[]	Array of number of harmonics of each fundamental to consider
	for each fundamental.

Simulation interval parameters

3	tstab=0.0 s	Extra stabilization time after the onset of periodicity for
		independent sources.

4 tstart=0.0 s Initial transient analysis start time.

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Time-step parameters

5 maxstep (s) Maximum time step. Default derived from errpreset.

6 step=0.001 period s

Minimum time step that would be used solely to maintain the

aesthetics of the results.

Initial-condition parameters

7 ic=all What should be used to set initial condition.

Possible values are dc, node, dev, or all.

8 skipdc=no If yes, there will be no dc analysis for transient.

Possible values are no or yes.

9 readic File that contains initial condition.

Convergence parameters

10 readns File that contains estimate of initial transient solution.

11 cmin=0 F Minimum capacitance from each node to ground.

Output parameters

12 outputtype=time for PSS, freq for PDISTO

Output type.

Possible values are all, time or freq.

13 save Signals to output.

Possible values are all, lvl, allpub, lvlpub, selected, or

none.

14 nestlvl Levels of subcircuits to output.

15 oppoint=no Should operating point information be computed for initial

timestep, and if so, where should it be sent.

Possible values are no, screen, logfile, or rawfile.

16 skipstart=starttime s

The time to start skipping output data.

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47		
17	skipstop=stoptime	ď
	brightop-beoperme	

The time to stop skipping output data.

18 skipcount Save only one of every skipcount points.

19 strobeperiod (s) The output strobe interval (in seconds of transient time).

20 strobedelay=0 s The delay (phase shift) between the skipstart time and the first

strobe point.

21 compression=no Do data compression on output.

Possible values are no or yes.

22 saveinit=no If set, the waveforms for the initial transient before steady state

are saved.

Possible values are no or yes.

State-file parameters

23 write File to which initial transient solution (before steady-state) is to

be written.

24 writefinal File to which final transient solution in steady-state is to be

written.

25 swapfile Temporary file that holds steady-state information. Tells Spectre

to use a regular file rather than virtual memory to hold the periodic operating point. Use this option if Spectre complains about not having enough memory to complete this analysis.

Integration method parameters

26 method Integration method. Default derived from errpreset.

Possible values are euler, trap, traponly, gear 2, or

gear2only.

Accuracy parameters

27 errpreset=moderate

Selects a reasonable collection of parameter settings.

Possible values are liberal, moderate or conservative.

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28	relref	Reference used for the relative convergence criteria. Default derived from errpreset. Possible values are pointlocal, alllocal, sigglobal, or allglobal.
29	lteratio	Ratio used to compute LTE tolerances from Newton tolerance. Default derived from errpreset.
30	steadyratio	Ratio used to compute steady state tolerances from LTE tolerance. Default derived from errpreset.
31	maxperiods=20 for	driven PSS, 50 for autonomous PSS Maximum number of simulated periods to reach steady-state.
32	tolerance=1e-4	Relative tolerance for linear solver.
33	finitediff	Options for finite difference method refinement after quasi- periodic shooting method. finitediff is changed from no to samegrid automatically when readqpss and writeqpss are used to re-use QPSS results.

Annotation parameters

34 stats=no	Analysis statistics.
77 50005-110	สเเดเขอเอ อเดเเอเเบอ.

Possible values are no or yes.

Possible values are no, yes or refine.

35 annotate=sweep Degree of annotation.

Possible values are no, title, sweep, status, or steps.

36 title Analysis title.

Newton parameters

37 maxiters=5 Maximum number of iterations per time step.

38 restart=yes Do not use previous DC solution as initial guess.

Possible values are no or yes.

Analysis Statements

Circuit age

39 circuitage (Years) Stress Time. Age of the circuit used to simulate hot-electron degradation of MOSFET and BSIM circuits.

40 writegpss File to which final quasi-periodic steady-state solution is to be

written. Small signal analyses such as qpac, qpxf and qpnoise can read in the steady-state solution from this file directly instead

of running the qpss analysis again.

41 readqpss File from which final quasi-periodic steady-state solution is to be

read. Small signal analyses such as qpac, qpxf and qpnoise can read in the steady-state solution from this file directly instead of

running the qpss analysis again.

Most of PDISTO analysis parameters are inherited from PSS analysis, and their meanings remain essentially unchanged. Two new important parameters are funds and maxharms. They replace and extend the role of fund and harms parameters of PSS analysis. One important difference is that funds accepts a list of fundamental names instead of actual frequencies. The frequencies associated with fundamentals are figured out automatically by the simulator. An important feature is that each input signal can be a composition of more than one sources. However, these sources must have the same fundamental name. For each fundamental name, its fundamental frequency is the greatest common factor of all frequencies associated with the name. Missing or not listing all fundamental names using the parameter funds will result in an amputation of the current simulation. However if maxharms is not given, a warning message will be issued, and the number of harmonics is defaulted to 1 for each of the fundamentals.

The role of some PSS parameters is extended. The parameter maxperiods that controls the maximum number of shooting iterations for PSS analysis also controls the number of the maximum number of shooting iterations for PDISTO analysis.

The tstab parameter controls both the length of the initial transient integration with only the clock tone activated and the number of stable iterations with moderate tones activated. The stable iterations are run before Newton iterations.

The errpreset parameter lets you adjust the simulator parameters to fit your needs quickly. In most cases, it should also be the only parameter you need to adjust. If you want a fast simulation with reasonable accuracy, you may set errpreset to liberal. If have some concern for accuracy, you may set errpreset to moderate. If accuracy is your main interest, you may set errpreset to conservative.

If users dont specify steadyratio, it is always 1.0, not affected by errpreset. The effect of errpreset on other parameters is shown in the following table.

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Parameter defaults as a function of errpreset

check siggloaal??

errpreset	reltol	relref	method	Iteratio	maxstep
liberal	1e-3	sigglobal	gear2only	3.5	clock period/80
moderate	1e-4	siggloaal	gear2only	3.5	clock period/100
conservative	1e-5	sigglobal	gear2only	*	clock period/200

^{*:} If user specified reltol <= 1e-5*10.0/3.5, lteratio=3.5. Otherwise lteratio=10.0.

The value of reltol can only decrease from its value in the options statement, when reltol in options statement is larger. Spectre sets the value of maxstep so that it is no larger than the value given in the table. Except for reltol and maxstep, errpreset does not change the value of any parameters you have explicitly set. The actual values used for the QPSS analysis are given in the log file.

Parameter Index

In the following index, the number following each parameter name indicates where to find the description of that parameter.

annotate 35	maxiters 37	restart 38	strobeperiod 19
circuitage 39	maxperiods 31	save 13	swapfile 25
cmin 11	maxstep 5	saveinit 22	title 36
compression 21	method 26	skipcount 18	tstab 3
errpreset 27	nestlvl 14	skipdc 8	tstart 4
finitediff 33	oppoint 15	skipstart 16	write 23
funds 1	outputtype 12	skipstop 17	writefinal 24
ic 7	readic 9	stats 34	writeqpss 40
itres 32	readns 10	steadyratio 30	
lteratio 29	readqpss 41	step 6	
maxharms 2	relref 28	strobedelay 20	

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Quasi-Periodic Transfer Function Analysis (qpxf)

Description

A conventional transfer function analysis computes the transfer function from every source in the circuit to a single output. It differs from a conventional AC analysis in that the AC analysis computes the response from a single stimulus to every node in the circuit. The difference between QPAC and QPXF analysis are similar. The Quasi Periodic Transfer Function or QPXF analysis computes the transfer functions from any source at any frequency to a single output at a single frequency. Thus, like QPAC analysis, QPXF analysis includes frequency conversion effects.

The QPXF analysis directly computes such useful quantities as conversion efficiency (transfer function from input to output at desired frequency), image and sideband rejection (input to output at undesired frequency), and LO feed-through and power supply rejection (undesired input to output at all frequencies).

As with a QPAC, QPSP, and QPNOISE analyses, a QPXF analysis must follow a QPSS analysis.

Unlike other analyses in Spectre, this analysis can only sweep frequency.

Definition

Name [p] [n] qpxf parameter=value ...

The optional terminals (p and n) specify the output of the circuit. If you do not give the terminals, then you must specify the output with a probe component.

Parameters

4 span=0

Sweep interval parameters

1	start=0	Start sweep limit.
2	stop	Stop sweep limit.
3	center	Center of sweep.

Sweep limit span.

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5	step	Step size, linear sweep.
6	lin=50	Number of steps, linear sweep.
7	dec	Points per decade.
8	log=50	Number of steps, log sweep.
9	values=[]	Array of sweep values.
10	sweeptype	Specifies if the sweep frequency range is absolute frequency of input or if it is relative to the port harmonics. Possible values are absolute or relative.

11 relharmnum=[...] Harmonic to which relative frequency sweep should be referenced.

Probe parameters

12 probe Compute every transfer function to this probe component.

Output parameters

17 save

13 stimuli=source	Stimuli used for xf analysis. Possible values are sources or nodes_and_terminals.
14 sidevec=[]	Array of relevant sidebands for the analysis.
15 clockmaxharm=0	An alternative to the sidevec array specification, which automatically generates the array: [-clockmaxharm 0 +clockmaxharms][-maxharms(QPSS)[2]0maxharms(QPSS)[2]][].
16 freqaxis	Specifies whether the results should be output versus the input frequency, the output frequency, or the absolute value of the input frequency. Default is out for logarithmic frequency sweeps and absin otherwise. Possible values are absin, in or out.

Possible values are all, lvl, allpub, lvlpub, selected, or

none.

Signals to output.

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18 nestlvl Levels of subcircuits to output.

Convergence parameters

19 tolerance=1e-9 Relative tolerance for linear solver.

20 gear_order=2 Gear order used for small-signal integration, 1 or 2.

21 solver=turbo Solver type.

Possible values are std or turbo.

Annotation parameters

22 annotate=sweep Degree of annotation.

Possible values are no, title, sweep, status, or steps.

23 stats=no Analysis statistics.

Possible values are no or yes.

24 title Analysis title.

The variable of interest at the output can be voltage or current, and its frequency is not constrained by the period of the large periodic solution. While sweeping the selected output frequency, you can select the periodic small-signal input frequencies of interest by setting either the clockmaxharm or the sidevec parameters. Sidebands are vectors in QPXF. Assume we have one large tone and one moderate tone in QPSS. A sideband K1 will be represented as [K1_1 K1_2]. Corresponding frequency is

We assume that there are L (1 large plus L-1 moderate) tones in QPSS analysis and a given set of n integer vectors representing the sidebands

$$K1 = \{ K1_1, ..., K1_j, K1_L \}, K2, ..., Kn.$$

The input signal frequency at each sideband is computed as

$$f(in) = f(out) + SUM_i = 1_to_L\{K_i i * fund_i(qpss)\},$$

where f(out) represent the (possibly swept) output signal frequency, and fund_j(pss) represents the fundamental frequency used in the corresponding QPSS analysis. Thus, when analyzing a down-converting mixer, and sweeping the IF output frequency, Ki= {1, 0} for

Analysis Statements

the RF input represents the first upper-sideband, while Ki= {-1, 0} for the RF input represents the first lower-sideband.

User would enter sidevec as a sequence of integer numbers, separated by spaces. The set of vectors {1 1 0} {1 -1 0} {1 1 1} becomes sidevec=[1 1 0 1 -1 0 1 1 1]. For clockmaxharm, only the large tone - first fundamental will be affected by this entry, all the rest - moderate tones - will be limited by maxharms, specified for a QPSS analysis. Given maxharms=[k1max k2max ... knmax] in QPSS and clockmaxharm=Kmax all (2*Kmax + 1)*(2*k3max+1)*...*(2*knmax+1) sidebands are generated.

The number of requested sidebands changes substantially the simulation time. In addition, the maxacfreq of the corresponding QPSS analysis should be set to guarantee that | max{f(in)} | is less than maxacfreq, otherwise the computed solution might be contaminated by aliasing effects. The QPXF simulation is not executed for | f(out) | greater than maxacfreq. Diagnostic messages are printed for those extreme cases, indicating how maxacfreq should be set in the QPSS analysis. In the majority of the simulations, however, this is not an issue, because maxacfreq is never allowed to be smaller than 40x the QPSS fundamental.

With QPXF the frequency of the stimulus and of the response are usually different (this is an important way in which QPXF differs from XF). The freqaxis parameter is used to specify whether the results should be output versus the input frequency (in), the output frequency (out), or the absolute value of the input frequency (absin).

You can specify the output with a pair of nodes or a probe component. Any component with two or more terminals can be a voltage probe. When there are more than two terminals, they are grouped in pairs; and you use the porty parameter to select the appropriate pair of terminals. Alternatively, you can simply specify a voltage to be the output by giving a pair of nodes on the QPXF analysis statement.

Any component that naturally computes current as an internal variable can be a current probe. If the probe component computes more than one current, you use the portiparameter to select the appropriate current. It is an error to specify both porty and portiparameter is specified, the probe component provides a reasonable default.

The stimuli parameter specifies what is used for the inputs for the transfer functions. There are two choices. stimuli=sources indicates that the sources present in the circuit should be used. The xfmag parameters provided by the sources may be used to adjust the computed gain to compensate for gains or losses in a test fixture. One can limit the number of sources in hierarchical netlists by using the save and nestlvl parameters. stimuli=nodes_and_terminals indicates that all possible transfer functions should be computed.

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This is useful when it is not known in advance which transfer functions are interesting. Transfer functions for nodes are computed assuming that a unit magnitude flow (current) source is connected from the node to ground. Transfer functions for terminals are computed assuming that a unit magnitude value (voltage) source is connected in series with the terminal. By default, the transfer functions from a small set of terminals are computed. If transfer functions from specific terminals are desired, specify the terminals in the save statement. You must use the :probe modifier (for example, Rout:1:probe) or specify useprobes=yes on the options statement. If transfer functions from all terminals are desired, specify currents=all and useprobes=yes on the options statement.

You can specify sweep limits by giving the end points or by providing the center value and the span of the sweep. Steps can be linear or logarithmic, and you can specify the number of steps or the size of each step. You can give a step size parameter (step, lin, log, dec) to determine whether the sweep is linear or logarithmic. If you do not give a step size parameter, the sweep is linear when the ratio of stop to start values is less than 10, and logarithmic when this ratio is 10 or greater. Alternatively, you may specify the particular values that the sweep parameter should take using the values parameter. If you give both a specific set of values and a set specified using a sweep range, the two sets are merged and collated before being used. All frequencies are in Hertz.

Parameter Index

In the following index, the number following each parameter name indicates where to find the description of that parameter.

annotate 22	lin 6	sidevec 14	stimuli 13
center 3	log 8	solver 21	stop 2
clockmaxharm 15	nestlvl 18	span 4	sweeptype 10
dec 7	probe 12	start 1	title 24
freqaxis 16	relharmnum 11	stats 23	tolerance 19
gear order 20	save 17	step 5	values 9

Deferred Set Options (set)

Description

The deferred set options statement sets or changes various program control options. You can set the options in any order and, once set, the options retain their value until reset. The set statement is queued with all analyses and is executed sequentially (The changes made to these options are deferred until the statement setting them is encountered). To set temp,

Analysis Statements

tnom, scalem, or scale, use the alter statement. For further options, see individual analyses.

Definition

Name set parameter=value ...

Parameters

Tolerance parameters

1	reltol=0.001	Relative convergence criterion.
---	--------------	---------------------------------

2 vabstol=1e-06 V Voltage absolute tolerance convergence criterion.

3 iabstol=1e-12 A Current absolute tolerance convergence criterion.

Temperature parameters

4 tempeffects=all Temperature effect selector.

Possible values are vt, tc or all.

Convergence parameters

5 homotopy=all Method used when no convergence on initial attempt of DC

analysis.

Possible values are none, gmin, source, dptran, ptran,

arclength, or all.

6 limit=dev Limiting algorithms to aid DC convergence.

Possible values are delta, log or dev.

Component parameters

7 compatible=spectre

Encourage device equations to be compatible with a foreign

simulator. This option does not affect input syntax.

Possible values are spectre, spice2, spice3, cdsspice,

hspice, or spiceplus.

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8 approx=no Use approximate models. Difference between approximate and

exact models is generally very small.

Possible values are no or yes.

Error-checking parameters

9 diagnose=no Print additional information that might help diagnose accuracy

and convergence problems. Possible values are no or yes.

10 opptcheck=yes Check operating point parameters against soft limits.

Possible values are no or yes.

Resistance parameters

11 gmin=1e-12 S Minimum conductance across each nonlinear device.

12 gmin_check=max_v_only

Specifies that effect of gmin should be reported if significant.

Possible values are no, max_v_only, max_only, or all.

13 rforce=1 Ω Resistance used when forcing nodesets and node-based initial

conditions.

Quantity parameters

14 quantities=no Print quantities.

Possible values are no, min or full.

Annotation parameters

15 narrate=yes Narrate the simulation.

Possible values are no or yes.

16 debug=no Give debugging messages.

Possible values are no or yes.

17 info=yes Give informational messages.

Possible values are no or yes.

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18 note=yes	Give notice messages. Possible values are no or yes.
19 maxnotes=5	Maximum number of times any notice will be issued per analysis.
20 warn=yes	Give warning messages. Possible values are no or yes.
21 maxwarns=5	Maximum number of times any warning message will be issued per analysis.
22 error=yes	Give error messages. Possible values are no or yes.
23 digits=5	Number of digits used when printing numbers.
24 notation=eng	When printing real numbers to the screen, what notation should be used. Possible values are eng, sci or float.
25 annotate=no	Degree of annotation. Possible values are no or title.
Matrix parameters	
26 pivotdc=no	Use numeric pivoting on every iteration of DC analysis. Possible values are no or yes.
27 pivrel=0.001	Relative pivot threshold.
28 pivabs=0	Absolute pivot threshold.

Parameter Index

In the following index, the number following each parameter name indicates where to find the description of that parameter.

annotate 25	gmin 11	maxwarns 21	pivrel 27	
approx 8	gmin_check 12	narrate 15	quantities 14	4
compatible 7	homotopy 5	notation 24	reltol 1	
debug 16	iabstol 3	note 18	rforce 13	

Analysis Statements

diagnose 9	info 17	opptcheck 10	tempeffects 4
digits 23	limit 6	pivabs 28	vabstol 2
error 22	maxnotes 19	pivotdc 26	warn 20

Shell Command (shell)

Description

The shell analysis passes a command to the operating system command interpreter given in the SHELL environment variable. The command behaves as if it were typed into the command interpreter, except that any %X codes in the command are expanded first.

The default action of the shell analysis is to terminate the simulation.

Definition

Name shell parameter=value ...

Parameters

1	cmd="kill %P"	Shell command.
2	iferror=quit	What to do if command returns nonzero error status. Possible values are quit or continue.
3	annotate	Degree of annotation. Possible values are no, title or yes.

S-Parameter Analysis (sp)

Description

The S-parameter analysis linearizes the circuit about the DC operating point and computes S-parameters of the circuit taken as an N-port. The port statements define the ports of the circuit. Each active port is turned on sequentially, and a linear small-signal analysis is performed. Spectre converts the response of the circuit at each active port into S-parameters and outputs these parameters. There must be at least one active port statement in the circuit.

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If a filename is specified using the file parameter, the S-parameter analysis generates an ASCII file containing the S-parameters of the circuit that can later be read-in by the nport component.

Spectre can perform the analysis while sweeping a parameter. The parameter can be frequency, temperature, component instance parameter, component model parameter, or netlist parameter. If changing a parameter affects the DC operating point, the operating point is recomputed on each step. You can sweep the circuit temperature by giving the parameter name as temp with no dev or mod parameter. You can sweep a netlist parameter by giving the parameter name with no dev, or mod parameter. After the analysis has completed, the modified parameter returns to its original value.

Definition

Name sp parameter=value ...

Parameters

1 prevoppoint=no Use operating point computed on the previous analysis. Possible values are no or yes.

Sweep interval parameters

2	start=0	Start sweep limit.
3	stop	Stop sweep limit.
4	center	Center of sweep.
5	span=0	Sweep limit span.
6	step	Step size, linear sweep.
7	lin=50	Number of steps, linear sweep.
8	dec	Points per decade.
9	log=50	Number of steps, log sweep.
10	values=[]	Array of sweep values.

Analysis Statements

Sweep variable parameters

11 dev Device instance whose parameter value is to be swept.

12 mod Model whose parameter value is to be swept.

13 param Name of parameter to sweep.

14 freq (Hz) Frequency when parameter other than frequency is being swept.

Port parameters

15 ports=[...] List of active ports. Ports are numbered in the order given.

State-file parameters

16 readns File that contains estimate of DC solution (nodeset).

Output parameters

17 file S-parameters output file name.

18 oppoint=no Should operating point information be computed, and if so,

where should it be sent.

Possible values are no, screen, logfile, or rawfile.

Noise parameters

19 donoise=no Perform noise analysis. If oprobe is specified as a valid port, this

is set to yes, and a detailed noise output is generated.

Possible values are no or yes.

20 oprobe Compute total noise at the output defined by this component.

21 iprobe Input probe. Refer the output noise to this component.

Convergence parameters

22 restart=yes Do not use previous DC solution as initial guess.

Possible values are no or yes.

Analysis Statements

Annotation parameters

23 annotate=sweep Degree of annotation.

Possible values are no, title, sweep, status, or steps.

24 stats=no Analysis statistics.

Possible values are no or yes.

25 title Analysis title.

If the list of active ports is specified with the ports parameter, then the ports are numbered sequentially from one in the order given. Otherwise, all ports present in the circuit are active, and the port numbers used are those that were assigned on the port statements. If donoise=yes is specified, then the noise correlation matrix is computed. If in addition, the output is specified using oprobe, the amount that each noise source contributes to the output is computed. Finally, if an input is also specified (using iprobe), the two-port noise parameters are computed (F, Fmin, NF, NFmin, Gopt, Bopt, and Rn).

You can specify sweep limits by giving the end points or by providing the center value and the span of the sweep. Steps can be linear or logarithmic, and you can specify the number of steps or the size of each step. You can give a step size parameter (step, lin, log, dec) to determine whether the sweep is linear or logarithmic. If you do not give a step size parameter, the sweep is linear when the ratio of stop to start values is less than 10, and logarithmic when this ratio is 10 or greater. All frequencies are in Hertz.

The small-signal analysis begins by linearizing the circuit about an operating-point. By default this analysis computes the operating-point if it is not known, or recomputes it if any significant component or circuit parameter has changed. However, if a previous analysis computed an operating point, you can set prevoppoint=yes to avoid recomputing it. For example, if you use this option when the previous analysis was a transient analysis, the operating point is the state of the circuit on the final time point.

Parameter Index

In the following index, the number following each parameter name indicates where to find the description of that parameter.

annotate 23	iprobe 21	ports 15	step 6
center 4	lin 7	prevoppoint 1	stop 3
dec 8	log 9	readns 16	title 25
dev 11	mod 12	restart 22	values 10
donoise 19	oppoint 18	span 5	

Analysis Statements

file 17 oprobe 20 start 2 freg 14 param 13 stats 24

Stability Analysis (stb)

Description

The STB analysis linearizes the circuit about the DC operating point and computes the loop gain, gain and phase margins (if the sweep variable is frequency), for a feedback loop or a gain device.

Spectre can perform the analysis while sweeping a parameter. The parameter can be frequency, temperature, component instance parameter, component model parameter, or netlist parameter. If changing a parameter affects the DC operating point, the operating point is recomputed on each step. You can sweep the circuit temperature by giving the parameter name as temp with no dev or mod parameter. You can sweep a netlist parameter by giving the parameter name with no dev, or mod parameter. After the analysis has completed, the modified parameter returns to its original value.

Definition

Name stb parameter=value ...

Parameters

1 prevoppoint=no Use operating point computed on the previous analysis.

Possible values are no or yes.

Sweep interval parameters

2 start=0 Start sweep limit.

3 stop Stop sweep limit.

4 center Center of sweep.

5 span=0 Sweep limit span.

6 step Step size, linear sweep.

Analysis Statements

7 lin=50 Number of steps, linear sweep.

8 dec Points per decade.

9 log=50 Number of steps, log sweep.

10 values=[...] Array of sweep values.

Sweep variable parameters

11 dev Device instance whose parameter value is to be swept.

12 mod Model whose parameter value is to be swept.

13 param Name of parameter to sweep.

14 freq (Hz) Frequency when parameter other than frequency is being swept.

Probe parameters

15 probe Probe instance around which the loop gain is calculated.

State-file parameters

16 readns File that contains estimate of DC solution (nodeset).

Output parameters

17 save Signals to output.

Possible values are all, lvl, allpub, lvlpub, selected, or

none.

18 nestlvl Levels of subcircuits to output.

19 oppoint=no Should operating point information be computed, and if so,

where should it be sent.

Possible values are no, screen, logfile, or rawfile.

Analysis Statements

Convergence parameters

20 restart=yes Do not use previous DC solution as initial guess.

Possible values are no or yes.

Annotation parameters

21 annotate=sweep Degree of annotation.

Possible values are no, title, sweep, status, or steps.

22 stats=no Analysis statistics.

Possible values are no or yes.

23 title Analysis title.

You can specify sweep limits by giving the end points or by providing the center value and the span of the sweep. Steps can be linear or logarithmic, and you can specify the number of steps or the size of each step. You can give a step size parameter (step, lin, log, dec) to determine whether the sweep is linear or logarithmic. If you do not give a step size parameter, the sweep is linear when the ratio of stop to start values is less than 10, and logarithmic when this ratio is 10 or greater. All frequencies are in Hertz.

The small-signal analysis begins by linearizing the circuit about an operating-point. By default this analysis computes the operating-point if it is not known, or recomputes it if any significant component or circuit parameter has changed. However, if a previous analysis computed an operating point, you can set prevoppoint=yes to avoid recomputing it. For example, if you use this option when the previous analysis was a transient analysis, the operating point is the state of the circuit on the final time point.

Loop based and Device Based Algorithms

Two algorithms--the loop based and the device based, are available for small-signal stability analysis. Both algorithms are based on the calculation of Bodes return ratio. Loop gain waveform, gain margin, and phase margin are the analysis output.

The probe parameter must be specified to perform stability analysis. When it points to a current probe or voltage source instance, the loop based algorithm will be invoked; when it points to a supported active device instance, the device based algorithm will be invoked.

Analysis Statements

Loop Based Algorithm

The loop based algorithm calculates the true loop gain that consists of normal loop gain and reverse loop gain. The loop based algorithm requires the probe being placed on the feedback loop to identify and characterize the particular loop of interest. The introduction of the probe component should not change any of the circuit characteristics.

The loop based algorithm provides accurate stability information for single loop circuits, and multiloop circuits in which a probe component can be placed on a critical wire to break all loops. For a general multiloop circuit, such a critical wire may not be available. The loop based algorithm can only be performed on individual feedback loops to ensure they are stable. Although the stability of all feedback loops is only a necessary condition for the whole circuit to be stable, the multiloop circuit tends to be stable if all individual loops are associated with reasonable stability margins.

Device Based Algorithm

The device based algorithm calculates the loop gain around a particular active device. This algorithm is often applied to assess the stability of circuit design in which local feedback loops cannot be neglected; the loop based algorithm cannot be performed for these applications since the local feedback loops are inside the devices, they are not accessible from the schematic level or netlist level to insert the probe component.

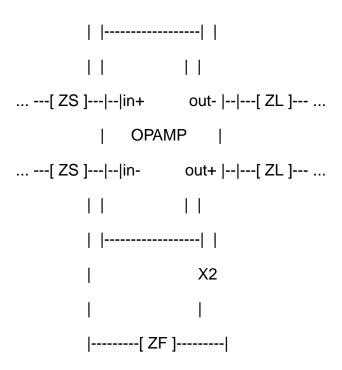
With the probe parameter points to a particular active device, the dominant controlled source in the device will be nulled during the analysis. The dominant controlled source is defined as by nulling this source renders the active device to be passive. The device based algorithm produces accurate stability information for a circuit in which a critical active device can be identified such that nulling the dominant gain source of this device renders the whole network to be passive.

Stability Analysis of Differential Feedback Circuits

A balanced fully differential feedback circuit is illustrated below:

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Analysis Statements



The feedback loops are broken at X1 and X2, with x1in and x2in being the input side nodes, x1out and x2out being the output side nodes. The following subcircuit connects these four nodes togather:

```
subckt diffprobe xlin x2in xlout x2out
   ibranch inout xlout iprobe
   vinj inout xlin iprobe
   evinj x2in x2out xlin xlout vcvs gain=0
   fiinj 0 x2out pcccs probes=[ibranch vinj] coeffs=[0 1 1] gain=0
ends diffprobe
```

Let diffprobe_inst be the instance of subcircuit diffprobe, the following analysis measures the differential-mode loop gain:

```
DMalterv alter dev=diffprobe_inst.evinj param=gain value=-1
DMalteri alter dev=diffprobe_inst.fiinj param=gain value=-1
DMloopgain stb probe=diffprobe_inst.vinj
```

and the following analysis measures the common-mode loop gain:

```
CMalterv alter dev=diffprobe_inst.evinj param=gain value=1
CMalteri alter dev=diffprobe_inst.fiinj param=gain value=1
CMloopgain stb probe=diffprobe_inst.vinj
```

Analysis Statements

Parameter Index

In the following index, the number following each parameter name indicates where to find the description of that parameter.

annotate 21	log 9	probe 15	stats 22
center 4	mod 12	readns 16	step 6
dec 8	nestlvl 18	restart 20	stop 3
dev 11	oppoint 19	save 17	title 23
freq 14	param 13	span 5	values 10
lin 7	prevoppoint 1	start 2	

Sweep Analysis (sweep)

Description

The sweep analysis sweeps a parameter executing the list of analyses (or multiple analyses) for each value of the parameter. The swept parameter can be circuit temperature, a device instance parameter, a device model parameter, a netlist parameter, or a subcircuit parameter for a particular subcircuit instance.

A set of parameters can be swept simultaneously, using the parameter parameter. The other sweep interval or variable parameters cannot be specified with the parameter parameter. Do spectre -h parameter for information on defining a parameter.

Within a sweep statement, you can specify analyses statements. These statements should be bound within braces. The opening brace is required at the end of the line defining the sweep. Sweep statements can be nested.

You can sweep the circuit temperature by giving the parameter name as param=temp with no dev, mod, or sub parameter. You can sweep a top-level netlist parameter by giving the parameter name with no dev, mod, or sub parameter. You can sweep a subcircuit parameter for a particular subcircuit instance by specifying the subcircuit instance name with the sub parameter and the subcircuit parameter name with the param parameter. The same can be done using dev for the device instance name or mod for the device model name.

After the analysis has completed, the modified parameter returns to its original value.

Analysis Statements

Definition

Name sweep parameter=value ...

Parameters

Sweep interval parameters

1 start=0 Star	t sweep limit.
----------------	----------------

2 stop Stop sweep limit.

3 center Center of sweep.

4 span=0 Sweep limit span.

5 step Step size, linear sweep.

6 lin=50 Number of steps, linear sweep.

7 dec Points per decade.

8 log=50 Number of steps, log sweep.

9 values=[...] Array of sweep values.

Sweep variable parameters

10 dev Device instance whose parameter value is to be swept.

11 sub Subcircuit instance whose parameter value is to be swept.

12 mod Model whose parameter value is to be swept.

13 param Name of parameter to sweep.

14 paramset Name of parameter set to sweep.

Analysis Statements

Annotation parameters

15 annotate=sweep Degree of annotation.

Possible values are no, title or sweep.

16 title Analysis title.

You can specify sweep limits by giving the end points or by providing the center value and the span of the sweep. Steps can be linear or logarithmic, and you can specify the number of steps or the size of each step. You can give a step size parameter (step, lin, log, or dec) and determine whether the sweep is linear or logarithmic. If you do not give a step size parameter, the sweep is linear when the ratio of the stop-to-start values is less than 10 and logarithmic when this ratio is 10 or greater.

Example

Parameter Index

In the following index, the number following each parameter name indicates where to find the description of that parameter.

annotate 15	lin 6	paramset 14	stop 2
center 3	log 8	span 4	sub 11
dec 7	mod 12	start 1	title 16
dev 10	param 13	step 5	values 9

Time-Domain Reflectometer Analysis (tdr)

Description

The time-domain reflectometer analysis linearizes the circuit about the DC operating point and computes the reflection coefficients versus time, looking from the active ports into the circuit.

Analysis Statements

Definition

Name tdr parameter=value ...

Parameters

1	stop	Stop time.
2	settling=stop	Time required for circuit to settle.
3	start=-0.1 stop	Time output waveforms begin.
4	smoothing=2	Window smoothing parameter (useful range is 0 to 15).
5	vel=1	Propagation velocity of medium normalized to c.
6	points=64	Number of time points.
7	ports=[]	List of active ports. If not given, all ports are used.
8	readns	File that contains estimate of DC solution (nodeset).
9	restart=yes	Do not use previous DC solution as initial guess. Possible values are no or yes.
10	annotate=sweep	Degree of annotation. Possible values are no, title, sweep, status, or steps.
11	title	Analysis title.
12	? oppoint=no	Should operating point information be computed, and if so, where should it be sent. Possible values are no, screen, logfile, or rawfile.
13	B prevoppoint=yes	Use operating point computed on the previous analysis. Possible values are no or yes.

Such a small-signal analysis begins by linearizing the circuit about an operating point. By default, this analysis computes the operating point, if it is not yet known, or recomputes it, if any significant component or circuit parameter has changed. However, if a previous analysis computed an operating point, you can set prevoppoint=yes to avoid recomputing it. For

Analysis Statements

example, if you use this command when the previous analysis was a transient analysis, the operating point is the state of the circuit on the final time point.

Parameter Index

In the following index, the number following each parameter name indicates where to find the description of that parameter.

annotate 10	prevoppoint 13	smoothing 4	vel 5
oppoint 12	readns 8	start 3	
points 6	restart 9	stop 1	
ports 7	settling 2	title 11	

Transient Analysis (tran)

Description

This analysis computes the transient response of a circuit over the interval from start to stop. The initial condition is taken to be the DC steady-state solution if not otherwise given.

Definition

Name tran parameter=value ...

Parameters

Simulation interval parameters

1	stop (s)	Stop time.
2	start=0 s	Start time.
3	outputstart=start	s Output is saved only after this time is reached.

Analysis Statements

4 autostop=no Enable early termination of the analysis, when all measurement

expressions have been evaluated.

Possible values are no or yes.

Time-step parameters

5 maxstep (s) Maximum time step. Default derived from errpreset.

6 step=0.001 (stop-start) s

Minimum time step used by the simulator solely to maintain the

aesthetics of the computed waveforms.

Initial-condition parameters

7 ic=all What should be used to set initial condition.

Possible values are dc, node, dev, or all.

8 skipdc=no If yes, there will be no dc analysis for transient.

Possible values are no, yes, waveless, rampup, autodo, or

sigrampup.

9 readic File that contains initial condition.

Convergence parameters

10 readns File that contains estimate of initial transient solution.

11 cmin=0 F Minimum capacitance from each node to ground.

State-file parameters

12 write File to which initial transient solution is to be written.

13 writefinal File to which final transient solution is to be written.

14 ckptperiod Checkpoint the analysis periodically using the specified period.

Analysis Statements

Integration method parameters

15 method Integration method. Default derived from errpreset.

Possible values are euler, trap, traponly, gear2,

gear2only, or trapgear2.

Accuracy parameters

16 errpreset=moderate

Selects a reasonable collection of parameter settings.

Possible values are liberal, moderate or conservative.

17 relref Reference used for the relative convergence criteria. Default

derived from errpreset.

Possible values are pointlocal, alllocal, sigglobal, or

allglobal.

18 Iteratio Ratio used to compute LTE tolerances from Newton tolerance.

Default derived from errpreset.

Annotation parameters

19 stats=no Analysis statistics.

Possible values are no or yes.

20 annotate=sweep Degree of annotation.

Possible values are no, title, sweep, status, or steps.

21 title Analysis title.

Output parameters

22 save Signals to output.

Possible values are all, lvl, allpub, lvlpub, selected, or

none.

23 nestlvl Levels of subcircuits to output.

24 oppoint=no Should operating point information be computed for initial

timestep, and if so, where should it be sent.

Possible values are no, screen, logfile, or rawfile.

Analysis Statements

$^{\circ}$		
ノコ	skipstart=starttime	S
	DITEDUCATE DECETION	\sim

The time to start skipping output data.

26 skipstop=stoptime s

The time to stop skipping output data.

27 skipcount Save only one of every skipcount points.

28 strobeperiod (s) The output strobe interval (in seconds of transient time).

29 strobedelay=0 s The delay (phase shift) between the skipstart time and the first

strobe point.

30 compression=no Do data compression on output.

Possible values are no or yes.

31 flushpoints Flush outputs after number of calculated points.

32 flushtime (s) Flush outputs after real time has elapsed.

33 flushofftime (s) Time to stop flushing outputs.

34 infoname Name of info analysis to save operating point.

35 infotimes=[...] s Times when operating points should be saved.

Newton parameters

36 maxiters=5 Maximum number of iterations per time step.

37 restart=yes Do not use previous DC solution as initial guess.

Possible values are no or yes.

Circuit age

38 circuitage (Years) Stress Time. Age of the circuit used to simulate hot-electron degradation of MOSFET and BSIM circuits.

You may specify the initial condition for the transient analysis by using the ic statement or the ic parameter on the capacitors and inductors. If you do not specify the initial condition, the DC solution is used as the initial condition. The ic parameter on the transient analysis

Analysis Statements

controls the interaction of various methods of setting the initial conditions. The effects of individual settings are:

ic=dc: Any initial condition specifiers are ignored, and the DC solution is used.

ic=node: The ic statements are used, and the ic parameter on the capacitors and inductors are ignored.

ic=dev: The ic parameters on the capacitors and inductors are used, and the ic statements are ignored.

ic=all: Both the ic statements and the ic parameters are used, and the ic parameters override the ic statements.

If you specify an initial condition file with the readic parameter, initial conditions from the file are used, and any ic statements are ignored.

Once you specify the initial conditions, Spectre computes the actual initial state of the circuit by performing a DC analysis. During this analysis, Spectre forces the initial conditions on nodes by using a voltage source in series with a resistor whose resistance is rforce (see options).

With the ic statement it is possible to specify an inconsistent initial condition (one that cannot be sustained by the reactive elements). Examples of inconsistent initial conditions include setting the voltage on a node with no path of capacitors to ground or setting the current through a branch that is not an inductor. If you initialize Spectre inconsistently, its solution jumps; that is, it changes instantly at the beginning of the simulation interval. You should avoid such changes if possible because Spectre can have convergence problems while trying to make the jump.

You can skip the DC analysis entirely by using the parameter skipdc. If the DC analysis is skipped, the initial solution will be either trivial, or given in the file you specified by the readic parameter, or, if the readic parameter is not given, the values specified on the ic statements. Device based initial conditions are not used for skipdc. Nodes that you do not specify with the ic file or ic statements will start at zero. You should not use this parameter unless you are generating a nodeset file for circuits that have trouble in the DC solution; it usually takes longer to follow the initial transient spikes that occur when the DC analysis is skipped than it takes to find the real DC solution. The skipdc parameter might also cause convergence problems in the transient analysis.

The possible settings of parameter skipdc and their meanings are:

skipdc=no: Initial solution is calculated using the normal DC analysis (default).

Analysis Statements

skipdc=yes: Initial solution is given in the file specified by the readic parameter or the values specified on the ic statements.

skipdc=wireless: Same initial solution as skipdc=yes. But, the waveform production in the time-varying independent sources is disabled during the transient analysis. The independent source values are fixed to their initial values (not their DC values).

skipdc=ramup: The independent source values start at 0 and ramp up to their initial values in the first 10% of the analysis interval. After that their values remain constant. Zero initial solution is used.

skipdc=autodc: Same as skipdc=wireless if a nonzero initial condition is specified. Otherwise, same as skipdc=ramup.

skipdc=sigrampup: The independent source values start at 0 and ramp up to their initial values in the first phase of the simulation. Unlike skipdc=rampup, the waveform production in the time-varying independent source is enable after the rampup phase. The rampup simulation is from start to time=0 s, and the main simulation is from time=0 s to stop. If the start parameter is not specified, the default start time is set to -0.1*stop.

Nodesets help find the DC or initial transient solution. You can supply them in the circuit description file with nodeset statements, or in a separate file using the readns parameter. When nodesets are given, Spectre computes an initial guess of the solution by performing a DC analysis while forcing the specified values onto nodes by using a voltage source in series with a resistor whose resistance is rforce. Spectre then removes these voltage sources and resistors and computes the true solution from this initial guess.

Nodesets have two important uses. First, if a circuit has two or more solutions, nodesets can bias the simulator towards computing the desired one. Second, they are a convergence aid. By estimating the solution of the largest possible number of nodes, you might be able to eliminate a convergence problem or dramatically speed convergence.

When you simulate the same circuit many times, we suggest that you use both the write and readns parameters and give the same file name to both parameters. The DC analysis then converges quickly even if the circuit has changed somewhat since the last simulation, and the nodeset file is automatically updated.

Nodesets and initial conditions have similar implementation but produce different effects. Initial conditions actually define the solution, whereas nodesets only influence it. When you simulate a circuit with a transient analysis, Spectre forms and solves a set of differential equations. However, differential equations have an infinite number of solutions, and a complete set of initial conditions must be specified in order to identify the desired solution. Any initial conditions you do not specify are computed by the simulator to be consistent. The transient waveforms then start from initial conditions. Nodesets are usually used as a convergence aid and do not affect the final results. However, in a circuit with more than one

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solution, such as a latch, nodesets bias the simulator towards finding the solution closest to the nodeset values.

The method parameter specifies the integration method. The possible settings and their meanings are:

method=euler: Backward-Euler is used exclusively.

method=traponly: Trapezoidal rule is used almost exclusively.

method=trap: Backward-Euler and the trapezoidal rule are used.

method=gear2only: Gears second-order backward-difference method is used almost exclusively.

method=gear2: Backward-Euler and second-order Gear are used.

method=trapgear2: Allows all three integration methods to be used.

The trapezoidal rule is usually the most efficient when you want high accuracy. This method can exhibit point-to-point ringing, but you can control this by tightening the error tolerances. For this reason, though, if you choose very loose tolerances to get a quick answer, either backward-Euler or second-order Gear will probably give better results than the trapezoidal rule. Second-order Gear and backward-Euler can make systems appear more stable than they really are. This effect is less pronounced with second-order Gear or when you request high accuracy.

Several parameters determine the accuracy of the transient analysis. reltol and abstol control the accuracy of the discretized equation solution. These parameters determine how well charge is conserved and how accurately steady-state or equilibrium points are computed. You can set the integration error, or the errors in the computation of the circuit dynamics (such as time constants), relative to reltol and abstol by setting the lteratio parameter.

The parameter relref determines how the relative error is treated. The relref options are:

relref=pointlocal: Compares the relative errors in quantities at each node to that node alone.

relref=alllocal: Compares the relative errors at each node to the largest values found for that node alone for all past time.

relref=sigglobal: Compares relative errors in each of the circuit signals to the maximum for all signals at any previous point in time.

Analysis Statements

relref=allglobal: Same as relref=sigglobal except that it also compares the residues (KCL error) for each node to the maximum of that nodes past history.

The errpreset parameter lets you adjust the simulator parameters to fit your needs quickly. You can set errpreset to conservative if the circuit is very sensitive, or you can set it to liberal for a fast. but possibly inaccurate, simulation. The setting errpreset=moderate suits most needs.

The effect of errpreset on other parameters is shown in the following table. In this table, T= stop - start. check???

errpreset	reltol	relref	method	maxstep	Iteratio
liberal	10	allglobal	gear2	Interval/10	3.5
moderate		sigglobal	traponly	Interval/50	3.5
conservative	0.1	alllocal	gear2only	Interval/100	10.0

The value of reltol is increased or decreased from its value in the options statement, but it is not allowed to be larger than 0.01. Spectre sets the value of maxstep so that it is no larger than the value given in the table. Except for reltol and maxstep, errpreset does not change the value of any parameters you have explicitly set. The actual values used for the transient analysis are given in the log file.

If the circuit you are simulating can have infinitely fast transitions (for example, a circuit that contains nodes with no capacitance), Spectre might have convergence problems. To avoid this, you must prevent the circuit from responding instantaneously. You can accomplish this by setting cmin, the minimum capacitance to ground at each node, to a physically reasonable nonzero value. This often significantly improves Spectre convergence.

Spectre provides two methods for reducing the number of output data points saved: strobing, based on the simulation time, and skipping time points, which saves only every Nth point.

The parameters strobeperiod and strobedelay control the strobing method.strobeperiod sets the interval between points that you want to save, and strobedelay sets the offset within the period relative to skipstart. The simulator forces a time step on each point to be saved, so the data is computed, not interpolated.

The skipping method is controlled by skipcount. If this is set to N, then only every Nth point is saved.

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The parameters skipstart and skipstop apply to both data reduction methods. Before skipstart and after skipstop, Spectre saves all computed data.

If you do not want any data saved before a given time, use outputstart. If you do not want any data saved after a given time, change the stop time.

Parameter Index

In the following index, the number following each parameter name indicates where to find the description of that parameter.

annotate 20	ic 7	readic 9	stats 19
autostop 4	infoname 34	readns 10	step 6
circuitage 38	infotimes 35	relref 17	stop 1
ckptperiod 14	lteratio 18	restart 37	strobedelay 29
cmin 11	maxiters 36	save 22	strobeperiod 28
compression 30	maxstep 5	skipcount 27	title 21
errpreset 16	method 15	skipdc 8	write 12
flushofftime 33	nestlvl 23	skipstart 25	writefinal 13
flushpoints 31	oppoint 24	skipstop 26	
flushtime 32	outputstart 3	start 2	

Transfer Function Analysis (xf)

Description

The transfer function analysis linearizes the circuit about the DC operating point and performs a small-signal analysis that calculates the transfer function from every independent source in the circuit to a designated output. The variable of interest at the output can be voltage or current.

You can specify the output with a pair of nodes or a probe component. Any component with two or more terminals can be a voltage probe. When there are more than two terminals, they are grouped in pairs; and you use the porty parameter to select the appropriate pair of terminals. Alternatively, you can simply specify a voltage to be the output by giving a pair of nodes on the xf analysis statement.

Any component that naturally computes current as an internal variable can be a current probe. If the probe component computes more than one current (as transmission lines, microstrip lines, and N-ports do), you use the porti parameter to select the appropriate

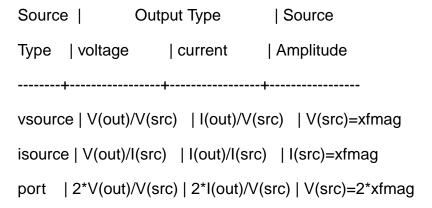
Analysis Statements

current. It is an error to specify both porty and porti. If neither is specified, the probe component provides a reasonable default.

The stimuli parameter specifies what is used for the inputs for the transfer functions. There are two choices. stimuli=sources indicates that the sources present in the circuit should be used. The xfmag parameters provided by the sources may be used to adjust the computed gain to compensate for gains or losses in a test fixture. One can limit the number of sources in hierarchical netlists by using the save and nestlyl parameters.

The transfer functions computed versus output and source types are:

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where xfmag defaults to 1 for each source type. For the port, V(src) is the internal source voltage.

Specifying stimuli=nodes_and_terminals indicates that all possible transfer functions should be computed. This is useful when it is not known in advance which transfer functions are interesting. Transfer functions for nodes are computed assuming that a unit magnitude flow (current) source is connected from the node to ground. Transfer functions for terminals are computed assuming that a unit magnitude potential (voltage) source is connected in series with the terminal. By default, the transfer functions from a small set of terminals are computed. If transfer functions from specific terminals are desired, specify the terminals in the save statement. You must use the :probe modifier (for example, Rout:1:probe) or specify useprobes=yes on the options statement. If transfer functions from all terminals are desired, specify currents=all and useprobes=yes on the options statement.

Spectre can perform the analysis while sweeping a parameter. The parameter can be frequency, temperature, component instance parameter, component model parameter, or netlist parameter. If changing a parameter affects the DC operating point, the operating point is recomputed on each step. You can sweep the circuit temperature by giving the parameter name as temp with no dev or mod parameter. You can sweep a netlist parameter by giving

Analysis Statements

the parameter name with no dev, or mod parameter. After the analysis has completed, the modified parameter returns to its original value.

Definition

Name [p] [n] xf parameter=value ...

The optional terminals (p and n) specify the output of the circuit. If you do not give the terminals, then you must specify the output with a probe component.

Parameters

1 prevoppoint=no Use operating point computed on the previous analysis.

Possible values are no or yes.

Sweep interval parameters

2 start=0 Start sweep limit.

3 stop Stop sweep limit.

4 center Center of sweep.

5 span=0 Sweep limit span.

6 step Step size, linear sweep.

7 lin=50 Number of steps, linear sweep.

8 dec Points per decade.

9 log=50 Number of steps, log sweep.

10 values=[...] Array of sweep values.

Sweep variable parameters

11 dev Device instance whose parameter value is to be swept.

12 mod Model whose parameter value is to be swept.

Analysis Statements

13 param Name of parameter to sweep.

14 freq (Hz) Frequency when parameter other than frequency is being swept.

Probe parameters

15 probe Compute every transfer function to this probe component.

State-file parameters

16 readns File that contains estimate of DC solution (nodeset).

Output parameters

17 stimuli=sources Stimuli used for xf analysis.

Possible values are sources or nodes_and_terminals.

18 save Signals to output.

Possible values are all, lvl, allpub, lvlpub, selected, or

none.

19 nestlvl Levels of subcircuits to output.

20 oppoint=no Should operating point information be computed, and if so,

where should it be sent.

Possible values are no, screen, logfile, or rawfile.

Convergence parameters

21 restart=yes Do not use previous DC solution as initial guess.

Possible values are no or yes.

Annotation parameters

22 annotate=sweep Degree of annotation.

Possible values are no, title, sweep, status, or steps.

23 stats=no Analysis statistics.

Possible values are no or yes.

24 title Analysis title.

Analysis Statements

You can specify sweep limits by giving the end points or by providing the center value and the span of the sweep. Steps can be linear or logarithmic, and you can specify the number of steps or the size of each step. You can give a step size parameter (step, lin, log, dec) to determine whether the sweep is linear or logarithmic. If you do not give a step size parameter, the sweep is linear when the ratio of stop to start values is less than 10, and logarithmic when this ratio is 10 or greater. All frequencies are in Hertz.

The small-signal analysis begins by linearizing the circuit about an operating-point. By default this analysis computes the operating-point if it is not known, or recomputes it if any significant component or circuit parameter has changed. However, if a previous analysis computed an operating point, you can set prevoppoint=yes to avoid recomputing it. For example, if you use this option when the previous analysis was a transient analysis, the operating point is the state of the circuit on the final time point.

Parameter Index

In the following index, the number following each parameter name indicates where to find the description of that parameter.

annotate 22	log 9	probe 15	stats 23
center 4	mod 12	readns 16	step 6
dec 8	nestlvl 19	restart 21	stimuli 17
dev 11	oppoint 20	save 18	stop 3
freq 14	param 13	span 5	title 24
lin 7	prevoppoint 1	start 2	values 10

Spectre Syntax

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- Configuring CMI Shared Objects (cmiconfig) on page 694
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- Subcircuit Definitions (subckt) on page 729
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Spectre Syntax

Using Analogmodel for Model Passing (analogmodel)

analogmodel is a reserved word in Spectre that allows you to bind an instance to different masters based on the value of a special instance parameter called modelname. An instance of analogmodel must have a parameter named modelname whose string value will be the name of the master this instance will be bound to. The value of modelname can be passed into subcircuits.

The analogmodel keyword is used by the Cadence[®] Analog Design Environment to enable model name passing through the schematic hierarchy.

The syntax for an instance statement with a modelname parameter is given below:

name Name of the statement or instance label.

[(]node1...nodeN[)] Names of the nodes that connect to the component.

analogmodelSpecial device name to indicate that this instance will have its master name specified by the value of the modelname parameter on the instance.

modelnameParameter to specify the master of this instance indicated by mastername. The mastername must either be a valid string identifier or a netlist parameter that must resolve to a valid master name – a primitive, model, subckt, or an AHDL module.

param1 Parameter values for the component. Depending on the master type, these can either be device parameters or netlist parameters. This is an optional field.

An Example

```
//example spectre netlist to illustrate modelname parameter
simulator lang=spectre
parameters a="low" b="bottom" modelname=10
ahdl_include "VerilogAStuff.va"
topInst1 (out in) top
topInst2 analogmodel modelname="VAMaster" //VAMaster is defined in
"VerilogAStuff.va"
    topInst3 (out in) analogmodel modelname="resistor" //topInst3 binds to a
primitive
```

Spectre Syntax

```
topInst4 (out in) analogmodel modelname="myOwnRes" //topInst4 binds to a
modelcard "myOwnRes" defined below
    topinst5 (out in) weiredRes modelname=modelname //modelname is just another
netlist param
    model myOwnRes resistor r=100
    subckt (out in) top
      parameters a="mid"
      x1 (out in) analogmodel modelname=a //topInst1.x1 binds to "mid"
    ends top
    subckt (out in) mid
      parameters c="low"
      x1 (out in) analogmodel modelname=b //topInst1.x1.x1 binds to "bottom"
      x2 (out in) analogmodel modelname=c //topInst1.x1.x1.x2 binds to "low"
    ends mid
    subckt (out in) low
      x1 (out in) analogmodel modelname="bottom" //topInst1.x1.x1.x2.x1 binds to
"bottom"
    ends low
    subckt (out in) bottom
      x1 (out in) analogmodel modelname="resistor" //x1 binds to primitive
"resistor"
    ends bottom
    dc1 dc
```

Checkpoint - Restart (checkpoint)

Description

Spectre has the ability to save checkpoint files while the analyses are running, and to restart an analysis from its checkpoint file. Checkpoint files can be generated in several ways:

- 1) Periodically based on real time (wall clock time).
- 2) Asynchronous UNIX signals.
- 3) By other methods unique to the analyses.

To generate checkpoint files periodically based on real time, set the Spectre option <code>ckptclock</code> to the time interval in seconds that you want checkpoints. This option is turned on by default with a value of 1800 seconds (30 minutes). Spectre will delete the checkpoint file if the simulation completes normally. If the simulation terminates abnormally, the checkpoint file will not be deleted.

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If Spectre receives the UNIX signal USR2, then Spectre will immediately write a checkpoint file. If Spectre receives interrupt signals like QUIT, TERM, INT, or HUP, Spectre will attempt to write a checkpoint file and then exit. After other fatal signals, it may not be possible for Spectre to write a checkpoint file.

The name of the checkpoint file is a combination of the circuit name, the analysis name, and the extension .ckpt. For example, if the circuit is named test1 and the transient analysis is named timeSweep, then the checkpoint file will be named test1.timeSweep.tran.ckpt.

Spectre keeps only the latest checkpoint file. When a new checkpoint is created, it creates the file under a temporary name. After the file has been successfully written, it deletes the previous checkpoint file and renames the new file.

Currently only the transient analyses supports checkpoint and restart.

Checkpoint for Transient Analyses

The transient analysis can generate checkpoint files by using the above methods, or by generating a checkpoint file periodically based on the transient simulation time. This is accessed by a transient analysis parameter called <code>ckptperiod</code>, which is turned off by default.

Restart

To restart an analysis from a checkpoint file, use the +recover option on the Spectre command line. Spectre will look though the requested analyses to see if a checkpoint file exists for any of them. If a checkpoint file for a given analysis does exist, Spectre will skip over any analyses previous to that one, and start the analysis using the information from the file.

Configuring CMI Shared Objects (cmiconfig)

Description

Spectre supports the ability to install devices dynamically from shared objects at run time. CMI Configuration files are used to determine and locate the set of shared objects to be installed. Spectre first reads the default CMI configuration file which specifies the default shared objects provided by Cadence. The configuration file specified by the value of the CMI_CONFIG environment variable is then read. The third configuration file that Spectre reads is ~/.cmiconfig. Finally, the configuration file specified in Spectre's -cmiconfig command

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line argument is read. Each CMI configuration file modifies the existing configuration established by the configuration files read before.

The following commands can be used in a CMI configuration file.

```
setpathSpecifies and resets the search path.
```

```
setpath <path> or setpath ( <path1> <path2> ...
```

prependAdds a path before the current search path.

```
prepend <path> or prepend ( <path1> <path2> ...
```

appendAdds a path after the current search path.

```
append <path> or append ( <path1> <path2> ...
```

loadAdd a shared object to the list of shared objects to load.

```
loads [path/]<shared_object_name>
```

unloadRemoves a shared object to the list of shared objects to load.

```
unload <shared_object_name>
```

For example, given the following CMI configuration file

```
append /hm/spectre_dev/tools.sun4v/spectrecmi/lib/cmi/1.0
load libbjtx+tfet.so
load libmosx.so
```

The shared objects libbjtx+tfet.so and libmosx.so are loaded from /hm/spectre_dev/tools.sun4v/spectrecmi/lib/cmi/1.0 in addition to the default shared objects provided by Cadence.

Built-in Mathematical and Physical Constants (constants)

Description

Spectre supports the following list of built-in mathematical and physical constants:

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${\tt M}_$ is a mathematical constant

M_E	2.7182818284590452354	1 / pi
M_LOG2E	1.4426950408889634074	log2(e)
M_LOG10E	0.43429448190325182765	log10(e)
M_LN2	0.69314718055994530942	In(2)
M_LN10	2.30258509299404568402	In(10)
M_PI	3.14159265358979323846	pi
M_TWO_PI	6.28318530717958647652	2 * pi
M_PI_2	1.57079632679489661923	pi/2
M_PI_4	0.78539816339744830962	pi/4
M_1_PI	0.31830988618379067154	1/pi
M_2_PI	0.63661977236758134308	2/pi
M_2_SQRTPI	1.12837916709551257390	2/sqrt(pi)
M_SQRT2	1.41421356237309504880	sqrt(2)
M_SQRT1_2	0.70710678118654752440	sqrt(1/2)
M_DEGPERRAD	57.2957795130823208772	number of degrees per radian

P_ is a physical constant

P_Q	1.6021918e-19	charge of electron in coulombs
P_C	2.997924562e8	speed of light in vacuum in meters/sec
P_K	1.3806226e-23	Boltzman's constant in joules/kelvin
P_H	6.6260755e-34	Planck's constant in joules*sec
P_EPS0	8.85418792394420013968e-12	permittivity of vacuum in farads/meter
P_U0	(4.0e-7 * M_PI)	permeability of vacuum in henrys/meter
P_CELS IUS0	273.15	zero celsius in kelvin

Spectre Syntax

These constants can be used in expressions, or anywhere that a numeric value of expression is expected.

Convergence Difficulties (convergence)

Description

If you are having convergence difficulties, try the following suggestions:

- 1. Carefully evaluate and resolve any notice, warning or error messages.
- Assure topology checker is used (set topcheck=full on options statement) and heed any warnings it gives.
- 3. Perform sanity checking on the parameter values using the parameter range checker (use +param param-limits-file as a command line argument) and heed any warnings. Print the minimum and maximum parameter value using the info analysis. Assure that the bounds given for instance, model, output, temperature-dependent, and operating-point (if possible) parameters are reasonable.
- 4. Small floating resistors connected to high impedance nodes can cause convergence difficulties. Avoid very small floating resistors, particularly small parasitic resistors in semiconductors. Use voltage sources or iprobes to measure current rather than small resistors.
- 5. Use realistic device models. Check all component parameters, particularly nonlinear device model parameters, to assure that they are reasonable.
- 6. Increase the value of gmin (on options statement).
- 7. Loosen tolerances, particularly absolute tolerances like iabstol (on options statement). If tolerances are set too tight, they might preclude convergence.
- 8. Try to simplify the nonlinear component models in order to avoid regions in the model that may contribute to convergence problems.

DC Convergence Suggestions

Once you have a solution, write it to a nodeset file using the write parameter, and read it back in on subsequent simulations using the readns parameter.

1. If you have an estimate of what the solution should be, use nodeset statements or a nodeset file and set as many nodes as possible.

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- 2. If convergence difficulties occur when using nodesets or initial conditions, try increasing rforce (on options statement).
- 3. If this is not the first analysis, perhaps the solution from the previous analysis is far from the solution for this analysis. If so, set restart=yes.
- 4. If simulating a bipolar analog circuit, assure the region parameter on all transistors and diodes is set correctly.
- 5. If analysis fails at an extreme temperature, but succeeds at room temperature, then try adding a DC analysis that sweeps temperature. Start at room temperature, sweep to the extreme temperature, and write the final solution to a nodeset file.
- 6. Use numeric pivoting in the sparse matrix factorization by setting pivotdc=yes (on options statement). Sometimes it is also necessary to increase the pivot threshold to somewhere in the range of 0.1 to 0.5 using pivrel (on options statement).
- 7. Divide the circuit into smaller pieces and simulate them individually, but be careful to assure that the results will be close to what they would be if the rest of the circuit was present. Use the results to generate nodesets for the whole circuit.
- 8. If all else fails, replace the DC analysis with a transient analysis and modify all the independent sources to start at zero and ramp to their DC values. Run the transient analysis well beyond the time when all the sources have reached their final value (remember that transient analysis is very cheap when all of the signals in the circuit are not changing) and write the final point to a nodeset file. To make the transient analysis more efficient set the integration method to backward Euler (method=euler) and loosen the local truncation error criteria by increasing lteratio, say to 50. Occasionally, this approach will fail or be very slow because the circuit contains an oscillator. Often times the oscillation can be eliminated for the sake of finding the dc solution by setting the minimum capacitance from each node to ground (cmin) to a large value.

Transient Convergence Suggestions

- Assure that a complete set of parasitic capacitors is used on nonlinear devices to avoid jumps in the solution waveforms. On MOS models, specify nonzero source and drain areas.
- 2. Use the cmin parameter to install a small capacitor from every node in the circuit to ground. This usually eliminates any jumps in the solution.

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Export a Measurement to Be Evaluated (export)

The export feature is not supported. It is designated for internal use only.

Expressions (expressions)

Description

An expression is a construct that combines operands with operators to produce a result that is a function of the values of the operands and the semantic meaning of the operators. Any legal operand is also an expression in itself. Legal operands include numeric constants and references to top-level netlist parameters or subcircuit parameters. Calls to algebraic and trigonometric functions are also supported. The complete lists of operators, algebraic, and trigonometric functions are given after some examples.

Examples

```
simulator lang=spectre
parameters p1=1 p2=2
                               // declare some top-level parameters
r1 (1 0) resistor r=p1
                               // the simplest type of expression
r2 (1 0) resistor r=p1+p2
                               // a binary (+) expression
r3 (1 0) resistor r=5+6/2
                               // expression of constants, = 8
x1 s1 p4=8
               // instantiate a subcircuit, defined in the following lines
subckt s1
parameters p1=4 p3=5 p4=6
                              // subcircuit parameters
   r1 (1 0) resistor r=p1
                                       // another simple expression
   r2 (1 0) resistor r=p2*p2
                                       // a binary multiply expression
   r3 (1 0) resistor r=(p1+p2)/p3
                                      // a more complex expression
                                      // an algebraic function call
   r4 (1 0) resistor r=sqrt(p1+p2)
   r5 (1 0) resistor r=3+atan(p1/p2) // a trigonometric function call
   r6 (1 0) RESMOD r=(p1 ? p4+1 : p3) // the ternary operator
ends
// a model card, containing expressions
model RESMOD resistor tc1=p1+p2 tc2=sqrt(p1*p2)
// some expressions used with analysis parameters
time_sweep tran start=0 stop=(p1+p2)*50e-6 // use 5*50e-6 = 150 us
// a vector of expressions (see notes on vectors below)
dc_sweep dc param=p1 values=[0.5 1 +p2 (sqrt(p2*p2)) ] // sweep p1
```

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Where Expressions Can Be Used

The Spectre native netlist language allows expressions to be used where numeric values are expected on the right-hand side of an "=" sign, or within a vector, where the vector itself is on the right-hand side of an "=" sign. Expressions can be used when specifying device or analysis instance parameter values (for example specifying the resistance of a resistor or the stop time of a transient analysis, as outlined in the preceding example), when specifying model parameter values in model cards (for example specifying "bf=p1*0.8" for a bipolar model parameter, bf), or when specifying initial conditions and nodesets for individual circuit nodes.

Operators

The following operators are supported, listed in order of decreasing precedence. Parentheses can be used to change the order of evaluation. For a binary expression like "a+b", "a" is the first operand and "b" is the second operand. All operators are left associative, with the exceptions of the "to the power of" operator (**) and the ternary operator (?:), which are right associative. For logical operands, any nonzero value is considered true. The relational and equality operators return a value of 1 to indicate true or 0 to indicate false. There is no short circuiting of logical expressions involving && and ||.

Operator	Symbol(s)	Value
Unary +, Unary -	+, -	Value of operand, negative of operand.
To the power of	**	First operand to raised to power of second operand.
Multiply, Divide	* , /	Product, Quotient of operands.
Binary Plus/Minus	+, -	Sum, Difference of operands.
Shift	<<, >>	First operand shifted left (, right) by number of bits specified by second operand.
Relational	<, <=, >, >=	greater than, greater than or equal.
Equality	==, !=	True if operands are equal, not equal.
Bitwise AND	&	Bitwise AND (of integer operands).
Bitwise Exclusive NOR	~^ (or ^~)	Bitwise Exclusive NOR (of integer operands).
Bitwise OR		Bitwise OR (of integer operands).
Logical AND	&&	True only if both operands true.

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Operator	Symbol(s)	Value
Logical OR		True if either operand is true.
Ternary Operator	(cond) ? x : Y	Returns x if <i>cond</i> is true, y if not where x and y are expressions.

Algebraic and Trigonometric Functions:

The trigonometric and hyperbolic functions expect their operands to be specified in radians. The atan2() and hypot() functions are useful for converting from Cartesian to polar form.

Function	Description	Domain
$\log(x)$	Natural logarithm	<i>x</i> > 0
log10(x)	Decimal logarithm	<i>x</i> > 0
exp(x)	Exponential	<i>x</i> < 80
sqrt(x)	Square Root	<i>x</i> > 0
$\min(x,y)$	Minimum value	All x , all y
$\max(x,y)$	Maximum value	All x , all y
abs(x)	Absolute value	AII x
pow(x,y)	x to the power of y	All x , all y
int(x)	integer value of x	All x
floor(x)	largest integer <= x	All x
ceil(x)	smallest integer $>= x$	
fmod(x,y)	floating-point modulus	All x , all y , except $y=0$
sin(x)	Sine	All x
cos(x)	Cosine	All x
tan(x)	Tangent	All x , except $x = n^*(pi/2)$, where n odd
asin(x)	Arc-sine	-1 <= <i>x</i> <= 1
acos(x)	Arc-cosine	-1 <= <i>x</i> <= 1
atan(x)	Arc-tangent	AII x
atan2(x,y)	Arc-tangent of x/y	All x , all y

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Function	Description	Domain
hypot(x,y)	sqrt(x*x + y*y)	All x , all y
sinh(x)	Hyperbolic sine	All x
cosh(x)	Hyperbolic cosine	All x
tanh(x)	Hyperbolic tangent	All x
asinh(x)	Arc-hyberbolic sine	All x
acosh(x)	Arc-hyperbolic cosine	x
atanh(x)	Arc-hyperbolic tangent	-1 <= <i>x</i> <= 1

User-defined functions are also supported. See spectre -h functions for a description of user-defined functions.

A large number of built-in mathematical and physical constants are available for use in expressions. See spectre -h constants for the list of these constants

Using Expressions in Vectors

Expressions can be used as vector elements, as in the following example:

```
dc_sweep dc param=p1 values=[0.5 1 +p2 (sqrt(p2*p2)) ] // sweep p1
```

Note that when expressions are used within vectors, anything other than constants, parameters, or unary expressions (unary +, unary -) must be surrounded by parentheses. Vector elements should be space separated for clarity, though this is not mandatory. The preceding dc_sweep example shows a vector of four elements, namely 0.5, 1, +p2, and sqrt(p2*p2). Note that the square root expression is surrounded by parentheses.

User Defined Functions (functions)

Description

Spectre's user-defined function capability allows you to build upon the provided set of built-in mathematical and trigonometric functions. You can write your own functions, and call these functions from within any expression. The syntax for calling a user-defined function is the same as the syntax for calling a built-in algebraic or trigonometric function. Note that user-defined functions must be defined before they are referenced (called). Arguments to user-defined functions will be taken as real values, and the functions will return real values. A user-

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defined function may contain only a single statement in braces and this statement must return an expression (which will typically be an expression involving the function arguments). The return expression may reference the built in parameters "temp" and "tnom". User-defined functions must be declared at the top level only, and must not be declared within subcircuits. User-defined functions may be called from anywhere that an expressions can be currently used in Spectre. User-defined functions may call other functions (both user-defined and built-in), however any user-defined function will need to be declared before it can be called. User-defined functions can override built-in mathematical and trigonometric functions.

Note: Only real values for arguments and return values are supported in this release.

See spectre -h expressions for a list of built-in algebraic and trigonometric functions.

Definition

```
real myfunc( [real arg1, ...real argn] ) {

Examples

real myfunc( real a, real b ) {
    return a+b*2+sqrt(a*sin(b));
}
```

An example of a function calling a previously defined function is given below.

The final example shows how a user-defined function may be called from an expression in the Spectre netlist.

```
r1 (1 0) resistor r=myfunc(2.0, 4.5)
```

Global Nodes (global)

Description

The global statement allows a set of nodes to be designated as common to the main circuit and all subcircuits. Thus, components inside subcircuits can be attached to global nodes even though the subcircuits terminals are not attached to these nodes.

Any number of global nodes may be specified using the global statement. To do this, follow the keyword global with a list of the node names that you wish to declare as global. The first

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node name that appears in this list is taken to be the name of the ground node. Ground is also known as the datum or reference node. If a global statement is not used, 0 is taken to be the name of the ground node.

At most one global statement is allowed and, if present, it must be the first statement in the file (however, you can have simulator lang=spectre statement, before the global statement so that you can use mixed case names for the node names). Ground is always treated as global even if a global statement is not used.

Definition

```
global <ground> <node> ...
```

Initial Conditions (ic)

Description

The ic statement is used to provide initial conditions for nodes in the transient analysis. It can occur multiple times in the input and the information provided in all the occurrences is collected. Initial conditions will only be accepted for inductor currents and node voltages where the nodes have a path of capacitors to ground. For more information, read the description of transient analysis. It should be noted that specifying cmin for a transient analysis, will not satisfy the condition that a node has a capacitive path to ground.

Definition

```
ic <node=value> ...
```

This statement takes a list of signals as an argument. The concept of nodes has been generalized to signals where a signal is a value associated with a topological node of the circuit or some other unknown that is solved by the simulator, such as the current through a inductor or the voltage of the internal node in a diode. Topological nodes can be either at the top-level or in a subcircuit.

For example,

```
ic 7=0 out=1 OpAmp1.comp=5 L1:1=1.0u
```

where 7=0 implies that node 7 should start at 0V, node out should start at 1V, node comp in subcircuit OpAmp1 should start at 5V, and the current through the first terminal of L1 should start at 1uA.

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The Structural if-statement (if)

Description

The structural if-statement can be used to conditionally instantiate other instance statements.

Definition

```
if <condition> <statement1> [ else <statement2> ]
```

The condition is a boolean expression based on the comparisons of various arithmetic expressions which are evaluated during circuit hierarchy flattening. The statement1 and statement2 fields can be ordinary instance statements, if-statements, or a list of these within braces ({}). (Note that ordinary instance statements need a newline to terminate them.) The else part is optional. When if-statements are nested without braces, an else matches the closest previous unmatched if at the same level.

It is possible to have duplicate instance names within the if statement under strict topological conditions: These are:

- references to instance with duplicate names is only possible within a structural if statement which has both an "if" part and an "else" part.
- both the "if" part and the "else" part must be either a simple one-statement block, or another structural if statement to which these same rules apply.
- The duplicate instances must have the same number of terminals and be bound to the same list of nodes.
- The duplicate instances must refer to the same primitive or model.
- Where duplicate instances refer to a model, the underlying primitive must be the same.

This feature allows automatic model selection based on any netlist or subcircuit parameter. As an example, consider using Spectre's inline subcircuits and structural if statement to implement automatic model selection based on bipolar device area. Here, the duplicate instances are the inline components.

```
model npn_default bjt is=3.2e-16 va=59.8
model npn10x10 bjt is=3.5e-16 va=61.5
model npn20x20 bjt is=3.77e-16 va=60.5
// npn_mod choses scaled models binned on area!
// if ( area < 100e-12 ) use model npn10x10
// else if ( area < 400e-12 ) use model npn20x20
// else use model npn_default</pre>
```

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```
inline subckt npn_mod (c b e s)
  parameters area=5e-12
if ( area < 100e-12 ) {
     npn_mod (c b e s) npn10x10  // 10u * 10u, inline device
} else if ( area < 400e-12 ) {
     npn_mod (c b e s) npn20x20  // 20u * 20u, inline device
} else {
     npn_mod (c b e s) npn_default  // 5u * 5u, inline device
}
ends npn_mod
q1 (1 2 0 0) npn_mod area=350e-12  // gets 20x20 model
q2 (1 3 0 0) npn_mod area=25e-12  // gets 10x10 model
q3 (1 3 0 0) npn_mod area=1000e-12  // gets default model</pre>
```

Include File (include)

Description

File inclusion allows the circuit description to be spread over several files. The include statement itself is replaced by the contents of the file named. An included file may also contain include statements. If the name given is not an absolute path specification, then it is taken relative to the directory of the file currently being read.

In order to read existing SPICE library and model files, Spectre automatically switches to SPICE input mode when it opens an include file. Thus, all files that use the Spectre native language must begin with a simulator lang=spectre statement. The one exception is files that end with a ".scs" file extension which are treated specially and are read in Spectre input mode. This language mode treatment applies to files included by both Spectre's include statement, and CPP's #include statement.

After reading the include file, Spectre restores the language processing mode to what it was before the file was included, and continues reading the original file starting at the line after the include statement. Lines cannot be continued across file boundaries.

The CPP #include statement differs from Spectre's include statement in that CPP macro processing will not be performed on files included by Spectre, but will be performed on files included by CPP. If your netlist contains a #include statement, you must run CPP to perform this inclusion, otherwise an error will occur.

Spectre Syntax

If the file to be included cannot be found in the same directory as the including file, both Spectre's include and CPP's #include will search for the file to be included along the search path specified by the -I command line arguments.

Spectre's include statement allows you to embed special characters in the name of the file to be included. Spectre's include statement will automatically expand the "~" character to the users home directory, and will expand environment variables and % codes, such as

include "~/models/\${SIMULATOR}_pd/npn.scs"

which will look in the directory given by the environment variable SIMULATOR followed by _pd, which is under the models directory, in the users home directory. Note: These special character features are not available using CPP's #include statement.

Definition

include "filename"

Spectre Netlist Keywords (keywords)

Description

The following lists the reserved Spectre keywords, including netlist keywords, built-in algebraic and trigonometric functions, and built-in mathematical and physical constants. When creating a netlist, you should avoid using any of the keywords from this list in any context other than that in which it was intended. Creating node names, parameter names, instance names, or model names from any of these keywords will result in an error.

Keyword	Keyword Type
M_1_PI	Mathematical Constant
M_2_PI	Mathematical Constant
M_2_SQRTPI	Mathematical Constant
M_DEGPERRAD	Mathematical Constant
M_E	Mathematical Constant
M_LN10	Mathematical Constant
M_LN2	Mathematical Constant

Spectre Circuit Simulator Reference Spectre Syntax

Keyword	Keyword Type
M_LOG10E	Mathematical Constant
M_LOG2E	Mathematical Constant
M_PI	Mathematical Constant
M_PI_2	Mathematical Constant
M_PI_4	Mathematical Constant
M_SQRT1_2	Mathematical Constant
M_SQRT2	Mathematical Constant
M_TWO_PI	Mathematical Constant
P_C	Mathematical Constant
P_CELSIUS0	Mathematical Constant
P_EPS0	Mathematical Constant
P_H	Mathematical Constant
P_K	Mathematical Constant
P_Q	Mathematical Constant
P_U0	Mathematical Constant
abs	Algebraic Function
acos	Trigonometric Function
acosh	Trigonometric Function
altergroup	Netlist Keyword
asin	Trigonometric Function
asinh	Trigonometric Function
atan	Trigonometric Function
atan2	Trigonometric Function
atanh	Trigonometric Function
ceil	Algebraic Function
correlate	Netlist Keyword
cos	Trigonometric Function

Spectre Circuit Simulator Reference Spectre Syntax

Keyword	Keyword Type
cosh	Trigonometric Function
else	Netlist Keyword
end	Netlist Keyword
ends	Netlist Keyword
exp	Algebraic Function
export	Netlist Keyword
floor	Algebraic Function
fmod	Algebraic Function
for	Netlist Keyword
function	Netlist Keyword
global	Netlist Keyword
hypot	Algebraic Function
ic	Netlist Keyword
if	Netlist Keyword
inline	Netlist Keyword
int	Algebraic Function
library	Netlist Keyword
local	Netlist Keyword
log	Algebraic Function
log10	Algebraic Function
march	Netlist Keyword
max	Algebraic Function
min	Algebraic Function
model	Netlist Keyword
nodeset	Netlist Keyword
parameters	Netlist Keyword
paramset	Netlist Keyword

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Keyword	Keyword Type
plot	Netlist Keyword
pow	Algebraic Function
print	Netlist Keyword
pwr	Netlist Keyword
real	Netlist Keyword
return	Netlist Keyword
save	Netlist Keyword
sens	Netlist Keyword
sin	Trigonometric Function
sinh	Trigonometric Function
sqrt	Algebraic Function
statistics	Netlist Keyword
subckt	Netlist Keyword
tan	Trigonometric Function
tanh	Trigonometric Function
to	Netlist Keyword
truncate	Netlist Keyword
vary	Netlist Keyword

Library - Sectional Include (library)

Description

Library inclusion allows the circuit description to be spread over several files. The library statement itself is replaced by the contents of the section of the library file. A library section may also contain library reference statements. If the file name given is not an absolute path specification, then it is taken relative to the directory of the file currently being read.

There are two kinds of library statements. One that references a library section, and one that defines a library section. The definition of a library section is prohibited in the netlist.

Spectre Syntax

In order to read existing SPICE library and model files, Spectre automatically switches to SPICE input mode when it opens a library file. Thus, all files that use the Spectre native language must contain a simulator lang=spectre statement within each section of the library or the file can have a scs filename extension. After reading the library section, Spectre restores the language processing mode and continues reading the original file starting at the line after the library statement. Lines cannot be continued across file boundaries.

Spectre allows only one library per file, but a library may contain multiple sections (typically one section per process corner for example.)

Definition

Inside netlist (reference library section)

Sample Library

```
library corner_lib
section tt
  model nch bsim3v3 type=n mobmod=1 capmod=2 version=3.1
   + xj=1.7e-7  vsat=7.99e4 at=3.6e4 a0=0.799 ags=0.4
   + a1=0 a2=1 keta=-0.05 nch=2.8e17 ngate=1.31e20 k1=0.74
   model pch bsim3v3 type=p mobmod=1 capmod=2 version=3.1
   + xj=1.7e-7  vsat=1.38e5 at=1e5 a0=1.3 ags=0.3
   + a1=1.1e-4 a2=1 keta=0 nch=4.1e17 ngate=7.6e19 k1=0.88
  model knpn bjt is=10e-13 bf=170 va=58.7 ik=5.63e-3 rb=rbn rbm=86
   + re=3.2 cje=0.25e-12 pe=0.76 me=0.34 tf=249e-12 cjc=0.34e-12 pc=0.55
   + mc = 0.35 ccs = 2.4e - 12 ms = 0.35 ps = 0.53 rc = 169
   model kpnp bjt type=pnp is=10e-13 bf=60 va=43.1 ik=0.206e-3 rb=rbp rbm=64.3
   + re=33.8 cje=0.16e-12 pe=0.5 me=0.26 tf=36e-9 cjc=0.72e-12 pc=0.58
   + mc=0.34 ccs=2.5e-12 ps=0.53 ms=0.35 rc=276
endsection
section ss
  model nch bsim3v3 type=n mobmod=1 capmod=2 version=3.1
   + xj=1.7e-7  vsat=7.99e4 at=3.6e4 a0=0.799 ags=0.4
   + a1=0 a2=1 keta=-0.05 nch=2.8e17 ngate=1.31e20 k1=0.74
  model pch bsim3v3 type=p mobmod=1 capmod=2 version=3.1
   + x_{j=1.7e-7} vsat=1.38e5 at=1e5 a0=1.3 ags=0.3
   + a1=1.1e-4 a2=1 keta=0 nch=4.1e17 ngate=7.6e19 k1=0.88
  model knpn bjt is=10e-13 bf=70 va=58.7 ik=5.63e-3 rb=rbn rbm=86
   + re=3.2 cje=0.25e-12 pe=0.76 me=0.34 tf=249e-12 cjc=0.34e-12 pc=0.55
   + mc=0.35 ccs=2.4e-12 ms=0.35 ps=0.53 rc=169
   model kpnp bjt type=pnp is=10e-13 bf=30 va=43.1 ik=0.206e-3 rb=rbp rbm=64.3
```

Spectre Syntax

```
+ re=33.8 cje=0.16e-12 pe=0.5 me=0.26 tf=36e-9 cjc=0.72e-12 pc=0.58
   + mc=0.34 ccs=2.5e-12 ps=0.53 ms=0.35 rc=276
endsection
section ff
  model nch bsim3v3 type=n mobmod=1 capmod=2 version=3.1
  + xj=1.7e-7 vsat=7.99e4 at=3.6e4 a0=0.799 ags=0.4
  + a1=0 a2=1 keta=-0.05 nch=2.8e17 ngate=1.31e20 k1=0.74
  model pch bsim3v3 type=p mobmod=1 capmod=2 version=3.1
  + xj=1.7e-7 vsat=1.38e5 at=1e5 a0=1.3 ags=0.3
  + a1=1.1e-4 a2=1 keta=0 nch=4.1e17 ngate=7.6e19 k1=0.88
  model knpn bit is=10e-13 bf=220 va=58.7 ik=5.63e-3 rb=rbn rbm=86
  + re=3.2 cje=0.25e-12 pe=0.76 me=0.34 tf=249e-12 cjc=0.34e-12 pc=0.55
  + mc=0.35 ccs=2.4e-12 ms=0.35 ps=0.53 rc=169
  model kpnp bjt type=pnp is=10e-13 bf=90 va=43.1 ik=0.206e-3 rb=rbp rbm=64.3
   + re=33.8 cje=0.16e-12 pe=0.5 me=0.26 tf=36e-9 cjc=0.72e-12 pc=0.58
   + mc=0.34 ccs=2.5e-12 ps=0.53 ms=0.35 rc=276
endsection
endlibrary
```

Node Sets (nodeset)

Description

The nodeset statement is used to provide an initial guess for nodes in any DC analysis or the initial condition calculation for the transient analysis. It can occur multiple times in the input, the information provided in all the occurrences is collected. For more information, read the description of DC analysis.

Definition

```
nodeset <node=value> ...
```

This statement takes a list of signals as an argument. The concept of nodes has been generalized to signals where a signal is a value associated with a topological node of the circuit or some other unknown that is solved by the simulator, such as the current through a inductor or the voltage of the internal node in a diode. Topological nodes can be either at the top-level or in a subcircuit.

For example,

```
nodeset 7=0 out=1 OpAmp1.comp=5 L1:1=1.0u
```

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where 7=0 implies that node 7 should be about 0V, node out should be about 1V, node comp in subcircuit OpAmp1 should be about 5V, and the current through the first terminal of L1 should be about 1uA.

Parameter Soft Limits (param_limits)

Description

The parameter values passed to Spectre components and analysis are subject to both hard and soft limits. If you set a parameter to a value that violates a hard limit, such as giving z0=0 to a transmission line, Spectre issues an error message and quits. If the given parameter value violates a soft limit, only a warning is issued, but Spectre uses the value of the component as given. Hard limits are used to prevent you from using values that would cause Spectre to fail or put a model in an invalid region. Soft limits are used to call attention to unusual parameter values that might have been given mistakenly. If a parameter value violates a soft limit, a message similar to one of the following sample messages is printed:

```
Parameter rb has the unusually small value of 1uOhms.
```

or

```
Parameter rb has the unusually large value of 1MOhms.
```

Spectre has built-in soft limits on a few parameter values. However, it is possible for you to override these limits, or provide limits on parameters that do not have built-in limits. To do so, create a parameter range limits file, and invoke Spectre giving the name of the file after the +param command line option. For example,

```
spectre +param limits-file input-file
```

Limits are given using the following syntax:

```
[PrimitiveName] [model] [LowerLimit <[=]] [|]Param[|] [<[=] UpperLimit]
```

The limits can be given as strict (using <=) or nonstrict (using <). If the limits are strict, there can be no space between < and =. The limits for one parameter are given on one line. There is no way of continuing the specification of the limits for a parameter over more than one line. If a parameter is given more than once, the limits given the last time override earlier limits. The primitive name must be a Spectre primitive name, not a name used for SPICE compatibility. So, for example, mos3 must be used rather than mos. Parameter limits can be written using Spectre native mode metric scale factors. Thus a limit of $f \le 1.0e6$ could also written as $f \le 1M$.

Here are some examples.

```
mos3 0.5u <= 1 <= 100u
0.5u <= w
```

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```
0 < as <= 1e-8

0 < ad <= 1e-8

model |vto| <= 3
```

Notice that it is not necessary to give the primitive name each time. If not given, it is assumed to be the same as the previous parameter. Upper and lower limits may be given, and if not given there will be no limit on the parameter value. Thus, in the example, if w is less than 0.5um, a warning will be issued, but there is no limit on how large w can be. If a parameter is mentioned, but no limits given, then all limits are disabled for that parameter. Limits are placed on model parameters by giving the model keyword. If the model keyword is not given, the limits are applied to instance parameters. Notice that you can also place upper or lower limits on the absolute value of a parameter. For example,

```
resistor 0.1 < |r| < 1M
```

indicates that the absolute value of r should be greater than 0.1 Ohm and less than 1 MOhm. There can be no spaces between the absolute value symbols and the parameter name.

Here are some more examples.

```
1 <= x < 0.5
1 <= y <= 1
1 < z < 1
```

In the first case the lower bound is larger than the upper bound, which indicates that the range of x is all real numbers except those from 0.5 to 1 and 0.5 itself. The limits are applied separately, thus x must be both greater than or equal to 1 ($1 \le x$) and less than 0.5 (x < 0.5). The second case specifies that y should be 1 and the third case specifies that z should not be 1.

It is possible to specify limits for any scalar parameter that takes either a real number, an integer, or an enumeration. To specify the limits of a parameter that takes enumerations use the indices associated with the enumerations. For example, consider the region parameter of the bjt. There are four possible regions: off, fwd, rev, or sat (see spectre -help bjt). Each enumeration is assigned a number starting at 0 and counting up. Thus, off=0, fwd=1, rev=2, and sat=3. The specification

```
bjt 3 <= region <= 1
```

indicates that a warning should be printed if region=rev because the conditions (3 <= region) and (region <= 1) exclude only (region=2) and region 2 is rev.

It is possible to read a parameter limits file from within another file. To do so, use an include statement. For example,

```
include "filename"
```

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will temporarily suspend the reading of the current file until the contents of filename have been read. Include statements may be nested arbitrarily deep with the condition that the operating system may limit the number of files that Spectre may have open at once. Paths in file names are taken to be relative to the directory that contains the current file, not from the directory in which Spectre was invoked.

Spectre can be instructed to always read a parameter limits file by using the SPECTRE_DEFAULTS environment variable. For example, if you put the following in you shell initialization file (.profile for sh, .cshrc for csh)

```
setenv SPECTRE DEFAULTS "+param /cds/etc/spectre/param.lmts"
```

Spectre would always read the specified limits file.

Netlist Parameters (parameters)

Description

The Spectre native netlist language allows parameters to be specified and referenced in the netlist, both at the top-level scope and within subcircuit declarations (run spectre -h subckt for more details on parameters within subcircuits).

Definition

```
parameters <param=value> [param=value] ...
```

Examples

```
simulator lang=spectre
parameters p1=1 p2=2
                               // declare some parameters
rl (1 0) resistor r=pl
                               // use a parameter, value=1
r2 (1 0) resistor r=p1+p2
                               // use parameters in an expression, value=3
               // "s1" is defined below, pass in value 8 for "p4"
x1 s1 p4=8
subckt s1
parameters p1=4 p3=5 p4=6
                               // note: no "p2" here, p1 "redefined"
r1 (1 0) resistor r=p1
                               // local definition used: value=4
r2 (1 0) resistor r=p2
                               // inherit from parent(top-level) value=2
                               // use local definition, value=5
r3 (1 0) resistor r=p3
r4 (1 0) resistor r=p4
                               // use passed-in value, value=8
r5 (1 0) resistor r=p1+p2/p3
                               // use local+inherited/local = (4+2/5) = 4.4
```

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time_sweep tran start=0 stop=(p1+p2)*50e-6 // use 5*50e-6 = 150 us

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dc_sweep dc param=p1 values=[0.5 1 +p2 (sqrt(p2*p2))] // sweep p1

Parameter Declaration

Parameters can be declared anywhere in the top-level circuit description or on the first line of a subcircuit definition. Parameters must be declared before they are used (referenced). Multiple parameters can be declared on a single line. When parameters are declared in the top-level, their values must be specified. When parameters are declared within subcircuits, their default values are optionally specified.

Parameter Inheritance

Subcircuit definitions inherit parameters from their parent (enclosing subcircuit definition, or top-level definition). This inheritance continues across all levels of nesting of subcircuit definitions, that is, if a subcircuit s1 is defined, which itself contains a nested subcircuit definition s2, then any parameters accessible within the scope of s1 are also accessible from within s2. Also, any parameters declared within the top-level circuit description are also accessible within both s1 and s2. However, any subcircuit definition can redefine a parameter that it has inherited. In this case, if no value is specified for the redefined parameter when the subcircuit is instantiated, then the redefined parameter uses the locally defined default value, rather than inheriting the actual parameter value from the parent.

Parameter Namespace

Parameter names must not conflict with device or analysis instance names, that is, it is not possible to reference a parameter called "r1" if there is an instance of a resistor (or other device or analysis) called "r1". Parameter names must also not be used where a node name is expected.

Parameter Referencing

Spectre netlist parameters can be referenced anywhere that a numeric value is normally specified on the right-hand side of an "=" sign or within a vector, where the vector itself is on the right-hand side of an "=" sign. This includes referencing of parameters in expressions (run spectre -h expressions for more details on netlist expression handling), as indicated in the preceding examples. You can use expressions containing parameter references when specifying device or analysis instance parameter values (for example specifying the resistance of a resistor or the stop time of a transient analysis, as outlined in the preceding example), when specifying model parameter values in model cards (for example specifying "bf=p1*0.8" for a bipolar model parameter, bf), or when specifying initial conditions and nodesets for individual circuit nodes.

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Altering/Sweeping Parameters

Just as certain Spectre analyses (for example sweep, alter, ac, dc, noise, sp, xf) can sweep device instance or model parameters, they can also sweep netlist parameters. Run spectre -h <analysis> to see the particular details for any of these analyses, where <analysis> is the analysis of interest.

Temperature as a parameter

You can use the reserved parameters temp and tnom anywhere that an expression can be used, including within expressions and user-defined functions. The "temp" parameter always represents the simulator (circuit) temperature, and "tnom" always represents the measurement temperature. All expressions involving "temp" or "tnom" are re-evaluated any time the circuit temperature or measurement temperature changes.

You can also alter or sweep the "temp" and "tnom" parameters using any of the techniques available for altering or sweeping netlist or subcircuit parameters (with the exception of altergroups).

This capability allows you to write temperature dependent models for example, by using "temp" in an equation for a model or instance parameter. For example

```
r1 1 0 res r=(temp-tnom)*15+10k // temp is temperature
o1 options temp=55 // causes a change in above resistor r1
```

Reserved Parameters

The following parameters are reserved, and may not be declared as either top-level parameters or subcircuit parameters: temp, tnom, scale, scalem, freq, time.

Parameter Set - Block of Data (paramset)

Description

A parameter set is a block of data, which can be referenced by a sweep analysis. Within a parameter the first row contains an array of top-level netlist parameters. All other rows contain numbers which are used to alter the value of the parameters during the sweep. Each row represents an iteration of the sweep. This data should be bound within braces. The opening brace is required at the end of the line defining the parameter. The parameter cannot be defined within subcircuits or cannot be nested.

Spectre Syntax

Definition

```
<Name> paramset {
     <list of parameter names>
      <list of number>
     [more rows of numbers]
}
```

Example

```
data paramset {
   p1  p2  p3
   1.1  2.2  3.3
   4.4  5.5  6.6
}
```

Output Selections (save)

Description

The save statement indicates that the values of specific nodes or signals should be saved in the output file. It works in conjunction with the save parameter on most analyses. The output file is written in Cadence Waveform Storage Format (WSF), Cadence Parameter Storage Format (PSF) or in Nutmeg/SPICE3 format as controlled by a command line argument or a global option (see the options statement). The proper postprocessor should be used to view the output, generate plots, or do any further processing.

Definition

```
save <node|component|terminal> ...
```

This statement takes a list of signals as an argument. The concept of nodes has been generalized to signals where a signal is a value associated with a topological node of the circuit or some other unknown that is solved by the simulator, such as the current through a inductor or the voltage of the internal node in a diode. Topological nodes can be either at the top-level or in a subcircuit.

For example,

```
save 7 out OpAmp1.comp M1:currents D3:oppoint L1:1 R4:pwr
```

which tells that node 7, node out, node comp in subcircuit OpAmp1, the currents through the terminals of M1, the oppoint information for diode D3, the current through the first terminal of

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L1, and the instantaneous power dissipated by R4 should be saved. These outputs are saved in addition to any outputs specified with the save parameter on the analysis.

To specify a component terminal current, give the name of the component and the name or the index of the terminal separated by a colon. If currents is specified after the component and the colon, then all the terminal currents for the component are saved unless the component has only two terminals, in which case only the current through the first terminal is saved. Current is positive if it enters the terminal flowing into the component.

If a component name is followed by a colon and oppoint, then the operating point information associated with the component is computed and saved. If the colon is followed by an operating point parameter name (see each component for list of operating point parameters), then the value of that parameter is output.

If only a component name is given, all available information about the component, including the terminal currents and the operating point parameter values, is saved.

Sensitivity Analyses (sens)

Description

Use the sens control statement to find sensitivities of the output variables with respect to component and instance parameters for the list of the analyses performed. Currently DC and AC sensitivity analyses are supported. The results of the sensitivity analyses are stored in the output files written in Cadence Parameter Storage Format (PSF). In addition, you can use +sensdata filename command line argument or a global option (see the options statement) to direct sensitivity analyses results into a specified ASCII file.

Definition

```
where
    output_variables_list = ovar1 ovar2 ...
    design_parameters_list = dpar1 dpar2 ...
    analyses_list = anal1 anal2 ...
```

The list of the design parameters may include valid instance and model parameters. You can also specify device instances or device models without a modifier. In this case Spectre will attempt to compute sensitivities with respect to all corresponding instance or model parameters. Caution should be exercised in using this option as warnings or errors may be generated since many instance and model parameters cannot be modified. If no design

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parameters are specified then all the instance and model parameters are added. The list of the output variables for both AC and DC analyses may include node voltages and branch currents. For DC analyses, it also may include device instance operating point parameters.

Examples

```
sens (q1:betadc 2 Out) to (vcc:dc nbjt1:rb) for (analDC)
```

For this statement DC sensitivities of betadc operating point parameter of transistor q1 and of nodes 2 and Out will be computed with respect to the dc voltage level of voltage source vcc and the model parameter rb for the DC analysis analDC. The results will be stored in the output file analDC.sens.dc.

```
sens (1 n2 7) to (q1:area nbjt1:rb) for (analAC)
```

For this statement AC sensitivities of nodes 1, n2, 7 will be computed with respect to the area parameter of transistor q1 and the model parameter rb for each frequency of the AC analysis analAC. The results will be stored in the output file analAC.sens.ac.

```
sens (1 n2 7) for (analAC)
```

For this statement AC sensitivities of nodes 1, n2, 7 will be computed with respect to all instance and model parameters of all devices in the design for each frequency of the AC analysis analAC. The results will be stored in the output file analAC.sens.ac.

```
sens (vbb:p q1:int_c q1:gm 7) to (q1:area nbjt1:rb) for (anaIDC1)
```

For this statement DC sensitivities of the branch current vbb:p, the operating point parameter gm of the transistor q1, the internal collector voltage $q1:int_c$ and the node 7 voltage will be computed with respect to the instance parameter area for instance q1 and the model parameter rb for model nbjt1.

SpectreHDL Usage and Language Summary (spectrehdl)

Description

SpectreHDL is a proprietary analog hardware description language. It allows analog circuit behavior to be described at a high level of abstraction, using a language which is similar to Verilog-A (run spectre -h veriloga for some details on the Verilog-A modeling language supported by spectre). Behavioral descriptions of modules/components may be instantiated in a Spectre netlist along with regular Spectre primitives.

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SpectreHDL descriptions are written in file(s) separate from the Spectre netlist file. These descriptions are written in modules (see the module alpha below). To include a module in the Spectre netlist, first add the line

```
ahdl_include "Ahdlfile.def"
```

to the Spectre netlist file (where Ahdlfile.def is the name of the file in which the required module is defined). The module is instantiated in the Spectre netlist in the same manner as Spectre primitives. For example,

```
name (node1 node2) alpha arg1=4.0 arg2=2 arg3="parameterized resistor"
```

This instantiates an element alpha, having two nodes and three parameters.

SpectreHDL modules can be debugged using hdldebug. hdldebug has a GUI and a command line mode. Please refer to the *Verilog-A Debugging Tool User Guide* for more information.

Module Template

The following is a SpectreHDL module template

```
module alpha( n1, n2 ) ( arg1, arg2, arg3 )
node [V,I] n1, n2;
parameter real arg1 = 2.0;
parameter integer arg2;
parameter string arg3;
        real local;
        // this is a comment
        initial {
                 // initializations performed before the
                // start of an analysis.
        analog {
                // module behavioral description
                V(n1, n2) \leftarrow I(n1, n2) * arg1;
        final {
                // tasks performed at the end of an analysis
        }
}
```

Spectre Syntax

Language Summary

The following provides a summary of the SpectreHDL analog hardware description language. For more information refer to the *SpectreHDL Reference Manual*.

Derivative and Integral Operators

dot(x)	Differentiate x wrt time.
<pre>integ(x <, ic <, assert>>)</pre>	Integrate x wrt time. Output = ic during DC analysis. assert causes the integration to be reset.
<pre>idtmod(x, <ic <,="" modulus="" offset=""> >)</ic></pre>	Circular Integration of x wrt time. Output = ic during DC analysis. Integration is performed with given offset and modulus if specified.

Built-In Mathematical Functions

abs(x)	Absolute value
floor(x)	Largest integer $< x$
ceil(x)	Smallest integer > x
ln(x)	Natural logarithm
log(x)	Decimal logarithm
exp(x)	Exponential
sqrt(x)	Square root
min(x, y)	Minimum
max(x, y)	Maximum
pow(x, y)	x to the power of y

Spectre Syntax

Simulator Time-Step Control Functions

<pre>\$threshold(x, direction <, abstol <, reltol_factor>>)</pre>	Set breakpoint when x crosses zero.
<pre>\$bound_step(max_step)</pre>	Limit time step, (time step <= max_step).
<pre>\$break_point(target <, period>)</pre>	Set breakpoints at time = target and at times = N*period + target if period is specified.
<pre>\$last_crossing(x, direction)</pre>	Return time when expression last crossed zero in a given direction.

Waveform Filter Functions

<pre>\$transition(x <, delay <, trise <, tfall>>>)</pre>	Specify details of signal transitions. For efficient simulation, it is recommended that x not be a continuous signal, i.e. a function of a probe. See the <u>SpectreHDL Reference</u> manual for further explanation of this issue.
<pre>\$slew(x <, SRpos <, SRneg>>)</pre>	Model slew rate behavior.
<pre>\$tdelay(x, time_delay, max_delay)</pre>	Response(t) = $x(t - time_delay)$.
<pre>\$zdelay(x <, period <, ttransition <, sample offset time <, ic>>>>)</pre>	Fixed period sample and hold function.
<pre>\$zi_nd(x, numer, denom, period <, ttransition <,sample offset time>>)</pre>	z-domain filter function, numerator-denominator form.
<pre>\$zi_zd(x, zeros, denom, period <, ttransition <,sample offset time>>)</pre>	z-domain filter function, zero- denominator form.
<pre>\$zi_np(x, numer, poles, period <, ttransition <,sample offset time>>)</pre>	z-domain filter function, numerator-pole form.
<pre>\$zi_zp(x, zeros, poles, period <, ttransition <,sample offset time>>)</pre>	z-domain filter function, zero-pole form.
<pre>\$laplace_nd(x, numer, denom, <, abstol >)</pre>	s-domain filter function, numerator-denominator form.

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<pre>\$laplace_zd(x, zeros, denom, <, abstol >)</pre>	s-domain filter function, zero- denominator form.
<pre>\$laplace_np(x, numer, poles, <, abstol >)</pre>	s-domain filter function, numerator-pole form.
<pre>\$laplace_zp(x, zeros, poles, <, abstol >)</pre>	s-domain filter function, zero-pole form.

Noise Functions

<pre>\$white_noise(power <, tag >)</pre>	Generates white noise with given power. Noise contributions with the same tag are combined for a module.
<pre>\$flicker_noise(power, exp <, tag >)</pre>	Generates pink noise with given power at 1 Hz that varies in proportion to 1/f^exp. Noise contributions with the same tag are combined for a module.
<pre>\$noise_table(vector <, tag >)</pre>	Generates noise where power is determined by linear interpolation from the given vector of frequency-power pairs. Noise contributions with the same tag are combined for a module.

AC Analysis Stimuli

\$ac_stim(<analysis_name <, mag > >)

Small signal source of specified magnitude, active for given analysis.

Interpolation Functions

\$build_table(type, response, inVec1, sizeVec1 <, inVec2,
sizeVec2 ...>)
Build a table for B-Spline
interpolation.

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Spectre Syntax

\$interpolate(interp_table, v1<, v2 <, v3 <, v4 >>>)

Perform interpolation at given point.

Simulator IO Functions

Print data to stdout every time step.
Print data to stdout every iteration.
Print data to a file every time step.
Print data to a file every iteration.
Read data from a file.
Warning message.
Error message. Abort analysis.
Fatal message. Abort simulation.
Open a file.
Flush a file to disk.
Close a file.
Open a pipe with given command in given mode.
Close a pipe.
Read from a file into a 2-D real array.
Write from a 2-D real array to a file.
Halt the simulation, printing given string.
Sends a command to the operating system.
Create a string from arguments in given format.
Compares two strings lexicographically.
Converts a string, int_as_str, to an integer.
Converts a string, real_as_str, to a real.

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Spectre Circuit Simulator Reference Spectre Syntax

<pre>\$strcpy(des_str, src_str)</pre>	Copies src_str to des_src.
<pre>\$strcat(des_str, src_str)</pre>	Appends src_str to des_src.
<pre>\$strlen(str)</pre>	Returns the number of characters in str.
<pre>\$substr(input_str, start_pos, end_pos)</pre>	Returns the substring of input_str between start_pos and end_pos.
<pre>\$strstr(input_str, sub_str)</pre>	Returns the first position where sub_str is found in input_str.
<pre>\$strchr(input_str, character)</pre>	Returns the first position where character is found in input_str.
<pre>\$strrchr(input_str, character)</pre>	Returns the last position where character is found in input_str.
<pre>\$strspn(input_str, span_set)</pre>	Returns the number of continuous characters from the start of input_str that are in span_set.
<pre>\$strcspn(input_str, span_set)</pre>	Returns the number of continuous characters from the start of input_str that are not in span_set.
<pre>\$ascii(character)</pre>	Returns the ascii code of character.

Simulator Environment Functions

<pre>\$time()</pre>	Returns current simulation time.
<pre>\$temp()</pre>	Returns ambient simulation temperature.
<pre>\$vt(<temp>)</temp></pre>	Returns thermal voltage. If temp is defined, returns the thermal voltage at temp.
<pre>\$analysis(analysis_string1<, analysis_string2 <,>>)</pre>	Returns true(1) if the current analysis phase matches one of the given analyses strings. Valid analyses strings are dc, tran, ac, pss, noise, pdisto, pac, pnoise, pxf, sp, tdr, xf, static, or ic.

Spectre Syntax

Simulator Tolerance Functions

\$reltol() Returns relative tolerance.

\$abstol(name) Returns absolute tolerance of quantity name.

Parameter Functions

\$param_given(param) Returns 1 if param was set. param can be a model

parameter or an instance parameter.

\$pwr(x) Assignment of model power consumption. Adds the

expression x to the pwr parameter of a module.

Data Types

integer	Discrete numerical type.
real	Continuous numerical type.
string	Text string type.
stream	File pointer and text stream type.
<pre>enum { name1 <, name2 <, name3 <, >>> }</pre>	Discrete name type.
void	Null or empty type.
table	Interpolation table type.
node [PotentialName, FlowName]	Interconnection point type.

Data Qualifiers

paramete	Indicates that a variable is a parameter and so may be given a different value
T	when the module is instantiated and may have a range specifier.

Indicates that a variable must be given a constant value when declared that can never be changed.

Spectre Syntax

global

Used only for internal nodes. Means that the internal node is an alias for a global node of the same name in the netlist.

Structural Statements

Structural statements are used inside the module block but outside the analog, final and initial blocks

```
model module_or_primative new_model (<param1 =
expr1 <,..>>);

module_or_primative inst_name (<nodel <, ..>>
)(<param1 = expr1 <,..>>);

Used to create a model called
new_model from
module_or_primative.

Creates a new instance of
module_or_primative called
inst_name.
```

SpectreRF Summary (spectrerf)

Description

SpectreRF is a optional collection of analyses that are useful for circuits that are driven with a large periodic signal. Examples include mixers, oscillators, switched-capacitor filters, sample-and-holds, chopper stabilized amplifiers, frequency multipliers, frequency dividers, and samplers. They efficiently and directly compute the periodic and quasiperiodic steady-state solution of such circuits. They are capable of computing the large-signal and small-signal behavior, including noise behavior. Thus, SpectreRF is capable of computing the noise figure or intermodulation distortion of a mixer, the phase noise and harmonic distortion of an oscillator, and the frequency-response and noise behavior of a switched-capacitor filter. For more information on the SpectreRF analyses, run spectre -help analysisName where analysisName is pss, pac, pxf, pnoise, pdisto, or envlp.

Spectre Syntax

Subcircuit Definitions (subckt)

Description

Hierarchical Circuit Description

The subckt statement is used to define a subcircuit. Subcircuit definitions are simply circuit macros that can be expanded anywhere in the circuit any number of times. When an instance in your input file refers to a subcircuit definition, the instances specified within the subcircuit are inserted into the circuit. Subcircuits may be nested. Thus a subcircuit definition may contain instances of other subcircuits. Subcircuits may also contain component, analysis or model statements. Subcircuit definitions may also be nested, in which case the innermost subcircuit definition can only be referenced from within the subcircuit in which it is defined, and cannot be referenced from elsewhere.

Instances that instantiate a subcircuit definition are referred to as subcircuit calls. The node names (or numbers) specified in the subcircuit call are substituted, in order, for the node names given in the subcircuit definition. All instances that refer to a subcircuit definition must have the same number of nodes as are specified in the subcircuit definition and in the same order. Node names inside the subcircuit definition are strictly local unless declared otherwise in the input file with a global statement.

Subcircuit Parameters

Parameter specification in subcircuit definitions is optional. In the case of nested subcircuit definitions, any parameters which have been declared for the outer subcircuit definition are also available within the inner subcircuit definition. Any parameters that are specified are referred to by name optionally followed by an equals sign and a default value. If, when making a subcircuit call, you do not specify a particular parameter, this default value is used in the macro expansion. Subcircuit parameters can be used in expressions within the subcircuit consisting of subcircuit parameters,

constants, and various mathematical operators. Run spectre -h expressions for more details on Spectre expression handling capability. Run spectre -h parameters for more details on how Spectre handles netlist parameters, including subcircuit parameters, and how they inherit within nested subcircuit definitions.

Subcircuits always have an implicitly defined parameter m. This parameter is passed to all components in the subcircuit and each component is expected to multiply it by its own multiplicity factor. In this way, it is possible to efficiently model several copies of the subcircuit in parallel. It is an error to attempt to explicitly define m on a parameters line. Also, because m is only implicitly defined, it is not available for use in expressions in the subcircuit.

Spectre Syntax

Inline Subcircuits

An inline subckt is a special case of a subckt where one of the devices or models instantiated within this subckt does not get its full hierarchical name, but rather inherits the subckt call name itself. An inline subckt is syntactically denoted by the presence of the keyword inline before the subckt. It is called in the same manner as a regular subcircuit. The body of the inline subcircuit can typically contain one of the following, corresponding to different use models:

- multiple device instances (one of which is the "inline" component)
- multiple device instances, (one of which is "inline") and one or more parameterized models
- a single "inline" device instance and a parameterized model to which the device instance refers

The inline component is denoted by giving it the same name as the inline subcircuit itself. When the subcircuit is flattened, the inline component does not take on a hierarchical name such as X1.M1, but rather takes on the name of the subckt call itself, such as X1. Any non-inline components in the subckt take on the regular hierarchical name, just as if the subcircuit were a regular subckt (i.e. not an inline subckt).

Probing the Inline Device

Spectre allows the following list of items to be saved or probed for primitive devices. These would also apply to devices modeled as the inline components of inline subcircuits:

- 1. all terminal currents e.g. save q1:currents"
- 2. specific (index) terminal current e.g. save q1:1 (#1=collector)
- 3. specific (named) terminal current e.g. save q1:b ("b"=base)
- 4. save all operating point info e.g. save q1:oppoint
- 5. save specific operating point info e.g. save q1:vbe
- 6. save all currents and oppoint info e.g. save q1

Parameterized Models and Inline Subckts

Inline subckts can be used in the same way as regular subcircuits to implement parameterized models, however inline subckts provide some powerful new options. When an inline subcircuit contains both a parameterized model and an inline device which references

Spectre Syntax

that model, then the user can create instances of the device, and each device will automatically get an appropriately scaled model assigned to it. For example, the instance parameters to an inline subckt could represent something like emitter width and length of a BJT device and within the subckt a model card could be created which is parameterized for emitter width and length and scales accordingly. When the designer instantiates the macro, he/she supplies the values for the emitter width and length, and a device is instantiated with an appropriate geometrically scaled model. Again, the inline device does not get a hierarchical name, and can be probed in the same manner as the inline device in the previous section on modeling parasitics, that is, it can be probed just as if it was a simple device, and not actually embedded in a subckt.

Automatic Model Selection using Inline Subckts

See spectre -h if for a description on how to combine Spectre's "structural if" statement with inline subckts to perform automatic model selection based on *any* netlist/subckt parameter.

Definition

```
[inline] subckt <Name> (<nodel> ... <nodeN>)
        [parameters <namel>=<valuel> ... <nameN>=<valueN>]
        ...
        <component, analysis, and/or model statements>
        ...

ends [Name] Example 1: subckt
subckt coax (i1 o1 i2 o2)
parameters zin=50 zout=50 vin=1 vout=1 len=0
   inner i1 o1 i2 o2 tline z0=zin vel=vin len=len
   outer o1 0 o2 0 tline z0=zout vel=vout len=len
ends coax
```

defines a parameterized coaxial transmission line macro from two ideal transmission lines. To instantiate this subcircuit, one could use an instance statement such as:

```
Coax1 pin nin out gnd coax zin=75 zout=150 len=35m
```

Example 2: inline subckt - Parasitics

Consider the following example of an inline subcircuit, which contains a mosfet instance, and two parasitic capacitances:

Spectre Syntax

The following circuit creates a simple mos device instance M1, and calls the inline subcircuit s1 twice (M2 & M3)

```
M1 (2 1 0 0) mos_mod

M2 (5 6) s1 p1=6u p2=7u

M3 (6 7) s1
```

This expands/flattens to:

```
M1 (2 1 0 0) mos_mod

M2 (5 6 0 0) mos_mod l=6u w=7u // the "inline" component, inherits call name

M2.cap1 (5 0) capacitor c=1n // a regular hierarchical name

M2.cap2 (6 0) capacitor c=1n

M3 (6 7 0 0) mos_mod l=1u w=2u // the "inline" component, inherits call name

M3.cap1 (6 0) capacitor c=1n

M3.cap2 (7 0) capacitor c=1n
```

Here the final flattened names of the three mosfets (one for each instance) are M1, M2 and M3, rather than M1, M2.s1 and M3.s1 as they would be if s1 was a regular subcircuit. The parasitic capacitors (which the user is not really interested in, or perhaps even aware of, if the inline subckt definition was written by a separate modeling engineer) have full hierarchical names however.

Example 3: inline subckt - Scaled Models

Consider the following example, in which a parameterized model is declared within an inline subcircuit for a bipolar transistor. The model parameters are the emitter width, length, and area, and also the temperature delta (trise) of the device above nominal. Ninety nine instances of a 4*4 transistor are then placed, and one instance of a transistor with area=50 is placed. Each transistor gets an appropriately scaled model.

Spectre Syntax

```
* declare a subckt, which instantiates a transistor with
* a parameterized model. The parameters are emitter width
*and length.
inline subckt bjtmod (c b e s)
parameters le=1u we=2u area=le*we trise=0
model mod1 bjt type=npn bf=100+(le+we)/2*(area/1e-12)
        is=1e-12*(le/we)*(area/1e-12)
bjtmod (c b e s) mod1 trise=trise
                                        // "inline" component
ends bjtmod
* some instances of this subckt
q1 (2 3 1 0) bjtmod le=4u we=4u
                                       // trise defaults to zero
q2 (2 3 2 0) bjtmod le=4u we=4u trise=2
q3 (2 3 3 0) bjtmod le=4u we=4u
q99 (2 3 99 0) bjtmod le=4u we=4u
q100 (2 3 100 0) bjtmod le=1u area=50e-12
```

Verilog-A Usage and Language Summary (veriloga)

Description

Verilog-A is an analog hardware description language standard from Open Verilog International. It allows analog circuit behavior to be described at a high level of abstraction, using a language which is similar to SpectreHDL (run spectre -h spectrehdl for some details on the SpectreHDL modeling language). Behavioral descriptions of modules/components may be instantiated in a Spectre netlist along with regular Spectre primitives. For more information about using the SpectreHDL product, see the <u>SpectreHDL Reference</u> manual. For more information about using Verilog-A, see the <u>Cadence Verilog-A Language Reference</u> manual.

Verilog-A descriptions are written in file(s) separate from the Spectre netlist file. These descriptions are written in modules (see the module alpha below). To include a module in the Spectre netlist, first add the line

```
ahdl include "VerilogAfile.va"
```

to the Spectre netlist file (where VerilogAfile.va is the name of the file in which the required module is defined). The module is instantiated in the Spectre netlist in the same manner as Spectre primitives for example,

```
name (node1 node2) alpha arg1=4.0 arg2=2
```

Spectre Syntax

This instantiates an element alpha, having two nodes and two parameters.

Verilog-A modules can be debugged using *hdldebug*. *hdldebug* has a GUI and a command line mode. Please refer to the *Verilog-A Debugging Tool User Guide* for more information.

Module Template

The following is a Verilog-A module template

```
include "discipline.h"
include "constants.h"
module alpha( n1, n2 );
electrical n1, n2;
parameter real arg1 = 2.0;
parameter integer arg2 = 0;
 real local;
 // this is a comment
 analog begin
  @ ( initial_step ) begin
   // performed at the first timestep of an analysis
  // module behavioral description
  V(n1, n2) <+ I(n1, n2) * arg1;
  @ (final_step ) begin
   // performed at the last time step of an analysis
   end
 end
endmodule
```

Language Summary

The following provides a summary of the Verilog-A analog hardware description language. For more information refer to the *Verilog-A Language Reference* manual.

Analog Operators/Waveform Filters

```
ddt(x <,abstol> )

idt(x, ic <, assert <, abstol> > )

Integrate x wrt time. Output = ic during dc
analysis and when assert is 1.

idtmod(x, <ic <, modulus <, offset> > )

Circular Integration of x wrt time. Output =
ic during DC analysis. Integration is
performed with given offset and modulus if
```

specified.

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Spectre Circuit Simulator Reference Spectre Syntax

<pre>transition(x <, delay <, trise <, tfall>>>)</pre>	Specify details of signal transitions. For efficient simulation, it is recommended that x not be a continuous signal, i.e. a function of a probe. See the <i>Cadence Verilog-A Language Reference</i> manual for further explanation of this issue.
<pre>slew(x <, SRpos <, SRneg>>)</pre>	Model slew rate behavior.
<pre>delay(x, time_delay, max_delay)</pre>	Response(t) = $x(t - time_delay)$.
<pre>zi_nd(x, numer, denom, period, < ttransition <,sample offset time >)</pre>	z-domain filter function, numerator-denominator form.
<pre>zi_zd(x, zeros, denom, period, < ttransition <,sample offset time >)</pre>	z-domain filter function, zero-denominator form.
<pre>zi_np(x, numer, poles, period, < ttransition <,sample offset time >)</pre>	z-domain filter function, numerator-pole form.
<pre>zi_zp(x, zeros, poles, period, < ttransition <,sample offset time >)</pre>	z-domain filter function, zero-pole form.
<pre>laplace_nd(x, numer, denom, <, abstol >)</pre>	s-domain filter function, numerator-denominator form.
<pre>laplace_zd(x, zeros, denom, <, abstol ></pre>	s-domain filter function, zero-denominator form.
<pre>laplace_np(x, numer, poles, <, abstol >)</pre>	s-domain filter function, numerator-pole form.
<pre>laplace_zp(x, zeros, poles, <, abstol >)</pre>	s-domain filter function, zero-pole form.

Built-In Mathematical Functions

abs(x)	Absolute value
exp(x)	Exponential if x < 80
ln(x)	Natural logarithm
log(x)	Log base 10
sqrt(x)	Square root
min(x,y)	Minimum
max(x,y)	Maximum

Spectre Syntax

pow(x,y) x to the power of y

Noise Functions

<pre>white_noise(power <, tag >)</pre>	Generates white noise with given power. Noise contributions with the same tag are combined for a module.
<pre>flicker_noise(power, exp <, tag >)</pre>	Generates pink noise with given power at 1 Hz that varies in proportion to 1/f^exp. Noise contributions with the same tag are combined for a module.
<pre>noise_table(vector <, tag >)</pre>	Generates noise where power is determined by linear interpolation from the given vector of frequency-power pairs. Noise contributions with the same tag are combined for a module.

AC Analysis Stimuli

```
ac_stim( <analysis_name <, mag > > ) Small signal source of specified magnitude, active for given analysis.
```

Analog Events

Analog events must be contained in an analog event detection statement; @(analog_event) statement.

<pre>cross(x, direction <, timetol <, abstol >>)</pre>	Generates an event when x crosses zero.
<pre>timer(start_time <, period>)</pre>	Set (optionally periodic) breakpoint event at time = start_time.
<pre>initial_step< (arg1 <, arg2 <, etc > >)</pre>	Generate an event at the initial step of an analysis. arg1, arg2, etc. may be any of: dc, tran, ac, pss, noise, pdisto, pac, pnoise, pxf, sp, tdr, xf, static, or ic.

Spectre Syntax

final_step< (arg1 <, arg2 <,</pre> Generate an event at the final step of an analysis. arg1, etc... > >) arg2, etc. may be any of:dc, tran, ac, pss, noise, pdisto, pac, pnoise, pxf, sp, tdr, xf, static, or ic.

Timestep Control

bound_step(max_step) Limit timestep, (timestep <= max step).

last crossing(x, Return time when expression last crossed zero in a given direction)

direction.

discontinuity(n) Hint to simulator that discontinuity is present in nth derivative.

Simulator IO Functions

\$display(argument_list) Print data to stdout. Formatting strings may be interspersed between arguments/data. \$fdisplay(fptr, Print data to a file. Formatting strings may be interspersed argument_list) between arguments/data. \$strobe(argument list) Print data to stdout. Formatting strings may be interspersed between arguments/data. \$fstrobe(fptr, Print data to a file. Formatting strings may be interspersed argument list) between arguments/data. \$fopen("filename") Open a file for writing. \$fclose(fptr) Close a file. \$finish<(n)> Finish the simulation. stop<(n)>

Simulator Environment Functions

\$realtime Returns current simulation time.

\$temperature Returns ambient simulation temperature.

Stop the simulation.

Spectre Syntax

\$vt Returns thermal voltage.

\$vt(temp) Returns thermal voltage at given temp.

\$analysis(analysis_string1<,
analysis_string2 <, ...>>)

Returns true(1) if the current analysis phase matches one of the given analyses strings. Valid analyses strings are; dc, tran, ac, pss, noise, pdisto, pac, pnoise, pxf, sp, tdr, xf, static, or ic.

Parameter Functions

\$pwr(x) Assignment of model power consumption. Adds the expression x to the pwr parameter of a module.

Data Types

integer Discrete numerical type.

real Continuous numerical type.

Data Qualifiers

parameter

Indicates that a variable is a parameter and so may be given a different value when the module is instantiated, and that it may not be assigned a different value inside the module.

Structural Statements

```
module_or_primative #(<.param1(expr1)<,...>>)
inst_name (<node1 <, ..>> );
```

Creates a new instance of module_or_primative called inst_name.

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